



FORM 10-Q

ADAPTEC INC - ADPT

Filed: February 07, 2006 (period: December 31, 2005)

Quarterly report which provides a continuing view of a company's financial position

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**UNITED STATES
SECURITIES AND EXCHANGE COMMISSION**
WASHINGTON, D.C. 20549

FORM 10-Q

(Mark One)

Quarterly report pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934
For the quarterly period ended December 31, 2005

or

Transition report pursuant to Section 13 or 15(d) of the Securities Exchange Act of 1934
For the transition period from to
Commission file number 0-15071

ADAPTEC, INC.

(Exact name of registrant as specified in its charter)

DELAWARE
(State or other jurisdiction of
incorporation or organization)

94-2748530
(I.R.S. Employer
Identification No.)

**691 S. MILPITAS BLVD.,
MILPITAS, CALIFORNIA**
(Address of principal
executive offices)

95035
(Zip Code)

Registrant's telephone number, including area code **(408) 945-8600**
N/A

(Former name, former address and former fiscal year, if changed since last report)

Indicate by check mark whether the registrant: (1) has filed all reports required to be filed by Section 13 or 15(d) of the Securities Exchange Act of 1934 during the preceding 12 months (or for such shorter period that the registrant was required to file such reports), and (2) has been subject to such filing requirements for the past 90 days.

Yes No

Indicate by check mark whether the registrant is an accelerated filer (as defined in Rule 12b-2 of the Exchange Act)

Yes No

Indicate by check mark whether the registrant is a shell company (as defined in Rule 12b-2 of the Exchange Act)

Yes No

The number of shares of Adaptec's common stock outstanding as of January 31, 2006 was 114,036,179.

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PART I. FINANCIAL INFORMATION

Item 1. Financial Statements

ADAPTEC, INC.

CONDENSED CONSOLIDATED STATEMENTS OF OPERATIONS

(unaudited)

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands, except per share amounts)			
Net revenues	\$ 77,831	\$ 93,473	\$ 236,731	\$ 292,299
Cost of revenues	48,857	59,577	156,442	164,912
Gross profit	28,974	33,896	80,289	127,387
Operating expenses:				
Research and development	14,404	21,293	47,254	68,237
Selling, marketing and administrative	15,739	17,785	49,717	55,044
Amortization of acquisition-related intangible assets	1,689	2,182	5,466	7,070
Restructuring charges	2,587	2,228	3,105	4,975
Goodwill impairment	—	—	90,602	—
Other charges (gains)	1,472	(2,755)	1,472	(2,755)
Total operating expenses	35,891	40,733	197,616	132,571
Loss from continuing operations	(6,917)	(6,837)	(117,327)	(5,184)
Interest and other income	4,479	3,097	12,610	8,599
Interest expense	(758)	(1,083)	(2,598)	(3,350)
Income (loss) from continuing operations before income taxes	(3,196)	(4,823)	(107,315)	65
Provision for (benefit from) income taxes	(582)	(21,788)	3,206	(31,463)
Income (loss) from continuing operations	(2,614)	16,965	(110,521)	31,528
Discontinued operations, net of taxes (Note 4)				
Income (loss) from discontinued operations, net of taxes	(4,149)	5,524	(31,045)	(17,092)
Income (loss) from disposal of discontinued operations, net of taxes	3,502	—	(3,474)	—
Income (loss) from discontinued operations	(647)	5,524	(34,519)	(17,092)
Net income (loss)	\$ (3,261)	\$ 22,489	\$ (145,040)	\$ 14,436
Net income (loss) per share:				
Basic				
Continuing operations	\$ (0.02)	\$ 0.15	\$ (0.98)	\$ 0.29
Discontinued operations	\$ (0.01)	\$ 0.05	\$ (0.31)	\$ (0.15)
Net income (loss)	\$ (0.03)	\$ 0.20	\$ (1.28)	\$ 0.13
Diluted				
Continuing operations	\$ (0.02)	\$ 0.13	\$ (0.98)	\$ 0.25
Discontinued operations	\$ (0.01)	\$ 0.04	\$ (0.31)	\$ (0.13)
Net income (loss)	\$ (0.03)	\$ 0.17	\$ (1.28)	\$ 0.12
Shares used in computing net income (loss) per share:				
Basic	113,531	111,136	112,980	110,429
Diluted	113,531	134,517	112,980	131,607

See accompanying Notes to Unaudited Condensed Consolidated Financial Statements.

ADAPTEC, INC.
CONDENSED CONSOLIDATED BALANCE SHEETS
(unaudited)

	December 31, 2005	March 31, 2005
	(in thousands)	
Assets		
Current assets:		
Cash and cash equivalents	\$ 107,688	\$ 441,588
Marketable securities	424,618	84,968
Restricted cash and marketable securities	1,647	1,766
Accounts receivable, net	57,086	70,159
Inventories	22,441	60,204
Prepaid expenses and other current assets	14,384	26,081
Assets held for sale	22,583	—
Current assets of discontinued operations	4,597	—
Total current assets	655,044	684,766
Property and equipment, net	32,750	56,180
Restricted marketable securities, less current portion	3,084	4,615
Goodwill	—	91,486
Other intangible assets, net	21,739	79,457
Other long-term assets	9,867	47,002
Long-term assets of discontinued operations	25,884	—
Total assets	\$ 748,368	\$ 963,506
Liabilities and Stockholders' Equity		
Current liabilities:		
Accounts payable	\$ 48,976	\$ 61,637
Accrued liabilities	86,067	116,007
Current liabilities of discontinued operations	5,336	—
Total current liabilities	140,379	177,644
¾% Convertible Senior Subordinated Notes	225,000	225,000
3% Convertible Subordinated Notes	11,992	35,190
Other long-term liabilities	3,656	15,349
Commitments and contingencies (Note 13)		
Stockholders' equity:		
Common stock	114	112
Additional paid-in capital	168,604	165,707
Deferred stock-based compensation	(460)	(2,416)
Accumulated other comprehensive income (loss), net of taxes	(2,091)	706
Retained earnings	201,174	346,214
Total stockholders' equity	367,341	510,323
Total liabilities and stockholders' equity	\$ 748,368	\$ 963,506

See accompanying Notes to Unaudited Condensed Consolidated Financial Statements.

ADAPTEC, INC.
CONDENSED CONSOLIDATED STATEMENTS OF CASH FLOWS
(unaudited)

	Nine-Month Period Ended	
	December 31, 2005	December 31, 2004
	(in thousands)	
Cash Flows From Operating Activities:		
Income (loss) from continuing operations	\$ (110,521)	\$ 31,528
Adjustments to reconcile income (loss) from continuing operations to net cash provided by (used for) operating activities:		
Non-cash restructuring charges	—	109
Impairment of goodwill	90,602	—
Stock-based compensation	284	2,348
Non-cash effect of tax settlement	—	(26,009)
Loss on extinguishment of debt	102	—
Loss (gain) on sale of long-lived assets	1,472	(2,755)
Depreciation and amortization	19,398	28,359
Deferred income taxes	—	(40)
Other non-cash items	378	(12)
Changes in assets and liabilities (net of acquired businesses)	(1,169)	(21,498)
Net Cash Provided by Operating Activities of Continuing Operations	546	12,030
Net Cash Provided by (Used for) Operating Activities of Discontinued Operations	7,876	(27,980)
Net Cash Provided by (Used for) Operating Activities	\$ 8,422	\$ (15,950)
Cash Flows From Investing Activities:		
Purchases of certain net assets in connection with acquisitions, net of cash acquired	—	(65,380)
Payment of holdback in connection with acquisition of Eurologic	—	(2,279)
Proceeds from sale of business	24,126	—
Maturities of restricted marketable securities	1,688	2,213
Purchases of property and equipment	(6,452)	(8,102)
Proceeds from sale of long-lived assets	—	9,577
Proceeds from the sale of property and equipment	2,684	—
Purchases of marketable securities	(495,893)	(270,249)
Sales of marketable securities	137,826	327,574
Maturities of marketable securities	16,084	65,541
Net Cash Provided by (Used for) Investing Activities of Continuing Operations	(319,937)	58,895
Net Cash Used for Investing Activities of Discontinued Operations	(1,655)	(63,048)
Net Cash Used for Investing Activities	(321,592)	(4,153)
Cash Flows From Financing Activities:		
Repurchases and redemption of long-term debt	(22,988)	—
Proceeds from issuance of common stock	3,329	5,446
Net Cash Provided by (Used for) Financing Activities	(19,659)	5,446
Effect of Foreign Currency Translation on Cash and Cash Equivalents	(1,071)	822
Net Decrease in Cash and Cash Equivalents	(333,900)	(13,835)
Cash and Cash Equivalents at Beginning of Period	441,588	102,463
Cash and Cash Equivalents at End of Period	\$ 107,688	\$ 88,628

See accompanying Notes to Unaudited Condensed Consolidated Financial Statements.

ADAPTEC, INC.
NOTES TO CONDENSED CONSOLIDATED FINANCIAL STATEMENTS
(unaudited)

1. Basis of Presentation

In the opinion of management, the accompanying Unaudited Condensed Consolidated Interim Financial Statements (“financial statements”) of Adaptec, Inc. and its wholly-owned subsidiaries (collectively, the “Company”) have been prepared on a consistent basis with the March 31, 2005 audited consolidated financial statements and include all adjustments, consisting of only normal recurring adjustments, necessary to fairly state the information set forth therein. The financial statements have been prepared in accordance with the regulations of the Securities and Exchange Commission (“SEC”), and, therefore, omit certain information and footnote disclosure necessary to present the statements in accordance with accounting principles generally accepted in the United States of America. These financial statements should be read in conjunction with the audited consolidated financial statements and notes thereto included in the Company’s Annual Report on Form 10-K for the fiscal year ended March 31, 2005, which was filed with the SEC on June 14, 2005. The third quarters of fiscal 2006 and 2005 ended on December 30, 2005 and December 31, 2004, respectively. For presentation purposes, the accompanying financial statements have been shown as ending on December 31. The results of operations for the third quarter and first nine months of fiscal 2006 are not necessarily indicative of the results to be expected for the entire fiscal year.

Certain reclassifications have been made to prior period reported amounts to conform to the current period presentation, including reclassification of auction rate securities from cash and cash equivalents to marketable securities. Previously, such auction rate securities were classified as cash and cash equivalents. Accordingly, the Company has revised its presentation and made adjustments to the accompanying Unaudited Condensed Consolidated Statement of Cash Flows to reflect the gross purchases and sales of these auction rate securities as investing activities. This adjustment resulted in a net increase in cash used for investing activities by \$12.6 million in the first nine months of fiscal 2005. This reclassification had no impact on previously reported results of operations, operating cash flows or working capital of the Company.

In addition, as discussed in Note 4, on September 30, 2005, the Company completed the sale to International Business Machines (“IBM”) of its IBM i/p Series RAID component business (“IBM i/p Series RAID Business”) and on September 29, 2005 the Company’s Board of Directors approved management’s recommendation to divest its systems business. Both of these businesses have been accounted for as discontinued operations. Accordingly, the Company has reclassified the underlying Unaudited Condensed Consolidated Statements of Operations and Unaudited Condensed Consolidated Statements of Cash Flows and related disclosures for all periods presented to reflect the IBM i/p Series RAID Business and the systems business as discontinued operations. In the third quarter of fiscal 2006, in conjunction with the renegotiation of a customer supply contract, the Company decided to retain a product line that was previously classified within discontinued systems business. Accordingly, the Company has reclassified the underlying Unaudited Condensed Consolidated Statements of Operations and Unaudited Condensed Consolidated Statements of Cash Flows and related disclosures for all periods presented to reflect that product line as part of continuing operations.

Unless otherwise indicated and other than balance sheet amounts as of March 31, 2005, the Notes to the Unaudited Condensed Consolidated Financial Statements relate to the discussion of the Company’s continuing operations.

The glossary of key acronyms used in the Company’s industry and accounting rules and regulations referred to within this Quarterly Report on Form 10-Q is listed in alphabetical order in Note 20.

2. Recent Accounting Pronouncements

In June 2005, the FASB issued SFAS No. 154, which changes the requirements for the accounting for, and reporting of, a change in accounting principle. Previously, most voluntary changes in accounting principles were required to be recognized by way of a cumulative effect adjustment within net income during the period of the change. SFAS No. 154 requires retrospective application to prior periods' financial statements, unless it is impracticable to determine either the period-specific effects or the cumulative effect of the change. SFAS No. 154 is effective for accounting changes made in fiscal years beginning after December 15, 2005; however, the Statement does not change the transition provisions of any existing accounting pronouncements. The Company's results of operations and financial condition will only be impacted following the adoption of SFAS No. 154 if it implements changes in accounting principles that are addressed by the standard or corrects accounting errors in future periods.

In December 2004, the FASB issued SFAS No. 123(R). This statement replaces SFAS No. 123, amends SFAS No. 95 and supersedes APB Opinion No. 25. SFAS No. 123(R) requires companies to apply a fair-value based measurement method in accounting for share-based payment transactions with employees and to record compensation expense for all stock awards granted and to awards modified, repurchased or cancelled after the required effective date. In addition, the Company is required to record compensation expense (as previous awards continue to vest) for the unvested portion of previously granted awards that remain outstanding at the date of adoption. In April 2005, the SEC approved that SFAS No. 123(R) will be effective for annual periods, as opposed to interim periods as originally issued by the FASB, beginning after June 15, 2005. In March 2005, the SEC issued SAB 107, which offers guidance on SFAS No. 123(R). SAB 107 was issued to assist preparers by simplifying some of the implementation challenges of SFAS No. 123(R) while enhancing the information that investors receive. The Company intends to use the modified prospective method, which will result in a significant increase to expenses on the Company's consolidated financial statements beginning April 1, 2006. The Company cannot currently quantify the impact of the adoption of SFAS No. 123(R) and SAB 107 as it will depend on the amount of share-based payments that the Company grants in the future as well as other variables that affect the fair market value estimates which cannot be forecasted at this time. The pro forma disclosures of the impact of SFAS No. 123 provided in Note 3 may not be representative of the impact of adopting this statement.

In November 2004, the FASB issued SFAS No. 151, which clarifies the accounting for abnormal amounts of facility expense, freight, handling costs and wasted materials (spoilage) to require them to be recognized as current-period charges. This statement is effective for inventory costs incurred during fiscal years beginning after June 15, 2005. Earlier application is permitted. The adoption of this standard is not expected to have a material impact on the Company's financial statements.

3. Stock-Based Compensation

The Company accounts for stock-based compensation using the intrinsic-value-based method, which is in accordance with APB Opinion No. 25 as interpreted by FIN 44, and complies with the disclosure provisions of SFAS No. 148, an amendment of SFAS No. 123. The Company accounts for equity instruments issued to non-employees in accordance with the provisions of SFAS No. 123 and EITF No. 96-18, which requires that such equity instruments be recorded at their fair value on the measurement date, which is typically the date of grant.

The following table illustrates the effect on net income (loss) and net income (loss) per share as if the Company had applied the fair value recognition provisions of SFAS No. 123 to employee and director stock option plans, including shares issued under the Company's ESPP, collectively called "options," for all periods presented:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands, except per share amounts)			
Net income (loss), as reported	\$ (3,261)	\$ 22,489	\$ (145,040)	\$ 14,436
Add: Deferred stock-based compensation expense included in reported net income (loss)	223	775	1,526	2,453
Deduct: Total stock-based compensation expense determined under the fair value-based method, net of tax	(3,740)	(3,837)	(10,120)	(9,923)
Pro forma net income (loss)	\$ (6,778)	\$ 19,427	\$ (153,634)	\$ 6,966
Basic net income (loss) per share:				
As reported	\$ (0.03)	\$ 0.20	\$ (1.28)	\$ 0.13
Pro forma	\$ (0.06)	\$ 0.17	\$ (1.36)	\$ 0.06
Diluted net income (loss) per share:				
As reported	\$ (0.03)	\$ 0.17	\$ (1.28)	\$ 0.12
Pro forma	\$ (0.06)	\$ 0.15	\$ (1.36)	\$ 0.06

SFAS No. 123 requires the use of option pricing models that were not developed for use in valuing employee stock options. The Black-Scholes option pricing model, used by the Company, was developed for use in estimating the fair value of short-lived exchange traded options that have no vesting restrictions and are fully transferable. In addition, option pricing models require the input of highly subjective assumptions, including the option's expected life and the price volatility of the underlying stock.

The fair value of options granted in the third quarter and first nine months of fiscal 2006 and 2005, as reported were estimated at the date of grant using the Black-Scholes valuation model with the following weighted average assumptions:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
Employee Stock Option Plans:				
Expected life (in years)	4.3	2.0	2.5	2.3
Risk-free interest rates	4.4 %	3.1 %	4.1 %	3.0 %
Expected volatility	52 %	39 %	38 %	44 %
Dividend yield	—	—	—	—
ESPP:				
Expected life (in years)	1.3	1.4	1.1	1.4
Risk-free interest rates	3.9 %	2.1 %	3.8 %	2.1 %
Expected volatility	40 %	50 %	39 %	50 %
Dividend yield	—	—	—	—

4. Discontinued Operations

IBM i/p Series RAID Business:

On September 30, 2005, the Company entered into a series of arrangements with IBM pursuant to which the Company sold its IBM i/p Series RAID Business to IBM for approximately \$22.0 million plus \$1.3 million for certain fixed assets. In addition, IBM purchased certain related inventory at the Company's net book value of \$0.8 million. Expenses incurred in the transaction primarily included costs of approximately \$0.5 million for legal and accounting fees. In addition, the Company accrued \$0.3 million for lease obligations. Under the terms of the agreements, the Company granted IBM a nonexclusive license to certain intellectual property and sold to IBM substantially all of the assets dedicated to the engineering and manufacturing of RAID controllers and connectivity products for the IBM i/p Series RAID Business. Under the terms of the nonexclusive license, IBM will pay royalties to the Company for the sale of its board-level products over the next six quarters, which will be recognized as contingent consideration in discontinued operations when earned. In the third quarter of fiscal 2006, the Company received royalties of \$3.5 million, which the Company recorded in "Income (loss) from disposal of discontinued operations, net of taxes," in the Unaudited Condensed Consolidated Statements of Operations.

Net revenues and the components of income (loss) related to these discontinued operations, which were previously included in the Company's DPS segment, were as follows:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands)			
Net revenues	\$ 237	\$ 9,870	\$ 20,046	\$ 15,056
Income (loss) from discontinued operations before income taxes	424	(3,341)	(14,239)	(8,945)
Provision for (benefit from) income taxes	282	(11,714)	(360)	(903)
Income (loss) from discontinued operations, net of taxes	\$ 142	\$ 8,373	\$ (13,879)	\$ (8,042)

The components of net assets, at the time of the sale of the IBM i/p Series RAID Business, were as follows:

	September 30, 2005
	(in thousands)
Inventories	\$ 838
Prepaid expenses	11,139
Property and equipment, net	3,326
Other intangibles, net	10,958
Other long-term assets	24,507
Accrued liabilities	(10,051)
Other long-term liabilities	(10,625)
Net assets of discontinued operations	\$ 30,092

Accounts receivable related to the IBM i/p Series RAID Business were not included in discontinued operations as the Company will be retaining these assets.

Systems Business:

On September 29, 2005, the Company's Board of Directors approved management's recommendation to divest its systems business, which includes substantially all of the operating assets and cash flows that were obtained through the Snap Appliance and Eurologic Systems acquisitions as well as internally developed hardware and software. In connection with this action, the Company has classified the systems business as a discontinued operation in the financial statements. The Company has entered into an exclusive arrangement with an investment banker to sell this business and expects to receive proceeds, less cost to sell, in excess of its carrying value.

In the third quarter of fiscal 2006, in conjunction with the renegotiation of a customer supply contract, the Company decided to retain a product line that was previously classified within discontinued systems business. Accordingly, the Company has reclassified the underlying Unaudited Condensed Consolidated Statements of Operations and Unaudited Condensed Consolidated Statements of Cash Flows and related disclosures for all periods presented to reflect that product line as part of continuing operations.

Net revenues and the components of net loss related to the discontinued operations, were as follows:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands)			
Net revenues	\$ 18,958	\$ 23,205	\$ 53,704	\$ 56,395
Loss from discontinued operations before provision for income taxes	(3,501)	(2,729)	(16,651)	(10,510)
Provision for (benefit from) income taxes	790	120	515	(1,460)
Loss from discontinued operations, net of taxes	\$ (4,291)	\$ (2,849)	\$ (17,166)	\$ (9,050)

The components of net assets related to the discontinued operations were as follows:

	December 31, 2005
	(in thousands)
Inventories	\$ 4,522
Prepaid expenses	75
Current assets of discontinued operations	4,597
Property and equipment, net	1,145
Other intangibles, net	24,730
Other long-term assets	9
Total assets of discontinued operations	30,481
Accrued liabilities	(5,336)
Current liabilities of discontinued operations	(5,336)
Net assets of discontinued operations	\$ 25,145

Accounts receivable related to the systems business were not included in discontinued operations as the Company intends to retain these assets.

5. Balance Sheet Details

Inventories:

	<u>December 31, 2005</u>	<u>March 31, 2005</u>
	(in thousands)	
Raw materials	\$ 10,775	\$ 15,914
Work-in-process	6,334	7,435
Finished goods	5,332	36,855
Total	<u>\$ 22,441</u>	<u>\$ 60,204</u>

Accrued Liabilities:

	<u>December 31, 2005</u>	<u>March 31, 2005</u>
	(in thousands)	
Tax related	\$ 46,632	\$ 57,538
Acquisition related	3,604	6,748
Accrued compensation and related taxes	19,676	18,304
IBM distribution agreement	—	11,575
Other	16,155	21,842
Total	<u>\$ 86,067</u>	<u>\$ 116,007</u>

6. Goodwill and Other Intangible Assets

Goodwill:

Goodwill allocated to the Company's reportable segments and changes in the carrying amount of goodwill for the first nine months of fiscal 2006 was as follows:

	<u>OEM</u>	<u>Channel</u>	<u>Total</u>
	(in thousands)		
Balance at March 31, 2005	\$ 48,783	\$ 42,703	\$ 91,486
Goodwill adjustments	(166)	(718)	(884)
Goodwill impairment	<u>(48,617)</u>	<u>(41,985)</u>	<u>(90,602)</u>
Balance at December 31, 2005	<u>\$ —</u>	<u>\$ —</u>	<u>\$ —</u>

In the first quarter of fiscal 2006, adjustments were made to goodwill for changes to the acquisition-related restructuring reserves and other purchase price adjustments for the IBM i/p Series RAID business and Snap Appliance. As a result of the segment reorganization, discussed in Note 15, an assessment of the recoverability of goodwill was performed. Impairment of goodwill is tested at the Company's operating segment level by comparing each segment's carrying amount, including goodwill, to the fair value of that segment. To determine fair value, the Company's review process uses the income, or discounted cash flows, approach and the market approach. In performing its analysis, the Company uses the best information available under the circumstances, including reasonable and supportable assumptions and projections. If the carrying amount of the operating segment exceeds its implied fair value, goodwill is considered impaired and a second step is performed to measure the amount of impairment loss, if any. As a result of this review, the Company wrote-off its entire balance of goodwill of \$90.6 million in the second quarter of fiscal 2006. Factors that led to this conclusion were industry technology changes such as the shift from parallel to serial technology and the migration of core functionality to server chipsets; required increased investments that eventually led the Company to sell the IBM i/p Series RAID Business and the proposed sale of the systems business; continued losses associated with sales of systems to IBM; and general market conditions.

Other Intangible Assets:

	December 31, 2005		March 31, 2005	
	Gross Carrying Amount	Accumulated Amortization	Gross Carrying Amount	Accumulated Amortization
	(in thousands)			
Acquisition-related intangible assets:				
Patents, core and existing technologies	\$ 39,578	\$ (27,861)	\$ 74,009	\$ (26,265)
Supply agreement	—	—	7,600	(1,140)
Customer relationships	1,047	(708)	1,290	(631)
Trade names	674	(577)	10,930	(1,523)
Foundry agreement	—	—	600	(90)
Subtotal	41,299	(29,146)	94,429	(29,649)
Intellectual property assets and warrants	41,623	(32,037)	41,942	(27,265)
Total	\$ 82,922	\$ (61,183)	\$ 136,371	\$ (56,914)

Amortization of other intangible assets was \$3.3 million and \$4.1 million in the third quarter of fiscal 2006 and 2005, respectively. Amortization of other intangible assets was \$10.5 million and \$12.5 million in the first nine months of fiscal 2006 and 2005, respectively.

The annual amortization expense of the other intangible assets that existed as of December 31, 2005 is expected to be as follows:

	Estimated Amortization Expense	
	Acquisition-related Intangible Assets	Intellectual Property Assets
	(in thousands)	
Fiscal Years:		
2006 (remaining three months)	\$ 1,688	\$ 1,579
2007	5,726	6,316
2008	2,534	1,691
2009	2,205	—
2010 and thereafter	—	—
Total	\$ 12,153	\$ 9,586

7. Interest and Other Income

The components of interest and other income for the third quarter and first nine months of fiscal 2006 and 2005, were as follows:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands)			
Interest income	\$ 4,450	\$ 2,833	\$ 11,993	\$ 8,593
Payment of license fee with NSE	—	(442)	—	(1,692)
Loss on redemption of debt	—	—	(102)	—
Foreign currency transaction gains (losses)	(241)	461	(621)	800
Other	270	245	1,340	898
Total	\$ 4,479	\$ 3,097	\$ 12,610	\$ 8,599

In the first nine months of fiscal 2006, the Company repurchased \$23.2 million in aggregate principal amount of its 3% Convertible Subordinated Notes ("3% Notes") on the open market for an aggregate price of \$23.1 million, resulting in an immaterial loss. The loss on extinguishment of debt has been included in "Interest and other income" in the Company's Unaudited Condensed Consolidated Statement of Operations. Subsequent to the third quarter of fiscal 2006, the Company repurchased \$1.4 million of the 3% Notes on the open market for \$1.3 million, resulting in an immaterial gain. The gain on extinguishment of debt will be included in "Interest and other income" in the Company's Consolidated Statement of Operations in the fourth quarter of fiscal 2006.

In June 2004, the Company, Nevada SCSI Enterprises, Inc. and Thomas A. Gafford (jointly, "NSE") entered into a license and release agreement, pursuant to which the Company paid NSE \$1.3 million as a one-time, fully paid-up license payment fee to settle NSE's claims that some of the Company's products infringed certain patents. The license and release agreement expressly excluded any sales of products made by Eurologic prior to the Company's April 2003 acquisition of Eurologic. In November 2004, the Company exercised its option to secure a license and release with respect to such Eurologic sales by payment to NSE of a royalty fee of \$0.4 million. The Company has filed a claim against the Eurologic acquisition Holdback for the \$0.4 million royalty it paid with respect to Eurologic's pre-acquisition sales. The Eurologic shareholders are disputing the Company's right to withhold the \$0.4 million from the Holdback. See Note 13 for further discussion of the Eurologic Holdback.

8. Restructuring Charges

In the third quarter of fiscal 2006, management approved and initiated a plan to restructure the operations of the Company by simplifying its infrastructure. The third quarter of fiscal 2006 restructuring plan eliminated certain duplicative resources in all functions of the organization worldwide, due in part, to the discontinued operations and vacated redundant facilities in order to reduce the combined cost structure of the Company. This resulted in a restructuring charge of \$2.4 million for the third quarter of fiscal 2006.

The Company recorded provision adjustments of \$0.2 million and \$0.7 million in the third quarter of fiscal 2006 and first nine months of fiscal 2006, respectively, related to severance and benefits as actual costs were lower than anticipated and additional lease costs related to the estimated loss on facilities that the Company subleased. The provision adjustments also include additional lease costs related to the estimated loss on facilities that the Company subleased in connection with Snap Appliance acquisition (Note 18). These provision adjustments pertained to the restructuring plans that the Company implemented in each quarter of fiscal 2005, and restructuring plans that it implemented in fiscal 2004, fiscal 2003, fiscal 2002 and fiscal 2001. The fiscal 2004 restructuring plan was completed in the first quarter of fiscal 2006. The third quarter of fiscal 2005 restructuring plan and fourth quarter of fiscal 2005 restructuring plan were completed in the third quarter of fiscal 2006. For a complete discussion of all restructuring actions that were implemented prior to fiscal 2006, please refer to the Notes to Consolidated Financial Statements included in the Company's Annual Report on Form 10-K for the fiscal year ended March 31, 2005. All expenses, including adjustments, associated with the Company's restructuring plans are included in "Restructuring charges" in the Unaudited Condensed Consolidated Statements of Operations and are not allocated to segments, but are managed at the corporate level.

The activity in the accrued restructuring reserves related to all of the plans was as follows for the first nine months of fiscal 2006:

	<u>Severance And Benefits</u>	<u>Other Charges</u>	<u>Total</u>
	(in thousands)		
Reserve balance at March 31, 2005	\$ 896	\$ 1,627	\$ 2,523
Q3'06 Restructuring Plan	1,738	695	2,433
Provision adjustments	(288)	716	428
Cash paid	(1,886)	(1,037)	(2,923)
Reserve balance at December 31, 2005	<u>\$ 460</u>	<u>\$ 2,001</u>	<u>\$ 2,461</u>

The Company anticipates that the remaining restructuring reserve balance of \$2.5 million will be substantially paid out by the first quarter of fiscal 2009, primarily attributable to longer term lease obligations. The remaining restructuring reserve balance is reflected both in "Accrued liabilities" and "Other long-term liabilities" in the Unaudited Condensed Consolidated Balance Sheet.

9. Other Charges (Gains)

In January 2006, the Company entered into a three-year contract manufacturing agreement with Sanmina-SCI whereby Sanmina-SCI has assumed manufacturing operations of Adaptec products. In addition, the Company sold certain manufacturing assets, buildings and improvements and inventory located in Singapore to Sanmina-SCI. In connection with this agreement, the Company recorded a loss on disposal of assets of \$1.5 million that was recorded in the third quarter of fiscal 2006 in "Other charges (gains)" on the Unaudited Condensed Consolidated Statements of Operations. Please refer to Note 17 for further details.

In October 2004, the Company completed the sale of certain properties in Milpitas, California that were previously classified as held for sale. Net proceeds from the sale of the properties aggregated \$9.6 million, which exceeded the Company's final revised fair value of \$6.8 million. As a result, a gain on the sale of the properties of \$2.8 million was recorded in the third quarter of fiscal 2005 as a credit to "Other charges (gains)" in the Unaudited Condensed Consolidated Statements of Operations.

10. Net Income (Loss) Per Share

Basic net income (loss) per share is computed by dividing net income (loss) by the weighted average number of common shares outstanding during the period. Diluted net income (loss) per share gives effect to all potentially dilutive common shares outstanding during the period, which include certain stock options and warrants, calculated using the treasury stock method, and convertible notes which are potentially dilutive at certain earnings levels, and are computed using the if-converted method.

A reconciliation of the numerator and denominator of the basic and diluted income (loss) per share computations for continuing operations, discontinued operations and net income (loss) were as follows:

	Three-Month Period Ended					
	Continuing Operations		Discontinued Operations		Net Income (Loss)	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands, except per share amounts)					
Numerators:						
Income (loss)	\$ (2,614)	\$ 16,965	\$ (647)	\$ 5,524	\$ (3,261)	\$ 22,489
Adjustment for interest expense on ¾% Notes, net of taxes	—	454	—	—	—	454
Adjustment for interest expense on 3% Notes, net of taxes	—	196	—	—	—	196
Adjusted income (loss)	<u>\$ (2,614)</u>	<u>\$ 17,615</u>	<u>\$ (647)</u>	<u>\$ 5,524</u>	<u>\$ (3,261)</u>	<u>\$ 23,139</u>
Denominators:						
Weighted average shares outstanding—basic	113,531	111,136	113,531	111,136	113,531	111,136
Effect of dilutive securities:						
Employee stock options and other	—	1,859	—	1,859	—	1,859
¾% Notes	—	19,224	—	19,224	—	19,224
3% Notes	—	2,298	—	2,298	—	2,298
Weighted average shares and potentially dilutive common shares outstanding—diluted	<u>113,531</u>	<u>134,517</u>	<u>113,531</u>	<u>134,517</u>	<u>113,531</u>	<u>134,517</u>
Income (loss) per share:						
Basic	\$ (0.02)	\$ 0.15	\$ (0.01)	\$ 0.05	\$ (0.03)	\$ 0.20
Diluted	\$ (0.02)	\$ 0.13	\$ (0.01)	\$ 0.04	\$ (0.03)	\$ 0.17

	Nine-Month Period Ended					
	Continuing Operations		Discontinued Operations		Net Income (Loss)	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
(in thousands, except per share amounts)						
Numerators:						
Income (loss)	\$ (110,521)	\$ 31,528	\$ (34,519)	\$ (17,092)	\$ (145,040)	\$ 14,436
Adjustment for interest expense on ¾% Notes, net of taxes	—	1,371	—	—	—	1,371
Adjustment for interest expense on 3% Notes, net of taxes	—	—	—	—	—	—
Adjusted income (loss)	<u>\$ (110,521)</u>	<u>\$ 32,899</u>	<u>\$ (34,519)</u>	<u>\$ (17,092)</u>	<u>\$ (145,040)</u>	<u>\$ 15,807</u>
Denominators:						
Weighted average shares outstanding—basic	112,980	110,429	112,980	110,429	112,980	110,429
Effect of dilutive securities:						
Employee stock options and other	—	1,954	—	1,954	—	1,954
¾% Notes	—	19,224	—	19,224	—	19,224
3% Notes	—	—	—	—	—	—
Weighted average shares and potentially dilutive common shares outstanding—diluted	<u>112,980</u>	<u>131,607</u>	<u>112,980</u>	<u>131,607</u>	<u>112,980</u>	<u>131,607</u>
Income (loss) per share:						
Basic	\$ (0.98)	\$ 0.29	\$ (0.31)	\$ (0.15)	\$ (1.28)	\$ 0.13
Diluted	\$ (0.98)	\$ 0.25	\$ (0.31)	\$ (0.13)	\$ (1.28)	\$ 0.12

Diluted loss per share from continuing operations, discontinued operations and net loss for the third quarter and first nine months of fiscal 2006 was based only on the weighted-average number of shares outstanding during the period, as the inclusion of any common stock equivalents would have been anti-dilutive. In addition, certain potential common shares were excluded from the diluted computation from continuing operations, discontinued operations and net income for the third quarter and first nine months of fiscal 2005 because their inclusion would have been anti-dilutive. The items excluded for the third quarters and first nine months of fiscal 2006 and 2005 from continuing operations, discontinued operations and net income (loss) were as follows:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands)			
Outstanding employee stock options	23,549	13,971	22,939	14,478
Warrants(1)	19,874	19,624	19,874	19,624
¾% Notes	19,224	—	19,224	—
3% Notes	783	—	1,030	2,298

- (1) In connection with the issuance of its ¾% Notes, the Company entered into a derivative financial instrument to repurchase up to 19,224,000 shares of its common stock, at the Company's option, at specified prices in the future to mitigate any potential dilution as a result of the conversion of the ¾% Notes. For further discussion on this derivative financial instrument, please refer to Note 6 of the Notes to Consolidated Financial Statements in the Company's Annual Report on Form 10-K for the fiscal year ended March 31, 2005.

11. Comprehensive Income (Loss)

The Company's comprehensive income (loss), which consisted of net loss and the changes in net unrealized gains (losses) on marketable securities, net of taxes, and foreign currency translation adjustments, net of taxes, were as follows:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands)			
Net income (loss)	\$ (3,261)	\$ 22,489	\$ (145,040)	\$ 14,436
Net unrealized losses on marketable securities, net of taxes	(739)	(921)	(1,549)	(3,955)
Foreign currency translation adjustment, net of taxes	(286)	1,089	(1,248)	1,036
Comprehensive income (loss)	\$ (4,286)	\$ 22,657	\$ (147,837)	\$ 11,517

The components of accumulated other comprehensive income (loss), net of taxes, were as follows:

	December 31, 2005	March 31, 2005
	(in thousands)	
Unrealized losses on marketable securities	\$ (2,095)	\$ (546)
Foreign currency translation, net of tax of \$3 at December 31, 2005 and \$834 at March 31, 2005	4	1,252
Total	\$ (2,091)	\$ 706

12. Income Taxes

Income tax provisions for interim periods are based on the Company's estimated annual income tax. The estimated annual tax for fiscal 2006 primarily consists of foreign taxes related to the Company's foreign subsidiaries and interest accrued on prior years' tax disputes. The Company currently has a full valuation allowance on its net U.S. deferred tax assets. The Company is in ongoing negotiations with the IRS with regard to its various tax disputes that may result in settlement of certain issues. The Company's tax rate for the period in which a settlement is reached will be impacted if the settlement materially differs from the amounts previously accrued. The tax rate for the third quarter and the first nine months of fiscal 2005 also differed from the combined United States Federal and state statutory income tax rate of 40% due to tax benefits of \$21.9 million and \$31.9 million respectively from discrete events relating to the method and amount of settled controversies. As a result of the settlements, \$21.9 million previously recorded as a tax provision was reversed during the third quarter of fiscal 2005. In addition, \$4.1 million previously recorded as a tax provision was reclassified as a reduction to additional paid-in capital, \$1.8 million previously recorded as a tax provision has been reversed, and a \$4.0 million tax benefit associated with a refund claim has been recognized during the second quarter of fiscal 2005.

13. Commitments and Contingencies

The Company has been, or is, subject to IRS audits for its fiscal years 1994 through 2003. The fiscal 1994 through fiscal 1996 cycle, which is docketed in the United States Tax Court, was resolved in December 2001. The outcome did not have a material adverse effect on the Company's financial position or results of operations, as sufficient tax provisions had been made. The final Tax Court stipulation will be filed when the subsequent audit cycles are completed. Tax credits that were generated but not used in subsequent years may be carried back to the fiscal 1994 to 1996 audit cycle.

On December 15, 2000, the Company received a statutory notice of deficiency from the IRS with respect to its Federal income tax return for fiscal 1997. The Company filed a Petition with the United States Tax Court on March 14, 2001, contesting the asserted deficiencies. Settlement agreements have been filed with the United States Tax Court on all but one issue. The Company believes that the final outcome of all issues will not have a material adverse impact on its financial position or results of operations, as the Company believes that it has meritorious defenses against the asserted deficiencies and any proposed adjustments and that it has made sufficient tax provisions. However, the Company cannot predict with certainty how these matters will be resolved and whether it will be required to make additional payments.

In addition, the IRS is currently auditing the Company's Federal income tax returns for fiscal 1998 through fiscal 2003. In the third quarter of fiscal 2005, the Company resolved all issues for fiscal 1998 through fiscal 2001, other than the rollover impact of any potential resolution on the remaining fiscal 1997 issue and tax credits that were generated but not used in subsequent years that may be carried back. The Company believes that it has provided sufficient tax provisions for these years and the ultimate outcome of the IRS audits will not have a material adverse impact on its financial position or results of operations in future periods. However, the Company cannot predict with certainty how these matters will be resolved and whether it will be required to make additional tax payments.

The Company is a party to other litigation matters and claims, including those related to intellectual property, which are normal in the course of its operations, and while the results of such litigation matters and claims cannot be predicted with certainty, the Company believes that the final outcome of such matters will not have a material adverse impact on its financial position or results of operations. However, because of the nature and inherent uncertainties of litigation, should the outcome of these actions be unfavorable, the Company's business, financial condition, results of operations and cash flows could be materially and adversely affected.

In connection with the Company's acquisitions of Snap Appliance, Eurologic, Elipsan Limited ("Elipsan"), and Platys Communications, Inc. ("Platys"), a portion of the purchase price and other future payments totaling \$6.7 million, \$3.8 million, \$2.0 million and \$15.0 million, respectively, were held back (the "Holdbacks") for unknown liabilities that may have existed as of the acquisition dates. The Company has asserted claims against the Snap Appliance, Eurologic and Platys Holdbacks totaling \$3.0 million, \$1.5 million and \$0.7 million, respectively. The Elipsan Holdback of \$2.0 million was paid in the second quarter of fiscal 2006.

14. Guarantees

Intellectual Property Indemnification Obligations

The Company has entered into agreements with customers and suppliers that include intellectual property indemnification obligations. These indemnification obligations generally require the Company to compensate the other party for certain damages and costs incurred as a result of third party intellectual property claims arising from these transactions. In each of these circumstances, payment by the Company is conditional on the other party making a claim pursuant to the procedures specified in the particular contract, which procedures typically allow the Company to challenge the other party's claims. Further, the Company's obligations under these agreements may be limited in terms of time and/or amount, and in some instances, the Company may have recourse against third parties for certain payments made by it under these agreements. It is not possible to make a reasonable estimate of the maximum potential amount of future payments under these or similar agreements due to the conditional nature of the Company's obligations and the unique facts and circumstances involved in each particular agreement. Historically, the Company has not incurred significant costs to defend lawsuits or settle claims related to such agreements and no amount has been accrued in the accompanying financial statements with respect to these indemnification guarantees.

Product Warranty

The Company provides an accrual for estimated future warranty costs based upon the historical relationship of warranty costs to sales. The estimated future warranty obligations related to product sales are recorded in the period in which the related revenue is recognized. The estimated future warranty obligations are affected by product failure rates, material usage and replacement costs incurred in correcting a product failure. If actual product failure rates, material usage or replacement costs differ from the Company's estimates, revisions to the estimated warranty obligations would be required; however, the Company made no adjustments to pre-existing warranty accruals in the first nine months of fiscal 2006 and 2005.

A reconciliation of the changes to the Company's warranty accrual for the first nine months of fiscal 2006 and 2005 was as follows:

	<u>Nine-Month Period Ended</u>	
	<u>December 31, 2005</u>	<u>December 31, 2004</u>
	(in thousands)	
Balance at beginning of period	\$ 2,084	\$ 1,598
Warranties assumed	—	2,562
Warranties provided	3,958	3,932
Actual costs incurred	(4,053)	(4,188)
Warranties classified as current liabilities of discontinued operations (Note 4)	(359)	—
Balance at end of period	<u>\$ 1,630</u>	<u>\$ 3,904</u>

15. Segment Reporting

In the second quarter of fiscal 2006, the Company reorganized its internal organization structure related to its OEM and Channel segments. Where previously the Company's former OEM and Channel segments each offered an integrated set of customer-focused products, the new organization is managed at the product level.

Following the reorganization, the Company operated in two reportable segments: DPS and DSG. A description of the types of customers or products and services provided by each reportable segment is as follows:

- DPS provides storage products and currently sells all of its storage technologies in various form factors, such as board-level products, ASICs, RAID enclosures and stand-alone software. The Company sells these products directly to OEMs, ODMs that supply OEMs, VARs and end users through its network of distribution and reseller customers.
- DSG provides high-performance I/O connectivity and digital media products for personal computing platforms, including notebook and desktop PCs. The Company sells these products to retailers, OEMs and distributors.

The unallocated corporate income and expenses, which are in the "Other" category, include amortization of acquisition-related intangible assets, restructuring charges, goodwill impairment, other charges (gains), interest and other income, interest expense, all administrative expenses and certain research and development, selling and marketing expenses.

Summarized financial information on the Company's reportable segments, under the new organizational structure, is shown in the following table. The segment financial data for the third quarter of fiscal 2005 and first nine months of fiscal 2005 and fiscal 2006 has been restated to reflect this change. There were no inter-segment revenues for the periods shown below. The Company does not separately track all tangible assets or depreciation by operating segments nor are the segments evaluated under these criteria. Segment financial information is summarized as follows for the third quarters and first nine months of fiscal 2006 and 2005:

	<u>DPS</u>	<u>DSG</u>	<u>Other</u>	<u>Consolidated</u>
	(in thousands)			
Three-Month Period Ended December 31, 2005:				
Net revenues	\$ 69,130	\$ 8,701	\$ —	\$ 77,831
Segment income (loss)	16,778	(403)	(19,571)	(3,196)
Three-Month Period Ended December 31, 2004:				
Net revenues	\$ 84,888	\$ 8,585	\$ —	\$ 93,473
Segment income (loss)	16,034	(402)	(20,455)	(4,823)
Nine-Month Period Ended December 31, 2005:				
Net revenues	\$ 208,114	\$ 28,617	\$ —	\$ 236,731
Segment income (loss)	42,794	(1,875)	(148,234)	(107,315)
Nine-Month Period Ended December 31, 2004:				
Net revenues	\$ 263,756	\$ 28,543	\$ —	\$ 292,299
Segment income (loss)	62,917	5,558	(68,410)	65

The following table presents the details of unallocated corporate income and expenses for the third quarters and first nine months of fiscal 2006 and 2005:

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
	(in thousands)			
Unallocated corporate expenses, net	\$ (19,233)	\$ (22,996)	\$ (63,067)	\$ (71,439)
Restructuring charges	(2,587)	(2,228)	(3,105)	(4,975)
Other charges (gains)	(1,472)	2,755	(1,472)	2,755
Goodwill impairment	—	—	(90,602)	—
Interest and other income	4,479	3,097	12,610	8,599
Interest expense	(758)	(1,083)	(2,598)	(3,350)
Total	<u>\$ (19,571)</u>	<u>\$ (20,455)</u>	<u>\$ (148,234)</u>	<u>\$ (68,410)</u>

16. Supplemental Disclosure of Cash Flows

	Nine-Month Period Ended	
	December 31, 2005	December 31, 2004
	(in thousands)	
Non-cash investing and financial activities:		
Deferred stock-based compensation	\$ —	\$ 7,060
Adjustment for deferred stock-based compensation	430	116
Unrealized loss on available-for-sale securities	(1,549)	(3,955)
Restricted stock	—	118

17. Assets Held for Sale

The Company entered into on December 23, 2005 and subsequently closed on January 9, 2006 a three-year contract manufacturing agreement with Sanmina—SCI whereby Sanmina—SCI has assumed manufacturing operations of Adaptec products. In addition, the Company sold certain manufacturing assets, buildings and improvements and inventory located in Singapore with respect to printed circuit board assemblies and storage system manufacturing operations to Sanmina—SCI for the Company's net book value of approximately \$27.0 million, subject to final closing adjustments for \$25.5 million (net of closing costs of \$0.5 million) resulting in a loss on disposal of assets of \$1.5 million that was recorded in the third quarter of fiscal 2006 in "Other charges (gains)" on the Unaudited Condensed Consolidated Statements of Operations. Those assets have been reclassified to "Assets held for sale" on the Unaudited Condensed Consolidated Balance Sheets.

18. Business Acquisitions

The acquisitions described below were previously accounted for as purchase transactions and, accordingly, the results of operations and financial position of the acquired businesses were included in the Company's financial statements as of the respective effective dates of the acquisitions. However, as a result of the sale of the IBM i/p Series RAID Business and the Company's plan to divest its systems business, the assets expected to be sold have been reclassified as Assets and Liabilities of Discontinued Operations on the Unaudited Condensed Consolidated Balance Sheet at December 31, 2005 and the related operations have been reclassified to "Income (loss) from discontinued operations, net of taxes" on the Unaudited Condensed Consolidated Statements of Operations, as discussed in Note 4.

IBM i/p Series RAID: On June 29, 2004, the Company completed the acquisition of the IBM i/p Series RAID component business line consisting of certain purchased RAID data protection intellectual property, semiconductor designs and assets, and licensed from IBM related RAID intellectual property.

The licensing agreement granted the Company the right to use IBM's RAID technology and embedded Power PC technology for the Company's internal and external RAID products to be sold to IBM and other customers. In conjunction with the acquisition, the Company also entered into a three-year exclusive product supply agreement under which the Company agreed to supply RAID software, firmware and hardware to IBM for use in IBM's iSeries and pSeries servers. The Company also entered into an agreement for IBM to provide silicon wafer manufacturing processing services to the Company for the term of the supply agreement at agreed upon rates.

The final purchase price was \$49.3 million, which consisted of a cash payment to IBM of \$47.5 million, warrants valued at \$1.1 million, net of registration costs, and transaction costs of \$0.7 million. This purchase price included a final adjustment of \$0.2 million in the first quarter of fiscal 2006 to both goodwill and acquisitions costs. In connection with the acquisition, the Company issued a warrant to IBM to purchase 250,000 shares of the Company's common stock at an exercise price of \$8.13 per share. The warrant has a term of 5 years from the date of issuance and is immediately exercisable. The warrant was valued using the Black-Scholes valuation model using a volatility rate of 62%, a risk-free interest rate of 3.9% and an estimated life of 5 years. The transaction costs consisted primarily of legal, valuation and other fees. The IBM i/p Series RAID business was included in the Company's DPS segment.

Snap Appliance: On July 23, 2004, the Company completed the acquisition of Snap Appliance, a provider of NAS products, to expand its product offerings in the external storage market and to deliver cost-effective, scalable and easy-to-use DAS, NAS, Fibre Channel and IP-based SAN products from the workgroup to the data center. The final purchase price was \$83.7 million, consisting of \$76.7 million in cash and transaction fees and \$7.0 million related to the fair value of assumed stock options to purchase 1.2 million shares of the Company's common stock. This purchase price included a final adjustment of \$0.7 million in the first half of fiscal 2006 to both goodwill and acquisitions costs. The assumed stock options were valued using the Black-Scholes valuation model with the following assumptions: volatility rate of 58%; a risk-free interest rate of 2.6%; and an estimated life of 2.25 years. In the first quarter of fiscal 2006, adjustments of \$0.7 were made to both goodwill and the acquisition costs.

Of the total assumed stock options, stock options to purchase approximately 0.7 million shares of the Company's common stock, with exercise prices ranging between \$1.42 and \$5.66 per share, were unvested (the "Snap Unvested Options"). The Snap Unvested Options have a ten-year term and vest primarily over four years from the date of grant. The intrinsic value of the Snap Unvested Options of \$3.6 million was accounted for as deferred stock-based compensation and is being recognized as compensation expense over the related vesting periods.

In addition, a management incentive program was established to pay former employees of Snap Appliance cash payments totaling \$13.8 million, which is being paid, contingent upon their employment with the Company, over a two-year period through the second quarter of fiscal 2007. Payments under the management incentive program will be expensed as employees meet their employment obligations or are recorded as part of the Snap Appliance acquisition-related restructuring for involuntary terminations by the Company. Any amounts outstanding as of the completion of the sale of the systems business will be accelerated.

Acquisition-Related Restructuring:

During the first quarter of fiscal 2006, the Company finalized its Snap Appliance integration plan to eliminate certain duplicative resources, including severance and benefits in connection with the involuntary termination of approximately 24 employees, exiting duplicative facilities and disposing of duplicative assets. The acquisition-related restructuring liabilities were accounted for under EITF No. 95-3 and therefore were included in the purchase price allocation. The Company recorded a total liability of \$6.7 million for these activities, of which the original estimate of \$6.0 million was recorded in the second

quarter of fiscal 2005 and adjustments were recorded in each subsequent quarter through the first quarter of fiscal 2006 totaling \$0.7 million. Any further changes to the Company's finalized plan will be accounted for under SFAS No. 146 and will be recorded in "Restructuring charges" in the Unaudited Condensed Consolidated Statements of Operations. In the third quarter of fiscal 2006, the Company recorded additional adjustments of \$0.2 million due to additional lease costs related to the estimated loss of facilities that the Company subleased, which was recorded in "Restructuring charges" in the Unaudited Condensed Consolidated Statements of Operations (Note 8). As of December 31, 2005, the Company had utilized \$4.2 million of these charges. The Company anticipates that the remaining restructuring reserve balance of \$2.7 million will be paid out by the third quarter of fiscal 2012, primarily related to long-term facility leases.

The activity in the accrued restructuring reserve related to the Snap Appliance acquisition-related restructuring plan was as follows for the first nine months of fiscal 2006:

	<u>Severance And Benefits</u>	<u>Other Charges</u> (in thousands)	<u>Total</u>
Snap Appliance Acquisition-Related Restructuring Plan:			
Reserve balance at March 31, 2005	\$ 155	\$ 2,901	\$ 3,056
Adjustments	(49)	244	195
Cash paid	(60)	(538)	(598)
Reserve balance at December 31, 2005	<u>\$ 46</u>	<u>\$ 2,607</u>	<u>\$ 2,653</u>

In-process Technology

As part of the purchase agreements of the IBM i/p Series RAID business and Snap Appliance, certain amounts of the purchase prices were allocated to acquired in-process technology which were determined through established valuation techniques in the high-technology computer industry and written off in the first and second quarter of fiscal 2005, respectively, because technological feasibility had not been established and no alternative future uses existed. The values were determined by estimating the net cash flows and discounting the estimated net cash flows to their present values. A summary of the amounts written off were as follows:

	<u>Acquired In-Process Technology</u> (in thousands)
IBM i/p Series RAID business(1)	\$ 3,000
Snap Appliance(2)	2,200

- (1) The in-process projects were related to designing semiconductors and related boards and enhancements to RAID and firmware code.
- (2) The identified in-process projects were related to operating system enhancements and system functionality improvements.

The net cash flows from the identified projects were based on estimates of revenues, cost of revenues, research and development expenses, including costs to complete the projects, selling, marketing and administrative expenses, royalty expenses and income taxes from the projects. The Company believes the assumptions used in the valuations were reasonable at the time of the acquisitions. The estimated net revenues and gross margins were based on management's projections of the projects and were in line with industry averages. Estimated total net revenues from the projects of the IBM i/p Series RAID business and Snap Appliance were expected to grow through fiscal 2009 and decline thereafter as other new products were expected to become available. Estimated operating expenses included research and development expenses and selling, marketing and administrative expenses based upon historical and expected direct expense levels and general industry metrics. Estimated research and development expenses included costs

to bring the projects to technological feasibility and costs associated with activities undertaken to correct errors or keep products updated with current information (also referred to as “maintenance” research and development) after a product is available for general release to customers. These activities range from 0% to 5% of net revenues for the in-process technologies.

The effective tax rate used in the analysis of the in-process technologies reflects a combined historical industry specific average for the United States Federal and state statutory income tax rates. The cost of capital reflects the estimated time to complete the projects and the level of risk involved. The following discount rates were used in computing the present value of net cash flows for the acquired companies: between 23% and 28% for the IBM i/p Series RAID business and approximately 24% for Snap Appliance.

The percentage of completion was determined using costs incurred by the IBM i/p Series RAID business and Snap Appliance prior to their respective acquisition dates compared to the estimated remaining research and development to be completed to bring the projects to technological feasibility. The Company estimated, as of the respective acquisition dates for the IBM i/p Series RAID business and Snap Appliance, that the projects were approximately 50% complete and 25% complete, respectively. All projects outstanding as of the acquisition date for the IBM i/p Series RAID business ceased as of September 30, 2005 with the sale of the business. All projects outstanding as of the acquisition date for Snap Appliance were completed as of September 30, 2005.

Pro forma financial information for the first nine months of fiscal 2005 has not been disclosed as the acquisitions of the IBM i/p Series RAID business and Snap Appliance were included as part of discontinued operations.

19. Subsequent Events

On January 31, 2006, the Company and one of its wholly owned subsidiaries signed a definitive agreement with Sanmina—SCI Corporation and its wholly owned subsidiary, Sanmina-SCI USA, Inc. (the “Definitive Agreement”), for the sale of the Company’s OEM block-based systems business for \$14.6 million, of which \$5.0 million will be received over the next two years. In addition, Sanmina-SCI USA agreed to pay the Company contingent consideration of up to an additional \$12.0 million if certain revenue levels are achieved over the next three years. Sanmina intends to operate the Company’s OEM block-based business within Sanmina-SCI’s ODM subsidiary, Newisys.

Under the terms of the Definitive Agreement, Sanmina-SCI USA will assume most OEM contracts for its block-based systems customers. The sale of the OEM block-based systems business, in terms of future expected revenues, represents approximately half of the planned divestiture of the systems business that was included in discontinued operations as of December 31, 2005. In return, Sanmina-SCI USA will supply the Company with block-based system products for the continued sale through the channel. This arrangement will cease upon identifying a buyer for the remainder of the Company’s systems business, which represents block- and file-based systems, including Snap-branded solutions. At that time, the new buyer would assume the supply agreement and channel distribution of all products of the systems business.

The Company expects to record a gain of approximately \$13.0 million, subject to final closing adjustments, on the sale of the OEM block-based systems business in the fourth quarter of fiscal 2006, which will be recorded in “Income (loss) from disposal of discontinued operations, net of taxes,” in the Consolidated Statements of Operations.

20. Glossary

The following is a list of business related acronyms that are contained within this Quarterly Report on Form 10-Q. They are listed in alphabetical order.

- **ASIC:** Application Specific Integrated Circuit
- **ATA:** Advanced Technology Attachment

- **DAS:** Direct-Attached Storage
- **DPS:** Data Protection Solutions
- **DSG:** Desktop Solutions Group
- **ESPP:** Employee Stock Purchase Plan
- **I/O:** Input/Output
- **IP:** Internet Protocol
- **IPsec:** Internet Protocol Security
- **IRS:** Internal Revenue Service
- **iSCSI:** Internet Protocol SCSI
- **NAS:** Network Attached Storage
- **ODM:** Original Design Manufacturer
- **OEM:** Original Equipment Manufacturer
- **PC:** Personal Computer
- **PCI:** Peripheral Component Interconnect
- **RAID:** Redundant Array of Independent Disks
- **ROC:** RAID on a Chip
- **SAN:** Storage Area Networks
- **SAS:** Serial Attached SCSI
- **SATA:** Serial Advanced Technology Attachment
- **SCSI:** Small Computer System Interface
- **SMI-S:** Storage Management Initiative Specification
- **Ultra DMA:** Ultra Direct Memory Access
- **USB:** Universal Serial Bus
- **VARs:** Value Added Reseller

The following is a list of accounting rules and regulations and related regulatory bodies referred to within this Quarterly Report on Form 10-Q. They are listed in alphabetical order.

- **APB:** Accounting Principles Board
- **APB Opinion No. 20:** Accounting Changes
- **APB Opinion No. 25:** Accounting for Stock Issued to Employees
- **ARB:** Accounting Research Bulletin
- **EITF:** Emerging Issues Task Force
- **EITF No. 95-3:** Recognition of Liabilities in Connection with Purchase Business Combinations

- **EITF No. 96-18:** Accounting for Equity Instruments That Are Issued to Other Than Employees for Acquiring, or in Conjunction with Selling, Goods or Services
- **FASB:** Financial Accounting Standards Board
- **FIN:** FASB Interpretation Number
- **FIN 44:** Accounting for Certain Transactions Involving Stock Compensation
- **SAB:** Staff Accounting Bulletin
- **SAB 107:** Share Based Payment
- **SEC:** Securities Exchange Commission
- **SFAS:** Statement of Financial Accounting Standards
- **SFAS No. 3:** Reporting Accounting Changes in Interim Financial Statements
- **SFAS No. 95:** Statement of Cash Flows
- **SFAS No. 123:** Accounting for Stock-Based Compensation
- **SFAS No. 123(R):** Share Based Payment
- **SFAS No. 146:** Accounting for Costs Associated with Exit or Disposal Activities
- **SFAS No. 148:** Accounting for Stock-Based Compensation—Transition and Disclosure—an amendment of SFAS No. 123
- **SFAS No. 151:** Inventory Costs—an amendment of ARB No. 43, Chapter 4
- **SFAS No. 154:** Accounting Changes and Error Corrections, a replacement of APB Opinion No. 20 and SFAS No. 3

Item 2. Management's Discussion and Analysis of Financial Condition and Results of Operations

This Quarterly Report on Form 10-Q contains forward-looking statements that involve risks and uncertainties. The statements contained in this document that are not purely historical are forward-looking statements within the meaning of Section 27A of the Securities Act of 1933 and Section 21E of the Securities Exchange Act of 1934, including, without limitation, statements regarding our expectations, beliefs, intentions or strategies regarding our business, including, but not limited to, our intention to divest our systems business, revenues from our SCSI-based desktop products and our liquidity in future periods. We may identify these statements by the use of words such as "anticipate," "believe," "continue," "could," "estimate," "expect," "intend," "may," "might," "plan," "potential," "predict," "project," "should," "will," "would" and other similar expressions. All forward-looking statements included in this document are based on information available to us on the date hereof, and we assume no obligation to update any such forward-looking statements, except as may otherwise be required by law.

Our actual results could differ materially from those anticipated in these forward-looking statements as a result of certain factors, including those set forth in the "Risk Factors" section and elsewhere in this document. In evaluating our business, current and prospective investors should consider carefully these factors in addition to the other information set forth in this document.

While management believes that the discussion and analysis in this report is adequate for a fair presentation of the information presented, we recommend that you read this discussion and analysis in conjunction with our Annual Report on Form 10-K for the fiscal year ended March 31, 2005. Our critical accounting policies have not changed from our fiscal year ended March 31, 2005. For a complete discussion of our critical accounting policies, please refer to our Annual Report on Form 10-K for the fiscal year ended March 31, 2005.

As discussed below, on September 30, 2005, we completed the sale to International Business Machines, or IBM, of our IBM i/p Series RAID component business, or IBM i/p Series RAID Business, and on September 29, 2005, our Board of Directors approved management's recommendation to divest our systems business. Both of these businesses have been accounted for as discontinued operations. Accordingly, we have reclassified the underlying Unaudited Condensed Consolidated Statements of Operations and Unaudited Condensed Consolidated Statements of Cash Flows and related disclosures for all periods presented to reflect the IBM i/p Series RAID Business and systems business as discontinued operations. In the third quarter of fiscal 2006, in conjunction with the renegotiation of a customer supply contract, we decided to retain a product line that was previously classified within discontinued systems business. Accordingly, we have reclassified the underlying Unaudited Condensed Consolidated Statements of Operations and Unaudited Condensed Consolidated Statements of Cash Flows and related disclosures for all periods presented to reflect that product line as part of continuing operations.

Unless otherwise indicated and other than balance sheet amounts as of March 31, 2005, the following discussion pertains only to our continuing operations.

For your convenience, we have included, in Note 20 to the Notes to the Unaudited Condensed Consolidated Financial Statements, a Glossary that contains a list of (1) key acronyms commonly used in our industry that are used in this Quarterly Report and (2) accounting rules and regulations that are also referred to herein. These key acronyms and accounting rules and regulations are listed in alphabetical order.

Results of Operations

Overview

Our new management team is continuing to perform a thorough analysis of our operations, which it initiated in the first quarter of fiscal 2006, and has begun making a detailed plan of our corporate strategy.

This analysis of our operations includes a review of all aspects of our business, including our product portfolio, our relationships with strategic partners and our research and development focus. To date, we have implemented the following steps:

- On January 31, 2006, we and one of its wholly owned subsidiaries signed a definitive agreement with Sanmina-SCI Corporation and its wholly owned subsidiary, Sanmina-SCI USA, Inc., or the Definitive Agreement, for the sale of our OEM block-based systems business for \$14.6 million, of which \$5.0 million will be received over the next two years. In addition, Sanmina-SCI USA agreed to pay us contingent consideration of up to an additional \$12.0 million if certain revenue levels are achieved over the next three years. Sanmina intends to operate our OEM block-based business within Sanmina-SCI's ODM subsidiary, Newisys. We expect to record a gain of approximately \$13.0 million, subject to final closing adjustments, on the sale of the OEM block-based systems business in the fourth quarter of fiscal 2006.
- We entered into on December 23, 2005 and subsequently closed on January 9, 2006 a three-year contract manufacturing agreement with Sanmina-SCI whereby Sanmina-SCI has assumed manufacturing operations of Adaptec products. In addition, we sold certain manufacturing assets, buildings and improvements and inventory located in Singapore with respect to printed circuit board assemblies and storage system manufacturing operations to Sanmina-SCI for our net book value of approximately \$27.0 million, subject to final closing adjustments for \$25.5 million (net of closing costs of \$0.5 million) resulting in a loss on disposal of assets of \$1.5 million that was recorded in the third quarter of fiscal 2006 in "Other charges (gains)" on the Unaudited Condensed Consolidated Statements of Operations. Those assets have been reclassified to "Assets held for sale" on the Unaudited Condensed Consolidated Balance Sheets.
- On September 30, 2005, we sold our IBM i/p Series RAID Business to IBM for approximately \$22.0 million plus \$1.3 million for certain fixed assets. In addition, IBM purchased certain related inventory at our net book value of \$0.8 million. We also granted IBM a nonexclusive license to certain intellectual property and sold to IBM substantially all of the assets dedicated to the engineering and manufacturing of RAID controllers and connectivity products for the IBM i/p Series RAID Business. Under the terms of the nonexclusive license, IBM will pay us royalties for the sale of our board-level products over the next six quarters, which will be recognized as contingent consideration in discontinued operations when earned. In the third quarter of fiscal 2006, we received royalties of \$3.5 million, which we recorded in "Income (loss) from disposal of discontinued operations, net of taxes," in the Unaudited Condensed Consolidated Statements of Operations.
- On September 29, 2005, our Board of Directors approved management's recommendation to divest our systems business, which includes substantially all of the operating assets and cash flows that were obtained through the Snap Appliance and Eurologic Systems acquisitions as well as internally developed hardware and software. In connection with this action, we have classified the systems business as a discontinued operation in the financial statements. We expect to receive proceeds, less cost to sell, in excess of our carrying value. In the third quarter of fiscal 2006, in conjunction with the renegotiation of a customer supply contract, we decided to retain a product line that was previously classified within discontinued systems business. Accordingly, we have reclassified the underlying Unaudited Condensed Consolidated Statements of Operations and Unaudited Condensed Consolidated Statements of Cash Flows and related disclosures for all periods presented to reflect that product line as part of continuing operations.
- We reorganized our internal organization structure related to our OEM and Channel segments in the second quarter of fiscal 2006. Where previously our former OEM and Channel segments each offered an integrated set of customer-focused products, the new organization is managed at the

product level. Our reportable segments currently are DPS and DSG. As a result of the segment reorganization, an assessment of the recoverability of goodwill was performed and we wrote-off our entire balance of goodwill of \$90.6 million in the second quarter of fiscal 2006. All prior periods have been restated to reflect our new segments.

The actions that we have taken and the actions that we are considering could adversely affect our business and financial results in the short-term, may not have the long-term beneficial results that we intend and could result in the following:

- Loss of customers;
- Loss of employees;
- Increased dependency on suppliers;
- Supply issues;
- Reduced revenue base;
- Impairment of our assets;
- Increased operating costs; and
- Material restructuring charges.

Our future revenue growth remains largely dependent on the success of our data protection solutions, new OEM design wins and our products addressing new technologies (i.e., Serial Attached SCSI, SATA and iSCSI).

In the third quarter of fiscal 2006, our revenues decreased 17% as compared to the third quarter of fiscal 2005 primarily reflecting a decline in sales volumes and the average selling prices of our parallel SCSI products, which was partially offset by sales of our serial products primarily sold to OEMs and one-time benefits associated with the renegotiation of a customer supply contract related to our systems products. The improvement in gross margin in the third quarter of fiscal 2006 compared to the third quarter of fiscal 2005 was primarily due to decreased component costs and one-time benefits associated with the renegotiation of a customer supply contract related to our systems products, which was partially offset by changes in our product mix, which led to lower average margins. Operating expenses decreased in the third quarter of fiscal 2006 as compared to the third quarter of fiscal 2005, primarily as a result of reduced headcount related to the ServerEngines and Vitesse strategic alliances we entered into in the fourth quarter of fiscal 2005 and decreased infrastructure spending and reduced headcount as a result of restructuring programs implemented in fiscal 2005 and the third quarter of fiscal 2006.

The following table sets forth the items in the Unaudited Condensed Consolidated Statements of Operations as a percentage of net revenues (references to notes in the footnotes to this table are to the Notes to Unaudited Condensed Consolidated Financial Statements appearing in this report):

	Three-Month Period Ended(1)		Nine-Month Period Ended(2)	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
Net revenues	100 %	100 %	100 %	100 %
Cost of revenues	63	64	66	56
Gross margin	37	36	34	44
Operating expenses:				
Research and development	19	23	20	23
Selling, marketing and administrative	20	19	21	19
Amortization of acquisition-related intangible assets	2	2	2	3
Restructuring charges	3	2	1	2
Goodwill impairment	—	—	38	—
Other charges (gains)	2	(3)	1	(1)
Total operating expenses	46	43	83	46
Loss from continuing operations	(9)	(7)	(49)	(2)
Interest and other income	6	3	5	3
Interest expense	(1)	(1)	(1)	(1)
Income (loss) from continuing operations before income taxes	(4)	(5)	(45)	0
Provision for (benefit from) income taxes	(1)	(23)	2	(11)
Income (loss) from continuing operations	(3)	18	(47)	11
Discontinued operations, net of taxes (Note 4)				
Income (loss) from discontinued operations, net of taxes	(5)	6	(13)	(6)
Income (loss) from disposal of discontinued operations, net of taxes	4	—	(1)	—
Income (loss) from discontinued operations	(1)	6	(14)	(6)
Net income (loss)	(4)%	24%	(61)%	5%

- (1) In the third quarter of fiscal 2006, we implemented a restructuring plan (Note 8) and recorded a loss on disposal of assets of \$1.5 million (Note 17). In the third quarter of fiscal 2005, we implemented a restructuring plan, recorded a gain of \$2.8 million on the sale of certain properties (Note 9), made a payment of \$0.4 million to Nevada SCSI Enterprises, Inc., or NSE, in the form of a license fee (Note 7) and received a tax benefit from the settlements of disputes with the IRS. These transactions affect the comparability of this data.
- (2) In the first nine months of fiscal 2006, we recorded a goodwill impairment charge of \$90.6 million (Note 6), implemented a restructuring plan in the third quarter of fiscal 2006 (Note 8) and recorded a loss on disposal of assets of \$1.5 million (Note 17). In the first nine months of fiscal 2005, we recorded a gain of \$2.8 million on the sale of certain properties (Note 9), made a payment of \$1.7 million to NSE in the form of a license fee (Note 7) and implemented restructuring plans in the first, second and third quarters of fiscal 2005. These transactions affect the comparability of this data.

Net Revenues.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
Segment Net Revenues:						
DPS	\$ 69.1	\$ 84.9	(19)%	\$ 208.1	\$ 263.7	(21)%
DSG	8.7	8.6	1%	28.6	28.6	0%
Total Net Revenues	<u>77.8</u>	<u>93.5</u>	(17)%	<u>236.7</u>	<u>292.3</u>	(19)%

Net revenues from our DPS segment decreased by \$15.8 million and \$55.6 million in the third quarter and first nine months of fiscal 2006, respectively, as compared to the corresponding periods of fiscal 2005, reflecting a decline in sales volumes and average selling prices of our parallel SCSI products, which was partially offset by sales of our serial products primarily to OEMs and one-time benefits associated with the renegotiation of a customer supply contract related to our systems products. The decline in sales volumes of our SCSI products was primarily attributable to the transition from our Ultra 160 products to Ultra 320 products in which we have a lower market share, a shift to lower cost SATA solutions in which we have a lower market share and motherboards that contain built-in SCSI I/O functionality, thus reducing our average selling price.

Net revenues from our DSG segment increased by \$0.1 million in the third quarter compared to the third quarter of fiscal 2005 as a result of increased sales of our digital media products and sales of storage products that were introduced in the fourth quarter of fiscal 2005, partially offset by the decline in sales volumes of our SCSI-based desktop computer products. We expect revenues from our SCSI-based desktop computer products to continue to decline as OEMs are incorporating other connectivity technologies directly into their products. Net revenues from our DSG segment remained relatively flat in the first nine months of fiscal 2006 compared to the first nine months of fiscal 2005.

	Three-Month Period Ended		Nine-Month Period Ended	
	December 31, 2005	December 31, 2004	December 31, 2005	December 31, 2004
Geographical Revenues:				
North America	37%	26%	36%	34%
Europe	31%	39%	31%	33%
Pacific Rim	32%	35%	33%	33%
Total Geographical Revenues	<u>100%</u>	<u>100%</u>	<u>100%</u>	<u>100%</u>

Our North America revenues increased as a percentage of our total gross revenues in the third quarter and first nine months of fiscal 2006 as compared to the corresponding periods of fiscal 2005 primarily as a result of one-time benefits associated with the renegotiation of a customer supply contract related to our systems products and increased sales related to a North America OEM, partially offset by a decline in channel sales in North America. Included in European revenues for the third quarter and first nine months of fiscal 2006 was \$1.0 million and \$11.7 million, respectively, of a last time buy customer order.

A small number of our customers account for a substantial portion of our net revenues, and we expect that a limited number of customers will continue to represent a substantial portion of our net revenues for the foreseeable future. IBM and Dell accounted for 34% and 17% of our total net revenues, respectively, in the third quarter of fiscal 2006. IBM and Dell accounted for 38% and 14% of our total net revenues, respectively, in the third quarter of fiscal 2005. IBM and Dell accounted for 30% and 16% of our total net revenues, respectively, in the first nine months of fiscal 2006. IBM, Dell and Synnex accounted for 26%, 14% and 11% of our total net revenues, respectively, in the first nine months of fiscal 2005.

Gross Margin.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
	(in millions, except percentages)					
Gross Profit	\$ 29.0	\$ 33.9	(15)%	\$ 80.3	\$ 127.4	(37)%
Gross Margin	37%	36%		34%	44%	

The improvement in gross margin in the third quarter of fiscal 2006 compared to the third quarter of fiscal 2005 was primarily due to decreased component costs and one-time benefits associated with the renegotiation of a customer supply contract related to our systems products, which was partially offset by changes in our product mix, which led to lower average margins.

The decline in gross margin in the first nine months of fiscal 2006 compared to the first nine months of fiscal 2005 was primarily due to changes in our product and customer mix, which led to lower average margins, fixed costs associated with our manufacturing facilities that were distributed over lower revenue levels and an excess inventory adjustment of \$1.9 million recorded in the first nine months of fiscal 2006 related to the transition of our products to comply with the European Union Restriction on Use of Hazardous Substances Directive, or RoHS Directive. This was partially offset by decreased component costs and one-time benefits associated with the renegotiation of a customer supply contract related to our systems products. Our gross margins will be significantly impacted in the future by the mix of OEM and channel revenue.

Research and Development Expense.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
	(in millions, except percentages)					
Research and Development	\$ 14.4	\$ 21.3	(32)%	\$ 47.3	\$ 68.2	(31)%

The decrease in research and development expense in the third quarter and first nine months of fiscal 2006 as compared to the corresponding periods of fiscal 2005 was primarily a result of reduced headcount achieved as a result of the ServerEngines and Vitesse strategic alliances we entered into in the fourth quarter of fiscal 2005, decreased infrastructure spending and reduced headcount as a result of restructuring programs implemented in fiscal 2005 and decreased deferred compensation charges of \$0.3 million and \$1.7 million in the third quarter and first nine months of fiscal 2006, respectively compared to the corresponding periods of fiscal 2005. Deferred compensation charges represented the vesting of assumed stock options in connection with our acquisition of Platys Communications, Inc., or Platys, in August 2001. Deferred compensation charges associated with the Platys acquisition ceased in the first quarter of fiscal 2006.

Selling, Marketing and Administrative Expense.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
	(in millions, except percentages)					
Selling, Marketing and Administrative	\$ 15.7	\$ 17.8	(12)%	\$ 49.7	\$ 55.0	(10)%

The decrease in selling, marketing and administrative expense in the third quarter and first nine months of fiscal 2006 as compared to the corresponding periods of fiscal 2005 was primarily a result of

decreased spending due to reductions of our workforce and infrastructure spending as a result of the restructuring plans we implemented in fiscal 2005 and the third quarter of fiscal 2006. This was partially offset by compensation of \$1.2 million recorded in the first quarter of fiscal 2006 related to retirement costs of our former Chief Executive Officer.

Amortization of Acquisition-Related Intangible Assets.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
Amortization of Acquisition-Related Intangible Assets	\$ 1.7	\$ 2.2	(23)%	\$ 5.5	\$ 7.1	(23)%

Acquisition-related intangible assets include patents, core and existing technologies, covenants-not-to-compete, customer relationships and trade names. We amortize the acquisition-related intangible assets over periods which reflect the pattern in which the economic benefits of the assets are expected to be realized, which is primarily using the straight-line method over their estimated useful lives, ranging from three months to five years.

The decrease in amortization of acquisition-related intangible assets in the third quarter and first nine months of fiscal 2006 compared to the corresponding periods of fiscal 2005 was due to intangible assets that became fully amortized in August 2005 associated with our Platys acquisition and certain intangible assets that became fully amortized in fiscal 2005 associated with our acquisition of Eurologic Systems Group Limited in April 2003.

Restructuring Charges.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
Restructuring Charges	\$ 2.6	\$ 2.2	16%	\$ 3.1	\$ 5.0	(38)%

In the third quarter of fiscal 2006, management approved and initiated a plan to restructure our operations by simplifying our infrastructure. The third quarter of fiscal 2006 restructuring plan eliminated certain duplicative resources in all functions of the organization worldwide, due in part, to the discontinued operations and vacated redundant facilities in order to reduce our combined cost structure. This resulted in a restructuring charge of \$2.4 million for the third quarter of fiscal 2006.

As a result of our third quarter of fiscal 2006 restructuring plan, we expect to reduce our annual infrastructure spending by approximately \$3 million, of which 24%, 34% and 42% will be reflected as a reduction in cost of revenues, research and development and selling, marketing and administrative expense, respectively.

We recorded provision adjustments of \$0.2 million and \$0.7 million in the third quarter of fiscal 2006 and first nine months of fiscal 2006, respectively, related to severance and benefits as actual costs were lower than anticipated and additional lease costs related to the estimated loss on facilities that we subleased. The provision adjustments also include additional lease costs related to the estimated loss on facilities that we subleased in connection with the Snap Appliance acquisition (Note 18). These provision adjustments pertained to restructuring plans that we implemented in each quarter of fiscal 2005, and restructuring plans that we implemented in fiscal 2004, fiscal 2003, fiscal 2002 and fiscal 2001. The fiscal 2004 restructuring plan was completed in the first quarter of fiscal 2006. The third quarter of fiscal 2005 restructuring plan and fourth quarter of fiscal 2005 restructuring plan were completed in the third quarter

of fiscal 2006. For a complete discussion of all restructuring actions that were implemented prior to fiscal 2006, please refer to the Notes to Consolidated Financial Statements included in our Annual Report on Form 10-K for the fiscal year ended March 31, 2005. All expenses, including adjustments, associated with our restructuring plans are included in “Restructuring charges” in the Unaudited Condensed Consolidated Statements of Operations and are not allocated to segments, but are managed at the corporate level.

In conjunction with the agreements entered into with Sanmina—SCI on December 23, 2005 related to the transaction that subsequently closed on January 9, 2006, management approved and initiated a plan to restructure our work force in our Singapore operations. To the extent that the employees are not be hired by Sanmina—SCI, the employees will be terminated by us over approximately the next two quarters. We estimate that we will incur future severance costs in the range of \$5 million and \$6 million.

Goodwill Impairment.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
	(in millions, except percentages)					
Goodwill Impairment	\$ —	\$ —	—	\$ 90.6	\$ —	100%

Goodwill is not amortized, but instead is reviewed annually and whenever events or circumstances occur which indicate that goodwill might be impaired. As a result of the segment reorganization discussed above and in Note 15 to the Notes to Unaudited Condensed Consolidated Financial Statements, an assessment of the recoverability of goodwill was performed. Impairment of goodwill is tested at our operating segment level by comparing each segment’s carrying amount, including goodwill, to the fair value of that segment. To determine fair value, our review process uses the income, or discounted cash flows, approach and the market approach. In performing our analysis, we use the best information available under the circumstances, including reasonable and supportable assumptions and projections. If the carrying amount of the operating segment exceeds its implied fair value, goodwill is considered impaired and a second step is performed to measure the amount of impairment loss, if any. As a result of this review, we wrote-off our entire balance of goodwill of \$90.6 million in the second quarter of 2006. Factors that led to this conclusion were industry technology changes such as the shift from parallel to serial technology and the migration of core functionality to server chipsets; required increased investments that eventually led us to sell the IBM i/p Series RAID Business and the proposed sale of the systems business; continued losses associated with sales of systems to IBM; and general market conditions.

Other Charges (Gains).

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
	(in millions, except percentages)					
Other Charges (Gains)	\$ 1.5	\$ (2.8)	(153)%	\$ 1.5	\$ (2.8)	(153)%

We entered into on December 23, 2005 and subsequently closed on January 9, 2006 a three-year contract manufacturing agreement with Sanmina—SCI whereby Sanmina—SCI has assumed manufacturing operations of Adaptec products. In addition, we sold certain manufacturing assets, buildings and improvements and inventory located in Singapore with respect to printed circuit board assemblies and storage system manufacturing operations to Sanmina—SCI for our net book value of approximately \$27.0 million, subject to final closing adjustments for \$25.5 million (net of closing costs of \$0.5 million) resulting in a loss on disposal of assets of \$1.5 million that was recorded in the third quarter of fiscal 2006 in “Other charges (gains)” on the Unaudited Condensed Consolidated Statements of Operations. Those assets have been reclassified to “Assets held for sale” on the Unaudited Condensed Consolidated Balance Sheets.

In October 2004, we completed the sale of certain properties in Milpitas, California that were previously classified as held for sale. Net proceeds from the sale of the properties aggregated \$9.6 million, which exceeded our final revised fair value of \$6.8 million. As a result, a gain on the sale of the properties of \$2.8 million was recorded in the third quarter of fiscal 2005 as a credit to “Other charges (gains)” in the Unaudited Condensed Consolidated Statements of Operations.

Interest and Other Income.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
(in millions, except percentages)						
Interest and Other Income:						
Interest income	\$ 4.5	\$ 2.8	57%	\$ 12.0	\$ 8.6	40%
Payment of license fee with NSE	—	(0.4)	100%	—	(1.7)	100%
Loss on redemption of debt	—	—	—	(0.1)	—	(100)%
Other	0.0	0.7	(96)%	0.7	1.7	(58)%
Total Interest and Other Income	4.5	3.1	45%	12.6	8.6	47%

Interest and other income is primarily attributable to interest income earned on our cash, cash equivalents and marketable securities, fluctuations in foreign currency gains or losses, realized gains and losses on marketable securities, sublease income received from third parties and loss from the repurchase of our 3% Convertible Subordinated Notes, or 3% Notes.

The increase in interest and other income in the third quarter and first nine months of fiscal 2006 as compared to the corresponding periods of fiscal 2005 was primarily due to higher interest rates earned on our cash, cash equivalents and marketable securities in the first nine months of fiscal 2006 and a one-time fully paid-up license payment fee of \$1.7 million to NSE, which was recorded in the first nine months of fiscal 2005, primarily for historical products that incorporated certain technology. This was partially offset by foreign currency fluctuations primarily related to the Euro and a loss of \$0.1 million on the repurchase of our 3% Notes for the first nine months of fiscal 2006. For further discussion on the settlement with NSE and gain on the sale of the property, please refer to Note 7 to the Notes to Unaudited Condensed Consolidated Financial Statements.

Interest Expense.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
(in millions, except percentages)						
Interest Expense	\$ (0.8)	\$ (1.1)	(30)%	\$ (2.6)	\$ (3.4)	(22)%

Interest expense is primarily associated with our ¾% Convertible Senior Subordinated Notes, or ¾% Notes, and 3% Notes issued in December 2003 and March 2002, respectively. The decrease in interest expense for the third quarter and first nine months of fiscal 2006 compared to the corresponding periods of fiscal 2005 was primarily due to the reduction in the outstanding balances of the 3% Notes, as we repurchased \$23.2 million in aggregate principal amount of our 3% Notes during the first nine months of fiscal 2006.

Income Taxes.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
Provision for (Benefit from) Income Taxes	\$ (0.6)	\$ (21.8)	(97)%	\$ 3.2	\$ (31.5)	(110)%

Income tax provisions for interim periods are based on our estimated annual effective income tax. The estimated annual tax for fiscal 2006 primarily consists of foreign taxes related to our foreign subsidiaries and interest accrued on prior years' tax disputes. We currently have a full valuation allowance on our net U.S. deferred tax assets. We are engaged in ongoing negotiations with the IRS with regard to various tax disputes that may result in settlement of certain issues. Our tax rate for the period in which a settlement is reached will be impacted if the settlement materially differs from the amounts previously accrued. The tax rate for the third quarter and first nine months of fiscal 2005 differed from the combined United States Federal and state statutory income tax rate of 40% primarily due to certain acquisition-related intangible assets, excluding goodwill, that are not fully deductible for tax purposes and interest accrued on prior years' tax disputes. The tax rate for the third quarter and the first nine months of fiscal 2005 also differed from the combined United States Federal and state statutory income tax rate of 40% due to tax benefits of \$21.9 million and \$31.9 million respectively from discrete events relating to the method and amount of settled controversies. As a result of the settlements, \$21.9 million previously recorded as a tax provision was reversed during the third quarter of fiscal 2005. In addition, \$4.1 million previously recorded as a tax provision was reclassified as a reduction to additional paid-in capital, \$1.8 million previously recorded as a tax provision has been reversed, and a \$4.0 million tax benefit associated with a refund claim has been recognized during the second quarter of fiscal 2005.

Historically our effective tax rate was benefited by a Singapore tax holiday relating to certain of our products. The contract manufacturing agreement entered into with Sanmina-SCI could jeopardize this holiday which may cause our effective tax rate to increase. We currently have alternative plans to reduce our effective tax rate; however, if these plans are not successful, our effective tax rate could increase, which would adversely affect our financial results.

Income (Loss) From Discontinued Operations.

	Three-Month Period Ended			Nine-Month Period Ended		
	December 31, 2005	December 31, 2004	Percentage Change	December 31, 2005	December 31, 2004	Percentage Change
Income (Loss) From Discontinued Operations	\$ (0.6)	\$ 5.5	(112)%	\$ (34.5)	\$ (17.1)	102%

IBM i/p Series RAID Business: On September 30, 2005, we entered into a series of arrangements with IBM pursuant to which we sold our IBM i/p Series RAID Business to IBM for approximately \$22.0 million plus \$1.3 million for certain fixed assets. In addition, IBM purchased certain related inventory at our net book value of \$0.8 million. Expenses incurred in the transaction primarily included costs of approximately \$0.5 million for legal and accounting fees. In addition, we accrued \$0.3 million for lease obligations. Under the terms of the agreements, we granted IBM a nonexclusive license to certain intellectual property and sold to IBM substantially all of the assets dedicated to the engineering and manufacturing of RAID controllers and connectivity products for the IBM i/p Series RAID Business. Under the terms of the nonexclusive license, IBM will pay us royalties for the sale of our board-level

products over the next six quarters, which will be recognized as contingent consideration in discontinued operations when earned. In the third quarter of fiscal 2006, we received royalties of \$3.5 million, which we recorded in "Income (loss) from disposal of discontinued operations, net of taxes," in the Unaudited Condensed Consolidated Statements of Operations.

Systems Business: On September 29, 2005, our Board of Directors approved management's recommendation to divest our systems business, which includes substantially all of the operating assets and cash flows that were obtained through the Snap Appliance and Eurologic Systems acquisitions as well as internally developed hardware and software. In connection with this action, we have classified the systems business as a discontinued operation in the financial statements. We have entered into an exclusive arrangement with an investment banker to sell this business and expect to receive proceeds, less cost to sell, in excess of our carrying value.

In the third quarter of fiscal 2006, in conjunction with the renegotiation of a customer supply contract, we decided to retain a product line that was previously classified within discontinued systems business. Accordingly, we have reclassified the underlying Unaudited Condensed Consolidated Statements of Operations and Unaudited Condensed Consolidated Statements of Cash Flows and related disclosures for all periods presented to reflect that product line as part of continuing operations.

Liquidity and Capital Resources

Key Components of Cash Flows

Cash provided by operations was \$8.4 million in the first nine months of fiscal 2006 as compared to cash used for operations of \$16.0 million in the first nine months of fiscal 2005. Cash provided by operations for the first nine months of fiscal 2006 resulted primarily from the benefit of non-cash items included in operating results, which primarily consisted of an impairment of goodwill of \$90.6 million and depreciation and amortization of \$19.4 million. This was partially offset by our loss from continuing operations of \$110.5 million. Additional factors included changes to working capital assets and liabilities that decreased cash provided by operating activities of continuing operations by \$1.2 million and increased cash provided by operating activities of discontinued operations of \$7.9 million. Cash used for the first nine months of fiscal 2005 resulted primarily from changes to working capital assets and liabilities that decreased cash used for operating activities of continuing operations and discontinued operations by \$21.5 million and \$28.0 million, respectively, and non-cash effect on tax settlement of \$26.0 million. This was partially offset by our income from continuing operations of \$31.5 million and depreciation and amortization of \$28.4 million.

Cash used for investing activities was \$321.6 million in the first nine months of fiscal 2006, which was primarily due to net sales and maturities of restricted marketable securities and marketable securities, net of purchases, of \$340.3 million and purchases of property and equipment from continuing operations of \$6.5 million, partially offset by proceeds from the sale of the IBM i/p Series RAID Business of \$24.1 million. Cash used for investing activities was \$4.2 million in the first nine months of fiscal 2005, which was primarily due to cash used to acquire Snap Appliance and the IBM i/p Series RAID business of \$65.4 million, purchases of property and equipment from continuing operations of \$8.1 million and cash used in investing activities of discontinued operations of \$63.0 million. This was offset by net purchases of restricted marketable securities and marketable securities, net of sales and maturities, of \$125.1 million and proceeds from the sale of long-lived assets of \$9.6 million.

Cash used for financing activities of \$19.7 million in the first nine months of fiscal 2006 was primarily driven by the repurchase of \$23.2 million in aggregate principal amount of our 3% Notes for \$23.0 million. Cash provided by financing activities was \$5.4 million in the first nine months of fiscal 2005, which related to net proceeds received from our issuance of common stock in connection with purchases made under our employee stock purchase plan and stock option exercises.

Liquidity. At December 31, 2005, we had \$532.3 million in cash, cash equivalents and marketable securities, of which approximately \$91.1 million was held by our Singapore subsidiary. In the fourth quarter of fiscal 2005, we repatriated \$360.6 million of undistributed earnings from Singapore to the United States and incurred a tax liability of \$17.6 million. The repatriated amounts will be used to fund a qualified Domestic Reinvestment Plan, as required by the American Jobs Creation Act of 2004. If we do not spend the repatriated funds in accordance with our reinvestment plan, we may incur additional tax liabilities. We have not provided for U.S. deferred income taxes or foreign withholding taxes on the remaining undistributed earnings since these earnings totaling approximately \$255.6 million are intended to be reinvested internationally indefinitely. Although we do not have any current plans to repatriate the remaining undistributed earnings from our Singapore subsidiary to our United States parent company, if we were to do so, additional income taxes at the combined United States Federal and state statutory rate of approximately 40% could be incurred from the repatriation.

At December 31, 2005, we had \$237.0 million of aggregate principal amount in convertible notes outstanding, consisting of \$12.0 million in aggregate principal amount of our 3% Notes that are due in March 2007 and \$225.0 million in aggregate principal amount of our ¾% Notes that are due in December 2023.

We are required to maintain restricted cash or investments to serve as collateral for the first ten scheduled interest payments on our ¾% Notes. As of December 31, 2005, we had \$4.7 million of restricted cash and restricted marketable securities, consisting of United States government securities, of which \$1.6 million was classified as short-term and \$3.1 million was long-term.

The IRS is currently auditing our income tax returns for fiscal 1997 and final settlement agreements have been filed with the United States Tax Court on all but one issue. In addition, the IRS is auditing our Federal income tax returns for fiscal 1998 through fiscal 2003. We have resolved all issues for fiscal 1998 through fiscal 2001 other than the rollover impact of any potential resolution on the remaining fiscal 1997 issue and tax credits that were generated but not used in subsequent years that may be carried back. The fiscal 2002 and 2003 audit is ongoing. We believe that we have sufficient tax provisions for these years. We believe the final outcome of the IRS audits will not have a material adverse impact on our liquidity. However, we cannot predict with certainty how these matters will be resolved and whether we will be required to make additional payments.

As of December 31, 2005, we did not have any material changes to our contractual obligations that were disclosed in the Liquidity section of our Form 10-K for the fiscal year ended March 31, 2005. However, as part of the three-year contract manufacturing agreement entered into with Sanmina-SCI on January 9, 2006, we are committed to purchasing majority of our products from Sanmina-SCI. In addition, as part of the agreement, we entered into a put agreement which entitles Sanmina-SCI to return any equipment not used within six months of the close of the transaction. We reserved for this potential liability as of December 31, 2005.

We believe that liquidity provided by our existing working capital, together with expected cash flows from operations and available sources of equity and equipment financing, will be sufficient to support our operations through at least the next twelve months. However, should prevailing economic conditions and/or financial, business and other factors beyond our control adversely affect our estimates of our future cash requirements, we would be required to fund our cash requirements by alternative financing. There can be no assurance that additional financing, if needed, would be available on terms acceptable to us or at all.

Recent Accounting Pronouncements

In June 2005, the FASB issued SFAS No. 154, which changes the requirements for the accounting for, and reporting of, a change in accounting principle. Previously, most voluntary changes in accounting

principles were required to be recognized by way of a cumulative effect adjustment within net income during the period of the change. SFAS No. 154 requires retrospective application to prior periods' financial statements, unless it is impracticable to determine either the period-specific effects or the cumulative effect of the change. SFAS No. 154 is effective for accounting changes made in fiscal years beginning after December 15, 2005; however, the Statement does not change the transition provisions of any existing accounting pronouncements. Our results of operations and financial condition will only be impacted following the adoption of SFAS No. 154 if it implements changes in accounting principles that are addressed by the standard or corrects accounting errors in future periods.

In December 2004, the FASB issued SFAS No. 123(R). This statement replaces SFAS No. 123, amends SFAS No. 95 and supersedes APB Opinion No. 25. SFAS No. 123(R) requires companies to apply a fair-value based measurement method in accounting for share-based payment transactions with employees and to record compensation expense for all stock awards granted and to awards modified, repurchased or cancelled after the required effective date. In addition, we are required to record compensation expense (as previous awards continue to vest) for the unvested portion of previously granted awards that remain outstanding at the date of adoption. In April 2005, the SEC approved that SFAS No. 123(R) will be effective for annual periods, as opposed to interim periods as originally issued by the FASB, beginning after June 15, 2005. In March 2005, the SEC issued SAB 107, which offers guidance on SFAS No. 123(R). SAB 107 was issued to assist preparers by simplifying some of the implementation challenges of SFAS No. 123(R) while enhancing the information that investors receive. We intend to use the modified prospective method, which will result in a significant increase to expenses on our consolidated financial statements beginning April 1, 2006. We cannot currently quantify the impact of the adoption of SFAS No. 123(R) and SAB 107 as it will depend on the amount of share-based payments that we grant in the future as well as other variables that affect the fair market value estimates which cannot be forecasted at this time. The pro forma disclosures of the impact of SFAS No. 123 provided in Note 3 of the Notes to the Unaudited Condensed Consolidated Financial Statements may not be representative of the impact of adopting this statement.

In November 2004, the FASB issued SFAS No. 151, which clarifies the accounting for abnormal amounts of facility expense, freight, handling costs and wasted materials (spoilage) to require them to be recognized as current-period charges. This statement is effective for inventory costs incurred during fiscal years beginning after June 15, 2005. Earlier application is permitted. The adoption of this standard is not expected to have a material impact on our financial statements.

RISK FACTORS

Our business faces significant risks. The risks described below may not be the only risks we face. Additional risks that we do not yet know of or that we currently think are immaterial may also impair our business operations. If any of the events or circumstances described in the following risks actually occurs, our business, financial condition or results of operations could suffer, and the trading price of our common stock could decline.

We depend on contract manufacturers and subcontractors, and if they fail to meet our manufacturing needs, it could delay shipments of our products and result in the loss of customers. We rely on contract manufacturers for manufacturing of our products and subcontractors for the assembly and packaging of the integrated circuits included in our products and for the assembly. On January 9, 2006 we entered into a three-year contract manufacturing agreement with Sanmina-SCI whereby Sanmina-SCI has assumed manufacturing operations of Adaptec products. If the transition of the manufacturing facilities does not go as expected it could result in loss of customers or revenue, which would have an adverse effect on our financial results. We have no long-term agreements with our assembly and packaging subcontractors. For example, we employ Quanta Computer, Inc. to manufacture certain products related to the acquisition of Snap Appliance. We also employ Amkor Technology and Advanced Semiconductor Engineering for our final assembly and test operations related to our ASIC products. We cannot assure you these subcontractors will continue to be able and willing to meet our requirements for these components or services. For example, in the third quarter of fiscal 2005, Quanta Computer, Inc. could not meet our manufacturing needs and as a result initial product delivery dates committed to customers were not met. Any significant disruption in supplies from or degradation in the quality of components or services supplied by, these contract manufacturers and subcontractors could delay shipments and result in the loss of customers or revenues, which could have an adverse effect on our financial results.

Actions that we have taken and the actions that we are considering could adversely affect our business and financial results in the short-term, and may not have the long-term beneficial results that we intend. Our new management team is continuing to perform a thorough analysis of our operations, which it initiated in the first quarter of fiscal 2006, and has begun making a detailed plan of our corporate strategy. This analysis of our operations includes a review of all aspects of our business, including our product portfolio, our relationships with strategic partners and our research and development focus. To date we have implemented the following steps described in “Management’s Discussion and Analysis of Financial Condition and Results of Operations—Results of Operations—Overview.”

The actions that we have taken and the actions that we are considering could adversely affect our business and financial results in the short-term, may not have the long-term beneficial results that we intend and could result in the following:

- Loss of customers;
- Loss of employees;
- Increased dependency on suppliers;
- Supply issues;
- Reduced revenue base;
- Impairment of our assets;
- Increased operating costs; and
- Material restructuring charges.

If we are unable to successfully complete the divestiture of our systems business it could result in an adverse effect on our business and financial results. Completing the systems divestiture could cause significant diversions of management time and resources. In addition, if the anticipated proceeds, less cost to sell, prove to be less than anticipated, it could lead to an impairment of our assets. Additionally, customers for our systems products could be reluctant to continue to buy from us. We may not be successful in selling the systems business on terms that are acceptable to us or might not be able to find a buyer for the business. We may not be successful in overcoming these risks or any other problems encountered in connection with this divestiture which may adversely affect our business, financial position and operating results.

Our operating results have fluctuated in the past, and are likely to continue to fluctuate, and if our future results are below the expectations of investors or securities analysts, the market price of our common stock would likely decline significantly. Our quarterly operating results have fluctuated in the past, and are likely to vary significantly in the future, based on a number of factors related to our industry and the markets for our products. Factors that are likely to cause our operating results to fluctuate include those discussed in this Risk Factors section. In the first nine months of fiscal 2006, our operating results were materially affected by unusual charges, including a goodwill impairment charge of \$90.6 million and an excess inventory adjustment of \$1.9 million related to the transition of our products to comply with the RoHS Directive.

Our operating expenses are largely based on anticipated revenues, and a large portion of our expenses, including facility costs and salaries, are fixed in the short term. As a result, lower than anticipated revenues for any reason could cause significant variations in our operating results from quarter to quarter.

Due to the factors summarized above, and the other risks described in this section, we believe that you should not rely on period-to-period comparisons of our financial results as an indication of our future performance. In the event that our operating results fall below the expectations of market analysts or investors, the market price of our common stock could decline substantially.

Our operating results may be adversely affected by unfavorable economic and market conditions and the uncertain geopolitical environment. Adverse economic conditions in some markets may impact our business, which could result in:

- Reduced demand for our products as a result of a decrease in capital spending by our customers;
- Increased price competition for our products;
- Increased risk of excess and obsolete inventories;
- Excess facilities and manufacturing capacity; and
- Higher overhead costs as a percentage of revenues.

Demand for our products would likely be negatively affected if demand in the server and network storage markets declines. For example, demand in the server market declined slightly in fiscal 2002 and fiscal 2003, which contributed to a decline in our net revenues. It is difficult to predict future server sales growth, if any. In addition, other technologies may replace the technologies used in our existing products and the acceptance of our products using new technologies in the market may not be widespread, which could adversely affect our revenues.

Because our sales are made by means of standard purchase orders rather than long-term contracts, if demand for our customers' products declines or if our customers do not control their inventories effectively, they may cancel or reschedule shipments previously ordered from us or reduce their levels of purchases from us. The volume and timing of orders received during a quarter are difficult to forecast. Our customers generally order based on their forecasts and they frequently encounter uncertain and changing demand for their

products. If demand falls below such forecasts or if our customers do not control their inventories effectively, they may cancel or reschedule shipments previously ordered from us. Our customers have from time to time in the past canceled or rescheduled shipments previously ordered from us, and we cannot assure you that they will not do so in the future. In addition, because our sales are made by means of standard purchase orders rather than long-term contracts, we cannot assure you that these customers will continue to purchase quantities of our products at current levels, or at all. Historically, we have set our operating budget based on forecasts of future revenues because we do not have significant backlog. Because much of our operating budget is relatively fixed in the short-term, if revenues do not meet our expectations, then our financial results will be adversely affected.

We depend on a few key customers and the loss of any of them could significantly reduce our revenues. Historically, a small number of our customers has accounted for a significant portion of our revenues. During the first nine months of fiscal 2006, sales to the ten customers from which we received the greatest revenues accounted for approximately 93% of our total gross revenues. In addition, IBM and Dell represented 30% and 16%, respectively, of our total net revenues in the first nine months of fiscal 2006. We believe that our major customers continually evaluate whether or not to purchase products from alternate or additional sources. Additionally, customers' economic and market conditions frequently change. Accordingly, we cannot assure you that a major customer will not reduce, delay or eliminate its purchases from us, which would likely cause our revenues to decline. In addition, we do not carry credit insurance on our accounts receivables and any difficulty in collecting outstanding amounts due from our customers, particularly customers that place larger orders or experience financial difficulties, could adversely affect our revenues and our net income. Because our sales are made by means of standard purchase orders rather than long-term contracts, we cannot assure you that these customers will continue to purchase quantities of our products at current levels, or at all.

If there is a shortage of components used in our customers' products, our sales may decline, which could adversely affect our results of operations and financial position. If our customers are unable to purchase certain components which are embedded into their products, their demand for our products may decline. For example, beginning in the fourth quarter of fiscal 2005, we experienced the impact of other companies' enterprise drive shortages, which reduced the demand for our SCSI-related products from our OEM and Channel customers. This negatively affected our revenues in the fourth quarter of fiscal 2005. In addition, our customers may be impacted by component shortages if components are not available that comply with the RoHS Directive. Similar shortages of components used in our customers' products could adversely affect our net revenues and financial results in future periods.

We may be subject to a higher effective tax rate that could negatively affect our results of operations and financial position. Our effective tax rate is benefited by a Singapore tax holiday relating to certain of our products. The tax holiday package, which is effective until fiscal 2010, provides that profits derived from certain products may be exempt from tax, subject to certain conditions. If we do not meet the conditions and requirements of the tax holiday in Singapore, our effective tax rate may increase, which would adversely affect our financial results. The contract manufacturing agreement entered into with Sanmina-SCI could jeopardize this holiday. We currently have alternative plans to reduce our effective tax rate; however, if these plans are not successful, our effective tax rate could increase, which would adversely affect our financial results.

We held approximately \$91.1 million of cash, cash equivalents and marketable securities at our subsidiary in Singapore at December 31, 2005. During the fourth quarter of fiscal 2005, we repatriated \$360.6 million of cash from Singapore to the United States in connection with the American Jobs Creation Act of 2004 which provides a one-time deduction of 85% for certain dividends from controlled foreign corporations. If the amount repatriated does not qualify for the one-time deduction, we could incur additional income taxes at up to the United States Federal statutory rate of 35%, which would negatively affect our results of operations and financial condition.

Our dependence on new products may cause our net revenues to fluctuate or decline. Our future success significantly depends upon our completing and introducing enhanced and new products at competitive prices and performance levels in a timely manner. The success of new product introductions depends on several factors, including the following:

- Designing products to meet customer needs;
- Product costs;
- Timely completion and introduction of new product designs;
- Quality of new products;
- Differentiation of new products from those of our competitors; and
- Market acceptance of our products.

Our product life cycles in each of our segments may be as brief as 12 months. As a result, we believe that we will continue to incur significant expenditures for research and development in the future. We may fail to identify new product opportunities and may not develop and bring new products to market in a timely manner. In addition, products or technologies developed by others may render our products or technologies obsolete or noncompetitive, or our targeted customers may not select our products for design or integration into their products. The failure of any of our new product development efforts could have an adverse effect on our business and financial results.

We have introduced RAID-enabled products based on the next generation SATA technology and delivered our products based on Serial Attached SCSI technology to certain major OEMs for testing and integration. We will not succeed in generating significant revenues from our new SATA and Serial Attached SCSI technology products if the market does not adapt to these new technologies, which would, over time, adversely affect our net revenues and operating results.

Our reliance on industry standards and technological changes in the marketplace may cause our net revenues to fluctuate or decline. The computer industry is characterized by various, evolving standards and protocols. We design our products to conform to certain industry standards and protocols such as the following:

Technologies:

- ATA
- Fibre channel
- FireWire/1394
- IPsec
- iSCSI
- PCI
- PCI-Express
- PCI-X
- RAID
- Serial Attached SCSI
- SATA
- SCSI

- SMI-S
- Ultra DMA
- USB

Operating Systems:

- Linux
- Macintosh
- Netware
- OS/2
- UNIX
- Windows

If user acceptance of these standards declines, or if new standards emerge, and if we do not anticipate these changes and develop new products, these changes could adversely affect our business and financial results.

If we lose the cooperation of other hardware and software producers whose products are integral to ours, our ability to sustain or grow our revenues could be adversely affected. We must design our products to operate effectively with a variety of hardware and software products supplied by other manufacturers, including the following:

- Microprocessors;
- Peripherals; and
- Operating system software.

We depend on significant cooperation from these manufacturers to achieve our design objectives and develop products that operate successfully with their products. These companies could, from time to time, elect to make it more difficult for us to design our products for successful operability with their products. For example, if one or more of these companies were to determine that as a result of competition or other factors our technology or products would not be broadly accepted by the markets we target, these companies may no longer work with us to plan for new products and new generations of our products, which would make it more difficult to introduce products on a timely basis or at all. Further, some of these companies might decide not to continue to offer products that are compatible with our technology and our markets could contract. If any of these events were to occur, our revenue could be adversely affected.

We are subject to various environmental laws and regulations that could impose substantial costs upon us and may adversely affect our business. The European Parliament has enacted the RoHS Directive, which restricts the sale of new electrical and electronic equipment containing certain hazardous substances, including lead that is currently used in some of the products we manufacture. We are working to modify our manufacturing processes to eliminate lead from our products in accordance with the timelines established in the RoHS Directive. This may require us to make additional capital expenditures. In addition, the costs associated with compliance may negatively impact our operating results and competitive position. For example, in the first nine months of fiscal 2006, we had an excess inventory adjustment of \$1.9 million related to the transition of our products to comply with the RoHS Directive. We are also working with our suppliers to redesign or reformulate their components containing lead to reduce or eliminate lead in our products. If we are unable to comply with the RoHS Directive, we may suffer a loss of revenue, be unable to sell affected products in certain markets or countries and be at a competitive disadvantage.

The European Parliament has also finalized the Waste Electrical and Electronic Equipment Directive, or WEEE Directive, which makes producers of electrical and electronic equipment financially responsible for specified collection, recycling, treatment and disposal of past and future covered products. We may incur financial responsibility for the collection, recycling, treatment or disposal of products covered under the WEEE Directive. Because the EU member states have not fully implemented the WEEE Directive, the nature and extent of the costs to comply and fees or penalties associated with non-compliance are unknown at this time. Costs to comply with the WEEE Directive and similar future legislation, if applicable, may also include legal and regulatory costs and insurance costs. We may also be required to take reserves for costs associated with compliance with these regulations.

We entered into strategic alliances with Vitesse for the development of our Serial Attached SCSI ROC product and with ServerEngines to advance our development of iSCSI products, and if these companies fail to develop and bring new products to market in a timely manner it could result in an adverse effect on our business and financial results. In January 2005, we entered into a strategic alliance with Vitesse for it to develop and market the next generation of our Serial Attached SCSI products. In March 2005, we entered into a strategic alliance with ServerEngines to develop and market the next generation of our IP storage products, such as 10Gb iSCSI. Accordingly, we are at risk that Vitesse and ServerEngines may encounter challenges in fulfilling their responsibilities under these alliances, such as timely completing and introducing new product designs, maintaining the quality of new products, minimizing product costs, differentiating new products from those of our competitors and achieving market acceptance of our products. The failure of this new product development effort could have an adverse effect on our business and financial results.

If we do not provide adequate support during our customers' design and development stage, or if we are unable to provide such support in a timely manner, we may lose revenues to our competitors. Certain of our products are designed to meet our customers' specifications and, to the extent we are not able to meet these expectations in a timely manner or provide adequate support during our customers' design and development stage, our customers may choose to buy similar products from another company. If this were to occur we may lose revenues and market share to our competitors.

If we are unable to compete effectively, our net revenues could be adversely affected. The markets for all of our products are intensely competitive and are characterized by the following:

- Rapid technological advances;
- Frequent new product introductions;
- Evolving industry standards; and
- Price erosion.

Consequently, we must continue to enhance our products on a timely basis to keep pace with market demands. If we do not do so, or if our competition is more effective in developing products that meet the needs of our existing and potential customers, we may lose market share and not participate in the future growth of our target markets. For example, intense competition in the transition from products employing Ultra 160 technology to products employing Ultra 320 technology has adversely affected revenues from our SCSI products. Our future success will depend on the level of acceptance of our external storage products and products based on the next generation SATA and Serial Attached SCSI technologies by new and existing customers. In addition, we expect that our future success will depend significantly on our ability to participate in the ongoing development of the network storage market in which we face intense competition from other companies that are also focusing on networked storage products.

We cannot assure you that we will have sufficient resources to accomplish all of the following:

- Satisfy any growth in demand for our products;

- Make timely introductions of new products;
- Compete successfully in the future against existing or potential competitors;
- Provide OEMs with design specifications in a timely manner; and
- Prevent price competition from eroding margins.

Costs associated with acquisitions or strategic alliances may adversely affect our results of operations, which could be exacerbated if we are unable to integrate the acquired companies, products or technologies. In fiscal 2005, we acquired Snap Appliance and the i/p Series RAID business from IBM. In fiscal 2004, we acquired Elipsan, ICP vortex, a provider of a broad range of hardware and software RAID data protection products, and Eurologic, a provider of external and networked storage products. In addition, we enter into strategic alliances from time to time with other companies. For example, we entered into strategic alliances with Vitesse and ServerEngines in January and March 2005, respectively. As part of our overall strategy, we may continue to acquire or invest in complementary companies, products or technologies and enter into strategic alliances with other companies. In order to be successful in these activities, we must:

- Conduct acquisitions that are timely, relative to existing business opportunities;
- Successfully prevail over competing bidders for target acquisitions at an acceptable price;
- Invest in companies and technologies that contribute to the growth of our business;
- Incorporate acquired operations into our business and maintain uniform standards, controls and procedures;
- Retain the key employees of the acquired operations; and
- Develop the capabilities necessary to exploit newly acquired technologies.

The benefits of acquisitions or strategic alliances may prove to be less than anticipated and may not outweigh the costs reported in our financial statements. For example, during the first nine months of fiscal 2006, we sold the IBM i/p Series RAID Business for a loss of \$3.5 million and plan to divest our systems business, which includes certain assets we obtained through the Snap Appliance and Eurologic Systems acquisitions.

Completing any potential future acquisitions or strategic alliances could cause significant diversions of management time and resources. If we acquire new businesses, products or technologies in the future, we may be required to assume warranty claims or other contingent liabilities, including liabilities unknown at the time of acquisition, and amortize significant amounts of other intangible assets and, over time, recognize significant charges for impairment of goodwill, other intangible assets or other losses. If we consummate any potential future acquisitions in which the consideration consists of stock or other securities, our existing stockholders' ownership may be significantly diluted. If we proceed with any potential future acquisitions in which the consideration is cash, we may be required to use a substantial portion of our available cash. In addition, we may be required to invest significant resources in order to perform under a strategic alliance or to complete an acquisition, which could adversely affect our results of operations, at least in the short-term, even if we believe the strategic alliance or acquisition will benefit us in the long-term. We may not be successful in overcoming these risks or any other problems encountered in connection with these or other business combinations, investments or strategic alliances. These transactions may adversely affect our business, financial position and operating results.

Product quality problems could lead to reduced revenues and gross margins. We produce highly complex products that incorporate leading-edge technologies, including both hardware and software. Software often contains "bugs" which can interfere with expected operations. We cannot assure you that our pre-shipment testing programs will be adequate to detect all defects which might interfere with customer

satisfaction, reduce sales opportunities, or affect our gross margins if the costs of remedying the problems exceed reserves established for that purpose. An inability to cure a product defect could result in the failure of a product line, and withdrawal, at least temporarily, from a product or market segment, damage to our reputation, inventory costs, product reengineering expenses, and a material impact on revenues and gross margins.

We currently purchase all of the finished production silicon wafers used in our products from wafer suppliers, and if they fail to meet our manufacturing needs, it would delay our production and our product shipments to customers and negatively affect our operations. Independent foundries manufacture to our specifications all of the finished silicon wafers used for our products. We currently purchase finished production silicon wafers used in our products from Taiwan Semiconductor Manufacturing Company, or TSMC, and IBM. The manufacture of semiconductor devices is sensitive to a wide variety of factors, including the following:

- The availability of raw materials;
- The availability of manufacturing capacity;
- Transition to smaller geometries of semiconductor devices;
- The level of contaminants in the manufacturing environment;
- Impurities in the materials used; and
- The performance of personnel and equipment.

We cannot assure you that manufacturing problems may not occur in the future. A shortage of raw materials or production capacity could lead our wafer suppliers to allocate available capacity to other customers. Any prolonged inability to obtain wafers with competitive performance and cost attributes, adequate yields or timely deliveries would delay our production and our product shipments, and could have an adverse effect on our business and financial results. We expect that our wafer suppliers will continually seek to convert their processes for manufacturing wafers to more advanced process technologies. Such conversions entail inherent technological risks that can affect yields and delivery times. If for any reason the wafer suppliers we use are unable or unwilling to satisfy our wafer needs, we will be required to identify and qualify additional suppliers. Additional wafer suppliers may be unavailable, may take significant amounts of time to qualify or may be unable to satisfy our requirements on a timely basis.

We depend on the efforts of our distributors, which if reduced, could result in a loss of sales of our products in favor of competitive offerings. We derived approximately 38% of our gross revenues for the first nine months of fiscal 2006 from independent distributor and reseller channels. Our financial results could be adversely affected if our relationships with these distributors or resellers were to deteriorate or if the financial condition of these distributors or resellers were to decline.

Our distributors generally offer a diverse array of products from several different manufacturers. Accordingly, we are at risk that these distributors may give higher priority to selling products from other suppliers. A reduction in sales efforts by our current distributors could adversely affect our business and financial results. For example, some of our distributors have threatened to stop selling our products or make pricing of our products non-competitive if we do not agree to absorb their costs to comply with the RoHS and WEEE Directives with respect to our products. Our distributors build inventories in anticipation of future sales, and if such sales do not occur as rapidly as they anticipate, our distributors will decrease the size of their product orders. If we decrease our price protection or distributor-incentive programs, our distributors may also decrease their orders from us. In addition, we have from time to time taken actions to reduce levels of products at distributors and may do so in the future. These actions may affect our net revenues and negatively affect our financial results.

We reorganized our business segments and have planned significant system enhancements and improvements, and these changes could adversely impact our business if not adequately managed and controlled. In the second quarter of fiscal 2006, we reorganized our internal organization structure related to our OEM and Channel segments. Where previously our former OEM and Channel segments each offered an integrated set of customer-focused products, the new organization is managed at the product level. The reorganization has placed demands on our management and our operational and financial infrastructure. In addition, management is in the process of enhancing our supply-chain systems and processes. These system enhancements and improvements require expenditures and allocation of management resources. If these improvements are not implemented successfully, our ability to manage our new organization could be impaired. In addition, we may be required to incur additional expenditures to address these issues, which could harm our financial position.

If we do not meet our restructuring objectives, we may have to implement additional plans in order to reduce our operating costs and may, as a result, incur additional material restructuring charges. We have implemented several restructuring plans to reduce our operating costs in the third quarter of fiscal 2006, fiscal 2005, fiscal 2004 and fiscal 2003, and recorded related restructuring charges of \$2.6 million, \$5.9 million, \$4.3 million and \$14.3 million, respectively. The plans included primarily the reduction of our workforce and the consolidation of our manufacturing operations in Singapore. The goals of these plans were to support future growth opportunities, focus on investments that grow revenues and increase operating margins. If we do not meet our restructuring objectives, we may have to implement additional restructuring plans to reduce our operating costs, which could cause us to incur material restructuring charges. Further, these restructuring plans may not achieve the goals we had in implementing them due to such factors as significant costs or restrictions on workforce reductions that may be imposed in some international locales and a potential adverse effect on employee morale that could harm our efficiency and our ability to act quickly and effectively in the rapidly changing technology markets in which we sell our products.

Some of our products contain "open source" software, and any failure to comply with the terms of one or more of these open source licenses could negatively affect our business. Some of our products are distributed with software licensed by its authors or other third parties under so-called "open source" licenses, including, for example, the GNU General Public License, or GPL, GNU Lesser General Public License, or LGPL, the Mozilla Public License, the BSD License, and the Apache License. Some of those licenses may require as a condition of the license that we make available source code for modifications or derivative works we create based upon, incorporating, or using the open source software, that we provide notices with our products, and/or that we license such modifications or derivative works under the terms of a particular open source license or other license granting third parties certain rights of further use. If an author or other third party that distributes such open source software were to allege that we had not complied with the conditions of one or more of those open source licenses, we could be required to incur legal expenses in defending against such allegations, and if our defenses were not successful we could be enjoined from distribution of the products that contained the open source software and required to either make the source code for the open source software available, to grant third parties certain rights of further use of our software, or to remove the open source software from our products, which could disrupt our distribution and sale of some of our products. In addition, if we combine our proprietary software with open source software in a certain manner, we could under some of the open source licenses, be required to release the source code of our proprietary software. If an author or other third party that distributes open source software were to obtain a judgment against us based on allegations that we had not complied with the terms of any such open source licenses, we could also be subject to liability for copyright infringement damages and breach of contract for our past distribution of such open source software.

Our operations depend on key personnel, the loss of whom could affect the growth and success of our business. In order to be successful, we must retain and motivate our executives, the general managers of

our business segments, our principal engineers and other key employees, including those in managerial, technical, marketing and information technology support positions. In particular, our product generation efforts depend on hiring and retaining qualified engineers. Competition for experienced management, technical, marketing and support personnel remains intense. For example, we transitioned certain research and development efforts to North Carolina, where we have experienced significant competition in our efforts to attract and retain qualified software engineers. The loss of any of these key employees could have a significant impact on our operations. We also must continue to motivate employees and keep them focused on our strategies and goals, which may be particularly difficult due to morale challenges posed by workforce reductions, the announcement of the divestiture of the systems business and general uncertainty.

Our international operations involve risks, and may be subject to political or other non-economic barriers to our being able to sell our products in certain countries, local economic conditions that reduce demand for our products among our target markets and potential disruption in the supply of necessary components. Many of our subcontractors are primarily located in Asia and we have sales offices and customers located throughout Europe, Japan and other countries. Our international operations and sales are subject to political and economic risks, including political instability, currency controls, changes in import/export regulations, tariffs and freight rates. In addition, because our primary wafer supplier, TSMC, is located in Taiwan, we may be subject to certain risks resulting from political instability in Taiwan, including conflicts between Taiwan and the People's Republic of China. These and other international risks could result in the creation of political or other non-economic barriers to our being able to sell our products in certain countries, create local economic conditions that reduce demand for our products among our target market or expose us to potential disruption in the supply of necessary components or otherwise adversely affect our ability to generate revenue and operate effectively.

We depend on third parties to transport our products. We rely on independent freight forwarders to move our products between manufacturing plants and our customers. Any transport or delivery problems because of their errors, or because of unforeseen interruptions in their activities due to factors such as strikes, political instability, terrorism, natural disasters and accidents, could adversely affect our business, financial condition and results of operations and ultimately impact our relationship with our customers.

If the carrying value of our long-lived assets is not recoverable, an impairment loss must be recognized which would adversely affect our financial results. Certain events or changes in circumstances would require us to assess the recoverability of the carrying amount of our long-lived assets. In the first nine months of fiscal 2006, we recorded a goodwill impairment charge of \$90.6 million related to our DPS segment. In fiscal 2005, we recorded a goodwill impairment charge of \$52.3 million related to our Channel segment. In fiscal 2004, we recorded an impairment charge of \$5.0 million related to certain properties classified as held-for sale and a charge of \$1.0 million relating to the decline in value of a minority investment. In fiscal 2003, we recorded an impairment charge of \$1.5 million relating to the decline in value of minority investments. In fiscal 2002, we recorded impairment charges of \$77.6 million relating to technology acquired in a prior acquisition and the decline in value of minority investments. We will continue to evaluate the recoverability of the carrying amount of our long-lived assets, and we may incur substantial impairment charges which could adversely affect our financial results.

If actual results or events differ materially from those contemplated by us in making estimates and assumptions, our reported financial condition and results of operations for future periods could be materially affected. The preparation of financial statements in conformity with accounting principles generally accepted in the United States of America requires management to make estimates and assumptions that affect the amounts reported in the consolidated financial statements and accompanying notes. For example, we have identified key accounting estimates in our Critical Accounting Policies in our Annual Report on Form 10-K for the fiscal year ended March 31, 2005, which includes revenue, inventory, goodwill and income taxes. In addition, Note 1 of the Notes to Consolidated Financial Statements in our

Annual Report on Form 10-K for the fiscal year ended March 31, 2005 describes the significant accounting policies essential to preparing our consolidated financial statements. The preparation of these financial statements requires estimates and assumptions that affect the reported amounts and disclosures. Although we believe that our judgments and estimates are appropriate and correct, actual future results may differ materially from our estimates.

If we are unable to protect and enforce our intellectual property rights, we may be unable to compete effectively. Although we actively maintain and defend our intellectual property rights, we may be unable to adequately protect our proprietary rights. In addition, the laws of certain territories in which our products are or may be developed, manufactured or sold, including Asia and Europe, may not protect our products and intellectual property rights to the same extent as the laws of the United States. Because we conduct a substantial portion of our operations in Singapore and other locations outside of the United States and sell to a worldwide customer base, we are more dependent on our ability to protect our intellectual property in international environments than would be the case if a larger portion of our operations were domestic.

Despite our efforts, we may be unable to prevent third parties from infringing upon or misappropriating our intellectual property, which could harm our business and ability to compete effectively. We have from time to time discovered counterfeit copies of our products being manufactured or sold by others. Although we have programs to detect and deter the counterfeiting of our products, significant availability of counterfeit products could reduce our revenues and damage our reputation and goodwill with customers.

Third parties may assert infringement claims against us, which may be expensive to defend and could divert our resources. From time to time, third parties assert exclusive patent, copyright and other intellectual property rights to our key technologies, and we expect to continue to receive such claims in the future. For example, in fiscal 2005, we, Nevada SCSI Enterprises, Inc. and Thomas A. Gafford (jointly, "NSE") entered into a license and release agreement, pursuant to which we paid NSE \$1.7 million as a one-time, fully paid-up license fee to settle NSE's claims that some of our products infringed certain patents. In addition, we entered into a patent cross-license agreement with IBM in May 2000. Under this agreement, which was amended in March 2002, we received a release from infringement claims prior to January 1, 2000 and received the right to use certain of IBM's patents through June 30, 2007. In consideration, we paid, in annual installments, an aggregate patent fee of \$13.3 million through June 30, 2004. The risks of our receiving additional claims from third parties may be enhanced in periods such as the one that we are currently entering where we are beginning to offer product lines employing new technologies relative to our existing products.

We cannot assure you that third parties will not assert other infringement claims against us, directly or indirectly, in the future, that assertions by third parties will not result in costly litigation or that we would prevail in such litigation or be able to license any valid and infringed intellectual property from third parties on commercially reasonable terms. These claims may be asserted in respect of intellectual property that we own or that we license from others. In addition to claims brought against us by third parties, we may also bring litigation against others to protect our rights. Intellectual property litigation, regardless of the outcome, could result in substantial costs to us and diversion of our resources, and could adversely affect our business and financial results.

We may be required to pay additional federal income taxes which could negatively affect our results of operations and financial position. On December 15, 2000, we received a statutory notice of deficiency from the IRS with respect to our Federal income tax return for fiscal 1997. We filed a Petition with the United States Tax Court on March 14, 2001, contesting the asserted deficiencies and settlement agreements have been filed with the United States Tax Court on all but one issue. In addition, the IRS is currently auditing our Federal income tax returns for fiscal 1998 through fiscal 2003. We have resolved all issues for fiscal

1998 through fiscal 2001 other than the rollover impact of any potential resolution on the remaining fiscal 1997 issue and tax credits that were generated but not used in subsequent years that may be carried back. While we believe we have meritorious defenses against the asserted deficiencies and any proposed adjustments, and that sufficient taxes have been provided, we cannot predict the final outcome of these matters, and the final resolution could adversely affect our results of operations and financial position.

We may be engaged in legal proceedings that could cause us to incur unforeseen expenses and could occupy a significant amount of our management's time and attention. From time to time we are subject to litigation or claims that could negatively affect our business operations and financial position. Such disputes could cause us to incur unforeseen expenses, could occupy a significant amount of our management's time and attention, and could negatively affect our business operations and financial position.

We have in the past financed a portion of our capital expenditure needs from capital market financing, and if we need to seek additional financing, it may not be available on favorable terms. In order to finance strategic acquisitions, capital asset acquisitions and other general corporate needs, we have in the past relied, in part, on the capital markets. Historically, we have been able to access capital markets, but this does not necessarily guarantee that we will be able to access these markets in the future or at terms that are acceptable to us. The availability of capital in these markets is affected by several factors, including geopolitical risk, the interest rate environment and the condition of the economy as a whole. In addition, our own operating performance, capital structure and expected future performance impacts our ability to raise capital. For example, in the third quarter of fiscal 2006, Standard and Poor's Ratings Services downgraded our subordinated debt rating from B- to CCC+. We believe that our current cash, cash equivalents, short-term investments and future cash provided by operations will be sufficient to fund our needs for at least the next twelve months. However, if our operating performance falls below expectations, we may need additional funds, which may not be available on favorable terms, if at all.

We are exposed to fluctuations in foreign currency exchange rates. Because a significant portion of our business is conducted outside the United States, we face exposure to adverse movements in non-United States currency exchange rates. These exposures may change over time as business practices evolve and could have an adverse impact on our financial results and cash flows. Historically, our exposures have related to non-dollar-denominated operating expenses in Europe and Asia. We began Euro-denominated sales to our distribution customers in the European Union in the fourth quarter of fiscal 2003. Additionally, we purchase a substantial portion of our raw materials and manufacturing equipment from foreign suppliers, and incur labor and other operating costs in foreign currencies, particularly in our Singapore manufacturing facility. An increase in the value of the dollar could increase the real cost to our customers of our products in markets outside the United States where we sell in dollars, and a weakened dollar could increase the cost of local operating expenses and procurement of raw materials to the extent we must purchase components in foreign currencies.

We hold minority interests in privately held venture funds, and if these venture funds face financial difficulties in their operations, our investments could be impaired. We continue to hold minority interests in privately held venture funds. At December 31, 2005, the carrying value of such investments aggregated \$3.5 million. We have also committed to provide additional funding of up to \$0.3 million. These investments are inherently risky because these venture funds invest in companies that may still be in the development stage or depend on third parties for financing to support their ongoing operations. In addition, the markets for the technologies or products of these companies are typically in the early stages and may never develop. If these companies do not have adequate cash funding to support their operations, or if they encounter difficulties developing their technologies or products, the venture funds' investments in these companies may be impaired, which in turn, could result in impairment of our investment in these venture funds.

Our spin-off of Roxio Inc., which is now known as Napster Inc., may have potential subsequent tax liabilities that could negatively affect our results of operations. Pursuant to our distribution of the Roxio, Inc. common stock, we received an opinion from PricewaterhouseCoopers LLP, or PwC, regarding the tax-free nature of the transaction to us and to our stockholders under Section 355 of the Internal Revenue Code. The validity of the PwC opinion relating to the qualification of the distribution as a tax-free transaction is subject to factual representations and assumptions. We are not aware of any facts or circumstances that would cause such representations and assumptions to be untrue. In addition, the opinion of PwC is not binding on the IRS. If Napster or we fail to conform to the requirements set forth in the IRS regulations, it could cause the distribution to be taxable to us and to our stockholders, and our financial results could be adversely affected.

We may have potential business conflicts of interest with Roxio, which is now known as Napster, with respect to our past and ongoing relationships, and we may not resolve these conflicts on terms favorable to us. Conflicts of interest may arise between Napster and us in areas relating to our past and ongoing relationship, including tax, indemnification and other matters arising from the separation. These and other business conflicts could adversely affect the growth of our business in the future.

Changes in securities laws and regulations have increased and may continue to increase our costs. Changes in the laws and regulations affecting public companies, including the provisions of the Sarbanes-Oxley Act of 2002 and rules promulgated by the Securities and Exchange Commission, have increased and may continue to increase our expenses as we evaluate the implications of these rules and devote resources to respond to their requirements. In particular, we incurred additional administrative expense to implement Section 404 of the Sarbanes-Oxley Act, which requires management to report on, and our Independent Registered Public Accounting Firm to attest to, our internal control over financial reporting.

In addition, The Nasdaq National Market, on which our common stock is listed, has also adopted comprehensive rules and regulations relating to corporate governance. These laws, rules and regulations have increased and will continue to increase the scope, complexity and cost of our corporate governance, reporting and disclosure practices. We also expect these developments to make it more difficult and more expensive for us to obtain director and officer liability insurance in the future, and we may be required to accept reduced coverage or incur substantially higher costs to obtain coverage. Further, our board members, Chief Executive Officer and Chief Financial Officer could face an increased risk of personal liability in connection with the performance of their duties. As a result, we may have difficulty attracting and retaining qualified board members and executive officers, which would adversely affect our business.

Internal control deficiencies or weaknesses that are not yet identified could emerge. Over time we may identify and correct deficiencies or weaknesses in our internal control over financial reporting and, where and when appropriate, report on the identification and correction of these deficiencies or weaknesses. However, the internal control procedures can provide only reasonable, and not absolute, assurance that deficiencies or weaknesses are identified. Deficiencies or weaknesses that are not yet identified could emerge, and the identification and corrections of these deficiencies or weaknesses could have a material impact on our results of operations.

Internal control issues that appear minor now may later become material weaknesses. We are required to publicly report on deficiencies or weaknesses in our internal control over financial reporting that meet a materiality standard as required by law. Management may, at a point in time, accurately categorize a deficiency or weakness as immaterial or minor and therefore not be required to publicly report such deficiency or weakness. Such determination, however, does not preclude a change in circumstances such that the deficiency or weakness could, at a later time, become a material weakness that could have a material impact on our results of operations.

We may encounter natural disasters, which could cause disruption to our employees or interrupt the manufacturing process for our products. Our operations could be subject to natural disasters and other

business disruptions, which could seriously harm our revenues and financial condition and increase our costs and expenses. Our corporate headquarters are located in California, near major earthquake faults. Additionally, our primary wafer supplier, TSMC, is located in Taiwan, which has experienced significant earthquakes in the past. A severe earthquake could cause disruption to our employees or interrupt the manufacturing process, which could affect TSMC's ability to supply wafers to us, which would negatively affect our business and financial results. The ultimate impact on us and our general infrastructure of being located near major earthquake faults is unknown, but our net revenues and financial condition and our costs and expenses could be significantly impacted in the event of a major earthquake.

Manmade problems such as computer viruses or terrorism may disrupt our operations and harm our operating results.

Despite our implementation of network security measures, our servers are vulnerable to computer viruses, break-ins and similar disruptions from unauthorized tampering with our computer systems. Any such event could have an adverse effect on our business, operating results, and financial condition. In addition, the effects of war or acts of terrorism could have an adverse effect on our business, operating results, and financial condition. In addition, as a company with headquarters and significant operations located in the United States, we may be impacted by actions against the United States. We are predominantly uninsured for losses and interruptions caused by terrorist acts and acts of war.

We may experience significant fluctuations in our stock price, which may, in turn, significantly affect the trading price of our convertible notes.

Our stock has experienced substantial price volatility, particularly as a result of quarterly variations in our operating results, the published expectations of analysts and as a result of announcements by our competitors and us. In addition, the stock market has experienced price and volume fluctuations that have affected the market price of many technology companies, in particular, and that have often been unrelated to the operating performance of such companies. In addition, the price of our securities may also be affected by general global, economic and market conditions and the cost of operations in one or more of our product markets. While we cannot predict the individual effect that these factors may have on the price of our securities, these factors, either individually or in the aggregate, could result in significant variations in the price of our common stock during any given period of time. These fluctuations in our stock price also impact the price of our outstanding convertible securities and the likelihood of the convertible securities being converted into our common stock.

Item 3. Quantitative and Qualitative Disclosures About Market Risk

For financial market risks related to changes in interest rates, equity price and foreign currency exchange rates, reference is made to Item 7A "Quantitative and Qualitative Disclosures About Market Risk" contained in Part II of our Annual Report on Form 10-K for the fiscal year ended March 31, 2005. Our exposure to market risk has not changed materially since March 31, 2005.

Item 4. Controls and Procedures

Evaluation of Disclosure Controls and Procedures

Under the supervision and with the participation of our management, including our Chief Executive Officer (CEO) and our Chief Financial Officer (CFO), we conducted an evaluation of our disclosure controls and procedures (as defined in Rules 13a-15(e) and 15d-15(e) under the Securities Exchange Act of 1934 (Exchange Act), as of the end of the period covered by this Quarterly Report on Form 10-Q. Based upon that evaluation, our CEO and our CFO have concluded that the design and operation of our disclosure controls and procedures were effective to ensure that information required to be disclosed by us in reports that we file or submit under the Exchange Act is recorded, processed, summarized and reported within the time periods specified in Securities and Exchange Commission rules and forms.

Changes in Internal Control Over Financial Reporting

There has been no change in our internal control over financial reporting that occurred during the period covered by this Quarterly Report on Form 10-Q that has materially affected, or is reasonably likely to materially affect, our internal control over financial reporting.

Inherent Limitations on Effectiveness of Controls

Our management, including our CEO and CFO, does not expect that our disclosure controls and procedures or our internal control over financial reporting will prevent or detect all error and all fraud. A control system, no matter how well designed and operated, can provide only reasonable, not absolute, assurance that the control system's objectives will be met. The design of a control system must reflect the fact that there are resource constraints, and the benefits of controls must be considered relative to their costs. Further, because of the inherent limitations in all control systems, no evaluation of controls can provide absolute assurance that misstatements due to error or fraud will not occur or that all control issues and instances of fraud, if any, within the company have been detected. These inherent limitations include the realities that judgments in decision-making can be faulty and that breakdowns can occur because of simple error or mistake. Controls can also be circumvented by the individual acts of some persons, by collusion of two or more people, or by management override of the controls. The design of any system of controls is based in part on certain assumptions about the likelihood of future events, and there can be no assurance that any design will succeed in achieving its stated goals under all potential future conditions. Projections of any evaluation of controls effectiveness to future periods are subject to risks. Over time, controls may become inadequate because of changes in conditions or deterioration in the degree of compliance with policies or procedures.

PART II. OTHER INFORMATION

Item 6. Exhibits

<u>Exhibit Number</u>	<u>Description</u>
Exhibit 10.1	Manufacturing Services and Supply Agreement by and between Adaptec, Inc. and Sanmina-SCI Corporation*
Exhibit 10.2	Asset Purchase and Sale Agreement, dated as of December 23, 2005, by and among Adaptec Manufacturing (s) Pte. Ltd., Sanmina-SCI Corporation and Sanmina-SCI Systems Singapore Pte. Ltd.
Exhibit 10.3	Amendment to Manufacturing Services and Supply Agreement by and between Adaptec, Inc. and Sanmina-SCI Corporation*
Exhibit 31.1	Certification of Chief Executive Officer pursuant to Section 302 of the Sarbanes-Oxley Act of 2002.
Exhibit 31.2	Certification of Chief Financial Officer pursuant to Section 302 of the Sarbanes-Oxley Act of 2002.
Exhibit 32.1	Certification of Chief Executive Officer and Chief Financial Officer pursuant to Section 906 of the Sarbanes-Oxley Act of 2002.

* Confidential treatment has been requested for portions of this exhibit pursuant to an application for confidential treatment sent to the Securities and Exchange Commission. Such portions are omitted from this filing and are filed separately with the Securities and Exchange Commission.

SIGNATURE

Pursuant to the requirements of the Securities Exchange Act of 1934, the registrant has duly caused this report to be signed on its behalf by the undersigned hereunto duly authorized.

ADAPTEC, INC.

By: /s/ MARSHALL L.
 MOHR
 Marshall L. Mohr
 *Vice President and Chief
 Financial Officer
 (principal financial and
 accounting officer)*

Date: February 7, 2006

EXHIBIT INDEX

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Confidential Treatment Requested. Certain portions of this document have been omitted pursuant to a request for confidential treatment and, where applicable, have been marked with an asterisk to denote where omissions have been made. The confidential material has been filed separately with the Securities and Exchange Commission.

MANUFACTURING SERVICES AND SUPPLY AGREEMENT

THIS MANUFACTURING SERVICES AND SUPPLY AGREEMENT (the “**Agreement**”) with an effective date as of the Closing Date is made and entered into by and between **ADAPTEC, INC.**, a Delaware corporation having a place of business at 691 S. Milpitas Blvd., Milpitas, California 95035, on behalf of itself and its Affiliates (collectively, “**ADAPTEC**”), and **SANMINA-SCI CORPORATION**, a Delaware corporation having its principal place of business at 2700 North First Street, San Jose, California 95134, on behalf of itself and its Affiliates (collectively “**SANMINA-SCI**”). ADAPTEC and SANMINA-SCI are sometimes individually referred to herein as a “**Party**” and collectively referred to herein as the “**Parties**”.

RECITALS

A. Concurrently with the execution of this Agreement, ADAPTEC and SANMINA-SCI entered into an Asset Purchase and Sale Agreement (the “**Asset Purchase Agreement**”) and certain other ancillary agreements.

B. Under the Asset Purchase Agreement, SANMINA-SCI purchased certain assets of ADAPTEC used to conduct the Business (as defined in Asset Purchase Agreement).

C. The Parties are entering into this Agreement to set forth the terms and conditions pursuant to which ADAPTEC will purchase from SANMINA-SCI and SANMINA-SCI will manufacture and supply to ADAPTEC, on an exclusive basis (except as specified herein), certain printed circuit assemblies and storage systems produced for ADAPTEC through the operation of the Business as well as certain other products, as mutually agreed to by the Parties.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the Parties agree as follows:

1. DEFINITIONS

Capitalized terms used in this Agreement that are not defined below or elsewhere in this Agreement are defined in the Asset Purchase Agreement and will have the meaning given to such terms in the Asset Purchase Agreement.

1.1 “**Affiliate**” means, with respect to any Party, any entity that directly or indirectly controls, is controlled by, or is under common control with a Party. For purposes of this definition, “**control**” means having: (i) ownership of more than fifty percent (50%) of the outstanding voting securities entitled to vote for the election of directors (or, in the case of an entity that is not a corporation, for the election of the corresponding managing authority); or (ii) the right to vote for or appoint a majority of the board of directors or other governing body of such entity. An entity will be deemed to be an Affiliate only so long as such control exists.

1.2 “**BOM**” means bill of materials.

1.3 “**Exclusivity Period**” means a * period commencing as of the Closing Date.

1.4 “**Forecast**” shall have the meaning set forth in Section 5.1(b).

1.5 “**Fountain Products**” means those Products that SANMINA-SCI is manufacturing for ADAPTEC at SANMINA-SCI’s Fountain, Colorado manufacturing facility, as of the Closing Date, pursuant to that certain Letter of Intent dated June 2, 2005 (the “**LOA**”), as well as any revisions, releases or upgrades thereto that ADAPTEC desires to have manufactured.

1.6 “**Inventory**” or “**Inventories**” or “**Components**” means any raw material, component, part or other item used in the manufacture of the Products, whether purchased by SANMINA-SCI at the Closing or thereafter.

* Confidential treatment requested

1.7 “**Manufacturing Specifications**” means the written specifications that describe the manner in which a Product is manufactured and tested, and excludes all other Specifications.

1.8 “**New Asian EMS Products**” means any New EMS Product that ADAPTEC desires to have manufactured in Asia (including but not limited to China, Malaysia, Singapore, Indonesia and Thailand).

1.9 “**New EMS Products**” means any printed circuit board assembly and/or storage system that ADAPTEC requires to be manufactured during the term of this Agreement. New EMS Products excludes Singapore Products.

1.10 “**Order**” shall have the meaning set forth in Section 5.1(d).

1.11 “**Other Products**” shall have the meaning set forth in Section 4.1.

1.12 “**Products**” means, collectively, Fountain Products, New EMS Products and Singapore Products.

1.13 “**SANMINA-SCI In-Sourced Components**” shall have the meaning set forth in Section 12.4.

1.14 “**Singapore Products**” means those printed circuit assemblies and storage systems, as identified in Exhibit A hereto, that are produced by ADAPTEC through the operation of the Business as of the Closing Date, and any follow-on products, revisions, releases, or upgrades thereto that ADAPTEC desires to have manufactured. For purposes of clarification, “follow-on products” means any product that incorporates substantially the same or similar functionality and features as an existing Singapore Product, but also includes new functionality and/or features.

1.15 “**Specifications**” means the written specifications that describe the design, functionality, configuration and/or performance requirements of a Product.

1.16 “**Warranted In-sourced Components**” means any SANMINA-SCI In-Sourced Components that are primarily manufactured by SANMINA-SCI, such as, but not limited to, PCB fabs and memory modules. Warranted In-Sourced Components exclude any SANMINA-SCI In-Sourced Components that are produced by SANMINA-SCI primarily by assembling or incorporating third-party components (such as backplanes and PCB assemblies).

2. **TERM**

The initial term of this Agreement shall commence on the Closing Date and shall continue through the third anniversary of the Closing Date (the “**Initial Term**”) unless sooner terminated by mutual agreement or in accordance with the terms of this Agreement. Upon the expiration of the Initial Term, this Agreement shall continue from year to year until one Party terminates the Agreement by giving at least ninety (90) days’ prior written notice to the other Party or unless terminated sooner in accordance with the terms of this Agreement.

3. **EXCLUSIVE SUPPLY RELATIONSHIP**

3.1 Exclusivity. Subject to the terms and conditions of this Agreement, and except as specified in Sections 3.2 through 3.4, during the Exclusivity Period ADAPTEC will purchase from SANMINA-SCI, and SANMINA-SCI will manufacture and supply to ADAPTEC, all of ADAPTEC’s requirements for Singapore Products and New Asian EMS Products (the “**Exclusive Products**”).

3.2 Disposition Transaction Exception. Notwithstanding the provisions of Section 3.1, ADAPTEC will have no obligation to continue to purchase from SANMINA-SCI, and SANMINA-SCI will

have no obligation to continue to manufacture and supply to ADAPTEC, any Exclusive Product that is part of or included in any Disposition Transaction; provided, that except as expressly agreed to in writing by the Parties, the foregoing provisions will not be deemed to affect any Orders outstanding as of the consummation of such Disposition Transaction. ADAPTEC shall be liable to repurchase Equipment and/or Inventory from SANMINA-SCI in accordance with the Asset Purchase Agreement.

3.3 New Asian EMS Products. Notwithstanding the foregoing, New Asian EMS Products shall be deemed to be Exclusive Products only if the pricing set forth in SANMINA-SCI's BOM for a New Asian EMS Product, taken as a whole, is less than or equal to the pricing set forth in the BOM of any third party that makes a bona fide offer to manufacture a New Asian EMS Product in Asia. For clarification, the Parties agree that only the * shall be taken into account.

3.4 Second Source Rights.

(a) Notwithstanding the provisions of Section 3.1 and subject to Section 3.4(b), and without limiting ADAPTEC's rights or remedies under this Agreement or otherwise, ADAPTEC will have the right to purchase Exclusive Products from any third party (a "**Second Source Supplier**"), without obligation or liability to SANMINA-SCI (other than any liability for Components in accordance with Section 5.4(e)), upon the occurrence of any of the following conditions (each, a "**Second Source Condition**"): (i) SANMINA-SCI breaches its material obligations under Section 5 with respect to meeting ADAPTEC's volume requirements, as set forth in a Forecast (defined in Section 5.1(a)) or in Section 5.4(c); (ii) SANMINA-SCI breaches its material obligations under Section 12 (Quality); (iii) SANMINA-SCI breaches its material obligations under Section 6.1 (Delivery) by failing to use reasonable efforts to deliver the Products or repeatedly failing to deliver the Products on the agreed-upon delivery dates; (iv) a strike, lockout or other labor dispute by SANMINA-SCI employees that makes it impossible for SANMINA-SCI to perform; (v) ADAPTEC has a good faith belief, based on SANMINA-SCI's financial condition, that SANMINA-SCI will not be able to continue to perform its material obligations hereunder and, following ADAPTEC's request, SANMINA-SCI fails to provide ADAPTEC with reasonable written assurances of its ability to continue to perform; or (vi) SANMINA-SCI: (A) enters into or files a petition, arraignment or proceeding seeking an order for relief under the bankruptcy laws of its respective jurisdictions; (B) enters into a receivership of any of its assets; or (C) enters into a dissolution or liquidation of its assets or an assignment for the benefit of its creditors. Notwithstanding the foregoing, a Second Source Condition shall not be deemed to have occurred unless ADAPTEC provides SANMINA-SCI with written notice of the Second Source Condition and SANMINA-SCI fails to cure or resolve such condition within twenty (20) days following receipt of such notice. Without limiting the foregoing, the Parties agree that transferring the manufacture of an Exclusive Product from the facility at which it was originally being manufactured by SANMINA-SCI to another SANMINA-SCI facility, if acceptable to ADAPTEC, could constitute a cure or resolution of a Second Source Condition, notwithstanding the fact that such a transfer may take longer than twenty (20) days to effect.

(b) ADAPTEC may exercise the rights set forth in Section 3.4(a) for as long as the applicable Second Source Condition remains in effect or is not otherwise cured or resolved by SANMINA-SCI. For as long as a Second Source Condition remains in effect or is not otherwise cured or resolved by SANMINA-SCI, SANMINA-SCI will use its best reasonable efforts to assist and cooperate with ADAPTEC and the Second Source Supplier and to provide such materials and documentation as reasonably requested by ADAPTEC or the Second Source Supplier to enable ADAPTEC to have the Exclusive Products manufactured by the Second Source Supplier and to minimize any disruption in the supply of Exclusive Products to ADAPTEC. Without limiting the foregoing, at ADAPTEC's request, SANMINA-SCI will sell to the Second Source Supplier, at cost, any Inventories purchased by SANMINA-SCI that the Second Source Supplier may require to manufacture the applicable Exclusive Products.

(c) Subject to the limitations set forth herein, SANMINA-SCI shall be liable to reimburse ADAPTEC, up to a maximum reimbursement of *, for: (i) reasonable and customary amounts that ADAPTEC pays to third parties to transition the manufacturing of the applicable Exclusive Products to the Second Source Supplier (e.g., expedited freight), but SANMINA-SCI shall not be liable for any costs or expenses incurred by the Second Source Supplier to commence

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manufacturing such Exclusive Products for ADAPTEC or for any internal costs incurred by ADAPTEC, including but not limited to any employee time, spent remedying the Second Source Condition; and (ii) ADAPTEC's reasonable cover costs, i.e., any increased prices that ADAPTEC may have to pay to the Second Source Supplier for the manufacture of such Exclusive Products; provided, that SANMINA-SCI's liability for such cover costs will terminate as of the date SANMINA-SCI cures or resolves the applicable Second Source Condition and is able to resume the manufacture of the applicable Exclusive Products under the same terms and conditions, including without limitation, pricing, quality and delivery times in accordance with which SANMINA-SCI manufactured such Exclusive Products prior to the occurrence of the Second Source Condition.

(d) Upon the cessation of the Second Source Condition or SANMINA-SCI's cure or resolution thereof, the provisions of Section 3.1 will apply; provided, however, that: (i) ADAPTEC will have a reasonable period following the date of such cessation, cure or resolution, as the case may be, to resume purchasing Exclusive Products from SANMINA-SCI; (ii) SANMIA-SCI will be liable to reimburse ADAPTEC for any reasonable costs and expenses incurred by ADAPTEC to resume purchasing Exclusive Products from SANMINA-SCI; and (iii) in no event will ADAPTEC be required to breach an agreement with a Second Source Supplier in order to resume purchasing Exclusive Products from SANMIA-SCI. Notwithstanding the foregoing, ADAPTEC acknowledges and agrees that it will not enter into any agreement to purchase products from any Second Source Supplier if such agreement is not terminable by ADAPTEC after one (1) year or if such agreement requires ADAPTEC to purchase a minimum quantity of Exclusive Products from the Second Source Supplier after one (1) year.

(e) If, upon the occurrence of a Second Source Condition, ADAPTEC, in its sole discretion, elects to exercise the rights and remedies set forth in the foregoing provisions of this Section 3.4, ADAPTEC will have no right to terminate this Agreement for cause under Section 11.1 (or claim any damages from SANMINA-SCI as a result of any breach) based on such Second Source Condition; provided, that SANMINA-SCI complies with its obligations herein.

3.5 Fountain Products and New EMS Products.

(a) Section 3.1 shall not apply to any Fountain Products. The Parties' rights and obligations with respect to the purchase, manufacture and sale of the Fountain Products will be solely as set forth in the LOA.

(b) The Parties acknowledge and agree that, except as set forth in Section 3.6, the provisions of Section 3.1 shall apply only to the New Asian EMS Products and not to any other New EMS Product.

3.6 Right of First Refusal; Last Call. Prior to entering into an agreement with any third party supplier (each, a "**Third-Party Supplier**") for the manufacture and supply any Fountain Product or New EMS Product (other than a New Asian EMS Product), ADAPTEC shall solicit a quotation from SANMINA-SCI. If SANMINA-SCI's quotation for the manufacture of such Fountain Product or New EMS Product is not competitive (as defined in Section 3.5(b)), then ADAPTEC shall advise SANMINA-SCI as to the specific terms or condition(s) of its quotation that are not competitive (as defined in Section 3.5(b)) prior to awarding the manufacture of such Fountain Product or New EMS Product to a Third-Party Supplier. In such event, SANMINA-SCI shall have a reasonable opportunity to amend its terms and conditions to match or exceed the terms and conditions of a Third-Party Supplier that is willing and able to manufacture and supply such Fountain Product or New EMS Product for ADAPTEC pursuant to terms and conditions that are competitive (as defined in Section 3.5(b)). If SANMINA-SCI agrees to amends its terms and conditions in accordance with the foregoing, then the manufacture and supply of the applicable Fountain Product or New EMS Product shall be subject to Section 3.1. SAMINA-SCI acknowledges and agrees that nothing in this provision or otherwise will be deemed to require ADAPTEC to breach any non-disclosure agreement or similar obligation between ADAPTEC and a potential Third-Party Supplier.

4. PRICING

4.1 Definition of Forecasted Singapore Products. For the purpose of this Agreement, the term “**Forecasted Singapore Products**” includes any Singapore Product or New Asian EMS Product for which ADAPTEC provides a Forecast (as defined in Section 5.1(b)) to SANMINA-SCI. Forecasted Singapore Products shall not include: (i) any Singapore Product or New Asian EMS Product that is purchased under an “end of life buy”; (ii) any Singapore Product or New Asian EMS Product that SANMINA-SCI manufactures for warranty replacement or out-of-warranty repair, or (iii) any Singapore Product or New Asian EMS Product for which ADAPTEC does not provide a Forecast (collectively “**Other Products**”). For the avoidance of doubt, Forecasted Singapore Products do not include Fountain Products or New EMS Products other than New Asian EMS Products.

4.2 Pricing for Forecasted Singapore Products. During the term of this Agreement, the pricing for all Forecasted Singapore Products will be determined solely in accordance with the terms and conditions set forth in Exhibit B. The pricing set forth in Exhibit B (but subject expressly to the additional pricing terms set forth in Section 1(c) of Exhibit B) will also apply to any Singapore Products and New Asian EMS Products that SANMINA-SCI manufactures pursuant to Section 5.4(c) (Upside Demand).

4.3 Pricing for Small Builds. For purposes hereof, “**Small Build**” means any Singapore Product or New Asian EMS Product that ADAPTEC requests SANMINA-SCI to manufacture in quantities having an aggregate U.S. Dollar purchase price of less than * (on a “per product” basis). For clarification, all products in any Small Build must be from the same product family (i.e., the same PCB). The pricing set forth in Exhibit B will apply to Small Builds; provided, however, that SANMINA-SCI will be entitled to charge an additional amount for each Small Build to cover its costs in producing small volume Products (“**Setup Fee**”). SANMINA-SCI will advise ADAPTEC of the amount of the Setup Fee within five (5) business days after a request from ADAPTEC (“**Request**”). In the event ADAPTEC believes that the Setup Fee is not competitive, it shall have a right to place an order with a Third-Party Supplier for the Products contained in the Request without breaching its obligations in Section 3.1; provided, however, that it shall only be entitled to have the Third-Party Supplier manufacture the specific Products set forth in the Request and not any subsequent Products (even if the subsequent Products are identical to those in the Request, it must provide a subsequent Request to SANMINA-SCI).

4.4 Pricing for Other Products.

(a) During the term of this Agreement, the pricing for Other Products will be as negotiated in good faith by the Parties. Unless otherwise agreed in writing by the Parties, the price of Other Products: (i) will include ADAPTEC packaging, or as specified by ADAPTEC; (ii) will exclude Price Exclusions (defined in subsection (b), below), and (iii) will be based on: (A) the configuration set forth in the Specifications provided to SANMINA-SCI on which SANMINA-SCI’s quotation was based; and (B) the projected volumes, minimum run rates and other assumptions set forth in SANMINA-SCI’s quotation.

(b) For purposes hereof, “**Price Exclusions**” means and is limited to (i) fees and other charges associated with export licensing of the Other Products and payment of broker’s fees, duties, tariffs and other similar charges; (ii) taxes or charges (other than those based on net income of SANMINA-SCI) imposed by any taxing authority upon the manufacture, sale, shipment, storage, “value add” or use of Other Products; and (iii) setup for products not in production, tooling, or non-recurring engineering activities incurred with respect to the Other Products.

(c) Unless otherwise agreed in writing by the Parties, the Other Products prices shall remain fixed for any given quarter, subject to SANMINA-SCI’s right to revise such prices: (i) to account for any variations on the market prices of Components, including any such variations resulting from allocations or shortages; (ii) to account for any changes in the exchange rate between the currency in which the pricing is calculated and the currency in which SANMINA-SCI pays for its labor, overhead and Components; or (iii) to account for any increases in SANMINA-SCI’s costs as result of changes in the pricing assumptions or the Specifications.

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(d) The Parties acknowledge and agree that the pricing for any Fountain Products that SANMINA-SCI manufactures for and supplies to SANMINA-SCI pursuant to the LOA will be solely as set forth in such agreement.

4.5 Payment Terms. Payment terms for all Products purchased by a party hereunder are net * days after the date of the invoice. The Parties acknowledge that these terms are intended to be “firm” (e.g., that payment is expected to be received on the * day after the invoice date). On any invoices not paid by the due date, a party shall pay interest from due date to the date of payment at the rate of 1.5% per month unless such invoice was disputed in good faith, in which case the interest rate shall be reduced to 1.0% per month. Unless otherwise stated, all prices are stated in and all payments shall be made in U.S. Dollars.

4.6 Setoffs. Except as expressly agreed to in writing by the Parties, neither Party shall be entitled to set-off any amount owing from the other Party to such Party against any amount payable to the other Party from such Party, under this Agreement or arising out of other Agreement or transaction between the Parties. For purposes of this Section 4.6, a Party shall be deemed to include the Parties to this transaction and each of the Party’s Affiliates.

4.7 Credit Limit. SANMINA-SCI’s Credit Department shall provide ADAPTEC with an initial credit limit, which shall be reviewed (and, if necessary, adjusted) from time to time. SANMINA-SCI shall have the right to reduce the credit limit upon five (5) days’ prior written notice to ADAPTEC. In the event ADAPTEC exceeds this credit limit or has any outstanding invoice more than fifteen (15) days past due, SANMINA-SCI shall have the right to stop shipments of Product to ADAPTEC until ADAPTEC makes a sufficient payment to bring its account within the credit limit provided.

4.8 Security Interest. ADAPTEC grants SANMINA-SCI a security interest in the Products delivered to ADAPTEC until ADAPTEC has paid for the Products and all Product-related charges. ADAPTEC agrees to promptly execute any documents requested by SANMINA-SCI to perfect and protect such security interest.

5. PURCHASE ORDERS/FORECAST/RESCHEDULE

5.1 Definitions.

(a) “**Channel Customer Order**” is an order for Products to be sold by ADAPTEC, under ADAPTEC’s brand, directly or indirectly to an end user customer.

(b) “**Forecast**” means ADAPTEC’s forecast for Products for the ensuing nine-month period (with the first six months forecasted in weekly buckets and the last three months forecasted in monthly buckets).

(c) “**OEM Customer Order**” is an order for Products to be sold by ADAPTEC to a customer for resale under such customer’s brand, either standalone or incorporated with such customer’s product, to an end user customer.

(d) “**Order**” is the document authorizing SANMINA-SCI to build the Product and shall be submitted in accordance with Section 5.3(a). Order includes Channel Customer Orders and OEM Customer Orders.

(e) “**Pick Order**” is a document advising SANMINA-SCI of: (i) the delivery date and shipping schedule for the shipment of Products; (ii) the location to which the Product is to be shipped; and (iii) transportation instructions for the Product.

(f) “**Purchase Agreement Release ABAP**” is the document advising SANMINA-SCI of the location to which the Product is shipped.

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(g) “**Schedule Agreement**” means ADAPTEC’s anticipated demand for the ensuing period (which will contain, at a minimum, the part number of the Product, and the quantity of the Product, as well as billing information).

5.2 Forecast.

(a) Upon the execution of this Agreement, ADAPTEC shall provide SANMINA-SCI with (i) an initial Forecast; (ii) an Order and (iii) any necessary Purchase Agreement Release ABAP.

(b) The Parties agree that (i) the Forecast is the document pursuant to which SANMINA-SCI will order Components, and (ii) the Order is the document which authorizes SANMINA-SCI to build the Product. ADAPTEC acknowledges that it is financially responsible for all Components ordered by SANMINA-SCI based on its then-current Forecast; provided that such Components were ordered in accordance with this Section 5, and that, subject to the terms and conditions of this Agreement, ADAPTEC is financially responsible for all Products built as a result of the Order. For all other purposes, the Forecast is non binding.

(c) On the first business day of each calendar month (or as agreed to by the Parties), ADAPTEC shall supply SANMINA-SCI with an additional Forecast and Order. In the event the revised Forecast or Order result in any Component becoming excess or obsolete, SANMINA-SCI shall promptly notify ADAPTEC thereof.

5.3 Orders

(a) Each OEM Customer Order will cover a thirty to sixty day time period, and shall contain (i) the delivery date or shipping schedule; (ii) the location to which the Product is to be shipped; and (iii) transportation instructions. Each Channel Customer Order will cover a thirty to sixty day time period and shall contain the date on which the Product should be shipped to the inventory location owned and managed by SANMINA-SCI (the “**Supplier-Owned Inventory Location**”). Products located at the Supplier Owned Inventory Location shall be shipped in accordance with the Pick Order. In the event SANMINA-SCI has not received a Pick Order for Products located in the Supplier Owned Inventory Location within sixty (60) days after the date on which the Product was manufactured, SANMINA-SCI shall have the right to invoice ADAPTEC for such Products. At ADAPTEC’s request upon payment for the Products, SANMINA-SCI will continue to warehouse the Products at no charge for up to an additional one hundred twenty (120) days.

(b) No Order, Purchase Agreement Release ABAP, Pick Order or Schedule Agreement shall contain anything which conflicts with or is inconsistent with this Agreement.

(c) All Orders shall be confirmed by SANMINA-SCI within three (3) business days of receipt. If SANMINA-SCI does not accept or reject the Order within the three (3) day period, the Order shall be deemed rejected by SANMINA-SCI. Notwithstanding the foregoing, the Parties acknowledge that SANMINA-SCI shall have no right to reject an Order for Forecasted Singapore Products, or for any Product that SANMINA-SCI is required to manufacture for ADAPTEC pursuant to the first sentence of Section 5.4(c) (Upside Demand), or for any Fountain Product or New Asian EMS Product to which the provisions of Section 3.1 apply and for which ADAPTEC has provided SANMINA-SCI with a Forecast, unless (i) the Order attempts to alter the delivery dates; (ii) the Order contains an incorrect price; or (iii) the Order is otherwise inconsistent with this Agreement.

5.4 MRP Process, Reschedules, Excess and Obsolete Inventory; Component Liability.

(a) MRP Process.

(1) SANMINA-SCI shall take the Order and Forecast and generate a Master Production Schedule (“**MPS**”) for a nine month period in accordance with the process described in this Section 5. The MPS shall define the master plan on which SANMINA-SCI shall base its procurement, internal capacity projections and commitments.

(2) SANMINA-SCI shall process the MPS through industry-standard software that will break down ADAPTEC's Product requirements into Component requirements. When no Product testing (in-circuit or functional testing) is required by ADAPTEC, SANMINA-SCI will use commercially reasonable efforts to schedule delivery of all Components to SANMINA-SCI eleven (11) working days before the Products are scheduled to ship to ADAPTEC. In the event Product testing is required, SANMINA-SCI will use commercially reasonable efforts to schedule delivery of all Components to SANMINA-SCI sixteen (16) working days before the Products are scheduled to ship to ADAPTEC.

(3) SANMINA-SCI will release (launch) purchase orders to Component suppliers ("Vendors") (including other SANMINA-SCI facilities) prior to the anticipated date that the Components are needed at SANMINA-SCI. The date on which these orders are launched will depend on the lead time determined between the Vendor and SANMINA-SCI and SANMINA-SCI's manufacturing or materials planning systems. At ADAPTEC's request, SANMINA-SCI will provide a report showing the amount of Components on hand, on order, or in the process of being ordered.

(4) ADAPTEC acknowledges that SANMINA-SCI will order Components in quantities sufficient to support ADAPTEC's Forecast. In determining the quantity of Components to order, SANMINA-SCI divides the Components into three classes, "Class A," "Class B" and "Class C." Class A Components are comprised of the approximately * of Components constituting approximately *. Class C Components are comprised of the approximately * of Components constituting approximately *. Class B Components are comprised of the remaining * Components constituting approximately *. SANMINA-SCI will place orders with its Vendors for approximately * Class "A" Components, * Class "B" Components and * of Class "C" Components. A summary of SANMINA-SCI's purchase commitments is set forth in the table below.

Part Class	*	*	*
A	*	*	*
B	*	*	*
C	*	*	*

(5) ADAPTEC acknowledges that SANMINA-SCI will be required to order Components in accordance with the various minimum buy quantities, tape and reel quantities, and multiples of packaging quantities required by the Vendor. In addition, ADAPTEC acknowledges that there is a lag time (not to exceed two weeks) between any ADAPTEC cancellation and the cancellation of the Components required to support production.

(6) ADAPTEC acknowledges that the Vendor leadtimes can be significant, and understands that it is possible for SANMINA-SCI to have Components on order which would support the last week of ADAPTEC's Forecast. For example, assuming a Vendor leadtime of * and a "B" Component, SANMINA-SCI would place an order for *.

(7) SANMINA-SCI has provided to ADAPTEC a list of all Components together with the current Vendor leadtime for such Components ("**Leadtime List**"). SANMINA-SCI shall use reasonable efforts to update the Leadtime List every quarter and present an updated Leadtime List to ADAPTEC at the time SANMINA-SCI presents the ADAPTEC with the E&O List described in the previous section. In the event SANMINA-SCI fails to present an updated Leadtime List, (i) the Parties shall continue to rely on the preceding Leadtime List (as updated in writing by the Parties) and (ii) ADAPTEC will accept responsibility for Components ordered outside the leadtimes set forth in the Leadtime List; provided, that SANMINA-SCI can demonstrate to ADAPTEC's reasonable satisfaction that such Components were ordered in accordance with the then-current Vendor leadtimes. ADAPTEC acknowledges that leadtimes constantly change and that SANMINA-SCI might not always be able to present ADAPTEC with a current Leadtime List.

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(b) Reschedules. ADAPTEC may reschedule all or part of a scheduled delivery at any time; provided, however, that (i) delivery for Channel Customer Orders must take place within the time period set forth in Section 5.3(a); and (ii) delivery for OEM Customer Orders must take place within sixty (60) days after the date on which the Product was manufactured (provided that it was manufactured in accordance with this Agreement).

(c) Upside Demand.

(i) Subject to the terms set forth herein and in Exhibit B, SANMINA-SCI will manufacture Products to meet any un-forecasted demand in accordance with this Section.

(ii) “**Critical Products**” shall mean Products which the parties have defined as such in writing. “**Non-Critical Products**” shall mean any Product other than Critical Products. “**Days**” shall mean calendar days from the date on when the upside request is received.

(iii) For Critical Products, SANMINA-SCI will commit to manufacture Products to meet any unforecasted demand up to the percentages specified below (the “**Upside Demand Percentage**”) beyond the quantities set forth in the applicable Forecast, subject to the limitations contained in this Section:

*	*
*	*
*	*
*	*

For Critical Products, SANMINA-SCI will maintain a one-week supply of finished Products, and ADAPTEC shall be financially responsible for all such Products.

(iv) For Non-Critical Products, SANMINA-SCI will commit to meet the following Upside Demand Percentages, subject to the limitations contained in this Section:

*	*
*	*
*	*
*	*

(v) The Upside Demand Percentages are not cumulative. For example, if ADAPTEC receives an additional * upside of a Critical Product in * days, ADAPTEC can only request an additional * upside in * days, and (if SANMINA-SCI meets the additional * upside in * days), an additional * upside in * days. Similarly, if ADAPTEC receives an additional * upside of a Non-Critical Product within * days, ADAPTEC can only request an additional * upside in * days, and (if SANMINA-SCI meets the additional * upside in * days), an additional * upside in * days

(vi) In addition, if in any given month, ADAPTEC does not take delivery of the requested Upside Demand Percentages, it loses the right to later take delivery of such Upside Demand Percentage for that month; ADAPTEC cannot pull more than * upside in any given * day period. For example, if for a Critical Product ADAPTEC requests the maximum upside (* within * days, an additional * within * days and an additional * within * days) and fails to take delivery of the initial * within the first * days, it cannot take delivery of more than * during the second * day period (even though SANMINA-SCI committed to a total of * within * days).

(vii) SANMINA-SCI will use commercially reasonable efforts to meet any upside in excess of the Upside Demand Percentages.

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(d) Excess and Obsolete Inventory. Within fourteen days prior to the end of each calendar quarter, commencing as of the 2nd calendar quarter following the Closing Date, SANMINA-SCI shall advise ADAPTEC in writing of any excess or obsolete Components in its inventory and their Delivered Cost (the “**E&O List**”). The E&O List should contain a comprehensive where-used analysis and rationale for the excess (MOQ, cancelled order or forecast, ECO, etc.). For the purpose of this Agreement, “**Delivered Cost**” shall mean SANMINA-SCI’s quoted cost of Components as stated on the *. Within ten (10) business days of receiving SANMINA-SCI’s E&O List, ADAPTEC shall advise SANMINA-SCI of any Component on the E&O List that it believes is not excess or obsolete. Within fifteen (15) business days after receiving SANMINA-SCI’s E&O List, SANMINA-SCI and ADAPTEC shall finalize the E&O List, and ADAPTEC shall issue to SANMINA-SCI an Order for all Components on the E&O List or an Order for Product that will consume the Components. ADAPTEC shall pay SANMINA-SCI its Delivered Cost for Components on the E&O List within forty-five (45) days of the date of invoice. In the event the Parties cannot agree as to the Components on the E&O List, ADAPTEC shall pay SANMINA-SCI for all non-disputed Components in accordance with this Section, and shall pay SANMINA-SCI for all other Components on SANMINA-SCI’s E&O List (in the event they remain excess or obsolete) forty-five (45) days thereafter (provided that this payment shall be due fifteen days after the date of invoice rather than forty-five days after the invoice date). For the purpose of this Section, the phrase “**obsolete Component**” shall mean any Component that is not currently used to manufacture a Product (whether as a result of an ECO or otherwise), and the term “**excess Component**” shall mean any Component that is not required to meet ADAPTEC’s Order or ADAPTEC’s Forecast to which such Component was initially ordered. ADAPTEC shall not have the right to delay payment for excess Components by increasing or pushing out its Forecast.

(e) Component Liability. ADAPTEC acknowledges that it shall be financially liable for all Components ordered in accordance with this Section 5 (such liability is referred to as “**Component Liability**”), and shall pay SANMINA-SCI for such charges in accordance with Section 5.4(d). Specifically, ADAPTEC’s Component Liability shall be equal to SANMINA-SCI’s Delivered Cost of all Components ordered in support of any Order or Forecast, including any excess Components resulting from any minimum buy quantities, tape and reel quantities, and multiples of packaging quantities required by the Vendor less the actual cost (per the BOM) of those Components that are returnable to Vendor (less any cancellation or restocking charges). Notwithstanding the foregoing, ADAPTEC shall not be financially liable for any Components that are ordered in quantities greater than those set forth in the “Periods of Supply” column in Section 5.4(a)(4) or for any Components ordered outside of the parameters set forth in Section 5.4(a)(7).

(f) At ADAPTEC’s request, SANMINA-SCI shall use commercially reasonable efforts to minimize ADAPTEC’s Component Liability by attempting to return Components to the Vendor or using the Components on other Products or on products that SANMINA-SCI manufactures for third parties.

6. DELIVERY AND ACCEPTANCE

6.1 Delivery. All Product shipments (including shipments made in accordance with Section 8 (Warranty)) shall be Ex Works (Incoterms 2000), SANMINA-SCI’s facility of manufacture (or repair). Title to and risk of loss or damage to the Product shall pass to ADAPTEC upon SANMINA-SCI’s tender of the Product to the common carrier. ADAPTEC shall be the exporter and importer of record for all shipments of Products, including any repaired or replacement Products. SANMINA-SCI is not the importer or exporter of the Products. SANMINA-SCI shall mark, pack, package, crate, transport, ship and store Products to ensure (a) delivery of the Product to its ultimate destination in safe condition, (b) compliance with all requirements of the carrier and destination authorities, and (c) compliance with any special instructions of ADAPTEC. SANMINA-SCI shall use reasonable efforts to deliver the Products on the agreed-upon delivery dates and shall use commercially reasonable efforts to notify ADAPTEC of any anticipated delays; provided, however that SANMINA-SCI shall not be liable for any failure to meet ADAPTEC delivery dates and/or any failure to give notice of anticipated delays. For clarification, ADAPTEC’s sole remedy for SANMINA-SCI’s failure to meet ADAPTEC’s delivery dates during the Exclusivity Period is to claim a Second Source Condition in accordance with Section 3.4.

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6.2 Acceptance. Acceptance of the Product shall occur no later than fifteen (15) days after shipment of Product and shall be based solely on whether the Product passes a mutually agreeable acceptance test procedure or inspection designed to demonstrate compliance with the Manufacturing Specifications. In the event of conflict between any of the foregoing, the following order of precedence shall apply: (i) Order as agreed to between ADAPTEC and SANMINA-SCI; (ii) 100% compliance with all Assembly/Test plan criteria or component drawing (as applicable); (iii) industry-recognized workmanship standard; and (iv) other applicable referenced documents. Products cannot be rejected based on criteria that were unknown to SANMINA-SCI or based on test procedures that SANMINA-SCI has not approved or does not conduct. Notwithstanding anything to the contrary, Products shall be deemed accepted if not rejected within this fifteen-day period. Once a Product is accepted, all Product returns shall be handled in accordance with Article 8 (Warranty). Prior to returning any rejected Product, ADAPTEC shall obtain an Authorized Return Material (“RMA”) number from SANMINA-SCI, and shall return such Product in accordance with SANMINA-SCI’s instructions; ADAPTEC shall specify the reason for such rejection in all RMA’s. In the event a Product is rejected, SANMINA-SCI shall have a reasonable opportunity to cure any defect which led to such rejection.

7. CHANGES

7.1 General. ADAPTEC may upon sufficient notice make changes within the general scope of this Agreement. Such changes may include, but are not limited to changes in (1) drawings, plans, designs, procedures, Specifications, test specifications or BOM, (2) methods of packaging and shipment, (3) quantities of Product to be furnished, (4) delivery schedule, or (5) ADAPTEC-Furnished Items (defined in Section 9.1). All changes other than changes in quantity of Products to be furnished shall be requested pursuant to an Engineering Change Notice (“ECN”) and finalized in an Engineering Change Order (“ECO”). If any such change causes either an increase or decrease in SANMINA-SCI’s cost or the time required for performance of any part of the work under this Agreement (whether changed or not changed by any ECO) the Prices and/or delivery schedules shall be adjusted in a manner which would adequately compensate the Parties for such change.

7.2 ECN’s. SANMINA-SCI will respond to * ECN requests * without a non-recurring administrative fee. Responses to additional ECN’s will incur an administrative fee of * each. Within five (5) business days after an ECN is received, SANMINA-SCI shall advise ADAPTEC in writing (a) of any change in Prices or delivery schedules resulting from the ECN and (b) the Delivered Cost of any finished Product, Work-in-Process or Component rendered excess or obsolete as a result of the ECN (collectively the “ECN Charge”). Unless otherwise stated, ECN Charges are valid from thirty (30) days from the date of the ECN Charge.

7.3 ECO’s. In the event ADAPTEC desires to proceed with the change after receiving the ECN Charge pursuant to Section 7.2, ADAPTEC shall advise SANMINA-SCI in writing and shall immediately pay the portion of the ECN Charge set forth in Section 7.2(b). In the event ADAPTEC does not desire to proceed with the Change after receiving the ECN Charge, it shall so notify SANMINA-SCI. In the event SANMINA-SCI does not receive written confirmation of ADAPTEC’s desire to proceed with the change within thirty (30) days after SANMINA-SCI provides ADAPTEC with the ECN Charge, the ECN shall be deemed cancelled.

8. WARRANTY

8.1 SANMINA-SCI Warranty. SANMINA-SCI warrants that, for a period of * months from the date of manufacture (the “Warranty Period”), the Products shall comply with the applicable Manufacturing Specifications and shall be free from defects in any Warranted In-sourced Component and workmanship. Products shall be considered free from defects in workmanship (and ADAPTEC shall have no warranty claim) if they are manufactured in accordance with the latest version of IPC-A-600 or IPC-A-610 and successfully complete any mutually agreed product acceptance test. SANMINA-SCI shall, at its option and at its expense (and as ADAPTEC’s sole and exclusive remedy for

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breach of any warranty), repair, replace or issue a credit for Products found defective during the warranty period. In addition, SANMINA-SCI will pass on to ADAPTEC all Vendors' (and manufacturers') Component warranties to the extent that they are transferable, but will not independently warrant any Components. All warranty obligations will cease upon the earlier of the expiration of the warranty period set forth above or the return (at ADAPTEC's request) of any test equipment or test fixtures. ALL CLAIMS FOR BREACH OF WARRANTY MUST BE RECEIVED BY SANMINA-SCI NO LATER THAN THIRTY (30) DAYS AFTER THE EXPIRATION OF THE WARRANTY PERIOD.

8.2 RMA Procedure. SANMINA-SCI shall concur in advance on all Products to be returned for repair or rework. ADAPTEC shall obtain a RMA number from SANMINA-SCI prior to return shipment. All returns shall state the specific reason for such return, and will be processed in accordance with SANMINA-SCI's RMA Procedure, a copy of which is available from SANMINA-SCI upon request. SANMINA-SCI shall pay all transportation costs for valid returns of the Products to SANMINA-SCI and for the shipment of the repaired or replacement Products to ADAPTEC, and shall bear all risk of loss or damage to such Products while in transit; ADAPTEC shall pay these charges, plus a handling charge, for invalid or "no defect found" returns. Any repaired or replaced Product shall be warranted as set forth in this Article for a period equal to the greater of (i) the balance of the applicable warranty period relating to such Product or (ii) sixty (60) days after it is received by ADAPTEC. Out of Warranty repairs will be covered under a separate reverse logistics agreement to be negotiated in good faith by the Parties and entered into within one hundred twenty (120) days of the Closing Date. The prices for any out-of warranty services that SANMINA-SCI provides prior to the Parties' execution of such reverse logistics agreement will be as specified in Exhibit B.

8.3 Exclusions From Warranty. The warranties set forth in Section 8.1 do not apply to the extent a failure of a Product to conform to such warranties results from: (a) ADAPTEC's design including, but not limited to, design functionality failures, specification inadequacies, failures relating to the functioning of Products in the manner for the intended purpose or in the specific ADAPTEC environment; (b) accident, disaster, neglect, abuse, misuse, improper handling, testing, storage or installation including improper handling in accordance with static sensitive electronic device handling requirements by ADAPTEC; (c) alterations, modifications or repairs by ADAPTEC or third parties not authorized by SANMINA-SCI; or (d) defective ADAPTEC-provided test equipment or test software. In the event SANMINA-SCI believes that a Product is not covered by the warranty, it shall advise ADAPTEC of the specific reasons therefore and, where possible, supply ADAPTEC with any failure analysis and/or root cause evaluation which supports its position. ADAPTEC bears all design responsibility for Products.

8.4 Remedy. THE SOLE REMEDY UNDER THIS WARRANTY SHALL BE THE REPAIR, REPLACEMENT OR CREDIT FOR DEFECTIVE PARTS AS STATED ABOVE. THIS WARRANTY IS THE SOLE WARRANTY GIVEN BY SANMINA-SCI AND IS IN LIEU OF ANY OTHER WARRANTIES EITHER EXPRESS OR IMPLIED. SANMINA-SCI DOES NOT MAKE ANY WARRANTIES REGARDING MERCHANTABILITY, NONINFRINGEMENT, COMPLIANCE WITH ROHS AND WEEE (OR SIMILAR LEGISLATION), OR FITNESS FOR A PARTICULAR PURPOSE, AND SPECIFICALLY DISCLAIMS ANY SUCH WARRANTY, EXPRESS OR IMPLIED.

8.5 Epidemic Failure. For the purposes of this Agreement, "**Epidemic Failure**" will be deemed to have occurred if more than * of any Products manufactured by SANMINA-SCI hereunder fail during the Warranty Period or sixty days thereafter in a manner attributable to the same "root cause" within any time period of ninety (90) days or if more than * of any Products manufactured by SANMINA-SCI hereunder fail in a manner attributable to the same "root cause" within any time period of thirty (30) days. In such event, without limiting SANMINA-SCI's obligations and ADAPTEC's remedies under Section 8.4, (i) SANMINA-SCI shall promptly deliver to ADAPTEC a reasonable plan to correct the problem, (ii) SANMINA-SCI shall exert its best reasonable efforts to diagnose the problem; and (iii) SANMINA-SCI shall reimburse ADAPTEC for any costs or expenses reasonably incurred by ADAPTEC to repair, replace or retrofit the defective Products including but not limited to the cost of recovery and replacement (or transportation) of such defective Products already sold to and used by customers, up to an amount not exceeding *. Upon the acceptance of any such plan by ADAPTEC, SANMINA-SCI shall implement the plan and deliver to ADAPTEC progress reports relating thereto.

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9. ADAPTEC FURNISHED EQUIPMENT AND COMPONENTS WARRANTY

9.1 ADAPTEC-Furnished Items. ADAPTEC shall provide SANMINA-SCI with the Product design and related specifications, applicable regulatory requirements, equipment, tooling, test software, Components or documentation set forth in Exhibit C (collectively the “**ADAPTEC-Furnished Items**”). ADAPTEC hereby represents and warrants that the ADAPTEC-Furnished Items are or will: (a) comply with any applicable technical specifications or documentation; (b) meet all applicable regulatory requirements, and (c) will be delivered to SANMINA-SCI in a timely manner. Documentation (including BOM’s, drawings and artwork) shall be current and complete. ADAPTEC shall be responsible for schedule delay, reasonable inventory carrying charges and allocated equipment down-time charges incurred by SANMINA-SCI to the extent caused by such incompleteness, late delivery or non-delivery of the ADAPTEC-Furnished Items; provided that SANMINA-SCI is not able to compensate for such incompleteness, late delivery or non-delivery through the exercise of reasonable efforts.

9.2 Care of ADAPTEC-Furnished Items. All ADAPTEC-Furnished Items shall remain the property of ADAPTEC. SANMINA-SCI shall clearly identify all ADAPTEC-Furnished Items by an appropriate tag and shall utilize such ADAPTEC-Furnished Items solely in connection with the manufacture of the Products. To the extent that any ADAPTEC-Furnished Items consist of software (“**ADAPTEC-Furnished Software**”), SANMINA-SCI is deemed to have a non-exclusive, non-transferable, limited license during the term of this Agreement, without the right to sublicense, to use the ADAPTEC-Furnished Software solely in connection with the manufacture of Products. To the extent any ADAPTEC-Furnished Software is provided in binary form, SANMINA-SCI agrees not to disassemble, decompile or reverse engineer the ADAPTEC-Furnished Software (or authorize any third party to do any of the foregoing), except and solely to the extent, if any, that applicable local law requires that such activities be permitted. SANMINA-SCI shall not make or allow modifications to be made to the ADAPTEC-Furnished Items without ADAPTEC’s prior written consent. SANMINA-SCI shall be responsible for reasonable diligence and care in the use and protection of any ADAPTEC-Furnished Items and routine maintenance of any ADAPTEC-Furnished Items that consists of equipment, but shall not be responsible for repairs or replacements (including servicing and calibration to the equipment) unless such failure was caused by SANMINA-SCI’s negligence or willful misconduct. SANMINA-SCI’s production and warranty obligations which require the utilization of the returned ADAPTEC-Furnished Items will cease upon SANMINA-SCI’s fulfillment of ADAPTEC’s request. Nothing contained herein shall be deemed to limit any rights to any ADAPTEC-Furnished Software that SANMINA-SCI has obtained as a result of any other Agreement between the Parties

9.3. ADAPTEC-Furnished Components. ADAPTEC-Furnished Components shall be handled in accordance with SANMINA-SCI’s procedures regarding ADAPTEC-Furnished Material, incorporated by reference herein, copies of which are available upon request.

10. INDEMNIFICATION AND LIMITATION OF LIABILITY

10.1 SANMINA-SCI’s Indemnification. SANMINA-SCI shall indemnify, defend, and hold ADAPTEC and ADAPTEC’s affiliates, shareholders, directors, officers, employees, contractors, agents and other representatives (the “**ADAPTEC-Indemnified Parties**”) harmless from all third party demands, claims, actions, causes of action, proceedings, suits, assessments, losses, damages, liabilities, settlements, judgments, fines, penalties, interest, costs and expenses (including fees and disbursements of counsel) of every kind (each a “**Claim**,” and, collectively “**Claims**”): (i) based upon personal injury or death or injury to property (other than damage to the Product itself, which is handled in accordance with Article 8/Warranty) to the extent any of the foregoing is proximately caused either by the negligent or willful acts or omissions of SANMINA-SCI or its officers, employees, subcontractors or agents and/or (ii) arising from or relating to any actual or alleged infringement or misappropriation of any patent, trademark, mask work, copyright, trade secret or any actual or alleged violation of any other intellectual property rights arising from or in connection with SANMINA-SCI’s manufacturing processes, which, as to all Products, shall include any Warranted In-Sourced Components for which SANMINA-SCI has designed for ADAPTEC.

10.2 ADAPTEC's Indemnification. ADAPTEC shall indemnify, defend, and hold SANMINA-SCI and SANMINA-SCI's affiliates, shareholders, directors, officers, employees, contractors, agents and other representatives (the "**SANMINA-SCI-Indemnified Parties**") harmless from all third party Claims (i) based upon personal injury or death or injury to property to the extent any of the foregoing is proximately caused either by a defective Product, except to the extent that a Product is defective as a result of SANMINA-SCI's manufacture thereof, which as to all Products, shall include any Warranted In-Sourced Components that SANMINA-SCI has designed for ADAPTEC (ii) by the negligent or willful acts or omissions of ADAPTEC or its officers, employees, subcontractors or agents and/or (iii) arising from or relating to any actual or alleged infringement or misappropriation of any patent, trademark, mask work, copyright, trade secret or any actual or alleged violation of any other intellectual property rights arising from or in connection with the Products, except for Claims of infringement, misappropriation or violation for which SANMINA-SCI is responsible under Section 10.2 above.

10.3 Procedure. A Party entitled to indemnification pursuant to this Section 10 (the "**Indemnitee**") shall promptly notify the other Party (the "**Indemnitor**") in writing of any Claims covered by this indemnity. Promptly after receipt of such notice, the Indemnitor shall assume the defense of such Claim with counsel reasonably satisfactory to the Indemnitee. If the Indemnitor fails, within a reasonable time after receipt of such notice, to assume the defense with counsel reasonably satisfactory to the Indemnitee or, if in the reasonable judgment of the Indemnitee, a direct or indirect conflict of interest exists between the Parties with respect to the Claim, the Indemnitee shall have the right to undertake the defense, compromise and settlement of such Claim for the account and at the expense of the Indemnitor. Notwithstanding the foregoing, if the Indemnitee in its sole judgment so elects, the Indemnitee may also participate in the defense of such action by employing counsel at its expense, without waiving the Indemnitor's obligation to indemnify and defend. The Indemnitor shall not compromise any Claim (or portions thereof) or consent to the entry of any judgment without an unconditional release of all liability of the Indemnitee as to each claimant or plaintiff.

10.4 Limitation of Liability. IN NO EVENT SHALL EITHER PARTY BE LIABLE TO THE OTHER FOR ANY INDIRECT, CONSEQUENTIAL, INCIDENTAL, PUNITIVE OR SPECIAL DAMAGES, OR ANY DAMAGES WHATSOEVER RESULTING FROM LOSS OF USE, DATA OR PROFITS, EVEN IF SUCH OTHER PARTY HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. The foregoing shall not limit a Party's liability for a breach of its obligations under Section 14.2. IN ADDITION, IN NO EVENT SHALL SANMINA-SCI'S LIABILITY FOR ALL CLAIMS ARISING OUT OF THIS AGREEMENT EXCEED *. THESE LIMITATIONS SHALL APPLY NOTWITHSTANDING ANY FAILURE OF ESSENTIAL PURPOSE OF ANY LIMITED REMEDY. Notwithstanding the foregoing, the foregoing cap on liability shall not apply to limit: (i) a Party's obligation to indemnify the other Party against any third party Claim for personal injury or property damage, (ii) a Party's liability for actual damages required to be paid to any third party as a result of any infringement claim; or (iii) a Party's liability for a breach of Section 14.2. Nothing herein shall limit ADAPTEC's liability under Section 11.5.

11. TERMINATION

11.1 Termination for Cause. Either Party may terminate this Agreement or an Order hereunder for default if the other Party materially breaches this Agreement; provided, however, no termination right shall accrue until thirty (30) days after the defaulting Party is notified in writing of the material breach; provided, that as to any alleged material breach by ADAPTEC of its payment obligations under Section 4.5 such termination right shall accrue after five (5) days, and has failed to cure or give adequate assurances of performance within the thirty (30) day period or five (5) day period, as applicable, after notice of material breach.

11.2 Termination for Convenience. Subject to Section 3.1, ADAPTEC may terminate this Agreement hereunder for any reason upon thirty (30) days' prior written notice and may terminate any Order hereunder for any reason upon ninety (90) days' (before scheduled shipment) prior written notice. For clarification, ADAPTEC may terminate this Agreement for convenience as to the Products other than the Exclusive Products in accordance with the preceding sentence. ADAPTEC may not terminate this Agreement for convenience as to the Exclusive Products until after the end of the Exclusivity Period.

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SANMINA-SCI may terminate this Agreement, in whole or in part, for any reason upon one hundred eighty (180) days' notice.

11.3 Termination for Financial Condition. Either Party may terminate this Agreement upon notice to the other Party if the other Party (a) enters into or file a petition, arraignment or proceeding seeking an order for relief under the bankruptcy laws of its respective jurisdiction; (b) enters into a receivership of any of its assets or (c) enters into a dissolution or liquidation of its assets or an assignment for the benefit of its creditors.

11.4 Termination for Force Majeure Event. If, as a result of a Force Majeure Event (defined in Section 13.1), a Party's is unable to perform for a cumulative period of ninety (90) days, then the other Party, at its option may terminate this Agreement upon five (5) days notice to the other Party.

11.5 Consequences of Termination.

(a) Termination by SANMINA-SCI for Cause. In the event that SANMINA-SCI terminates this Agreement or an Order pursuant to Section 11.1 (Termination of Cause), ADAPTEC shall pay SANMINA-SCI termination charges equal to: (1) the contract price for all finished Product existing at the time of termination; and (2) ADAPTEC's Component Liability pursuant to Section 5.4(e).

(b) Termination for Convenience; Termination for Financial Condition; Termination for ADAPTEC Force Majeure Event. In the event that either Party terminates this Agreement pursuant to Section 11.2 (Termination for Convenience) or Section 11.3 (Termination for Financial Condition) or SANMINA-SCI terminates this Agreement pursuant to Section 11.4 (Termination for Force Majeure Event), ADAPTEC shall pay SANMINA-SCI termination charges equal to (1) the contract price for all finished Product existing at the time of termination; and (2) ADAPTEC's Component Liability pursuant to Section 5.4(e).

(c) Termination by ADAPTEC for Cause; Termination for SANMINA-SCI Force Majeure Event. In the event ADAPTEC terminates this Agreement or any Order pursuant to Section 11.1 (Termination for Cause) or ADAPTEC terminates this Agreement pursuant to Section 11.4 (Termination for Force Majeure Event), ADAPTEC shall pay SANMINA-SCI termination charges equal to (1) the contract price for all finished Product existing at the time of termination; and (2) ADAPTEC's Component Liability pursuant to Section 5.4(e); provided, however, that, for the purposes of this subsection only, ADAPTEC's Component Liability shall be calculated based on the quoted cost of Components as stated on the BOM rather than the Delivered Cost (i.e., exclusive of any margin).

(d) Work In Process. In the event of termination for any reason, SANMINA-SCI shall finish all work in process such that the product can be shipped as a finished Product. In the event ADAPTEC requests that SANMINA-SCI not complete any work in process, the termination charges shall include the value of the work in process (e.g., SANMINA-SCI's cost of the work-in-progress (including labor and Components, and a * margin on Components).

11.6 Survival. In addition to the Parties' obligations to pay any unpaid but accrued amounts due and payable prior to the effective date of termination or expiration, the rights and obligations of the Parties under Sections 5.4(d), 5.4(e), 8, 10, 11.5, 11.6, 14 and 16 will survive any termination or expiration of this Agreement.

12. QUALITY

12.1 Specifications. Product shall be manufactured by SANMINA-SCI in accordance with the Specifications, as modified via written ECO's in accordance with this Agreement. Neither Party shall make any change to the Specifications, to any Components described therein, or to the Products (including, without limitation, changes in form, fit, function, design, appearance or place of manufacture of the Products or changes which would affect the reliability of any of the Products) unless such change is made in accordance with Section 7.1. Notwithstanding the foregoing, SANMINA-SCI shall be permitted to make

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changes in its manufacturing process at any time, so long as such changes do not affect the form, fit or function of the Products. SANMINA-SCI will inform ADAPTEC of changes to its manufacturing process by means of a PCN (product change notice).

12.2 Content of Specifications. The Specifications shall include (as applicable), but shall not be limited to (i) detailed electrical, mechanical, performance and appearance specifications for each model of Product, (ii) the BOM; (iii) tooling specifications, along with a detailed description of the operation thereof, (iv) art work drawings, (v) Component specifications, and (vi) Vendor cross references.

12.3 Components. SANMINA-SCI shall use in its production of Products such Components of a type, quality, and grade specified by ADAPTEC to the extent ADAPTEC chooses to so specify, and shall purchase Components only from Vendors appearing on ADAPTEC's approved vendor list ("AVL"); provided, however, that in the event SANMINA-SCI cannot purchase a Component from a Vendor on ADAPTEC's AVL for any reason, SANMINA-SCI shall be able to purchase such Component from an alternate Vendor, subject to ADAPTEC's prior written approval, which approval shall not be unreasonably withheld or delayed. SANMINA-SCI shall use commercially reasonable efforts to manage all Vendors, but shall not be responsible for any Component (including the failure of any Component to comply with the Specifications).

12.4 SANMINA-SCI In-Sourced Components. Notwithstanding the provisions of Section 12.3 or anything in this Agreement to the contrary, subject to the provisions of this Section 12.4, SANMINA-SCI will have the right to in-source one hundred percent (100%) of Components, including without limitation, PCBs, Backplane Assemblies, PCBAs, Enclosures, Cables, Memory Modules, and Optical Modules, if SANMINA-SCI has the capability to do so. SANMINA-SCI will provide ADAPTEC with such information as ADAPTEC may reasonably request to enable ADAPTEC to confirm that SANMINA-SCI has the required quality and technology to in-source such Components, as described herein. In addition, and without limiting the generality of the foregoing, ADAPTEC reserves the right to require qualification and test data of any Components that SANMINA-SCI desires to in-source. Subject to the foregoing, SANMINA-SCI will inform ADAPTEC if it commences manufacturing of any Products using Components in-sourced by SANMINA-SCI in accordance with the terms hereof. Any Component in-sourced by SANMINA-SCI pursuant to the terms hereof is referred to as a "**SANMINA In-Sourced Component**".

12.5 Quality Specifications. SANMINA-SCI shall comply with the quality specifications set forth in the ADAPTEC Quality Plan provided to SANMINA-SCI on December 20, 2005.

12.6 Inspection of Facility. Upon reasonable advance written notice and, upon SANMINA-SCI's request the execution of an appropriate nondisclosure agreement, ADAPTEC may inspect the Products and Components held by SANMINA-SCI for ADAPTEC at SANMINA-SCI's facilities during SANMINA-SCI's regular business hours, provided that such inspection does not unduly affect SANMINA-SCI'S operations. ADAPTEC and its representatives shall observe all security and handling measures of SANMINA-SCI while on SANMINA-SCI's premises. ADAPTEC and its representatives acknowledge that their presence on SANMINA-SCI's property is at their sole risk. If SANMINA-SCI desires to manufacture Products for ADAPTEC at a facility not previously inspected and qualified by ADAPTEC, SAMINA-SCI will provide ADAPTEC with a reasonable opportunity to inspect such facility and to undertake any processes deemed reasonably necessary by ADAPTEC to qualify the facility, including the equipment and the personnel that will be used for the manufacture of Products.

13. **FORCE MAJEURE**

13.1 Force Majeure Event. For purposes of this Agreement, a "**Force Majeure Event**" shall mean the occurrence of unforeseen circumstances beyond a Party's control and without such Party's negligence or intentional misconduct, including, but not limited to, any act by any governmental authority, act of war, natural disaster, strikes, lockouts or labor disputes by or with any non-SANMINA-SCI employees, boycott, embargo, riot or civil commotion.

13.2 Notice of Force Majeure Event. Neither Party shall be responsible for any failure to perform due to a Force Majeure Event; provided that such Party gives notice to the other Party of the Force Majeure Event as soon as reasonably practicable, but not later than five (5) days after the date on which such Party knew or should reasonably have known of the commencement of the Force Majeure Event, specifying the nature and particulars thereof and the expected duration thereof; provided, however, that the failure of a Party to give notice of a Force Majeure Event shall not prevent such Party from relying on this Section except to the extent that the other Party has been prejudiced thereby.

13.3 Termination of Force Majeure Event. The Party claiming a Force Majeure Event shall use reasonable efforts to mitigate the effect of any such Force Majeure Event and to cooperate to develop and implement a plan of remedial and reasonable alternative measure to remove the Force Majeure Event. Upon the cessation of the Force Majeure Event, the Party affected thereby shall immediately notify the other Party of such fact, and use its best efforts to resume normal performance of its obligations under the Agreement as soon as possible. Nothing herein shall require a Party to settle any labor strikes.

13.4 Limitations. Notwithstanding that a Force Majeure Event otherwise exists, the provisions of this Article shall not excuse (i) any obligation of either Party, including the obligation to pay money in a timely manner for Product actually delivered or other liabilities actually incurred, that arose before the occurrence of the Force Majeure Event causing the suspension of performance; or (ii) any late delivery of Product, equipment, materials, supplies, tools, or other items to the extent caused by negligent acts or omissions on the part of such Party.

14. CONFIDENTIALITY AND NON-SOLICITATION OF EMPLOYEES

14.1 Definitions. For the purpose of this Agreement,

(a) **“Confidential Information”** means information (in any form or media) regarding a Party’s customers, prospective customers (including lists of customers and prospective customers), methods of operation, engineering methods and processes (include any information which may be obtained by a Party by reverse engineering, decompiling or examining any software or hardware provided by the other Party under this Agreement), programs and databases, patents and designs, billing rates, billing procedures, vendors and suppliers, business methods, finances, management, or any other business information relating to such Party (whether constituting a trade secret or proprietary or otherwise) which has value to such Party and is treated by such Party as being confidential; provided, however, that Confidential Information does not include information that (i) is rightfully known to the other Party prior to receipt from the Disclosing Party hereunder, which knowledge shall be evidenced by written records, (ii) is independently developed by the Receiving Party, as evidenced by written records, without access to any of the Disclosing Party’s Confidential Information; (iii) is or becomes in the public domain through no breach of this Agreement, or (iv) is received from a third party without breach of any obligation of confidentiality; and provided further, that Confidential Information does not include any information provided by ADAPTEC to SANMINA-SCI regarding the manufacturing process.

(b) **“Person”** shall mean and include any individual, partnership, association, corporation, trust, unincorporated organization, limited liability company or any other business entity or enterprise.

(c) **“Representative”** shall mean a Party’s employees, agents, or representatives, including, without limitation, financial advisors, lawyers, accountants, experts, and consultants.

14.2 Nondisclosure Covenants.

(a) In connection with this Agreement, each Party (the **“Disclosing Party”**) may furnish to the other Party (the **“Receiving Party”**) or its Representatives certain Confidential Information. For a period of three (3) years from the date of the last disclosure under this Agreement, the Receiving Party: (a) shall maintain as confidential all Confidential Information disclosed to it by the Disclosing Party, (b) shall

not, directly or indirectly, disclose any such Confidential Information to any Person other than (i) those Representatives of the Receiving Party whose duties justify the need to know such Confidential Information and then only after each Representative has agreed to be bound by this Confidentiality Agreement and clearly understands his or her obligation to protect the confidentiality of such Confidential Information and to restrict the use of such Confidential Information or (ii) if SANMINA-SCI is the Receiving Party, a third party Vendor for the purpose of obtaining price quotations and (c) shall treat such Confidential Information with the same degree of care as it treats its own Confidential Information (but in no case with less than a reasonable degree of care).

(b) The disclosure of any Confidential Information is solely for the purpose of enabling each Party to perform under this Agreement, and the Receiving Party shall not use any Confidential Information disclosed by the Disclosing Party for any other purpose.

(c) Except as otherwise set forth in this Agreement, all Confidential Information supplied by the Disclosing Party shall remain the property of the Disclosing Party, and will be promptly returned by the Receiving Party upon receipt of written request therefor.

(d) If the Receiving Party or its Representative is requested or becomes legally compelled to disclose any of the Confidential Information, it will provide the Disclosing Party with prompt written notice. If a protective order or other remedy is not obtained, then only that part of the Confidential Information that is legally required to be furnished will be furnished, and reasonable efforts will be made to obtain reliable assurances of confidentiality.

14.3 Injunctive Relief Authorized. Any material breach of this Article by a Party or its Representatives may cause irreparable injury and the non-breaching Party may be entitled to equitable relief, including injunctive relief and specific performance, in the event of a breach. The above will not be construed to limit the remedies available to a Party. In addition, the prevailing Party will be entitled to be reimbursed for all of its reasonable attorneys' fees and expenses at all levels of proceedings and for investigations, from the non-prevailing Party.

14.4 No Publicity. Each Party agrees not to issue any press release or make any public announcement relating to the subject matter of this Agreement without the prior consent of the other Party, except as a Party believes in good faith is required by applicable law or any listing or trading agreement concerning its publicly-traded securities (in which case, the Party seeking to disclose the information shall give reasonable notice to the other Party of its intent to make such a disclosure).

15. INSURANCE

SANMINA-SCI agrees to maintain during the term of this Agreement a) workers' compensation insurance as prescribed by the law of the state in which SANMINA-SCI's services are performed; (b) employer's liability insurance with limits of at least \$500,000 per occurrence; (c) commercial automobile liability insurance if the use of motor vehicles is required, with limits of at least \$1,000,000 for bodily injury and property damage for each occurrence; (d) commercial general liability insurance, including blanket contractual liability and broad form property damage, with limits of at least \$1,000,000 combined single limit for personal injury and property damage for each occurrence; and (e) commercial general liability insurance endorsed to include products liability and completed operations coverage in the amount of \$1,000,000 for each occurrence. SANMINA-SCI shall furnish to ADAPTEC certificates or evidence of the foregoing insurance indicating the amount and nature of such coverage and the expiration date of each policy. Each Party agrees that it, its insurer(s) and anyone claiming by, through, under or in its behalf shall have no claim, right of action or right of subrogation against the other Party and the other Party's affiliates, directors, officers, employees and customers based on any loss or liability insured against under the insurance required by this Agreement.

16. MISCELLANEOUS

16.1 Integration Clause. This Agreement (including the Exhibits and Schedules to this Agreement), together with the Asset Purchase Agreement and the Ancillary Agreements, constitutes the entire agreement between the Parties with respect to the subject matter hereof and supersedes any prior understandings, agreements, warranties or representations by or between the Parties, written or oral, to the extent they related in any way to the subject matter hereof. This Agreement may be amended by the Parties hereto at any time by execution of an instrument in writing signed on behalf of each of the Parties hereto.

16.2 Order of Precedence. All quotations, Orders, acknowledgments and invoices issued pursuant to this Agreement are issued for convenience of the Parties only and shall be subject to the provisions of this Agreement and the Exhibits hereto. When interpreting this Agreement, precedence shall be given to the respective parts in the following descending order: (a) this Agreement; (b) Schedules and Exhibits to this Agreement; and (c) if Orders are used to release product, those portions of the Order that are not pre-printed and which are accepted by SANMINA-SCI. The Parties acknowledge that (y) the preprinted provisions on the reverse side of any such quotation, Order, acknowledgment or invoice and (z) all terms other than the specific terms set forth in Section 5.3(a) shall be deemed deleted and of no effect whatsoever.

16.3 Waiver. The rights and remedies of the Parties to this Agreement are cumulative and not alternative. Neither the failure nor any delay by any Party in exercising any right, power or privilege under this Agreement or the documents referred to in this Agreement will operate as a waiver of such right, power or privilege, and no single or partial exercise of such right, power, or privilege will preclude any other or further exercise of such right, power, or privilege or the exercise of any other right, power, or privilege. To the maximum extent permitted by applicable law, (i) no claim or right arising out of this Agreement or the documents referred to in this Agreement can be discharged by one Party, in whole or in part, by a waiver or renunciation of the claim or right unless in writing signed by the other Party; (ii) no waiver that may be given by a Party will be applicable except in the specific instance for which it is given; and (iii) no notice to or demand on one Party will be deemed to be a waiver of any obligation of such Party or of the right of the Party giving such notice or demand to take further action without notice or demand as provided in this Agreement or the documents referred to in this Agreement.

16.4 Assignment. This Agreement shall be binding upon and inure to the benefit of the Parties named herein (including their Affiliates) and their respective successors and permitted assigns. Neither Party may assign or transfer this Agreement or any of its rights, interests, or obligations hereunder without the prior written approval of the other Party. Notwithstanding the foregoing, (i) either Party may assign or transfer this Agreement or any of its rights, interests, or obligations hereunder to an Affiliate, without the consent of the other Party; and (ii) ADAPTEC may assign or transfer this Agreement or any of its rights, interests, or obligations hereunder, to a third party that succeeds to all or substantially all of its assets or related business (whether by sale, merger, operation of law or otherwise), without the consent of SANMINA-SCI.

16.5 Independent Contractors. In the exercise of their respective rights, and the performance of their respective obligations under this Agreement, the Parties are, and will remain, independent contractors. Nothing in this Agreement will be construed (i) to constitute the Parties as principal and agent, partners, joint venturers, or otherwise as participants in a joint undertaking; or (ii) to authorize a Party to enter into any contract or other binding obligation on the part of the other Party. No Party will represent to any other person, firm, corporation or other entity that it is authorized to enter into any contract or other binding obligation on behalf of the other Party.

16.6 Notices. All notices and other communications required or permitted hereunder shall be in writing, shall be effective when given, and shall in any event be deemed to be given upon receipt or, if earlier, (a) upon delivery, if delivered by hand, (b) three business days after the business day of deposit with Federal Express or similar overnight courier, freight prepaid or (c) one business day after the business day of facsimile transmission, if delivered by facsimile transmission with copy by Federal Express or similar overnight courier, freight prepaid, and shall be addressed to the intended recipient as set forth below:

If to SANMINA-SCI:

Sanmina-SCI Corporation
2700 North First Street
San Jose, CA 95134
Attention: Robin Walker, Senior Vice President, Corporate Development
Steven Jackman, Vice President and Corporate Counsel
Telephone No.: (408) 964-3500
Facsimile No.: (408) 964-3636

Copy to:

Wilson Sonsini Goodrich & Rosati, Professional Corporation
650 Page Mill Road
Palo Alto, California 94304
Attention: Christopher D. Mitchell, Esq.
Facsimile: (650) 493-6811

If to ADAPTEC:

ADAPTEC, INC.
691 S. Milpitas Blvd.
Milpitas, California 95035
Attention: Chief Financial Officer

Copy to:

ADAPTEC, INC.
691 S. Milpitas Blvd.
Milpitas, California 95035
Attention: Chief Financial Officer

Either Party may change the address to which notices, requests, demands, claims, and other communications hereunder are to be delivered by giving the other Party ten (10) days' advance written notice to the other Party pursuant to the provisions above.

16.7 Severability. Any term or provision of this Agreement that is invalid or unenforceable in any situation in any jurisdiction shall not affect the validity or enforceability of the remaining terms and provisions hereof or the validity or enforceability of the offending term or provision in any other situation or in any other jurisdiction.

16.8 Construction. The Parties have participated jointly in the negotiation and drafting of this Agreement. In the event an ambiguity or question of intent or interpretation arises, this Agreement shall be construed as if drafted jointly by the Parties and no presumption or burden of proof shall arise favoring or disfavoring any Party by virtue of the authorship of any of the provisions of this Agreement. Any reference to any federal, state, local, or foreign statute or law shall be deemed also to refer to all rules and regulations promulgated thereunder, unless the context requires otherwise. The word "including" shall mean including without limitation. Unless the context requires otherwise, all words used in this Agreement in the singular number shall extend to and include the plural, all words in the plural number shall extend to and include the singular, and all words in any gender shall extend to and include all genders.

16.9 Headings. The section headings contained in this Agreement are inserted for convenience only and shall not affect in any way the meaning or interpretation of this Agreement.

16.10 Counterparts. This Agreement may be executed in counterparts, each of which shall be deemed an original but all of which together will constitute one and the same instrument.

16.11 Disputes/Choice of Law/Attorneys Fees. The Parties shall attempt to resolve any disputes between them arising out of this Agreement through good faith negotiations. In the event the Parties cannot resolve a dispute, the Parties acknowledge and agree that the competent court in Santa Clara, California (the “**Competent Court**”) (and not any other court in any state or country) shall have exclusive jurisdiction in connection with this Agreement. Each Party hereby irrevocably submits to the exclusive jurisdiction of the Competent Court in any action or proceeding arising out of or relating to this Agreement and irrevocably waives any objection such person may now or hereafter have as to the venue of any such suit, action or proceeding brought in the Competent Court or that the Competent Court is an inconvenient forum. This Agreement shall be governed in all respects solely by the substantive laws of the State of California, without regard to conflicts of laws or the choice of law principles of any jurisdiction including the State of California, and without the need of any Party to establish the reasonableness of the relationship between the laws of the State of California and the subject matter of this Agreement, and all questions concerning the validity and construction hereof shall be determined in accordance with the laws of the State of California. If any legal proceeding or other action relating to this Agreement is brought or otherwise initiated, the prevailing Party shall be entitled to recover reasonable attorneys fees, costs and disbursements (in addition to any other relief to which the prevailing Party may be entitled).

IN WITNESS WHEREOF, the Parties hereto have caused this Agreement to be executed effective as of the Closing Date, by their officers, duly authorized.

SANMINA-SCI CORPORATION

ADAPTEC, INC.

By: /s/ Charles C. Mason Jr.
Signature

By: /s/ Marshall Mohr
Signature

Charles C. Mason Jr.
Typed Name

Marshall Mohr
Typed Name

Vice President, Business Development
Title

VP & CFO
Title

Date

December 23, 2005
Date

Signature Page to Manufacturing Services and Supply Agreement

EXHIBITS

- A SINGAPORE PRODUCTS
- B PRICING FOR FORECASTED SINGAPORE PRODUCTS
- C ADAPTEC FURNISHED EQUIPMENT/CONSIGNMENT COMPONENTS

**EXHIBIT A
SINGAPORE PRODUCTS**

Mat Class	Material #	Description	System Products
FINB	2123200	ASR-2020ZCR/128MB/FSC BULK	
FINB	2176400	ASR-2200S/128MB/LGC BULK	
FINB	2074500GE	ICP GDT8523RZ/GE KIT	
FINB	1820300	AHA-2940U2W/SIEMENS-2 BAG BULK	
FINB	1873800EU	(OBS)3200S/EU KIT(TA-1422-OTC)	
FINB	1913800	ASR-3210S/64MB BULK	
FINB	1851300	AHA-2940UW/NEC BULK	
FINB	1902600	DM4050-64 IPP KT TA-1142-CPQ	
FINB	2077800	ICP 8958 INT LVDS/SE TERM	
FINB	1901900	PM3755U2B-B-3U2-64MTA-1364-SUN	
FINB	1662100	(OBS)AHA-2940UW RTL(97)	
FINB	1911100	PM3755U2B-B-2U2-32MTA-1383-BUL	
FINB	1858400	ASC-29160LP BAG BULK	
FINB	1755700	(OBS)AHA-3950U2B BAG BULK	
FINB	1911700	PM3755U2B-B-3U2-64MTA-1375-CPQ	
FINB	2005200JA	ASC-39320D-R/JA KIT	
FINB	1902900	FRU FOR PM3755U2B TA-1180-SUN	
FINB	1999700	ASC-39320D 10PK	
FINB	2075100	ICP GDT8623RZ KIT	
FINB	1851700	AAC-364/DELL2 W/O HDL BAG BULK	
FINB	939200	(OBS)AHA-2744W KIT	
FINB	1883400	ASR-2100S SGL (TA-1432-OTC)	
FINB	2031600	ASR-2200S/64MB/HITACHI BULK	
FINB	1964200	AHA-2940UW/FSC BULK	
FINB	1828200	(OBS)ASC-19160 BULK	
FINB	1822300JA	ASC-39160/JA KIT	
FINB	1728700JA	AHA-2944UW/FUJITSU SGL	
FINB	1917400JA	ASR-3410S/JA KIT	
FINB	1803600CN	(OBS)AHA-2940UW/CN KIT	
FINB	1706600	AHA-2944UW/SNI BAG BULK	
FINB	1736700	(OBS)AHA-3950U2 KIT	
FINB	1903000	FRU FOR BB4050 BK TA-1136-SUN	
FINB	2076300	ICP 8799 FIRMWARE UPGRADE	
FINB	1721400	AHA-2940U2W/DELL BAG BULK	
FINB	949500	(OBS)AHA-2940/IBM-1	
FINB	2122700	ABM-400 KIT	
FINB	1605100	AHA-2940 ULT 10-PK	
FINB	1844700	(OBS) AAC-3642/128MB/HP BULK	
FINB	2197200	ASR-2025ZCR/64MB/HIT BULK	
FINB	2033900	ASR-2020S/128MB/3U/IBM BULK	
FINB	2118700	ASR-2130SLP/256MB SGL	
FINB	2045800	ASR-2120S/64MB/HPWS BULK	
FINB	451700	(OBS)AHA-1744 BULK	
FINB	1806500	(OBS)AAA-133U2/2MB BAG BULK	
FINB	2108900	ASR-2020S/128MB/IBM FRU-2	

Mat Class	Material #	Description	System Products
FINB	2067800	ASC-39160/DELL2 BULK	
FINB	1795400JA	AHA-2940U/JA 10PK	
FINB	2057400	ASC-29320LP/HPRV BULK	
FINB	581600	(OBS)AHA-2740W SINGLE	
FINB	2075000	ICP GDT8524RZ+BBU KIT	
FINB	950400	AHA-2940U BAG BULK	
FINB	1654600	(OBS)AHA-2944UW/OF BAG	
FINB	1961700JA	ASR-2200S/JA KIT	
FINB	1843000	AHA-2940U2B/FUJITSU BULK	
FINB	1891300	AAR-2400A KIT	
FINB	1786000	(OBS)AHA-3950U2B/ACER BAG BULK	
FINB	1931500	ASR-2000S KIT	
FINB	2164100	ASR-2025ZCR/64MB/SUP BULK	
FINB	2119000	ASR-2230SLP 20PK	
FINB	2074400	ICP GDT8124RZ KIT	
FINB	1874000	(OBS)AMM-232 KIT (TA-1410-OTC)	
FINB	1873700EU	ASR-2100S/EU KIT (TA-1420-OTC)	
FINB	581700	(OBS)AHA-2742W SINGLE	
FINB	1978600	ASC-29320LP-R 10PK	
FINB	1911300	2100S/32M SPAREKT TA-1418-CPQ	
FINB	2001600	ASR-2200S SGL	
FINB	1913700	ASR-3210S/32MB BULK	
FINB	1848800	ASC-29160 CPQ BULK	
FINB	2148300	ASR-2020ZCR-B/128MB BULK	
FINB	989000	AHA-2940 ULTRA KIT	
FINB	1829000	(OBS)AHA-3960D CPQ02 BAG BULK	
FINB	1863600JA	ASC-29160LP/JA 10 PK	
FINB	1965500	ASC-39160/NETAPP BULK	
FINB	2071800	ASC-39320A BULK	
FINB	2092800	ASR-2130SLP/128MB BULK	
FINB	1871100	AHA-2940UW/IBM-6 FRU	
FINB	1798400	(OBS)AHA-2930U2, BAG BULK	
FINB	2034000	ASR-2020S/128MB/IBM OPTION KIT	
FINB	1870500	ASC-29160LP HIGH/IBM FRU	
FINB	2100500	ATB-100/256MB/IBM BATT PK FRU	
FINB	1961800	ASR-2120S KIT	
FINB	1917500	ASR-3410S SGL	
FINB	1605300	(OBS)AHA-3940UW SINGLE	
FINB	1902700	DM4050-16 IPP KT TA-1140-CPQ	
FINB	2130300	ASR-2025ZCR/64MB BULK	
FINB	966500	(OBS)AHA-3940UW KIT	
FINB	1615800	AHA-2944UW BAG BLK	
FINB	1978200	ASC-29320-R 10PK	
FINB	1804200	(OBS)AAA-131U2 KIT	
FINB	2042600	ASR-2000S/48MB/FUJ-U160 BULK	
FINB	2181200	ASR-2120S/64MB/LP/LGC BULK	
FINB	1739900	(OBS)AHA-2940U2B BAG BULK	

Mat Class	Material #	Description	System Products
FINB	1777500	(OBS)ARO-1130CA2 BAG BULK	
FINB	1799400	(OBS)ARO-1130U2/2MB BAG BULK	
FINB	1760300	(OBS)AAA-132SA/2MB, BAG BULK	
FINB	1970300	ABM-300 BULK	
FINB	1803800	(OBS)AAA-131U2/2MB BAG BULK	
FINB	1742000	(OBS)AHA-2940UW/OF KIT	
FINB	979300	(OBS)AHA-3940UWD BAG BK	
FINB	1991500	ASR-2200S/64MB/DELL WS BULK	
FINB	2050300	ASR-2020S/128MB/2U/IBM BULK	
FINB	2036100	ASR-2010S/48MB/HITACHI BULK	
FINB	1832400	(OBS)AHA-3960D CPQ01 BAG BULK	
FINB	1692800	(OBS)AAA-131CA KIT	
FINB	1650600	(OBS)AHA-3940AU BAGBULK	
FINB	1873700JA	ASR-2100S/JA KIT (TA-1426-OTC)	
FINB	1912200	ASR-2100S32MBULKTA-1389FUJ	
FINB	1927600	ASR-2000S/48MB BULK	
FINB	2016300	ASR-2000S/48MB-LP BULK	
FINB	2093200	ASR-2230SLP/128MB BULK	
FINB	1648000	AHA-3944AUWD BAGBK	
FINB	961900	(OBS)AHA-3980/85UPGRADE	
FINB	1779200	(OBS)AHA-2940U2 OEM/COMPAQ BAG	
FINB	1681700	(OBS)AHA-2940U/B BAG BK	
FINB	1698500	(OBS)ARO-1130CA OEM BAG	
FINB	1894700	ASR-3200S2X32MBKTA-1439FUJ	
FINB	1639300	(OBS)AHA-2940UW/IBM-4	
FINB	1796700	(OBS)AHA-3950U2 SGL	
FINB	1993700	ASR-2110S/32MB/HITACHI BULK	
FINB	583100	(OBS)AHA-2742AT KIT	
FINB	1928700	ASR-2100S BULK TA-1389-FSJ	
FINB	1658300	(OBS)AHA-2940UW/NCR TRY	
FINB	2010000	ASR-2010S/16MB BULK	
FINB	950500	(OBS)AHA-2940U TRAY BLK	
FINB	2058300	ASR-2010S/48MB/FUJ BULK	
FINB	1946300	ASC-29160LP HIGH/IBM-2 BULK	
FINB	1994000	ASR-2005S/48MB/HITACHI BULK	
FINB	1860500	ASC-29320LP BAG BULK	
FINB	1804200JA	(OBS)AAA-131U2/JA KIT	
FINB	1916400	AHA-2944UW/FSC1 BULK	
FINB	1832700	AHA-3944AUWD/EMC1 BAG BULK	
FINB	1875600	ASC-29160/FSC BAG BULK	
FINB	1605000	(OBS)AHA-2940UW SINGLE	
FINB	1853200	ASC-29160/MICRON BULK	
FINB	1785900	AHA-2940U2W/ACER BAG BULK	
FINB	2148100	ASR-2020ZCR-B/64MB BULK	
FINB	1745000JA	AHA-2940U/HITACHI BAG BULK	
FINB	1769400	AHA-2940U/S1.32 BAG BULK	
FINB	1978500	ASC-29320LP-R KIT	

Mat Class	Material #	Description	System Products
FINB	1834800	(OBS)AHA-2940U2 OEM/DELL2 BAG	
FINB	1775600	(OBS)AHA-2940U2W/SNI BAGBULK	
FINB	1839700	ASC-29160N CPQ KIT	
FINB	1978300	ASC-39320-R KIT	
FINB	1821000	ARO-1302/0MB DELL BULK	
FINB	1887000	ASC-29160LP LOW HT BRKT 50-PK	
FINB	1820900	AHA-2944UW/B COMPAQ BAG BULK	
FINB	1728200	AHA-2944UW/A NCR TRAY BULK	
FINB	1907500	ABM-100 KIT TA-1242-FSC	
FINB	2058400	ASR-2010S/48MB-LP/FUJ BULK	
FINB	1797600	ASW-7800 v3.02 VOL	
FINB	1860700	ASC-39320 BAG BULK	
FINB	2010800	ASR-2015S/16MB BULK	
FINB	1730000	AHA-2940UW/B IBM-6	
FINB	1993900	ASR-2000S/48MB/HITACHI BULK	
FINB	1982500	ASC-29160/GATEWAY1 BULK	
FINB	1887400	ASC-29160/HP NSD ACC KIT	
FINB	1978500JA	ASC-29320LP-R/JA KIT	
FINB	2051800	ASC-29320LP/HPWS BULK	
FINB	1699200	(OBS)AHA-2940U/A TRAY BULK	
FINB	1978300JA	ASC-39320-R/JA KIT	
FINB	1913900	ASR-3410S/32MB BULK	
FINB	1799300	(OBS)ARO-1130U2/0MB BAG BULK	
FINB	988300	(OBS)AHA-2940U/COMPAQ B	
FINB	1748800	(OBS)AHA-2930U2 KIT	
FINB	1648300	(OBS)AHA-3940AUW BAGBLK	
FINB	1705500	(OBS)AHA-3940AUW KIT	
FINB	1811000	(OBS)ARO-1130U2 KIT	
FINB	1605200JA	(OBS)AHA-2940UW/SJ 10PK	
FINB	1906500	(OBS)AAR-2400A BAG BULK	
FINB	1914000	ASR-3410S/64MB BULK	
FINB	597000	(OBS)AHA-2940W TRAY BLK	
FINB	2077500	(OBS)ICP 8845 SCSI BKT 2HD-VHD	
FINB	1705600	(OBS)AHA-3940AUW SINGLE	
FINB	1799200CN	(OBS)AHA-2940UW/CN BAG BULK	
FINB	1805700	(OBS)AHA-2940U2 OEM/MICRON	
FINB	1807700JA	AHA-2940UW PRO/JA RTL KIT	
FINB	1657900	(OBS)AHA-2944UW/DEC TRY	
FINB	1869200	(OBS)AHA-3960D/CPQ1B BULK	
FINB	1807800JA	(OBS)AHA-2940UW PRO/JA 10-PK	
FINB	1969800	PM2664U3-2U3-R-BK TA-1255-SNP	
FINB	2018600	ASR-3225S/256MB/IBM BULK	
FINB	2004400	EAGLE FRU (37L6902)	
FINB	2108600	ASR-2020S/128MB/2U-2/IBM BULK	
FINB	2016700	ASR-3225S/128MB/IBM FRU	
FINB	2059000	ASC-29160i LED/HP BULK	
FINB	2079500	ASR-2010S 50PK	

Mat Class	Material #	Description	System Products
FINB	1911600	PM3755U2B-B-3U2-64MTA-1149-CPQ	
FINB	2074900GE	ICP GDT8524RZ+/GE KIT	
FINB	1917200	ASR-3210S KIT	
FINB	2016500	ASR-3225S/128MB/IBM BULK	
FINB	1991400	ASR-2120S/64MB/FSC BK	
FINB	1910900	PM3757U2 BULK TA-1285-FOR	
FINB	1957500	ASR-2005S KIT	
FINB	1856000	ASC-39160/DELL BULK	
FINB	1873700	ASR-2100S KIT (TA-1388-OTC)	
FINB	2036200	ASR-2015S/48MB/HITACHI BULK	
FINB	1738300	AHA-2944UW/DELL BAG BULK	
FINB	2074900	ICP GDT8524RZ+ KIT	
FINB	2018800	ASR-3225S/256MB/IBM FRU	
FINB	2009800	ASR-2010S/48MB BULK	
FINB	1936400	ASC-29160N/DELL2 BULK	
FINB	1911800	PM3755U2B-B-16M TA-1417-CPQ	
FINB	1871500	AAC-364/DELL3 W/HDL v2 BULK	
FINB	2139400	ASC-29160N 50 PK	
FINB	1908100	SX4055U2-2 BK TA-1133-FSC	
FINB	1917400	ASR-3410S KIT	
FINB	1970500	ASR-2200S/64MB-B BULK	
FINB	2031000	ASR-2010S/48MB/FSC BULK	
FINB	1917400EU	ASR-3410S/EFIGS KIT	
FINB	1907800	ASR-3200S/0M BKTA-1393-FSC	
FINB	1883600	(OBS)ASR-3400S SGL TA-1436-OTC	
FINB	2078900	ICP SRCU32U KIT	
FINB	1917200EU	ASR-3210S/EFIGS KIT	
FINB	2074200GE	ICP GDT8123RZ/GE KIT	
FINB	2079600	ASR-2015S 50PK	
FINB	1873900	(OBS)ASR-3400S KIT TA-1404-OTC	
FINB	2074300	ICP GDT8114RZ KIT	
FINB	2189200	ASC-39320A/Dell FMS Bulk	
FINB	1948100	ASC-29160LP/HITACHI BULK	
FINB	2181300	ICP9014RO BULK	
FINB	2079000	ICP SRCZCR KIT	
FINB	2074200	ICP GDT8123RZ KIT	
FINB	1801100	(OBS)AHA-2940U2/GATEWAY 1 BAG	
FINB	2031500	ASR-2010S/48MB-LP/FSC BULK	
FINB	1883500	(OBS)ASR-3200S SGL TA-1434-OTC	
FINB	1976200	ASR-2120S/64MB BULK	
FINB	1873900EU	(OBS)3400S/EU KIT(TA-1424-OTC)	
FINB	1877500	ASR-2100S/32MBBKTA-1389FSC	
FINB	1902800	PM3755U2B-B-3U2-64MTA-1149-SUN	
FINB	1826700	(OBS)AAA-UDMA KIT	
FINB	1970200	ASR-2200S/64MB BULK	
FINB	1931400	(OBS)ASR-5400S KIT	
FINB	2074600	ICP GDT8543RZ KIT	

Mat Class	Material #	Description	System Products
FINB	1907600	OBS,AMM-232 BK TA-1411-FSC	
FINB	1976300	ASR-2120S/128MB BULK	
FINB	2075000GE	ICP GDT8524RZ+BBU/GE KIT	
FINB	2034100	ASR-2020S/128MB/IBM FRU	
FINB	1802200	AAC-364/DELL2 BAG BULK	
FINB	1768800	AHA-3944AUWD/DELL BAG BULK	
FINB	2170400	ASC-39320A/Dell Bulk	
FINB	2019600	ASR-2010S/48MB/LP BULK	
FINB	1978500EU	ASC-29320LP-R/EFIKS KIT	
FINB	2181400	ICP9024RO BULK	
FINB	1978100	ASC-29320-R KIT	
FINB	1894500	ASR-3200S2X32MBKTA-1435FSC	
FINB	2075200	ICP GDT8643RZ KIT	
FINB	1851500	(OBS)AAA-133U2 16MB KIT	
FINB	1705300	(OBS)AHA-3940AU KIT	
FINB	2037700	ASR-2120S/64MB/LEGEND BULK	
FINB	1994400	ASR-2120S/64MB-LP/FSC BK	
FINB	1933200	ABM-200 KIT	
FINB	1978300EU	ASC-39320-R/EFIKS KIT	
FINB	2123300	ASR-2020ZCR/128-LP/FSC BULK	
FINB	2164000	ASR-2020ZCR/64MB/SUP BULK	
FINB	1993000	(OBS)ASR-5400S/128MB SGL	
FINB	2075300GE	ICP GDT8522RZ/GE KIT	
FINB	1906600	ASC-29160LP/HP CPB FH BULK	
FINB	1957500EU	ASR-2005S/EFIKS KIT	
FINB	1971400	ASR-2000S/48MB/FSC-U160 BULK	
FINB	1917200JA	ASR-3210S/JA KIT	
FINB	1806600	(OBS)AAA-133U2/16MB BAG BULK	
FINB	1970400	ASR-2200S/128MB BULK	
FINB	1919400	ASC-29160N/HP BDD BULK	
FINB	1864000	ASC-39160/FUJITSU BULK	
FINB	2040200	ASR-2110S/32MB/LEGEND BULK	
FINB	1927400	ASR-2005S/48MB BULK	
FINB	1870400	ASC-29160LP HIGH/IBM BULK	
FINB	1785400	AHA-2940U2W/IBM BAG BULK	
FINB	1856100	ASC-29160LP/DELL BULK	
FINB	2074400GE	ICP GDT8124RZ/GE KIT	
FINB	2039300	ASR-2020ZCR KIT	
FINB	1931400EU	(OBS)ASR-5400S/EFIKS KIT	
FINB	1982300	ASC-39320D/HPQ ABG BULK	
FINB	1931500EU	ASR-2000S/EFIKS KIT	
FINB	1646700	(OBS)AHA-3940AUWD BAG	
FINB	1877800	AHA-2940U2W/DELL3 BULK	
FINB	1917300	ASR-3210S SGL	
FINB	2074600GE	ICP GDT8543RZ/GE KIT	
FINB	1994600	ASR-2200S/128MB-LP/FSC BK	
FINB	1978100EU	ASC-29320-R/EFIKS KIT	

Mat Class	Material #	Description	System Products
FINB	1961700EU	ASR-2200S/EFIGS KIT	
FINB	2059100	ASR-2120S/64MB/HITACHI BULK	
FINB	1860200	AHA-2940U2W/DG BULK	
FINB	2079800	ASR-2200S 20PK	
FINB	1863000	ASC-29160/FUJITSU BULK	
FINB	1978400	ASC-39320-R 10PK	
FINB	2075100GE	ICP GDT8623RZ/GE KIT	
FINB	1820500	(OBS)AHA-3960D BAG BULK	
FINB	2035300	ASC-29160i/HPQ BULK	
FINB	1873800	(OBS)ASR-3200S KIT TA-1400-OTC	
FINB	1776500	(OBS)AAC-364/DELL BAG BULK	
FINB	1946600	ASC-29160N/MICRON-2 BULK	
FINB	1957500JA	ASR-2005S/JA KIT	
FINB	2075400GE	ICP GDT8622RZ/GE KIT	
FINB	1726100	AHA-2940UW/COMPAQ BAG BULK	
FINB	1887300	ASC-29160/HP NSD BULK	
FINB	2120300	ASR-2230SLP SGL	
FINB	1877400	OBS,ASR-2100S/32MBKTTA-1388CPQ	
FINB	1761900	(OBS)AHA-2930U2 BAG BULK	
FINB	2075400	ICP GDT8622RZ KIT	
FINB	1937300	ASR-2110S/32MB BULK	
FINB	2059900	ASC-29320A BULK	
FINB	1946900	AHA-2940UW/IBM-8 BULK	
FINB	1853100	(OBS)ASC-29160N/DELL BULK	
FINB	1689000	(OBS)ARO-1130xA-B/16MB BAG BLK	
FINB	1920500	ASC-29160/FSC3 BULK	
FINB	1804300	(OBS)AAA-133U2 KIT	
FINB	2005200EU	ASC-39320D-R/EFIGS KIT	
FINB	1947000	AHA-2940UW/IBM-8 FRU	
FINB	1737400	(OBS)ARO-1130SA KIT	
FINB	1834100	ASC-39160 BULK	
FINB	1930700	ASC-29160LP LOW/IBM BULK	
FINB	1887500	OBS,ASR-2100S/32MBBKTA-1389CPQ	
FINB	1699600	AHA-2940UW/A TRAY BULK	
FINB	2181700	ICP9014RO KIT	
FINB	1850100	ASC-29160N/GATEWAY BULK	
FINB	1871400	AAC-364/DELL3 W/O HDL v2 BULK	
FINB	1854400	AAC-364/DELL2 W/HD V2 BULK	
FINB	1699800	(OBS)AHA-2944UW/A TRAY BULK	
FINB	1911900	PM3755U2B-B-16M TA-1173-CPQ	
FINB	1681100	(OBS)ARO-1130CA KIT	
FINB	1931500JA	ASR-2000S/JA KIT	
FINB	1928300	BB4050 KT TA-1136-FSC	
FINB	984500	(OBS)AHA-2940AU BAG BLK	
FINB	2030400	ASC-29160N/LEGEND NF BULK	
FINB	988500	AHA-2940U/UNI KIT	
FINB	2075300	ICP GDT8522RZ KIT	

Mat Class	Material #	Description	System Products
FINB	1913600	ABM-200 BAG BULK	
FINB	2005200	ASC-39320D-R KIT	
FINB	1947300	OBS,ASR-2100S/32MB/HP TCD BULK	
FINB	1853500	(OBS) AAC-3642/128MB/HP KIT	
FINB	1849700	ASC-29160N/MICRON BULK	
FINB	1874100	(OBS)AMM-264 KIT (TA-1412-OTC)	
FINB	1946800	ASC-29160/HP TCD BULK	
FINB	1848100	ASC-29160N/CPQ BULK	
FINB	1788800JA	AHA-2940UW/FUJITSU JA BAGBULK	
FINB	1704400JA	(OBS)AHA-2940U/SJ-UNI KIT	
FINB	1861600	AHA-2940UW/HP UCK BULK	
FINB	1824000	AHA-2940U2B/IBM FRU	
FINB	1883400EU	ASR-2100S/EU SGL (TA-1438-OTC)	
FINB	1797200	AHA-2940UW/SIEMENS-1 BAG BULK	
FINB	2073900GE	ICP GDT8500RZ/GE KIT	
FINB	2074500	ICP GDT8523RZ KIT	
FINB	1834300	(OBS)ASC-29160N BULK	
FINB	1628700JA	AHA-2940UW/F SGL	
FINB	1893900	ASW-U160 FMS v1.11/HP NSD DISK	
FINB	989000IT	AHA-2940AU/IT KIT	
FINB	1848600	AHA-2940U2B/HP SSD KIT	
FINB	1834200	ASC-29160 BULK	
FINB	1972900	ASR-2020ZCR/64MB BULK	
FINB	2075200GE	ICP GDT8643RZ/GE KIT	
FINB	990500	(OBS)AHA-2940UW/UNI KIT	
FINB	2034200	ASR-2020S/IBM BATTERY FRU	
FINB	2003900	OBS,ASR-2100S/32MB/LEGEND BULK	
FINB	1874200	OBS,ABM-100 KIT (TA-1242-OTC)	
FINB	1900100	ASC-29160/FSC2 BULK	
FINB	2034400	ASC-29320LP HIGH/IBM BULK	
FINB	1770100	(OBS)AHA-2940UW/S1.32 TRY BULK	
FINB	2034500	ASC-29320LP HIGH/IBM FRU	
FINB	1970600	ASR-2200S/128MB-B BULK	
FINB	946700	AHA-2940UW BAG BULK	
FINB	2004500	EAGLE FRU JAPAN (19K0561)	
FINB	1716000	(OBS)AHA-2940U2W KIT	
FINB	1867400	ASC-29160N/EPSON BULK	
FINB	2094000	ICP 3700 CLUSTER RAIDYNE	
FINB	1628900	(OBS)AHA-2940UW/OF BGBK	
FINB	1902100	FRU FOR BB4050 BK TA-1366-SUN	
FINB	1850000	ASC-29160/GATEWAY BULK	
FINB	2120200JA	ASR-2230SLP/JA KIT	
FINB	1968700	ASC-39320D BULK	
FINB	1921900	ASC-29160/DG1 BULK	
FINB	1654700	(OBS)AHA-2944UW/OF TRY	
FINB	1877300	OBS,ASR-2100S/32MBBKTA-1389OTC	
FINB	1944600	ASR-2110S/64MB BULK	

Mat Class	Material #	Description	System Products
FINB	1769900	AHA-2940UW/S1.32 BAG BULK	
FINB	989000GE	AHA-2940 ULT/GE KIT	
FINB	1929100	ASR-3410S/OMB BULK	
FINB	1738400	(OBS)AHA-2950U2B BAG BULK	
FINB	939100	(OBS)AHA-2944W KIT	
FINB	1803500CN	(OBS)AHA-2940AU/CN KIT	
FINB	1803000	AHA-2940U2W/FUJITSU BAG BULK	
FINB	974200	(OBS)AHA-2940UW/DELL	
FINB	1978100JA	ASC-29320-R/JA KIT	
FINB	2076400	ICP 3510 BATTERY PACK	
FINB	1665000	(OBS)AHA-2940UW/SNI BAG	
FINB	989100	(OBS)AHA-2940UW/GATEWAY	
FINB	946600	(OBS)AHA-2940UW TRAY BK	
FINB	2077300	(OBS)ICP 8850 SCSI BKT 1HD-HD	
FINB	1708000	AHA-2940U2W BAG BULK	
FINB	963400	(OBS)AHA-2940/SNI-2 KIT	
FINB	1637200	(OBS)AHA-2940UW/SNI KIT	
FINB	1822800	AHA-2940U2B/IBM BAG BULK	
FINB	2078100	ICP 8957 SCSI DIRECTOR	
FINB	1877100	ASR-U160 MEDIA KIT TA-1416-OTC	
FINB	1853300	(OBS)MEDIA PK, ASC-29160/MICRN	
FINB	1698000	(OBS)AHA-2940AU/B TRAY BULK	
FINB	2001800	ASR-U320 MEDIA KIT	
FINB	2094400	ASR-2130LP/128MB BULK	
FINB	2100300	ATB-100/256MB/IBM OPTION KIT	
FINB	2016600	ASR-3225S/128MB/IBM OPTION KIT	
FINB	2114300	ASR-2200S/64MB/DELL2 BULK	
FINB	2108800	ASR-2020S/128MB/IBM OPTION-2	
FINB	2100200	ATB-100/256MB/IBM BULK	
FINB	2108700	ASR-2020S/128MB/3U-2/IBM BULK	
FINB	2018700	ASR-3225S/256MB/IBM OPTION KIT	
FINB	2061300	ASC-39320/DELL BULK	
FINB	2166200	ASC-29320ALP KENDAL KIT	
FINB	2078800	ICP SRCU42L KIT	
FINB	2079700	ASR-2120S 20PK	
FINB	1891200	AAR-1200A KIT	
FINB	2118900	ASR-2130SLP 20PK	
FINB	1821900	ASC-29160 KIT	
FINB	2170400-R	ASC-39320A/Dell RoHS Bulk	
FINB	2001700	ASR-2120S SGL	
FINB	2029900	ASC-29320/FSC SCSI BULK	
FINB	2074800GE	ICP GDT8524RZ/GE KIT	
FINB	2146100	ASC-29320ALP KENDAL HIGH BULK	
FINB	2074700	ICP GDT8514RZ KIT	
FINB	2074700GE	ICP GDT8514RZ/GE KIT	
FINB	2189200-R	ASC-39320A/Dell RoHS FMS Bulk	
FINB	1852300	ASC-29160 10 PK	

Mat Class	Material #	Description	System Products
FINB	1994500	ASR-2200S/128MB/FSC BK	
FINB	1973200	ASC-29160/FSC4 BULK	
FINB	2060800	ASC-29320A-R 10PK	
FINB	1961700	ASR-2200S KIT	
FINB	1957800	ASR-2110S SGL	
FINB	1891300EU	AAR-2400A/EFIGS KIT	
FINB	2093500	ASR-2130SLP SGL	
FINB	2074300GE	ICP GDT8114RZ/GE KIT	
FINB	2073900	ICP GDT8500RZ KIT	
FINB	1852400	ASC-39160 10 PK	
FINB	2004000	ASR-2010S KIT	
FINB	2074800	ICP GDT8524RZ KIT	
FINB	2030100	ASR-2200S/128MB SGL	
FINB	1961800EU	ASR-2120S/EFIGS KIT	
FINB	2099800	ASR-2010S/48MB/NEC BULK	
FINB	2139700	ASC-29320A-R 50PK	
FINB	2093400	ASR-2130SLP KIT	
FINB	2060500EU	ASC-29320A-R/EFIGS KIT	
FINB	1835200	ASC-29160N 10 PK	
FINB	1891200EU	AAR-1200A/EFIGS KIT	
FINB	1931600	ASR-2110S KIT	
FINB	2093400EU	ASR-2130SLP/EFIGS KIT	
FINB	2030200	ASR-2120S/128MB SGL	
FINB	1641200	AHA-2944UW KIT	
FINB	2004100	ASR-2015S KIT	
FINB	2060900EU	ASC-39320A-R/EFIGS KIT	
FINB	2060900	ASC-39320A-R KIT	
FINB	1822200	ASC-19160 10 PK	
FINB	2060500JA	ASC-29320A-R/JA KIT	
FINB	1835000	ASC-29160N KIT	
FINB	1821900JA	ASC-29160/JA KIT	
FINB	2004000EU	ASR-2010S/EU KIT	
FINB	1972100	ABM-300 KIT	
FINB	1822100	ASC-19160 KIT	
FINB	1931600JA	ASR-2110S/JA KIT	
FINB	2060400	ASC-29320ALP-R 10PK	
FINB	2093400JA	ASR-2130SLP/JA KIT	
FINB	1891300JA	AAR-2400A/JA KIT	
FINB	2004100EU	ASR-2015S/EU KIT	
FINB	2060100	ASC-29320ALP-R KIT	
FINB	2120200	ASR-2230SLP KIT	
FINB	1860300	ASC-39160/CPQ HPSD BULK	
FINB	1835000EU	ASC-29160N/EFIGS KIT	
FINB	2060500	ASC-29320A-R KIT	
FINB	2032300	ASC-39320D/NETAPP BULK	
FINB	1860400	ASC-29320 BAG BULK	
FINB	1892100	ASC-39160/CPQ BULK	

Mat Class	Material #	Description	System Products
FINB	1863600	ASC-29160LP 10 PK	
FINB	2078200	ICP 8961 128MB ECC DIMM	
FINB	1863700	ASC-29160LP KIT	
FINB	1931600EU	ASR-2110S/EFIGS KIT	
FINB	1822300EU	ASC-39160/EFIGS KIT	
FINB	1865500	ASC-29160LP HIGH BAG BULK	
FINB	1822100EU	ASC-19160/EFIGS KIT	
FINB	1822300	ASC-39160 KIT	
FINB	2181800	ICP9024RO SGL	
FINB	2060100JA	ASC-29320ALP-R/JA KIT	
FINB	1835000JA	ASC-29160N/JA KIT	
FINB	1852300CN	ASC-29160/CN 10 PK	
FINB	2060100EU	ASC-29320ALP-R/EFIGS KIT	
FINB	1821900EU	ASC-29160/EFIGS KIT	
FINB	1994700	ABM-300/FSC BK	
FINB	2139300	ASC-29160 50 PK	
FINB	2077400	ICP 3505 U320 SCSI BKT 1HD-VHD	
FINB	2120200EU	ASR-2230SLP/EFIGS KIT	
FINB	2181900	ICP9024RO KIT	
FINB	2060000	ASC-29320ALP BULK	
FINB	1982800	ASC-29160LP/FSC BULK	
FINB	2204600	ASC-29160LP/NEC BULK	
FINB	1822100JA	ASC-19160/JA KIT	
FINB	1891200JA	AAR-1200A/JA KIT	
FINB	1852300JA	ASC-29160/JA 10 PK	
FINB	1961800JA	ASR-2120S/JA KIT	
FINB	2004000JA	ASR-2010S/JA KIT	
FINB	2060900JA	ASC-39320A-R/JA KIT	
FINB	1920900	ASC-29160/NEC1 BULK	
FINB	1783500JA	AHA-2940AU/JA RTL KIT	
FINB	2010600	ASR-2015S/48MB BULK	
FINB	2061000	ASC-39320A-R 10PK	
FINB	1926700	ASC-29160N NF BAG BULK	
FINB	2198700	ASR-2120S LP BRACKET 50 PACK	
FINB	2034300	ASC-29320LP LOW/IBM BULK	
FINB	1902500	BB4050 IPP KT TA-1374-CPQ	
FINB	2118800	ASR-2230SLP/256MB SGL	
FINB	2004100JA	ASR-2015S/JA KIT	
FINB	2016800	ASR-3225S BATTERY FRU	
FINB	2075800	ICP 8798 FIRMWARE UPGRADE	
FINB	2199700	ICP9047MA/256MB BULK	
FINB	2199900	ICP9047MA SATA II RAID KIT	
FINB	2187500	(OBS)ATB-205/32MB/IBM BULK	
FINB	2218300-R	ABM-600 RoHS KIT	
FINB	1920900-R	ASC-29160/NEC1 RoHS BULK	
FINB	1835200JA	ASC-29160N/JA 10 PK	
FINB	2200000	ICP9087MA SATA II RAID KIT	

Mat Class	Material #	Description	System Products
FINB	2149900-R	ASC-29320A/FUJITSU RoHS BULK	
FINB	1834200-R	ASC-29160 RoHS BULK	
FINB	2224500	ASC-29160LP/NETAPP BULK	
FINB	2148500	ASR-2020ZCR BATTERY KIT	
FINB	1865500-R	ASC-29160LP HIGH RoHS BULK	
FINB	2039300JA	ASR-2020ZCR/JA SGL	
FINB	2039300EU	ASR-2020ZCR/EU SGL	
FINB	2213700-R	ABM-500 RoHS KIT	
FINB	2199800	ICP9087MA/256MB BULK	
FINB	2216100-R	ASR-2120S/64MB/HIT RoHS BULK	
FINB	2141400	ASC-29160LP 50 PK	
FINB	2093400JA-R	ASR-2130SLP/JA RoHS KIT	
FINB	2143100-R	ASC-29320ALP/NEC RoHS BULK	
FINB	2102600-R	ASC-39160 HP/GE RoHS BULK	
FINB	2204600-R	ASC-29160LP/NEC RoHS BULK	
FINB	1982800-R	ASC-29160LP/FSC RoHS BULK	
FINB	1641200-R	AHA-2944UW RoHS KIT	
FINB	1973200-R	ASC-29160/FSC4 RoHS BULK	
FINB	2215200-R	ASR-2120S RoHS SGL	
FINB	2216000-R	ASR-2120S/64MB/HPWS RoHS BULK	
FINB	989000FR	AHA-2940 ULT/FR KT	
FINB	2057500	ASC-29320LP/HPRV FULL BULK	
FINB	2087200	ASC-29320ALP/HPWS BULK	
FINB	1873800JA	(OBS)3200S/JA KIT(TA-1428-OTC)	
FINB	993500	(OBS)AHA-2940U/COMPAQ K	
FINB	1779400	(OBS)AHA-2940UW DUAL/DELL2 BAG	
FINB	1640500	(OBS)AHA-2940UW/DELL2	
FINB	1861500	(OBS)AHA-2940UW/HP NSD BULK	
FINB	1943600	(OBS)DM4060-16 RMA RPL	
FINB	1943700	(OBS)DM4060-64 RMA RPL	
FINB	1944200	(OBS)SX4054U2-2 RMA RPL	
FINB	2139200	ASC-19160 50 PK	
FINB	2139600	ASC-29320ALP-R 50PK	
FINB	2123400	ASR-2020ZCR BP/FSC BULK	
FINB	2036500	ASR-2130S/128MB BULK	
FINB	1902000	FRU FOR PM3755U2B TA-1365-SUN	
FINB	1906800	PM3755U2B-B-64M BK TA-1381-FSC	
FINB	1946400	ASC-29160LP HIGH/IBM-2 FRU	
FINB	1677000	(OBS)AHA-2940U DUAL BAG	
FINB	1834100-R	ASC-39160 RoHS BULK	
FINB	2060000-R	ASC-29320ALP RoHS BULK	
FINB	2197400-R	ASR-2020ZCR/64MB/HIT RoHS BULK	
FINB	2197200-R	ASR-2025ZCR/64MB/HIT RoHS BULK	
FINB	1863700-R	ASC-29160LP RoHS KIT	
FINB	1972900-R	ASR-2020ZCR/64MB RoHS BULK	
FINB	2146200	ASC-29320ALP KENDAL FRU BULK	
FINB	2146000	SC-29320ALP KENDAL LOW BULK	

Mat Class	Material #	Description	System Products
FINB	2111700	ASC-29320ALP FMS BULK	
FINB	2071800-R	ASC-39320A RoHS BULK	
FINB	491153-00	SFT PKG, HP MCA INSTALLATION	
FINB	2092900	ASR-2130SLP/256MB BULK	
FINB	2115900	ASC-39160/DELL3 BULK	
FINB	2093300	ASR-2230SLP/256MB BULK	
FINB	2143100	ASC-29320ALP/NEC BULK	
FINB	2102600	ASC-39160 HP/GE BULK	
FINB	2150500	ASC-29320ALP/STR BULK	
FINB	2176200	ASR-2120S/64MB/LGC BULK	
FINB	2149900	ASC-29320A/FUJITSU BULK	
FINB	2199900-R	ICP9047MA SATA II RAID RoHS KT	
FINB	2216800	ICP9085LI KIT	
FINB	2216900	ICP5085BR KIT	
FINB	2200000-R	ICP9087MA SATA II RAID RoHS KT	
FINB	1864000-R	ASC-39160/FUJITSU RoHS BULK	
FINB	1615800-R	AHA-2944UW RoHS BAG BLK	
FINB	1790700-R	AVA-2906 RoHS 10-PACK	
FINB	1662200JA-R	AHA-2930U/JA RTL RoHS KIT	
FINB	2077800-R	ICP 8958 INT LVDS/SE TERM RoHS	
FINB	1852300CN-R	ASC-29160/CN RoHS10 PK	
FINB	2060500JA-R	ASC-29320A-R/JA RoHS KIT	
FINB	2060900JA-R	ASC-39320A-R/JA RoHS KIT	
FINB	1852300JA-R	ASC-29160/JA RoHS 10 PK	
FINB	2181400-R	ICP9024RO RoHS BULK	
FINB	1822300JA-R	ASC-39160/JA RoHS KIT	
FINB	2118800-R	ASR-2230SLP/256MB RoHS SGL	
FINB	2216500-R	ASC-48300 I2C RoHS HostRD BULK	
FINB	2060100EU-R	ASC-29320ALP-R/EFIGS RoHS KIT	
FINB	2122700-R	ABM-400 RoHS KIT	
FINB	2146000-R	ASC-29320ALP KENDAL LOW R BULK	
FINB	2060100JA-R	ASC-29320ALP-R/JA RoHS KIT	
FINB	2181800-R	ICP9024RO RoHS SGL	
FINB	1821900JA-R	ASC-29160/JA RoHS KIT	
FINB	2039300-R	ASR-2020ZCR RoHS KIT	
FINB	2060100-R	ASC-29320ALP-R RoHS KIT	
FINB	2181300-R	ICP9014RO RoHS BULK	
FINB	1822300EU-R	ASC-39160/EFIGS RoHS KIT	
FINB	1662200EU-R	AHA-2930U/EFIGS RoHS KIT	
FINB	2216400-R	ASC-48300 with I2C HR RoHS Kit	
FINB	2215100JA-R	ASR-2120S/JA RoHS KIT	
FINB	1863600-R	ASC-29160LP RoHS 10 PK	
FINB	1772900-R	AVA-2906 RoHS KIT PC/MAC	
FINB	2060900EU-R	ASC-39320A-R/EFIGS RoHS KIT	
FINB	1965400-R	AHA-2930U RoHS 10 PK	
FINB	2074300GE-R	ICP GDT8114RZ/GE RoHS KIT	
FINB	2060500EU-R	ASC-29320A-R/EFIGS RoHS KIT	

Mat Class	Material #	Description	System Products
FINB	2074000-R	ICP GDT8546RZ RoHS KIT	
FINB	1821900EU-R	ASC-29160/EFIGS RoHS KIT	
FINB	2060400-R	ASC-29320ALP-R RoHS 10PK	
FINB	1860300-R	ASC-39160/CPQ HPSD RoHS BULK	
FINB	1852400-R	ASC-39160 RoHS 10 PK	
FINB	1662200-R	AHA-2930U RoHS KIT	
FINB	2181900-R	ICP9024RO RoHS KIT	
FINB	2060900-R	ASC-39320A-R RoHS KIT	
FINB	2074700GE-R	ICP GDT8514RZ/GE RoHS KIT	
FINB	2120300-R	ASR-2230SLP RoHS SGL	
FINB	2060500-R	ASC-29320A-R RoHS KIT	
FINB	2146100-R	ASC-29320ALP KENDAL HIGH R BLK	
FINB	2181700-R	ICP9014RO RoHS KIT	
FINB	2061000-R	ASC-39320A-R RoHS 10PK	
FINB	2119000-R	ASR-2230SLP RoHS 20PK	
FINB	2120200EU-R	ASR-2230SLP/EFIGS RoHS KIT	
FINB	1892100-R	ASC-39160/CPQ RoHS BULK	
FINB	2215100EU-R	ASR-2120S/EFIGS RoHS KIT	
FINB	2093400EU-R	ASR-2130SLP/EFIGS RoHS KIT	
FINB	2093500-R	ASR-2130SLP RoHS SGL	
FINB	2215700-R	ASR-2120S/128MB RoHS SGL	
FINB	2074000GE-R	ICP GDT8546RZ/GE RoHS KIT	
FINB	2120200-R	ASR-2230SLP RoHS KIT	
FINB	2060800-R	ASC-29320A-R RoHS 10PK	
FINB	2093400-R	ASR-2130SLP RoHS KIT	
FINB	2215100-R	ASR-2120S RoHS KIT	
FINB	2118900-R	ASR-2130SLP RoHS 20PK	
FINB	2215800-R	ASR-2120S RoHS 20PK	
FINB	2166200-R	ASC-29320ALP KENDAL RoHS KIT	
FINB	2216700	ICP5085BR/256MB BULK	
FINB	1943400	(OBS)DM4050-16 RMA RPL	
FINB	1943500	(OBS)DM4050-64 RMA RPL	
FINB	1943300	(OBS)SM4050-64 RMA RPL	
FINB	1944100	(OBS)SX4054U2-1 RMA RPL	
FINB	1945800	(OBS)SX4055U2-1 RMA RPL	
FINB	1945900	(OBS)SX4055U2-2 RMA RPL	
FINB	2139300-R	ASC-29160 RoHS 50 PK	
FINB	2141400-R	ASC-29160LP RoHS 50 PK	
FINB	2139700-R	ASC-29320A-R RoHS 50PK	
FINB	2216600	ICP9085LI/256MB BULK	
FINB	2100400	ATB-100/256MB/IBM FRU	
FINB	2059900-R	ASC-29320A RoHS BULK	
FINB	2120200JA-R	ASR-2230SLP/JA RoHS KIT	
FINB	2118700-R	ASR-2130SLP/256MB RoHS SGL	
FINB	1822300-R	ASC-39160 RoHS KIT	
FINB	1852300-R	ASC-29160 RoHS 10 PK	
FINB	1821900-R	ASC-29160 RoHS KIT	

Mat Class	Material #	Description	System Products
FINB	2037600	AAR-2410SA/128MB BULK	
FINB	2080800EU	AAR-21610SA/EFIGS KIT	
FINB	2154400	AAR-2610SA/64MB/HP BULK	
FINB	2113500	AAR-2020SA 50-PK	
FINB	2096900	AAR-2410SA ENCL HS TRAY BLACK	
FINB	2100000	AAR-2610SA/64MB/DELL BULK	
FINB	2078700	ICP SRCS14L KIT	
FINB	2116100	AAR-2410SA/64MB/2U/IBM BULK	
FINB	2130200	AAR-2020SA/64MB BULK	
FINB	2063200	AAR-2410SA/64MB/IBM BULK	
FINB	2190700	AAR-2610SA/64MB Dell4 Bulk	
FINB	2096700	AAR-21610SA 10PK	
FINB	2074100	(OBS) ICP SATA KIT GDT8546RZ	
FINB	2074000	ICP GDT8546RZ KIT	
FINB	2076500	ICP 3500 SATA/PATA ADAPTER	
FINB	2080900	AAR-21610SA/64MB BULK	
FINB	2068400JA	AAR-2810SA/JA KIT	
FINB	2037500	AAR-2410SA/64MB BULK	
FINB	2081000	AAR-21610SA/128MB BULK	
FINB	2068500	AAR-2810SA/64MB BULK	
FINB	2096800	AAR-2410SA ENCL HS TRAY	
FINB	2015100	AAR-1210SA BULK	
FINB	2068600	AAR-2810SA/128MB BULK	
FINB	2074000GE	ICP GDT8546RZ/GE KIT	
FINB	2083700	AAR-2410SA 10PK	
FINB	2083800	AAR-2810SA 10PK	
FINB	2084000GE	ICP GDT8586RZ/GE KIT	
FINB	2082000	AAR-2810SA SGL	
FINB	2050500	AAR-1210SA 10 PK	
FINB	1961900	AAR-2410SA KIT	
FINB	1961900EU	AAR-2410SA/EFIGS KIT	
FINB	2080800	AAR-21610SA KIT	
FINB	2084000	ICP GDT8586RZ KIT	
FINB	2015000EU	AAR-1210SA/EFIGS KIT	
FINB	2207200	AAR-2610SA/64MB Dell5 Bulk	
FINB	2015000	AAR-1210SA KIT	
FINB	2113400	AAR-2020SA KIT	
FINB	2170600	AAR-1420SA 10PK	
FINB	1961900JA	AAR-2410SA/JA KIT	
FINB	2170200EU	AAR-1420SA/EFIGS Kit	
FINB	2068400EU	AAR-2810SA/EFIGS KIT	
FINB	2113600	AAR-2025SA KIT	
FINB	2015000JA	AAR-1210SA/JA KIT	
FINB	2063400	AAR-2410SA/64MB/IBM FRU	
FINB	2169500-R	AAR-2420SA ROHS 10PK	
FINB	2169400-R	AAR-2420SA/256MB ROHS SGL	
FINB	2169300-R	AAR-2420SA ROHS KIT	

Mat Class	Material #	Description	System Products
FINB	2113700	AAR-2025SA 50-PK	
FINB	2113600JA	AAR-2025SA/JA KIT	
FINB	2113600EU	AAR-2025SA/EFIKS KIT	
FINB	2113400JA	AAR-2020SA/JA KIT	
FINB	2196600	AAR-1420SA/HP BULK	
FINB	2113400EU	AAR-2020SA/EFIKS KIT	
FINB	2181100-R	AAR-1420SA RoHS BULK	
FINB	2169900JA-R	AAR-2820SA/JA RoHS KIT	
FINB	2154200-R	AAR-2410SA/HITACHI RoHS BULK	
FINB	2170000-R	AAR-2820SA/256MB RoHS SGL	
FINB	2170100-R	AAR-2820SA RoHS 10PK	
FINB	2147200-R	AAR-2410SA/64MB/HP RoHS BULK	
FINB	2203500-R	AAR-2420SA/128MB HP RoHS BULK	
FINB	2169900-R	AAR-2820SA RoHS KIT	
FINB	2138400	AAR-2020SA/64MB TEST BULK	
FINB	2169500	AAR-2420SA 10PK	
FINB	2169300	AAR-2420SA KIT	
FINB	2169300EU	AAR-2420SA/EFIKS KIT	
FINB	2169300JA	AAR-2420SA/JA KIT	
FINB	2169800	AAR-2620SA 10PK	
FINB	2169600	AAR-2620SA KIT	
FINB	2169600EU	AAR-2620SA/EFIKS KIT	
FINB	2169600JA	AAR-2620SA/JA KIT	
FINB	2170100	AAR-2820SA 10PK	
FINB	2169900	AAR-2820SA KIT	
FINB	2169900EU	AAR-2820SA/EFIKS KIT	
FINB	2169900JA	AAR-2820SA/JA KIT	
FINB	2080800JA	AAR-21610SA/JA KIT	
FINB	2196600-R	AAR-1420SA/HP RoHS BULK	
FINB	2203400	AAR-2410SALP/64MB/HP Bulk	
FINB	2169300JA-R	AAR-2420SA/JA ROHS KIT	
FINB	2158200	AAR-2025SA/64MB BULK	
FINB	2177300	AAR-2610SA/64MB/DELL3 BULK	
FINB	2199400-R	AAR-2820SA/128MB RoHS BULK	
FINB	2158200-R	AAR-2025SA/64MB RoHS BULK	
FINB	2142400	AAR-2410SA/LENOVO BULK	
FINB	2074100GE	(OBS)ICP SATA KIT GDT8546RZ/GE	
FINB	2049700	AAR-2410SA/64MB TEST BULK	
FINB	2170500	AAR-1420SA SGL	
FINB	2063300	AAR-2410SA/64MB/IBM OPTION KIT	
FINB	2147200	AAR-2410SA/64MB/HP BULK	
FINB	2154200	AAR-2410SA/HITACHI BULK	
FINB	2170200	AAR-1420SA Kit	
FINB	2181100	AAR-1420SA Bulk	
FINB	2170200JA	AAR-1420SA/JA Kit	
FINB	2169300EU-R	AAR-2420SA/EFIKS ROHS KIT	
FINB	2170200JA-R	AAR-1420SA/JA RoHS KIT	

Mat Class	Material #	Description	System Products
FINB	2113600-R	AAR-2025SA RoHS KIT	
FINB	1961900JA-R	AAR-2410SA/JA RoHS KIT	
FINB	2170200EU-R	AAR-1420SA/EFIGS RoHS KIT	
FINB	1961900EU-R	AAR-2410SA/EFIGS RoHS KIT	
FINB	2170600-R	AAR-1420SA RoHS 10PK	
FINB	2113400-R	AAR-2020SA RoHS KIT	
FINB	1961900-R	AAR-2410SA RoHS KIT	
FINB	2113500-R	AAR-2020SA RoHS 50-PK	
FINB	2113700-R	AAR-2025SA RoHS 50-PK	
FINB	2138500	ASR-2025ZCR/64MB TEST BULK	
FINB	2170200-R	AAR-1420SA RoHS KIT	
FINB	2154400-R	AAR-2610SA/64MB/HP RoHS BULK	
FINB	1975200	ASA-7211F 5 PK	
FINB	1974700	ASA-7211C INITIATOR BULK	
FINB	1975000	ASA-7211F KIT	
FINB	1974600	ASA-7211F INITIATOR BULK	
FINB	1975300	ASA-7211C 5 PK	
FINB	1975100	ASA-7211C KIT	
FINB	1975100JA	ASA-7211C/JA KIT	
FINB	1901600	AFC-9210 BULK	
FINB	1840600	ACK-LVD-3M-U320	
FINB	2167100	ACK-INT-SATA-FANOUT-0.5M	
FINB	1755000	(OBS)ACK-SS50HD-50HD	
FINB	1977700	ACK-6815-LVD-LP-ROUND-U320	
FINB	1664300	(OBS)ANA-5945 BAG BULK	
FINB	1756400	(OBS)ANA-6944B/TX BAG BULK	
FINB	1868000	ACK-D2L-1M	
FINB	1831200	ACK-6815-LVD CABLE KIT	
FINB	1737000	ANA-62022 SGL KIT	
FINB	993700	(OBS)ACK-H2H	
FINB	2076800	ICP 3101 EXT U320 1M CB VHD-HD	
FINB	1737200	(OBS)ANA-69011/TX SGL KIT	
FINB	1719100	(OBS)ANA-6922/DELL BAG BULK	
FINB	2008300	ACK-RS232-NM-2M	
FINB	1737100	ANA-62044 SGL KIT	
FINB	1736900	ANA-62011/TX SGL KIT	
FINB	1609300	(OBS)ANA-6904/BNC SGL	
FINB	1890200	(OBS)ACK-Cu-HSSDC-HSSDC-2G-1M	
FINB	1742800-0005	ANA-6910/FXSC BAG BULK	
FINB	1778700	(OBS)ANA-6944A/TX EMC BAGBULK	
FINB	2076600	ICP 3201 SATA CABLE	
FINB	1735400	(OBS)ACK-68I-U2W CBL KIT	
FINB	915800	(OBS)ACK-W2W-5I	
FINB	1607800	(OBS)ANA-6901 SGL	
FINB	1865400	AFC-9110G SGL	
FINB	1975900	ANA-7711C 5 PK	
FINB	1965100	ANA-62022AC/FSC2 BULK	

Mat Class	Material #	Description	System Products
FINB	1905500	AFC-9210LP KIT	
FINB	1782300	ANA-6911A/TX EMC BULK	
FINB	1975700	ANA-7711C KIT	
FINB	1977900	ACK-68V-68HD-LVD-2M-T-SILC	
FINB	916200	(OBS)ACK-GCH2L	
FINB	1905600	AFC-9210LPC KIT	
FINB	1669700	ANA-6911A/AUI HP B	
FINB	1735500	(OBS)ACK-U2W-1M CBL KIT	
FINB	1674400	(OBS)ACK-68P-50P(97)	
FINB	1674500	(OBS)ACK-H2H CBL KT(97)	
FINB	1608700	(OBS)ANA-6511/TXC SGL	
FINB	1717800	(OBS)ACK-U2W-3M CBL KIT	
FINB	1872400	AFC-9110G OPTICAL KIT	
FINB	1901700	AFC-9210LP BULK	
FINB	1901400	AFC-9210C BULK	
FINB	1890300	(OBS)ACK-Cu-HSSDC-HSSDC-2G-3M	
FINB	1672400	(OBS)ACK-H2L CBL KT(97)	
FINB	1606600	(OBS)ANA-6911/TXC SGL	
FINB	915900	(OBS)ACK-W2W-E	
FINB	1685900	(OBS)ANA-6911A/TX SVR KIT	
FINB	973100	(OBS)ACK-W2W-5IT	
FINB	1611700	(OBS)ANA-6910/TX SGL	
FINB	1672200	(OBS)ACK-D2D CBL KT(97)	
FINB	1838200	ACK-68V-68HD-LVD-4M-U320	
FINB	1605900	(OBS)ANA-6911/TX SGL	
FINB	1672300	(OBS)ACK-D2H CBL KT(97)	
FINB	995000	(OBS)ACK-68C-68P-E	
FINB	1645400	ANA-6911A/TXC SGL	
FINB	1880100	(OBS)ACK-Cu-HSSDC-HSSDC-3M	
FINB	1879600	(OBS)ACK-Cu-HSSDC-DB9-3M	
FINB	562900	(OBS)ACK-H2L	
FINB	1903200	(OBS)ACK-Cu-HSSDC-DB9-2G-1M	
FINB	1872500	AFC-9110G COPPER KIT	
FINB	961000	(OBS)ACK-INT3-PNP	
FINB	950600	(OBS)ACK-50I-50E	
FINB	1743300	(OBS)ANA6922ATX SIEMENS SVR KT	
FINB	1948000	ACK-68VHDCI-U320	
FINB	1635000	(OBS)ANA-6944A/TX SGL	
FINB	1697500	(OBS)ANA-6944A/TX BAG BULK	
FINB	1841000	(OBS)ACK-D2D-1M	
FINB	1686400	(OBS)ANA-6944A/TX SVR KIT	
FINB	1880000	(OBS)ACK-Cu-HSSDC-HSSDC-1M	
FINB	1818300	ANA-62044/DG BAG BULK	
FINB	1724900JA	ACK-H2N/JA CABLE KIT	
FINB	1643400-0329	ANA-6911/TX OEM BAG BULK	
FINB	1880200	(OBS)ACK-Cu-HSSDC-HSSDC-10M	
FINB	1865200	AFC-5101BK KIT	

Mat Class	Material #	Description	System Products
FINB	1845600	(OBS)ACK-68I-68E-LVD	
FINB	973000	(OBS)ACK-F2F-5IT	
FINB	562800	(OBS)ACK-L2L	
FINB	1724300JA	(OBS)ACK-WP2WP/JA CABLE KIT	
FINB	1620100HL	(OBS)ACK-ASI-H/HL KIT	
FINB	1686200	(OBS)ANA-6922A/TX SVR KIT	
FINB	1771400	(OBS)ANA-5945/1M-SNI BAG BULK	
FINB	1686100	(OBS)ANA-6922A/TX SGL	
FINB	1734700	(OBS)ANA-69011/TX BAG BULK	
FINB	1874400	AFC-5101CP-S99 BULK	
FINB	1977800	ACK-68V-68V-LVD-2M-T-SILC	
FINB	1905700	AFC-9210LP SGL	
FINB	1975800	ANA-7711F 5 PK	
FINB	1782100-0104	(OBS)ANA-6501 BAG BULK	
FINB	1924000	ANA-64044 KIT	
FINB	1608100	(OBS)ANA-6904 SGL	
FINB	1606300	(OBS)ANA-6944/TX SGL	
FINB	1855800	ANA-62022/FSC BULK	
FINB	1663800	(OBS)ANA-6911A/TX SGL	
FINB	1838400	ACK-68V-68V-LVD-10M-U320	
FINB	1975600	ANA-7711F KIT	
FINB	1734600	ANA-62020/FX BAG BULK	
FINB	1880600	ACK-OPT-SC-SC-10M	
FINB	1890100	ACK-Cu-HSSDC-HSSDC-2G-9M	
FINB	1880500	ACK-OPT-SC-SC-5M	
FINB	1734500	ANA-62044 BAG BULK	
FINB	2076700	ICP 8859 INT W/U320 CABLE	
FINB	2076900	ICP 3103 EXT U320 3M CB VHD-HD	
FINB	1866900	(OBS)AFC-5101BK-S99 KIT	
FINB	1633500	ANA-6911A/TX BULK	
FINB	1857500	ANA-64044 BAG BULK	
FINB	1903600	ACK-Cu-HSSDC-DB9-2G-9M	
FINB	1832000	ACK-68F-50HDM	
FINB	1889900	(OBS)ACK-OPT-LC-LC-2G-100M	
FINB	1718200	ACK-50 TERM CBL KIT	
FINB	1735300	ACK-50I-50E CBL KT(98)	
FINB	1671800	(OBS)ANA-6922 BAG BULK	
FINB	1904000	(OBS)ACK-OPT-LC-SC-2G-100M	
FINB	1723100JA	ACK-H2H/JA CABLE KIT	
FINB	1729600	ACK-68I9-LVD CBL KIT	
FINB	1661700	ANA-6911A/TXC 20PK	
FINB	1975700JA	ANA-7711C/JA KIT	
FINB	2163200	ACK-IB-SATA FAN OUT CABLE-0.5M	
FINB	1901500	AFC-9210LPC BULK	
FINB	1890500	(OBS)ACK-Cu-HSSDC-HSSDC-2G-7M	
FINB	1873000	CD-5101BK-S50	
FINB	1831400	ACK-68I5-LVD 10PK	

Mat Class	Material #	Description	System Products
FINB	1734400	ANA-62022 BAG BULK	
FINB	1734300	ANA-62011/TX BAG BULK	
FINB	CBL-DB9MHSDC-03	FCAL CABLE, NON-EQUALIZED	
FINB	1736900JA	ANA-62011/TX SGL JA	
FINB	1975600JA	ANA-7711F/JA KIT	
FINB	1889800	ACK-OPT-LC-LC-2G-25M	
FINB	1816100	ACK-D2D-2M	
FINB	2077100	ICP 3113 EXT U320 3M CB VHDVHD	
FINB	1810600	(OBS)ANA-62044 SEQUENT MDIA PK	
FINB	1887200	ACK-50HDF-50LDM	
FINB	1879700	(OBS)ACK-Cu-HSSDC-DB9-10M	
FINB	1620200HL	(OBS)ACK-ASI-L/HL KIT	
FINB	1850500	ACK-D2H-1M-ICE	
FINB	1737000JA	ANA-62022 SVR JA	
FINB	2077000	ICP 3111 EXT U320 1M CB VHDVHD	
FINB	1633700	ANA-6911A/TXC BULK	
FINB	1903500	(OBS)ACK-Cu-HSSDC-DB9-2G-7M	
FINB	563000	ACK-INT5	
FINB	1956500	ACK-RS232-2M	
FINB	1903300	(OBS)ACK-Cu-HSSDC-DB9-2G-3M	
FINB	1830500	(OBS)ACK-D2H 10PK	
FINB	1915100	ASW-FIBRE CHANNEL INSPECTOR	
FINB	1620200JA	(OBS)ACK-ASI-L/JA CABLE KIT	
FINB	1620100JA	(OBS)ACK-ASI-H/JA CABLE KIT	
FINB	1723600JA	(OBS)ACK-M2WP/JA CABLE KIT	
FINB	1660700	ANA-6911A/TX HPBAG	
FINB	1932600	ANA-64044LV 5PK	
FINB	1932300	ANA-64022LV 5PK	
FINB	1932500	ANA-64044LV KIT	
FINB	1932200	ANA-64022LV KIT	
FINB	1932400	ANA-64044LV BULK	
FINB	1932100	ANA-64022LV BULK	
FINB	1867900	ACK-68V-50LD-1M-T	
FINB	1838600	ACK-68V-68V-LVD-4M-U320	
FINB	1855100	ACK-68V-50HD-1M-T	
FINB	2035400	ACK-68I5-LVD-LP-RND-U320 10PK	
FINB	1838300	ACK-68V-68HD-LVD-6M-U320	
FINB	1986800	ACK-68V-68HD-LVD-1M-U320	
FINB	1841200	ACK-H2H-1M	
FINB	1840500	ACK-LVD-1M-U320	
FINB	1838500	ACK-68V-68V-LVD-2M-U320	
FINB	1838100	ACK-68V-68HD-LVD-2M-U320	
FINB	1718100	ACK-68 TERM-U320	
FINB	986300	ACK-68P-50P-IU	
FINB	1937100	ACK-68V-68V-LVD-1M-U320	
FINB	1816000	ACK-H2L-2M	
FINB	2029700	ACK-68I-68E-LVD-LP-ROUND-U320	

Mat Class	Material #	Description	System Products
FINB	2017100	ACK-68I3-LVD-LP-ROUND-U320	
FINB	1841300	ACK-H2L-1M	
FINB	2138800	ACK-68I6-LVD-LP-RND-U320 10PK	
FINB	2163100	ACK-IB-SATA FAN OUT CABLE-1M	
FINB	1816200	ACK-D2H-2M	
FINB	1815700	ACK-W2H-2M-T	
FINB	2054300	ACK-68I2-LVD-LP-ROUND-U320	
FINB	1815800	ACK-W2L-2M-T	
FINB	1815900	ACK-H2H-2M	
FINB	1841100	ACK-D2H-1M	
FINB	1850400	ACK-H2H-1M-ICE	
FINB	1831500	ACK-68I3-LVD 10PK	
FINB	1723300JA	ACK-H2WP/JA CABLE KIT	
FINB	1840900	ACK-68P-50P	
FINB	2147100	ACK-CU-SFP-SFP-2G-0.5M	
FINB	1831800	ACK-DB25M-50HDF	
FINB	2166400	ACK-EXT-SAS-1M	
FINB	2077200	ICP 8880 EXT W/U160 1M CBL	
FINB	2166700	ACK-EXT-SAS-8M	
FINB	2166600	ACK-EXT-SAS-4M	
FINB	2166900	ACK-INT-SAS-0.5M	
FINB	2166800	ACK-INT-SAS-1M	
FINB	2167000	ACK-INT-SATA-FANOUT-1M	
FINB	2214700-R	ACK-INT-SAS-FANOUT-1M RoHS kit	
FINB	2166500	ACK-EXT-SAS-2M	
FINB	1987200	(OBS)ACK-LVD-2.9M/LUC-CC4 10PK	
FINB	1737100JA	ANA-62044 SVR JA	
FINB	2214600-R	ACK-INT-SAS-FANOUT-.5M RoHSkit	
FINB	1702800	(OBS)AEC-7412B SGL	
FINB	1702600	(OBS)AEC-4412BS8 SGL	
FINB	1740400	(OBS)AEC-5312 BAG BULK	
FINB	1649100	(OBS)AHA-F950 BAG BULK	
FINB	1668300	(OBS)AHA-F940 BAG BULK	
FINB	1732500	(OBS)AEC-7010 FIBRE CH UPGD KI	
FINB	1679600	(OBS)AEC-4312AS SINGLE	
FINB	2025500-R	ACK-UTP-PTCH6-RJ45-RJ45-10FTR	
FINB	1753400-R	ACK-SS26-DB25 RoHS	
FINB	2025400-R	ACK-UTP-PTCH6-RJ45-RJ45-7FTRoH	
FINB	1753200-R	ACK-SS26-50LD RoHS	
FINB	2025300-R	ACK-UTP-PTCH6-RJ45-RJ45-3FTRoH	
FINB	1850700-R	ACK-68V-50HD-1M-T-ICE RoHS	
FINB	1892800-R	ACK-6P-4P-S400-1394 RoHS	
FINB	2020500-R	ACK-1394-6P-6P-6FT RoHS	
FINB	1850600-R	ACK-68V-68HD-LVD-2M-ICE RoHS	
FINB	2020900-R	ACK-1394-4P-4P-6FT RoHS	
FINB	2020700-R	ACK-1394-6P-4P-6FT RoHS	
FINB	2028500-R	ACK-USB2-AB-10FT RoHS	

Mat Class	Material #	Description	System Products
FINB	2028400-R	ACK-USB2-AB-6FT RoHS	
FINB	2057700-R	ACK-1420A-USBPOWERCBL-3FTRoHS	
FINB	1998300-R	ACK-7P-7P-SATA-STCN-.5M RoHS	
FINB	1945600-R	ACK-USB2-2M RoHS	
FINB	2104700-R	ACK-7P-7P-SATA-RTCN-1M-R RoHS	
FINB	1971500-R	ACK-USB2-3M RoHS	
FINB	1998500-R	ACK-7P-7P-SATA-RTCN-.5M RoHS	
FINB	1998200-R	ACK-7P-7P-SATA-STCN-1M RoHS	
FINB	2069800-R	ACK-1411 PWR RoHS KIT	
FINB	1977600-R	ACK-3121 POWER CABLE RoHS	
FINB	1718200-R	ACK-50 TERM CBL RoHS KIT	
FINB	1887200-R	ACK-50HDF-50LDM RoHS	
FINB	1735300-R	ACK-50I-50E CBL RoHS KT(98)	
FINB	1718100-R	ACK-68 TERM-U320 RoHS	
FINB	1832000-R	ACK-68F-50HDM RoHS	
FINB	2054300-R	ACK-68I2-LVD-LP-RND-U320 RoHS	
FINB	2017100-R	ACK-68I3-LVD-LP-RND-U320 RoHS	
FINB	1831200-R	ACK-68I5-LVD CABLE RoHS KIT	
FINB	1977700-R	ACK-68I5LVD-LP-ROUND-U320 RoHS	
FINB	2029700-R	ACK-68I-68E-LVD-LP-RND-U320 R	
FINB	1729600-R	ACK-68I9-LVD CBL RoHS KIT	
FINB	1840900-R	ACK-68P-50P RoHS	
FINB	986300-R	ACK-68P-50P-IU RoHS	
FINB	1855100-R	ACK-68V-50HD-1M-T RoHS	
FINB	1867900-R	ACK-68V-50LD-1M-T RoHS	
FINB	1986800-R	ACK-68V-68HD-LVD-1M-U320 RoHS	
FINB	1977900-R	ACK-68V-68HD-LVD2M-T-SILC RoHS	
FINB	1838100-R	ACK-68V-68HD-LVD-2M-U320RoHS	
FINB	1838300-R	ACK-68V-68HD-LVD-6M-U320RoHS	
FINB	1838400-R	ACK-68V-68V-LVD-10M-U320 RoHS	
FINB	1838500-R	ACK-68V-68V-LVD-2M-U320 RoHS	
FINB	1838600-R	ACK-68V-68V-LVD-4M-U320 RoHS	
FINB	1948000-R	ACK-68VHDCI-U320 RoHS	
FINB	1816100-R	ACK-D2D-2M RoHS	
FINB	1841100-R	ACK-D2H-1M RoHS	
FINB	1850500-R	ACK-D2H-1M-ICE RoHS	
FINB	1816200-R	ACK-D2H-2M RoHS	
FINB	1868000-R	ACK-D2L-1M RoHS	
FINB	1831800-R	ACK-DB25M-50HDF RoHS	
FINB	1841200-R	ACK-H2H-1M RoHS	
FINB	1850400-R	ACK-H2H-1M-ICE RoHS	
FINB	1815900-R	ACK-H2H-2M RoHS	
FINB	1841300-R	ACK-H2L-1M RoHS	
FINB	1816000-R	ACK-H2L-2M RoHS	
FINB	2163200-R	ACK-IB-SATA FAN OUT CBL-0.5M R	
FINB	2163100-R	ACK-IB-SATA FANOUT CBL-1M RoHS	
FINB	563000-R	ACK-INT5 RoHS	

Mat Class	Material #	Description	System Products
FINB	1840500-R	ACK-LVD-1M-U320 RoHS	
FINB	1840600-R	ACK-LVD-3M-U320 RoHS	
FINB	1889800-R	ACK-OPT-LC-LC-2G-25M RoHS	
FINB	1815700-R	ACK-W2H-2M-T RoHS	
FINB	1815800-R	ACK-W2L-2M-T RoHS	
FINB	1937100-R	sACK-68V-68V-LVD-1M-U320 RoHS	
FINB	2025600-R	ACK-UTP-PTCH6-RJ45-RJ45-14FTRo	
FINB	1753000-R	ACK-SS26-50HD RoHS	
FINB	1892900-R	ACK-6P-6P-S400-1394 RoHS	
FINB	1998400-R	ACK-7P-7P-SATA-RTCN-1M RoHS	
FINB	2057800-R	ACK-SATA POWERCABLE-8INCH RoHS	
FINB	1980300NK	AVC-2010/NK VIDEO PCI KIT	
FINB	1980200NK	AVC-2210/NK VIDEO DVD USB KIT	
FINB	2042900AU	AVC-2310/AU VIDEO TV USB KIT	
FINB	2042900	AVC-2310 VIDEO TV USB KIT	
FINB	2109100	AVC-1200 VIDEO CD USB KIT	
FINB	2052500	AVC-2210 BULK	
FINB	2043000ENFR	AVC-2410/ENFR VIDEO TV PCI KIT	
FINB	1980200CAN	AVC-2200 VIDEO DVD USB/CAN KIT	
FINB	2052800	AVC-2010 BULK	
FINB	2053700JA	AVC-2410/JA NTSC BULK	
FINB	1980300JA	(OBS)AVC-2000/JA KIT	
FINB	1980200	AVC-2210 VIDEO DVD USB KIT	
FINB	2042900UK	AVC-2310/UK VIDEO TV USB KIT	
FINB	1980300	AVC-2010 VIDEO PCI KIT	
FINB	2042900ENFR	AVC-2310/ENFR VIDEO TV USB KIT	
FINB	2043000	AVC-2410 VIDEO TV PCI KIT	
FINB	2042900GE	AVC-2310/GE VIDEO TV USB KIT	
FINB	1980400	AVC-1100 VIDEO CD USB KIT	
FINB	1980400ENFR	AVC-1100 VIDEO CD USB/ENFR KIT	
FINB	1980400GE	AVC-1100 VIDEO CD USB/GE KIT	
FINB	1980300GE	AVC-2010/GE VIDEO PCI KIT	
FINB	2043000GE	AVC-2410/GE VIDEO TV PCI KIT	
FINB	2042900NK	AVC-2310/NK VIDEO TV USB KIT	
FINB	2042900ITSP	AVC-2310/ITSP VIDEO TV USB KIT	
FINB	2043000NK	AVC-2410/NK VIDEO TV PCI KIT	
FINB	2043000UK	AVC-2410/UK VIDEO TV PCI KIT	
FINB	1980200ENFR	AVC-2210/ENFR VIDEO DVD USB KT	
FINB	1980300ENFR	AVC-2010/ENFR VIDEO PCI KIT	
FINB	1980200UK	AVC-2210/UK VIDEO DVD USB KIT	
FINB	2043000JA	AVC-2410/JA KIT	
FINB	1980200GE	AVC-2210/GE VIDEO DVD USB KIT	
FINB	1980200ITSP	AVC-2210/ITSP VIDEO DVD USB KT	
FINB	2109100NK	AVC-1200/NK VIDEO CD USB KIT	
FINB	1980300ITSP	AVC-2010/ITSP VIDEO PCI KIT	
FINB	1980400ITSP	AVC-1100 VIDEO CD USB/ITSP KIT	
FINB	2043000ITSP	AVC-2410/ITSP VIDEO TV PCI KIT	

Mat Class	Material #	Description	System Products
FINB	2042800JA	AVC-2210/JA KIT	
FINB	2042900CAN	AVC-2310/CAN VIDEO TV USB KIT	
FINB	2144600	AVC-3610 VIDEO DUO TV USB KIT	
FINB	2042900JA	AVC-2310/JA KIT	
FINB	2057000JA	AVC-2010/JA KIT	
FINB	1980200AU	AVC-2210 VIDEO DVD USB/AU KIT	
FINB	1980200JA	(OBS)AVC-2200/JA KIT	
FINB	2217300JA	AVC-1410JA/Bufalo Kit	
FINB	2177500	AVC-1500 VIDEO DVD USB KIT	
FINB	2177600	AVC-1510 VIDEO TV USB KIT	
FINB	2184100	AVC-3610/HP MISC CABLE KIT	
FINB	2184000	AVC-3610/HP PWR/AC ADAPTER	
FINB	1980300-R	AVC-2010 RoHS VIDEO PCI KIT	
FINB	1980300ENFR-R	AVC-2010/ENFR RoHSVIDEO PCI KT	
FINB	1980200-R	AVC-2210 VIDEO DVD USB RoHS KT	
FINB	1980200ENFR-R	AVC-2210/ENFR VDO DVD USB R KT	
FINB	1980200GE-R	AVC-2210/GE VIDEO DVD USB R KT	
FINB	1980200UK-R	AVC-2210/UK VIDEO DVD USB R KT	
FINB	2042900-R	AVC-2310 VIDEO TV USB RoHS KIT	
FINB	2042900ENFR-R	AVC-2310/ENFR VDO TV USB R KIT	
FINB	2042900GE-R	AVC-2310/GE VDO TV USB R KIT	
FINB	2042900ITSP-R	AVC-2310/ITSP VDO TV USB R KIT	
FINB	2042900UK-R	AVC-2310/UK VDO TV USB R KIT	
FINB	2043000-R	AVC-2410 VIDEO TV PCI RoHS KIT	
FINB	2144700	AVC-3610/HP NTSC VIDEO TV KIT	
FINB	953400	(OBS)AHA-2920 KIT	
FINB	1738500JA	AHA-2910C/FUJITSU KIT	
FINB	1870600EU	APD-29160 MAC/EU KIT	
FINB	1790700	AVA-2906 10-PACK	
FINB	1624900	(OBS)AVA-1502AI BAG BLK	
FINB	1796200JA	AHA-2930U MAC/JA KIT	
FINB	1827500	APD-39160 MAC KIT	
FINB	1856600	USB-Xchange KIT	
FINB	1811300	(OBS)AVA-2902B BAG BULK	
FINB	1827500JA	APD-39160 MAC/JA KIT	
FINB	907800	(OBS)AHA-1540CP BAG BLK	
FINB	1827400	APD-39160 MAC BAG BULK	
FINB	1812800	AVA-2903B BAG BULK	
FINB	929100	(OBS)AHA-1542CP SINGLE	
FINB	930800	(OBS)AHA-1522B BAG BULK	
FINB	965300	(OBS)AHA-1520B KIT	
FINB	1604000	(OBS)AHA-3940UW MAC+ K	
FINB	1748200	(OBS)AHA-2940U2W/MAC BAG BULK	
FINB	1793600	(OBS)AHA-2940U2B APPLE/MAC BLK	
FINB	956100	(OBS)AHA-2940UW/MAC BAG	
FINB	930600	(OBS)AHA-1520B BAG BULK	
FINB	1811500	(OBS)AVA-2902BI BAG BULK	

Mat Class	Material #	Description	System Products
FINB	1604100	(OBS)AHA-3944UW MAC+ K	
FINB	930400	(OBS)AHA-1510B BAG BULK	
FINB	1847300	APD-1480 MAC KIT	
FINB	1672700	(OBS)AVA-2902E RTL(97)	
FINB	1796200	AHA-2930U MAC KIT	
FINB	1601200	(OBS)AHA-3944UW/MAC SGL	
FINB	1627200	(OBS)AVA-1505AE BAG BLK	
FINB	1808700	APA-1460D BAG BULK HD50	
FINB	1808500JA	AVA-2906 MAC/JA KIT	
FINB	1747800	(OBS)AVA-2902A BAG BULK	
FINB	1739400	(OBS)APA-1450C BAG BULK HD50	
FINB	1780700	AVA-2906 BAG BULK	
FINB	1713800	(OBS)AHA-2920C KIT	
FINB	1847300EU	APD-1480 MAC/EFIGS KIT	
FINB	1811700	AVA-2904BE BAG BULK	
FINB	1620900	(OBS)AHA-2930B BAG BULK	
FINB	1649300	AVA-2904 BAG BULK	
FINB	1624700	(OBS)AVA-1502AE BAG BLK	
FINB	1626400	(OBS)APA-358 SCSI-1 KIT	
FINB	586500	(OBS)AVA-1515 KIT	
FINB	1671700	(OBS)AVA-1505AE RTL(97)	
FINB	1642100EU	(OBS)AVA-1505/EFIGS KIT	
FINB	1773200	(OBS)APA-1350 PARALLEL KIT	
FINB	1663700	(OBS)AHA-2930B MAC TRAY	
FINB	585000	(OBS)AVA-1505 TRAY BULK	
FINB	1893000	APD-29160 MAC BULK	
FINB	1757200	(OBS)AHA-2940U2B/MAC BAG BULK	
FINB	923900	(OBS)AHA-1542CP KIT	
FINB	1697700	AHA-2920C BAG BULK	
FINB	936000	(OBS)APA-358A SCSI2 KIT	
FINB	1681600	(OBS)APA-1460B TRAY 50HD	
FINB	1642400JA	(OBS)AHA-1510B/FUJI-2KT	
FINB	1839300	AHA-2930CU MAC/APPLE2 BULK	
FINB	1816800	APA-1460C/IOMEGA JAZ BULK	
FINB	1832500	AVA-2903B/EPSON BAG BULK	
FINB	1818700	(OBS)USB-2000 KIT	
FINB	1680400	(OBS)APA-1460B KIT	
FINB	1878300	AVA-2915LP/L BULK	
FINB	1821200	AVA-2902BE/EPSON BAG BULK	
FINB	1705900JA	(OBS)APA-1450B/MELCO BULK	
FINB	1806700	(OBS)APA-1460 WIN CE DISK KIT	
FINB	1796100	AHA-2930CU MAC BAG BULK	
FINB	584800	(OBS)AVA-1505 BAG BULK	
FINB	1655000	(OBS)AVA-2902I BAG BULK	
FINB	1731100	(OBS)AHA-2930CU BAG BULK	
FINB	1768500	(OBS)AHA-3950U2B/MAC BAG BULK	
FINB	568900	(OBS)AHA-1542CFS5 BULK	

Mat Class	Material #	Description	System Products
FINB	905000	(OBS)APA-1460 BAG/SCSI	
FINB	1641900	(OBS)AHA-2910B KIT	
FINB	1847300JA	APD-1480 MAC/JA KIT	
FINB	1662200	AHA-2930U KIT	
FINB	1836700	APD-29160N MAC KIT	
FINB	1827500EU	APD-39160 MAC/EU KIT	
FINB	1836700EU	APD-29160N MAC/EU KIT	
FINB	1808500EU	AVA-2906 MAC/EU RTL KIT	
FINB	1640100	(OBS)AHA-1520B SINGLE	
FINB	1870600	APD-29160 MAC KIT	
FINB	1725800	(OBS)AVA-1505A KIT	
FINB	1688400	(OBS)APA-358 COMBO KIT	
FINB	1796200EU	AHA-2930U MAC/EU KIT	
FINB	1814200	(OBS)AVA-2903B/IOMEGA BAG BULK	
FINB	1648500	(OBS)AHA-1520B/FUJITSU	
FINB	1870600JA	APD-29160 MAC/JA KIT	
FINB	1725500	(OBS)AVA-1505A BAG BLK	
FINB	1836800	APD-29160N MAC 10 PK	
FINB	1866800	(OBS)AHA-2930C/EPSON BULK	
FINB	1814300	AHA-2930U MAC 10-PACK	
FINB	1797900	(OBS)AVA-2902E/CANON BAG BULK	
FINB	1748700	AHA-2930C POEM BAG BULK	
FINB	907600	(OBS)AHA-1542CP BAG BLK	
FINB	981300	(OBS)AHA-3940UW/MAC SGL	
FINB	990400HL	(OBS)APA-1460A/HL97 KIT	
FINB	1816700	(OBS)APA-1460C/IOMEGA ZIP BULK	
FINB	1682000	(OBS)APA-1480A TRAY 50HD	
FINB	944100	(OBS)ASW-REMUS SOFTWARE	
FINB	1873100	(OBS)APA-1480A/FUJITSU BULK	
FINB	1891800EU	AVA-2904/EFIKS KIT	
FINB	1772900	AVA-2906 KIT PC/MAC	
FINB	1965400	AHA-2930U 10 PK	
FINB	1807600	APA-1460D KIT	
FINB	1662200EU	AHA-2930U/EFIKS KIT	
FINB	1680400EU	APA-1460B/EFIKS KIT	
FINB	1873500JA	AVA-2930LP/JA KIT	
FINB	1989900	USB2-Xchange KIT	
FINB	1873200	AVA-2915LP BULK	
FINB	2002900	AVA-2930LP 10 PK	
FINB	1662000EU	APA-1480A/EFIKS KIT	
FINB	1856600EU	USB-Xchange/EFIKS KIT	
FINB	1662000	APA-1480A KIT	
FINB	1873400JA	AVA-2915LP/JA KIT	
FINB	1713900JA	AHA-2910C/JA KIT	
FINB	1989900JA	USB2-Xchange/JA KIT	
FINB	1697900	AHA-2910C BAG BULK	
FINB	1856600JA	USB-Xchange/JA KIT	

Mat Class	Material #	Description	System Products
FINB	1873300	AVA-2930LP BULK	
FINB	1662200JA	AHA-2930U/JA RTL KIT	
FINB	1701800	AHA-2930C BAG BULK	
FINB	1836700JA	APD-29160N MAC/JA KIT	
FINB	1714200	AHA-2915C BAG BULK	
FINB	1738800JA	APA-1460B/FUJITSU KIT	
FINB	1810100JA	APA-1460D-L/JA RTL KIT	
FINB	1810000JA	APA-1460D-H/JA RTL KIT	
FINB	1862900JA	APA-1480/JA KIT	
FINB	1811400	AVA-2902BE BAG BULK	
FINB	1873300-R	AVA-2930LP RoHS BULK	
FINB	1873200-R	AVA-2915LP RoHS BULK	
FINB	1873400JA-R	AVA-2915LP/JA RoHS KIT	
FINB	1713900	(OBS)AHA-2910C KIT	
FINB	992000	(OBS)AHA-2930 BAG BULK	
FINB	992200	(OBS)AHA-2930 TRAY BULK	
FINB	1680500	(OBS)APA-1450B KIT	
FINB	1827600	APD-29160N MAC BULK	
FINB	1870700	APD-29160 MAC SGL	
FINB	599200	(OBS)APA-348 PLUS BULK	
FINB	1862900JA-R	APA-1480/JA RoHS KIT	
FINB	1810100JA-R	APA-1460D-L/JA RTL RoHS KIT	
FINB	1810000JA-R	APA-1460D-H/JA RTL RoHS KIT	
FINB	1713900JA-R	AHA-2910C/JA RoHS KIT	
FINB	1873500JA-R	AVA-2930LP/JA RoHS KIT	
FINB	1662000EU-R	APA-1480A/EFIGS RoHS KIT	
FINB	1680400EU-R	APA-1460B/EFIGS RoHS KIT	
FINB	2002900-R	AVA-2930LP RoHS 10 PK	
FINB	1807600-R	APA-1460D RoHS KIT	
FINB	1662000-R	APA-1480A RoHS KIT	
FINB	1891800EU-R	AVA-2904/EFIGS RoHS KIT	
FINB	1923600	AUA-3020A 10 PK	
FINB	1716200	(OBS)AHA-8945 RETAIL KIT	
FINB	1933300EU	AUH-4000/EFIGS KIT	
FINB	1950000	AUA-1420A KIT	
FINB	1933300JA	AUH-4000/JA KIT	
FINB	2053200	AFW-1430V KIT	
FINB	1933600	AUH-4000PLUS AUSTRALIA KIT	
FINB	1936900	(OBS)AFW-4300 DVPICS PLUS KIT	
FINB	2000300	AUA-4000C KIT	
FINB	2029500	AUA-5100B BULK	
FINB	1992200JA	AUH-4100/JA KIT	
FINB	2052900JA	AUH-4400/JA KIT	
FINB	2101600-R	AFW-2100/HP RoHs Bulk	
FINB	1933700ENFR	AUH-7000PLUS/ENFR KIT	
FINB	1935400AU	AUH-4000BNDL/AU KIT	
FINB	1933500	AUH-4000PLUS KIT	

Mat Class	Material #	Description	System Products
FINB	2126600	AUA-1422CS KIT	
FINB	2091300	AFW-4300ACS KIT	
FINB	1933700	AUH-7000PLUS KIT	
FINB	1933700UK	AUH-7000PLUS/UK KIT	
FINB	1933500EU	AUH-4000PLUS/EFIKS KIT	
FINB	1719900	(OBS)AHA-8945/DPS BAG BULK	
FINB	1933300	AUH-4000 KIT	
FINB	1992200ITSP	AUH-4100/ITSP KIT	
FINB	1992200UK	AUH-4100/UK KIT	
FINB	1935400EU	AUH-4000BNDL/EU KIT	
FINB	1914500	(OBS)AFW-4300 DV KIT	
FINB	1705700	(OBS)AHA-8920 BAG BULK	
FINB	1933300UK	AUH-4000/UK KIT	
FINB	2033300	AFW-4300V KIT	
FINB	1993200	AUA-4000A BULK	
FINB	1933000	AUA-2000LP BULK	
FINB	2053000ITSP	AUH-2000/ITSP KIT	
FINB	1916600	(OBS)AUA-3100LP BULK	
FINB	1623800	(OBS)AHA-8940 TRAY BULK	
FINB	1711700	(OBS)AHA-8920 RETAIL KIT	
FINB	1812900	(OBS)AHA-8945CP/MATROX BAG BK	
FINB	2053100	AUA-1420V KIT	
FINB	2126700	ASH-1233CS ULTRA ATA/133 CARD	
FINB	2132000	AUA-3020ACS KIT	
FINB	2045100	AUA-1411 KIT	
FINB	1932800	AFW-1430 KIT	
FINB	1936800	AFW-4300 FCONN PLUS KIT	
FINB	1965900	AUA-2000LP 50 PK	
FINB	1712900	(OBS)AHA-8945CP BAG BULK	
FINB	2053000JA	AUH-2000/JA KIT	
FINB	2033200	AUA-4000V KIT	
FINB	1933500UK	AUH-4000PLUS/UK KIT	
FINB	1923700	AUA-5100 10 PK	
FINB	1923400	AUA-5100 KIT	
FINB	2053000ENFR	AUH-2000/ENFR KIT	
FINB	1933700EU	AUH-7000PLUS/EFIKS KIT	
FINB	1923800	AUA-3100LP 10 PK	
FINB	1992200ENFR	AUH-4100/ENFR KIT	
FINB	1935400UK	AUH-4000BNDL/UK KIT	
FINB	1992200GE	AUH-4100/GE KIT	
FINB	1936800EU	AFW-4300 FCONN PLUS/EFIKS KIT	
FINB	1933500JA	AUH-4000PLUS/JA KIT	
FINB	1983700	AUA-4000/DELL BULK	
FINB	2045100EU	AUA-1411/EU KIT	
FINB	1933800	AUH-7000PLUS AUSTRALIA KIT	
FINB	1933400	AUH-4000 AUSTRALIA KIT	
FINB	1926300	AFW-4300 BAG BULK	

Mat Class	Material #	Description	System Products
FINB	1623700	(OBS)AHA-8940 BAG BULK	
FINB	2053000UK	AUH-2000/UK KIT	
FINB	2052900ITSP	AUH-4400/ITSP KIT	
FINB	2052900UK	AUH-4400/UK KIT	
FINB	1933700JA	AUH-7000PLUS/JA KIT	
FINB	1982200	AFW-4300 DVPICS PLUS RTL KIT	
FINB	2043400	AUA-2000B BULK	
FINB	2045100JA	AUA-1411/JA KIT	
FINB	1935400JA	AUH-4000BNDL/JA KIT	
FINB	2053000GE	AUH-2000/GE KIT	
FINB	2126900	AUA-2000CS KIT	
FINB	2126500	AUA-5100CS KIT	
FINB	2065200	AFW-8300A KIT	
FINB	2047600	ASH-1205SA KIT	
FINB	2047600EU	ASH-1205SA/EFIGS KIT	
FINB	1992900	AFW-4300 50 PK	
FINB	1950000EU	AUA-1420A/EFIGS KIT	
FINB	1923400EU	AUA-5100/EFIGS KIT	
FINB	1890600EU	AFW-4300A/EFIGS KIT	
FINB	1935400	AUH-4000BNDL KIT	
FINB	1929600	AFW-4300 10 PK	
FINB	1923200EU	AUA-3020A/EFIGS KIT	
FINB	2052900	AUH-4400 KIT	
FINB	1992200	AUH-4100 KIT	
FINB	1932800EU	AFW-1430/EFIGS KIT	
FINB	1913500	AUA-3100LP KIT	
FINB	1923200	AUA-3020A KIT	
FINB	1913500EU	AUA-3100LP/EFIGS KIT	
FINB	2004600	AUA-2000 KIT	
FINB	2124100	AFW-2100 2-PORT LP BRKT 50PK	
FINB	2047600JA	ASH-1205SA/JA KIT	
FINB	1923400JA	AUA-5100/JA KIT	
FINB	2004600JA	AUA-2000/JA KIT	
FINB	1913500JA	AUA-3100LP/JA KIT	
FINB	2052900GE	AUH-4400/GE KIT	
FINB	2052900ENFR	AUH-4400/ENFR KIT	
FINB	1950000JA	AUA-1420A/JA KIT	
FINB	2053000AU	AUH-2000/AU KIT	
FINB	2052900AU	AUH-4400/AU KIT	
FINB	2030600JA	AUA-3020/JA KIT	
FINB	2004600JA-R	AUA-2000/JA RoHS KIT	
FINB	1993100	(OBS)AUA-4000A/DELL BULK	
FINB	1914500JA	(OBS)AFW-4300 DV/JA KIT	
FINB	2212000	AUA-2000B/KODAK BULK	
FINB	1925200	AUA-3121 BULK	
FINB	1934900	AUH-4000 STD BULK	
FINB	2053000	AUH-2000 KIT	

Mat Class	Material #	Description	System Products
FINB	1992200AU	AUH-4100/AU KIT	
FINB	1890600	AFW-4300A KIT	
FINB	2045300	ASH-1205SA BULK	
FINB	1950000RP	AUA-1420 REPACK KIT	
FINB	1932800RP	AFW-1430 REPACK KIT	
FINB	2000300RP	AUA-4000 REPACK KIT	
FINB	2013900	AUA-5100A BULK	
FINB	2228000	AUA-7500A Media Reader	
FINB	2146700	ASH-1205CS KIT	
FINB	2047700	ASH-1205SA 10 PK	
FINB	2065200EU	AFW-8300A/EU KIT	
FINB	2030600JA-R	AUA-3020/JA RoHS KIT	
FINB	1923200EU-R	AUA-3020A/EFIGS RoHS KIT	
FINB	1923400-R	AUA-5100 RoHS KIT	
FINB	1923200-R	AUA-3020A RoHS KIT	
FINB	1923700-R	AUA-5100 RoHS 10 PK	
FINB	2065200EU-R	AFW-8300A/EU RoHS KIT	
FINB	1929600-R	AFW-4300 RoHS 10 PK	
FINB	1950000-R	AUA-1420A RoHS KIT	
FINB	2047600JA-R	ASH-1205SA/JA RoHS KIT	
FINB	1913500JA-R	AUA-3100LP/JA RoHS KIT	
FINB	1950000JA-R	AUA-1420A/JA RoHS KIT	
FINB	1950000EU-R	AUA-1420A/EFIGS RoHS KIT	
FINB	1923400JA-R	AUA-5100/JA RoHS KIT	
FINB	2047700-R	ASH-1205SA RoHS 10 PK	
FINB	2065200-R	AFW-8300A RoHS KIT	
FINB	2004600-R	AUA-2000 RoHS KIT	
FINB	1992900-R	AFW-4300 RoHS 50 PK	
FINB	1923400EU-R	AUA-5100/EFIGS RoHS KIT	
FINB	1932800-R	AFW-1430 RoHS KIT	
FINB	1989900JA-R	USB2-Xchange/JA RoHS KIT	
FINB	1913500-R	AUA-3100LP RoHS KIT	
FINB	2126700-R	ASH-1233CS UL ATA133 RoHS CARD	
FINB	1913500EU-R	AUA-3100LP/EFIGS RoHS KIT	
FINB	1932800EU-R	AFW-1430/EFIGS RoHS KIT	
FINB	2126600-R	AUA-1422CS RoHS KIT	
FINB	2047600EU-R	ASH-1205SA/EFIGS RoHS KIT	
FINB	1890600EU-R	AFW-4300A/EFIGS RoHS KIT	
FINB	1890600-R	AFW-4300A RoHS KIT	
FINB	1989900-R	USB2-Xchange RoHS KIT	
FINB	2146700-R	ASH-1205CS RoHS KIT	
FINB	2053100-R	AUA-1420V RoHS KIT	
FINB	2033200-R	AUA-4000V RoHS KIT	
FINB	2047600-R	ASH-1205SA RoHS KIT	
FINB	2091300-R	AFW-4300ACS RoHS KIT	
FINB	2126500-R	AUA-5100CS RoHS KIT	
FINB	2053200-R	AFW-1430V RoHS KIT	

Mat Class	Material #	Description	System Products
FINB	2126900-R	AUA-2000CS RoHS KIT	
FINB	1856600EU-R	(OBS)USB-Xchange/EFIGSRoHS KIT	
FINB	1856600-R	(OBS)USB-XchangeRoHS KIT	
FINB	1936800EU-R	AFW-4300 FW PLUS EFIG RoHS KIT	
FINB	2000300-R	AUA-4000C RoHS KIT	
FINB	2132000-R	AUA-3020ACS RoHS KIT	
FINB	2188700	ACS-120 2.5 USB HDD ENCL. KIT	
FINB	2188800	ACS-200 USB/1394 HDD ENCL. KIT	
FINB	2177400	ACS-100 USB HDD Enclosure KIT	
FINB	2127100	ACC-9100 KIT	
FINB	984700	(OBS)ACK-1460-25	
FINB	998400	(OBS)ACK-1460A-50LD	
FINB	2127200	ACC-9800 KIT	
FINB	2012400	(OBS)AWN-8030 PC CARD KIT	
FINB	2020700	ACK-1394-6P-4P-6FT	
FINB	2012600UK	(OBS)AWN-8084/UK ROUTER KIT	
FINB	2009200ITSP	AVS-MYDVD MS/ITSP KIT v4	
FINB	2012300UK	(OBS)AWN-8020/UK USB KIT	
FINB	2012600GE	(OBS)AWN-8084/GE RTR 4-PT KIT	
FINB	2012600	(OBS)AWN-8084 RTR 4-PT KIT	
FINB	2012200	(OBS)AWN-8010 PCI KIT	
FINB	998600	(OBS)ACK-1460A-25	
FINB	2028400	ACK-USB2-AB-6FT	
FINB	1893800	(OBS)ACK-68I3-LVD-ICE	
FINB	2063800	(OBS)AVS-MYDVD SVE KIT	
FINB	2127000	ACC-9500 KIT	
FINB	998500	(OBS)ACK-1460A-50HD	
FINB	2012300	(OBS)AWN-8020 USB KIT	
FINB	2012500FR	(OBS)AWN-8060/FR ACCESS PT KIT	
FINB	984800	(OBS)ACK-1460-50LD	
FINB	2012600FR	(OBS)AWN-8084/FR ROUTER KIT	
FINB	2012500GE	(OBS)AWN-8060/GE ACCESS POINT	
FINB	2012600SP	(OBS)AWN-8084/SP ROUTER KIT	
FINB	1752700	(OBS)ACK-SS32-50HD	
FINB	2012500IT	(OBS)AWN-8060/IT ACCESS PT KIT	
FINB	2012500SP	(OBS)AWN-8060/SP ACCESS PT KIT	
FINB	2012600IT	(OBS)AWN-8084/IT ROUTER KIT	
FINB	2012400IT	(OBS)AWN-8030/IT PC CARD KIT	
FINB	2012400SP	(OBS)AWN-8030/SP PC CARD KIT	
FINB	2012400FR	(OBS)AWN-8030/FR PC CARD KIT	
FINB	2127300	ACC-9700 KIT	
FINB	2012300FR	(OBS)AWN-8020/FR USB KIT	
FINB	2012400UK	(OBS)AWN-8030/UK PC CARD KIT	
FINB	1753100	(OBS)ACK-SS32-50LD	
FINB	2131900	ACC-9200 KIT	
FINB	2012300GE	(OBS)AWN-8020/GE USB KIT	
FINB	1684000	(OBS)ACK-6P-6P CABLE KIT	

Mat Class	Material #	Description	System Products
FINB	2009200	(OBS)AVS-MYDVD MS KIT v4	
FINB	2002800ITSP	AVS-MYDVD VS/ITSP KIT v4	
FINB	2009200CAN	AVS-MYDVD MS/CAN KIT v4	
FINB	2002800GE	AVS-MYDVD VS/GE KIT v4	
FINB	2002800ENFR	(OBS)AVS-MYDVD VS/ENFR KIT v4	
FINB	2002800CAN	AVS-MYDVD VS/CAN KIT v4	
FINB	2012500UK	(OBS)AWN-8060/UK ACCESS PT KIT	
FINB	2009200UK	AVS-MYDVD MS/UK KIT V4	
FINB	2063700	AVS-MYDVD SD KIT	
FINB	2012500	(OBS)AWN-8060 ACCESS POINT KIT	
FINB	2012400GE	(OBS)AWN-8030/GE PC CARD KIT	
FINB	984900	(OBS)ACK-1460-50HD	
FINB	1753300	(OBS)ACK-SS32-DB25	
FINB	2063900	AVS-RECORDNOW DELUXE KIT	
FINB	2025600	ACK-UTP-PTCH6-RJ45-RJ45-14FT	
FINB	1977600	ACK-3121 POWER CABLE	
FINB	2025300	ACK-UTP-PTCH6-RJ45-RJ45-3FT	
FINB	1753400	ACK-SS26-DB25	
FINB	2012300IT	(OBS)AWN-8020/IT USB KIT	
FINB	2069800	ACK-1411 PWR KIT	
FINB	2009200GE	AVS-MYDVD MS/GE KIT v4	
FINB	2025400	ACK-UTP-PTCH6-RJ45-RJ45-7FT	
FINB	1989000JA	ACK-1420A/JA PWR KIT	
FINB	2009200ENFR	AVS-MYDVD MS/ENFR KIT v4	
FINB	1753000	ACK-SS26-50HD	
FINB	1945600	ACK-USB2-2M	
FINB	2104700	ACK-7P-7P-SATA-RTCN-1M-R	
FINB	1850700	ACK-68V-50HD-1M-T-ICE	
FINB	1850600	ACK-68V-68HD-LVD-2M-ICE	
FINB	1892900	ACK-6P-6P-S400-1394	
FINB	1892800	ACK-6P-4P-S400-1394	
FINB	2020500	ACK-1394-6P-6P-6FT	
FINB	2020900	ACK-1394-4P-4P-6FT	
FINB	2057800	ACK-SATA POWER CABLE-8INCH	
FINB	1998300	ACK-7P-7P-SATA-STCN-.5M	
FINB	1998400	ACK-7P-7P-SATA-RTCN-1M	
FINB	1998200	ACK-7P-7P-SATA-STCN-1M	
FINB	1971500	ACK-USB2-3M	
FINB	2057700	ACK-1420A-USB POWER CABLE-3FT	
FINB	2025500	ACK-UTP-PTCH6-RJ45-RJ45-10FT	
FINB	1998500	ACK-7P-7P-SATA-RTCN-.5M	
FINB	2028500	ACK-USB2-AB-10FT	
FINB	2002800	(OBS)AVS-MYDVD KIT v4	
FINB	1788300JA	ACK-1460B/HD FUJITSU KIT	
FINB	2168000	ACC-9520-AMD KIT	
FINB	2012300SP	(OBS)AWN-8020/SP USB KIT	
FINB	2168100	ACC-9540-INTEL KIT	

Mat Class	Material #	Description	System Products
FINB	1933900	(OBS)PDS-GOBACK 3 DELUXE TC	
FINS	2065500	AAR-2410SA ENCL KIT	
FINS	2095700	AAR-2410SA ENCL KT BLACK	
FINS	2095700EU	AAR-2410SA/EFIQS ENCL KT BLACK	
FINS	2065500EU	AAR-2410SA/EFIQS ENCL KIT	
FINS	2095700JA	AAR-2410SA/JA ENCL KT BLACK	
FINS	2065500JA	AAR-2410SA/JA ENCL KIT	
FINS	CBL-OPTMLCLC-10	10M, 2GB, FC OPT CABLE	
FINS	CBL-HSDCHSDC2-06	6 M, 2GB FC CU CABLE,	
FINS	CBL-RS232DB9FR	RS232 CABLE FOR FS4500	
FINS	CBL-RS232DB9FJ	RS232 CABLE FOR FS4100	
FINS	CBL-SFPSFP-3.0	FC CU CABLE DUAL SFP 3M	
FINS	CBL-SFPHSDC-2.0	FC CU CABLE SFP-HSSDC 2M	
FINS	CBL-620M620M3-05	5M U320 CABLE	
FINS	CBL-HSDCHSDC-0.5	FCAL CABLE, NON-EQUALIZED R000	
FINS	2131800	ACK-CU-HSSDC-HSSDC-2G-0.3M	
FINS	CBL-DB9MHSDC-10	FCAL CABLE, NON-EQUALIZED	
FINS	CBL-HSDCHSDC2-0.3	0.3 M, 2GB FC CU CABLE	
FINS	CBL-620M620M3-02	2M U320 CABLE	
FINS	CBL-HSDCHSDC2-03	3 M, 2GB FC CU CABLE,	
FINS	CBL-RS232DB9F2	FFX2 3 PIN, DB9F CABLE	
FINS	2129100	ACK-CU-HSSDC-HSSDC-2G-1M	
FINS	CBL-HSDCHSDC-03	FCAL CABLE, NON-EQUALIZED	
FINS	CBL-HSDCHSDC2-01	1 M, 2GB FC CU CABLE,	
FINS	CBL-HSDCHSDC-01	FCALCABLE, NON-EQUALIZED	
FINS	2129200	ACK-CU-HSSDC-HSSDC-2G-3M	
FINS	CBL-HSDCHSDC2-0.6	0.6M, 2GB FC CU CABLE,	
FINS	2142800	ACK-RS232 - FS4500	
FINS	2142900	ACK-RS232 - FS4100	
FINS	2129300	ACK-RS232 SANBLOC	
FINS	CBL-SFPHSDC-2-STR	CBL-SFPHSDC-2-STR	
FINS	CBL-620M620M-10	68PIN (VHDCI) TO 68PIN	
FINS	CBL-DB9MHSDC-30	30M FC COPPER CAB EQUAL	
FINS	CBL-620M620M3-10	10M U320 CABLE	
FINS	CBL-620M620M-25	68PIN (VHDCI) TO 68PIN	
FINS	CBL-620M620M3-25	25M U320 CABLE	
FINS	CBL-HSDCHSDC-30	30M FC COPPER CAB EQUAL	
FINS	CBL-HSDCHSDC-10	FCAL CABLE, NON-EQUALIZED	
FINS	CBL-SFPSFP-0.5	FC CU CABLE DUAL SFP .5M	
FINS	CBL-OPTMLCLC-0.3	0.3M, 2GB, FC OPT CABLE	
FINS	CBL-OPTMLCLC-0.5	0.5M, 2GB, FC OPT CABLE	
FGSD	2070000	AES-iSA1500/1.0TB KIT	CTC
FGSD	2115800	AES-iSA1500 CHASSIS ASSY FRU	CTC
FGSD	2115700	AES-ESA1500 CHASSIS ASSY FRU	CTC
FGSD	2069300	AES-ESA 1500/1.0TB KIT	CTC
FGSD	5325301328	ARU, PV705N, 160GB, JAPANESE	CTC
FGSD	2104300	DISK-25072-KN1MN ASSY	CTC

Mat Class	Material #	Description	System Products
FGSD	2174600	DISK-7310-S2S7-AVI 4PK	CTC
FINB	1903400	ACK-Cu-HSSDC-DB9-2G-5M	CTC
FINB	1890400	ACK-Cu-HSSDC-HSSDC-2G-5M	CTC
FINB	1889700	ACK-OPT-LC-LC-2G-10M	CTC
FINB	1889600	ACK-OPT-LC-LC-2G-5M	CTC
FINB	1903800	ACK-OPT-LC-SC-2G-10M	CTC
FINB	1903900	ACK-OPT-LC-SC-2G-25M	CTC
FINB	1903700	ACK-OPT-LC-SC-2G-5M	CTC
FINB	1903400-R	ACK-Cu-HSSDC-DB9-2G-5M RoHS	CTC
FINB	1890400-R	ACK-Cu-HSSDC-HSSDC-2G-5M RoHS	CTC
FINB	1889700-R	ACK-OPT-LC-LC-2G-10M RoHS	CTC
FINB	1889600-R	ACK-OPT-LC-LC-2G-5M RoHS	CTC
FINB	1903800-R	ACK-OPT-LC-SC-2G-10M RoHS	CTC
FINB	1903900-R	ACK-OPT-LC-SC-2G-25M RoHS	CTC
FINB	1903700-R	ACK-OPT-LC-SC-2G-5M RoHS	CTC
FINB	1968900	ADA-2GB FC LC OPT SFP XCVR SGL	CTC
FINS	2129000	ACK-OPT-LC-LC-2G-0.5M	CTC
FINS	CBL-620M620M3-01	1M U320 CABLE	CTC
FINS	TKIT-FC2000-B	1 & 2GB TOWER KIT BLACK	CTC
FINS	256MB-FC2500	256MB FFX1 MEMORY	CTC
FINS	CAB29U-FC2000-A	29U CABINET FOR US RA02	CTC
FINS	FC2101ODR2-AC-S	2GB DUAL OPT SHF-STRATUS	CTC
FINS	CIOM-FC2002-F	2GB IO, CU/CU	CTC
FINS	EMA-BXF112-01-A	2GB IO, OPT/OPT-EL	CTC
FINS	LSM-FC2002-C	2GB LS ASSEMBLY, ACER	CTC
FINS	FC2101CSR2-AC-B	2GB RACK BLK,SNGL CU/LS	CTC
FINS	FC2101MSR2-AC-B	2GB RACK,BLK,SNGL MXD/LS	CTC
FINS	TKIT-FC2002	2GB TOWER KIT BLUE	CTC
FINS	FC2101ODT2-AC	2GB TOWER, BLUE, DUAL	CTC
FINS	MAN-FC2002	2GB USER DOCUMENTATION	CTC
FINS	FC2101ODR2-AC-A	2GB, RACK, DUAL, AVID	CTC
FINS	FC2101ODR2-AC-X	2GB, RACK, DUAL, XIOTECH	CTC
FINS	FC2101CDR2-AC-C	2GB,RACK,JBOD,DUAL,ACER	CTC
FINS	FC2501DR2-AC-C	2GB,RACK,RAID,DUAL,ACER	CTC
FINS	FC2501DR2E-AC-C	2GB,RACK,RAID,DUAL,ACER	CTC
FINS	FC2501SR2-AC-C	2GB,RACK,RAID,SNGL,ACER	CTC
FINS	FC2101MDR2-AC	2GB. RACK, BLUE, DUAL	CTC
FINS	FC2101CDR2-AC	2GB. RACK, BLUE, DUAL	CTC
FINS	FC2101ODR2-AC	2GB. RACK, BLUE, DUAL	CTC
FINS	2173600	5100F-DR DUAL RAID SYSTEM	CTC
FINS	2173700	5100F-SR SINGLE RAID SYSTEM	CTC
FINS	512MB-FC2500	512MB FFX1 MEMORY	CTC
FINS	2117600	512MB-FS4000 FRU	CTC
FINS	FS4500DR-AC-160-P	ADAPTEC FS4500DR-AC-160GB/PDS	CTC
FINS	FS4500DR-AC-250-P	ADAPTEC FS4500DR-AC-250GB/PDS	CTC
FINS	CIOM-FC2000	ADD ON COPPER IO MODULE	CTC
FINS	OIOM-FC2000	ADD ON OPTICAL IO MODULE	CTC

Mat Class	Material #	Description	System Products
FINS	3-01634-01	ADIC IOP MOD FRU	CTC
FINS	3-01635-01	ADIC RCM MOD FRU	CTC
FINS	ACM-FC2000	ADVANCED COOLING MODULE	CTC
FINS	2147800	AES-FS4500 1GB DIMM ECC	CTC
FINS	2187000	AES-FS4500SR FC-SATA RAID 2TB	CTC
FINS	APC-4000-STR	APC-4000-STR	CTC
FINS	FC210100R2-AC	ASSEMBLY, 2GB FSC RACK	CTC
FINS	ACM-FC2000-X	ASSEMBLY, ACM	CTC
FINS	CAR-FC2000-X	ASSEMBLY, DRIVE CARRIER	CTC
FINS	OIOM-FC2002-X	ASSEMBLY, OPT/OPT I/O	CTC
FINS	PSMAC-FC2000-X	ASSEMBLY, PSU	CTC
FINS	LSM-FC2002-A	ASSY, 2GB LS	CTC
FINS	RCM-FC2502-F	ASSY, 2GB FFX2 RAID	CTC
FINS	RCMNB-FC2502-F	ASSY, 2GB FFX2 RAID	CTC
FINS	PSMAC-FC2000-A	ASSY, AC PSU	CTC
FINS	CAR-FC2000-C	ASSY, DRIVE CARRIER ACER	CTC
FINS	CARB-FC2000-A	ASSY, DRV CARRIER BLANK	CTC
FINS	CARB-FC2000-F	ASSY, DRV CARRIER BLANK	CTC
FINS	CARB-FC2000-X	ASSY, DRV CARRIER BLANK	CTC
FINS	CIOM-FC2002	ASSY, EL 2GB IO, CU/CU	CTC
FINS	MIOM-FC2002	ASSY, EL 2GB IO, OPT/CU	CTC
FINS	OIOM-FC2002	ASSY, EL 2GB IO, OPT/OPT	CTC
FINS	OIOM-FC2002-A	ASSY, EL 2GB IO, OPT/OPT	CTC
FINS	PSMAC-FC2000-F	ASSY, S80 AC PSU	CTC
FINS	BAT-FC2500-F	ASSY, S80 BBU	CTC
FINS	LSM-FC2002-F	ASSY, S80 LS MODULE	CTC
FINS	LSM-FC2002-X	ASSY, XIOTECH 2GB LS	CTC
FINS	BAT-FC2500	BATTERY ASSEMBLY RA01	CTC
FINS	FC2101CDR	BOXSTOR JBOD SHELF	CTC
FINS	FC2501DR	BOXSTOR RAID SHELF	CTC
FINS	FC2101CDT	BOXSTORE 1GB. TOWER,JBOD	CTC
FINS	FC2501ST	BOXSTORE 1GB.TOWER,	CTC
FINS	FC2501DT	BOXSTORE 1GB.TOWER, DUAL	CTC
FINS	CAR-FC2000-B	BOXSTORE DRIVE CARRIER	CTC
FINS	FC2501DR-S	BOXTR RAID SHELF-STRATUS	CTC
FINS	BULKH-FC2500	BULKHEAD BOXSTORE RNA00	CTC
FINS	CARB-4000-STR	CARB-4000-STR	CTC
FINS	2130400	CARB-FC2000-UNI	CTC
FINS	CAR-GR4000-B-STR	CAR-GR4000-B-STR	CTC
FINS	CARB-FC2000	DRIVE CARRIER BLANK -	CTC
FINS	LSM-FC2002	EL 2GB LS ASSEMBLY (BLU)	CTC
FINS	IOC-4000-C	EMPTY IO CAN CIPRICO FRU	CTC
FINS	CAR-FS4000-MAX	EMTY CARRIER ASSY SATA MAXDATA	CTC
FINS	CAR-FS4000	EMTY CARRIER ASSY, SATA	CTC
FINS	ENCLD-FS4000	EURO DUAL SATA SHELF	CTC
FINS	ENCLS-FS4000	EURO SNGL SATA SHELF	CTC
FINS	CARB-FC2000-B	FC2000 DRIVE CARRIER -	CTC

Mat Class	Material #	Description	System Products
FINS	2131500	FC2101ODR2-AC-UNI	CTC
FINS	FC4100DR-AC-STR	FC4100DR-AC-STR	CTC
FINS	RCM-FC2500	FFX1 RAID MODULE	CTC
FINS	RCM-FC2500-M	FFX1 RAID MODULE 256MB	CTC
FINS	RCM-FC2502E	FFX2 ET RAID MOD, FRU	CTC
FINS	256MB-FC2502	FFX2 RAID 256 MB MEMORY	CTC
FINS	512MB-FC2502	FFX2 RAID 512 MB MEMORY	CTC
FINS	RCM-FC2502	FFX2 RAID MODULE, FRU	CTC
FINS	RCM-FC2502-M	FFX2 RAID MODULE, FRU	CTC
FINS	FS4050SR-AC-X	FS4050SR-AC-XIO	CTC
FINS	2117700	FS4500 CNTRL BATTERY FRU	CTC
FINS	RCM-FS4000	FS4500 CONTROLLER FRU	CTC
FINS	FS4500DR-AC-400-P	FS4500DR-AC-400-PDS	CTC
FINS	FS4500DR-AC-500-P	FS4500DR-AC-500-PDS	CTC
FINS	ENCL-FC2000-F	FSC EMPTY ENCLOSURE	CTC
FINS	HAN-FC2500	HANDLE FOR RAID MODULE RA02	CTC
FINS	IDES-FC4000-P-FRU	IDES MOD FRU, 10 POS PDS	CTC
FINS	IIOP-FS4100	IIOP MOD WITH 128MB RAM	CTC
FINS	2122200	IIOP-FS4100-DDN FRU	CTC
FINS	IIOP-FS4100-X	IIOP-FS4100-XIO FRU	CTC
FINS	IOMB-FC2000	IO MODULE BLANK	CTC
FINS	LSM-FC2000-B	LOOP RESILIENCY AND SES	CTC
FINS	LSM-FC2000-M	LOOP RESILIENCY AND SES	CTC
FINS	LSM-FC2000	LOOP RESILIENCY AND SES R 03	CTC
FINS	PATH-FC2502-WL	PATHPILOT 2.0 WIN/LIN	CTC
FINS	ENCL-FC4000-P	PDS 12 DRV SHELF W/ PWR	CTC
FINS	APC-4000-P FRU	PDS APC MODULE FRU	CTC
FINS	RCM-FS4000-P FRU	PDS RAID MOD FRU	CTC
FINS	PSMAC-FC2000	POWER SUPPLY FRU BOXSTOR	CTC
FINS	PSMAC-FC2000-S	POWER SUPPLY, STRATUS	CTC
FINS	FS4100DR-AC	RACK DSATA DUAL IIOP	CTC
FINS	FS4500DR-AC	RACK DSATA DUAL RAID	CTC
FINS	FS4500DR-AC-C	RACK DSATA DUAL RAID,CIP	CTC
FINS	FS4100SR-AC	RACK DSATA SINGLE IIOP	CTC
FINS	FS4500SR-AC	RACK DSATA SINGLE RAID	CTC
FINS	FC4100DR-AC	RACK FIBRE DUAL I/O	CTC
FINS	FS4050SR-AC	RACK SSATA SINGLE IIOP	CTC
FINS	FS4050SR-AC-DDN	RACK SSATA SNGL IIOP DDN	CTC
FINS	FC2101CSR	RACK, JBOD, SINGLE	CTC
FINS	FC2501SR-B	RACK, SINGLE FIBRE RAID	CTC
FINS	FC2501SR	RACK, SINGLE FIBRE RAID	CTC
FINS	FC2501DR2-AC-B	RACK,2GB,DUAL RAID,BLK	CTC
FINS	FC2501DR2-AC	RACK,2GB,DUAL RAID,BLUE	CTC
FINS	FC2501SR2-AC-B	RACK,2GB,SINGL RAID,BLK	CTC
FINS	FC2501SR2-AC	RACK,2GB,SINGL RAID,BLUE	CTC
FINS	RKIT-FC2000	RACKMOUNT RAIL KIT	CTC
FINS	NRKIT-FC2000	RACKMOUNT RAIL KIT	CTC

Mat Class	Material #	Description	System Products
FINS	RKIT-FC2000-A	RACKMOUNT RAIL KIT ACER	CTC
FINS	FC2501DR2E-AC-B	RCK,2GB,DUAL ET RAID,BLK	CTC
FINS	FC2501DR2E-AC	RCK,2GB,DUAL ET RAID,BLU	CTC
FINS	FC2501SR2E-AC-B	RCK,2GB,SNGL ET RAID,BLK	CTC
FINS	FC2501SR2E-AC	RCK,2GB,SNGL ET RAID,BLU	CTC
FINS	2117400	RCM-FC2500/128MB FRU	CTC
FINS	2117500	RCM-FC2500/512MB FRU	CTC
FINS	2117100	RCM-FC2502/128MB FRU	CTC
FINS	2117200	RCM-FC2502/256MB FRU	CTC
FINS	2117300	RCM-FC2502/512MB FRU	CTC
FINS	2116800	RCM-FC2502E/128MB FRU	CTC
FINS	2116900	RCM-FC2502E/256MB FRU	CTC
FINS	2117000	RCM-FC2502E/512MB FRU	CTC
FINS	FC2101EDR2-AC-M	SANBLOC, 2GB MIRAPPOINT	CTC
FINS	ENCL-FC2000	SIEMENS EMPTY ENCLOSURE	CTC
FINS	LSM-FC2002-B	UNBRANDED 2GB LS	CTC
FINS	FC2101ODR2-AC-B	UNBRANDED 2GB, RACK,DUAL	CTC
FINS	FC2101CDR2-AC-B	UNBRANDED 2GB. RACK,DUAL	CTC
FINS	MANRKIT-FC2000	USER DOCUMENT FOR R1.1	CTC
FINS	IOM-FC4100-STR	IOM-FC4100-STR	CTC
FINS	EMA-BXF105-02-A	2GB IO, COPPER-EL	CTC
FINS	EMA-BXF109-01-C	2GB IO, OPT/CU-EL	CTC
FINS	EMA-BXF109-01-A	2GB IO, OPT/CU-EL RXXX.	CTC
FINS	EMA-BXF112-01-C	2GB IO, OPT/OPT-EL	CTC
FINS	EMA-BXF110-03-C	2GB LS ASSY, (BLACK)-EL	CTC
FINS	ACM-FC2000-S	ACM, STRATUS	CTC
FINS	1968900-R	ADA-2GB FCLC OPT SFP XCVR RoHS	CTC
FINS	3-01630-01	ADIC SINGLE IMP W/ DRIVES	CTC
FINS	3-01628-01	ADIC SINGLE MAX W/ DRIVES	CTC
FINS	3-01631-01	ADIC SINGLE MAX WO DRIVES	CTC
FINS	2164600	AES-FS4500SR FC-SATA RAID 2TB	CTC
FINS	2203600	AES-FS4500SR FC-SATA SBS,2TB	CTC
FINS	ARKIT-FC2000	ASIAN RACKMOUNT RAIL KIT	CTC
FINS	NRKIT-FC2000-X	ASSY, RACKMOUNT RAIL KIT	CTC
FINS	ACM-FC2000-F	ASSY, S80 ACM	CTC
FINS	4D274	BOXSTORE 2GB LS ASSEMBLY	CTC
FINS	CAR-FC2000	BOXSTORE DRIVE CARRIER	CTC
FINS	2131300	FC2101MDR2-AC-UNI	CTC
FINS	CARM-FS4000	GRY, DRV CARRIER W/MUX	CTC
FINS	LSMB-FC2000	LS MODULE BLANK	CTC
FINS	2131000	NRKIT-FC2000-UNI	CTC
FINS	3-01635-03	RCM-FS4500/ADIC FRU	CTC
FINS	FC2101EDR-M	SANBLOC, 1GB MIRAPPOINT	CTC
FINS	2205500-R	CARB-FC2000 RoHS	CTC
FINS	2140000	AES-iSA1500 1TB/SAWTEL KIT	CTC
FINS	2173400	S50-DJ DUAL JBOD SYSTEM	CTC
FINS	2173500	S50-SR SINGLE JBOD SYSTEM	CTC

Mat Class	Material #	Description	System Products
FINS	DSA-SMM	55FKV SCSI MANAGMEENT RA02	CTC
FINS	CAR-SC2000	ASSY, DRIVE CARRIER	CTC
FINS	0020-03404-01	AVID MDU320 ENCLOSURE	CTC
FINS	0020-03434-01	AVID MDU320 TOWER KIT	CTC
FINS	0020-03432-01	AVID MDU320 X4 BLANK DC	CTC
FINS	CSM-SC2000	CCESM MODULE	CTC
FINS	ESM-SC2000	CESM MODULE	CTC
FINS	ESM-SC2000-A	CESM MODULE	CTC
FINS	CARB-SC2000	DISK DRIVE BLANK MODULE	CTC
FINS	CARB-SC2000-A	DISK DRIVE BLANK MODULE	CTC
FINS	CAR-SC4000-A	EMPTY CARRIER ASSY, AVID	CTC
FINS	ENCL-SC2000	ENCL SHELL, STRAIGHT BUS	CTC
FINS	ENCL-SC4000	EUROLOGIC SCSI SHELF	CTC
FINS	SC2101CCR-AC-S	JBOD DUAL CCESM RACK	CTC
FINS	SC2100CTR-AC	JBOD SNG CCESM TESH RACK	CTC
FINS	SC2100CTR-AC-A	JBOD SNG CCESM TESH RACK	CTC
FINS	SC2100ETR-AC-B	JBOD SNG CESM TESH RACK	CTC
FINS	SC2100ETT-AC	JBOD SNG CESM TESH TWR	CTC
FINS	JM-SC2000	JOINER MODULE	CTC
FINS	LEDB-SC2000-B	LED BLANK MODULE	CTC
FINS	LEDB-SC2000	LED BLANK MODULE	CTC
FINS	LEDM-SC2000-B	LED MODULE	CTC
FINS	LEDM-SC2000	LED MODULE	CTC
FINS	PSMAC-SC2000	PSU MODULE AC	CTC
FINS	SC4100EDR-AC	RACK U320 DUAL BUS JBOD	CTC
FINS	SC4100ESR-AC-A	RACK U320 SINGL BUS AVID	CTC
FINS	SC4100ESR-AC	RACK U320 SINGL BUS JBOD	CTC
FINS	TM-SC2000	TERMINATOR MODULE	CTC
FINS	TSM-SC2000	TESM MODULE	CTC
FINS	ESM-SC4000	U320 ESIO MODULE FRU	CTC
FINS	JM-SC4000	U320 JOINER MODULE FRU	CTC
FINS	0030-03208-01	AVID MDU320 I/O ASSY	CTC
FINS	CARB-SC2000-B	DISK DRIVE BLANK MODULE	CTC
FINS	SC2100EJR-AC-B	JBOD SNG CESM DJ RACK	CTC
FINS	SC2100ETR-AC	JBOD SNG CESM TESH RACK	CTC
FINS	2206900-R	JM-SC4000 FRU RoHS	CTC
FINS	0010-05664-01	RACKMOUNT RAIL KIT, AVID	CTC
FINS	MAN-SC2100	USER DOCUMENTATION PACK	CTC
FINS	DISK-14610-AS3H1-A	146G 10K U320 SCSI AVID	CTC
FINS	DISK-14610-AS3S6	146G 10K U320 SCSI SGATE	CTC
FINS	DISK-14610-X1IB1-A	146GB ASSY SCSI DAYTONA	CTC
FINS	DISK-1815-AS3S3	18G 15K U320 SCSI SGATE	CTC
FINS	DISK-1810M-A1	18GB 10K RPM ULTRA 160 R0002	CTC
FINS	DISK-1810M-A2	18GB 10K RPM ULTRA 160 RS96H	CTC
FINS	DISK-3610-X1S5-AV	36 GB C5 SCSI LVD AVID	CTC
FINS	DISK-3610-X1S1-AV	36 GB C5 SCSI LVD AVID	CTC
FINS	DISK-3610-AS3S6	36G 10K U320 SCSI SGATE	CTC

Mat Class	Material #	Description	System Products
FINS	DISK-3610F2-SA1	36GB 10K RPM 2GBIT	CTC
FINS	DISK-3610G-A1	36GB 10K RPM C4 FIBRE	CTC
FINS	DISK-3610M-A1	36GB 10K RPM ULTRA 160 R0001	CTC
FINS	DISK-3610-X1IB1-A	36GB ASSY SCSI DAYTONA	CTC
FINS	DISK-3610-U1S5	36GB ULTRA160 DRIVE ASSY	CTC
FINS	DISK-7310-AS3H1	73G 10K U320 SCSI HGST	CTC
FINS	DISK-7310-AS3S6	73G 10K U320 SCSI SGATE	CTC
FINS	DISK-7315-AS3S3	73G 15K U320 SCSI SGATE	CTC
FINS	DISK-7310G-A1	73GB 10K RPM C4 FIBRE	CTC
FINS	DISK-7310M-A1	73GB 10K RPM CHEETAH 4 R0001	CTC
FINS	DISK-XS57310F51-NR	73GB 10K RPM CHEETAH 5	CTC
FINS	DISK-7310-X1IB1-A	73GB ASSY SCSI DAYTONA	CTC
FINS	DISK-7310-S2S5	73GB F/C DRIVE SANBLOC	CTC
FINS	DISK-7310-S2S5-B	73GB F/C DRIVE SANBLOC	CTC
FINS	2148800	AES-DISK-14610-AS3S7	CTC
FINS	2148600	AES-DISK-14610-S2S7	CTC
FINS	2149200	AES-DISK-14615-AS3S4	CTC
FINS	2149000	AES-DISK-14615-S2S4	CTC
FINS	2176000	AES-DISK-25072-AA3MM4	CTC
FINS	2175700	AES-DISK-25072-AA3MN4	CTC
FINS	2147900	AES-DISK-30010-S2S7	CTC
FINS	2149500	AES-DISK-3615-AS3S4	CTC
FINS	2149400	AES-DISK-3615-S2S4	CTC
FINS	2176100	AES-DISK-50072-AA1HM2	CTC
FINS	2175800	AES-DISK-50072-AA1HN2	CTC
FINS	2175900	AES-DISK-50072-AA3MM4	CTC
FINS	2175600	AES-DISK-50072-AA3MN4	CTC
FINS	2148900	AES-DISK-7310-AS3S7	CTC
FINS	2148700	AES-DISK-7310-S2S7	CTC
FINS	2149100	AES-DISK-7315-S2S4	CTC
FINS	DISK-16072-AA1M-P	ASSY 160GB SATA PDS DRIVE WMUX	CTC
FINS	DISK-16072-AA1MR-P	ASSY 160GB SATA PDS REAR WMUX	CTC
FINS	DISK-25072-AA1MR-P	ASSY 250GB SATA PDS REAR WMUX	CTC
FINS	DISK-14610-S2S6	ASSY, 146GB 10K CHEETAH6	CTC
FINS	DISK-14610-S2S6-B	ASSY, 146GB 10K CHEETAH6	CTC
FINS	DISK-14610-S2S6-F	ASSY, 146GB 10K CHEETAH6	CTC
FINS	DISK-14610-U3S6-B	ASSY, 146GB 10K CHEETAH6	CTC
FINS	DISK-14610-U3S6	ASSY, 146GB 10K CHEETAH6	CTC
FINS	DISK-14610-S2IB1-A	ASSY, 146GB AVID DRIVE	CTC
FINS	DISK-1815-U3S3-B	ASSY, 18GB 15K CHEETAH	CTC
FINS	DISK-1815-S2S3	ASSY, 18GB 15K.3 CHEETAH	CTC
FINS	DISK-1815-S2S3-B	ASSY, 18GB 15K.3 CHEETAH	CTC
FINS	DISK-3610-U3S6	ASSY, 36GB 10K CHEETAH 6	CTC
FINS	DISK-3610-S2S6-B	ASSY, 36GB 10K CHEETAH 6	CTC
FINS	DISK-3610-S2S6-F	ASSY, 36GB 10K CHEETAH 6	CTC
FINS	DISK-3610-S2S6-B-S	ASSY, 36GB 10K CHEETAH 6	CTC
FINS	DISK-3610-S2S6	ASSY, 36GB 10K CHEETAH 6	CTC

Mat Class	Material #	Description	System Products
FINS	DISK-3615-U3S3	ASSY, 36GB 15K CHEETAH	CTC
FINS	DISK-3615-U3S3-B	ASSY, 36GB 15K CHEETAH	CTC
FINS	DISK-3615-S2S5-F	ASSY, 36GB 15K CHEETAH 5	CTC
FINS	DISK-3615-S2S3	ASSY, 36GB 15K.3 CHEETAH	CTC
FINS	DISK-3615-S2S3-F	ASSY, 36GB 15K.3 CHEETAH	CTC
FINS	DISK-3615-S2S3-B	ASSY, 36GB 15K.3 CHEETAH	CTC
FINS	DISK-3610-S2S5-A	ASSY, 36GB AVID DRIVE	CTC
FINS	0020-03341-01	ASSY, 4X146GB AVID PACK	CTC
FINS	DISK-7310-S2S5-F	ASSY, 73GB 10K CHEETAH 5	CTC
FINS	DISK-7310-S2S6	ASSY, 73GB 10K CHEETAH 6	CTC
FINS	DISK-7310-S2S6-B	ASSY, 73GB 10K CHEETAH 6	CTC
FINS	DISK-7310-S2S6-F	ASSY, 73GB 10K CHEETAH 6	CTC
FINS	DISK-7310-S2S6-B-S	ASSY, 73GB 10K CHEETAH 6	CTC
FINS	DISK-7315-U3S3-B	ASSY, 73GB 15K CHEETAH	CTC
FINS	DISK-7315-S2S3-B	ASSY, 73GB 15K.3 CHEETAH	CTC
FINS	DISK-7315-S2S3	ASSY, 73GB 15K.3 CHEETAH	CTC
FINS	DISK-7315-S2S3-F	ASSY, 73GB 15K.3 CHEETAH	CTC
FINS	DISK-7310-S2S5-A	ASSY, 73GB AVID DRIVE	CTC
FINS	DISK-7310-S2IB1-A	ASSY, 73GB AVID DRIVE	CTC
FINS	0020-03338-01	ASSY, 1X146GB AVID PACK	CTC
FINS	0020-03340-01	AVID 4 PACK 73GB GEN6 ME	CTC
FINS	0020-03337-01	AVID 73GB GEN6 MEDIARRAY II DR	CTC
FINS	DISK-18072-X1S1-AV	AVID DRIVE ASSY 180GB LC	CTC
FINS	DISK-7310-X1S5-AV	AVID DRIVE ASSY 73GB LC	CTC
FINS	DISK-1810M-AV1-1	AVID DRIVE CARRIER 18GB	CTC
FINS	DISK-3610M-AV1-1	AVID DRIVE CARRIER 36GB	CTC
FINS	DISK-7310M-AV1-1	AVID DRIVE CARRIER 73GB	CTC
FINS	0020-03407-01	AVID MDU320 146G IBM X1	CTC
FINS	0020-03406-01	AVID MDU320 73G IBM X1	CTC
FINS	0020-03430-01	AVID MDU320 73G IBM X4	CTC
FINS	DISK-3610-V1S5	CHEETAH 5 36LD 10K U160	CTC
FINS	DISK-7310-V1S5	CHEETAH 5 73LP 10K U160.	CTC
FINS	DISK-3615-S2S5	CHEETAH X15 36LP FC 36GB	CTC
FINS	2165200	DISK-14610-AF2S7	CTC
FINS	2212500	DISK-14610-AF2S7-B	CTC
FINS	2168600	DISK-14610-AS3S7-AVI	CTC
FINS	2168600-R	DISK-14610-AS3S7-AVI RoHS	CTC
FINS	2130500	DISK-14610-S2S6-UNI	CTC
FINS	2167500	DISK-14610-S2S7-ACE	CTC
FINS	2168300-R	DISK-14610-S2S7-AVI RoHS	CTC
FINS	2162600	DISK-14610-S2S7-BLACK	CTC
FINS	2160800	DISK-14610-S2S7-FSC	CTC
FINS	2175400	DISK-14610-SAS-SB	CTC
FINS	2141300	DISK-14610-U3S6-ESL	CTC
FINS	2163500	DISK-14610-U3S7	CTC
FINS	2179400	DISK-14610-U3S7-AVI	CTC
FINS	DISK-14615-AF2G-P	DISK-14615-AF2G-PDS	CTC

Mat Class	Material #	Description	System Products
FINS	2186500	DISK-14615-S2S4-FSC	CTC
FINS	2175200	DISK-14615-SAS-SB	CTC
FINS	2130600	DISK-1815-S2S3-UNI	CTC
FINS	2122400	DISK-25072-AA1MM SNGL FRU	CTC
FINS	DISK-25072-AA1MN-X	DISK-25072-AA1MN-XIO	CTC
FINS	2223000	DISK-25072-SATA-SB-4PK	CTC
FINS	2165100	DISK-30010-AF2S7	CTC
FINS	2168500	DISK-30010-AS3S7-AVI	CTC
FINS	2168500-R	DISK-30010-AS3S7-AVI RoHS	CTC
FINS	2175500	DISK-30010-SAS-SB	CTC
FINS	2130700	DISK-3610-S2S6-UNI	CTC
FINS	2173300	DISK-3615-AF2S4	CTC
FINS	2136400	DISK-3615-S2S3-UNI	CTC
FINS	2172600	DISK-3615-S2S4-BLACK	CTC
FINS	2160700	DISK-3615-S2S4-FSC	CTC
FINS	DISK-40072-AA1HM	DISK-40072-AA1HM	CTC
FINS	DISK-40072-AA1HN-X	DISK-40072-AA1HN-XIO	CTC
FINS	DISK-40072-AA1M-P	DISK-40072-AA1M-PDS	CTC
FINS	DISK-40072-AA1MR-P	DISK-40072-AA1MR-PDS	CTC
FINS	DISK-50072-AA1MR-P	DISK-50072-AA1MR-P	CTC
FINS	2165300	DISK-7310-AF2S7	CTC
FINS	2168700	DISK-7310-AS3S7-AVI	CTC
FINS	2168700-R	DISK-7310-AS3S7-AVI RoHS	CTC
FINS	2168900	DISK-7310-S2H2-AVI	CTC
FINS	2168400-R	DISK-7310-S2S7-AVI RoHS	CTC
FINS	2162700	DISK-7310-S2S7-BLACK	CTC
FINS	2160900	DISK-7310-S2S7-FSC	CTC
FINS	2184500	DISK-7310-S2S7-STR	CTC
FINS	2175300	DISK-7310-SAS-SB	CTC
FINS	2163600	DISK-7310-U3S7	CTC
FINS	2179300	DISK-7310-U3S7-ACE	CTC
FINS	2179500	DISK-7310-U3S7-AVI	CTC
FINS	DISK-7315-AF2G-P	DISK-7315AF2G-PDS	CTC
FINS	2160600	DISK-7315-S2S4-FSC	CTC
FINS	2175100	DISK-7315-SAS-SB	CTC
FINS	DISK-12072-AA1SM	GRY 120GB 7200 DSATA FRU	CTC
FINS	DISK-16072-AA1SM	GRY 160GB 7200 DSATA FRU	CTC
FINS	DISK-16072-AA1SN	GRY 160GB 7200 SSATA FRU	CTC
FINS	DISK-20072-AA1DM	GRY 200GB 7200 DSATA FRU	CTC
FINS	DISK-25072-AA1MM	GRY 250GB 7200 DSATA FRU	CTC
FINS	DISK-25072-AA1MN	GRY 250GB 7200 SSATA FRU	CTC
FINS	DISK-8072-AA1SM	GRY 80GB 7200 DSATA FRU	CTC
FINS	DISK-16072-AA1SM-P	PDS 160GB 7200 DSATA FRU	CTC
FINS	DISK-3610-S2S5-B	SANBLOC 36GB CHEETAH 5	CTC
FINS	DISK-3610-S2S5	SANBLOC CHEETAH 5	CTC
FINS	DISK-1872L-A3	Seagate Cheetah 10k.7 U320 73G	CTC
FINS	DISK-25072-AA1M-P	ASSY 250GB SATA PDS DRIVE WMUX	CTC

Mat Class	Material #	Description	System Products
FINS	2175000	DISK-3615-SAS-SB	CTC
FINS	DISK-1815F2-SA2	18 GB 15K RPM - 2GBIT	CTC
FINS	DISK-1810F2-SA2	18GB 10K RPM 2GBIT	CTC
FINS	DISK-1810G-A1	18GB 10K RPM C4 FIBRE	CTC
FINS	DISK-1810F-NP3	18GB 10K RPM CHEETAH 4 RNA06	CTC
FINS	DISK-1810F-NP2	18GB 10K RPM DISCOVERY RNA08	CTC
FINS	DISK-1810M-CS1	18GB 10K RPM ULTRA 160 R0002	CTC
FINS	DISK-1810G-NP1	18GB DRIVES 520 BYTES RNA29	CTC
FINS	DISK-3615-AS3S3	36G 15K U320 SCSI SGATE	CTC
FINS	DISK-3610G-A2	36GB 10K DISCOVERY FIBRE	CTC
FINS	DISK-XS53610F51-N1	36GB 10K RPM CHEETAH 5	CTC
FINS	DISK-3610F-NP2	36GB 10K RPM DISCOVERY RNA08	CTC
FINS	DISK-3610M-A2	36GB 10K RPM ULTRA RS96H	CTC
FINS	DISK-XS53610F52-N1	36GB DRIVES 520BPS	CTC
FINS	DISK-XS57310F52-NR	73GB DRIVES 520BPS	CTC
FINS	DISK-7310-U1S5	73GB ULTRA160 DRIVE ASSY	CTC
FINS	DISK-7310-U1S5-B	73GB ULTRA160 DRIVE ASSY	CTC
FINS	DISK-0910M-A1	9GB 10K RPM ULTRA 160 R0002	CTC
FINS	DISK-0910M-A2	9GB 10K RPM ULTRA 160 RS96H	CTC
FINS	3-01482-01	ADIC 250G 7200 DSATA FRU	CTC
FINS	2148000	AES-DISK-30010-AS3S7	CTC
FINS	2149300	AES-DISK-7315-AS3S4	CTC
FINS	DISK-14610-U3S6-A	ASSY, 146GB 10K CHEETAH6	CTC
FINS	DISK-1810L-A1	ASSY, 18GB 10K RPM LVD Cheetah	CTC
FINS	DISK-3610-S2S5-F	ASSY, 36GB 10K CHEETAH 5	CTC
FINS	DISK-3610-U3S6-B	ASSY, 36GB 10K CHEETAH 6	CTC
FINS	DISK-3672L-A1	ASSY, 36GB 7200RPM LVD	CTC
FINS	DISK-7310-U3S6	ASSY, 73GB 10K CHEETAH 6	CTC
FINS	DISK-1872L-A1	ASSY,18GB 7200RPM LVD Baracuda	CTC
FINS	DISK-1872L-A2	ASSY,18GB 7200RPM LVD Baracuda3	CTC
FINS	DISK-12072-AA1SM-B	BLK 120GB 7200 DSATA FRU	CTC
FINS	DISK-7310-AF2S6	BLU 73GB 10K FC DRV FRU	CTC
FINS	DRV-00013-01-A	CHEETAH 36ES 36GB HDA.	CTC
FINS	DISK-3610-VF1S5	CHEETAH 5 36GB FCAL	CTC
FINS	DISK-7310-VF1S5	CHEETAH 5 73GB FCAL	CTC
FINS	DISK-1815-S2S5	CHEETAH X15 18LP FC 18GB	CTC
FINS	DISK-1815-S2S5-B	CHEETAH X15 18LP FC 18GB	CTC
FINS	DISK-3615-S2S5-B	CHEETAH X15 36LP FC 36GB	CTC
FINS	2169100	DISK-14610-AS3H2-AVI	CTC
FINS	2148800-R	DISK-14610-AS3S7 RoHS	CTC
FINS	2172200	DISK-14610-AS3S7-AVI 4PK	CTC
FINS	2168800	DISK-14610-S2H2-AVI	CTC
FINS	2148600-R	DISK-14610-S2S7 RoHS	CTC
FINS	2168300	DISK-14610-S2S7-AVI	CTC
FINS	2174500	DISK-14610-S2S7-AVI 4PK	CTC
FINS	2163500-R	DISK-14610-U3S7 RoHS	CTC
FINS	2179200	DISK-14610-U3S7-ACE	CTC

Mat Class	Material #	Description	System Products
FINS	2163800	DISK-14610-U3S7-BLACK	CTC
FINS	2149200-R	DISK-14615-AS3S4 RoHS	CTC
FINS	2149000-R	DISK-14615-S2S4 RoHS	CTC
FINS	2175200-R	DISK-14615-SAS-SB RoHS	CTC
FINS	2122300	DISK-16072-AA1SM SNGL FRU	CTC
FINS	2176000-R	DISK-25072-AA3MM4 RoHS	CTC
FINS	2169000	DISK-30010-AS3H2-AVI	CTC
FINS	2148000-R	DISK-30010-AS3S7 RoHS	CTC
FINS	2172100	DISK-30010-AS3S7-AVI 4PK	CTC
FINS	2147900-R	DISK-30010-S2S7 RoHS	CTC
FINS	2162500	DISK-30010-S2S7-BLACK	CTC
FINS	2175500-R	DISK-30010-SAS-SB RoHS	CTC
FINS	2179100	DISK-30010-U3S7-ACE	CTC
FINS	2149400-R	DISK-3615-S2S4 RoHS	CTC
FINS	2182200	DISK-3615-S2S4-UNI	CTC
FINS	2175000-R	DISK-3615-SAS-SB RoHS	CTC
FINS	2175900-R	DISK-50072-AA3MM4 RoHS	CTC
FINS	2169200	DISK-14610-AF2S7-B	CTC
FINS	2169200	DISK-7310-AS3H2-AVI	CTC
FINS	2148900-R	DISK-7310-AS3S7 RoHS	CTC
FINS	2172300	DISK-7310-AS3S7-AVI 4PK	CTC
FINS	2148700-R	DISK-7310-S2S7 RoHS	CTC
FINS	2168400	DISK-7310-S2S7-AVI	CTC
FINS	2181600	DISK-7310-S2S7-UNI	CTC
FINS	2175300-R	DISK-7310-SAS-SB RoHS	CTC
FINS	2163900	DISK-7310-U3S7-BLACK	CTC
FINS	2149300-R	DISK-7315-AS3S4 RoHS	CTC
FINS	2149100-R	DISK-7315-S2S4 RoHS	CTC
FINS	2172500	DISK-7315-S2S4-BLACK	CTC
FINS	2182100	DISK-7315-S2S4-UNI	CTC
FINS	2175100-R	DISK-7315-SAS-SB RoHS	CTC
FINS	DISK-7310-S2S5-B-S	DRIVE CAR,73GB,10K,FC,BK	CTC
FINS	DISK-20072-AA1DN	GRY 200GB 7200 SSATA FRU	CTC
FINS	DISK-8072-AA1SN	GRY 80GB 7200 SSATA FRU	CTC
FINS	DISK-7310-U3S6-B	ASSY, 73GB 10K CHEETAH 6	CTC
FINS	2175700-R	DISK-25072-AA3MN4 RoHS	CTC
FINS	2175600-R	DISK-50072-AA3MN4 RoHS	CTC
FINS	2175400-R	DISK-14610-SAS-SB RoHS	CTC
FINS	2204900-R	CBL-RS232DB9F RoHS	CTC
FINS	2200100	ASE-335SAS Kit - Beige	CTC
FINS	2200200	ASE-335SAS Kit - Black	CTC
FINS	XLPSU-AR3	POWER SUPPLY AUTORANRING	CTC
FINS	VUA-3121R-A	VOYAGER 3111 1 SHELF U2	CTC
FINS	XLRDC-AAU	ULT,3.5"CONTR.2UW CHNL +	CTC
FINS	VOYRDC-5500-000	RAIDCONT V5K VIPER W RC1.8	CTC
FINS	VUA-3111T-A	VOYAGER 3111 1 TOWER U2	CTC
FINS	XLRDC-AAUD	ULT.DIFF,3.5" CONT.2XUW	CTC

Mat Class	Material #	Description	System Products
FINS	PSMAC-SC2000-S	PSU MODULE AC	CTC
FINS	XLACM2-AA	ACM FAN FOR XL500	CTC
FINS	XLVEM-AA	VERSATILE ENVIORMENTAL	CTC
FINS	VUA-3111R-A	VOYAGER 3111 1 SHELF U2	CTC
FINS	DSA-BPL12	0672T BACKPLANE H12 RA00	CTC
FINS	DSA-SEMM	107KT SEMM FOR HENDRIX RA03	CTC
FINS	IDES-4000	2U ES MOD FRU, SATA U320	CTC
FINS	ASM-00103-01-A	2U ES MODULE ASSY-8 POS	CTC
FINS	RKIT-4000	2U RAIL KIT FRU	CTC
FINS	TWRKIT-4000	2U TOWER CONVERSION KIT	CTC
FINS	DSA-DUALB2	3489P SPLIT BUS MODULE RA01	CTC
FINS	46PJJ	46PJJ DELL PSU ASSEMBLY RA02	CTC
FINS	DSA-PS2-A01	46PJJ POWER SUPPLY,	CTC
FINS	DSA-TBLANK2	8489P I/O TERMINATION RA01	CTC
FINS	DSA-ESEM2	9478U CLUSTER ESEM FOR H RA02	CTC
FINS	DSA1121-0000	9572T SHELF ASSEMBLY, RA07	CTC
FINS	DSA-BPL2	9579P BACKPLANE RA.00	CTC
FINS	4J673	ACM, DELL MOON	CTC
FINS	337KJ	ACM-FC2000-DELL ADVANCED	CTC
FINS	4W472	ASSY- 1GB DELL COPPER IO	CTC
FINS	7U502	ASSY- 1GB DELL COPPER IO	CTC
FINS	ASM-00175-01-A	ASSY, 2U SCSI ES IO	CTC
FINS	ASM-00176-01-A	ASSY, 2U SCSI JOINER	CTC
FINS	7X900	ASSY-1GB DELL COPPER IO RA00	CTC
FINS	AVID-TWR-001	AVID DESKSIDE RC07	CTC
FINS	0840-03040-01	AVID MDU320 POWER SUPPLY	CTC
FINS	AVID-RMT-001	AVID RACK MOUNT RC06	CTC
FINS	655TN	BAT-FC2500-DELL BATTERY RA00	CTC
FINS	EMA-XL6010	BEZEL ASSEMBLY, DCAR	CTC
FINS	083MH	CHAS-FC2000R-DELL R A01	CTC
FINS	90YGX	CIOM-FC2000-DELL COPPER	CTC
FINS	00XED	DELL MOON BACKPLANE PCA RA02	CTC
FINS	CARB-4000	DRIVE CARRIER BLANK FRU	CTC
FINS	APC-4000	EUROLOGIC ACP MODULE	CTC
FINS	MEC-00009-07-B	FFX2 CAN/BHD, ETHERNET	CTC
FINS	ASM-00042-02-A	FFX2 CONTROLLER, EL	CTC
FINS	128MB-FC2502	FFX2 RAID 128 MB MEMORY	CTC
FINS	IOB-4000	I/O BLANK, 2X, 2U	CTC
FINS	XLEMU-AD	KIT,ENV MON REV1.19 / E R1.19	CTC
FINS	47RPP	LEM-FC2000-DELL LOOP	CTC
FINS	0K602	MOON 1GB LS MODULE 1.9.5 RA01	CTC
FINS	ASA-PS2-AV	MUSTANG FRU POWER SUPPLY RA04	CTC
FINS	6118Y	PSM-FC2000-DELL BOXSTOR	CTC
FINS	2173500-R	S50-SR SINGLE JBOD SYSTEM RoHS	CTC
FINS	SPHSSD	SPHERAS STORAGE DIRECTOR	CTC
FINS	SMS-STOMGR10-01	SSM LINUX, SOLARIS & WIN	CTC
FINS	CSM-SC2000-S	STRATUS CCESM	CTC

Mat Class	Material #	Description	System Products
FINS	1886100	(OBS)DPT-FC/DLOOP-II SS-0119-	CTC
FINS	2133700	AES-170X 256MB CACHE/IBM FRU	CTC
FINS	2198400	AES-1701 RCM DUAL FRU/IBM	CTC
FINS	9H422	ACM-FC2000-DELL (REWORK)	CTC
FINS	SPHRDW-JA	SPHERAS RAID WATCH - JAPAN VER	CTC
FINS	SPHRDW	SPHERAS RAID WATCH	CTC
FINS	RKIT-4000-STR	RKIT-4000-STR	CTC
FINS	ASM-00129-01-A	2G FFX2 CONT, RF, NE, CR	CTC
FINS	MEM-128H-AE	128 MG USEABLE CACHE FOR	CTC
FINS	ASM-00106-03-A	2U CAR BEZEL ASSY, BLUE	CTC
FINS	ASM-00106-02-A	2U CAR BEZEL ASSY, GRAY	CTC
FINS	ASM-00106-04-A	2U CAR BEZEL ASSY, WINE	CTC
FINS	MEM-VOYDHA-32M	32 MEG USEABLE CACHE FOR	CTC
FINS	2173600-R	5100F-DR DUAL RAID SYSTEM RoHS	CTC
FINS	2173700-R	5100F-SR SINGLE RAID SYST RoHS	CTC
FINS	DSA-ESM2	5489P ESM FOR HENDRIX RA02	CTC
FINS	MEM-VOYDHA-64M	64 MEG USEABLE CACHE FOR	CTC
FINS	2145500	AES PAK MATL - 2U DRV - SINGLE	CTC
FINS	EMA-BXG100-02-C	ARTESYN POWER SUPPLY	CTC
FINS	EMA-BXG100-02-B	ASSEMBLY BOXSTORE POWER	CTC
FINS	EMA-BXF106-02-B	ASSEMBLY I/O RAID FFX1	CTC
FINS	EMA-BXF111-02-B	ASSEMBLY, BOXSTORE 1GB	CTC
FINS	EMA-BXF111-01-B	ASSEMBLY, BOXSTORE 1GB R.XXX	CTC
FINS	EMA-BXF110-08-A	ASSY, 2GB LS	CTC
FINS	ASA-RESM	AVID SCSI REPEATER RA01	CTC
FINS	MEC-BXG102-01-A	BOXSTOR IO BLANK ASSY	CTC
FINS	EMA-CP0002	CABLE/PLATE,AC CHK. GARD	CTC
FINS	AA-D84006	COBRA MODULE ASSEMBLY R003	CTC
FINS	DSA-RKIT3	D/P 0935P HENDRIX RA02	CTC
FINS	EMA-XF500-203	DC/ID MODULE XL500 FIBRE	CTC
FINS	DA-FC2500	DEVICE ADAPTOR FOR FFX1 RNA00	CTC
FINS	APCB-4000	EUROLOGIC APCB MODULE	CTC
FINS	EMA-BXF113-01-B	FFX1 RAID CONTROLLER	CTC
FINS	AA-D84000	GEMINI PRIMARY DISK SHF R 012	CTC
FINS	EMA-XF500-201	LRC MODULE XL500	CTC
FINS	ASA-ESM-AV	MUSTANG FRU ESM ASSY RA05	CTC
FINS	EMA-CAR103-01-B	NON- BRANDED, CESM ASSY	CTC
FINS	EMA-CAR104-01-B	NON-BRANDED, TESM ASSY	CTC
FINS	EMA-BXG100-04-D	POWER SUPPLY - STRATUS	CTC
FINS	5E+160	PSM-FC2000-DELL BOXSTOR	CTC
FINS	2173400-R	S50-DJ DUAL JBOD SYSTEM RoHS	CTC
FINS	DSA-PS2-A02	USE 46PJJ POWER SUPPLY, RA02	CTC
FINS	ASA-BLM2	XL600 ACM ASSY (AVID) RA03	CTC
FINS	VSA-501T-FJ-A	VOYAGER TWR,LVD U2,	CTC
FINS	VSA-501R-FJ-A	VSA-FIBRE SHELF, 1 PBC	CTC
FINS	XLPSU-AR4	PSU AC GENERIC 100-240V	CTC
FINS	SC2101CCR-AC-A	JBOD DUAL CCESM RACK	CTC

Mat Class	Material #	Description	System Products
FINS	5758540	SHS 5K CONTROLLER W	CTC
FINS	VSA-501R-LJ-A	VSA LVD SHELF,1 PBC, 7	CTC
FINS	XL501R-F-23N-A2	XL500 FIBRE-AC,19"	CTC
FINS	XL401R-R-02N	19"RAID RACK,EMU SEPERAT	CTC
FINS	XL401R-S-02Z	19"RACK,2BUS.ULT.2XACM	CTC
FINS	2122600	TWRKIT-4000 FRU	CTC
FINS	XL401-R-SH	ELEC.M.ASY,RAID SHELF	CTC
FINS	XLPSU-NA1	POWER SUPPLY +CAN 110V	CTC
FINS	XLPSU-NC2	POWER SUPPLY ASSY 48V	CTC
FINS	XLVEM-AC	COBRA MODULE CORVETTE R000	CTC
FINS	CBL-00050-01-A	CABLE, iPASS TILLER to VATHMAL	CTC
FINS	LBL-00116-01-A	LBL, PB FREE ROHS MASTER MRKNG	CTC
FINS	XLPSU-NF2	POWER SUPPLY F.C. 220V	CTC
FINS	2122500	CARB-4000 SNGL FRU	CTC
FINS	XLPSU-NA2	POWER SUPPLY +CAN ,220V	CTC
FINS	XL601R-L-23E-A1	XL600 STORAGE RACK	CTC
FINS	SC2100ETR-AC-U	JBOD SNG CESM TESM RACK	CTC
FINS	XLACM-AF	FAN BLOWER ASSY W/REV A	CTC
FINS	2195100	EMULEX LP101E HBA	CTC
FINS	2195000	BROCADE SILKWORM 3252 SWITCH	CTC
FINS	XL501R-F-03N-A2	XL500 FIBRE-AC,19" RACK	CTC
FINS	XL501R-F-03N-D2	XL500 FBR-DC 19" RACK	CTC
FINS	XLPSU-NR1-D	POWER SUPPLY, AUTO	CTC
FINS	XL401R-FJ-02	STOR.RACK,FIBER	CTC
FINS	XL501T-F-03S-A2	FIBRE TWR.2 AC INPUT	CTC
FINS	ASM-00106-02-B	2U CARRIER BEZEL, GRAY	CTC
FINS	2208400-R	PATH-FC2502-WL RoHS	CTC
FINS	CBL-OPTMLCLC-150	150M, 2GB, FC OPT CABLE	Jupiter
FINS	CBL-RS232DB9F	3 PIN NULL MODEM CABLE	Jupiter
FINS	CBL-DB9MDB9M-05	FCAL CABEL, NON-EQ DB9 RA01	Jupiter
FINS	2133000	AES-1700-1RS FC-SC SUBSYS/IBM	Jupiter
FINS	2133100	AES-1700-2RD FC-SC SUBSYS/IBM	Jupiter
FINS	2133800	AES-1700 RCM WO BT-MEM/IBM FRU	Jupiter
FINS	2133200	AES-1700 FC-SC RCM/IBM OPT	Jupiter
FINS	2198300	AES-1700 RCM DUAL FRU/IBM	Jupiter
FINS	2134500	AES-1701-1RL ISC-SC SUBSYS/IBM	Jupiter
FINS	2134700	AES-1701-2RD ISC-SC SUBSYS/IBM	Jupiter
FINS	2134600	AES-1701-1RS ISC-SC SUBSYS/IBM	Jupiter
FINS	2135100	AES-1701 RCM WO BT-MEM/IBM FRU	Jupiter
FINS	2134800	AES-1701 ISC-SC RCM/IBM OPT	Jupiter
FINS	2135000	AES-1701 RCMLC WO BT-M/IBM FRU	Jupiter
FINS	2134100	AES-170X PSPLY AC 120V/IBM FRU	Jupiter
FINS	2134400	AES-170X SERIAL CABLE/IBM FRU	Jupiter
FINS	2134300	AES-170X MISC HW KIT/IBM FRU	Jupiter
FINS	2134900	AES-170X 7-14HDD UP KT/IBM OPT	Jupiter
FINS	2133900	AES-170X IO CAN BLNK/IBM FRU	Jupiter
FINS	2133600	AES-170X LION BAT/IBM FRU	Jupiter

Mat Class	Material #	Description	System Products
FINS	2134200	AES-170X MIDPLANE-CHAS/IBM FRU	Jupiter
FINB	2163300	ASC-T100 BULK	
FINB	2197400	ASR-2020ZCR/64MB/HIT BULK	
FINB	2137800-E	ASR-4005SAS/256MB/IBM RoHSE BK	
FINB	2137900	ASR-4005SAS/256MB/IBM FRU	
FINB	2137800	ASR-4005SAS/256MB/IBM BK	
FINB	2181000	ASC-48300 I2C HostRAID BULK	
FINB	2137500	ASR-4005SAS/IBM BATTERY FRU	
FINB	2183100EU	ASR-4800SAS/EFIGS KIT	
FINB	2182800	ASR-4800SAS/256MB BULK	
FINB	2183000	ASR-4805SAS/256MB BULK	
FINB	2183300JA	ASR-4805SAS/JA KIT	
FINB	2183100JA	ASR-4800SAS/JA KIT	
FINB	2185900	ASR-4805SAS/256MB/SGL	
FINB	2183800	ASR-4805SAS 20 PK	
FINB	2185700	ASR-4800SAS/256MB/SGL	
FINB	2183600	ASR-4800SAS 20 PK	
FINB	2185600	ASR-4800SAS/128MB/SGL	
FINB	2183300	ASR-4805SAS KIT	
FINB	2183100	ASR-4800SAS KIT	
FINB	2204200-E	ASR-4005SAS/256/IBM2A RoHSE KT	
FINB	2180800EU	ASC-48300/EU with I2C Kit	
FINB	2183300EU	ASR-4805SAS/EFIGS KIT	
FINB	2180800JA	ASC-48300/JA with I2C HR Kit	
FINB	2185800	ASR-4805SAS/128MB/SGL	
FINB	2187900-E	ATB-200/256MB/IBM RoHSE BULK	
FINB	2182900	ASR-4805SAS/128MB BULK	
FINB	2204300-E	ASR-4005SAS/256/IBM2A RoHSEFRU	
FINB	2204400-E	ASR-4005SAS/IBM2A BATRoHSE FRU	
FINB	2182700	ASR-4800SAS/128MB BULK	
FINB	2137600	ASR-4005SAS/256MB/IBM OPT KT	
FINB	2180800	ASC-48300 with I2C HR Kit	
FINB	2186100	ASC-48300 with I2C HR 10 PK	
FINB	2220200-R	ASC-44300 RoHS Bulk	
FINB	2204500-E	ASR-4005SAS/256/IBM3U RoHSE BK	
FINB	2214400-E	ASR-4005SAS/256/IBMPIVRoHSE BK	
FINB	2187500-E	ATB-205/32MB/IBM RoHSE BULK	
FINS	2224200	SEAGATE 36GB SAS DISK DRIVE	

EXHIBIT B

PRICING FOR FORECASTED SINGAPORE PRODUCTS

1. Price Calculation.

(a) Except for Singapore Systems as specified in subsection (b) below, and as otherwise provided in Sections 2, 3 and 4 below, prices for Forecasted Singapore Products shall be established * and shall be set at the *, as set forth in Appendix 1 hereto *:

- * for the period beginning as of the * and ending on *;
- * for the period beginning as of the * and ending on *;
- * for the period beginning as of the * and ending on the *;
- After the *,
 - * for Forecasted Singapore Products for which *; and
 - * for Forecasted Singapore Products for which *. In no event shall the * for each Forecasted Singapore Product be *.

For the purpose of determining the *, and * provided by ADAPTEC under a consignment model shall be deemed *.

(b) Notwithstanding the provisions of subsection (a) above (including any * specified therein), the pricing for Singapore Products * will be equal to *.

(c) For Singapore Products manufactured by SANMINA-SCI pursuant to Section 5.4(c) (“Upside Demand”), the pricing will be as set forth in this Exhibit B, herein, but SANMINA-SCI shall also be entitled to charge ADAPTEC *. In addition, ADAPTEC shall be financially responsible for *.

(d) In the event the Closing does not occur on or before January 13, 2006, the *.

2. Committed Cost Reductions.

(a) Commencing with * after the Closing Date and continuing for * thereafter, SANMINA-SCI shall * (the “**Committed Cost Reduction**”); provided, however, that the Committed Cost Reduction shall not take effect until *. During the period in which such *; the Committed Cost Reduction shall be prorated to reflect the *.

(b) SANMINA-SCI’s obligation with respect to Committed Cost Reduction, as set forth in subsection (a), above, is predicated *. In the event that *, (i) the Committed Cost Reduction shall not apply, but (ii) any cost reduction achieved will be shared by the Parties in accordance with the provisions of Section 3 below.

3. Further Cost Reductions. In the event SANMINA-SCI is able to enjoy cost reductions above and beyond the Committed Cost Reductions or in the event ADAPTEC is able to achieve cost reductions on * (“**Further Reductions**”), the Further Reductions shall be shared between ADAPTEC and SANMINA-SCI as follows:

- * to ADAPTEC / * to SANMINA-SCI for the first 2 quarters following the quarter in which the Further Reduction becomes effective;
- * to ADAPTEC / * to SANMINA-SCI for the ensuing two quarters; and
- * to ADAPTEC thereafter

* Confidential treatment requested

4. Other Changes in Pricing Model. The Parties agree that:

(a) *.

(b) Either Party shall have the right to revise prices (i) to account for * or (ii) to account for any changes in the exchange rate (in excess of 2%) during any given quarter) between the currency in which the pricing is calculated (currently United States Dollars) and the currency in which SANMINA-SCI pays for its labor and overhead (Singapore Dollars, Malaysian Ringgit and Indonesia Rupiah) *; provided, that, for the avoidance of doubt, *. When determining the amount by which prices should be adjusted, the Parties agree that (i) the portion of the pricing model representing * and (ii) the exchange rates upon which the pricing model is based are

INDIAN RUPIAH	\$1 = IDR 10,053
SINGAPORE DOLLAR	\$1 = SGD 1.69
MALAYSIAN RINGGIT	\$1 = MYR 3.775

*

5. Out of Warranty Repair Pricing. In accordance with Section 8.2, out-of warranty services will be provided on a “time and materials” basis, using a labor rate of *.

* Confidential treatment requested

APPENDIX 1

*

SANMINA-SCI has the right to validate the * set forth in Exhibit B up to sixty (60) days after Closing, and the Parties will revise Appendix 1 in a manner consistent with such validation. For example, if * for a Singapore Product is *, but SANMINA-SCI *, then Appendix 1 will be modified * for such Singapore Product.

* Confidential treatment requested

Appendix 1

P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
400	FINC	722511	AIC-7880P REV A1	*	*	*	*	*	*	*
		738611	AIC-7860Q REV B	*	*	*	*	*	*	*
		738612	(OBS) AIC-7860T REV B	*	*	*	*	*	*	*
		738620	AIC-7860QR REV B	*	*	*	*	*	*	*
		740111	AIC-7880P REV B1	*	*	*	*	*	*	*
		741611	AIC-7815G REV A1	*	*	*	*	*	*	*
		742111	AIC-7890AB REV A	*	*	*	*	*	*	*
		742211	AIC-7859T REV B	*	*	*	*	*	*	*
		742220	AIC-7859TR REV B	*	*	*	*	*	*	*
		742420	AIC-3860Q REV A3	*	*	*	*	*	*	*
		742423	AIC-3860QR REV A3	*	*	*	*	*	*	*
		742811	AIC-7895P REV C	*	*	*	*	*	*	*
		745011	AIC-7856T REV B	*	*	*	*	*	*	*
		745911	AIC-7815G REV B	*	*	*	*	*	*	*
		747111	(OBS)AIC-7896N REV A	*	*	*	*	*	*	*
		747211	AIC-7897N REV A	*	*	*	*	*	*	*
		747511	AIC-7880P REV C	*	*	*	*	*	*	*
		747512	AIC-7880H REV C	*	*	*	*	*	*	*
		748412	AIC-7890ABR REV C	*	*	*	*	*	*	*
		748511	AIC-7891B REV C	*	*	*	*	*	*	*
		752311	(OBS)AIC-43C97M REV C1	*	*	*	*	*	*	*
		752911	AIC-7865T REV B	*	*	*	*	*	*	*
		753312	AIC-7899G REV B	*	*	*	*	*	*	*
		753315	AIC-7899GR REV B	*	*	*	*	*	*	*
		753411	AIC-7892B REV B1	*	*	*	*	*	*	*
		753420	AIC-7892BR REV B1	*	*	*	*	*	*	*
		753711	AIC-7930W REV A	*	*	*	*	*	*	*
		754811	AIC-7902W REV A4	*	*	*	*	*	*	*
		754911	AIC-7901X REV A1	*	*	*	*	*	*	*
		755211	AIC-7902W REV B_HBA	*	*	*	*	*	*	*
		755212	AIC-7902WR REV B_HBA	*	*	*	*	*	*	*
		755812	AIC-7902WR REV B	*	*	*	*	*	*	*
		755911	AIC-7901X REV B_HBA	*	*	*	*	*	*	*
		755912	AIC-7901XR REV B_HBA	*	*	*	*	*	*	*
		757611	AIC-7942W REV B	*	*	*	*	*	*	*
		757612	AIC-7942WR REV B	*	*	*	*	*	*	*
401	RAWB	01K2290	RES;6.8KX4,5%,.063W,1206	*	*	*	*	*	*	*
		01K2343	47UF,20%;6.3V;AL,2816L	*	*	*	*	*	*	*
		01K2389	IND;10UH,20%,5400MA(DC)	*	*	*	*	*	*	*
		01K2714	0.068UF, 10%; 16V; 0603; X7R	*	*	*	*	*	*	*
		01K2841	RES; 4.7 1%;.125W;0805	*	*	*	*	*	*	*
		02N4652	RES;475,.1%.1W;THIN FILM;0805	*	*	*	*	*	*	*
		03G9605	0.01UF,10%;50V;0603;X7R	*	*	*	*	*	*	*
		03G9676	RES;48.7K,1%;.125W;0805	*	*	*	*	*	*	*
		03G9704	RES;102K,1%;.125W;0805	*	*	*	*	*	*	*
		04P9507	4.7UF,10%,16V,1206,X5R	*	*	*	*	*	*	*
		04P9511	8200PF,10%,50V,0603,X7R	*	*	*	*	*	*	*
		04P9576	OSC;100MHZ,3.3 V;CSMT;4LEADS	*	*	*	*	*	*	*
		04P9585	2.5V PLL CLOCK DRIVER	*	*	*	*	*	*	*
		04P9650	RES;2.32K,0.1%;THIN FILM;0805	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		04P9651	RES;24.9K,0.1%;THIN FILM;0805	*	*	*	*	*	*	*
		04P9652	RES;49.9K,0.1%;THIN FILM;0805	*	*	*	*	*	*	*
		04P9726	1 TO 4 CLOCK BUFFER	*	*	*	*	*	*	*
		04P9793	100UF,20%;16V;AL,SMT	*	*	*	*	*	*	*
		04P9808	8PF, +-0.25PF; 50V; 0402; NPO	*	*	*	*	*	*	*
		04P9815	LI ION CHARGE IC,W/INT. CNTRLR	*	*	*	*	*	*	*
		04P9887	PNP PWR TRANS;LO SAT,SOT-223	*	*	*	*	*	*	*
		05K2491	RES;11.5K,1%;THIN FILM;0805	*	*	*	*	*	*	*
		08G3032	LABEL, STOCK-MINI	*	*	*	*	*	*	*
		08G4811	RES;10,1%;.1W;0603	*	*	*	*	*	*	*
		08G4886	RES;43,5%;.1W;0603	*	*	*	*	*	*	*
		08G4891	RES; 82, 5%; .1W; 0603	*	*	*	*	*	*	*
		08G4895	RES;120,5%;.1W;0603	*	*	*	*	*	*	*
		08G4906	RES;430,5%;.1W;0603	*	*	*	*	*	*	*
		08G4921	RES;3K,5%;.1W;0603	*	*	*	*	*	*	*
		08G4928	RES;6.8K,5%;.1W;0603	*	*	*	*	*	*	*
		08G4935	RES;15K,5%;.1W;0603	*	*	*	*	*	*	*
		08G5006	RES; 24, 5%; .1W; 0603	*	*	*	*	*	*	*
		08G5116	RES;28K,1%;.125W;0805	*	*	*	*	*	*	*
		08G5165	RES;100K,1%;.125W;0805	*	*	*	*	*	*	*
		08G5167	RES;2K,1%;.125W;0805	*	*	*	*	*	*	*
		08G5174	RES;909,1%;.125W;0805	*	*	*	*	*	*	*
		09G9131	RES; 24.3, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9161	RES; 49.9, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9190	RES;.1K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9198	RES; 121, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9201	RES; 130, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9244	RES;365,1%;.1W;0603	*	*	*	*	*	*	*
		09G9252	RES; 442, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9257	RES; .499K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9271	RES; 698, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9276	RES; 787, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9282	RES; 909, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9286	RES; 1K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9297	RES; 1.3K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9303	RES; 1.5K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9306	RES;1.62K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9314	RES; 1.96K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9315	RES; 2K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9316	RES; 2.05K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9321	RES;2.32K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9323	RES; 2.43K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9327	RES; 2.67K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9332	RES; 3.01K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9353	RES;4.99K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9361	RES; 6.04K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9365	RES; 6.65K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9366	RES; 6.81K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9370	RES; 7.5K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9371	RES; 7.68K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9374	RES;8.25K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9381	RES; 9.76K, 1%; .1W; 0603	*	*	*	*	*	*	*

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		09G9382	RES;10K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9386	RES; 11K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9388	RES; 11.5K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9397	RES; 14.3K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9399	RES; 15K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9404	RES; 16.9K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9405	RES;17.4K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9407	RES; 18.2K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9411	RES;20K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9422	RES; 26.1K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9432	RES; 33.2K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9436	RES; 36.5K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9438	RES; 38.3K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9443	RES; 43.2K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9446	RES; 46.4K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9447	RES;47.5K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9448	RES; 48.7K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9457	RES; 60.4K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9458	RES; 61.9K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9464	RES;71.5K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9470	RES; 82.5K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9474	RES; 90.9K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9477	RES; 97.6K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9478	RES;100K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9479	RES; 102K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9486	RES; 121K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9487	RES; 124K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9491	RES; 137K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9495	RES; 150K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9504	RES; 187K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9510	RES;215K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9519	RES;267K,1%;.1W;0603	*	*	*	*	*	*	*
		09G9535	RES; 392K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9545	RES; 499K, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9574	RES; 1M, 1%; .1W; 0603	*	*	*	*	*	*	*
		09G9731	2200PF, 5%; 50V; 0603; X7R	*	*	*	*	*	*	*
		09G9735	0.001UF,5%;50V;0603;X7R	*	*	*	*	*	*	*
		09G9736	220PF,5%;50V;0603;NPO	*	*	*	*	*	*	*
		09G9739	RES; 100, 1%; .125W; 0805	*	*	*	*	*	*	*
		09G9742	RES;22.1K,1%;.125W;0805	*	*	*	*	*	*	*
		09G9748	RES;2.7K,5%;.125W;0805	*	*	*	*	*	*	*
		09G9947	RES;.301K,1%;.125W;0805	*	*	*	*	*	*	*
		09J5074	0.027UF,10%;16VDC;0603;X7R	*	*	*	*	*	*	*
		09L5706	CONNECTOR, MICTOR, 38 POSITION	*	*	*	*	*	*	*
		10-00226-003-20	CAP, 22UF 16V AL H7.0 RAD	*	*	*	*	*	*	*
		10063	LED, RED DIFFUSED (T-1 3/4)	*	*	*	*	*	*	*
		10114	CONN, 4-PIN DISC DRIVE POWER	*	*	*	*	*	*	*
		10116	HEADER, 20-PIN DIP	*	*	*	*	*	*	*
		10122	SOCKET, 28 PIN DIP	*	*	*	*	*	*	*
		10148	RES NTWK, 9X4.7K 2% SIP10	*	*	*	*	*	*	*
		10173	HEADER, 3-PIN SIP	*	*	*	*	*	*	*
		10175	HEADER, 5-PIN SIP	*	*	*	*	*	*	*

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		10287	HEADER, 8-PIN DIP	*	*	*	*	*	*	*
		10295	HEADER, 4-PIN POWER RA	*	*	*	*	*	*	*
		10305	CAP, 10uF 25V 20% AL ELEC RAD	*	*	*	*	*	*	*
		10331	HEADER, 14-PIN DIP	*	*	*	*	*	*	*
		10332	HEADER, 2-PIN DIP	*	*	*	*	*	*	*
		10332-R	HEADER, 2-PIN DIP	*	*	*	*	*	*	*
		10370	LABEL, IC/PCA POLYESTER WHITE	*	*	*	*	*	*	*
		10400	LABEL, .65" x .20" WHT POLY	*	*	*	*	*	*	*
		10H6104	IND;10UH,10%;300MA,1210	*	*	*	*	*	*	*
		10H6144	10UF,+80-20%;16V;1210;Y5V	*	*	*	*	*	*	*
		10H7189	0.047UF, 10%; 16V; 0603; X7R	*	*	*	*	*	*	*
		11031	TRANS, 2N2222A NPN GP (TO-18)	*	*	*	*	*	*	*
		11088	HEADER, 6-PIN DIP	*	*	*	*	*	*	*
		11089	HEADER, 4-PIN DIP	*	*	*	*	*	*	*
		111158-001	COMPAQ BOX	*	*	*	*	*	*	*
		11130	DIODE, 1N5820 3A 20V SHTKY BRR	*	*	*	*	*	*	*
		11158	RES NTWK, 9X10K 2% SIP10	*	*	*	*	*	*	*
		11160	RES NTWK, 220/330 DT 2% SIP8	*	*	*	*	*	*	*
		11166	HEADER, 10-PIN DIP	*	*	*	*	*	*	*
		11178	DIODE, 1N5817 1A 20V SHTKY BRR	*	*	*	*	*	*	*
		11258	BAG, 6" X 10" STATIC SHIELD	*	*	*	*	*	*	*
		11276	CAP, CHIP 820PF 50V NPO 1206	*	*	*	*	*	*	*
		11278	CAP, CHIP .01UF 50V Z5U 0805	*	*	*	*	*	*	*
		11279	CAP, CHIP 100PF 50V NPO 0805	*	*	*	*	*	*	*
		11281	DIODE, 1N4148 FAST SW SOT	*	*	*	*	*	*	*
		11281-R	DIODE, 1N4148 FAST SW SOT	*	*	*	*	*	*	*
		11284	RES, CHIP 100 5% 1/8W 1206	*	*	*	*	*	*	*
		11286	RES, CHIP 1K 5% 1/8W 1206	*	*	*	*	*	*	*
		11287	RES, CHIP 2.2K 5% 1/8W 1206	*	*	*	*	*	*	*
		11326	RES, CHIP 220 5% 1/8W 1206	*	*	*	*	*	*	*
		11349	CONN, BNC VERT PCB/PANEL MOUNT	*	*	*	*	*	*	*
		11357	CAP, CHIP .1UF 50V X7R 1206	*	*	*	*	*	*	*
		11358	RES, CHIP 22 5% 1/8W 1206	*	*	*	*	*	*	*
		11359	RES, CHIP 10K 5% 1/8W 1206	*	*	*	*	*	*	*
		11365	HEADER, 4-PIN SIP	*	*	*	*	*	*	*
		11376	INSERT, 50PCK ACB-2320/2370	*	*	*	*	*	*	*
		11379	WASHER, #4 FLAT NYLON 1/16 THK	*	*	*	*	*	*	*
		11379-R	WASHER, #4 FLAT NYLON 1/16 THK	*	*	*	*	*	*	*
		11461	IC, 74LS174(SO) HEX D-FF	*	*	*	*	*	*	*
		11465	TRANS, MMBT3904 NPN GP SOT-23	*	*	*	*	*	*	*
		11465-R	TRANS, MMBT3904 NPN GP SOT-23	*	*	*	*	*	*	*
		11466-R	TRANS, 2N3906(SOT) PNP GP	*	*	*	*	*	*	*
		11474	RES, CHIP 100 1% 1/8W 1206	*	*	*	*	*	*	*
		11483	RES, CHIP 430 5% 1/8W 1206	*	*	*	*	*	*	*
		11486	RES, CHIP 910 5% 1/8W 1206	*	*	*	*	*	*	*
		11490	RES, CHIP 3.3K 5% 1/8W 1206	*	*	*	*	*	*	*
		11518	CAP, CHIP 2200PF 50V X7R 0805	*	*	*	*	*	*	*
		11526	IC, 74ALS139(SO) 1-OF-4 DEMUX	*	*	*	*	*	*	*
		11534	FILM, ESD STATIC SHIELD	*	*	*	*	*	*	*
		11554	BAG, 6.5" X 18" STATIC SHIELD	*	*	*	*	*	*	*
		11576	IC, 74F74(SO) DUAL EDG-TR D-FF	*	*	*	*	*	*	*
		11593	HEADER, 6-PIN FRICTION-LOCK	*	*	*	*	*	*	*

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		11598	RES, CHIP 4.7K 5% 1/8W 1206	*	*	*	*	*	*	*
		11661	RES, CHIP ZERO-OHM JUMPER 1206	*	*	*	*	*	*	*
		11661-R	RES, CHIP ZERO-OHM JUMPER 1206	*	*	*	*	*	*	*
		11674	IC, 74ALS74(SO) DUAL D-FF E/T	*	*	*	*	*	*	*
		11690	CONN, POST .025" SQ (TEST PT)	*	*	*	*	*	*	*
		11711	XTAL, 24MHZ LO-PRO P-RES 49S	*	*	*	*	*	*	*
		11738	CAP: 1000PF 10% 50V X7R 1206	*	*	*	*	*	*	*
		11785	CARD, HUMIDITY INDICATOR	*	*	*	*	*	*	*
		11808	CAP, CHIP 22UF 20V TANT 7343	*	*	*	*	*	*	*
		11832	HEADER, 20-PIN DIP RA SHROUDED	*	*	*	*	*	*	*
		11832-R	HEADER, 20-PIN DIP RA SHROUDED	*	*	*	*	*	*	*
		11847	CAP, 22UF 25V 20% AL ELEC RAD	*	*	*	*	*	*	*
		11941	CONN, SHUNT DW AU .265" MAX HT	*	*	*	*	*	*	*
		11946	LABEL, CAUTION/MADE IN S'PORE	*	*	*	*	*	*	*
		11983	IC, 74ALS08(SO) QUAD 2-INP AND	*	*	*	*	*	*	*
		11994	OSC, XTAL TTL CLK 40MHZ FS	*	*	*	*	*	*	*
		11996	IC, 74ALS00A(SO) QUAD 2IN NAND	*	*	*	*	*	*	*
		12013	CONN, 25-P DSUB RCPT RA NO H/W	*	*	*	*	*	*	*
		12019	IC, GAL 16V8 15NS PCI2.1 PLCC	*	*	*	*	*	*	*
		12085	CONN, 50-P RA SCSI-2 4-40 BL F	*	*	*	*	*	*	*
		12087	DISKETTE, 3 1/2 DSHD SWITCH BK	*	*	*	*	*	*	*
		12099	FERRITE CHIP, EMI FLT Z70 1206	*	*	*	*	*	*	*
		12099-R	FERRITE CHIP, EMI FLT Z70 1206	*	*	*	*	*	*	*
		12100	FERRITE CHIP, EMI LF Z600 1206	*	*	*	*	*	*	*
		12133	LABEL, IC AMB PLYMD 1/4" SQ	*	*	*	*	*	*	*
		12134	LABEL, IC AMB PLYMD 3/8" SQ	*	*	*	*	*	*	*
		12161	RES, CHIP 10 5% 1/8W 1206	*	*	*	*	*	*	*
		12187	FILTER, EMI 22000PF DISC 3-LD	*	*	*	*	*	*	*
		12209	DIODE, MBRD320 3A 20V SHTKY BR	*	*	*	*	*	*	*
		12269	TRANS, MMBT2222A NPN GP SOT-23	*	*	*	*	*	*	*
		12349	CAP, CHIP 10uF 25V TANT 7343	*	*	*	*	*	*	*
		12352	HEADER, 20-PIN DIP SHD	*	*	*	*	*	*	*
		12436	RES, CHIP 110 1% 1/10W 0805	*	*	*	*	*	*	*
		12438	IC, 74ALS874(SOL)DUAL 4-B D-FF	*	*	*	*	*	*	*
		12465	LED, RED SUBMINIATURE (SM GW)	*	*	*	*	*	*	*
		12492	HDR, 2X5X.1 RA SHRD	*	*	*	*	*	*	*
		12497	HEADER, 50-P DIP RA SHD OPNBCK	*	*	*	*	*	*	*
		12500	CAP: 0.1uF 20% 25V Z5U 0805	*	*	*	*	*	*	*
		12521	RES, CHIP ZERO-OHM JUMPER 0805	*	*	*	*	*	*	*
		12521-R	RES, CHIP ZERO-OHM JUMPER 0805	*	*	*	*	*	*	*
		12525	RES, CHIP 75 5% 1/10W 0805	*	*	*	*	*	*	*
		12532	CKT PROTECT, 1.25AMP SMD125	*	*	*	*	*	*	*
		12561	RES, CHIP 62 5% 1/10W 0805	*	*	*	*	*	*	*
		12562	RES, CHIP 30 5% 1/10W 0805	*	*	*	*	*	*	*
		12575	CONN, 9-PIN DSUB FEMALE RA	*	*	*	*	*	*	*
		12590	CONN, 68-P RA P-CONN RCP NS BL	*	*	*	*	*	*	*
		12608	CONN, 68-P RA P-CONN NR 440 BL	*	*	*	*	*	*	*
		12612	IC, 93C46 1K SER EEPROM SO	*	*	*	*	*	*	*
		12623	LED, CHIP RED LHT674-LN TOP	*	*	*	*	*	*	*
		12679	CAP: 1000PF 10% 50V X7R 0805	*	*	*	*	*	*	*
		12680	CAP, CHIP 220PF 50V NPO 0805	*	*	*	*	*	*	*
		12725	RES, CHIP 10K 5% 1/10W 0805	*	*	*	*	*	*	*

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		12726	RES, CHIP 150 5% 1/10W 0805	*	*	*	*	*	*	*
		12727	RES, CHIP 22 5% 1/10W 0805	*	*	*	*	*	*	*
		12728	RES, CHIP 220 5% 1/10 0805	*	*	*	*	*	*	*
		12729	RES, CHIP 2K 5% 1/10W 0805	*	*	*	*	*	*	*
		12730	RES, CHIP 5.1K 5% 1/10W 0805	*	*	*	*	*	*	*
		12734	BRACKET, PCI SCSI-2 SE LOGO	*	*	*	*	*	*	*
		12758	XTAL, 18.432M LO-PRO P-RES 49S	*	*	*	*	*	*	*
		12769	RES, CHIP 220K 5% 1/8W 1206	*	*	*	*	*	*	*
		12796	CAP: CHIP 33PF 50V NPO 0805	*	*	*	*	*	*	*
		12798	CAP, CHIP 4700PF 50V X7R 0805	*	*	*	*	*	*	*
		12801	CAP, CHIP 10UF 10V TANT 6032	*	*	*	*	*	*	*
		12803	CAP, CHIP 1UF 35V TANT 3528	*	*	*	*	*	*	*
		12805	RES, CHIP 2.2K 5% 1/10W 0805	*	*	*	*	*	*	*
		12806	RES, CHIP 4.7K 5% 1/10W 0805	*	*	*	*	*	*	*
		12808	RES, CHIP 33 5% 1/10W 0805	*	*	*	*	*	*	*
		12809	RES, CHIP 1M 5% 1/10W 0805	*	*	*	*	*	*	*
		12810	RES, CHIP 1K 5% 1/10W 0805	*	*	*	*	*	*	*
		12811	RES, CHIP 100K 5% 1/10W 0805	*	*	*	*	*	*	*
		12819	HEADER, 50-PIN DIP SHD	*	*	*	*	*	*	*
		12858	RES, CHIP 100 5% 1/10W 0805	*	*	*	*	*	*	*
		12875	CAP, CHIP 4.7UF 16V TA FUS6032	*	*	*	*	*	*	*
		12876	CAP, CHIP 10UF 16V TA FUS6032	*	*	*	*	*	*	*
		12903	TERMINATOR, SCSI SE REG MA/FEM	*	*	*	*	*	*	*
		12908	BRACKET, PCI WIDE SCSI SE LOGO	*	*	*	*	*	*	*
		12923	IC, 256KX36(72-P SIMM)DRAM 70	*	*	*	*	*	*	*
		12942	RES, CHIP 470 5% 1/10W 0805	*	*	*	*	*	*	*
		12943	RES, CHIP 3.0K 5% 1/10W 0805	*	*	*	*	*	*	*
		12943-R	RES, CHIP 3.0K 5% 1/10W 0805	*	*	*	*	*	*	*
		12955	BRACKET, PCI ISA BLANK	*	*	*	*	*	*	*
		12956	RES, CHIP 1.21K 1% 1/10W 0805	*	*	*	*	*	*	*
		12957	RES, CHIP 3.3K 5% 1/10W 0805	*	*	*	*	*	*	*
		12986	RES, CHIP 100 1% 1/10W 0805	*	*	*	*	*	*	*
		12993	RES, CHIP 80.6 1% 1/10W 0805	*	*	*	*	*	*	*
		13014	RES, CHIP 107K 1% 1/10W 0805	*	*	*	*	*	*	*
		13020	RES, CHIP 383K 1% 1/10W 0805	*	*	*	*	*	*	*
		13022	RES, CHIP 681K 1% 1/10W 0805	*	*	*	*	*	*	*
		13028	DIODE, SHTK DUAL CC SOT23	*	*	*	*	*	*	*
		13038	IC, TL7705BD(SO) V SUPERVISOR	*	*	*	*	*	*	*
		13040	RETAINER, PLASTIC PCI/ISA	*	*	*	*	*	*	*
		13042	CAP, CHIP 1uF 16V TANT 3216	*	*	*	*	*	*	*
		13045	RES, CHIP 4.99K 1% 1/10W 0805	*	*	*	*	*	*	*
		13056	HEADER, 6-PIN SIP RA 2mm	*	*	*	*	*	*	*
		13070	CKT PROTECT, 1.1AMP RUE110	*	*	*	*	*	*	*
		13073	RES, CHIP 47 5% 1/10W 0805	*	*	*	*	*	*	*
		13087	DIODE, MBRS120T3(SMB)1A 20V SB	*	*	*	*	*	*	*
		13089	IC, 32KX9(SOJ) SRAM 20NS CMOS	*	*	*	*	*	*	*
		13094	IC, 2105Z(SO) SCSI TERMINATOR	*	*	*	*	*	*	*
		13095	IC, 93C66 4K SER EEPROM SO	*	*	*	*	*	*	*
		13095-R	IC, 93C66 4K SER EEPROM SO	*	*	*	*	*	*	*
		13104	RES, CHIP 75.0 1% 1/10W 0805	*	*	*	*	*	*	*
		13106	TRANS, 2N7002 N-MOSFET SOT-23	*	*	*	*	*	*	*
		131215-002	COMPAQ 131216-019 QUAL STAT	*	*	*	*	*	*	*

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		13122	RES, CHIP 1 5% 1/10W 0805	*	*	*	*	*	*	*
		13122-R	RES, CHIP 1 5% 1/10W 0805	*	*	*	*	*	*	*
		13123	RES, CHIP 10 5% 1/10W 0805	*	*	*	*	*	*	*
		13124	RES, CHIP 100K 1% 1/10W 0805	*	*	*	*	*	*	*
		13127	RES, CHIP 255K 1% 1/10W 0805	*	*	*	*	*	*	*
		13131	CAP, CHIP 47UF 16V TANT 7343	*	*	*	*	*	*	*
		13136	RES, CHIP 221 1% 1/10W 0805	*	*	*	*	*	*	*
		13138	RES, CHIP 124 1% 1/10W 0805	*	*	*	*	*	*	*
		13144	CAP, CHIP 22PF 50V NPO 0805	*	*	*	*	*	*	*
		13148	DIODE, SHTK BARR 20V 3A SMC	*	*	*	*	*	*	*
		13156	RES, CHIP 221K 1% 1/10W 0805	*	*	*	*	*	*	*
		13159	RES, CHIP 200 1% 1/10W 0805	*	*	*	*	*	*	*
		13161	RES, CHIP 11.8K 1% 1/8W 1206	*	*	*	*	*	*	*
		13169	IC, 27C512(PDIP-28) OTP 150NS	*	*	*	*	*	*	*
		13172	IC, 74ABT126(SSOP) 4 BUS BFR3S	*	*	*	*	*	*	*
		13181	RES, CHIP 464K 1% 1/10W 0805	*	*	*	*	*	*	*
		13191	RES, CHIP 2.7K 5% 1/10W 0805	*	*	*	*	*	*	*
		13193	OSC, XTAL TTL CLK 40MHZ 1/2 3S	*	*	*	*	*	*	*
		13194	RES, CHIP 33K 5% 1/10W 0805	*	*	*	*	*	*	*
		13201	IC, 21S07AS SCSI TRM SOL	*	*	*	*	*	*	*
		13221	CONN, 68-PIN RCPT RA .8MM	*	*	*	*	*	*	*
		13221-R	CONN, 68-PIN RCPT RA .8MM	*	*	*	*	*	*	*
		13222	CONN, 68-PIN RCPT STRDLMT	*	*	*	*	*	*	*
		13226	HEADER, 2-PIN SIP SMT 2mm	*	*	*	*	*	*	*
		13227	HEADER, 3-PIN SIP SMT 2mm	*	*	*	*	*	*	*
		13233	RES, CHIP 2.4 5% 1/10W 0805	*	*	*	*	*	*	*
		13235	RES, CHIP 523K 1% 1/10W 0805	*	*	*	*	*	*	*
		13259	IC, ISPLSI2064 PLD 100MHZ TQFP	*	*	*	*	*	*	*
		13261	RES, CHIP 11.8K 1% 1/10W 0805	*	*	*	*	*	*	*
		13275	RES, CHIP 15K 5% 1/10W 0805	*	*	*	*	*	*	*
		13280	RES, CHIP 330 5% 1/10W 0805	*	*	*	*	*	*	*
		13282	SCREWLOCK, M2X0.4M/M2X0.4F THD	*	*	*	*	*	*	*
		13282-R	SCREWLOCK, M2X0.4M/M2X0.4F THD	*	*	*	*	*	*	*
		13287	BRACKET, PCI SCSI2 2.6"SE LOGO	*	*	*	*	*	*	*
		13298	IC, 2108(SOL)DIFF SCSI TRM	*	*	*	*	*	*	*
		13300	IC, 75976A2(TSSOP)9CH DIFF XCV	*	*	*	*	*	*	*
		13305	HEADER, 8-PIN SIP	*	*	*	*	*	*	*
		13335	RES, CHIP 51 5% 1/10W 0805	*	*	*	*	*	*	*
		13336	INDUCTOR, CHIP .47UH 10% 1210	*	*	*	*	*	*	*
		13342	CAP, CHIP 100UF 16V TANT 7343	*	*	*	*	*	*	*
		13344	RES, CHIP 47K 5% 1/10W 0805	*	*	*	*	*	*	*
		13346	CAP, CHIP 68PF 50V NPO 0805	*	*	*	*	*	*	*
		13347	RES, CHIP 33.2K 1% 1/10W 0805	*	*	*	*	*	*	*
		13351	CAP, CHIP .1UF 25V X7R 0805	*	*	*	*	*	*	*
		13353	IC, ispLSI2032(TQFP) PLD 80MHZ	*	*	*	*	*	*	*
		13365	IC, GAL 18V10(PLCC) 15NS CMOS	*	*	*	*	*	*	*
		13372	IC, X9C102(SO) 1K DIG POT	*	*	*	*	*	*	*
		13379	RES, CHIP 100 5% 1/2W 2010	*	*	*	*	*	*	*
		13381	XTAL, 40MHZ 3 O/T P-RES HC-49U	*	*	*	*	*	*	*
		13384	IC, 29EE512A FLH 120NS 1K PLCC	*	*	*	*	*	*	*
		13402	LED, CHIP GRN HSMG TOP 3528	*	*	*	*	*	*	*
		13402-R	LED, CHIP GRN HSMG TOP 3528	*	*	*	*	*	*	*

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		13403	CAP, CHIP 1000PF 100V NPO 0805	*	*	*	*	*	*	*
		13404	CAP: 0.01UF 10% 100V X7R 0805	*	*	*	*	*	*	*
		13407	IC, LT1086 LDO VR 3.3V 1.5A M	*	*	*	*	*	*	*
		13422	DIODE, MBR0530(SOD).5A 30V SB	*	*	*	*	*	*	*
		13430	CKT PROTECT, 0.5AMP 1812	*	*	*	*	*	*	*
		13434	RES, CHIP 13.7K 1% 1/10W 0805	*	*	*	*	*	*	*
		13435	RES, CHIP 2.21K 1% 1/10W 0805	*	*	*	*	*	*	*
		13447	IC, 24C02(SO) 2K SER EEPROM	*	*	*	*	*	*	*
		13475	RES, CHIP 150 1% 1/10W 0805	*	*	*	*	*	*	*
		13491	RES, CHIP 5.76K 1% 1/10W 0805	*	*	*	*	*	*	*
		13493	RES, CHIP 56 5% 1/10W 0805	*	*	*	*	*	*	*
		13494	RES, CHIP 732K 1% 1/10W 0805	*	*	*	*	*	*	*
		13497	DIODE, MBRS330T3 SB 3A 30V SMC	*	*	*	*	*	*	*
		13497-R	DIODE, MBRS330T3 SB 3A 30V SMC	*	*	*	*	*	*	*
		13507	HEADER, 16-PIN DIP SHD	*	*	*	*	*	*	*
		13508	CONN, RF SMA PCB MOUNT	*	*	*	*	*	*	*
		13526	SWITCH, N.O. PB GULL WING SMT	*	*	*	*	*	*	*
		13527	HEADER, 5-PIN SIP RA	*	*	*	*	*	*	*
		13547	CAP, CHIP 10PF 50V NPO 0805	*	*	*	*	*	*	*
		13555	RES, CHIP 1.00K 1% 1/10W 0805	*	*	*	*	*	*	*
		13575	CAP, CHIP 10UF 16V TANT 3528	*	*	*	*	*	*	*
		13579	IC, 27C010(DIP) EPROM 120NS	*	*	*	*	*	*	*
		13620	RES, CHIP 3.65K 1% 1/10W 0805	*	*	*	*	*	*	*
		13621	RES, CHIP 35.7K 1% 1/10W 0805	*	*	*	*	*	*	*
		13622	IC, 74HC00(SO) QUAD 2-IN NAND	*	*	*	*	*	*	*
		13658	BRACKET, 68-POS HI-DENSITY	*	*	*	*	*	*	*
		13670	BRACKET, BLANK ARO-1130	*	*	*	*	*	*	*
		13681	CAP: 0.01UF 10% 50V X7R 0603	*	*	*	*	*	*	*
		13681-R	CAP: 0.01UF 10% 50V X7R 0603	*	*	*	*	*	*	*
		13683	RES NTWK, CHIP 4X22 5% 3216	*	*	*	*	*	*	*
		13684	RES NTWK, CHIP 4X4.7K 5% 3216	*	*	*	*	*	*	*
		13685	RES, CHIP 33 5% 1/16W 0603	*	*	*	*	*	*	*
		13685-R	RES, CHIP 33 5% 1/16W 0603	*	*	*	*	*	*	*
		13688	RES, CHIP 10 5% 1/16W 0603	*	*	*	*	*	*	*
		13688-R	RES, CHIP 10 5% 1/16W 0603	*	*	*	*	*	*	*
		13689	RES, CHIP 1.0K 5% 1/16W 0603	*	*	*	*	*	*	*
		13689-R	RES, CHIP 1.0K 5% 1/16W 0603	*	*	*	*	*	*	*
		13690	RES, CHIP 4.7K 5% 1/16W 0603	*	*	*	*	*	*	*
		13690-R	RES, CHIP 4.7K 5% 1/16W 0603	*	*	*	*	*	*	*
		13691	RES, CHIP 10K 5% 1/16W 0603	*	*	*	*	*	*	*
		13691-R	RES, CHIP 10K 5% 1/16W 0603	*	*	*	*	*	*	*
		13692	RES, CHIP 10M 5% 1/16W 0603	*	*	*	*	*	*	*
		13694	RES, CHIP 100K 1% 1/16W 0603	*	*	*	*	*	*	*
		13695	RES, CHIP 330 5% 1/16W 0603	*	*	*	*	*	*	*
		13696	RES, CHIP 11.8K 1% 1/16W 0603	*	*	*	*	*	*	*
		13700	LED, YEL RA MT .200HT T1	*	*	*	*	*	*	*
		13704	CAP, CHIP 22UF 20V TA FUS 7343	*	*	*	*	*	*	*
		13706	XTAL, 14.318MHZ P-RES .2HT SMD	*	*	*	*	*	*	*
		13708	RES, CHIP ZERO-OHM JUMPER 0603	*	*	*	*	*	*	*
		13708-R	RES, CHIP ZERO-OHM JUMPER 0603	*	*	*	*	*	*	*
		13721	IC, 32KX8 SRAM(SOJ) 15NS CMOS	*	*	*	*	*	*	*
		13727	RES, CHIP 22K 5% 1/10W 0805	*	*	*	*	*	*	*

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		13742	CAP, CHIP 10UF 16V AL 434355	*	*	*	*	*	*	*
		13765	IC, LT1117 LDO VR 3.3V SOT223	*	*	*	*	*	*	*
		13767	CAP, CHIP 10UF 16V Y5V 1210	*	*	*	*	*	*	*
		13767-R	CAP, CHIP 10UF 16V Y5V 1210	*	*	*	*	*	*	*
		13798	HEADER, 2-PIN SIP RA	*	*	*	*	*	*	*
		13798-R	HEADER, 2-PIN SIP RA	*	*	*	*	*	*	*
		13802	CAP, CHIP .01UF 50V X7R 0805	*	*	*	*	*	*	*
		13803	IC, LT1585 LDO VR 3.3V 4.6A M	*	*	*	*	*	*	*
		13804	RES, CHIP 33.2 1% 1/10W 0805	*	*	*	*	*	*	*
		13807	RES, CHIP 1.2K 5% 1/10W 0805	*	*	*	*	*	*	*
		13810	RES, CHIP 180 5% 1/10W 0805	*	*	*	*	*	*	*
		13811	RES, CHIP 2.2 5% 1/10W 0805	*	*	*	*	*	*	*
		13813	RES, CHIP 3.0M 5% 1/10W 0805	*	*	*	*	*	*	*
		13819	RES, CHIP 8.2K 5% 1/10W 0805	*	*	*	*	*	*	*
		13824	CAP: 330PF 5% 50V NPO 0805	*	*	*	*	*	*	*
		13825	CAP, CHIP .047UF 50V X7R 0805	*	*	*	*	*	*	*
		13853	RES, CHIP 10.0K 1% 1/10W 0805	*	*	*	*	*	*	*
		13855	RES, CHIP 6.81K 1% 1/10W 0805	*	*	*	*	*	*	*
		13855-R	RES, CHIP 6.81K 1% 1/10W 0805	*	*	*	*	*	*	*
		13858	RES, CHIP 301 1% 1/10W 0805	*	*	*	*	*	*	*
		13878	RES, CHIP 22 5% 1/16W 0603	*	*	*	*	*	*	*
		13931	CAP: 0.1UF 25V Y5V 0603	*	*	*	*	*	*	*
		13932	RES NTWK, CHIP 4X1K 5% 3216	*	*	*	*	*	*	*
		13933	RES, CHIP 100 5% 1/16W 0603	*	*	*	*	*	*	*
		13933-R	RES, CHIP 100 5% 1/16W 0603	*	*	*	*	*	*	*
		13935	RES, CHIP 2.2K 5% 1/16W 0603	*	*	*	*	*	*	*
		13936	RES, CHIP 2.7K 5% 1/16W 0603	*	*	*	*	*	*	*
		13936-R	RES, CHIP 2.7K 5% 1/16W 0603	*	*	*	*	*	*	*
		13945	SKT, 168 DIMM RA NB3.3VDL BERG	*	*	*	*	*	*	*
		13960	IC, LT1085 LDO VR 3.3V 3A M	*	*	*	*	*	*	*
		13964	HEADER, 34-PIN DIP SHD .155"ST	*	*	*	*	*	*	*
		13965	HEADER, 10-PIN DIP SHD .155"ST	*	*	*	*	*	*	*
		13998	RES, CHIP 220 5% 1/16W 0603	*	*	*	*	*	*	*
		13998-R	RES, CHIP 220 5% 1/16W 0603	*	*	*	*	*	*	*
		13999	CAP: 0.001UF 10% 50V X7R 0603	*	*	*	*	*	*	*
		14011	BRACKET, .8mm 2 CH DIFF LOGO	*	*	*	*	*	*	*
		14029	BRACKET, .8mm 2 CH SE LOGO	*	*	*	*	*	*	*
		14031	RES, CHIP 16.9K 1% 1/10W 0805	*	*	*	*	*	*	*
		14037	DIO, RECTIFIER 1A 50V MIN SMA	*	*	*	*	*	*	*
		14061-LC	IC, DS2110Z SCSI TERM SO LC	*	*	*	*	*	*	*
		14067	RES, CHIP .025 OHM 1% 1W 2512	*	*	*	*	*	*	*
		14069	RES, CHIP 49.9K 1% 1/10W 0805	*	*	*	*	*	*	*
		14070	RES, CHIP 82.5K 1% 1/10W 0805	*	*	*	*	*	*	*
		14090	BRACKET, PCI WIDE SCSI DIFF	*	*	*	*	*	*	*
		14094	CAP, CHIP 10UF 6V TA FUS 3528	*	*	*	*	*	*	*
		14095	CAP, 22UF 16V AL ELECT RAD	*	*	*	*	*	*	*
		14117	RES, CHIP 100 1% 1/16W 0603	*	*	*	*	*	*	*
		14126	CAP, CHIP 2.2UF 16V Y5V 1206	*	*	*	*	*	*	*
		14141	CAP, CHIP 3300PF 50V X7R 0805	*	*	*	*	*	*	*
		14145	IC, BQ2003(SO) FAST CHARGE	*	*	*	*	*	*	*
		14150	RES, CHIP 20K 5% 1/10W 0805	*	*	*	*	*	*	*
		14160	RES, CHIP 30 5% 1/4W 1210	*	*	*	*	*	*	*

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		14162	RES, CHIP 422K 1% 1/10W 0805	*	*	*	*	*	*	*
		14195	DIODE, MBRS340T3(SMC)SB 3A 40V	*	*	*	*	*	*	*
		14197	RES, CHIP .04 OHM 1% .5W 2010	*	*	*	*	*	*	*
		14199	CAP, CHIP 220UF 10V TANT 7343H	*	*	*	*	*	*	*
		14202	CAP, 10UF 35V 20% AL ELEC RAD	*	*	*	*	*	*	*
		14205	DIO, HFM103 RECT 200V 1A SMA	*	*	*	*	*	*	*
		14211	HEADER, 10-PIN DIP RA 30U" K6	*	*	*	*	*	*	*
		14213	IC, 32X861 20-BIT BUS SW QVSOP	*	*	*	*	*	*	*
		14216	IC, 27C256(PLCC)32KX8 OTP 45NS	*	*	*	*	*	*	*
		14219	CAP, CHIP 100UF 10V TANT 7343	*	*	*	*	*	*	*
		14221	RES, CHIP 1.00M 1% 1/10W 0805	*	*	*	*	*	*	*
		14222	RES, CHIP 18 5% 1/10W 0805	*	*	*	*	*	*	*
		14223	RES, CHIP 200K 1% 1/10W 0805	*	*	*	*	*	*	*
		14224	RES, CHIP 3.01K 1% 1/10W 0805	*	*	*	*	*	*	*
		14225	RES, CHIP 365K 1% 1/10W 0805	*	*	*	*	*	*	*
		14226	RES, CHIP 68 5% 1/10W 0805	*	*	*	*	*	*	*
		14227	RES, CHIP 7.50K 1% 1/10W 0805	*	*	*	*	*	*	*
		14228	RES, CHIP 9.09K 1% 1/10W 0805	*	*	*	*	*	*	*
		14230	RES, CHIP .10 OHM 1% 1/8W 0805	*	*	*	*	*	*	*
		14235	IC, 74CBT3125(SO4.5)4X BUS SW	*	*	*	*	*	*	*
		14237	IC, LT1129(SO) VR 3.3V LDO	*	*	*	*	*	*	*
		14242	CAP, CHIP 33UF 6V TA FUS 6032	*	*	*	*	*	*	*
		14243	CAP, CHIP .22UF 25V X7R 0805	*	*	*	*	*	*	*
		14244	DIO, 5229B 4.3V 225mW ZNR SOT	*	*	*	*	*	*	*
		14257	LED, CHIP RED LU60341 TOP 3213	*	*	*	*	*	*	*
		14257-R	LED, CHIP RED LU60341 TOP 3213	*	*	*	*	*	*	*
		14265	IC, GAL 22V10(PLCC)3.3 15NS 0P	*	*	*	*	*	*	*
		14267	CAP, CHIP 100UF6V TA 7343LO HT	*	*	*	*	*	*	*
		14308	CAP, CHIP .47UF 16V Y5V 0805	*	*	*	*	*	*	*
		14322	RES, CHIP 470 5% 1/16W 0603	*	*	*	*	*	*	*
		14322-R	RES, CHIP 470 5% 1/16W 0603	*	*	*	*	*	*	*
		14324	CAP: 2200PF 10% 50V X7R 0603	*	*	*	*	*	*	*
		14325	CAP: 470PF 10% 50V X7R 0603	*	*	*	*	*	*	*
		14326	RES, CHIP 75 5% 1/16W 0603	*	*	*	*	*	*	*
		14333	RES, CHIP 121 1% 1/10W 0805	*	*	*	*	*	*	*
		14338	RES NTWK, CHIP 4X10K 5% 3216	*	*	*	*	*	*	*
		14357	IC, LT1117 VR LDO ADJ .8A SOT	*	*	*	*	*	*	*
		14358	IC, 1MX16X4 SDRAM 3.3V TSOP2	*	*	*	*	*	*	*
		14359	RES, CHIP 10.0K 1% 1/16W 0603	*	*	*	*	*	*	*
		14361	OSC, CER SMD 50MHZ 7550	*	*	*	*	*	*	*
		14363	CONN, 68-P DUALST RCPT RA .8mm	*	*	*	*	*	*	*
		14364	IC, LT1117 VR LDO 2.85V SOT223	*	*	*	*	*	*	*
		14371	CAP, CHIP 22UF 16V AL 535355	*	*	*	*	*	*	*
		14373	OSC, HCMOS CLK 40HMZ 1/2 3S GW	*	*	*	*	*	*	*
		14378	RES, CHIP 2.00K 1% 1/10W 0805	*	*	*	*	*	*	*
		14392	FERRITE, CHIP Z600 .1A 0603	*	*	*	*	*	*	*
		14393	RES, CHIP 4.75K 1% 1/10W 0805	*	*	*	*	*	*	*
		14399-LC	IC, LX5115 9X SCSI TERM ULT SO	*	*	*	*	*	*	*
		14414	RES, CHIP 270 5% 1/16W 0603	*	*	*	*	*	*	*
		14445	BRACKET, ULTRA2 LVD/SE 2.05"	*	*	*	*	*	*	*
		14446	LABEL, 1.25X.25 WHT PE REMVBL	*	*	*	*	*	*	*
		14450	CAP, CHIP 22UF 6.3V AL 434355	*	*	*	*	*	*	*

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		14455	CAP, CHIP 1UF 16V Y5V 0805	*	*	*	*	*	*	*
		14471	BAT, LI/MNO2 3V .035AH CR1220	*	*	*	*	*	*	*
		14478	HOLDER, BATTERY FOR CR1220 SMT	*	*	*	*	*	*	*
		14488	TRANS, IRL2203N N-MOSFET D2PAK	*	*	*	*	*	*	*
		14492	RES, CHIP 33K 5% 1/16W 0603	*	*	*	*	*	*	*
		14496	CONN, 200-PIN PLUG .025"CL SMT	*	*	*	*	*	*	*
		14497	CONN, 200-POS RCPT .025"CL SMT	*	*	*	*	*	*	*
		14514	RES, CHIP .015 OHM 1% 1W 2512	*	*	*	*	*	*	*
		14518	CAP, CHIP 33UF 16V TANT 7343	*	*	*	*	*	*	*
		14527	DIO, SHTK BARR 30V .1A SOD	*	*	*	*	*	*	*
		14539	RES, CHIP 1.5K 5% 1/16W 0603	*	*	*	*	*	*	*
		14540	RES NTWK, CHIP 4X2.7K 5% 3216	*	*	*	*	*	*	*
		14540-R	RES NTWK, CHIP 4X2.7K 5% 3216	*	*	*	*	*	*	*
		14541	CONN, 40-P RCPT .635MM STK SMT	*	*	*	*	*	*	*
		14542	CONN, 40-P PLUG .635MM STK SMT	*	*	*	*	*	*	*
		14547	RES, CHIP 12.4K 1% 1/10W 0805	*	*	*	*	*	*	*
		14548	RES, CHIP 267 1% 1/16W 0603	*	*	*	*	*	*	*
		14549	RES, CHIP 1K 1% 1/16W 0603	*	*	*	*	*	*	*
		14549-R	RES, CHIP 1K 1% 1/16W 0603	*	*	*	*	*	*	*
		14551	RES, CHIP 10 1% 1/16W 0603	*	*	*	*	*	*	*
		14556	IC, 32KX8 SRAM 12NS CMOS SOJ	*	*	*	*	*	*	*
		14564	IC, 7733 VOLTAGE MNTR 3.3V	*	*	*	*	*	*	*
		14564-R	IC, 7733 VOLTAGE MNTR 3.3V SO	*	*	*	*	*	*	*
		14576	TRANS, FDS4410 N-MOSFET SO-8	*	*	*	*	*	*	*
		14578	RES, CHIP 20K 5% 1/16W 0603	*	*	*	*	*	*	*
		14578-R	RES, CHIP 20K 5% 1/16W 0603	*	*	*	*	*	*	*
		14586	CAP, CHIP 100UF 10V TA FUS7343	*	*	*	*	*	*	*
		14587	RES, CHIP 3.32K 1% 1/16W 0603	*	*	*	*	*	*	*
		14587-R	RES, CHIP 3.32K 1% 1/16W 0603	*	*	*	*	*	*	*
		14588	RES, CHIP 200 1% 1/16W 0603	*	*	*	*	*	*	*
		14591	HEADER, 8-PIN SIP P5 RMVD	*	*	*	*	*	*	*
		14593	RES, CHIP 2.00K 1% 1/16W 0603	*	*	*	*	*	*	*
		14594	RES, CHIP 3.01K 1% 1/16W 0603	*	*	*	*	*	*	*
		14595	RES, CHIP 33.2K 1% 1/16W 0603	*	*	*	*	*	*	*
		14596	RES, CHIP 63.4K 1% 1/16W 0603	*	*	*	*	*	*	*
		14597	RES, CHIP 75K 1% 1/16W 0603	*	*	*	*	*	*	*
		14598	CAP: 10PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		14606	STANDOFF, STL 6MM HEX M3 X12MM	*	*	*	*	*	*	*
		14609	RES, CHIP 162 1% 1/16W 0603	*	*	*	*	*	*	*
		14611	CAP: 22PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		14613	CAP: 100PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		14614	CAP: 220PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		14616	RES, CHIP 221K 1% 1/10W 0603	*	*	*	*	*	*	*
		14622	SCREW, M3 X 3MM PANHD PHIL STL	*	*	*	*	*	*	*
		14625	CAP, CHIP 100UF16VTA FUS734340	*	*	*	*	*	*	*
		14642	RES, CHIP .10 OHM 1% 1/4W 1206	*	*	*	*	*	*	*
		14644	IC, 21554 PCI-PCI BRIDGE PBGA	*	*	*	*	*	*	*
		14645	TRANS, SI2301 2.5 P-MOSFET SOT	*	*	*	*	*	*	*
		14646	TRANS, SI2302 2.5 N-MOSFET SOT	*	*	*	*	*	*	*
		14649	RES, CHIP 511 1% 1/16W 0603	*	*	*	*	*	*	*
		14650	RES, CHIP 1.27K 1% 1/10W 0603	*	*	*	*	*	*	*
		14654	IC, BQ2092 BATT GAS GAUGE SO	*	*	*	*	*	*	*

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		14661	RES, CHIP 1.00M 1% 1/16W 0603	*	*	*	*	*	*	*
		14663	RES, CHIP 2.49K 1% 1/16W 0603	*	*	*	*	*	*	*
		14663-R	RES, CHIP 2.49K 1% 1/16W 0603	*	*	*	*	*	*	*
		14665	RES, CHIP 3.65K 1% 1/16W 0603	*	*	*	*	*	*	*
		14666	RES, CHIP 35.7K 1% 1/16W 0603	*	*	*	*	*	*	*
		14667	RES, CHIP 365 1% 1/16W 0603	*	*	*	*	*	*	*
		14669	RES, CHIP 4.75K 1% 1/16W 0603	*	*	*	*	*	*	*
		14670	RES, CHIP 523K 1% 1/16W 0603	*	*	*	*	*	*	*
		14671	RES, CHIP 732K 1% 1/16W 0603	*	*	*	*	*	*	*
		14674	RES, CHIP 24.3 1% 1/16W 0603	*	*	*	*	*	*	*
		14677	CAP, CHIP 330PF 50V NPO 0603	*	*	*	*	*	*	*
		14678	CAP, CHIP .22UF 10V Y5V 0603	*	*	*	*	*	*	*
		14685	IC, 28F800FLSH 3V TOP120 TSOP1	*	*	*	*	*	*	*
		14689	RES, CHIP 422 1% 1/16W 0603	*	*	*	*	*	*	*
		14699	OSC, CER SMD 40MHZ 7550 50PF	*	*	*	*	*	*	*
		14700	IC, 29C010A FLASH 150 TSOP1	*	*	*	*	*	*	*
		14701	RES, CHIP 150K 1% 1/16W 0603	*	*	*	*	*	*	*
		14701-R	RES, CHIP 150K 1% 1/16W 0603	*	*	*	*	*	*	*
		14719	OSC, XTAL CLK 20MHZ GW HS	*	*	*	*	*	*	*
		14726	RES, CHIP 54.9 1% 1/16W 0603	*	*	*	*	*	*	*
		14727	RES, CHIP 4.99K 1% 1/16W 0603	*	*	*	*	*	*	*
		14727-R	RES, CHIP 4.99K 1% 1/16W 0603	*	*	*	*	*	*	*
		14728	RES, CHIP 47K 5% 1/16W 0603	*	*	*	*	*	*	*
		14729	CAP: 0.047UF 10% 16V X7R 0603	*	*	*	*	*	*	*
		14729-R	CAP: 0.047UF 10% 16V X7R 0603	*	*	*	*	*	*	*
		14737	SKT, 168 DIMM RA NB3.3V DL AMP	*	*	*	*	*	*	*
		14741-R	RES, CHIP 1.0M 5% 1/16W 0603	*	*	*	*	*	*	*
		14742	RES, CHIP 2.67K 1% 1/16W 0603	*	*	*	*	*	*	*
		14758	BRACKET, PCI JALAPENO	*	*	*	*	*	*	*
		14763	RES NTWK, CHIP 4X22K 5% 3216	*	*	*	*	*	*	*
		14770	IC, 555 CMOS TIMER SO	*	*	*	*	*	*	*
		14789	RES, CHIP 47 5% 1/4W 1210	*	*	*	*	*	*	*
		14808	RES, CHIP 13.7K 1% 1/16W 0603	*	*	*	*	*	*	*
		14809	RES, CHIP 7.32K 1% 1/16W 0603	*	*	*	*	*	*	*
		14810	RES, CHIP 165K 1% 1/16W 0603	*	*	*	*	*	*	*
		14813	IC, 256KX72DRAM 3V 50 UBF DIMM	*	*	*	*	*	*	*
		14820	RES, CHIP 24.3K 1% 1/10W 0805	*	*	*	*	*	*	*
		14832	RES, CHIP 150 1% 1/16W 0603	*	*	*	*	*	*	*
		14858	RES, CHIP ZERO-OHM JUMPER 2010	*	*	*	*	*	*	*
		14861	DIO, RB491D 20V 1A SHTKY SMD3	*	*	*	*	*	*	*
		14867	OSC, CER SMD 66.000MHZ 7550	*	*	*	*	*	*	*
		14883	CAP, CHIP 4.7UF 16V TANT 3528	*	*	*	*	*	*	*
		14891	IC, CY2308-2 3.3V DELAY BFR SO	*	*	*	*	*	*	*
		1490060-00	LBL, GENERIC 3 1/2" DISK (STD)	*	*	*	*	*	*	*
		1490416-00	LBL BLANK, PRODUCT/BIOS COMBO	*	*	*	*	*	*	*
		1490571-00	CABLE, IN 18" 80p/80p UDMA/66	*	*	*	*	*	*	*
		1490694-00	FOAM, 15 3/4" X 9 3/8" X 2 5/8	*	*	*	*	*	*	*
		1490904-00	LABEL, PCA VERSION "--58"	*	*	*	*	*	*	*
		1490973-00	RETAINER, ALUMINUM 4 HOLE	*	*	*	*	*	*	*
		1491070-00	SCD, LARGE CLAMSHELL	*	*	*	*	*	*	*
		1491219-00	BOX, 20"X16 9/16"X8 1/2" RSC	*	*	*	*	*	*	*
		1491497-00	LABEL, PCA VERSION "59"	*	*	*	*	*	*	*

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		1491517-00	BAG, 7"X10" 2MIL CLR POLY ZPLK	*	*	*	*	*	*	*
		1491644-00	DISK ASSY, EZ-SCSI DE v5.01	*	*	*	*	*	*	*
		1491646-00	DISK ASSY, 7800 FMS v3.03	*	*	*	*	*	*	*
		1491647-00	DISK ASSY, 7800 FMS LITE v3.01	*	*	*	*	*	*	*
		1491647-00FR	DISK ASSY, 7800 FMS/FR v3.01	*	*	*	*	*	*	*
		1491647-00GE	DISK ASSY, 7800 FMS/GE v3.01	*	*	*	*	*	*	*
		1491647-00IT	DISK ASSY, 7800 FMS/IT v3.01	*	*	*	*	*	*	*
		1491649-00JA	DISK ASSY, 7800 FMS v3.01	*	*	*	*	*	*	*
		1491650-00SP	DISK ASSY, 7800 FMS/SP v2.10	*	*	*	*	*	*	*
		1491746-00JA	DISK ASSY, 7800FMS/SCSEL v3.0J	*	*	*	*	*	*	*
		1491947-00EU	DISK ASSY,EZ5.0dd/U160/EUv1.11	*	*	*	*	*	*	*
		1491967-00	LABEL, PCA VERSION "-60"	*	*	*	*	*	*	*
		1491969-00	HOLDER, AAC-9001 BATTERY CLIP	*	*	*	*	*	*	*
		1491973-00	LABEL, PCA VERSION "-61"	*	*	*	*	*	*	*
		1491995-00	LBL, BATTERY ENABLE JMP LBL	*	*	*	*	*	*	*
		1492005-00	SCD, HP BSMI 3892H206 LBL	*	*	*	*	*	*	*
		1492188-00	BOX, 18 3/4" X 15" X 16 1/2"	*	*	*	*	*	*	*
		1492260-00	BOX, 11"x10 1/16"x6 1/2" MSTR	*	*	*	*	*	*	*
		1492418-00	STIFFENER, 6 1/4"X5 1/8"CARDBD	*	*	*	*	*	*	*
		1492483-00EU	DISK ASSY, ULT160EU FMSWIN1.12	*	*	*	*	*	*	*
		1492483-00JA	DISK ASSY,ULT160FMS/JAWINv1.12	*	*	*	*	*	*	*
		1492511-00	BRACKET, 2X VHDCI DUAL W/LED	*	*	*	*	*	*	*
		1492817-00	SCD, BATT NIMH 2.4V 2000MAH	*	*	*	*	*	*	*
		1492818-00	BRKT, FOR BATTERY 1492817-00	*	*	*	*	*	*	*
		1492836-00	SCD, 2PIN X.1 HDR W/IR CARRIER	*	*	*	*	*	*	*
		1492837-00	SCD, 4PIN X.1 HDR W/IR CARRIER	*	*	*	*	*	*	*
		1492888-00	BOX, 16 7/8"X14 3/4"X10" 5 PK	*	*	*	*	*	*	*
		1492901-00	SCD, MANUAL/HP 5971-0821	*	*	*	*	*	*	*
		1492917-00	BRKT, 2 CH U160 VHDCI EXTERNAL	*	*	*	*	*	*	*
		1492918-00	BRKT, 4 CH U160 VHDCI EXTERNAL	*	*	*	*	*	*	*
		1492971-00	BRKT, 2 CH DUAL STK U160 VHDCI	*	*	*	*	*	*	*
		1493040-00	SCD,CBL IN 40P 3CN .45M ATA100	*	*	*	*	*	*	*
		1493182-01	SCD, ASR FULL SIZE CLAMSHELL 2	*	*	*	*	*	*	*
		1493198-00	SCD, ASR FULL SIZE BOTTOM TRAY	*	*	*	*	*	*	*
		14932	IC, MAX232 RS-232 XCVR SO	*	*	*	*	*	*	*
		1493213-00	SCD, AAR FULL SIZE CABLE TRAY	*	*	*	*	*	*	*
		1493268-00	SCD, BLUE DOT STICKER	*	*	*	*	*	*	*
		1493278-00	BOX, 15 3/4" X 14 1/4" X 9"	*	*	*	*	*	*	*
		1493296-00	PAD, 29160HP NSD DSK/MNL ASSY	*	*	*	*	*	*	*
		1493433-40	DISK, FMS v4.0a SP3 UTIL wDS	*	*	*	*	*	*	*
		14935	CAP: 12PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		1493567-00	BRACKET, ASC-39320	*	*	*	*	*	*	*
		1493568-00	BOX, 22 1/8"X12 7/16"X8 7/32"	*	*	*	*	*	*	*
		1493569-00	INSERT,20 PC BULK	*	*	*	*	*	*	*
		1493570-00	FOAM, 21 7/8"X11 7/8"X1/2" BOT	*	*	*	*	*	*	*
		1493571-00	FOAM, 21 7/8"X11 7/8"X1" TOP	*	*	*	*	*	*	*
		1493774-00	BRACKET, ZERO CH LP FULL HGT	*	*	*	*	*	*	*
		1493915-00	BRKT, MTG FULL HEIGHT PCI	*	*	*	*	*	*	*
		1493916-00	BRKT, MTG LOW PROFILE PCI	*	*	*	*	*	*	*
		14940	STANDOFF, SS 6MM HEX M3 X12MM	*	*	*	*	*	*	*
		1494166-00	SCD, ASR/AAR 1/2SIZE CLAMSHELL	*	*	*	*	*	*	*
		1494167-00	SCD, ASR/AAR 1/2SIZE BTM TRAY	*	*	*	*	*	*	*

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		1494181-00	FOAM,8"X6 1/2"X1/2" TOP & BTM	*	*	*	*	*	*	*
		1494182-00	FOAM,8"X6 1/2"X1" INSERT FOAM	*	*	*	*	*	*	*
		1494183-00	BOX,8 3/4"X6 3/4"X2 1/4"KRAFT	*	*	*	*	*	*	*
		1494184-00	FOAM,7 3/4"X4 1/4"X1" CONV	*	*	*	*	*	*	*
		1494185-00	BOX,8"X4 1/2"X1 1/4" WHITE	*	*	*	*	*	*	*
		14942	CAP: 15PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		1494217-00	SCD, LITHIUM ION BAT PK 940MAH	*	*	*	*	*	*	*
		1494228-00	BOX,18"X12 5/8"X7 3/4"ABM MSTR	*	*	*	*	*	*	*
		1494239-00	BAG, 5 5/8" X 3 1/16" ZIPLOCK	*	*	*	*	*	*	*
		1494291-00	LABEL, PCA VERSION "-62"	*	*	*	*	*	*	*
		1494379-00	BRACKET, ASC-39320D	*	*	*	*	*	*	*
		1494412-00	BOX,16 1/2"X9 1/2"X2 5/8"KRAFT	*	*	*	*	*	*	*
		1494416-00	BOX, 15 1/2"x10 13/16"x2 1/8"	*	*	*	*	*	*	*
		1494417-00	BOX, 23 6/8"x16 1/8"x11 3/4"	*	*	*	*	*	*	*
		1494418-00	FOAM, 14 1/2"x10 1/8"x1"CNVLTD	*	*	*	*	*	*	*
		1494420-00	BOX, 11 1/2" X 7 1/2" X 2 7/8"	*	*	*	*	*	*	*
		1494424-00	BRACKET, LP DUAL STACK FULL	*	*	*	*	*	*	*
		1494424-01	BRACKET, LP SNGL STACK FULL	*	*	*	*	*	*	*
		1494425-00	(OBS)BRACKET, LP DUAL STAK LOW	*	*	*	*	*	*	*
		1494425-01	(OBS)BRACKET, LP SNGL STAK LOW	*	*	*	*	*	*	*
		1494541-00	LABEL, PCA VERSION "-90"	*	*	*	*	*	*	*
		1494542-00	LABEL, PCA VERSION "-91"	*	*	*	*	*	*	*
		1494552-00	SCD, AAC-3642/HP SHIELD	*	*	*	*	*	*	*
		1494553-00	SCD, AAC-3642/HP WARNING LBL	*	*	*	*	*	*	*
		1494555-00	SCD, AAC-3642/HP CLIP KIT	*	*	*	*	*	*	*
		1494564-00	LBL, PCA REVISION "PT/A"	*	*	*	*	*	*	*
		1494565-00	LBL, PCA REVISION "PT/B"	*	*	*	*	*	*	*
		1494566-00	LBL, PCA REVISION "PT/C"	*	*	*	*	*	*	*
		1494591-00	FOAM, 12" X 6" X 1"	*	*	*	*	*	*	*
		1494594-00	BRACKET, LP 2 CH VHDCI FULL	*	*	*	*	*	*	*
		1494595-40	DISK ASSY, ULT160 FMS 4.0a wDS	*	*	*	*	*	*	*
		14946	STANDOFF, SS 4.5MM HEX M3X12MM	*	*	*	*	*	*	*
		1494765-00	BRACKET, FULL HT VHDCI 2.723	*	*	*	*	*	*	*
		1495122-00	SCD, ASR/AAR 1/2SIZE2 BTM TRAY	*	*	*	*	*	*	*
		1495130-00	BAG, 1 9/16" X 2 3/4" ZIPLOCK	*	*	*	*	*	*	*
		1495176-00	BOX,11 7/16"X7 5/8"X3 1/4"KRFT	*	*	*	*	*	*	*
		1495177-00	INSERT, 10 PACK BULK	*	*	*	*	*	*	*
		1495178-00	BAG, 3" X 5" STATIC SHIELD	*	*	*	*	*	*	*
		1495183-00	BOX,17 5/16"X11 7/8"X8 3/8"MST	*	*	*	*	*	*	*
		1495303-00	CABLE, SATA 1.5Gb ST-RA 1M	*	*	*	*	*	*	*
		1495304-00	CABLE, SATA 1.5Gb ST-RA .5M	*	*	*	*	*	*	*
		1495305-00	CABLE, SATA 1.5Gb ST-ST 1M	*	*	*	*	*	*	*
		1495306-00	CABLE, SATA 1.5Gb ST-ST .5M	*	*	*	*	*	*	*
		1495337-00	BOX, 11" x 7.5" x 2.5" KRAFT	*	*	*	*	*	*	*
		1495341-00	BRACKET, 2CH VHDCI FULL CH1,2	*	*	*	*	*	*	*
		1495363-00	STIFFENER, 8.25"x.050" CRS	*	*	*	*	*	*	*
		1495590-00	SCD, ASR 1/2 SIZE CLAMSHELL	*	*	*	*	*	*	*
		1495639-00	SCD, LITH ION BAT PK 1040MAH	*	*	*	*	*	*	*
		1495640-00	SCD, 1040MAH LION CRU BAT ASSY	*	*	*	*	*	*	*
		1495652-00	LBL BLANK, .5"X1.8" WHT POLY	*	*	*	*	*	*	*
		1495696-00	SCD, CBL ETHERNET 1 METER	*	*	*	*	*	*	*
		1495743-00	BRACKET, AAR-2410SA WITH RIB	*	*	*	*	*	*	*

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		1495968-00	BRACKET, LP DUAL STACK LOW	*	*	*	*	*	*	*
		1495969-00	BRACKET, LP SINGLE STACK LOW	*	*	*	*	*	*	*
		14960	RMCF1/16-6.19K-1%	*	*	*	*	*	*	*
		14960-R	RMCF1/16-6.19K-1%	*	*	*	*	*	*	*
		1496238-00	BRACKET, 68P HD SCSI LVD 2.05	*	*	*	*	*	*	*
		1496241-00	BRACKET, AAR-2410SA LP FULL HT	*	*	*	*	*	*	*
		1496255-00	BRACKET, LP DUAL STK FULL RIB	*	*	*	*	*	*	*
		1496401-00	DISK ASSY, AAR-1200A DRV v1.3	*	*	*	*	*	*	*
		1496467-00	SCD, 80321 I/O PRCR 600MHZ IBM	*	*	*	*	*	*	*
		1496526-00	BRACKET, 2000/2010 LP MOD TAB	*	*	*	*	*	*	*
		1496527-00	BRACKET, 2000/2010 FH MOD TAB	*	*	*	*	*	*	*
		1496540-00	FOAM, 29" X 14 1/4" X 1/2" TOP	*	*	*	*	*	*	*
		1496541-00	FOAM, 29" X 14 1/4" X 1" BOT	*	*	*	*	*	*	*
		1496542-00	INSERT, 50 PACK (5 X 10)	*	*	*	*	*	*	*
		1496543-00	BOX,29 3/8"X14 9/16" X 10 5/8"	*	*	*	*	*	*	*
		1496586-00	JMPR WIRE, AWG #20	*	*	*	*	*	*	*
		1496651-00	LBL BLNK, PCBA S/N 2PC LABEL	*	*	*	*	*	*	*
		1496710-00	SCD, IC UCC5672/DS2119ME(C1)	*	*	*	*	*	*	*
		1496710-00-R	SCD, IC UCC5672/DS2119ME(C1)	*	*	*	*	*	*	*
		1496729-00	SCD, BAT PK LIQ-LI 3.7V 900MAH	*	*	*	*	*	*	*
		1496799-00	SCD, 128MB DIMM DDR200LP IBMC3	*	*	*	*	*	*	*
		1496800-00	SCD, 256MB DIMM DDR200LP IBM	*	*	*	*	*	*	*
		1496801-00	LABEL, PCA VERSION "-72"	*	*	*	*	*	*	*
		1496870-00	CABLE, LED PANEL REF	*	*	*	*	*	*	*
		1496894-00	FOAM, 14 1/2"x10 1/8"x1"CUTOUT	*	*	*	*	*	*	*
		1496952-00	BOX, ICP9 7/8"x7 1/2"x2 3/8"KT	*	*	*	*	*	*	*
		1496953-00	BOX, ICP 11 5/8"x7 1/2"x2 3/8KT	*	*	*	*	*	*	*
		1496954-00	BOX, 17 1/8"X7"X 3 1/2" KIT	*	*	*	*	*	*	*
		1496955-00	INSERT, 19 11/16" X 17 7/16"	*	*	*	*	*	*	*
		1496956-00	INSERT, 20 5/32" X 9"	*	*	*	*	*	*	*
		1496969-00	SCD, AAR-2410SA ENCLOSURE	*	*	*	*	*	*	*
		1496971-00	BRACKET, BLANK 2.010	*	*	*	*	*	*	*
		1497007-00	BOX, 8.9" x 7" x 1" SLEEVE	*	*	*	*	*	*	*
		1497008-00	FOAM SET, 18.3"x11"x4.6"	*	*	*	*	*	*	*
		1497009-00	BOX, 18.7"x11.3"x11.9" MSTR	*	*	*	*	*	*	*
		1497010-00	BOX, ICP/INTEL MASTER	*	*	*	*	*	*	*
		1497011-00	FOAM, 8x6.75x1.5 CONV ICP/INT	*	*	*	*	*	*	*
		1497012-00	FOAM, 16x2.25x1 DIECUT ICP/INT	*	*	*	*	*	*	*
		1497013-00	LBL BLNK, 2" x 6" WHT GLOSSY	*	*	*	*	*	*	*
		1497014-00	FOAM, 8 11/16x8 1/8x1 3/8 CONV	*	*	*	*	*	*	*
		1497015-00	FOAM, 17.75x2.5x0.5 DIECUT INT	*	*	*	*	*	*	*
		1497059-00	SCD, 80321 I/O PRCR 400MHZ IBM	*	*	*	*	*	*	*
		1497095-00	BRACKET, ROCKET MULE CARD	*	*	*	*	*	*	*
		1497100-00	BRACKET, RAZOR MULE BOARD	*	*	*	*	*	*	*
		1497108-00	BOX, ICP MSTR CARTON 1 CHNL	*	*	*	*	*	*	*
		1497109-00	BOX, ICP MSTR CARTON 2 CHNL	*	*	*	*	*	*	*
		1497110-00	LBL BLNK, 3.78" x 1.34" WHT	*	*	*	*	*	*	*
		1497111-00	LBL BLNK, 1.89" x 1.34" WHT	*	*	*	*	*	*	*
		1497133-00	BOX, ICP MSTR CARTON 3 CHNL	*	*	*	*	*	*	*
		1497156-00	BOX, 13.94"x13.31"x9.29"MASTER	*	*	*	*	*	*	*
		1497157-00	INSERT, 50.94" X 12.91"	*	*	*	*	*	*	*
		1497165-00	BRACKET, DEERFIELD 2 CH	*	*	*	*	*	*	*

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		1497165-01	BRACKET, DEERFIELD 2 CH GOLD	*	*	*	*	*	*	*
		1497191-00	SCD, ICP EXT U320 VHD-HD CBL1m	*	*	*	*	*	*	*
		1497192-00	SCD, ICP EXT U320 VHD-HD CBL3m	*	*	*	*	*	*	*
		1497193-00	SCD, ICP EXT U320 VHDVHD CBL1m	*	*	*	*	*	*	*
		1497194-00	SCD, ICP EXT U320 VHDVHD CBL3m	*	*	*	*	*	*	*
		1497196-00	SCD, ICP SATA CABLE 1m	*	*	*	*	*	*	*
		1497197-00	SCD, ICP INT WIDE U320 CBL1.6m	*	*	*	*	*	*	*
		1497198-00	SCD, ICP EXT U160 HD-HD CBL 1m	*	*	*	*	*	*	*
		1497199-00	STIFFENER, DEERFIELD	*	*	*	*	*	*	*
		1497203-00	BAG, 8"x6" ANTI-STATIC ZIPLOCK	*	*	*	*	*	*	*
		1497220-00	SCD, ICP 128MB 133DIMM ART8961	*	*	*	*	*	*	*
		1497222-00	BOX, ICP FIRMWARE UPGRADE	*	*	*	*	*	*	*
		1497236-00	SCD, ICP U320 INT CABLE 3505	*	*	*	*	*	*	*
		1497268-00	SCD, AAR-2410SA ENCLOSURE BLK	*	*	*	*	*	*	*
		1497276-00	FOAM, 10 1/2" x 7 1/8" x 1/2"	*	*	*	*	*	*	*
		1497277-00	SCD, CABLE SATA1.5GbST-RA 1MLP	*	*	*	*	*	*	*
		1497278-00	SCD, CABLE SATA1.5GbST-RA.5MLP	*	*	*	*	*	*	*
		1497279-00	SCD, CABLE SATA1.5GbST-ST 1MLP	*	*	*	*	*	*	*
		1497280-00	SCD, CABLE SATA1.5GbST-ST.5MLP	*	*	*	*	*	*	*
		1497284-00	SCD, SATA SIGNL CBL IBM73P0774	*	*	*	*	*	*	*
		1497285-00	SCD, SATA SPLITTER IBM 13N2410	*	*	*	*	*	*	*
		1497286-00	SCD, SATA PANEL MNT IBM13N2375	*	*	*	*	*	*	*
		1497303-00	SCD, CABLE PWR 2M BLK	*	*	*	*	*	*	*
		1497303-00EU	SCD, CABLE PWR 2M BLK EU	*	*	*	*	*	*	*
		1497303-00JA	SCD, CABLE PWR 2M BLK JA	*	*	*	*	*	*	*
		1497303-00UK	SCD, CABLE PWR 2M BLK UK	*	*	*	*	*	*	*
		1497315-00	BAG, 23 5/8" x 16 5/32" POLY	*	*	*	*	*	*	*
		1497316-00	INSERT, 49 7/32x13 3/8 W/FOAM	*	*	*	*	*	*	*
		1497317-00	SLEEVE, ICP SCSI DIRECTOR	*	*	*	*	*	*	*
		1497318-00	BOX, 22 7/16"x14 9/16" MASTER	*	*	*	*	*	*	*
		1497343-00	BRACKET, LP TOP MT W/NOTCH	*	*	*	*	*	*	*
		1497360-00	BOX, 30.91"x22.64"x12.40" MSTR	*	*	*	*	*	*	*
		1497361-00	INSERT, 56.93"x 22.64" HRDDRV	*	*	*	*	*	*	*
		1497362-00	FOAM, SERVER ENDCAP	*	*	*	*	*	*	*
		1497387-00	SCD, AAR-2410SA ENCL HS TRAY	*	*	*	*	*	*	*
		1497388-00	SCD, 2410SA ENCL HS TRAY BLK	*	*	*	*	*	*	*
		1497413-00	BOX, 11.8" X 9.4" X 5.5"	*	*	*	*	*	*	*
		1497414-00	FOAM, TOP & BOTTOM DRIVE SGL	*	*	*	*	*	*	*
		1497415-00	FOAM, DIECUT DRIVE SGL	*	*	*	*	*	*	*
		1497479-00	BOX, 17.52"x 12.2"x 8.11" MSTR	*	*	*	*	*	*	*
		1497489-00	BRACKET, MARAUDER	*	*	*	*	*	*	*
		1497609-00	SCD, 4Mx16x4 DDR266B LP IBM	*	*	*	*	*	*	*
		1497610-00	SCD, ASR-2020/2025ZCR CLAMSHLL	*	*	*	*	*	*	*
		1497616-00	CABLE, IN 68LP6CN RND U320 TRM	*	*	*	*	*	*	*
		1497626-00	SCD,4MX16 SDRAM 133MHZ/HITACHI	*	*	*	*	*	*	*
		1497630-00	SCD, 8Mx16x4 DDR333 6TL LP IBM	*	*	*	*	*	*	*
		1497669-00	BOX, 8.58" X 6.77" X 2.28" KIT	*	*	*	*	*	*	*
		1497692-00	CLAMSHELL, 64-BIT PCI	*	*	*	*	*	*	*
		1497693-00	TRAY, 64-BIT PCI CLAMSHELL	*	*	*	*	*	*	*
		1497709-00	BOX, 13.94"x13.31"x11.18" MSTR	*	*	*	*	*	*	*
		1497710-00	INSERT, 57.01"x 12.91"	*	*	*	*	*	*	*
		1497766-00	CABLE, IB 4X-4 1X7P 1.5G .5M	*	*	*	*	*	*	*

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		1497767-00	CABLE, IB 4X-4 1X7P 1.5G 1M	*	*	*	*	*	*	*
		1497826-00	SCD, 8Mx16x4 DDR SDRAM LP IBM	*	*	*	*	*	*	*
		14981	IC, AM186ES 16B UC 40MHZ PQFP	*	*	*	*	*	*	*
		14991	RES, CHIP 182 1% 1/10W 0805	*	*	*	*	*	*	*
		14992	RES, CHIP 10.0 1% 1/4W 1210	*	*	*	*	*	*	*
		14994	DIO, 5226B 3.3V .5W ZNR SOD123	*	*	*	*	*	*	*
		15-00561-010-05	RES, 560 5% 1/8W 1206	*	*	*	*	*	*	*
		1501831	HEADER, 1X3, 0.1" PITCH, VERT	*	*	*	*	*	*	*
		15202	DIO, STPS340B 3A 40V SHTKY BR	*	*	*	*	*	*	*
		15216	IC CY2305 0 DLY BUFR 3V SO8	*	*	*	*	*	*	*
		15216-R	IC CY2305 0 DLY BUFR 3V SO8	*	*	*	*	*	*	*
		15218	SCREW, M3X6.5MM PANHD PHIL STL	*	*	*	*	*	*	*
		15226	BAG, 6" X 13" STATIC SHIELD	*	*	*	*	*	*	*
		15230	RES, CHIP 36 5% 1/16W 0603	*	*	*	*	*	*	*
		15231	RES, CHIP 24 5% 1/16W 0603	*	*	*	*	*	*	*
		15232	RES, CHIP 30 5% 1/10W 0603	*	*	*	*	*	*	*
		15233	FERRITE, CHIP Z30 3A 0805	*	*	*	*	*	*	*
		15233-R	FERRITE, CHIP Z30 3A 0805	*	*	*	*	*	*	*
		15235	CAP: 18PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		15242	XTAL, 16.000MHZ P-RES .2HT SMD	*	*	*	*	*	*	*
		15246	CKT PROTECT, 1.5AMP 1812	*	*	*	*	*	*	*
		15246-R	CKT PROTECT, 1.5AMP 1812	*	*	*	*	*	*	*
		15247	CONN,EDGE 184-PIN .050" C STMT	*	*	*	*	*	*	*
		15257	CAP, CHIP 4.7UF 10V Y5V 0805	*	*	*	*	*	*	*
		15257-R	CAP, CHIP 4.7UF 10V Y5V 0805	*	*	*	*	*	*	*
		15259	CAP: 120PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		15261	IC, 24C02 2K SER EEPROM 3V SO	*	*	*	*	*	*	*
		15262	BRACKET, PCI AHA-3960D	*	*	*	*	*	*	*
		15263	CAP, CHIP 4.7UF 16V Y5V 1206	*	*	*	*	*	*	*
		15263-R	CAP, CHIP 4.7UF 16V Y5V 1206	*	*	*	*	*	*	*
		15268	RES, CHIP 51 OHM 5% .5W 2010	*	*	*	*	*	*	*
		15269	TRANS, MJD45H11 PNP PWR DPAK	*	*	*	*	*	*	*
		15270	IC, FS6377-01 PLL CLK GEN SOP	*	*	*	*	*	*	*
		15273	CAP, CHIP 10UF 16V AL LZ434355	*	*	*	*	*	*	*
		15275	SWITCH, 4-POS SPST SMT 0.050	*	*	*	*	*	*	*
		15277	DIODE, SK22 2A 20V SCHOTKY SMB	*	*	*	*	*	*	*
		15279	RES, CHIP 309 1% 1/16W 0603	*	*	*	*	*	*	*
		15281	CAP, CHIP 2.2UF 16V Y5V 0805	*	*	*	*	*	*	*
		15282	IC, TL7702 V SUPERVISOR 2.5 V	*	*	*	*	*	*	*
		15285	BRACKET, 2 CH ULTRA 160	*	*	*	*	*	*	*
		15286	RETAINER, PLASTIC SM FOOTPRINT	*	*	*	*	*	*	*
		15297	RES, CHIP 82 5% 1/10W 0603	*	*	*	*	*	*	*
		15298	BRACKET, 68HD 2.05 SCSI LVD SE	*	*	*	*	*	*	*
		15308	IND, CHIP 10UH 20% 1.1A SMT	*	*	*	*	*	*	*
		15315	OSC, 14.3181M 3.3V SMD 7550	*	*	*	*	*	*	*
		15319	SCREW, M3X6MM PANHD PHIL SST	*	*	*	*	*	*	*
		15320	SCREW, D965A M3X6MM FL HD SST	*	*	*	*	*	*	*
		15324	HEADER, 2POS 2X1 TH RT ANG 2MM	*	*	*	*	*	*	*
		15325	SCREW, M2.5X6MM SL PNHD SST	*	*	*	*	*	*	*
		15327	IC, LT1638 OP AMP MSOP8	*	*	*	*	*	*	*
		15336	HEADER, 2 POS 1X2 RT ANGLE SMT	*	*	*	*	*	*	*
		15339	RES, CHIP 15K 1% 1/10W 0805	*	*	*	*	*	*	*

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		15345	RES, CHIP .02 OHM 1% 1/4W 1206	*	*	*	*	*	*	*
		15346	RES, CHIP 0.2 OHM 1% 1/4W 1206	*	*	*	*	*	*	*
		15347	IND, CHIP 4.7UH20% 4.8A DO3316	*	*	*	*	*	*	*
		15349	IC, 21285-AB SA110 INTRF PBGA	*	*	*	*	*	*	*
		15350	BAT PK, NIMH 2.4V1.96AH W/PIGT	*	*	*	*	*	*	*
		15352	CAP, CHIP 8PF 50V NPO 0603	*	*	*	*	*	*	*
		15352-R	CAP, CHIP 8PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		15355	IC, DS2119ME B4 LVD/SE U2TSSOP	*	*	*	*	*	*	*
		15360	IC, DS2118MB B1 LVD/SE U2 SSOP	*	*	*	*	*	*	*
		15363	IC, VR LDO 3.3V 1.5A D-PAK	*	*	*	*	*	*	*
		15367	CAP, CHIP 1UF 10V Y5V 0603	*	*	*	*	*	*	*
		15367-R	CAP, CHIP 1UF 10V Y5V 0603	*	*	*	*	*	*	*
		15369	DIMM, 8MX72 SDRAM PC100 1.75H	*	*	*	*	*	*	*
		15370	DIMM, 16MX72 SDRAM PC100 1.75H	*	*	*	*	*	*	*
		15372	HEADER, 4POS 1X4 RT ANGLE SMT	*	*	*	*	*	*	*
		15373	SWITCH, MOM RA 0.242" H PCB	*	*	*	*	*	*	*
		15379	RES NTWK, CHIP 8X2.7K 5% 6431	*	*	*	*	*	*	*
		15381	RES NTWK, CHIP 8X10K 5% 6431	*	*	*	*	*	*	*
		15383	RES, CHIP 42.2 1% 1/16W 0603	*	*	*	*	*	*	*
		15384	RES, CHIP 31.6K 1% 1/16W 0603	*	*	*	*	*	*	*
		15386	RES, CHIP .01 1% 1/4W 1206	*	*	*	*	*	*	*
		15387	IC, SI9430DY P-CHAN MOSFET SO8	*	*	*	*	*	*	*
		15388	IC, 29LV800 FLSH 3V 90NS TSOP1	*	*	*	*	*	*	*
		15389	INDUCTOR, CHIP 4.7UH 20% 2220	*	*	*	*	*	*	*
		15389-R	INDUCTOR, CHIP 4.7UH 20% 2220	*	*	*	*	*	*	*
		15398	RES, CHIP 15.4K 1% 1/10W 0805	*	*	*	*	*	*	*
		15401	RES, CHIP 34.8 1% 1/16W 0603	*	*	*	*	*	*	*
		15402	RES, CHIP 49.9 1% 1/16W 0603	*	*	*	*	*	*	*
		15403	RES, CHIP 24.9K 1% 1/16W 0603	*	*	*	*	*	*	*
		15406	RES, CHIP 560 5% 1/10W 0603	*	*	*	*	*	*	*
		15408	OSC, CER SMD 33MHZ 3.3V 7550	*	*	*	*	*	*	*
		15426	IC, 4MX16 SDRAM 133MHZ 3V TSOP	*	*	*	*	*	*	*
		15427	DIO, SL12 20V 1.5A SB SMA	*	*	*	*	*	*	*
		15428	RES, CHIP .05 OHM 1% 1/4W 1206	*	*	*	*	*	*	*
		15431	CONN, 68P DUST RCPT RA CNT/SH	*	*	*	*	*	*	*
		15432	RES, CHIP 59K 1% 1/16W 0603	*	*	*	*	*	*	*
		15433	CAP, CHIP 15UF 20% 10V TA 3216	*	*	*	*	*	*	*
		15435	BRACKET, AAC-3642 W/CTR SHLD	*	*	*	*	*	*	*
		15438	IC, 64KX16 SRAM 20NS 5V TSOPII	*	*	*	*	*	*	*
		15442	RES, CHIP 243K 1% 1/10W 0805	*	*	*	*	*	*	*
		15445	RES, CHIP 17.8K 1% 1/16W 0603	*	*	*	*	*	*	*
		15457	BRACKET, LOW PRO VHDCI 1.276"	*	*	*	*	*	*	*
		15461	RES, CHIP 402K 1% 1/10W 0805	*	*	*	*	*	*	*
		15463	IC, PIC16LF877-04 MCNTR TQFP	*	*	*	*	*	*	*
		15463-R	IC, PIC16LF877-04 MCNTR TQFP	*	*	*	*	*	*	*
		15466	BRACKET, ASC-29160LP FULL HT	*	*	*	*	*	*	*
		15471	CAP, CHIP 1000PF 25V NPO 0603	*	*	*	*	*	*	*
		15471-R	CAP, CHIP 1000PF 25V NPO 0603	*	*	*	*	*	*	*
		15472	CAP, CHIP .1UF 16V X7R 0603	*	*	*	*	*	*	*
		15472-R	CAP, CHIP .1UF 16V X7R 0603	*	*	*	*	*	*	*
		15473	CAP, CHIP 0.22UF 16V Y5V 0603	*	*	*	*	*	*	*
		15479	IC, 1085 LDO VR 3.3V 3A DDPK	*	*	*	*	*	*	*

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		15482	RES, CHIP 10.2K 1% 1/10W 0805	*	*	*	*	*	*	*
		15486	HEATSINK, HT-34X34 W/CHOM T411	*	*	*	*	*	*	*
		15492	JUMPER, SHUNT 2.00MM BLUE HP	*	*	*	*	*	*	*
		15511	IC, HPT370 ATA100 RAICONT LQFP	*	*	*	*	*	*	*
		15512	IC, 80960RS I/O PROCES H-PBGA	*	*	*	*	*	*	*
		15530	IC, ISPLSI2032A PLD110MHZ TQFP	*	*	*	*	*	*	*
		15532	IC, ISPLSI2032A PLD 80MHZ TQFP	*	*	*	*	*	*	*
		15538	IC, 39VF010-70/90 FLSH 3V PLCC	*	*	*	*	*	*	*
		15538-R	IC, 39VF010-70/90 FLSH 3V PLCC	*	*	*	*	*	*	*
		15541	CAP, CHIP 10UF 16V AL ULE 4343	*	*	*	*	*	*	*
		15541-R	CAP, CHIP 10UF 16V AL ULE 4343	*	*	*	*	*	*	*
		15550	CONN, 68-P RA P-CONN RCP, HT	*	*	*	*	*	*	*
		15550-R	CONN, 68-P RA P-CONN RCP, HT	*	*	*	*	*	*	*
		15553	HEADER, 2-PIN DIP, HT	*	*	*	*	*	*	*
		15554	HEADER, 4-PIN SIP RA, HT	*	*	*	*	*	*	*
		15558	OSC, CER SMD 80MHZ 3V TS 7550	*	*	*	*	*	*	*
		15558-R	OSC, CER SMD 80MHZ 3V TS 7550	*	*	*	*	*	*	*
		15564	IC, 74LVC74 DUAL DTYP FF TSSOP	*	*	*	*	*	*	*
		15566	IC, 74LVC06 HEX INVERTER SOIC	*	*	*	*	*	*	*
		15567	IC, 29LV160-70/90/120 FL3VTSOP	*	*	*	*	*	*	*
		15567-R	IC, 29LV160-70/90/120 FL3VTSOP	*	*	*	*	*	*	*
		15568	IC, 74FCT3807 CLK DRVR 3V QSOP	*	*	*	*	*	*	*
		15569	IC, TL16C752B DUAL UART LQFP	*	*	*	*	*	*	*
		15576	BUZZER, AUDIO TRANSDUCERS DIP	*	*	*	*	*	*	*
		15577	HDR, 6-POS DUAL RA 3MM P SMT/N	*	*	*	*	*	*	*
		15578	CONN, 38-POS VERTICAL MICTOR	*	*	*	*	*	*	*
		15579	IC, 24C32 I2C SEEPRM 32KB SO	*	*	*	*	*	*	*
		15579-R	IC, 24C32 I2C SEEPRM 32KB SO	*	*	*	*	*	*	*
		15580	IC, EPM7128AE-10 PLD TQFP-100	*	*	*	*	*	*	*
		15581	DIO, MMBD7000 DSWITCHING SOT23	*	*	*	*	*	*	*
		15585	LM431BCM3/N1DNOPB	*	*	*	*	*	*	*
		15585-R	LM431BCM3/N1DNOPB	*	*	*	*	*	*	*
		15587	CAP, 100UF 10V TA .1/.2S RDL	*	*	*	*	*	*	*
		15594	LED, CHIP GRN TOP 3216	*	*	*	*	*	*	*
		15596	CAP, CHIP 39PF 50V NPO 0603	*	*	*	*	*	*	*
		15597	IC, XC95144XL CPLD 3.3V TQFP	*	*	*	*	*	*	*
		15598	IC, 74CBT3306 2X FET BUS SW SO	*	*	*	*	*	*	*
		15600	RES, CHIP 5.6K 5% 1/16W 0603	*	*	*	*	*	*	*
		15601	RES, CHIP 68 5% 1/10W 0603	*	*	*	*	*	*	*
		15607	CAP, CHIP 4.7UF 25V TA LE 6032	*	*	*	*	*	*	*
		15612	RES NTWK, CHIP 4X10 5% 3216	*	*	*	*	*	*	*
		15621	IC, 39VF040 70NS FLSH 3V PLCC	*	*	*	*	*	*	*
		15623	IC, LT1764 LD VR 1.8V 3A DDPK	*	*	*	*	*	*	*
		15623-R	IC, LT1764 LD VR 1.8V 3A DDPK	*	*	*	*	*	*	*
		15630	DIODE, MBRS130L(SMB)SB 1A 30V	*	*	*	*	*	*	*
		15633	RES, CHIP .04 OHM 1% 1/4W 1206	*	*	*	*	*	*	*
		15633-R	RES, CHIP .04 OHM 1% 1/4W 1206	*	*	*	*	*	*	*
		15641	RES, CHIP 36K 5% 1/16W 0603	*	*	*	*	*	*	*
		15643	RES, CHIP 909K 1% 1/16W 0603	*	*	*	*	*	*	*
		15645	RES, CHIP 8.2K 5% 1/10W 0603	*	*	*	*	*	*	*
		15646	RES, CHIP 9.1K 5% 1/16W 0603	*	*	*	*	*	*	*
		15648	RES, CHIP 1.62K 1% 1/16W 0603	*	*	*	*	*	*	*

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		15649	RES, CHIP 1.30K 1% 1/16W 0603	*	*	*	*	*	*	*
		15665	XTAL, 25MHZ CERAMIC SMD 2-PIN	*	*	*	*	*	*	*
		15690	IC, EPM3128A CLPD 10NS 144TQFP	*	*	*	*	*	*	*
		15698	RES NTWK, CHIP 4X82 5% 3216	*	*	*	*	*	*	*
		15700	RES NTWK, CHIP 4X33 5% 3216	*	*	*	*	*	*	*
		15703	CAP, CHIP 150PF 50V NPO 0805	*	*	*	*	*	*	*
		15703-R	CAP, CHIP 150PF 50V NPO 0805	*	*	*	*	*	*	*
		15704	CAP, CHIP 15UF 16V TA 3528	*	*	*	*	*	*	*
		15705	CAP: 1UF 20% 25V Y5V 1206	*	*	*	*	*	*	*
		15706	CAP, CHIP 1000PF 3KV X7R 1808	*	*	*	*	*	*	*
		15707	CAP, CHIP 10UF 16V TA ULE 3528	*	*	*	*	*	*	*
		15708	CAP, CHIP .22UF 35V TA 3216	*	*	*	*	*	*	*
		15708-R	CAP, CHIP .22UF 35V TA 3216	*	*	*	*	*	*	*
		15709	IND, CHIP 2.2UH 7A DO3316	*	*	*	*	*	*	*
		15710	DIO, 5226B 3.3V .225W ZNR SOT	*	*	*	*	*	*	*
		15712	IC, LTC1440 COMPARATR W/REF SO	*	*	*	*	*	*	*
		15713	IC, 74LVC14A SCHMT TRG INV SO	*	*	*	*	*	*	*
		15717	IC, 74CBTLV3126 4X BUS SW SO	*	*	*	*	*	*	*
		15719	IC, 74LVC08 4X 2I AND GATE SO	*	*	*	*	*	*	*
		15720	IC, 80303 ZION I/O PROCSR PBGA	*	*	*	*	*	*	*
		15722	RES, CHIP 2.32K 1% 1/10W 0805	*	*	*	*	*	*	*
		15723	RES, CHIP 11.5K .1%TF .1W 0805	*	*	*	*	*	*	*
		15724	RES, CHIP 220K 5% 1/10W 0805	*	*	*	*	*	*	*
		15725	RES, CHIP 5.1 5% 1/10W 0805	*	*	*	*	*	*	*
		15727	RES, CHIP 6.19K 1% 1/10W 0805	*	*	*	*	*	*	*
		15728	RES, CHIP 68.1 1% 1/10W 0805	*	*	*	*	*	*	*
		15729	RES, CHIP 4.12K 1% 1/10W 0805	*	*	*	*	*	*	*
		15730	RES, CKT PROTECT 1.1A SMDM110	*	*	*	*	*	*	*
		15731	TRANS, SI9424 P-MOSFET SO	*	*	*	*	*	*	*
		15732	CAP, CHIP 100UF 10V TA LE 7343	*	*	*	*	*	*	*
		15734	IND, CHIP 10UH 20% 1.45A 2218	*	*	*	*	*	*	*
		15735	DIO, 5817 20V 1A SCHTKY MELF	*	*	*	*	*	*	*
		15736	IC, 24C01A 1K 2.7 SEEPROM SO	*	*	*	*	*	*	*
		15737	IC, BQ2004H FAST BAT CHRGR SO	*	*	*	*	*	*	*
		15739	RES, CHIP 28.7K 1% 1/10W 0805	*	*	*	*	*	*	*
		15740	RES, CHIP 43K 5% 1/10W 0805	*	*	*	*	*	*	*
		15742	RES, CHIP .1 OHM 1% .5W 2010	*	*	*	*	*	*	*
		15743	RES, CHIP 4.22K .1%TF .1W 0805	*	*	*	*	*	*	*
		15744	RES, CHIP 44.2K 1% 1/10W 0805	*	*	*	*	*	*	*
		15745	RES, CHIP 45.3K 1% 1/10W 0805	*	*	*	*	*	*	*
		15746	RES, CHIP 510K 5% 1/10W 0805	*	*	*	*	*	*	*
		15757	RES, CHIP 10.4 1% 2W 4527	*	*	*	*	*	*	*
		15759	RES, CHIP 46.4K 1% 1/10W 0805	*	*	*	*	*	*	*
		15760	RES, CHIP 210K 1% 1/10W 0805	*	*	*	*	*	*	*
		15761	RES, CHIP 20.0 1% 1/10W 0805	*	*	*	*	*	*	*
		15763	CONN, 5-PIN HEAD 0.100" RA SMT	*	*	*	*	*	*	*
		15765	OSC, CER SMD 40MHZ 3V TS 7550	*	*	*	*	*	*	*
		15769	IC, 74LVC139 2-4 DEMUX TSSOP	*	*	*	*	*	*	*
		15770	RES, CHIP 56 5% 1/10W 0603	*	*	*	*	*	*	*
		15777	RES, CHIP 3.16K .1%TF .1W 0805	*	*	*	*	*	*	*
		15779	RES, CHIP 6.04 1% 2W 4527	*	*	*	*	*	*	*
		15781	CAP, CHIP 100UF 6.3V AL 636355	*	*	*	*	*	*	*

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		15782	CAP, CHIP 10UF 50V AL 636355	*	*	*	*	*	*	*
		15783	IC, ISPLSI2032VE CPLD225M TQFP	*	*	*	*	*	*	*
		15785	IC, AT93C66-2.7 SEEPROM 3V SO	*	*	*	*	*	*	*
		15786	IC, LX8117 LD VR 2.5V 0.8A SOT	*	*	*	*	*	*	*
		15786-R	IC, LX8117 LD VR 2.5V 0.8A SOT	*	*	*	*	*	*	*
		15789	IND, CHIP 2.2UH 16A DO5022	*	*	*	*	*	*	*
		15793	IC, C9531C PCIX I/O CLK TSSOP	*	*	*	*	*	*	*
		15795	IC, XC9572XL-5 CPLD 3.3V VQFP	*	*	*	*	*	*	*
		15799	IC, 74LVC573A DTYPE LATCH SSOP	*	*	*	*	*	*	*
		15803	IC, ML4769 ADJ OP BOOST REG SO	*	*	*	*	*	*	*
		15806	RES, CHIP 165K 1% 1/10W 0805	*	*	*	*	*	*	*
		15810	IC, 74LVC245A BUS XCVR 3V SSOP	*	*	*	*	*	*	*
		15819	IC, CY2309 ZRO DELAY BFR 3V SO	*	*	*	*	*	*	*
		15820	OSC, 100MHZ TS 3.3V SMT 7050	*	*	*	*	*	*	*
		15827	RES, CHIP 8.45K .5%TF .1W 0805	*	*	*	*	*	*	*
		15838	OSC, 40MHZ 45/55 3.3V SMD 7550	*	*	*	*	*	*	*
		15841	IC, 21154AC PCI BRDG33MHZ PBGA	*	*	*	*	*	*	*
		15857	DIMM, 4MX72 SDRAM 100 3V 1.00H	*	*	*	*	*	*	*
		15860	IC, 1963 LDO VR 2.5V SOT223	*	*	*	*	*	*	*
		15863	IC, CY37032V-100 CPLD 3V TQFP	*	*	*	*	*	*	*
		15869	IC, 74LVC32A 4X 2I OR GATE SO	*	*	*	*	*	*	*
		15872	CONN, 60-POS .8MM VT-PLUG 7.7M	*	*	*	*	*	*	*
		15873	CONN, 60-POS .8MM VT-RCPT 7.7M	*	*	*	*	*	*	*
		15874	IC, 80200 PROCESSOR 733M PBGA	*	*	*	*	*	*	*
		15875	IC, 7558BC ADJ 8A SYNC SW HSOP	*	*	*	*	*	*	*
		15878	LED, SINGLE YELLOW SM 1206	*	*	*	*	*	*	*
		15879	CONN, 20-PIN VERT RCPT DR .100	*	*	*	*	*	*	*
		15884	DIMM, 8MX72 SDRAM 64MB-PC100	*	*	*	*	*	*	*
		15887	HDR, 40P VERT SHD OMIT P20 .1	*	*	*	*	*	*	*
		15891	IC, DS2119M C1 LVD/SE U2 TSSOP	*	*	*	*	*	*	*
		15896	IC, DS2118M C1 LVD/SE U2 SSOP	*	*	*	*	*	*	*
		15902	IC, QS3VH125 4X BUS SW 3V QSOP	*	*	*	*	*	*	*
		15904-R	FERRITE, CHIP EMI Z600 .2A0603	*	*	*	*	*	*	*
		15910	RES NTWK, CHIP 4X8.2K 5% 3216	*	*	*	*	*	*	*
		15915	IC, XCR3064XL CPLD 7NS 3V VQFP	*	*	*	*	*	*	*
		15923	HDR, 5-POS SR RA 4.2MM PITCH	*	*	*	*	*	*	*
		15924	CONN, 92 DUAL POS EDGE 3V PCI	*	*	*	*	*	*	*
		15926	SWITCH, DS1818 RESET 3.3V SOT	*	*	*	*	*	*	*
		15928	HDR, 20POS VERT 2X 4.2MM PITCH	*	*	*	*	*	*	*
		15929	IC, TLC7225C 4X 8-BIT DAC SOIC	*	*	*	*	*	*	*
		15931	IC, AD7859 8CH 12B ADC 3V PQFP	*	*	*	*	*	*	*
		15933	LED, CHIP ORANGE TOP 3216 SMT	*	*	*	*	*	*	*
		15936	IC, 1085 VREG LDO ADJ 3A TO263	*	*	*	*	*	*	*
		15939-R	RES, CHIP 121 1% 1/16W 0603	*	*	*	*	*	*	*
		15940	RES, CHIP 51.1 1% 1/16W 0603	*	*	*	*	*	*	*
		15943	RES, CHIP 68.1 1% 1/16W 0603	*	*	*	*	*	*	*
		15946	CAP, CHIP 68UF 8V AL LE 7343	*	*	*	*	*	*	*
		15952	IC, IBM133PCI-X BRG V2.0 HPBGA	*	*	*	*	*	*	*
		15953	IC, 80302 I/O PROCESSOR PBGA	*	*	*	*	*	*	*
		15955	IC, 74LVC08A 4X 2I AND G TSSOP	*	*	*	*	*	*	*
		15956	IC, 74LVC244A 8X BUF TS TSSOP	*	*	*	*	*	*	*
		15959	IC, UCC5672 LVD/SE U2 TSSOP	*	*	*	*	*	*	*

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		15960	IC, LT1763 REG LDO 500MA SO	*	*	*	*	*	*	*
		15964	IC, LTC3401 DC-DC CONVTR MSOP	*	*	*	*	*	*	*
		15965	IC, LTC1773 SYNC REG CONT MSOP	*	*	*	*	*	*	*
		15966	IC, LTC1732-4.2 BCH CONTR MSOP	*	*	*	*	*	*	*
		15967	RES, CHIP 40.2K 1% 1/16W 0603	*	*	*	*	*	*	*
		15968	RES, CHIP 30.1K 1% 1/16W 0603	*	*	*	*	*	*	*
		15969	RES, CHIP 412K 1% 1/16W 0603	*	*	*	*	*	*	*
		15970	RES, CHIP 549K 1% 1/16W 0603	*	*	*	*	*	*	*
		15971	RES, CHIP 187K 1% 1/16W 0603	*	*	*	*	*	*	*
		15972	RES, CHIP 249K 1% 1/10W 0603	*	*	*	*	*	*	*
		15980	CAP: 47PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		15981	TRANS, SI4500 NP-CH HBRIDGE SO	*	*	*	*	*	*	*
		15985	IC, EPM3128A CPLD 10NS 3V TQFP	*	*	*	*	*	*	*
		15985-R	IC, EPM3128A CPLD 10NS 3V TQFP	*	*	*	*	*	*	*
		15986	TRANS, SI5475 PMOSFET 1206-8	*	*	*	*	*	*	*
		15986-R	TRANS, SI5475 PMOSFET 1206-8	*	*	*	*	*	*	*
		15988	RES, CHIP 19.6K 1% 1/16W 0603	*	*	*	*	*	*	*
		15998	IC, DG406 16-CHAN MULTIPLEX SO	*	*	*	*	*	*	*
		15999	IND, CHIP 3UH 30% 3AMP SMT	*	*	*	*	*	*	*
		15G4249	RES; 0 OHMS X 4, 0.5A; 1206	*	*	*	*	*	*	*
		15G4251	RES;10KX4,5%;.063W,1206	*	*	*	*	*	*	*
		15G4255	RES;4.7KX4,5%;.063W,1206	*	*	*	*	*	*	*
		16008	HDR, 20-PIN DR VERT HIGH TEMP	*	*	*	*	*	*	*
		16009	HDR, 2-PIN SR VERT HIGH TEMP	*	*	*	*	*	*	*
		16010	HDR, 4-PIN SR VERT HIGH TEMP	*	*	*	*	*	*	*
		16015	IC, 29LV033 FLASH 90NS 3V TSOP	*	*	*	*	*	*	*
		16016	IC, EPM3256A CPLD 7NS 3V PQFP	*	*	*	*	*	*	*
		16017	IC, 29LV320 FLASH 90NS 3V TSOP	*	*	*	*	*	*	*
		16020	IC, 8MX16 SDRAM 133MHZ 3V TSOP	*	*	*	*	*	*	*
		16021	RES, CHIP 11.5K 1% 1/10W 0603	*	*	*	*	*	*	*
		16024	HEADER, 10-PIN DIP HI-TEMP	*	*	*	*	*	*	*
		16026	CAP, CHIP 33UF 10V TA 3528	*	*	*	*	*	*	*
		16027	CAP, CHIP 3.3+/- .25PF NPO 0603	*	*	*	*	*	*	*
		16028	CAP, CHIP 10UF 10V TA 3216	*	*	*	*	*	*	*
		16032	RES NTWK, CHIP 8X8.2K 5% 3816	*	*	*	*	*	*	*
		16032-R	RES NTWK, CHIP 8X8.2K 5% 3816	*	*	*	*	*	*	*
		16034	RES NTWK, CHIP 8X47 5% 3816	*	*	*	*	*	*	*
		16035	HDR, 1X2X.1 VERT .23H PTH	*	*	*	*	*	*	*
		16039	LED, GRN TOP SML210 20MA 0805	*	*	*	*	*	*	*
		16040	FERRITE, CHIP Z39 4A 0805	*	*	*	*	*	*	*
		16044	IC, SERDES FC/GB TRANSCVR PQFP	*	*	*	*	*	*	*
		16046	OSC, 125MHZ 3.3V TS 45/55 7050	*	*	*	*	*	*	*
		16047	IC, 74LCX573 OCTAL LATCH SSOP	*	*	*	*	*	*	*
		16048	IC, MIC39102 LDO VR ADJ 1A SO	*	*	*	*	*	*	*
		16056	IC, 80321 I/O PRCR 400MHZ PBGA	*	*	*	*	*	*	*
		16057	CKT PROTECT, 1A NANOSMD 1206	*	*	*	*	*	*	*
		16059	LED, RED RA MT 0.2HT T1(.060")	*	*	*	*	*	*	*
		16061	LED, YEL RA MT 0.2HT T1(.060")	*	*	*	*	*	*	*
		16063	TRANS, SI6465 PMFET 1.8V TSSOP	*	*	*	*	*	*	*
		16065	IC, 2MX16X4 DDR SDRAM TSOP	*	*	*	*	*	*	*
		16066	IC, XC95144XL 3V CPLD 144 TQFP	*	*	*	*	*	*	*
		16067	IC, 32KX8 3.3V NVSRAM 45 SO32	*	*	*	*	*	*	*

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		16069	IND, 3.3UH 20% 4.5A LP SMT	*	*	*	*	*	*	*
		16071	IC, 4MX16X4 SDRAM 133M 75 TSOP	*	*	*	*	*	*	*
		16072	IC, MAX6375 2.2V VOLT DET SC70	*	*	*	*	*	*	*
		16072-R	IC, MAX6375 2.2V VOLT DET SC70	*	*	*	*	*	*	*
		16073	IC, LTC1779 DC-DC CONVTR SOT23	*	*	*	*	*	*	*
		16074	IC, MAX6378 4.4V VOLT DET SC70	*	*	*	*	*	*	*
		16077	IC, IRU1206 LDO VR 1.8V SOT223	*	*	*	*	*	*	*
		16078	DIODE, MBR0520L .5A 20V SB SOD	*	*	*	*	*	*	*
		16079	DIODE, MBRM120ET3 1A 20V SB	*	*	*	*	*	*	*
		16079-R	DIODE, MBRM120ET3 1A 20V SB	*	*	*	*	*	*	*
		16082	IC, FAN6555 2A DDR SW REG SOIC	*	*	*	*	*	*	*
		16083	IC, MAX1818 LDO VR 2.5V SOT23	*	*	*	*	*	*	*
		16084	IC, 74LVC1G14 SCHTRIG INV SC70	*	*	*	*	*	*	*
		16085	IC, 74LVC1G126 BUF GATE SC70	*	*	*	*	*	*	*
		16085-R	IC, 74LVC1G126 BUF GATE SC70	*	*	*	*	*	*	*
		16086	IC, 74LVC1G08 AND GATE SC70	*	*	*	*	*	*	*
		16086-R	IC, 74LVC1G08 AND GATE SC70	*	*	*	*	*	*	*
		16089	IC, LT1963 LDO VR 1.8V 1.5A SO	*	*	*	*	*	*	*
		16093	IND, CHIP 3.3UH 5.9A D03316	*	*	*	*	*	*	*
		16094	IND, CHIP 4.7UH 2.2A D01813	*	*	*	*	*	*	*
		16095	CAP, CHIP 100UF 10V TA 7343LO	*	*	*	*	*	*	*
		16095-R	CAP, CHIP 100UF 10V TA 7343LO	*	*	*	*	*	*	*
		16098	CONN, 40P .8MM F STK 5/6/7/8MM	*	*	*	*	*	*	*
		16099	CONN, 68-POS VERT RCPT HI-TEMP	*	*	*	*	*	*	*
		16101	RES, CHIP 332 1% 1/16W 0603	*	*	*	*	*	*	*
		16104	IC, 29EE010 FLH 90NS 1K PLCC	*	*	*	*	*	*	*
		16113	RES, CHIP 107K 1% 1/16W 0402	*	*	*	*	*	*	*
		16113-R	RES, CHIP 107K 1% 1/16W 0402	*	*	*	*	*	*	*
		16114	RES, CHIP 174K 1% 1/16W 0402	*	*	*	*	*	*	*
		16114-R	RES, CHIP 174K 1% 1/16W 0402	*	*	*	*	*	*	*
		16116	RES, CHIP 2.00K 1% 1/16W 0402	*	*	*	*	*	*	*
		16118	RES, CHIP 309K 1% 1/16W 0402	*	*	*	*	*	*	*
		16127	RES, CHIP 1.5K 5% 1/16W 0402	*	*	*	*	*	*	*
		16127-R	RES, CHIP 1.5K 5% 1/16W 0402	*	*	*	*	*	*	*
		16128	RES, CHIP 100K 5% 1/16W 0402	*	*	*	*	*	*	*
		16129-R	RES, CHIP 10K 5% 1/16W 0402	*	*	*	*	*	*	*
		16130	RES, CHIP 150 5% 1/16W 0402	*	*	*	*	*	*	*
		16130-R	RES, CHIP 150 5% 1/16W 0402	*	*	*	*	*	*	*
		16132	RES, CHIP 18 5% 1/16W 0402	*	*	*	*	*	*	*
		16133	RES, CHIP 22 5% 1/16W 0402	*	*	*	*	*	*	*
		16136	RES, CHIP 2.7K 5% 1/16W 0402	*	*	*	*	*	*	*
		16136-R	RES, CHIP 2.7K 5% 1/16W 0402	*	*	*	*	*	*	*
		16138	RES, CHIP 4.7K 5% 1/16W 0402	*	*	*	*	*	*	*
		16138-R	RES, CHIP 4.7K 5% 1/16W 0402	*	*	*	*	*	*	*
		16139	RES, CHIP 5.1K 5% 1/16W 0402	*	*	*	*	*	*	*
		16141	RES, CHIP 8.2K 5% 1/16W 0402	*	*	*	*	*	*	*
		16141-R	RES, CHIP 8.2K 5% 1/16W 0402	*	*	*	*	*	*	*
		16142	RES, CHIP ZERO-OHM JUMPER 0402	*	*	*	*	*	*	*
		16142-R	RES, CHIP ZERO-OHM JUMPER 0402	*	*	*	*	*	*	*
		16145	CAP: 22PF 5% 50V NPO 0402	*	*	*	*	*	*	*
		16145-R	CAP: 22PF 5% 50V NPO 0402	*	*	*	*	*	*	*
		16146	CAP: 0.01UF 10% 16V X7R 0402	*	*	*	*	*	*	*

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		16146-R	CAP: 0.01UF 10% 16V X7R 0402	*	*	*	*	*	*	*
		16147	CAP, CHIP 0.022UF 16V X7R 0402	*	*	*	*	*	*	*
		16148	CAP: 1000PF 10% 50V X7R 0402	*	*	*	*	*	*	*
		16148-R	CAP: 1000PF 10% 50V X7R 0402	*	*	*	*	*	*	*
		16149	CAP: 100PF 5% 50V NPO 0402	*	*	*	*	*	*	*
		16149-R	CAP: 100PF 5% 50V NPO 0402	*	*	*	*	*	*	*
		16150	CAP: 220PF 10% 50V X7R 0402	*	*	*	*	*	*	*
		16150-R	CAP: 220PF 10% 50V X7R 0402	*	*	*	*	*	*	*
		16155	RES, CHIP 33 5% 1/16W 0402	*	*	*	*	*	*	*
		16155-R	RES, CHIP 33 5% 1/16W 0402	*	*	*	*	*	*	*
		16157	CAP, CHIP 0.022UF 25V Y5V 0402	*	*	*	*	*	*	*
		16158	CAP, CHIP 0.1UF 16V Y5V 0402	*	*	*	*	*	*	*
		16158-R	CAP, CHIP 0.1UF 16V Y5V 0402	*	*	*	*	*	*	*
		16159	CAP, CHIP 0.01UF 50V Y5V 0402	*	*	*	*	*	*	*
		16160	CAP, CHIP 0.22UF 10V Y5V 0402	*	*	*	*	*	*	*
		16160-R	CAP, CHIP 0.22UF 10V Y5V 0402	*	*	*	*	*	*	*
		16166	HEADER, 2-PIN SIP RA HT	*	*	*	*	*	*	*
		16168	CAP, CHIP 470UF 6V TA LE 7343H	*	*	*	*	*	*	*
		16169	RES NTWK, CHIP 8X33 5% 3816	*	*	*	*	*	*	*
		16169-R	RES NTWK, CHIP 8X33 5% 3816	*	*	*	*	*	*	*
		16170	RES NTWK, CHIP 8X68 5% 3816	*	*	*	*	*	*	*
		16170-R	RES NTWK, CHIP 8X68 5% 3816	*	*	*	*	*	*	*
		16173	RESONATOR, 4.00MHZ CERAMIC SMT	*	*	*	*	*	*	*
		16173-R	RESONATOR, 4.00MHZ CERAMIC SMT	*	*	*	*	*	*	*
		16174	CAP, CHIP 22UF 16V AL ULE 5353	*	*	*	*	*	*	*
		16174-R	CAP, CHIP 22UF 16V AL ULE 5353	*	*	*	*	*	*	*
		16177	IC, UCC5630A 9 LVDS/SE TERM SO	*	*	*	*	*	*	*
		16181	CONN, 7-P SATA SIGNAL RA SMT	*	*	*	*	*	*	*
		16182	IND, CHIP 1UH 20% .85A 1210	*	*	*	*	*	*	*
		16190	STANDOFF, STL 5MM HEX M3X0.5	*	*	*	*	*	*	*
		16193	IC, LT1763-2.5 VR LDO 500MA SO	*	*	*	*	*	*	*
		16195	CONN, 40P .8MM M STK 5/9/13MM	*	*	*	*	*	*	*
		16198	IC, 88I8030 SATA/PATA TQFP64	*	*	*	*	*	*	*
		16199	RES, CHIP 30.1 1% 1/4W 1210	*	*	*	*	*	*	*
		16199-R	RES, CHIP 30.1 1% 1/4W 1210	*	*	*	*	*	*	*
		16200	IND, 22UH 10% .73A SMT	*	*	*	*	*	*	*
		16203	CAP, CHIP 10UF10% 10V X5R 1210	*	*	*	*	*	*	*
		16203-R	CAP, CHIP 10UF10% 10V X5R 1210	*	*	*	*	*	*	*
		16205	OSC, XTAL CLK 8MHZ SOJ4	*	*	*	*	*	*	*
		16214	RES, CHIP 2.49K 1% 1/16W 0402	*	*	*	*	*	*	*
		16218	SKT, 184P DIMM RA DDR 2.5V HT	*	*	*	*	*	*	*
		16221	CONN, 114-POS VERT MICTOR RECP	*	*	*	*	*	*	*
		16222	BUZZER, ELECTROMAGNETIC SMT	*	*	*	*	*	*	*
		16227	DIMM, 16MX72DDR200 SDRAM 1.25H	*	*	*	*	*	*	*
		16228	IC, 29LV017-70/90/120 UF3VTSOP	*	*	*	*	*	*	*
		16241	CONN, 68-P RA PCON RCP WOBL HT	*	*	*	*	*	*	*
		16248	IC, 80321 I/O PRCR 600MHZ PBGA	*	*	*	*	*	*	*
		16249	RES, CHIP 68 5% 1/16W 0402	*	*	*	*	*	*	*
		16249-R	RES, CHIP 68 5% 1/16W 0402	*	*	*	*	*	*	*
		16250	CONN, 7-P SATA SIGNAL VRT PTH	*	*	*	*	*	*	*
		16251	IC, CDCV304 PCIX CLKBUF TSSOP8	*	*	*	*	*	*	*
		16252	OSC, 75MHZ CMOS 3.3V 15PF 7550	*	*	*	*	*	*	*

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		16253	RES, CHIP 249 1% 1/16W 0603	*	*	*	*	*	*	*
		16263	CAP, 820UF 20% 6.3V LO ESR SMT	*	*	*	*	*	*	*
		16266	HDR, 3-P 2.5MM STAGRD VERT PTH	*	*	*	*	*	*	*
		16270	IC, ISP5128VE 100M 3V TQFP128	*	*	*	*	*	*	*
		16272	CABLE, SERIAL-ATA SIGNAL 1M	*	*	*	*	*	*	*
		16273	RES, CHIP 66.5 1% 1/16W 0603	*	*	*	*	*	*	*
		16282	RES, CHIP 107 1% 1/16W 0603	*	*	*	*	*	*	*
		16285	IC, 256KX8 SRAM 70NS 3.3V TSOP	*	*	*	*	*	*	*
		16285-R	IC, 256KX8 SRAM 70NS 3.3V TSOP	*	*	*	*	*	*	*
		16286	ADAPTER, MOD RTC + NVRAM SOH28	*	*	*	*	*	*	*
		16286-R	ADAPTER, MOD RTC + NVRAM SOH28	*	*	*	*	*	*	*
		16287	MOD, BATTERY + CRYSTAL SH4	*	*	*	*	*	*	*
		16287-R	MOD, BATTERY + CRYSTAL SH4	*	*	*	*	*	*	*
		16295	CONN, 5X6 2MM F I/O SHLD RA	*	*	*	*	*	*	*
		16296	IC, SIL3112 PCI>SATA CTRLR TQFP	*	*	*	*	*	*	*
		16297	RES, CHIP 20.0K 1% 1/16W 0603	*	*	*	*	*	*	*
		16304	IC, 74LVC1G80 D-TYPE FF SC70	*	*	*	*	*	*	*
		16306	IC, LT1963 ADJ VR 1.5A SOIC8	*	*	*	*	*	*	*
		16307	IC, LTC1733 BAT CHRGR MSOP10	*	*	*	*	*	*	*
		16307-R	IC, LTC1733 BAT CHRGR MSOP10	*	*	*	*	*	*	*
		16309	IC, 74LVC1G00 NAND GATE SC70	*	*	*	*	*	*	*
		16310	CONN, 4P 1.25MM M SIP VERT SMT	*	*	*	*	*	*	*
		16310-R	CONN, 4P 1.25MM M SIP VERT SMT	*	*	*	*	*	*	*
		16311	IC, LTC3405A SW REG STP-DWN S6	*	*	*	*	*	*	*
		16311-R	IC, LTC3405A SW REG STP-DWN S6	*	*	*	*	*	*	*
		16313	RES, CHIP 3.01K 1% 1/16W 0402	*	*	*	*	*	*	*
		16314	RES, CHIP 1.0M 5% 1/16W 0402	*	*	*	*	*	*	*
		16315	RES, CHIP 1.0K 5% 1/16W 0402	*	*	*	*	*	*	*
		16316	RES, CHIP 470 5% 1/16W 0402	*	*	*	*	*	*	*
		16316-R	RES, CHIP 470 5% 1/16W 0402	*	*	*	*	*	*	*
		16317	RES, CHIP 680 5% 1/16W 0402	*	*	*	*	*	*	*
		16318	RES, CHIP 100 5% 1/16W 0402	*	*	*	*	*	*	*
		16318-R	RES, CHIP 100 5% 1/16W 0402	*	*	*	*	*	*	*
		16327	IC, 74LVC2G126 2 BUF GATE SSOP	*	*	*	*	*	*	*
		16329	IC, LTC3701 DUAL SD DC/DC SSOP	*	*	*	*	*	*	*
		16329-R	IC, LTC3701 DUAL SD DC/DC SSOP	*	*	*	*	*	*	*
		16336	RES, CHIP 71.5K 1% 1/16W 0402	*	*	*	*	*	*	*
		16336-R	RES, CHIP 71.5K 1% 1/16W 0402	*	*	*	*	*	*	*
		16337	RES, CHIP 80.6K 1% 1/16W 0402	*	*	*	*	*	*	*
		16337-R	RES, CHIP 80.6K 1% 1/16W 0402	*	*	*	*	*	*	*
		16338	RES, CHIP 0.005 1% 1W 2512	*	*	*	*	*	*	*
		16340	RES, CHIP 0.03 1% 1/4W 1206	*	*	*	*	*	*	*
		16341	RES, CHIP 2.80K 1% 1/16W 0402	*	*	*	*	*	*	*
		16342	RES, CHIP 200K 1% 1/16W 0402	*	*	*	*	*	*	*
		16343	RES, CHIP 27.4K 1% 1/16W 0402	*	*	*	*	*	*	*
		16344	RES, CHIP 340K 1% 1/16W 0402	*	*	*	*	*	*	*
		16345	RES, CHIP 7.15K 1% 1/16W 0402	*	*	*	*	*	*	*
		16346	IND, CHIP 4.7UH 20% .21A 2016	*	*	*	*	*	*	*
		16346-R	IND, CHIP 4.7UH 20% .21A 2016	*	*	*	*	*	*	*
		16350	CAP: 470PF 10% 50V X7R 0402	*	*	*	*	*	*	*
		16350-R	CAP: 470PF 10% 50V X7R 0402	*	*	*	*	*	*	*
		16351	IC, XC9572XL-10 CPLD 3.3V VQFP	*	*	*	*	*	*	*

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		16352	CAP, CHIP 4.7UF10% 6.3VX5R0805	*	*	*	*	*	*	*
		16353	IC, LTC3728 DUAL SD SW RG SSOP	*	*	*	*	*	*	*
		16362	CONN, 140P .6MM M STK6/10/14MM	*	*	*	*	*	*	*
		16363	CONN, 140P.6MM F ST4/5/6/7/8MM	*	*	*	*	*	*	*
		16384	RES, CHIP 150K 5% 1/16W 0402	*	*	*	*	*	*	*
		16385	RES, CHIP 2.2K 5% 1/16W 0402	*	*	*	*	*	*	*
		16400	RIVET, SNAP NYL6 D.126 T.118	*	*	*	*	*	*	*
		16405	CAP, CHIP 330PF 50V X7R 0402	*	*	*	*	*	*	*
		16406	CAP, CHIP 47PF 50V NPO 0402	*	*	*	*	*	*	*
		16407	RES, CHIP 240 5% 1/16W 0402	*	*	*	*	*	*	*
		16408	RES, CHIP 15K 5% 1/16W 0402	*	*	*	*	*	*	*
		16409	RES, CHIP 20.0K 1% 1/16W 0402	*	*	*	*	*	*	*
		16410	RES, CHIP 220 5% 1/16W 0402	*	*	*	*	*	*	*
		16411	CAP: 33PF 5% 50V NPO 0402	*	*	*	*	*	*	*
		16420	IC, 74ALVC1G04 INVERTER SC70	*	*	*	*	*	*	*
		16421	IC, 74ALVC1G08 AND GATE SC70	*	*	*	*	*	*	*
		16422	CAP, CHIP 10PF 50V NPO 0402	*	*	*	*	*	*	*
		16424	IC, DS1631 TEMP SENSOR USOP8	*	*	*	*	*	*	*
		16425	RES, CHIP 1.27K 1% 1/16W 0402	*	*	*	*	*	*	*
		16426	RES, CHIP 1.18K 1% 1/16W 0402	*	*	*	*	*	*	*
		16429	CONN, 9P .050 M DB9 RA PTH	*	*	*	*	*	*	*
		16431	IC, M50LPW002 FLASH 3V PLCC32	*	*	*	*	*	*	*
		16432	IC, 74LVC1G04 INVERTER SC70	*	*	*	*	*	*	*
		16434	CONN, 9P PLUG DSUB RA PTH	*	*	*	*	*	*	*
		16445	RES, CHIP 47 5% 1/16W 0402	*	*	*	*	*	*	*
		16446	IC, 74CBTLV3257 2-1 MUX QSOP16	*	*	*	*	*	*	*
		16447	TRANS, SI4864DY N-MOSFET SO8	*	*	*	*	*	*	*
		16457	IC, ISP PROM 4M 3.3V 44VQFP	*	*	*	*	*	*	*
		16458	IC, 1806 LDO VR 0.8V 0.5A UMAX	*	*	*	*	*	*	*
		16462	IC, LD1117 LDO VR 3.3V 1A SOT	*	*	*	*	*	*	*
		16463	IC, LD1117 LDO VR 1.8V .8A SOT	*	*	*	*	*	*	*
		16464	IC, 128KX8 FLASH 90NS 3V TSOP	*	*	*	*	*	*	*
		16472	HDR, 2X7X2MM 7.6MM H SHRD SMT	*	*	*	*	*	*	*
		16494	RETAINER, PLASTIC PCI 2.1	*	*	*	*	*	*	*
		16498	OSC, 150MHZ UL JT PECL 3V 7050	*	*	*	*	*	*	*
		16507	IND, 2.2UH 20% 8A LP SMT	*	*	*	*	*	*	*
		16509	HDR, 2X8X2MM SHRD RA KEY PTH	*	*	*	*	*	*	*
		16517	TRANS, SI4562 N & P MOSFET SO8	*	*	*	*	*	*	*
		16518	DIMM, 32MX72DDR200 LP 1.25H	*	*	*	*	*	*	*
		16536	RES, CHIP 5.62K 1% 1/16W 0603	*	*	*	*	*	*	*
		16537	RES, CHIP 8.66K 1% 1/16W 0603	*	*	*	*	*	*	*
		16542	CAP, CHIP 1UF 10V X5R 0603	*	*	*	*	*	*	*
		16542-R	CAP, CHIP 1UF 10V X5R 0603	*	*	*	*	*	*	*
		16555	BRACKET, BLANK LP FULL HT TABS	*	*	*	*	*	*	*
		16559	RES, CHIP 7.5 5% 1/16W 0402	*	*	*	*	*	*	*
		16571	IC, 74LV27 TRIPLE 3-IN NOR SO	*	*	*	*	*	*	*
		16573	HEAT SINK, 21 X 21 W/THERMAL	*	*	*	*	*	*	*
		16582	IC, SN5682 LVD ONLY TERM TSSOP	*	*	*	*	*	*	*
		16625	IC, 74CBTLV3245A 8-BIT SW QSOP	*	*	*	*	*	*	*
		16629	IC, LTC2902 4X SUPPLY MNTR SSOP	*	*	*	*	*	*	*
		16630	CONN, 20P .635MM PLUG STKG SMT	*	*	*	*	*	*	*
		16631	CONN, 20P .635MM RCPT STKG SMT	*	*	*	*	*	*	*

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		16635	IC, LP 2995 DDR TERM REG SO-8	*	*	*	*	*	*	*
		16639-R	FERRITE, CHIP Z120 3A 1206	*	*	*	*	*	*	*
		16645	CONN, 1X7X.1" F RA/W HOOKS PTH	*	*	*	*	*	*	*
		16646	CAP, CHIP 1.5PF 50V COG 0402	*	*	*	*	*	*	*
		16647	IC, EPM3032A CPLD 10NS 44 TQFP	*	*	*	*	*	*	*
		16648	FERRITE, CHIP Z7 2.2A 0805	*	*	*	*	*	*	*
		16649	IND, CHIP 10NH 5% 400MA 0603	*	*	*	*	*	*	*
		16653	RES NTWK, CHIP 4X22 5% 2010	*	*	*	*	*	*	*
		16654	RES NTWK, CHIP 4X7.5 5% 2010	*	*	*	*	*	*	*
		16656	IC,EPM3064A CPLD 10NS 100TQFP	*	*	*	*	*	*	*
		16657	CONN, 6-PIN F RJ11 RA SMT	*	*	*	*	*	*	*
		16660	RES NTWK, CHIP 4X47 5% 2010	*	*	*	*	*	*	*
		16661	RES NTWK, CHIP 4X51 5% 2010	*	*	*	*	*	*	*
		16664	CONN,2X5X2MM M SHRD VERT PTH	*	*	*	*	*	*	*
		16671	IC, 16248 24/48 MUX SW 3V QSOP	*	*	*	*	*	*	*
		16673	FERRITE, CHIP Z60 0.5A 0603	*	*	*	*	*	*	*
		16675	IC, 29W640 FLSH 3V 70/90 TFBGA	*	*	*	*	*	*	*
		16676	IC, 32KX8 3.3V NVSRAM 35 SO32	*	*	*	*	*	*	*
		16677	IC, 95128 128K SPI SEEPROM SO	*	*	*	*	*	*	*
		16678	IC, 24256 256K I2C SEEPROM SO	*	*	*	*	*	*	*
		16680	CONN, 2X8X.1 F .331H PTH	*	*	*	*	*	*	*
		16681	IC, 64KX16 SRAM 8NS 3.3 FBGA48	*	*	*	*	*	*	*
		16683	RELAY, SPDT/1 FORM C 5V-5A DIP	*	*	*	*	*	*	*
		16684	IC, ICS553 1:4 CLK BFR 2.5 SO	*	*	*	*	*	*	*
		16685	IC, 554-01 1:4CLKBFR PECLTSSOP	*	*	*	*	*	*	*
		16686	RIVET, SNAP NYL6 D.126 T.157	*	*	*	*	*	*	*
		16686-R	RIVET, SNAP NYL6 D.126 T.157	*	*	*	*	*	*	*
		16691	CONN, 2X7X.1 M RA .230L PTH	*	*	*	*	*	*	*
		16694	RES, CHIP 57.6 1% 1/16W 0603	*	*	*	*	*	*	*
		16695	IC, SIL3512 PCI>SATA CTRLR TQFP	*	*	*	*	*	*	*
		16699	CONN, MINI-DIN 4P RA W/NOTCH	*	*	*	*	*	*	*
		16700	IC, 1963A LDO VR 1.8V 1.5A SOT	*	*	*	*	*	*	*
		16701	IC, 1963A LDO VR 2.5V 1.5A SOT	*	*	*	*	*	*	*
		16709	BRACKET, BLANK 1.750-3.760 TAB	*	*	*	*	*	*	*
		16710	CONN, 1X8X1.25MM M VERT SMT	*	*	*	*	*	*	*
		16713	CAP, CHIP 0.1UF 10V X5R 0402	*	*	*	*	*	*	*
		16714	RES, CHIP 330 5% 1/16W 0402	*	*	*	*	*	*	*
		16721	RES, CHIP 137 1% 1/16W 0603	*	*	*	*	*	*	*
		16723	RES NTWK, CHIP 8X2.7K 5% 3816	*	*	*	*	*	*	*
		16728	IC, 21154AE PCI BRDG 33MZ PBGA	*	*	*	*	*	*	*
		16730	IC, 80332 I/O PRCR 500M FCBGA	*	*	*	*	*	*	*
		16731	IC, 8MX16X4 DDR SDRAM LP TSOP	*	*	*	*	*	*	*
		16733	IC, CIS8201 GBE PHY XCVR LPGA	*	*	*	*	*	*	*
		16740	IC, LTC4064 4V BAT CHRGR MSOP	*	*	*	*	*	*	*
		16741	BAG, 12"x16" STATIC SHIELD	*	*	*	*	*	*	*
		16742	BAG, 6"x13" STATIC SHIELD	*	*	*	*	*	*	*
		16743	BAG, 16"x24" STATIC SHIELD	*	*	*	*	*	*	*
		1675209	JUMPER, 2-PIN, 0.1" PITCH	*	*	*	*	*	*	*
		16753	CONN, 184P F RA PCIX64 3.3 PTH	*	*	*	*	*	*	*
		16754-R	RES, CHIP 510K 5% 1/16W 0603	*	*	*	*	*	*	*
		16756	STANDOFF, STL .18HEX 4-40 .31L	*	*	*	*	*	*	*
		16767	CONN, 50P M RA CMPCT FLSH SM	*	*	*	*	*	*	*

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		16770	CONN, 7P SATA RA LTCH SHRD SM	*	*	*	*	*	*	*
		16778	RES, CHIP 845 1% 1/16W 0603	*	*	*	*	*	*	*
		16779	RES, CHIP 383 1% 1/16W 0603	*	*	*	*	*	*	*
		16780	OSC, 20MHZ 50PPM ULJ 3.3V 7550	*	*	*	*	*	*	*
		16782	IC, 29LV002B FLSH 3 55-90 TSOP	*	*	*	*	*	*	*
		16783	IC, 80314GS IOP W/SRAM HSBGA	*	*	*	*	*	*	*
		16788	FERRITE, CHIP Z50 0.6A 120604	*	*	*	*	*	*	*
		16790	HEADER, 39P DIP SHD LO-PRO LT	*	*	*	*	*	*	*
		16791	IC, 88SX5041 PCIX>4P SATA BGA	*	*	*	*	*	*	*
		16811	CAP, CHIP 10UF 6.3V X5R 0805	*	*	*	*	*	*	*
		16816	IC, 4MX16X4 DDR266B LP TSOP	*	*	*	*	*	*	*
		16817	(OBS) RES,CHIP,22,1%,0402	*	*	*	*	*	*	*
		16820	IC, CD40106BC HEX SCHMITT SO	*	*	*	*	*	*	*
		16821	RES, CHIP 24.9 1% 1/4W 1210	*	*	*	*	*	*	*
		16822	CONN, 2X8X.1 M VERT SHRD PTH	*	*	*	*	*	*	*
		16826	CAP, CHIP 22UF 16V X5R 1812	*	*	*	*	*	*	*
		16828	IND, CHIP 4.7UH 80MA SHLD 2012	*	*	*	*	*	*	*
		16829	IC, LT1940 2SWREG SD1.4A TSSOP	*	*	*	*	*	*	*
		16830	IC, LTC1778 SW REG SD 10A SSOP	*	*	*	*	*	*	*
		16836	CAP, 470UF 25V AL H12.5 RAD	*	*	*	*	*	*	*
		16837	CAP, CHIP 6800PF 50V X7R 0603	*	*	*	*	*	*	*
		16839	RES, CHIP 0.499 1% 1/16W 0402	*	*	*	*	*	*	*
		16840	CAP, CHIP 10UF 25V X5R 1210	*	*	*	*	*	*	*
		16846	CONN, 7PX2 SATA M RA 12.3H SM	*	*	*	*	*	*	*
		16850	ADPTR, PWR 12V/2.1A WALL MT US	*	*	*	*	*	*	*
		16851	IC, DS2411 SILICON S/N SOT23-3	*	*	*	*	*	*	*
		16852	IC, 74LVC273 OCTAL D FF SSOP	*	*	*	*	*	*	*
		16853	IC, 74LVC373A 8X D LATCH SSOP	*	*	*	*	*	*	*
		16854	IC, 74LVC11 3X 3-IN AND SSOP	*	*	*	*	*	*	*
		16855	CONN, 2X20X.1 F VERT .335H PTH	*	*	*	*	*	*	*
		16856	IC, 29LV001B FLSH 3 55-90 TSOP	*	*	*	*	*	*	*
		16860	CONN, 64P F PCIE X4 VERT PTH	*	*	*	*	*	*	*
		16863	HEATSINK, 28SQ X 9MM BLK W/T4	*	*	*	*	*	*	*
		1686907-00	PCB, AHA-2940U2W	*	*	*	*	*	*	*
		16876	IC, AD8402 1K DIGTL POT 2CH SO	*	*	*	*	*	*	*
		16877	IC, AD8402 50K DIGTL POT2CH SO	*	*	*	*	*	*	*
		16878	IC, XC95288XL CPLD 6NS PBGA	*	*	*	*	*	*	*
		16880	HEATSINK, W/FAN 12V 40MM SQ1	*	*	*	*	*	*	*
		16881	RES, CHIP 115 1% 1/16W 0603	*	*	*	*	*	*	*
		16882	RES, CHIP 12.4K 1% 1/16W 0603	*	*	*	*	*	*	*
		16883	IC, MAX919 1.8V CMPARATR SOT	*	*	*	*	*	*	*
		16884	CONN, 3X1X.1 M RA LTCH SHRD TH	*	*	*	*	*	*	*
		16885	IC, PCA9564 PARLEL>I2C CTRLR SO	*	*	*	*	*	*	*
		16888	OSC, 10MHZ 3.3V LVC ULJ 7550	*	*	*	*	*	*	*
		16890	RES, CHIP 549 1% 1/16W 0603	*	*	*	*	*	*	*
		16892	IC, MAX8869 VR LDO 1V 1A TSSOP	*	*	*	*	*	*	*
		16893	IC, MAX8505 VR SD ADJ 3A QSOP	*	*	*	*	*	*	*
		16894	RES, CHIP 51K 5% 1/16W 0603	*	*	*	*	*	*	*
		16907	RIVET, SNAP NYL6 D.126 T.079	*	*	*	*	*	*	*
		16915	CONN, 2X70X.025 F VERT 12MM SM	*	*	*	*	*	*	*
		16916	CONN, 2X70X.025 M VERT 12MM SM	*	*	*	*	*	*	*
		16917	IC, 82545EM GBE CNTLR 1C TFBGA	*	*	*	*	*	*	*

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		16925	IC, GAL16V8D PLD 15NS DIP-20	*	*	*	*	*	*	*
		16929	OSC, XTAL 33MHZ 3.3V 30PF 7550	*	*	*	*	*	*	*
		16930	STANDOFF, STL TIN BROACH M3X12	*	*	*	*	*	*	*
		16931	RES, CHIP 5.11 1% 1/4W 1206	*	*	*	*	*	*	*
		16939	HEATSINK, 40MM SQ W/PUSH PIN	*	*	*	*	*	*	*
		16940	CONN, 10-PIN 2X5 3MM SMT	*	*	*	*	*	*	*
		16953	IC, 4MX16X4 DDR333 6TL LP TSOP	*	*	*	*	*	*	*
		16958	SOCKET, 8-PIN DIP .095HT	*	*	*	*	*	*	*
		16959	IC, 25HP512 SPI SEEPROM DIP	*	*	*	*	*	*	*
		16975	IC, XC9536XL-5 CPLD PLCC44	*	*	*	*	*	*	*
		16977	IC, SIL3512E PCI>SATA CTRLR TQF	*	*	*	*	*	*	*
		16982	RES, CHIP 6.04K 1% 1/16W 0603	*	*	*	*	*	*	*
		16985	IC, MAX3221E RS232 XCVR SSOP	*	*	*	*	*	*	*
		16989	OSC, 25MHZ 50PPM 3.3V 3S 7050	*	*	*	*	*	*	*
		17001	IC, 74AUC1G66 SW ANLG SC70	*	*	*	*	*	*	*
		17007	IC, MAX6423-22 UP RESET SC70-4	*	*	*	*	*	*	*
		17093	RES, CHIP 51 5% 1/16W 0402	*	*	*	*	*	*	*
		1809607-00	PCB, ASC-29160	*	*	*	*	*	*	*
		1817207-00	PCB, ASC-39160	*	*	*	*	*	*	*
		1824707-00	PCB, ASC-19160	*	*	*	*	*	*	*
		1841407-00	PCB, ASC-29160LP	*	*	*	*	*	*	*
		1870100	CD ASSY, ADAPTEC FMS v4.0	*	*	*	*	*	*	*
		1871607-00	PCB, ATA-2400A	*	*	*	*	*	*	*
		1879407-00	PCB, ASR-3410S	*	*	*	*	*	*	*
		1904206-00	BC2400/3A0L/162/0052112/STD1/1	*	*	*	*	*	*	*
		1906300	SCD, AAR-1200A RAID CONTROLLER	*	*	*	*	*	*	*
		1908807-00	PCB, ASR-2005S	*	*	*	*	*	*	*
		1908900JA	CD ASSY, AAR-1200A/JA v1.0&GD	*	*	*	*	*	*	*
		1918409-00	BC3010/380E/162/0079112/STD2/1	*	*	*	*	*	*	*
		1920007-00	PCB, ASR-2000S	*	*	*	*	*	*	*
		1925607-00	PCB, ASC-19160/29160N	*	*	*	*	*	*	*
		1929907-00	PCB, ASC-29320LP	*	*	*	*	*	*	*
		1947607-00	PCB, ASR-2200S	*	*	*	*	*	*	*
		1947807-00	PCB, ABM-300	*	*	*	*	*	*	*
		1950107-00	PCB, ASR-2110S RESPIN	*	*	*	*	*	*	*
		1958007-00	PCB, ASC-39320/29320	*	*	*	*	*	*	*
		1958407-00	PCB, ASC-39320D	*	*	*	*	*	*	*
		1966907-00	PCB, ASR-2020S	*	*	*	*	*	*	*
		1967007-00	PCB, ASR-2025ZCR	*	*	*	*	*	*	*
		19L1858	2.2UF,10%;10V;1206;X7R	*	*	*	*	*	*	*
		2004807-00	PCB, ASC-39320D NF	*	*	*	*	*	*	*
		2011716-00	BC2010/NE04/163/0080101/NE12/1	*	*	*	*	*	*	*
		2013500	CD ASSY, ASR-201xS GUIDE	*	*	*	*	*	*	*
		2041307-00	PCB, UART JTAG CARD	*	*	*	*	*	*	*
		2041407-00	PCB, ASC-29320A	*	*	*	*	*	*	*
		2041507-00	PCB, ASC-29320ALP	*	*	*	*	*	*	*
		2042507-00	PCB, AAR-1210SA RESPIN	*	*	*	*	*	*	*
		2048500	CD ASSY, ASR-3225S v6.10	*	*	*	*	*	*	*
		2050607-00	PCB, AAR-2810SA	*	*	*	*	*	*	*
		2051100	CD ASSY, ASR-3225S HDD V1.14	*	*	*	*	*	*	*
		2051700EU	CD ASSY, AAR2410SA/EU v1.0 GD	*	*	*	*	*	*	*
		2051700JA	CD ASSY, AAR-2410SA/JA v1.0 GD	*	*	*	*	*	*	*

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		2056707-00	PCB, AAR-2610SA	*	*	*	*	*	*	*
		2057907-00	PCB, ASR-2026ZCR	*	*	*	*	*	*	*
		2062000	CD ASSY, AAR-1210SA v1.1 GUIDE	*	*	*	*	*	*	*
		2062000EU	CD ASSY, AAR-1210SA/EU v1.1 GD	*	*	*	*	*	*	*
		2062000JA	CD ASSY, AAR-1210SA/JA v1.1 GD	*	*	*	*	*	*	*
		2064307-00	PCB, ASR-2020S RESPIN	*	*	*	*	*	*	*
		2065107-00	PCB, ASR-3225S RESPIN	*	*	*	*	*	*	*
		2068007-00	PCB, ASR-2240S	*	*	*	*	*	*	*
		2069907-00	PCB, AAR-2410SA W/LED CON	*	*	*	*	*	*	*
		2071407-00	PCB, ASC-39320A	*	*	*	*	*	*	*
		2071607-00	PCB, ASR-2230SLP	*	*	*	*	*	*	*
		2071907-00	PCB, SRCU32U BISBEE GREEN	*	*	*	*	*	*	*
		2071907-01	PCB, GDT8x23RZ GREEN	*	*	*	*	*	*	*
		2072407-00	PCB, GDT8500RZ GREEN CALDWELL	*	*	*	*	*	*	*
		2072407-01	PCB, GDT8500RZ BLUE	*	*	*	*	*	*	*
		2072607-00	PCB, GDT8x14RZ GREEN - CHILITO	*	*	*	*	*	*	*
		2072607-01	PCB, GDT8x14RZ BLUE	*	*	*	*	*	*	*
		2073007-01	PCB, GDT8x24RZ BLUE	*	*	*	*	*	*	*
		2073107-00	PCB, GDT8x43RZ GREEN	*	*	*	*	*	*	*
		2073307-01	PCB, GDT8x22RZ GREEN	*	*	*	*	*	*	*
		2073407-00	PCB, GDT8546RZ GREEN - TAFT	*	*	*	*	*	*	*
		2073407-01	PCB, GDT8546RZ BLUE	*	*	*	*	*	*	*
		2073607-00	PCB, ICP TERMINATOR CARD GREEN	*	*	*	*	*	*	*
		2073707-01	PCB, ICP SCSI BRACKETCARD BLUE	*	*	*	*	*	*	*
		2073807-00	PCB, ICP ELEV CONN CARD GREEN	*	*	*	*	*	*	*
		2073807-01	PCB, ICP ELEV CONN CARD BLUE	*	*	*	*	*	*	*
		2079207-00	PCB, ASR-2020ZCR	*	*	*	*	*	*	*
		2080407-01	PCB, GDT8586RZ BLUE	*	*	*	*	*	*	*
		2081607-00	PCB, AAR-1410SA	*	*	*	*	*	*	*
		2082700	CD ASSY, SRCU42L A98955-002	*	*	*	*	*	*	*
		2082800	CD ASSY, SRCZCR C16271-003	*	*	*	*	*	*	*
		2082900	CD ASSY, SRCU32U A65592-003	*	*	*	*	*	*	*
		2083000	CD ASSY, SRCS14L C22000-002	*	*	*	*	*	*	*
		2083107-00	PCB, AAR-2610SA RESPIN	*	*	*	*	*	*	*
		2083400	CD ASSY, U320 SCSI/GD v3.0.1	*	*	*	*	*	*	*
		2083400EU	CD ASSY, U320/EU SCSI/GD 3.0.1	*	*	*	*	*	*	*
		2083400JA	CD ASSY, U320/JA SCSI/GD 3.0.1	*	*	*	*	*	*	*
		2091400	CD ASSY, ICP CHANNEL v1.9.19	*	*	*	*	*	*	*
		2091500	CD ASSY, ICP CHANNEL v3.4	*	*	*	*	*	*	*
		2104907-00	PCB, EUROPA	*	*	*	*	*	*	*
		2116500	CD ASSY, SERVERAID v7.00 GUIDE	*	*	*	*	*	*	*
		2124900	CD ASSY, SCSI/SATA RAIDv1.0/GD	*	*	*	*	*	*	*
		2124900JA	CD ASSY, SCSI/SATA/JA v1.0/GD	*	*	*	*	*	*	*
		2127507-00	PCB, T-CARD	*	*	*	*	*	*	*
		2129907-00	PCB, INF/SAS ADAPTER	*	*	*	*	*	*	*
		2130007-00	PCB, SAS ZCR MULE	*	*	*	*	*	*	*
		2138307-00	PCB, ASR-4005SAS	*	*	*	*	*	*	*
		2139907-00	PCB, BLADE PASS THRU MOD	*	*	*	*	*	*	*
		214088-001	COMPAQ INSTALLATION GUIDE	*	*	*	*	*	*	*
		2141607-00	PCB, GALAXY MULE BOARD	*	*	*	*	*	*	*
		2142307-00	PCB, ASC-29320ALP RESPIN	*	*	*	*	*	*	*
		2146307-00	PCB, PHY-E TEST CARD	*	*	*	*	*	*	*

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		2160000	CD ASSY, ASR-2X30SLP v1.0/GD	*	*	*	*	*	*	*
		2164307-00	PCB, ICP90X4RO	*	*	*	*	*	*	*
		21F9599	SCREW-PLASTITE THREAD	*	*	*	*	*	*	*
		21P5035	I/O CONN 68P STRDL MT	*	*	*	*	*	*	*
		21P5806	SCREW 4-40 x 6.5 LOW HEAD	*	*	*	*	*	*	*
		21P8312	PLATE STIFFENER	*	*	*	*	*	*	*
		21P8313	BRACKET JACK SCREW 33.4 x 8	*	*	*	*	*	*	*
		21P8314	BRACKET JACK SCREW 33.4 x 8	*	*	*	*	*	*	*
		21P8315	INSULATOR STIFFENR PLATE	*	*	*	*	*	*	*
		21P8335	TAILSTOCK ZENITHR TLSTK	*	*	*	*	*	*	*
		24H4880	RES;10K,0.1%;.062W;0603	*	*	*	*	*	*	*
		24L7155	0.00002UF,5%;50VDC;0402;NPO	*	*	*	*	*	*	*
		24L7166	120PF, 5%; 50V; 0402; NPO	*	*	*	*	*	*	*
		24L7188	0.015UF, 10%; 16V; 0402; X7R	*	*	*	*	*	*	*
		25L1011	220UF, 20%; 16V; ALUM EL, SMT	*	*	*	*	*	*	*
		26P0093	2.5V PLL CLOCK DRIVER	*	*	*	*	*	*	*
		26P0254	IND,EMI ;600 OHM; 200MA; 0603	*	*	*	*	*	*	*
		26P0353	330UF,20%;10V;TANT,2816X	*	*	*	*	*	*	*
		26P0358	330UF,20%;6.3V;TANT,2816	*	*	*	*	*	*	*
		26P0416	XTAL; 27MHZ, 50PPM;SMT;4 LEADS	*	*	*	*	*	*	*
		26P0418	DRAM,32MX16,DDR266B,LP,TSOP2	*	*	*	*	*	*	*
		26P0489	RES;0.18,1%;1W;THIN FILM,2010	*	*	*	*	*	*	*
		26P0586	LVC/LVTTL 1:4 FANOUT BFR,SOIC8	*	*	*	*	*	*	*
		26P0734	10UF, 10%;10V;TANT,1206	*	*	*	*	*	*	*
		26P0740	32MBIT FLASH EEPROM,3V,BOOT	*	*	*	*	*	*	*
		26P0762	DC/DC CONV, 3A W/INT. FETS	*	*	*	*	*	*	*
		26P0770	10UF, 20%; 6.3V; 0805; X5R	*	*	*	*	*	*	*
		26P0803	330UF,20%;4V;TANT,2816X	*	*	*	*	*	*	*
		26P0815	DC-DC CONV,6A,PWM,W/FETS	*	*	*	*	*	*	*
		26P0822	DRAM,32MX16,DDR PC266B,TSOP2	*	*	*	*	*	*	*
		26P0823	SCSI TERM,U320,27LINE	*	*	*	*	*	*	*
		26P0838	LINEAR REG,1A,3.3V,LO-DROP	*	*	*	*	*	*	*
		26P0937	IND;2.7UH,20%;1600MA;SMT	*	*	*	*	*	*	*
		26P1128	DC/DC CONV, ADJ, 700KHZ	*	*	*	*	*	*	*
		26P1132	DC/DC CONV, ADJ, 300KHZ	*	*	*	*	*	*	*
		26P1275	DC-DC CONV,3.3V,3A,W/INT. FETS	*	*	*	*	*	*	*
		26P1321	0.01UF, 5%; 16V; 0402; X7R	*	*	*	*	*	*	*
		26P1396	33UF, 20%; 16V; 2220; X5R	*	*	*	*	*	*	*
		26P1722	IND;15UH,20%;1450MA;SMT	*	*	*	*	*	*	*
		26P1786	DC-DC CONV,SYNC STEP-DOWN	*	*	*	*	*	*	*
		2731398	HEADER, 2-PIN, 0.1" PITCH	*	*	*	*	*	*	*
		29L0465	IND, EMI, 1000 OHMS;100MA;0603	*	*	*	*	*	*	*
		29L0638	RES;6.2KX8,5%;.062W;2512;10PIN	*	*	*	*	*	*	*
		29L0929	10UF,10%;6.3V;1206;X5R	*	*	*	*	*	*	*
		29L0947	0.047UF,10%;25V;0603;X7R	*	*	*	*	*	*	*
		29L1012	RES; 6.8K, 5%; .062W; 0402	*	*	*	*	*	*	*
		29L1117	RES; 33K, 5%; .062W; 0402	*	*	*	*	*	*	*
		29L1272	RES; 6.2K, 5%; .062W; 0402	*	*	*	*	*	*	*
		29L1317	THERMISTOR;NEG TCR;10K,1%;0805	*	*	*	*	*	*	*
		29L1424	IND;4.7UH,20%;2700MA	*	*	*	*	*	*	*
		29L1474	DRAM,32MX8,DDR PC266B,TSOP2	*	*	*	*	*	*	*
		29L1542	IND;4.7UH,20%;4800MA	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		29L1591	RES; 10, 5%; .063W; 0402	*	*	*	*	*	*	*
		29L1622	0.1UF, 10%; 10V; 0402; X5R	*	*	*	*	*	*	*
		29L1670	DRAM,32MX8,DDR PC266B,LPT,TSOP2	*	*	*	*	*	*	*
		29L1681	LED;GRN;DIFF,15MCD;VERT,SMT	*	*	*	*	*	*	*
		29L2058	RES; 1K, 1%; .062W; 0402	*	*	*	*	*	*	*
		29L2263	4-512x8 70NS SIMM w/BR1632 BAT	*	*	*	*	*	*	*
		29L2298	OSC;120MHZ;3.3 V;CSMT;4 LEADS	*	*	*	*	*	*	*
		29L2543	RES; 33, 1%; .062W; 0402	*	*	*	*	*	*	*
		29L2649	220UF,20%;10V;TANT,2816	*	*	*	*	*	*	*
		29L2687	RES; 3K, 5%; .062W; 0402	*	*	*	*	*	*	*
		29L3015	OSC;66.67MHZ;3.3 V;CSMT;4LEADS	*	*	*	*	*	*	*
		29L3089	RES;3KX4,5%;.063W,1206	*	*	*	*	*	*	*
		29L3185	0.039UF,10%,25V;0603;X7R	*	*	*	*	*	*	*
		29L3201	0.1UF,5%;16V;0603;X7R	*	*	*	*	*	*	*
		29L3403	IND;150UH,20%;.9A;.34 OHMS;SMT	*	*	*	*	*	*	*
		29L3404	SCSI TERM,15LINE,MULTI SE/LVD	*	*	*	*	*	*	*
		29L3406	SCSI TERMPower MANAGER	*	*	*	*	*	*	*
		34G2884	RES;1KX4,5%;.063W,1206;8 LEADS	*	*	*	*	*	*	*
		36-50819-01.A01	3.5"X2.5" GENERIC COMPAQ LABEL	*	*	*	*	*	*	*
		37H9743	RES;4.7,5%;.125W;0805	*	*	*	*	*	*	*
		38L7719	220UF,20%;4V;TANT,2816	*	*	*	*	*	*	*
		38L7721	100UF, 20%; 10V; TANT, 2816	*	*	*	*	*	*	*
		38L7747	100UF, 20%; 6.3V; TANT, 2312	*	*	*	*	*	*	*
		38L7748	2.2UF,10%;6.3V;0805;X5R	*	*	*	*	*	*	*
		39J0210	HEADER, 28PIN, RA, SHROUDED	*	*	*	*	*	*	*
		39J0457	RAW CARD - ZENITH R1	*	*	*	*	*	*	*
		39J0776	INSULATOR STIFFENR PLATE	*	*	*	*	*	*	*
		39J5015	SUPPORT EXTENDER	*	*	*	*	*	*	*
		39J5016	RETAINER BATTERY	*	*	*	*	*	*	*
		39J5017	STANDOFF HEX 4-40X10	*	*	*	*	*	*	*
		40G6849	RES; 26.7, 1%; .125W; 0805	*	*	*	*	*	*	*
		40G6962	RES;698,1%;.125W;0805	*	*	*	*	*	*	*
		40G6998	RES;1.96K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7044	RES; 6.65K, 1%; .125W; 0805	*	*	*	*	*	*	*
		40G7049	RES;7.5K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7092	RES;26.1K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7097	RES;30.1K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7101	RES;33.2K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7121	RES;60.4K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7139	RES;97.6K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7180	RES;392K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7212	RES;1M,1%;.125W;0805	*	*	*	*	*	*	*
		40G7238	RES;2.05K,1%;.125W;0805	*	*	*	*	*	*	*
		40G7458	RES;75.5%;.125W;0805	*	*	*	*	*	*	*
		40G7631	RES;10M,5%;.1W;0603	*	*	*	*	*	*	*
		40H8328	0.1UF,10%;16V;0603;X7R	*	*	*	*	*	*	*
		40H8414	RES;2.2,5%;.25W;1206	*	*	*	*	*	*	*
		40H8935	INDUCTOR,EMI;30OHMS;3A;0805	*	*	*	*	*	*	*
		40H9085	INDUCTOR; 3.3UH, 20%; 6.4A;SMT	*	*	*	*	*	*	*
		42G3066	RES;27,5%;.125W;0805	*	*	*	*	*	*	*
		42G3400	82PF,5%;50V;0603;NPO	*	*	*	*	*	*	*
		47H1004	RES;150,1%;.25W;1210	*	*	*	*	*	*	*

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		47P2306	MODULE TASAR 3.0	*	*	*	*	*	*	*
		490301-00	LABEL, PCA REVISION "A"	*	*	*	*	*	*	*
		490304-00	LABEL, PCA REVISION "D"	*	*	*	*	*	*	*
		490307-00	LABEL, PCA REVISION "G"	*	*	*	*	*	*	*
		490327-00	LABEL, PCA VERSION "-01"	*	*	*	*	*	*	*
		490328-00	LABEL, PCA VERSION "-02"	*	*	*	*	*	*	*
		490329-00	LABEL, PCA VERSION "-03"	*	*	*	*	*	*	*
		490330-00	LABEL, PCA VERSION "-04"	*	*	*	*	*	*	*
		490331-00	LABEL, PCA VERSION "-05"	*	*	*	*	*	*	*
		490332-00	LABEL, PCA VERSION "-06"	*	*	*	*	*	*	*
		490333-00	LABEL, PCA VERSION "-07"	*	*	*	*	*	*	*
		490334-00	LABEL, PCA VERSION "-08"	*	*	*	*	*	*	*
		490335-00	LABEL, PCA VERSION "-09"	*	*	*	*	*	*	*
		490336-00	LABEL, PCA VERSION "-10"	*	*	*	*	*	*	*
		490343-00	SCD, DISKETTE FOLDER LABEL	*	*	*	*	*	*	*
		490412-02	BOX, DISTI 9" W/ADPT LOGO	*	*	*	*	*	*	*
		490413-01	FOAM, ANTI-STATIC 10"X6"X1.5"	*	*	*	*	*	*	*
		490416-01	BOX, MASTER PACK 25X12 W/LOGO	*	*	*	*	*	*	*
		490956-00	BOX, RSC 28 X 17 X 9.5 W/LOGO	*	*	*	*	*	*	*
		490968-00	BOX, ASW 50 PC BULK	*	*	*	*	*	*	*
		490969-00	PAD, ASW 50 PC BULK	*	*	*	*	*	*	*
		490991-00	LABEL, .4 X 1.7 WHITE POLY	*	*	*	*	*	*	*
		490991-01	LABEL, .75 X 2.75 WHT POLY	*	*	*	*	*	*	*
		490991-02	LABEL, 3.50 X 5.00 WHT PAPER	*	*	*	*	*	*	*
		490991-03	LBL, 2.56" X 1.10" MR CTD PAPER	*	*	*	*	*	*	*
		490991-05	LABEL, 2.25 X 4.0 WHT PAPER	*	*	*	*	*	*	*
		490991-10	LABEL, 4.0X6.5WHT MIRROR COATD	*	*	*	*	*	*	*
		490991-11	LABEL, 0.4" X 2.18" WHT POLY	*	*	*	*	*	*	*
		490991-13	LABEL, 2.5"X5" WHT LITHO PAPER	*	*	*	*	*	*	*
		490991-14	LABEL, 4X6 WHITE PAPER	*	*	*	*	*	*	*
		490991-15	LABEL, .25X2.0 WHITE POLY	*	*	*	*	*	*	*
		490991-16	LABEL, 4"X1.25"	*	*	*	*	*	*	*
		490991-17	LABEL, 1"X1.5" WHITE POLY	*	*	*	*	*	*	*
		490991-20	LABEL, .6"X1.4" WHITE POLY	*	*	*	*	*	*	*
		490991-23	LABEL, 0.25" X 1.55" WHT POLY	*	*	*	*	*	*	*
		490991-27	LABEL, .25X2.0 WHT POLY TAMPER	*	*	*	*	*	*	*
		490991-29	LABEL, 1.18" X .40" WHT POLY	*	*	*	*	*	*	*
		490991-30	LABEL, .50" X 2.00" WHT POLY	*	*	*	*	*	*	*
		490991-32	LABEL, .187" X .750" WHT POLY	*	*	*	*	*	*	*
		490991-34	LABEL, 2.625" X 1.000" LITHO	*	*	*	*	*	*	*
		490991-35	LABEL, .098" X .787 WHT POLY	*	*	*	*	*	*	*
		490991-41	LBL, 0.7" X 0.4" WHT POLY	*	*	*	*	*	*	*
		490991-43	LABEL, 1.5" CLEAR POLY SEALER	*	*	*	*	*	*	*
		490991-48	LABEL, 4" X 1.25" WHT POLY	*	*	*	*	*	*	*
		491007-00	LABEL, PCA VERSION "-13"	*	*	*	*	*	*	*
		491009-00	LABEL, PCA VERSION "-15"	*	*	*	*	*	*	*
		491040-00	BOX, 5/10 PC KIT MASTER	*	*	*	*	*	*	*
		491348-00	BOX, RSC 30 X 12 X 8	*	*	*	*	*	*	*
		491357-00	BOX, 10/20 PC KIT MASTER	*	*	*	*	*	*	*
		491733-00	BOX, RSC 27 X 13 X 10 W/LOGO	*	*	*	*	*	*	*
		492130-00	BOX, JEDEC MASTER CARTON	*	*	*	*	*	*	*
		492131-00	BOX, JEDEC INNER CARTON	*	*	*	*	*	*	*

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		492462-01	BOX, 10"X8"X2" W/LOGO (KRAFT)	*	*	*	*	*	*	*
		492463-00	BOX, 22" X 12" X 16" MASTER	*	*	*	*	*	*	*
		492475-01	BOX, 10"X8"X3" w/ LOGO (KRAFT)	*	*	*	*	*	*	*
		492514-00	TRAY, AHA-2940 CONDUCTIVE	*	*	*	*	*	*	*
		492613-00	BOX, FRU MASTER	*	*	*	*	*	*	*
		492615-00	BOX, HOST ADAPTER FRU SGL	*	*	*	*	*	*	*
		492621-00	FOAM, CONVOL 13 1/2 X 5 3/4	*	*	*	*	*	*	*
		492713-00	CABLE, 50P SCSI W/TERMINATOR	*	*	*	*	*	*	*
		492894-00	TRAY, AHA-294XW/394XW CONDUCT	*	*	*	*	*	*	*
		493314-00	SCD, 4-40X.166 SCREW W/#3 HEAD	*	*	*	*	*	*	*
		493721-00	ADAPTER 68 PIN TO 50 PIN	*	*	*	*	*	*	*
		493805-00	CARD, AHA-2944W REG/WAR	*	*	*	*	*	*	*
		493841-00	LBL, COMMON EUROPEAN (CE)	*	*	*	*	*	*	*
		494045-00SP	SCD, SP S/W POLYBAG w/NOTICE	*	*	*	*	*	*	*
		494464-00	SCD, STOFF,M/F,HEX,.150L,#2/#4	*	*	*	*	*	*	*
		494555-00	INSERT, 10"x8"x3" BOX	*	*	*	*	*	*	*
		494776-00	SCD, PCBA S/N LABEL	*	*	*	*	*	*	*
		495425-00	BOX, 10" X 7" X 3" KIT KRAFT	*	*	*	*	*	*	*
		495485-00	BOX, 10-PACK MASTER SERIES	*	*	*	*	*	*	*
		495544-00	BOX, 10 PC BULK	*	*	*	*	*	*	*
		495545-00	INSERT, 10 PC BULK	*	*	*	*	*	*	*
		495546-00	BAG, 10 X 22 PREPRINTED	*	*	*	*	*	*	*
		495581-00	FOAM, 27 X 12-5/8 X 1/2 TOP	*	*	*	*	*	*	*
		495581-01	FOAM, 27 X 12-5/8 X 1 BOTTOM	*	*	*	*	*	*	*
		495615-00	TRAY, 2940AU COND (SNGL/10PK)	*	*	*	*	*	*	*
		495766-00	FOAM, 13 3/4" X 6 3/4"	*	*	*	*	*	*	*
		495768-00	BOX, 14" X 7.5" X 3.5" RELF	*	*	*	*	*	*	*
		496017-00	BOX, RSC 16" X 11" X 16"	*	*	*	*	*	*	*
		496025-00	TRAY, AHA-2940UW KIT	*	*	*	*	*	*	*
		496188-00	LABEL, AHA-2944UW FCC	*	*	*	*	*	*	*
		496250-00	LABEL, PCA VERSION "-20"	*	*	*	*	*	*	*
		496251-00	LABEL, PCA VERSION "-21"	*	*	*	*	*	*	*
		496819-00	LABEL, PCA VERSION "-24"	*	*	*	*	*	*	*
		496820-00	LABEL, PCA VERSION "-22"	*	*	*	*	*	*	*
		497121-00	LABEL, 4" X 2 15/16"	*	*	*	*	*	*	*
		497206-00	LABEL, PCA VERSION "-25"	*	*	*	*	*	*	*
		497293-00	LABEL, PCA VERSION "-28"	*	*	*	*	*	*	*
		497400-00	LABEL, PCA VERSION "-30"	*	*	*	*	*	*	*
		497401-00	LABEL, PCA VERSION "-31"	*	*	*	*	*	*	*
		497402-00	LABEL, PCA VERSION "-32"	*	*	*	*	*	*	*
		497856-00	FOAM, 5 PIECE BULK	*	*	*	*	*	*	*
		497958-00	LBL, PCBA MAC ADD SERIAL NO.	*	*	*	*	*	*	*
		497980-00	LABEL, PCA VERSION "-37"	*	*	*	*	*	*	*
		497981-00	LABEL, PCA VERSION "-38"	*	*	*	*	*	*	*
		497983-00	LABEL, PCA VERSION "-40"	*	*	*	*	*	*	*
		497985-00	LABEL, PCA VERSION "-42"	*	*	*	*	*	*	*
		497987-00	LABEL, PCA VERSION "-44"	*	*	*	*	*	*	*
		497991-00	LABEL, PCA VERSION "-48"	*	*	*	*	*	*	*
		497993-00	LABEL, PCA VERSION "-50"	*	*	*	*	*	*	*
		497996-00	LBL, AHA-2940U2W LVD CONNECTOR	*	*	*	*	*	*	*
		498151-01	DISK, 7800FMS v3.0 WINNT/WIN95	*	*	*	*	*	*	*
		498151-02	DISK, 7800 FMS v3.0 NTWR/OS2	*	*	*	*	*	*	*

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		498151-03	DISK, 7800 FMS V3.0 SCO/UNIX	*	*	*	*	*	*	*
		498243-00	BOX, 10"X7"X3" KIT KRAFT HP	*	*	*	*	*	*	*
		498244-00	BOX, 10-PACK MASTER SERIES HP	*	*	*	*	*	*	*
		498413-00	CABLE, 50P INT/EXT 4 CONN LC	*	*	*	*	*	*	*
		499404-00	RETAINER, ALUMINUM	*	*	*	*	*	*	*
		499468-00	BOX,15 3/4 X 9 1/2 X 2 5/8RELF	*	*	*	*	*	*	*
		499695-00	LABEL, PCA VERSION "-51"	*	*	*	*	*	*	*
		499832-00	LABEL, PCA VERSION "-52"	*	*	*	*	*	*	*
		499833-00	LABEL, PCA VERSION "-53"	*	*	*	*	*	*	*
		499834-00	LABEL, PCA VERSION "-54"	*	*	*	*	*	*	*
		499835-00	LABEL, PCA VERSION "-55"	*	*	*	*	*	*	*
		499836-00	LABEL, PCA VERSION "-56"	*	*	*	*	*	*	*
		499863-00	CABLE, 68P ULTRA SCSI W/5 CONN	*	*	*	*	*	*	*
		49G3482	0.01UF,5%;50V;0603;X7R	*	*	*	*	*	*	*
		510888-00	GUIDE, AHA-2940U/UW USER (BOM)	*	*	*	*	*	*	*
		510889-00JA	INSTALL GUIDE, 2940U/UW JAPAN	*	*	*	*	*	*	*
		510894-00JA	CARD, S/W LICENSE AGREEMNT JPN	*	*	*	*	*	*	*
		510896-00	USER'S GUIDE, 7800 MGRSET v1.2	*	*	*	*	*	*	*
		511114-00	GUIDE, AHA-2940AU INST/USER	*	*	*	*	*	*	*
		511171-00	SLEEVE, AHA-2940 ULTRA KIT	*	*	*	*	*	*	*
		511171-00FR	SLEEVE, AHA-2940 ULTRA/FR KIT	*	*	*	*	*	*	*
		511171-00GE	SLEEVE, AHA-2940 ULTRA/GE KIT	*	*	*	*	*	*	*
		511171-00IT	SLEEVE, AHA-2940AU/IT KIT	*	*	*	*	*	*	*
		511248-00	INSTALL GUIDE, AHA-2944UW	*	*	*	*	*	*	*
		511355-00	ERRATA,2940 ULTRA NOTIFICATION	*	*	*	*	*	*	*
		511382-00FR	GUIDE, 7800/FR LITE v3.0 (BOM)	*	*	*	*	*	*	*
		511382-00GE	GUIDE, 7800/GE LITE v3.0 (BOM)	*	*	*	*	*	*	*
		511382-00IT	GUIDE, 7800/IT LITE v3.0 (BOM)	*	*	*	*	*	*	*
		511382-00JA	GUIDE, 7800FMS LITE/JA 3.0 BOM	*	*	*	*	*	*	*
		511415-00	INSTALL GUIDE, AHA-3944AUWD	*	*	*	*	*	*	*
		511659-00	GUIDE, 7800MGR LT2.1(BOM) USER	*	*	*	*	*	*	*
		511794-00	GUIDE, 2940U2W INSTALL	*	*	*	*	*	*	*
		511811-00	CARD, AHA-2940U2W REG/README	*	*	*	*	*	*	*
		511827-00JA	GUIDE, 2940U/UW-B SJ USER(BOM)	*	*	*	*	*	*	*
		511897-00	GUIDE, 7800 FMS v3.0 USER(BOM)	*	*	*	*	*	*	*
		511952-00	GUIDE, AHA-2944UW/DELL INSTALL	*	*	*	*	*	*	*
		511998-00	GUIDE, INSTAL SCSI CARD 2940U	*	*	*	*	*	*	*
		511998-00FR	GUIDE, 2940U/FR SCSI INSTALL	*	*	*	*	*	*	*
		511998-00GE	GUIDE, 2940U/GE SCSI INSTALL	*	*	*	*	*	*	*
		511998-00IT	GUIDE, 2940U/IT SCSI INSTALL	*	*	*	*	*	*	*
		511999-00	USER REF, SCASICARD 2940U (BOM)	*	*	*	*	*	*	*
		511999-00FR	GUIDE, 2940U/FR SCSI USR (BOM)	*	*	*	*	*	*	*
		511999-00GE	GUIDE, 2940U/GE SCSI USR (BOM)	*	*	*	*	*	*	*
		511999-00IT	GUIDE, 2940U/IT SCSI USR (BOM)	*	*	*	*	*	*	*
		512057-00	GUIDE, INSTAL HP A5252B	*	*	*	*	*	*	*
		512058-00	SLEEVE/BOX, GENERIC - OEM KITS	*	*	*	*	*	*	*
		512061-00	GUIDE, USER CI/O MGT SFT (BOM)	*	*	*	*	*	*	*
		512061-00JA	GUIDE, USR CI/O MGT SFT JA BOM	*	*	*	*	*	*	*
		512087-00	CARD, 2940U/2940UW README FRST	*	*	*	*	*	*	*
		512087-00FR	CARD, 2940U/2940UW FR README	*	*	*	*	*	*	*
		512087-00GE	CARD, 2940U/2940UW GE README	*	*	*	*	*	*	*
		512127-00JA	SLV/BOX, AHA-2940AU/JA RTL KIT	*	*	*	*	*	*	*

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		512278-00	GUIDE, 130U2 SRS INSTL/HW (BOM)	*	*	*	*	*	*	*
		512278-00FR	GUIDE, 130U2/FR INSTL/HW (BOM)	*	*	*	*	*	*	*
		512278-00GE	GUIDE, 130U2/GE INSTL/HW (BOM)	*	*	*	*	*	*	*
		512278-00JA	GUIDE, 130U2/JA SRS INS/HW BOM	*	*	*	*	*	*	*
		512278-00SP	GUIDE, 130U2/SP INSTL/HW (BOM)	*	*	*	*	*	*	*
		512279-00	SLV/BOX, AAA-131U2 KIT	*	*	*	*	*	*	*
		512280-00	CARD, READ ME FIRST, AAA-131U2	*	*	*	*	*	*	*
		512280-00FR	CARD, README FRST AAA-131U2/FR	*	*	*	*	*	*	*
		512280-00GE	CARD, README FRST AAA-131U2/GE	*	*	*	*	*	*	*
		512280-00SP	CARD, README FRST AAA-131U2/SP	*	*	*	*	*	*	*
		512294-00	ERRATA, NETWORK ALERT NOTICE	*	*	*	*	*	*	*
		512306-00	GUIDE, 2940U/UW EDITION 2.20	*	*	*	*	*	*	*
		512365-00JA	CARD, AAA-131U2/JA READ ME	*	*	*	*	*	*	*
		512372-00	GUIDE, AHA-3960D/MAC INSTALL	*	*	*	*	*	*	*
		512377-00	GUIDE, ULTRA160 FMS v1.10 USER	*	*	*	*	*	*	*
		512377-00JA	GUIDE, U160 FMS/JA v1.10J USER	*	*	*	*	*	*	*
		512377-05EU	GUIDE, ULT160 FMS/EU1.10CDASSY	*	*	*	*	*	*	*
		512405-03	GUIDE, ASC-29160N INSTALL HRD	*	*	*	*	*	*	*
		512407-03	GUIDE, UDMA CI/O 4.40 USR HRD	*	*	*	*	*	*	*
		512408-03	GUIDE, AAA-UDMA INSTL H/W HRD	*	*	*	*	*	*	*
		512408-03FR	GUIDE, UDMA/FR INSTL H/W HRD	*	*	*	*	*	*	*
		512408-03GE	GUIDE, UDMA/GE INSTL H/W HRD	*	*	*	*	*	*	*
		512408-03IT	GUIDE, UDMA/IT INSTL H/W HRD	*	*	*	*	*	*	*
		512408-03SP	GUIDE, UDMA/SP INSTL H/W HRD	*	*	*	*	*	*	*
		512414-00	CARD, AAA-UDMA READ ME FIRST	*	*	*	*	*	*	*
		512414-00FR	CARD, UDMA/FR READ ME FIRST	*	*	*	*	*	*	*
		512414-00GE	CARD, UDMA/GE READ ME FIRST	*	*	*	*	*	*	*
		512414-00IT	CARD, UDMA/IT READ ME FIRST	*	*	*	*	*	*	*
		512414-00SP	CARD, UDMA/SP READ ME FIRST	*	*	*	*	*	*	*
		512414-00UK	CARD, UDMA/UK READ ME FIRST	*	*	*	*	*	*	*
		512415-00EU	SLV, AAA-UDMA/EFIGS KIT SLV	*	*	*	*	*	*	*
		512440-03	GUIDE, ASC-29160 INSTALL HRD	*	*	*	*	*	*	*
		512440-03CN	GUIDE, ASC-29160/CN INSTLL HRD	*	*	*	*	*	*	*
		512440-03FR	GUIDE, ASC-29160/FR INSTL HRD	*	*	*	*	*	*	*
		512440-03GE	GUIDE, ASC-29160/GE INSTL HRD	*	*	*	*	*	*	*
		512440-03IT	GUIDE, ASC-29160/IT INSTL HRD	*	*	*	*	*	*	*
		512440-03JA	GUIDE, ASC-29160/JA INSTL HRD	*	*	*	*	*	*	*
		512440-03SP	GUIDE, ASC-29160/SP INSTL HRD	*	*	*	*	*	*	*
		512450-00	LABEL, COMPAQ LOGO, PCA, GREEN	*	*	*	*	*	*	*
		512459-03	GUIDE, ASC-29160 USER REF HRD	*	*	*	*	*	*	*
		512459-05EU	GUIDE, 29160/EU USR REF CDASSY	*	*	*	*	*	*	*
		512460-00	SLV, ASC-29160 KIT	*	*	*	*	*	*	*
		512460-00EU	SLV/BOX, ASC-29160/EU KIT	*	*	*	*	*	*	*
		512460-00JA	SLV, ASC-29160/JA KIT	*	*	*	*	*	*	*
		512461-00	SLV, ASC-39160 KIT	*	*	*	*	*	*	*
		512461-00EU	SLV, ASC-39160/EU KIT	*	*	*	*	*	*	*
		512461-00JA	SLV, ASC-39160/JA KIT	*	*	*	*	*	*	*
		512462-03	GUIDE, 29160 OEM INSTALL HRD	*	*	*	*	*	*	*
		512464-03	GUIDE, ASC-39160 INSTALL HRD	*	*	*	*	*	*	*
		512464-03FR	GUIDE, ASC-39160/FR INSTAL HRD	*	*	*	*	*	*	*
		512464-03GE	GUIDE, ASC-39160/GE INSTAL HRD	*	*	*	*	*	*	*
		512464-03IT	GUIDE, ASC-39160/IT INSTAL HRD	*	*	*	*	*	*	*

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		512464-03JA	GUIDE, 39160/JA INSTALL HRD	*	*	*	*	*	*	*
		512464-03SP	GUIDE, ASC-39160/SP INSTAL HRD	*	*	*	*	*	*	*
		512465-03	GUIDE, 39160 OEM INSTALL HRD	*	*	*	*	*	*	*
		512470-00	CARD, ASC-39160 REG/README	*	*	*	*	*	*	*
		512470-00FR	CARD, ASC-39160/FR REG/README	*	*	*	*	*	*	*
		512470-00GE	CARD, ASC-39160/GE REG/README	*	*	*	*	*	*	*
		512470-00IT	CARD, ASC-39160/IT REG/README	*	*	*	*	*	*	*
		512470-00SP	CARD, ASC-39160/SP REG/README	*	*	*	*	*	*	*
		512470-00UK	CARD, ASC-39160/UK REG/README	*	*	*	*	*	*	*
		512471-00	CARD, ASC-29160 REG/README	*	*	*	*	*	*	*
		512471-00FR	CARD, ASC-29160/FR REG/RDME	*	*	*	*	*	*	*
		512471-00GE	CARD, ASC-29160/GE REG/RDME	*	*	*	*	*	*	*
		512471-00IT	CARD, ASC-29160/IT REG/RDME	*	*	*	*	*	*	*
		512471-00SP	CARD, ASC-29160/SP REG/RDME	*	*	*	*	*	*	*
		512471-00UK	CARD, ASC-29160/UK REG/RDME	*	*	*	*	*	*	*
		512472-00	FLYER, 39160 RIGHT CONNECTIONS	*	*	*	*	*	*	*
		512472-00EU	FLYER, 39160/EU RIGHT CONNECT	*	*	*	*	*	*	*
		512472-00JA	FLYER, 39160/JA RIGHT CONNECTN	*	*	*	*	*	*	*
		512473-00	FLYER, 29160 RIGHT CONNECTIONS	*	*	*	*	*	*	*
		512473-00EU	FLYER, 29160/EU RIGHT CONNECT	*	*	*	*	*	*	*
		512473-00JA	FLYER, 29160/JA RIGHT CONNECT	*	*	*	*	*	*	*
		512478-03	GUIDE, ASC-39160 USER REF HRD	*	*	*	*	*	*	*
		512478-03JA	GUIDE, 39160/JA USER REF HRD	*	*	*	*	*	*	*
		512478-05EU	GUIDE, 39160/EU USER CD ASSY	*	*	*	*	*	*	*
		512479-00	LABEL, CANADIAN COMPLIANCE B	*	*	*	*	*	*	*
		512481-03	GUIDE,ASC29160N/CMPQ INSTL HRD	*	*	*	*	*	*	*
		512488-03	GUIDE, 19160 USER REF HRD	*	*	*	*	*	*	*
		512488-03JA	GUIDE, 19160/JA USER REF HRD	*	*	*	*	*	*	*
		512494-03	GUIDE, ASC-29160N STD USR REF	*	*	*	*	*	*	*
		512494-03JA	GUIDE, 29160N/JA STD USR REF	*	*	*	*	*	*	*
		512494-05EU	GUIDE, 29160N/EU STD USR CDASY	*	*	*	*	*	*	*
		512498-00	CARD, GENERIC LIC AGREE 10-PK	*	*	*	*	*	*	*
		512500-00	CARD, ASC-29160N REG/README	*	*	*	*	*	*	*
		512500-00FR	CARD, ASC-29160N/FR REG/README	*	*	*	*	*	*	*
		512500-00GE	CARD, ASC-29160N/GE REG/README	*	*	*	*	*	*	*
		512500-00IT	CARD, ASC-29160N/IT REG/README	*	*	*	*	*	*	*
		512500-00SP	CARD, ASC-29160N/SP REG/README	*	*	*	*	*	*	*
		512500-00UK	CARD, ASC-29160N/UK REG/README	*	*	*	*	*	*	*
		512501-00	FLYER, 29160N RIGHT CONNECTION	*	*	*	*	*	*	*
		512501-00EU	FLYER, 29160N/EU RIGHT CONNECT	*	*	*	*	*	*	*
		512501-00JA	FLYER, 29160N/JA RT CONNECTION	*	*	*	*	*	*	*
		512502-00	SLV, ASC-29160N KIT	*	*	*	*	*	*	*
		512502-00EU	SLV, ASC-29160N/EU KIT	*	*	*	*	*	*	*
		512502-00JA	SLV, ASC-29160N/JA KIT	*	*	*	*	*	*	*
		512503-00	CARD, ASC-19160 REG/README	*	*	*	*	*	*	*
		512503-00FR	CARD, ASC-19160/FR REG/README	*	*	*	*	*	*	*
		512503-00GE	CARD, ASC-19160/GE REG/README	*	*	*	*	*	*	*
		512503-00IT	CARD, ASC-19160/IT REG/README	*	*	*	*	*	*	*
		512503-00SP	CARD, ASC-19160/SP REG/README	*	*	*	*	*	*	*
		512503-00UK	CARD, ASC-19160/UK REG/README	*	*	*	*	*	*	*
		512504-00	FLYER, 19160 RIGHT CONNECTIONS	*	*	*	*	*	*	*
		512504-00EU	FLYER, 19160/EU RT CONNECTIONS	*	*	*	*	*	*	*

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		512504-00JA	FLYER, 19160/JA RIGHT CONNECT	*	*	*	*	*	*	*
		512505-00	SLV, ASC-19160 KIT	*	*	*	*	*	*	*
		512505-00EU	SLV/BOX, ASC-19160/EFIGS KIT	*	*	*	*	*	*	*
		512505-00JA	SLV, ASC-19160/JA KIT	*	*	*	*	*	*	*
		512506-03	GUIDE, 29160N STD INSTALL HRD	*	*	*	*	*	*	*
		512506-03FR	GUIDE, 29160N/FR STD INSTL HRD	*	*	*	*	*	*	*
		512506-03GE	GUIDE, 29160N/GE STD INSTL HRD	*	*	*	*	*	*	*
		512506-03IT	GUIDE, 29160N/IT STD INSTL HRD	*	*	*	*	*	*	*
		512506-03JA	GUIDE, 29160N/JA STD INSTL HRD	*	*	*	*	*	*	*
		512506-03SP	GUIDE, 29160N/SP STD INSTL HRD	*	*	*	*	*	*	*
		512507-03	GUIDE, 19160 INSTALL HRD	*	*	*	*	*	*	*
		512507-03FR	GUIDE, 19160/FR INSTALL HRD	*	*	*	*	*	*	*
		512507-03GE	GUIDE, 19160/GE INSTALL HRD	*	*	*	*	*	*	*
		512507-03IT	GUIDE, 19160/IT INSTALL HRD	*	*	*	*	*	*	*
		512507-03JA	GUIDE, 19160/JA INSTALL HRD	*	*	*	*	*	*	*
		512507-03SP	GUIDE, 19160/SP INSTALL HRD	*	*	*	*	*	*	*
		512509-00JA	CARD, ASC-39160/JA README	*	*	*	*	*	*	*
		512511-00JA	CARD, 29160/JA README	*	*	*	*	*	*	*
		512517-00JA	CARD, ASC-29160N/JA README	*	*	*	*	*	*	*
		512518-00JA	CARD, ASC-19160/JA README	*	*	*	*	*	*	*
		512528-03	GUIDE, ASC-29160LP INSTALL HRD	*	*	*	*	*	*	*
		512564-00JA	LBL, SOFTRAIID INCLUDED	*	*	*	*	*	*	*
		512568-00	CARD, CABLE INFO AAA-131U2	*	*	*	*	*	*	*
		512571-03	GUIDE, FMS v4.0 QCK START HRD	*	*	*	*	*	*	*
		512571-03JA	GUIDE, FMS/JA v4.0 QCK START	*	*	*	*	*	*	*
		512574-00	LBL, AAC-9001MD JMPR ENBL LBL	*	*	*	*	*	*	*
		512588-03	GUIDE, U160 FMS LITE v1.11 USR	*	*	*	*	*	*	*
		512590-03	GUIDE, 29160LP INSTAL HRD	*	*	*	*	*	*	*
		512591-03	GUIDE, 29160LP USER REF HRD	*	*	*	*	*	*	*
		512610-00	CARD, ASC-29160LP REG/README	*	*	*	*	*	*	*
		512611-00	SLV, ASC-29160LP KIT	*	*	*	*	*	*	*
		512627-03	GUIDE, 3642/HP BATT INSTAL HRD	*	*	*	*	*	*	*
		512634-00	CD POUCH, ADAPTEC FMS v4.0	*	*	*	*	*	*	*
		512636-03JA	GUIDE, 29160LP/JA SCSI HRD	*	*	*	*	*	*	*
		512643-03	GUIDE, 29160/29160N INSTL HRD	*	*	*	*	*	*	*
		512643-03FR	GUIDE,29160/29160N/FR INSTLHRD	*	*	*	*	*	*	*
		512643-03IT	GUIDE,29160/29160N/IT INSTLHRD	*	*	*	*	*	*	*
		512643-03SP	GUIDE,29160/29160N/SP INSTLHRD	*	*	*	*	*	*	*
		512643-03UK	GUIDE,29160/29160N/UK INSTLHRD	*	*	*	*	*	*	*
		512646-00	LBL, ASC-39160 BSMI	*	*	*	*	*	*	*
		512650-00	LBL, ASC-29160LP BSMI	*	*	*	*	*	*	*
		512651-00	LBL, ASC-29160 BSMI	*	*	*	*	*	*	*
		512655-00	LBL, AHA-2940UW BSMI	*	*	*	*	*	*	*
		512656-00	LBL, ASC-29160N BSMI	*	*	*	*	*	*	*
		512658-00	LBL, AHA-2940U BSMI	*	*	*	*	*	*	*
		512676-00	CARD, END USER S/W LIC AGREE	*	*	*	*	*	*	*
		512677-00	CARD, S/W LIC AGREE 10PK CHNNL	*	*	*	*	*	*	*
		512691-00	LBL, AHA-2944UW BSMI	*	*	*	*	*	*	*
		512692-00	LBL, ASC-19160 BSMI	*	*	*	*	*	*	*
		512697-00	CARD, RTF ADAP29160N/COMPAQ	*	*	*	*	*	*	*
		512726-00	LABEL, 1.5" X .375" CPQ LOGO	*	*	*	*	*	*	*
		512748-00JA	CARD, GEN REG/WARR/JA 3 YEARS	*	*	*	*	*	*	*

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		512758-00	LBL, AHA-3944AUWD/DELL BSMI	*	*	*	*	*	*	*
		512781-00	CARD, RAID WARRANTY DISCLOSURE	*	*	*	*	*	*	*
		512781-00JA	CARD, RAID WARTY/DISCLOSURE/JA	*	*	*	*	*	*	*
		512790-03	GUIDE, 1200A INSTALL/USER HRD	*	*	*	*	*	*	*
		512790-03JA	GUIDE, 1200A/JA INSTL/USER HRD	*	*	*	*	*	*	*
		512793-00	SLV/BOX, AAR-2400A KIT	*	*	*	*	*	*	*
		512793-00EU	SLV/BOX, AAR-2400A/EU KIT	*	*	*	*	*	*	*
		512793-00JA	SLV/BOX, AAR-2400A/JA KIT	*	*	*	*	*	*	*
		512814-05EU	GUIDE, 19160/EU USER&FMS CDASY	*	*	*	*	*	*	*
		512816-00	SLV, AAR-1200A KIT	*	*	*	*	*	*	*
		512816-00EU	SLV, AAR-1200A/EU KIT	*	*	*	*	*	*	*
		512816-00JA	SLV/BOX, AAR-1200A/JA KIT	*	*	*	*	*	*	*
		512857-00JA	CARD, AAR/ASR JA README FIRST	*	*	*	*	*	*	*
		512861-03	GUIDE, ASR/AAR INSTALL	*	*	*	*	*	*	*
		512868-00	SLV/BOX, ASR-3210S KIT	*	*	*	*	*	*	*
		512868-00EU	SLV/BOX, ASR-3210S/EU KIT	*	*	*	*	*	*	*
		512868-00JA	SLV/BOX, ASR-3210S/JA KIT	*	*	*	*	*	*	*
		512869-00	SLV/BOX, ASR-3410S KIT	*	*	*	*	*	*	*
		512869-00EU	SLV/BOX, ASR-3410S/EU KIT	*	*	*	*	*	*	*
		512869-00JA	SLV/BOX, ASR-3410S/JA KIT	*	*	*	*	*	*	*
		512875-00	CARD, ASR/AAR RMF	*	*	*	*	*	*	*
		512876-00JA	CARD, AAR-1200A/JA RMF	*	*	*	*	*	*	*
		512910-03	GUIDE, ASR/AAR INSTALL	*	*	*	*	*	*	*
		512910-03JA	GUIDE, ASR/AAR INSTALL/JA	*	*	*	*	*	*	*
		512956-03	GUIDE, ASR/AAR INSTALL V3	*	*	*	*	*	*	*
		512956-03JA	GUIDE, ASR/AAR INSTALL/JA	*	*	*	*	*	*	*
		512986-00	SLV, ASR-2000S KIT	*	*	*	*	*	*	*
		512986-00EU	SLV, ASR-2000S/EU KIT	*	*	*	*	*	*	*
		512999-00JA	LBL, XP DRVR WINDOWS/JA	*	*	*	*	*	*	*
		513000-00JA	LBL, XP DRVR WINDOWS UPDT3/JA	*	*	*	*	*	*	*
		513031-00	SLV, ASR-2110S KIT	*	*	*	*	*	*	*
		513031-00EU	SLV, ASR-2110S/EU KIT	*	*	*	*	*	*	*
		513031-00JA	SLV, ASR-2110S/JA KIT	*	*	*	*	*	*	*
		513041-00	SLV, ASR-2005S KIT	*	*	*	*	*	*	*
		513041-00EU	SLV, ASR-2005S/EU KIT	*	*	*	*	*	*	*
		513057-00JA	LBL, OFFRD SUPRT EMRL ONLY/JA	*	*	*	*	*	*	*
		513061-00	LBL, ASR-2100S BSMI	*	*	*	*	*	*	*
		513108-03	GUIDE, ASC-39320D OEM INSTALL	*	*	*	*	*	*	*
		513115-00	SLV, ASR-2100S KIT	*	*	*	*	*	*	*
		513115-00JA	SLV, ASR-2100S/JA KIT	*	*	*	*	*	*	*
		513133-00JA	LBL, 1200A/JA XP/LBA SUPPORT	*	*	*	*	*	*	*
		513135-00	LBL, ASC-29160/FSC4 PCA	*	*	*	*	*	*	*
		513145-03	GUIDE, EXTERNAL RAID WARRANTY	*	*	*	*	*	*	*
		513173-00JA	LBL, ASPI DRIVER INCLUDED/JA	*	*	*	*	*	*	*
		513215-00	SLV, ASR-2200S KIT	*	*	*	*	*	*	*
		513215-00EU	SLV, ASR-2200S/EFIGS KIT	*	*	*	*	*	*	*
		513215-00JA	SLV, ASR-2200S/JA KIT	*	*	*	*	*	*	*
		513216-00	SLV, ASR-2120S KIT	*	*	*	*	*	*	*
		513216-00EU	SLV, ASR-2120S/EFIGS KIT	*	*	*	*	*	*	*
		513216-00JA	SLV, ASR-2120S/JA KIT	*	*	*	*	*	*	*
		513221-03	GUIDE, ASC-39320D INSTALL HRD	*	*	*	*	*	*	*
		513221-03EU	GUIDE, ASC-39320D/EU INSTL HRD	*	*	*	*	*	*	*

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		513221-03JA	GUIDE, ASC-39320D/JA INSTL HRD	*	*	*	*	*	*	*
		513277-03EU	GUIDE, ASR U320 QCK INST/EU HD	*	*	*	*	*	*	*
		513280-03	GUIDE, ASC-39320 INSTALL HRD	*	*	*	*	*	*	*
		513280-03EU	GUIDE,ASC-39320-R/EU INSTL HRD	*	*	*	*	*	*	*
		513280-03JA	GUIDE,ASC-39320-R/JA INSTL HRD	*	*	*	*	*	*	*
		513281-03	GUIDE, ASC-29320 INSTALL HRD	*	*	*	*	*	*	*
		513281-03EU	GUIDE, ASC-29320/EU INSTL HRD	*	*	*	*	*	*	*
		513281-03JA	GUIDE, ASC-29320/JA INSTL HRD	*	*	*	*	*	*	*
		513294-00	SLV, ASR-2010S KIT	*	*	*	*	*	*	*
		513294-00EU	SLV, ASR-2010S/EU KIT	*	*	*	*	*	*	*
		513295-00	SLV, ASR-2015S KIT	*	*	*	*	*	*	*
		513295-00EU	SLV, ASR-2015S/EU KIT	*	*	*	*	*	*	*
		513308-03	GUIDE, LUN ZONING USER	*	*	*	*	*	*	*
		513324-03	GUIDE, ASC-39320 INSTALL OEM	*	*	*	*	*	*	*
		513325-03	GUIDE, ASC-29320 INSTALL OEM	*	*	*	*	*	*	*
		513327-03	GUIDE, ASC-29320LP INSTALL HRD	*	*	*	*	*	*	*
		513327-03EU	GUIDE, ASC-29320LP/EU INST HRD	*	*	*	*	*	*	*
		513327-03JA	GUIDE, ASC-29320LP/JA INST HRD	*	*	*	*	*	*	*
		513328-00	SLV, ASC-29320 KIT	*	*	*	*	*	*	*
		513328-00EU	SLV, ASC-29320-R/EU KIT	*	*	*	*	*	*	*
		513328-00JA	SLV, ASC-29320-R/JA KIT	*	*	*	*	*	*	*
		513329-00	SLV, ASC-39320 KIT	*	*	*	*	*	*	*
		513329-00EU	SLV, ASC-39320-R/EU KIT	*	*	*	*	*	*	*
		513329-00JA	SLV, ASC-39320-R/JA KIT	*	*	*	*	*	*	*
		513333-00	SLV, ASC-29320LP-R KIT	*	*	*	*	*	*	*
		513333-00EU	SLV, ASC-29320LP-R/EU KIT	*	*	*	*	*	*	*
		513333-00JA	SLV, ASC-29320LP-R/JA KIT	*	*	*	*	*	*	*
		513334-00	SLV, ASC-39320D KIT	*	*	*	*	*	*	*
		513334-00EU	SLV, ASC-39320D-R/EU KIT	*	*	*	*	*	*	*
		513334-00JA	SLV, ASC-39320D-R/JA KIT	*	*	*	*	*	*	*
		513336-03	GUIDE, ASR-201xS INSTALL v1	*	*	*	*	*	*	*
		513336-03JA	GUIDE, ASR-201xS INSTALL v1/JA	*	*	*	*	*	*	*
		513347-00	LABEL, ASC-39320 FAB	*	*	*	*	*	*	*
		513348-00	LABEL, ASC-29320 SE PCB LBL	*	*	*	*	*	*	*
		513349-00	LABEL, ASC-29320 FAB	*	*	*	*	*	*	*
		513378-03EU	GUIDE, ASC U320/EU QK INSTALL	*	*	*	*	*	*	*
		513385-00	LBL, ASR-2200S MIC	*	*	*	*	*	*	*
		513415-00	LBL, ASC-29320/FSC PCA	*	*	*	*	*	*	*
		513541-00	SLV, AAR-1210SA KIT	*	*	*	*	*	*	*
		513541-00EU	SLV, AAR-1210SA/EFIGS KIT	*	*	*	*	*	*	*
		513541-00JA	SLV, AAR-1210SA/JA KIT	*	*	*	*	*	*	*
		513549-00	LABEL, ASC-29160i/HPQ PCA	*	*	*	*	*	*	*
		513580-00JA	LBL, JAPAN RECYCLE "I"	*	*	*	*	*	*	*
		513585-03	GUIDE, AAR1210SA QCK INSTL HRD	*	*	*	*	*	*	*
		513585-03EU	GUIDE, AAR1210SA/EU QK INST HD	*	*	*	*	*	*	*
		513585-03JA	GUIDE, AAR1210SA/JA QK INST HD	*	*	*	*	*	*	*
		513594-03	GUIDE, ASC-39320A OEM INSTALL	*	*	*	*	*	*	*
		513600-00	FLYER, SERVERAID 6M HDD	*	*	*	*	*	*	*
		513601-03EU	GUIDE, 2410SA/EU QCK INSTL HD	*	*	*	*	*	*	*
		513601-03JA	GUIDE, AAR2410SA/JA QK INST HD	*	*	*	*	*	*	*
		513621-03	GUIDE, SERVERAID 6M INSTAL HRD	*	*	*	*	*	*	*
		513628-00	SLV, AAR-2410SA KIT	*	*	*	*	*	*	*

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		513628-00EU	SLV, AAR-2410SA/EFIGS KIT	*	*	*	*	*	*	*
		513628-00JA	SLV, AAR-2410SA/JA KIT	*	*	*	*	*	*	*
		513643-00	CARD, ABM-300 QUICK INSTALL	*	*	*	*	*	*	*
		513653-00	LBL, ASR-3225S IBM BATTERY FRU	*	*	*	*	*	*	*
		513654-00	LBL, ASR-2020S IBM BATTERY FRU	*	*	*	*	*	*	*
		513658-03	GUIDE, ASC-29320A INSTALL	*	*	*	*	*	*	*
		513658-03EU	GUIDE, ASC-29320A/EU INSTALL	*	*	*	*	*	*	*
		513658-03JA	GUIDE, ASC-29320A/JA INSTALL	*	*	*	*	*	*	*
		513659-03	GUIDE, ASC-29320ALP INSTALL	*	*	*	*	*	*	*
		513659-03EU	GUIDE, ASC-29320ALP/EU INSTALL	*	*	*	*	*	*	*
		513659-03JA	GUIDE, ASC-29320ALP/JA INSTALL	*	*	*	*	*	*	*
		513666-03	GUIDE, ASC-39320A INSTALL	*	*	*	*	*	*	*
		513666-03EU	GUIDE, ASC-39320A/EU INSTALL	*	*	*	*	*	*	*
		513666-03JA	GUIDE, ASC-39320A/JA INSTALL	*	*	*	*	*	*	*
		513667-00	FLYER, SERVERAID WINDOWS 2003	*	*	*	*	*	*	*
		513671-00	CARD, FMS v4.0a wDS ZIPLOCK BG	*	*	*	*	*	*	*
		513686-03	GUIDE, 29320A INSTALL OEM	*	*	*	*	*	*	*
		513687-03	GUIDE, 29320ALP INSTALL OEM	*	*	*	*	*	*	*
		513696-00	SLV, ASC-29320A-R KIT	*	*	*	*	*	*	*
		513696-00EU	SLV, ASC-29320A-R/EU KIT	*	*	*	*	*	*	*
		513696-00JA	SLV, ASC-29320A-R/JA KIT	*	*	*	*	*	*	*
		513697-00	SLV, ASC-29320ALP-R KIT	*	*	*	*	*	*	*
		513697-00EU	SLV, ASC-29320ALP-R/EU KIT	*	*	*	*	*	*	*
		513697-00JA	SLV, ASC-29320ALP-R/JA KIT	*	*	*	*	*	*	*
		513698-00	SLV, ASC-39320A-R KIT	*	*	*	*	*	*	*
		513698-00EU	SLV, ASC-39320A-R/EU KIT	*	*	*	*	*	*	*
		513698-00JA	SLV, ASC-39320A-R/JA KIT	*	*	*	*	*	*	*
		513760-03	GUIDE, AAR-2410SA ENCL HW INST	*	*	*	*	*	*	*
		513760-03EU	GUIDE, 2410SA/EU ENCL HW INST	*	*	*	*	*	*	*
		513760-03JA	GUIDE, 2410SA/JA ENCL HW INST	*	*	*	*	*	*	*
		513763-00	LBL, ATTENTION ICP/INTEL	*	*	*	*	*	*	*
		513764-00	LBL, CAUTION ICP/INTEL	*	*	*	*	*	*	*
		513767-03	GUIDE, SRCU42L QKSRT C10423-004	*	*	*	*	*	*	*
		513770-03	GUIDE, SRCZCR QKSRT C18224-004	*	*	*	*	*	*	*
		513772-03	GUIDE, SRCU32U QKSRT A77851-003	*	*	*	*	*	*	*
		513774-03	GUIDE, SRCS14LQKSRT C22490-002	*	*	*	*	*	*	*
		513776-00	SLV, ICP CHANNEL CONTROLLER	*	*	*	*	*	*	*
		513778-03	GUIDE, ICP QUICK INST GD	*	*	*	*	*	*	*
		513778-03GE	GUIDE, ICP QUICK INST GD GERM	*	*	*	*	*	*	*
		513780-00	SLV, INTEL PRTY BOX C10283-001	*	*	*	*	*	*	*
		513781-00	SLV, INTEL BISBEE A64937-001	*	*	*	*	*	*	*
		513782-00	LBL, UL 16mm x 6.5mm ICP/INTL	*	*	*	*	*	*	*
		513783-00	LBL, UL 24mm x 8mm ICP/INTL	*	*	*	*	*	*	*
		513784-03	GUIDE, GDT8500RZ HDW MANv1.1.6	*	*	*	*	*	*	*
		513784-03GE	GUIDE, GDT8500RZ HW v1.1.6/GE	*	*	*	*	*	*	*
		513786-03	GUIDE, GDT8514RZ HDW MANv1.2.6	*	*	*	*	*	*	*
		513786-03GE	GUIDE, GDT8514RZ HWMANv1.2.6GE	*	*	*	*	*	*	*
		513788-03	GUIDE, GDT8522RZ HDW MAN v1.0	*	*	*	*	*	*	*
		513788-03GE	GUIDE, GDT8522RZ HDWMANv1.0/GE	*	*	*	*	*	*	*
		513790-03	GUIDE, GDT8524RZ HDW MANv1.0.0	*	*	*	*	*	*	*
		513790-03GE	GUIDE, GDT8524RZ HWMANv1.0.0GE	*	*	*	*	*	*	*
		513792-03	GUIDE, GDT85x6RZ HDW MAN v1.2	*	*	*	*	*	*	*

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		513792-03GE	GUIDE, GDT85x6RZ HDWMANv1.2/GE	*	*	*	*	*	*	*
		513794-03	GUIDE, ICP CLUSTER HDW MANv1.0	*	*	*	*	*	*	*
		513796-03	GUIDE, SATA ADAPT HDW MAN v1.0	*	*	*	*	*	*	*
		513796-03GE	GUIDE, SATA ADAPT HWMANv1.0/GE	*	*	*	*	*	*	*
		513798-03	GUIDE, ICP SOFTWARE MAN v1.2.7	*	*	*	*	*	*	*
		513798-03GE	GUIDE, ICP SW MAN v1.2.4/GE	*	*	*	*	*	*	*
		513822-00	FLYER, AAR-2810SA CAUTION	*	*	*	*	*	*	*
		513824-00	SLV, ICP CHANL CONTROLER LARGE	*	*	*	*	*	*	*
		513825-03	GUIDE, ICP RS-RZ HW MAN 3rd ED	*	*	*	*	*	*	*
		513825-03GE	GUIDE, ICP RS-RZ HW 3rd ED/GE	*	*	*	*	*	*	*
		513828-03	GUIDE, ICP CLUSTER ADDEN 6th	*	*	*	*	*	*	*
		513828-03GE	GUIDE, ICP CLUSTER ADDEN 6thGE	*	*	*	*	*	*	*
		513840-00	CARD, SATA 7P RTCN 1M-R CLAM	*	*	*	*	*	*	*
		513841-03	GUIDE, ICP OLD QUICK INST GD	*	*	*	*	*	*	*
		513841-03GE	GUIDE, ICP OLD QUICK INSTGD/GE	*	*	*	*	*	*	*
		513842-00	LBL, ICP BATTERY - FRONT	*	*	*	*	*	*	*
		513844-00	LBL, ICP LOGO	*	*	*	*	*	*	*
		513845-00	LBL, ICP ART 3510 BBU KIT	*	*	*	*	*	*	*
		513846-00	LBL, ICP ART 8798 F/W UPGRADE	*	*	*	*	*	*	*
		513849-03	GUIDE, ICP ART 3510 BBU MANUAL	*	*	*	*	*	*	*
		513850-03	GUIDE, ICP RAIDYNE UPGRADE	*	*	*	*	*	*	*
		513855-03	GUIDE, SCSI/SATA RAID QK INSTL	*	*	*	*	*	*	*
		513869-00	LBL, iSA1500 GREY LABEL	*	*	*	*	*	*	*
		513871-03	GUIDE, SERVERAID 7t INSTALL HD	*	*	*	*	*	*	*
		513872-00	FLYER, BUY CABLES NOW	*	*	*	*	*	*	*
		513878-00	FLYER, IBM SERVERAID 7t CABLE	*	*	*	*	*	*	*
		513882-00	FLYER, DISK DR CARRIER INSTAL	*	*	*	*	*	*	*
		513902-00	SLV, ASR-2020ZCR KIT	*	*	*	*	*	*	*
		513948-00	SLV, ASR-2130SLP KIT	*	*	*	*	*	*	*
		513948-00EU	SLV/BOX, ASR-2130SLP/EU KIT	*	*	*	*	*	*	*
		513948-00JA	SLV/BOX, ASR-2130SLP/JA KIT	*	*	*	*	*	*	*
		513949-00	SLV, ASR-2230SLP KIT	*	*	*	*	*	*	*
		513949-00EU	SLV/BOX, ASR-2230SLP/EU KIT	*	*	*	*	*	*	*
		513949-00JA	SLV/BOX, ASR-2230SLP/JA KIT	*	*	*	*	*	*	*
		513964-00	FLYER, SERVERAID-7k INSTALL	*	*	*	*	*	*	*
		513968-00	LBL, ABM-400 PCA	*	*	*	*	*	*	*
		513970-03	GUIDE, SERVERAID 7K INSTAL HRD	*	*	*	*	*	*	*
		513975-00	FLYER, SERVERAID v7.10 SUPPORT	*	*	*	*	*	*	*
		513976-03JA	GUIDE, SCSI/SATA/JA S/T/L QKIN	*	*	*	*	*	*	*
		513978-00	LBL, ASR-2130SLP PCBA	*	*	*	*	*	*	*
		513993-00	LBL, 8958 U320 SCSI TERMINATOR	*	*	*	*	*	*	*
		53P1797	SPACER PRAM	*	*	*	*	*	*	*
		53P4559	CONN 24P SHRD HDR	*	*	*	*	*	*	*
		53P4641	CONN 6P MICRO FIT	*	*	*	*	*	*	*
		61F2952	RES;220K,5%;.125W;0805	*	*	*	*	*	*	*
		62H7977	MICROPOWER DUAL COMPARATOR	*	*	*	*	*	*	*
		68X6437	RES;10,5%;.25W;1206	*	*	*	*	*	*	*
		70G6459	150PF,5%;50V;0603;NPO	*	*	*	*	*	*	*
		70P4675	IC MODULE COL 2.3.1 01	*	*	*	*	*	*	*
		71F7629	INDUCTOR,EMI,70OHMS;200MA;1206	*	*	*	*	*	*	*
		71F7666	RES;33,5%;.1W;0603	*	*	*	*	*	*	*
		71F7670	RES;1K,5%;.1W;0603	*	*	*	*	*	*	*

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		71F7671	RES; 1.5K, 5%; .1W; 0603	*	*	*	*	*	*	*
		71F7674	RES;4.7K,5%;.1W;0603	*	*	*	*	*	*	*
		71F7676	RES; 10K, 5%; .1W; 0603	*	*	*	*	*	*	*
		71F7677	RES;20K,5%;.1W;0603	*	*	*	*	*	*	*
		71F7680	RES,0 OHM,1A;0603	*	*	*	*	*	*	*
		74G1022	INDUCTOR,EMI,600OHMS;.2A;1206	*	*	*	*	*	*	*
		74G1102	0.0047UF, 10%; 50V; 0603; X7R	*	*	*	*	*	*	*
		77P0130	22UF,20%;16V;1210;X5R	*	*	*	*	*	*	*
		77P0191	10UF,10%;25V;1206;X5R	*	*	*	*	*	*	*
		77P0657	100UF, 20%; 6.3V; 1210; X5R	*	*	*	*	*	*	*
		77P0916	QUAD 2-INPUT POS-OR GATE, 3.3V	*	*	*	*	*	*	*
		77P0931	74LVC14 HEX SCHMITT INVERTER	*	*	*	*	*	*	*
		77P1096	XTL OSC;75MHZ;100PPM;3.3V;SMT	*	*	*	*	*	*	*
		77P1105	74LVC06 HEX INVERTER W/ O.C.	*	*	*	*	*	*	*
		77P1154	RES;49.9K,0.1%;THIN FILM;0603	*	*	*	*	*	*	*
		77P1159	DRAM,16MX16,DDR333,CL2,TSOP2	*	*	*	*	*	*	*
		77P1184	FF,DUAL,POS-EDGE-TRIG,D-TYPE	*	*	*	*	*	*	*
		77P1218	DIODE,SWITCHING,75V;SOT23-3	*	*	*	*	*	*	*
		77P1256	PNP SIGNAL TRANS;SOT-23	*	*	*	*	*	*	*
		77P1335	74AC00 QUAD 2-INPUT NAND	*	*	*	*	*	*	*
		77P1351	74ALVC08 QUAD 2-INPUT AND	*	*	*	*	*	*	*
		77P1397	NCH,MOS;PWR,30V,2.5W,SOIC8	*	*	*	*	*	*	*
		77P1463	MOSFET; 20V;.35W;SOT23;3LEADS	*	*	*	*	*	*	*
		77P1664	74LVC08 QUAD 2-IN AND GATE	*	*	*	*	*	*	*
		77P1722	FUSE;2A;63V;1206	*	*	*	*	*	*	*
		77P1770	SCHOTTKY RECTIFIER,3A,40V;SMC	*	*	*	*	*	*	*
		77P1784	SCHOTTKY RECTIFIER;1A,30V;SMB	*	*	*	*	*	*	*
		77P1824	220UF,20%;6.3V;TANT/NB 2816X	*	*	*	*	*	*	*
		77P1914	NCH MOSFET;25V;.35 W;SOT23-3	*	*	*	*	*	*	*
		77P1942	RES; 0.3, 1%;1W;THIN FILM;2010	*	*	*	*	*	*	*
		77P1963	74ACT05 HEX INVERTER W/ O.D.	*	*	*	*	*	*	*
		77P2051	NPN SIGNAL TRANS;SOT-23;HI REL	*	*	*	*	*	*	*
		77P2175	OP AMP,SINGLE,1.8V,RRIO	*	*	*	*	*	*	*
		77P2314	COMPARATOR,HI SPEED,UPWR,RRIO	*	*	*	*	*	*	*
		77P2324	VOLTAGE MONITOR,CMOS,SOIC-16	*	*	*	*	*	*	*
		77P2375	I2C&SMBUS I/O PORT,8BIT,W/INT.	*	*	*	*	*	*	*
		77P2412	DC-DC CONV,STEP-UP,.03A,12V	*	*	*	*	*	*	*
		77P2424	HEX INVERTERS	*	*	*	*	*	*	*
		77P2449	TRANSLATOR,QUAD,LO-V,16MBPS	*	*	*	*	*	*	*
		77P2460	OP AMP,DUAL,LO-PWR,RRIO	*	*	*	*	*	*	*
		77P2489	RESET, 5V,W/ OPEN DRAIN OUTPUT	*	*	*	*	*	*	*
		77P2491	TRANSLATOR,DUAL,LO-V,16MBPS	*	*	*	*	*	*	*
		77P2663	NPN,QUAD ARRAY,SIGNAL;SOIC16	*	*	*	*	*	*	*
		77P2789	74AUC2G08; 2-INPUT AND, DUAL	*	*	*	*	*	*	*
		77P2844	UP SUPERVISORY,3-VOLTAGE,SC70	*	*	*	*	*	*	*
		77P2849	INDUCTOR;100UH,20%;2100MA;SMT	*	*	*	*	*	*	*
		77P3029	64MBIT FLASH EE,3V,TSOP,56PIN	*	*	*	*	*	*	*
		77P3115	REGULATOR,SWITCH.,BUCK,HI EFF	*	*	*	*	*	*	*
		77P3206	INDUCTOR; 10UH, 10%;450MA;1210	*	*	*	*	*	*	*
		77P3290	LI-ION CHARGE MGR, W/INT SW.	*	*	*	*	*	*	*
		77P3486	INDUCTOR; 15UH, 10%; 1.45A; SM	*	*	*	*	*	*	*
		77P3591	LM385, MICROPWR VOLTAGE REF	*	*	*	*	*	*	*

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		77P3821	74LVC273, FLIP-FLOP, OCTAL, 3.	*	*	*	*	*	*	*
		77P3831	DC/DC,BUCK,PWM,W/INT FETS, 6A	*	*	*	*	*	*	*
		77P3880	1.8V LOW PWR WD RG FRQ CLK DRV	*	*	*	*	*	*	*
		77P3940	CLK DRVR, WIDE FREQ RANGE,1.8V	*	*	*	*	*	*	*
		77P4003	OP AMP, 0.9V, RAIL-TO-RAIL	*	*	*	*	*	*	*
		77P4144	INDUCTOR; 3.3UH, 30%;4.0A; SMT	*	*	*	*	*	*	*
		77P4172	OP AMP, RAIL-TO-RAIL I/O, SOT2	*	*	*	*	*	*	*
		77P4232	REG, SWITCH, 3.3V,3A, INT FETS	*	*	*	*	*	*	*
		798886	MICROPOWER VOLTAGE REFERENCE	*	*	*	*	*	*	*
		80G5242	RES;15K,1%;.125W;0805	*	*	*	*	*	*	*
		80G5310	RES;3.79K,0.1%;THIN FILM;0805	*	*	*	*	*	*	*
		82G6838	RES;6.04K,1%;.125W;0805	*	*	*	*	*	*	*
		84H8811	INDUCTOR,EMI;600OHMS;.2A;0603	*	*	*	*	*	*	*
		89G3823	RES; 0 OHMS, 1A; 0402	*	*	*	*	*	*	*
		89G3840	RES;4.7K,1%;.1W;0603	*	*	*	*	*	*	*
		916507-00	PCB, AHA-2940/2940U	*	*	*	*	*	*	*
		917307-00	PCB, AHA-2940UW	*	*	*	*	*	*	*
		967107-00	PCB, AHA-2940AU	*	*	*	*	*	*	*
		97H7545	SCREW CARD, 4-40 x 6.4	*	*	*	*	*	*	*
		97P2006	BUMPER ADHESIVE BACK	*	*	*	*	*	*	*
		97P3748	RIVET REMOVABL RIVET	*	*	*	*	*	*	*
		97P4846	BATTERY PUNT/ZENITH	*	*	*	*	*	*	*
		97P5277	BRACKET SHROUD	*	*	*	*	*	*	*
		97P6099	RAW CARD - DOUBLOON	*	*	*	*	*	*	*
		97P6604	CONN 300 NEXLEV HDR	*	*	*	*	*	*	*
		97P6605	CONN 300 NEXLEV RCP	*	*	*	*	*	*	*
		97P6934	COVER BATTERY PORT	*	*	*	*	*	*	*
		98F1423	RES;1K,1%;.125W;0805	*	*	*	*	*	*	*
		98F1641	RES;1.3K,1%;.125W;0805	*	*	*	*	*	*	*
		98F1642	RES;10K,1%;.125W;0805	*	*	*	*	*	*	*
		98F1644	RES;36.5K,1%;.125W;0805	*	*	*	*	*	*	*
		99-10619-02	72MM X 50M COMPAQ LOGO TAPE	*	*	*	*	*	*	*
		991507-00	PCB, AHA-2944UW	*	*	*	*	*	*	*
		999107-00	PCB, AHA-3944AUD	*	*	*	*	*	*	*
		99F1718	HEATSINK, 33MM 8X8 GRID	*	*	*	*	*	*	*
		99F1719	7.5 +/-0.2 HEATSINK	*	*	*	*	*	*	*
		AS-0012-003	DOMINO RAID ACCEL 256 PIN PBGA	*	*	*	*	*	*	*
		BAT-00005-01-A	SCD, IBM 1100mA BAT PK 39J0374	*	*	*	*	*	*	*
		BAT-00007-01-A	SCD, BAT 2.0AH LION ATB-20X	*	*	*	*	*	*	*
		BX-0038-001	ANTI-STAT SHLD BAG	*	*	*	*	*	*	*
		BX-0125-001	FRONT LK MAILER 13.75X10.75X2	*	*	*	*	*	*	*
		BX-0170-001	BB4050 IPP BOX	*	*	*	*	*	*	*
		BX-0177-001	SUN X-OPTION BOX	*	*	*	*	*	*	*
		BX-0178-001	SUN FRU BOX	*	*	*	*	*	*	*
		BX-0195-001	GENERIC SIMM/DIMM BOX	*	*	*	*	*	*	*
		BX-0196-001	10"X14" LRG ANTI-STATIC BAG	*	*	*	*	*	*	*
		BX-0198-001	4.5 X 8 X 1 DIMM BOX CONV FOAM	*	*	*	*	*	*	*
		BX-0200-EU1	2100S HARDWARE SLEEVE EUROPE	*	*	*	*	*	*	*
		BX-0201-JA1	ASR-3200S HARDWARE SLEEVE (JA)	*	*	*	*	*	*	*
		BX-0202-JA1	ASR-3400S HARDWARE SLEEVE (JA)	*	*	*	*	*	*	*
		BZ-0003-001	BUZZER WITH BUILT IN OSC	*	*	*	*	*	*	*
		CA-0035-001	CAP 15UF +/-1 20% 10V TA "B"	*	*	*	*	*	*	*

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		CA-0036-001	CAP .1UF +80% -20% 25V 0805	*	*	*	*	*	*	*
		CA-0037-001	CAP 22PF +/-10% 25V 0805	*	*	*	*	*	*	*
		CA-0041-001	1UF+/- 20% 16V TANT CAP A CASE	*	*	*	*	*	*	*
		CA-0047-001	CAP 100UF 10V LOW ESR TA "D"	*	*	*	*	*	*	*
		CA-0049-001	CAP 4.7UF +/-20% 10V TANT-ALUM	*	*	*	*	*	*	*
		CA-0050-001	CAP .01UF +/- 10% 25V 0805	*	*	*	*	*	*	*
		CA-0055-001	CAP 39PF +/-5% 25V 0805	*	*	*	*	*	*	*
		CA-0056-001	CAP 100PF +/-10% 50V 0805	*	*	*	*	*	*	*
		CA-0057-001	CAP 150PF +/-10% 50V 0805	*	*	*	*	*	*	*
		CA-0058-001	CAP .22UF +/- 20% 25V 0805	*	*	*	*	*	*	*
		CA-0063-001	CAP 15UF +/-20% 16V TA "B"	*	*	*	*	*	*	*
		CA-0065-001	CAP 4.7UF +80/-20% 10V 1206	*	*	*	*	*	*	*
		CA-0066-001	CAP 22UF +80/-20% 10V 1210	*	*	*	*	*	*	*
		CA-0069-001	CAP 100UF +/-20% 10V FUSED	*	*	*	*	*	*	*
		CA-0070-001	CAP .047UF +/-10% 50V 0805	*	*	*	*	*	*	*
		CA-0071-001	CAP: 1UF +/-20% 25V Y5V 1206	*	*	*	*	*	*	*
		CA-0072-001	CAP 1000PF +/-20% 3KV 1808	*	*	*	*	*	*	*
		CA-0076-001	CAP 10UF 16V LOW ESR TA "B"	*	*	*	*	*	*	*
		CA-0078-001	CAP 18PF +/-10% 50V 0805	*	*	*	*	*	*	*
		CDA-00015-01-A	CD ASSY,29320ALP/KNDL v1.01/GD	*	*	*	*	*	*	*
		CDA-00016-01-A	CD ASSY, SCSI/SATA S/T/Lv2.0GD	*	*	*	*	*	*	*
		CDA-00016-01EU-A	CD ASSY,SCSI/SATA/EU S/T/Lv2.0	*	*	*	*	*	*	*
		CDA-00022-01-A	CD ASSY, SERVERAID 8.00 APPS	*	*	*	*	*	*	*
		CDA-00023-01-A	CD ASSY, SERVERAID 8.00 SUPRT	*	*	*	*	*	*	*
		CDA-00024-01-A	CD ASSY, ICP90X4RO v1.0 GD	*	*	*	*	*	*	*
		CDA-00027-01-A	CD ASSY, 1420SA v2.12 DRVR/ASM	*	*	*	*	*	*	*
		CDA-00040-01-A	CD ASSY, ASC-48300 v1.0 DR/GD	*	*	*	*	*	*	*
		CH-0005-001	22UH +/-20% INDUCTOR SMT	*	*	*	*	*	*	*
		CH-0013-001	FERRITE CHIP, EMI FLT Z70 1206	*	*	*	*	*	*	*
		CN-0084-001	CRANE 2 PIN HEADER SR IR	*	*	*	*	*	*	*
		CN-0086-001	CRANE 4 PIN HEADER SR IR	*	*	*	*	*	*	*
		CN-0090-001	10 PN HEADER, DUAL ROW, DETACH	*	*	*	*	*	*	*
		CN-0098-001	68-POS RCPT STRDLMT 0.05 CNTR	*	*	*	*	*	*	*
		CN-0100-001	120P VERT PLUG ASSY 8/12/16 HT	*	*	*	*	*	*	*
		CN-0101-001	120-P VERT RCPT 5/6/7/8MM HT	*	*	*	*	*	*	*
		CN-0109-002	68P RCPT .8MM STRDLMT SHIELDED	*	*	*	*	*	*	*
		CN-0115-001	68-POS .8MM VHDCI THRU HOLE	*	*	*	*	*	*	*
		CN-0124-001	60P .8MM VERT RCPT 5/6/7/8 HT	*	*	*	*	*	*	*
		CN-0131-001	4 POS SGL RW RA.100 HDR HI TMP	*	*	*	*	*	*	*
		CN-0155-001	60P .8MM VERT PLUG 8/12/16 HT	*	*	*	*	*	*	*
		CN-0164-001	68 POS .8MM RE SHIELDED	*	*	*	*	*	*	*
		CN-0167-002	2 X 72 PIN RIGHT ANGLE	*	*	*	*	*	*	*
		CN-0169-001	60P .8MM VERT PLUG 5/9/13 HT	*	*	*	*	*	*	*
		CN-0170-001	60P .8MM VERT RCPT 13-16MM HT	*	*	*	*	*	*	*
		CN-0175-001	110 POS TYPE A 2MM FEMALE PCI	*	*	*	*	*	*	*
		CN-0178-001	5P R/A SHRD SR HDR SMT .1 CNTR	*	*	*	*	*	*	*
		CN-0185-001	144P .8MM 3.3V S/O DIMM SKT	*	*	*	*	*	*	*
		CN-0187-001	110 POS TYPE B 2MM FEMALE PCI	*	*	*	*	*	*	*
		CN-0192-001	CONN, 1X3X1.25MM M VERT SMT	*	*	*	*	*	*	*
		CN-0198-001	95 POS R/ANGLE FEMALE CPCI J3	*	*	*	*	*	*	*
		CN-0199-001	64 POS 1MM VERT REC 8,9,10MM	*	*	*	*	*	*	*
		CN-0214-001	168-POS 3.3V RA THRU HOLE DIMM	*	*	*	*	*	*	*

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		DI-0009-001	20V 1A SCHOTTKY DIODE MELF	*	*	*	*	*	*	*
		DI-0011-001	3A 15V SCHOTTKY DIODE SMT	*	*	*	*	*	*	*
		DI-0013-001	3.3V 225MW ZENER DIODE SOT-23	*	*	*	*	*	*	*
		DI-0014-001	MMBD7000LT1 DUAL SW DIO SOT-23	*	*	*	*	*	*	*
		DI-0017-001	1SMA12CAT3 ZENER TRANS VOLT	*	*	*	*	*	*	*
		DM-1032-001	168P 32MB ECC SDRAM DIMM PC100	*	*	*	*	*	*	*
		DM-1032-002	168P 32MB ECC SDRAM DIMM PC100	*	*	*	*	*	*	*
		DM-1064-001	168P 64MB ECC SDRAM DIMM PC100	*	*	*	*	*	*	*
		DO-0995-002	MASS STORAGE CONTROLLER ERRATA	*	*	*	*	*	*	*
		DO-1009-EN1	2100S/3000S REG CARD ENGLISH	*	*	*	*	*	*	*
		DO-1009-FR1	2100S/3000S REGST CARD FRENCH	*	*	*	*	*	*	*
		DO-1009-GR1	2100S/3000S REGST CARD GERMAN	*	*	*	*	*	*	*
		DO-1009-IT1	2100S/3000S REGST CARD ITALIAN	*	*	*	*	*	*	*
		DO-1009-JA1	2100S&3000S READ ME 1ST JAPAN	*	*	*	*	*	*	*
		DO-1009-SP1	2100S/3000S REGST CARD SPANISH	*	*	*	*	*	*	*
		DO-1010-EN1	ULTRA 160 QUICK START ENGLISH	*	*	*	*	*	*	*
		DO-1010-FR1	ULTRA 160 QUICK START FRENCH	*	*	*	*	*	*	*
		DO-1010-GR1	ULTRA 160 QUICK START GERMAN	*	*	*	*	*	*	*
		DO-1010-IT1	ULTRA 160 QUICK START ITALIAN	*	*	*	*	*	*	*
		DO-1010-SP1	ULTRA 160 QUICK START SPANISH	*	*	*	*	*	*	*
		EP-0031-001	32KB 2.7 SERIAL EEPROM SOIC	*	*	*	*	*	*	*
		EP-0033-001	29LV800BT 120NS 8M BIT 48 PIN	*	*	*	*	*	*	*
		EP-0038-001	128X8 2.7V SER EEPROM SOIC	*	*	*	*	*	*	*
		EP-0039-002	AM29LV160DB 120N 3V FLSH TSOP	*	*	*	*	*	*	*
		EP-0042-001	AT34C02 2-WIRE SER EEPROM SOIC	*	*	*	*	*	*	*
		HD-0014-001	SCREW, #2X3/16,PAN PHIL	*	*	*	*	*	*	*
		HD-0016-001	SCREW, #4X3/8,SELF TAP,PHIL	*	*	*	*	*	*	*
		HD-0019-001	SPACER 0.337" SNAP-IN SPACER	*	*	*	*	*	*	*
		HD-0020-001	5/16" SNAP-IN SPACER	*	*	*	*	*	*	*
		HD-0022-001	SCREWLOCK, BOARDMOUNT	*	*	*	*	*	*	*
		HD-0048-001	12MM STAND OFF	*	*	*	*	*	*	*
		HD-0057-003	BATTERY CLAMP	*	*	*	*	*	*	*
		HD-0058-001	SINGLE LIGHT PIPE 1206 LED	*	*	*	*	*	*	*
		HD-0059-001	4-40 X .25 PHILLIPS PANHD BKL	*	*	*	*	*	*	*
		HD-0062-001	4-40X 13MM BLACK SPACER	*	*	*	*	*	*	*
		HD-0063-001	4-40X.25 100D FLT HD PHIL SCRW	*	*	*	*	*	*	*
		HDW-00074-01-A	IBM M3x0.5 HEX SCREW 33G3907	*	*	*	*	*	*	*
		HDW-00075-01-A	IBM AP PLASTIC RIVET 25K9673	*	*	*	*	*	*	*
		HDW-00076-01-A	IBM AVON PARK BRACKET 26K8889	*	*	*	*	*	*	*
		HDW-00077-01-A	IBM PIVOTING HANDLE 26K8993	*	*	*	*	*	*	*
		IC-0212-001	74LS06 HEX INV W/OC SOIC	*	*	*	*	*	*	*
		IC-0224-001	5V DUAL RS232 SMTR/RCVR NR SOI	*	*	*	*	*	*	*
		IC-0297-001	UCC3916 SCSI CKT BRKR 8-P SOIC	*	*	*	*	*	*	*
		IC-0303-001	UCC5630 9 CHANNEL SCSI	*	*	*	*	*	*	*
		IC-0304-001	MGX16 50NS 3.3V ECO DIMM TSOP	*	*	*	*	*	*	*
		IC-0306-001	PCI9080 I20 PCI BUS MASTER	*	*	*	*	*	*	*
		IC-0308-001	PCF8591 I2C 8 BIT A/D	*	*	*	*	*	*	*
		IC-0309-001	80960 HD 32 BIT 66MHZ 208 PIN	*	*	*	*	*	*	*
		IC-0311-001	DEC CHIP 21154 64 BIT PCI TBGA	*	*	*	*	*	*	*
		IC-0312-001	CY2308 3.3V 0 DLY CLK BUFF SO	*	*	*	*	*	*	*
		IC-0314-001	3A 3.3V LDO VOLTAGE REG TO-263	*	*	*	*	*	*	*
		IC-0317-001	DS1621 IIC BUS SERIAL	*	*	*	*	*	*	*

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		IC-0318-001	74LVTH245A 3.3V TRANS 20 PIN	*	*	*	*	*	*	*
		IC-0319-001	74LVTH543 3.3V OCTAL REG	*	*	*	*	*	*	*
		IC-0320-001	LM4040 AIM3-2.5 VOLT 3 PIN	*	*	*	*	*	*	*
		IC-0322-001	BQ2004 FAST CHARGE IC 16	*	*	*	*	*	*	*
		IC-0326-001	7T1304 3.3DC-DC W/BAT DET SOIC	*	*	*	*	*	*	*
		IC-0327-001	LTC1440 COMPARATOR W/REF SOIC	*	*	*	*	*	*	*
		IC-0332-002	ISP2100A FIBRE CHANNEL 256 BGA	*	*	*	*	*	*	*
		IC-0333-001	bq2092 GAS GAUGE IC 16P SOIC	*	*	*	*	*	*	*
		IC-0336-001	74CBTLV3245 3.3 8X BUS SW TSOP	*	*	*	*	*	*	*
		IC-0337-001	CY2305 3.3 0 DLY CLK BUFFER SO	*	*	*	*	*	*	*
		IC-0339-001	3 AMP 3.3 600MV DROPOUT	*	*	*	*	*	*	*
		IC-0341-001	74LVT652 3.3V OCTAL BUS 24PIN	*	*	*	*	*	*	*
		IC-0345-001	74LVC74 3.3V DUAL D FF TSOP	*	*	*	*	*	*	*
		IC-0347-001	74LVC14 3.3 SCHMT TRG INV TSOP	*	*	*	*	*	*	*
		IC-0353-001	ISP1080 64 BIT PCI TO SCSI	*	*	*	*	*	*	*
		IC-0353-002	ISP1080 64 BIT PCI 388 PBGA	*	*	*	*	*	*	*
		IC-0362-001	1MX16X4 BANK 125MHZ SDRAM TSOP	*	*	*	*	*	*	*
		IC-0363-001	74FCT3807 3.3 1-10 CLK DR QSOP	*	*	*	*	*	*	*
		IC-0364-001	TL16C550C UART W/AUTOFL 48-PIN	*	*	*	*	*	*	*
		IC-0367-001	4.6A 3.3V LDO VR TO-263	*	*	*	*	*	*	*
		IC-0374-001	74CBT16244 16-BT BUS	*	*	*	*	*	*	*
		IC-0376-001	64KX16 10NS 3.3V SRAM 44 PIN	*	*	*	*	*	*	*
		IC-0379-001	UCC5628 14 LINE 48 PIN LQFP	*	*	*	*	*	*	*
		IC-0380-001	LMV324 QUAD PUR AMP 14 PIN	*	*	*	*	*	*	*
		IC-0385-001	4 MEG X 4 60NS 3.3V ECO	*	*	*	*	*	*	*
		IC-0386-001	16 MEG X4 60NS ECO SELF REF	*	*	*	*	*	*	*
		IC-0387-001	LTC1643L PCI-BUS 16-PIN SSOP	*	*	*	*	*	*	*
		IC-0391-001	74LVC06A HEX INVERTER 14P SOIC	*	*	*	*	*	*	*
		IC-0394-001	3125 3.3V QUAD FET BUS SW SOIC	*	*	*	*	*	*	*
		IC-0404-001	PCI 9054 PCI I/O 176 PIN PQFP	*	*	*	*	*	*	*
		IC-0410-001	8MX8 125MHZ LP SDRM 54PN TSOP	*	*	*	*	*	*	*
		IC-0412-001	bq 2004H FAST CHARGE IC SOIC	*	*	*	*	*	*	*
		IC-0413-001	80960RN I/O uP H-PBGA	*	*	*	*	*	*	*
		IC-0414-001	74CBTLV3126 LOWVT 4X BUS SW SO	*	*	*	*	*	*	*
		IC-0415-001	800mA 2.85V LDO VR SOT-223	*	*	*	*	*	*	*
		IC-0417-001	74LVC573A 3.3V DTYPE LTCH SSOP	*	*	*	*	*	*	*
		IC-0420-001	DS2119M U3 LVD/SE SCSI TSSOP	*	*	*	*	*	*	*
		IC-0423-001	80960RS I/O PROCESSOR H-PBGA	*	*	*	*	*	*	*
		IC-0431-001	74LVC08A 4X 2I AND GATE SOIC	*	*	*	*	*	*	*
		IC-0453-001	74LVC245A 3.3V TRAN. 20 PIN	*	*	*	*	*	*	*
		ICP-00001	CAP, CHIP 1200PF 50V X7R 0402	*	*	*	*	*	*	*
		ICP-00002	CAP, CHIP .1UF 16V X7R 0603	*	*	*	*	*	*	*
		ICP-00003	CAP, CHIP .1UF 50V X7R 0805	*	*	*	*	*	*	*
		ICP-00004	0.1UF,10%,10V, X7R,0402	*	*	*	*	*	*	*
		ICP-00005	CAP, CHIP .1UF 25V Y5V 0603	*	*	*	*	*	*	*
		ICP-00006	CAP, CHIP 100PF 16V NPO 0402	*	*	*	*	*	*	*
		ICP-00007	CAP: 100PF 5% 50V NPO 0805	*	*	*	*	*	*	*
		ICP-00008	CAP, CHIP .01UF 16V X7R 0402	*	*	*	*	*	*	*
		ICP-00009	CAP, CHIP .01UF 50V X7R 0603	*	*	*	*	*	*	*
		ICP-00010	CAP, CHIP .01UF 50V X7R 0805	*	*	*	*	*	*	*
		ICP-00011	CAP, CHIP .01UF 50V X7R 0402	*	*	*	*	*	*	*
		ICP-00012	CAP, 10UF 16V LOWESR TANT 3528	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		ICP-00013	CAP, 10UF 16V 20% TANT 3528	*	*	*	*	*	*	*
		ICP-00014	CAP, CHIP 1000PF 50V X7R 0603	*	*	*	*	*	*	*
		ICP-00015	CAP, CHIP 1UF 10V X7R 0805	*	*	*	*	*	*	*
		ICP-00016	CAP, CHIP 2.2UF 10V X7R 0805	*	*	*	*	*	*	*
		ICP-00017	CAP, CHIP .22UF 10V X7R 0603	*	*	*	*	*	*	*
		ICP-00018	CAP, CHIP .22UF 25V X7R 0805	*	*	*	*	*	*	*
		ICP-00019	CAP, CHIP 220PF 50V NPO 0402	*	*	*	*	*	*	*
		ICP-00020	CAP, CHIP 220PF 50V NPO 0603	*	*	*	*	*	*	*
		ICP-00021	CAP, 220UF 10V SOLID AL RAD	*	*	*	*	*	*	*
		ICP-00022	CAP, CHIP .022UF 50V X7R 0603	*	*	*	*	*	*	*
		ICP-00023	CAP, CHIP 22PF 50V NPO 0805	*	*	*	*	*	*	*
		ICP-00024	CAP, 22UF 25V 20% TANT 7343	*	*	*	*	*	*	*
		ICP-00025	CAP, 22UF 6.3V LOWESR TANT3528	*	*	*	*	*	*	*
		ICP-00026	CAP, CHIP .33UF 25V X7R 0805	*	*	*	*	*	*	*
		ICP-00027	CAP, CHIP 330PF 50V NPO 0603	*	*	*	*	*	*	*
		ICP-00028	CAP, 330UF 10V ESR .15 TAN7343	*	*	*	*	*	*	*
		ICP-00029	CAP, CHIP 4.7UF 10V Y5V 1206	*	*	*	*	*	*	*
		ICP-00030	CAP, CHIP 4.7UF 10V TANT 3528	*	*	*	*	*	*	*
		ICP-00031	CAP, 4.7UF 16V TANT LEADED RAD	*	*	*	*	*	*	*
		ICP-00032	CAP, 4.7UF 35V LOWESR TANT6032	*	*	*	*	*	*	*
		ICP-00033	CAP, 68UF 6.3V LOWESR TANT3528	*	*	*	*	*	*	*
		ICP-00034	CAP, CHIP 1UF 10V X7R 0805	*	*	*	*	*	*	*
		ICP-00035	CAP, CHIP 10UF 10V X7R 1210	*	*	*	*	*	*	*
		ICP-00036	RES, CHIP ZERO-OHM JUMPER 0402	*	*	*	*	*	*	*
		ICP-00037	RES, CHIP ZERO-OHM JUMPER 0603	*	*	*	*	*	*	*
		ICP-00038	RES, CHIP ZERO-OHM JUMPER 0805	*	*	*	*	*	*	*
		ICP-00040	RES, CHIP 1.5K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00041	RES, CHIP 1.5K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00042	RES, CHIP 100K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00044	RES, CHIP 100K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00045	RES, CHIP 100K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00046	RES, CHIP 100K 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00047	RES, CHIP 100 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00048	RES, CHIP 100 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00049	RES, CHIP 100 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00050	RES, CHIP 100 5% 1/2W 2010	*	*	*	*	*	*	*
		ICP-00051	RES: 100 OHM,1%,50PPM/K,AXIAL	*	*	*	*	*	*	*
		ICP-00052	RES, CHIP 10K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00053	RES, CHIP 10K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00054	RES, CHIP 10K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00055	RES, CHIP 10K 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00056	RES, CHIP 10 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00057	RES, CHIP 10 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00058	RES, CHIP 10 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00059	RES, CHIP 12.1K 1% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00060	RES, CHIP 12.1K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00061	RES, CHIP 120 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00062	RES, CHIP 150K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00063	RES, CHIP 150K 1% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00066	RES, CHIP 165K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00067	RES, CHIP 1K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00068	RES, CHIP 1K 5% 1/16W 0603	*	*	*	*	*	*	*

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		ICP-00069	RES, CHIP 1K 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00070	RES, CHIP 1M 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00071	RES, CHIP 2.2K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00072	RES, CHIP 2.2K 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00073	RES, CHIP 2.2M 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00074	RES, CHIP 2.2M 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00075	RES, CHIP 2.7K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00076	RES, CHIP 2.7K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00077	RES, CHIP 2.7K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00078	RES, CHIP 2.7K 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00079	RES, CHIP 200 5% 1/8W 1206	*	*	*	*	*	*	*
		ICP-00080	RES, CHIP 20K 1% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00081	RES, CHIP 20K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00082	RES, CHIP 20 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00083	RES, CHIP 220K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00084	RES, CHIP 220 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00085	RES, CHIP 220 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00086	RES, CHIP 220 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00087	RES, CHIP 22K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00088	RES, CHIP 22K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00089	RES, CHIP 22K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00090	RES, CHIP 22 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00091	RES, CHIP 22 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00092	RES, CHIP 22 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00094	RES, CHIP 3.3K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00095	RES, CHIP 3.9K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00096	RES, CHIP 33 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00097	RES, CHIP 4.7K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00098	RES, CHIP 4.7K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00099	RES, CHIP 4.7K 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00100	RES, CHIP 4.99K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00102	RES, CHIP 47K 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00103	THERMISTOR, CHIP 47K NTC 0805	*	*	*	*	*	*	*
		ICP-00104	RES, CHIP 47 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00105	RES, CHIP 47 5% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00106	RES, CHIP 49.9 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00108	RES, CHIP 8.2K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00109	RES, CHIP 8.2K 1% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00110	RES, CHIP 8.2K 5% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00111	RES, CHIP 80.6K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00112	RES, CHIP 9.76K 1% 1/10W 0805	*	*	*	*	*	*	*
		ICP-00113	RES, NTKW 1.5KX4 5% 1206	*	*	*	*	*	*	*
		ICP-00114	RES, NTKW 10KX4 5% 1206	*	*	*	*	*	*	*
		ICP-00115	RES, NTKW 10X4 5% 1206	*	*	*	*	*	*	*
		ICP-00116	RES, NTKW 2.7KX4 5% 1206	*	*	*	*	*	*	*
		ICP-00117	RES, NTKW 22X4 5% 1206	*	*	*	*	*	*	*
		ICP-00118	RES, NTKW 30X4 5% 1206	*	*	*	*	*	*	*
		ICP-00119	RES, NTKW 47X4 5% 1206	*	*	*	*	*	*	*
		ICP-00120	RES, NTKW 8.2KX4 5% 1206	*	*	*	*	*	*	*
		ICP-00121	RES, NTKW 10KX8 5%	*	*	*	*	*	*	*
		ICP-00122	RES, NTKW 8.2KX8 5%	*	*	*	*	*	*	*
		ICP-00123	RES, NTKW 1KX4 5% 1206	*	*	*	*	*	*	*

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		ICP-00124	RES, CHIP .005 1% 1W 2512	*	*	*	*	*	*	*
		ICP-00125	RES, CHIP .012 1% 1W 2512	*	*	*	*	*	*	*
		ICP-00126	CAP, 47UF 10V 20% TANT 6032	*	*	*	*	*	*	*
		ICP-00127	HEADER, 3-PIN SIP	*	*	*	*	*	*	*
		ICP-00130	SCREWLOCK, M2X0.4-6HX10.68 SST	*	*	*	*	*	*	*
		ICP-00131	IC, 16MBIT 3.3V UNIF FLSH TSOP	*	*	*	*	*	*	*
		ICP-00132	IC, 32MBIT 3V STRATA FLSH BGA	*	*	*	*	*	*	*
		ICP-00133	IC, 16MBIT 5V UNIF FLSH TSOP	*	*	*	*	*	*	*
		ICP-00134	IC, 7407 HEX BUFFER SO14	*	*	*	*	*	*	*
		ICP-00135	IC, 74AC08 QUAD 2 I/P AND SO14	*	*	*	*	*	*	*
		ICP-00136	IC, 74AC125 QUAD BUFFER 3-S SO	*	*	*	*	*	*	*
		ICP-00137	IC, 74AC32 QUAD 2 I/P OR SO14	*	*	*	*	*	*	*
		ICP-00138	IC, 74AC74 DUAL POS D F/F SO14	*	*	*	*	*	*	*
		ICP-00139	IC, 74F373 OCT TRAN LATCH SO20	*	*	*	*	*	*	*
		ICP-00140	IC, 74HC132 QUAD NANDGATE SO14	*	*	*	*	*	*	*
		ICP-00141	IC, 74HCT04 HEX INVERTER SO14	*	*	*	*	*	*	*
		ICP-00142	IC, 74HCT174 D-TYPE F/F 16P SO	*	*	*	*	*	*	*
		ICP-00143	IC, 74LV07A HEX BUFFER SO14	*	*	*	*	*	*	*
		ICP-00144	IC, 74LVC02A QUAD 2 I/P NOR SO	*	*	*	*	*	*	*
		ICP-00145	IC, 74LVC08A QUAD 2 I/P AND SO	*	*	*	*	*	*	*
		ICP-00146	IC, 74LVC125A QUAD BUS BUFF SO	*	*	*	*	*	*	*
		ICP-00147	IC, 74LVC573A OCT D-TYPE TSSOP	*	*	*	*	*	*	*
		ICP-00148	IC, 88I8030 SER ATA BRIDGE TQF	*	*	*	*	*	*	*
		ICP-00150	IC, GAL16V8D PLD 15NS 20P DIP	*	*	*	*	*	*	*
		ICP-00151	IC, DS1481 1-WIRE BUS MSTER SO	*	*	*	*	*	*	*
		ICP-00154	TRANS, FDC638 PMSFET 2.5V SSOT	*	*	*	*	*	*	*
		ICP-00155	TRANS, FDS6575 PMSFET 2.5V SO8	*	*	*	*	*	*	*
		ICP-00156	IC, ISPLSI2064A PLD 100MHZ QFP	*	*	*	*	*	*	*
		ICP-00157	IC, ISPLSI2064VE PLD 3.3V TQFP	*	*	*	*	*	*	*
		ICP-00158	IC, ICS581 ZERO DLY CLK MUX SO	*	*	*	*	*	*	*
		ICP-00159	IC, LMV324 QUAD OP-AMP SO14	*	*	*	*	*	*	*
		ICP-00160	IC, SIL3112 PCI REV 1.21 TQFP	*	*	*	*	*	*	*
		ICP-00162	IC, SYM53C1010 DUAL U3 329 BGA	*	*	*	*	*	*	*
		ICP-00163	IC, SYM53C1030 D U320 SCSI BGA	*	*	*	*	*	*	*
		ICP-00165	IC, TL061 LP JFET OP-AMP SO8	*	*	*	*	*	*	*
		ICP-00167	IC, UCC5672 LVD/SE TERM TSSOP	*	*	*	*	*	*	*
		ICP-00168	IC, DS2119ME(C1) LVD/SE TSSOP	*	*	*	*	*	*	*
		ICP-00169	IC, GC80303 I/O PROCESSOR BGA	*	*	*	*	*	*	*
		ICP-00170	IC, ISPLSI2064E PLD 100M TQFP	*	*	*	*	*	*	*
		ICP-00171	IC, LT1117 LDO REG 3.3 SOT223	*	*	*	*	*	*	*
		ICP-00172	IC, LTC1530 SW REG 3.3V SO8	*	*	*	*	*	*	*
		ICP-00173	IC, LT1761 LDO VR 1.8V SOT23-5	*	*	*	*	*	*	*
		ICP-00174	IC, LT1761 LDO VR 3.3V SOT23-5	*	*	*	*	*	*	*
		ICP-00175	IC, LT1764 LDO VR 3A 1.8V DPAK	*	*	*	*	*	*	*
		ICP-00176	IC, LT1772 DC DC CONVERTER SOT	*	*	*	*	*	*	*
		ICP-00177	IC, ISPMACH4A CPLD 5NS 48P QFP	*	*	*	*	*	*	*
		ICP-00178	IC, MAX6326 UP RESET CCT SOT23	*	*	*	*	*	*	*
		ICP-00179	IC, MAX6381 UP RESET CCT SC70	*	*	*	*	*	*	*
		ICP-00180	IC, MAX767 STEP DOWN CNTR SSOP	*	*	*	*	*	*	*
		ICP-00181	IC, MAX8863T LDO VR .12A SOT23	*	*	*	*	*	*	*
		ICP-00182	IC, MAX921 COMPARATOR 8PIN SO	*	*	*	*	*	*	*
		ICP-00183	IC, MAX971 COMPARATOR 8PIN SO	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		ICP-00184	DIODE, MBR0520LT1 0.5A 20V SOD	*	*	*	*	*	*	*
		ICP-00185	DIODE, MBRS130T3 1.0A 30V SMB	*	*	*	*	*	*	*
		ICP-00186	DIODE, MBRS340T3 3.0A 40V SMC	*	*	*	*	*	*	*
		ICP-00187	ENCLOSURE, TOP ICP LVD/SE TERM	*	*	*	*	*	*	*
		ICP-00188	IC, SDRAM 256MBIT 3.3V TSOP	*	*	*	*	*	*	*
		ICP-00190	IC, SDRAM 128MBIT 3.3V TSOP	*	*	*	*	*	*	*
		ICP-00191	TRANS, MTB75N05 N-MOSFET DDPAK	*	*	*	*	*	*	*
		ICP-00192	TRANS, SI4421DY P-MOSFET 8P SO	*	*	*	*	*	*	*
		ICP-00193	TRANS, SI4890DY N-MOSFET SO8	*	*	*	*	*	*	*
		ICP-00194	TRANS, SI9433DY P-MOSFET SO8	*	*	*	*	*	*	*
		ICP-00200	DIODE, 1N4148 0.45A 100V MELF	*	*	*	*	*	*	*
		ICP-00201	TRANS, BC847 NPN SOT-23	*	*	*	*	*	*	*
		ICP-00202	DIODE, DS9502 ESD PROTECT TSOC	*	*	*	*	*	*	*
		ICP-00203	FUSE, RUE110 CKT PRTECT PTH	*	*	*	*	*	*	*
		ICP-00204	FUSE, MICROSMDC010 .1A PTC 1210	*	*	*	*	*	*	*
		ICP-00205	FUSE, MINISMDC110 1.1A PT 1812	*	*	*	*	*	*	*
		ICP-00206	SPEAKER, TMB-05 ELECTRONIC	*	*	*	*	*	*	*
		ICP-00207	IND, 1.0UH 20% 15.3A SMD	*	*	*	*	*	*	*
		ICP-00208	IND, 2.2UF 20% 6.1A SMD	*	*	*	*	*	*	*
		ICP-00209	LED, L934YD YELLOW DIFF PTH	*	*	*	*	*	*	*
		ICP-00210	LED, YELLOW T-1 PTH	*	*	*	*	*	*	*
		ICP-00211	LED, GREEN T-1 PTH	*	*	*	*	*	*	*
		ICP-00213	IND, CHIP 4.7UH 20% 2.7A SMD	*	*	*	*	*	*	*
		ICP-00214	RES, CHIP 0.03OHM 1% 1/2W 2010	*	*	*	*	*	*	*
		ICP-00215	FERRITE, CHIP Z600 0.2A 0805	*	*	*	*	*	*	*
		ICP-00216	FERRITE, CHIP Z70 0.2A 1206	*	*	*	*	*	*	*
		ICP-00219	DIODE, MMBD301LT1 30V SOT-23	*	*	*	*	*	*	*
		ICP-00220	OSC, XTAL 100MHZ 50PPM FUND SM	*	*	*	*	*	*	*
		ICP-00221	OSC, XTAL 20MHZ 25PPM 3.3V SMD	*	*	*	*	*	*	*
		ICP-00222	OSC, XTAL 33MHZ 100PPM 3.3 SMD	*	*	*	*	*	*	*
		ICP-00223	OSC, XTAL 40MHZ 100PPM FUND SM	*	*	*	*	*	*	*
		ICP-00224	OSC, XTAL 80MHZ 100PPM FUND SM	*	*	*	*	*	*	*
		ICP-00225	LED, YELLOW 1206	*	*	*	*	*	*	*
		ICP-00226	LED, GREEN 1206	*	*	*	*	*	*	*
		ICP-00228	LED, RED 1206	*	*	*	*	*	*	*
		ICP-00231	HEATSINK, BLUE	*	*	*	*	*	*	*
		ICP-00236	HEATSINK, BLUE 30X30X10MM	*	*	*	*	*	*	*
		ICP-00237	HEATSINK, BLUE 43X43X8MM	*	*	*	*	*	*	*
		ICP-00239	HEADER, 5-PIN SIP	*	*	*	*	*	*	*
		ICP-00241	CONN, 7P SATA RA PLUG SMT	*	*	*	*	*	*	*
		ICP-00243	HEADER, 3-PIN SIP RA 2.5MM	*	*	*	*	*	*	*
		ICP-00244	CONN, 3-PIN HDR SHRD VERT	*	*	*	*	*	*	*
		ICP-00245	HEADER, 4-PIN SIP RA 2.5MM	*	*	*	*	*	*	*
		ICP-00246	SPOX, CRIMP RECEPTACLE 2.5MM	*	*	*	*	*	*	*
		ICP-00247	CONN, 40-PIN FEMALE RCPT 2.54M	*	*	*	*	*	*	*
		ICP-00248	SOCKET, 20-PIN DIP	*	*	*	*	*	*	*
		ICP-00249	SOCKET, 16-PIN DIP	*	*	*	*	*	*	*
		ICP-00251	BRACKET FULL HEIGHT GOLD	*	*	*	*	*	*	*
		ICP-00252	BRACKET, HALF HEIGHT GOLD	*	*	*	*	*	*	*
		ICP-00253	HEATSINK, BLACK	*	*	*	*	*	*	*
		ICP-00255	CONN, 40-PIN IDE DIP RA	*	*	*	*	*	*	*
		ICP-00257	HEADER, 8-PIN SIP	*	*	*	*	*	*	*

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		ICP-00258	HEADER, 8-PIN SIP SMT	*	*	*	*	*	*	*
		ICP-00259	HEADER, 4-PIN SIP	*	*	*	*	*	*	*
		ICP-00260	HEADER, 2-PIN SIP	*	*	*	*	*	*	*
		ICP-00261	HEADER, 4-PIN DIP SMT	*	*	*	*	*	*	*
		ICP-00262	HEADER, 6-PIN DIP	*	*	*	*	*	*	*
		ICP-00263	HEADER, 6-PIN DIP SMT	*	*	*	*	*	*	*
		ICP-00264	HEADER, 8-PIN DIP RA	*	*	*	*	*	*	*
		ICP-00265	HEADER, 8-PIN DIP SMT	*	*	*	*	*	*	*
		ICP-00266	HEADER, 8-PIN DIP SMT CTR PIN	*	*	*	*	*	*	*
		ICP-00267	HEADER, 10-PIN DIP	*	*	*	*	*	*	*
		ICP-00268	HEADER, 14-PIN DIP	*	*	*	*	*	*	*
		ICP-00269	HEADER, 3-PIN SIP	*	*	*	*	*	*	*
		ICP-00270	HEADER, 3-PIN SIP RA	*	*	*	*	*	*	*
		ICP-00271	HEADER, 3-PIN SIP SMT	*	*	*	*	*	*	*
		ICP-00273	BRACKET, EMI BISBEE	*	*	*	*	*	*	*
		ICP-00274	BRACKET, EMI	*	*	*	*	*	*	*
		ICP-00276	BRACKET, FULL HEIGHT	*	*	*	*	*	*	*
		ICP-00277	BRACKET, EMI HALF HEIGHT	*	*	*	*	*	*	*
		ICP-00278	BRACKET, EMI FOR GDT8X24RZ	*	*	*	*	*	*	*
		ICP-00283	BRACKET, EMI GOLD	*	*	*	*	*	*	*
		ICP-00284	BRACKET, EMI GOLD	*	*	*	*	*	*	*
		ICP-00285	BRACKET, EMI (LP)	*	*	*	*	*	*	*
		ICP-00287	CONN, RCPT FEMALE W/BD LOCK	*	*	*	*	*	*	*
		ICP-00289	CONN, 68-PIN RCPT RA 1.27MM	*	*	*	*	*	*	*
		ICP-00290	CONN, 68-PIN RCPT 1.27MM	*	*	*	*	*	*	*
		ICP-00291	HEADER, 4-PIN SIP RA 2.5MM	*	*	*	*	*	*	*
		ICP-00292	SCREW, DIN7985 4.8 VZ UNC 4/40	*	*	*	*	*	*	*
		ICP-00293	CONN, 68-PIN RCPT .8MM SCR LK	*	*	*	*	*	*	*
		ICP-00295	SOCKET, 72-PIN DIMM RA	*	*	*	*	*	*	*
		ICP-00297	CONN, SHUNT LO-PRO 2.54MM	*	*	*	*	*	*	*
		ICP-00302	FAN, 35X35X8.5MM	*	*	*	*	*	*	*
		ICP-00303	SPOX, FEMALE RECEPTACLE 2.5MM	*	*	*	*	*	*	*
		ICP-00304	PAD, THERMAL PAD 25X25MM	*	*	*	*	*	*	*
		ICP-00306	IC, 74LVX74M D-TYPE F/F SO14	*	*	*	*	*	*	*
		ICP-00307	IC, 74VCX08MX QUAD 2I/P AND SO	*	*	*	*	*	*	*
		ICP-00308	CAP, CHIP 100PF 50V NPO 0603	*	*	*	*	*	*	*
		ICP-00309	CAP, 10UF 16V 20% TANT	*	*	*	*	*	*	*
		ICP-00310	CAP, CHIP 22PF 50V NPO 0603	*	*	*	*	*	*	*
		ICP-00311	IC, CDC509 PLL CLK DRV TSSOP	*	*	*	*	*	*	*
		ICP-00312	CONN, 8-PIN RCPT FIBRE CH	*	*	*	*	*	*	*
		ICP-00315	TRANS, FDD6690A N-CHANNEL DPAK	*	*	*	*	*	*	*
		ICP-00316	IC, HDMP2630 2.125GBD 64P MQFP	*	*	*	*	*	*	*
		ICP-00317	IC, HPFC-5200 TACHYON FC EPBGA	*	*	*	*	*	*	*
		ICP-00319	LED, GREEN DUAL W HOUSING PTH	*	*	*	*	*	*	*
		ICP-00320	FERRITE, CHIP Z1000 0.4A 1608	*	*	*	*	*	*	*
		ICP-00321	DIODE, MBRM120L SCHKY RECT SMD	*	*	*	*	*	*	*
		ICP-00322	IC, MC100LVELT22 TRANSLATOR SO	*	*	*	*	*	*	*
		ICP-00323	IC, SRAM 3.3V 64KX32 TQFP-100	*	*	*	*	*	*	*
		ICP-00324	OSC, XTAL 106.25MHZ 100PPM SMD	*	*	*	*	*	*	*
		ICP-00325	OSC, XTAL 66MHZ 100PPM 3.3 SMD	*	*	*	*	*	*	*
		ICP-00327	RES, CHIP 150 1% 1/10W 0603	*	*	*	*	*	*	*
		ICP-00328	RES, CHIP 174K 1% 1/10W 0603	*	*	*	*	*	*	*

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		ICP-00329	RES, CHIP 20K 1% 1/10W 0603	*	*	*	*	*	*	*
		ICP-00330	RES, CHIP 4.7 5% 1/10W 0603	*	*	*	*	*	*	*
		ICP-00331	RES, CHIP 470 5% 1/10W 0603	*	*	*	*	*	*	*
		ICP-00333	RES, NTWK 2.2KX4 5% 1206	*	*	*	*	*	*	*
		ICP-00334	IC, 53C1000B1 U3 W LVDLINK BGA	*	*	*	*	*	*	*
		ICP-00336	SLOT, FC SLOT-BLECH 2CH	*	*	*	*	*	*	*
		ICP-00337	IC, 74LVC273 OCT D-T F/F TSSOP	*	*	*	*	*	*	*
		ICP-00338	IC, PCI-X 140M CLK BUFFER TSSO	*	*	*	*	*	*	*
		ICP-00339	FERRITE, CHIP Z70 0.5A 0402	*	*	*	*	*	*	*
		ICP-00340	OSC, XTAL 25MHZ 50PPM 3.3V SMD	*	*	*	*	*	*	*
		ICP-00341	RES, CHIP 1K 1% 1/16W 0603	*	*	*	*	*	*	*
		ICP-00342	RES, CHIP 47 5% 1/16W 0402	*	*	*	*	*	*	*
		ICP-00343	HEADER, 12-PIN RA 0.100"CS DIP	*	*	*	*	*	*	*
		ICP-00344	RES, CHIP 0.033 5% 1/2W 1206	*	*	*	*	*	*	*
		ICP-00346	FERRITE, Z30 3A DCR 0.01 PTH	*	*	*	*	*	*	*
		ICP-00348	RES, CHIP 100 1% 1/10W 0603	*	*	*	*	*	*	*
		ICP-00349	RES, CHIP 560 1% 1/10W 0603	*	*	*	*	*	*	*
		ICP-00350	SCREWLOCK, FEMALE 4-40 UNC	*	*	*	*	*	*	*
		ICP-00351	KEY, IDE-CONNECTOR	*	*	*	*	*	*	*
		ICP-00352	ENCLOSURE, BOTTOM ICP TERM	*	*	*	*	*	*	*
		ICP-00353	MYLAR, THICKNESS .25MM IN TERM	*	*	*	*	*	*	*
		ICP-00354	LABEL, HOLOGRAMM INTEL 1-1-1/2	*	*	*	*	*	*	*
		ICP-00355	LABEL, SAFETY H014 INTEL 1MIL	*	*	*	*	*	*	*
		ICP-00357	IC, MAX6383 UP RESET CCT SC70	*	*	*	*	*	*	*
		ICP-00358	DIODE, BAT54T1 SW HI SPD SOD	*	*	*	*	*	*	*
		ICP-00359	HEADER, 2-PIN SIP RA	*	*	*	*	*	*	*
		ICP-00360	HEADER, 4-PIN DIP	*	*	*	*	*	*	*
		ICP-00361	LED, BRIGHT RED 1206 SMD	*	*	*	*	*	*	*
		ICS-00207-01-A	MAX2003A, NIMH/NICD CHARGER,SO	*	*	*	*	*	*	*
		INT-00131	IC, 16MBIT 3.3V UNIF FLSH TSOP	*	*	*	*	*	*	*
		INT-00132	IC, 32MBIT 3V STRATA FLSH BGA	*	*	*	*	*	*	*
		INT-00133	IC, 16MBIT 5V UNIF FLSH TSOP	*	*	*	*	*	*	*
		INT-00134	IC, 7407 HEX BUFFER SO14	*	*	*	*	*	*	*
		INT-00135	IC, 74AC08 QUAD 2 I/P AND SO14	*	*	*	*	*	*	*
		INT-00136	IC, 74AC125 QUAD BUFFER 3-S SO	*	*	*	*	*	*	*
		INT-00137	IC, 74AC32 QUAD 2 I/P OR SO14	*	*	*	*	*	*	*
		INT-00138	IC, 74AC74 DUAL POS D F/F SO14	*	*	*	*	*	*	*
		INT-00139	IC, 74F373 OCT TRAN LATCH SO20	*	*	*	*	*	*	*
		INT-00143	IC, 74LV07A HEX BUFFER SO14	*	*	*	*	*	*	*
		INT-00144	IC, 74LVC02A QUAD 2 I/P NOR SO	*	*	*	*	*	*	*
		INT-00145	IC, 74LVC08A QUAD 2 I/P AND SO	*	*	*	*	*	*	*
		INT-00146	IC, 74LVC125A QUAD BUS BUFF SO	*	*	*	*	*	*	*
		INT-00147	IC, 74LVC573A OCT D-TYPE TSSOP	*	*	*	*	*	*	*
		INT-00154	TRANS, FDC638 PMSFET 2.5V SSOT	*	*	*	*	*	*	*
		INT-00155	TRANS, FDS6575 PMSFET 2.5V SO8	*	*	*	*	*	*	*
		INT-00156	IC, ISPLSI2064A PLD 100MHZ QFP	*	*	*	*	*	*	*
		INT-00157	IC, ISPLSI2064VE PLD 3.3V TQFP	*	*	*	*	*	*	*
		INT-00160	IC, SIL3112 PCI REV 1.21 TQFP	*	*	*	*	*	*	*
		INT-00162	IC, SYM53C1010 DUAL U3 329 BGA	*	*	*	*	*	*	*
		INT-00163	IC, SYM53C1030 D U320 SCSI BGA	*	*	*	*	*	*	*
		INT-00165	IC, TL061 LP JFET OP-AMP SO8	*	*	*	*	*	*	*
		INT-00166	IC, LVD/SE SCSI TERM 9L 36 SOP	*	*	*	*	*	*	*

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		INT-00168	IC, DS2119ME(C1) LVD/SE TSSOP	*	*	*	*	*	*	*
		INT-00169	IC, GC80303 I/O PROCESSOR BGA	*	*	*	*	*	*	*
		INT-00170	IC, ISPLSI2064E PLD 100M TQFP	*	*	*	*	*	*	*
		INT-00171	IC, LT1117 LDO REG 3.3 SOT223	*	*	*	*	*	*	*
		INT-00175	IC, LT1764 LDO VR 3A 1.8V DPAK	*	*	*	*	*	*	*
		INT-00176	IC, LT1772 DC DC CONVERTER SOT	*	*	*	*	*	*	*
		INT-00177	IC, ISPMACH4A CPLD 5NS 48P QFP	*	*	*	*	*	*	*
		INT-00179	IC, MAX6381 UP RESET CCT SC70	*	*	*	*	*	*	*
		INT-00180	IC, MAX767 STEP DOWN CNTR SSOP	*	*	*	*	*	*	*
		INT-00182	IC, MAX921 COMPARATOR 8PIN SO	*	*	*	*	*	*	*
		INT-00188	IC, SDRAM 256MBIT 3.3V TSOP	*	*	*	*	*	*	*
		INT-00189	IC, SDRAM 64MBIT 3.3V 7.5N TSO	*	*	*	*	*	*	*
		INT-00190	IC, SDRAM 128MBIT 3.3V TSOP	*	*	*	*	*	*	*
		INT-00191	TRANS, MTB75N05 N-MOSFET DDPAK	*	*	*	*	*	*	*
		INT-00192	TRANS, SI4421DY P-MOSFET 8P SO	*	*	*	*	*	*	*
		INT-00194	TRANS, SI9433DY P-MOSFET SO8	*	*	*	*	*	*	*
		INT-00220	OSC, XTAL 100MHZ 50PPM FUND SM	*	*	*	*	*	*	*
		INT-00223	OSC, XTAL 40MHZ 100PPM FUND SM	*	*	*	*	*	*	*
		INT-00224	OSC, XTAL 80MHZ 100PPM FUND SM	*	*	*	*	*	*	*
		INT-00315	TRANS, FDD6690A N-CHANNEL DPAK	*	*	*	*	*	*	*
		INT-00321	DIODE, MBRM120L SCHKY RECT SMD	*	*	*	*	*	*	*
		INT-00324	OSC, XTAL 106.25MHZ 100PPM SMD	*	*	*	*	*	*	*
		INT-00325	OSC, XTAL 66MHZ 100PPM 3.3 SMD	*	*	*	*	*	*	*
		INT-00334	IC, 53C1000B1 U3 W LVDLINK BGA	*	*	*	*	*	*	*
		JU-0003-001	0.1" SHORTING JUMPER	*	*	*	*	*	*	*
		LB-0003-001	2" WHITE THERMAL XFER	*	*	*	*	*	*	*
		LB-0240-001	4"X6" BLNK BRCD LBL THRM TRF	*	*	*	*	*	*	*
		LB-0248-001	1"X.393" FI/FW BLANK LBL THER	*	*	*	*	*	*	*
		LB-0326-001	CE MARK LABEL	*	*	*	*	*	*	*
		LB-0542-001	BLANK 2 X .5 POLY LABEL	*	*	*	*	*	*	*
		LB-0788-002	BB4050 MEMORY LABEL	*	*	*	*	*	*	*
		LB-0914-001	BLANK DISKETTE LABEL (2X2 3/4)	*	*	*	*	*	*	*
		LD-0009-001	SINGLE LED RED 1206 SMT	*	*	*	*	*	*	*
		LD-0010-001	SINGLE LED GREEN 1206 SMT	*	*	*	*	*	*	*
		LD-0014-001	SINGLE LED BLUE SMT 1206	*	*	*	*	*	*	*
		LD-0015-001	RED/GREEN BI-COLOR LED 1210	*	*	*	*	*	*	*
		MAN-00031-01-A	GUIDE, ICP SCSI RAID CNTRL QIG	*	*	*	*	*	*	*
		MAN-00031-01GE-A	GUIDE, ICP/GE SCSI RD CNTL QIG	*	*	*	*	*	*	*
		MAN-00036-01-A	CARD, ABM-400 QUICK INSTALL	*	*	*	*	*	*	*
		MAN-00039-01-A	GUIDE, SRVRD 8i SAS INSTL/IBM	*	*	*	*	*	*	*
		MB-0020-003	2 HOLE FBR CHNNL (1-F/1-F)BKT	*	*	*	*	*	*	*
		MB-0022-003	1 HOLE FIBRE CHANNEL (1-F) BKT	*	*	*	*	*	*	*
		MB-0023-001	3 HOLE VHDCI (1-U2/2-U2) BKT	*	*	*	*	*	*	*
		MB-0024-001	2 HOLE VHDCI (1-U2/1-U2) BKT	*	*	*	*	*	*	*
		MB-0025-001	1 HOLE VHDCI (1-U2) METAL BRKT	*	*	*	*	*	*	*
		MB-0027-005	ISA RETAINER - BATTERY MODULE	*	*	*	*	*	*	*
		MB-0028-002	PCI RETAINER - BATTERY MODULE	*	*	*	*	*	*	*
		MEC-00223-01-A	HEATSINK, W/THERMAL 30X30X10MM	*	*	*	*	*	*	*
		MEC-00225-01-A	BRACKET, LP 2 STACK LOW GOLD	*	*	*	*	*	*	*
		MEC-00226-01-A	BRACKET, LP 1 STACK LOW GOLD	*	*	*	*	*	*	*
		MEC-00227-01-A	BRACKET, LP 1 STACK FULL GOLD	*	*	*	*	*	*	*
		MEC-00228-01-A	BRACKET, LP 2 STACK FULL GOLD	*	*	*	*	*	*	*

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		MEC-00239-01-A	BRACKET, AURORA MULE BOARD	*	*	*	*	*	*	*
		MEC-00240-01-A	BRACKET, ZERO CH GOLD	*	*	*	*	*	*	*
		MEC-00241-01-A	BRACKET, BLANK LP TABS GOLD	*	*	*	*	*	*	*
		MEC-00263-01-A	BRACKET, ICP9085LI GOLD	*	*	*	*	*	*	*
		OS-0016-001	80MHZ CRYSTAL	*	*	*	*	*	*	*
		OS-0039-001	100 MHZ 3.3V FIXED CRYSTAL SMT	*	*	*	*	*	*	*
		OS-0041-001	80MHZ 3.3V XTAL OSCILLATOR SMT	*	*	*	*	*	*	*
		PA-0062-001	EPM7128 10NS 128 MACRO	*	*	*	*	*	*	*
		PA-0068-001	PZ3064 10NS 64 MAC 44 PIN TQFP	*	*	*	*	*	*	*
		PA-0073-001	EPM7256A 7NS 256 5.V 208 PIN	*	*	*	*	*	*	*
		PA-0078-001	PZ3064 7NS 64 MACRO CPLD TQFP	*	*	*	*	*	*	*
		PA-0079-001	EPM7064 10NS 3.3V 64 MACRO	*	*	*	*	*	*	*
		PA-0081-001	EPM7128A 10NS 3.3V 100-P TQFP	*	*	*	*	*	*	*
		PA-0082-001	EPM7256AE 7NS 3.3V 256 MAC	*	*	*	*	*	*	*
		PAK-00198-01-A	BOX, 3.6" X 3" X 4" KIT	*	*	*	*	*	*	*
		PAK-00200-01-A	BOX, 7.07" X 3.54" X 4.78" KIT	*	*	*	*	*	*	*
		PAK-00201-01-A	BOX, 18.62"X14.88"X10.35" MSTR	*	*	*	*	*	*	*
		PAK-00210-01-A	CLAMSHELL, ASC-39320A-R	*	*	*	*	*	*	*
		PC-1035-005	SX4055U2 PCB	*	*	*	*	*	*	*
		PC-1040-005	BB4050 PCB	*	*	*	*	*	*	*
		PC-1050-006	PM3755U2B PCB	*	*	*	*	*	*	*
		PC-1060-001	DM4050-16 PCB	*	*	*	*	*	*	*
		PC-1185-001	ABM-100 PCB (4 LYR)	*	*	*	*	*	*	*
		PC-1230-003	PM3757U2 PCB	*	*	*	*	*	*	*
		PC-1290-003	ASR-3000S PCB v3	*	*	*	*	*	*	*
		PC-1320-002	ASR-2100S PCB	*	*	*	*	*	*	*
		PCB-00165-01-A	MSTR FILE, MYNAH TEST CARD	*	*	*	*	*	*	*
		PCB-00168-01-A	MSTR FILE, ICP90X7MA ICPINTRDR	*	*	*	*	*	*	*
		PCB-00168-01-B	MSTR FILE, ICP90X7MA INTDR RSP	*	*	*	*	*	*	*
		PCB-00168-01-C	MSTR FILE, ICP90X7MA INTDR RSP	*	*	*	*	*	*	*
		PCB-00174-01-A	MSTR FILE, ATB-200	*	*	*	*	*	*	*
		PCB-00174-01-B	MSTR FILE, ATB-200	*	*	*	*	*	*	*
		PCB-00189-01-A	MSTR FILE, ICP9085LI	*	*	*	*	*	*	*
		PCB-00189-01-B	MSTR FILE, ICP9085LI	*	*	*	*	*	*	*
		PCB-00205-01-A	MSTR FILE,RIGEL BATTERY MODULE	*	*	*	*	*	*	*
		RE-0050-001	RES, CHIP 22 OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0051-001	RES, CHIP 1K OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0052-001	RES, CHIP 10K OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0053-001	RES, CHIP 220 OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0054-001	RES, CHIP ZERO OHM 0805	*	*	*	*	*	*	*
		RE-0055-001	RES, CHIP 47 OHM +/- 5% 0805	*	*	*	*	*	*	*
		RE-0056-001	RES, CHIP 330 OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0057-001	RES, CHIP 2.2K 1/8W 5% 0805	*	*	*	*	*	*	*
		RE-0058-001	RES, CHIP 1.2K OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0063-001	RES, CHIP 4.7K OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0064-001	RES, CHIP 40.2K OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0072-001	33 OHM +/- 5% RESISTOR	*	*	*	*	*	*	*
		RE-0081-001	RES, CHIP 3.32K OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0082-001	RES, CHIP 11.5KOHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0083-001	6.98K OHM +/-1%	*	*	*	*	*	*	*
		RE-0086-001	RES, CHIP 75 OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0088-001	RES, CHIP 620 1/8W 5% 0805	*	*	*	*	*	*	*

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		RE-0089-001	RES, CHIP 2.7K OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0090-001	RES, CHIP 100 OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0091-001	RES, CHIP 100K OHM 1% 0805	*	*	*	*	*	*	*
		RE-0093-001	RES, CHIP 22K 5% 1/8W 0805	*	*	*	*	*	*	*
		RE-0094-001	RES, CHIP 28.7K 1% 1/8W 0805	*	*	*	*	*	*	*
		RE-0096-001	RES, CHIP 43K 5% 1/8W 0805	*	*	*	*	*	*	*
		RE-0097-001	RES, CHIP 240 OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0098-001	RES, CHIP 10 OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0100-001	4.22K OHM +/- 1% RES.CHIP 0805	*	*	*	*	*	*	*
		RE-0101-001	RES, CHIP 3.32K 1% 1/8W 0805	*	*	*	*	*	*	*
		RE-0113-001	RES, CHIP 3.01K OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0115-001	1.25OHM +/-5% 5 WATT	*	*	*	*	*	*	*
		RE-0116-001	76.8K OHM +/-1% RESISTOR	*	*	*	*	*	*	*
		RE-0117-001	RES, CHIP 23.2K OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0118-001	RES, CHIP .1 OHM 1% .5W 2010	*	*	*	*	*	*	*
		RE-0125-001	3.16 OHM +/-1% 2W RES. SMT	*	*	*	*	*	*	*
		RE-0127-001	RES, CHIP 100 OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0130-001	RES, CHIP 220K OHM +/-5% 0805	*	*	*	*	*	*	*
		RE-0141-001	80.6OHM +/-1% 1 WATT	*	*	*	*	*	*	*
		RE-0142-001	RES, CHIP 4.22K 0.1% 0805	*	*	*	*	*	*	*
		RE-0143-001	RES, 10.4 OHM +/-1% 2W SMT	*	*	*	*	*	*	*
		RE-0148-001	RES, CHIP .005OHM +/-1% 1W SMT	*	*	*	*	*	*	*
		RE-0149-001	RES, CHIP .012OHM +/-1% 1W SMT	*	*	*	*	*	*	*
		RE-0154-001	RES, CHIP 44.2K OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0155-001	RES, 2.5 OHM +/-5% 5W SMT	*	*	*	*	*	*	*
		RE-0156-001	RES, CHIP 4.99K 1% 1/8W 0805	*	*	*	*	*	*	*
		RE-0157-001	RES, CHIP 6.19K 1% 1/8W 0805	*	*	*	*	*	*	*
		RE-0158-001	RES, CHIP 45.3K OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0162-001	RES, CHIP 4.12K OHM +/-1% 0805	*	*	*	*	*	*	*
		RE-0167-001	RES, CHIP 8.45K .1% 1/10W 0805	*	*	*	*	*	*	*
		RP-0057-001	RES, PK 10 OHM +/-5% X 4 1206	*	*	*	*	*	*	*
		RP-0058-001	RES, PAK 10K OHM +/-5% X 4 1206	*	*	*	*	*	*	*
		RP-0059-001	RES NTWK CHIP 4X4.7K 5% 1206	*	*	*	*	*	*	*
		RP-0060-001	RES NTWK CHIP 4X2.7K 5% 1206	*	*	*	*	*	*	*
		TH-0006-001	1.1A 16V RESETTABLE FUSE SMT	*	*	*	*	*	*	*
		TR-0008-001	Si9424DY P-CH ENHANCEMENT MODE	*	*	*	*	*	*	*
		TR-0010-001	MMBT2222ALT1 NPN TRANS SOT-23	*	*	*	*	*	*	*
		TR-0012-001	IRF7413A N-CHANNEL MOSFET 8 PN	*	*	*	*	*	*	*
		TR-0013-001	BSS138 N-CHANNEL LOGIC SOT-23	*	*	*	*	*	*	*
RAWS		PAK-00245-01JA-A	SLV, AAR-2820SA/JA KIT	*	*	*	*	*	*	*
		1491633-00	DISK ASSY, 7800 FMS v3.02	*	*	*	*	*	*	*
		1491699-00	DISK ASSY, 7800 FMS LITE v2.11	*	*	*	*	*	*	*
		1492392-00	CD ROM, ADAPTEC FMS v4.0	*	*	*	*	*	*	*
		1492392-00JA	CD ROM, ADPT FMS/JA v4.0 woDs	*	*	*	*	*	*	*
		1494316-00	LBL GRP, PCBA SERIAL # ONLY	*	*	*	*	*	*	*
		1615700-R	AHA-2944UW RoHS HOST ADAPTER	*	*	*	*	*	*	*
		1686906-19	PCA, AHA-2940U2W/DELL3	*	*	*	*	*	*	*
		1691500-R	AHA-2944UW/SNI RoHS HST ADPTR	*	*	*	*	*	*	*
		1697800-R	AHA-2910C RoHS HOST ADAPTER	*	*	*	*	*	*	*
		1701700-R	AHA-2930C RoHS HOST ADAPTER	*	*	*	*	*	*	*
		1714100-R	AHA-2915C RoHS HOST ADAPTER	*	*	*	*	*	*	*
		1731000-R	AHA-2930CU RoHS HOST ADAPTER	*	*	*	*	*	*	*

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		1742100-01JA-R	AHA-2910C/FUJITSU RoHS TRAYPKG	*	*	*	*	*	*	*
		1780600-R	AVA-2906 RoHS VALUE ADAPTER	*	*	*	*	*	*	*
		1790106-00	PCA, AAC-364 MAIN BD	*	*	*	*	*	*	*
		1790106-01	PCA, AAC-364/DELL2 MAIN BOARD	*	*	*	*	*	*	*
		1790106-03	PCA, AAC-364/DELL2 v2 MAIN BD	*	*	*	*	*	*	*
		1796906-01	PCA, AAC-9001MD/HP	*	*	*	*	*	*	*
		1796906-02	PCA, ABM-9001MD	*	*	*	*	*	*	*
		1807106-01	PCA, AAC-3642/HP	*	*	*	*	*	*	*
		1807106-02	PCA, ASR-3642	*	*	*	*	*	*	*
		1809300-R	AHA-2930C POEM RoHS HOST ADPTR	*	*	*	*	*	*	*
		1809606-04	PCA, ASC-29160 '00	*	*	*	*	*	*	*
		1809606-12	PCA, ASC-29160/NEC1	*	*	*	*	*	*	*
		1809606-15	PCA, ASC-29160/FSC4	*	*	*	*	*	*	*
		1814000-R	AVA-2904 RoHS VALUE ADPTR (99)	*	*	*	*	*	*	*
		1814800-R	AHA-2910C RoHS HOST ADPTR (99)	*	*	*	*	*	*	*
		1815500-R	AVA-2902BE RoHS VALUE ADAPTER	*	*	*	*	*	*	*
		1817206-01	PCA, ASC-39160 '00	*	*	*	*	*	*	*
		1817206-03	PCA, ASC-39160/CPQ HPSD	*	*	*	*	*	*	*
		1817206-08	PCA, ASC-39160/CPQ	*	*	*	*	*	*	*
		1817206-12	PCA, ASC-39160/DELL3	*	*	*	*	*	*	*
		1818900	CD-ASSY, CI/O MGNT v4.01.40	*	*	*	*	*	*	*
		1833397-00	BIOS, ASC-29160LP/NEC	*	*	*	*	*	*	*
		1834606-02	PCA, AAC-9000MD/DELL3 (TAB II)	*	*	*	*	*	*	*
		1835300-R	ASC-39160 RoHS HOST ADAPTER	*	*	*	*	*	*	*
		1836400EU	CD-ASSY, CI/O v4.01/USER EFGS	*	*	*	*	*	*	*
		1836600	CD ASSY, UDMA CI/O MGT v4.40	*	*	*	*	*	*	*
		1837600-R	ASC-29160 RoHS HOST ADAPTER	*	*	*	*	*	*	*
		1841406-00	PCA, ASC-29160LP	*	*	*	*	*	*	*
		1841406-03	PCA, ASC-29160LP '00	*	*	*	*	*	*	*
		1841406-09	PCA, ASC-29160LP HIGH/IBM-2	*	*	*	*	*	*	*
		1841406-11	PCA, ASC-29160LP/FSC	*	*	*	*	*	*	*
		1841406-22	PCA, ASC-29160LP/NEC	*	*	*	*	*	*	*
		1850900-R	ASC-29160/MICRON RoHS HST ADPT	*	*	*	*	*	*	*
		1857900	ASC-19160 HOST ADAPTER '00	*	*	*	*	*	*	*
		1858000-R	ASC-39160 RoHS HOST ADPTR '00	*	*	*	*	*	*	*
		1858200	ASC-29160 HOST ADAPTER '00	*	*	*	*	*	*	*
		1858200-R	ASC-29160 RoHS HST ADAPTER '00	*	*	*	*	*	*	*
		1858300-R	ASC-29160LP RoHS HOST ADAPTER	*	*	*	*	*	*	*
		1861100-R	ASC-39160/CPQ HPSD RoHS H/A	*	*	*	*	*	*	*
		1865000-R	ASC-29160LP RoHS HST ADPTR'00	*	*	*	*	*	*	*
		1866200-R	ASC-29160LP HIGH RoHS HST ADPT	*	*	*	*	*	*	*
		1867300EU	CD ASSY,UDMA/EFIGS CIO/USR4.03	*	*	*	*	*	*	*
		1871606-01	PCA, AAR-2400A	*	*	*	*	*	*	*
		1879406-50	PCA, ASR-3410S (C1)	*	*	*	*	*	*	*
		1879406-70	PCA, ASR-3210S (C1)	*	*	*	*	*	*	*
		1881906-00	PCA, ABM-200	*	*	*	*	*	*	*
		1892000-R	ASC-39160/CPQ RoHS HOST ADPTR	*	*	*	*	*	*	*
		1908806-00	PCA, ASR-2005S/48MB	*	*	*	*	*	*	*
		1908806-02	PCA, ASR-2005S/48MB HITACHI	*	*	*	*	*	*	*
		1908806-50	PCA, ASR-2015S/48MB	*	*	*	*	*	*	*
		1908806-52	PCA, ASR-2015S/48MB HITACHI	*	*	*	*	*	*	*
		1920006-00	PCA, ASR-2000S/48MB	*	*	*	*	*	*	*

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		1920006-04	PCA, ASR-2000S/48MB HITACHI	*	*	*	*	*	*	*
		1920006-05	PCA, ASR-2000S/48MB FUJ	*	*	*	*	*	*	*
		1920006-50	PCA, ASR-2010S/48MB	*	*	*	*	*	*	*
		1920006-55	PCA, ASR-2010S/48MB NEC	*	*	*	*	*	*	*
		1920800-R	ASC-29160/NEC1 RoHS HST ADAPTER	*	*	*	*	*	*	*
		1925606-00	PCA, ASC-29160N NF	*	*	*	*	*	*	*
		1925606-01	PCA, ASC-29160N/DELL2 NF	*	*	*	*	*	*	*
		1925606-02	PCA, ASC-29160N NF CHNL	*	*	*	*	*	*	*
		1925606-03	PCA, ASC-19160 NF CHNL	*	*	*	*	*	*	*
		1925606-05	PCA, ASC-29160N/HPQ NF	*	*	*	*	*	*	*
		1929800EU	CD ASSY,ASR/AAR v1.1/GUIDES EU	*	*	*	*	*	*	*
		1929800JA	CD ASSY,ASR/AAR v1.1/GUIDES JA	*	*	*	*	*	*	*
		1929906-01	PCA, ASC-29320LP/IBM	*	*	*	*	*	*	*
		1929906-05	PCA, ASC-29320LP CHNL	*	*	*	*	*	*	*
		1935500JA	CD ASSY,ASR/AAR v2.0/GUIDES JA	*	*	*	*	*	*	*
		1947606-04	PCA, ASR-2200S/64MB CHNL	*	*	*	*	*	*	*
		1947606-06	PCA, ASR-2200S/64MB/DELL 2	*	*	*	*	*	*	*
		1947606-07	PCA, ASR-2200S/64MB CHNL (US)	*	*	*	*	*	*	*
		1947606-22	PCA, ASR-2200S/128MB/FSC	*	*	*	*	*	*	*
		1947606-24	PCA, ASR-2200S/128MB LGC	*	*	*	*	*	*	*
		1947606-25	PCA, ASR-2200S/128MB CHNL	*	*	*	*	*	*	*
		1947606-52	PCA, ASR-2120S/64MB/FSC	*	*	*	*	*	*	*
		1947606-53	PCA, ASR-2120S/64MB/LEGEND	*	*	*	*	*	*	*
		1947606-54	PCA, ASR-2120S/64MB HPWS	*	*	*	*	*	*	*
		1947606-55	PCA, ASR-2120S/64MB HITACHI	*	*	*	*	*	*	*
		1947606-59	PCA, ASR-2120S/64MB LGC	*	*	*	*	*	*	*
		1947606-60	PCA, ASR-2120S/64MB CHNL (US)	*	*	*	*	*	*	*
		1947606-74	PCA, ASR-2120S/128MB CHNL	*	*	*	*	*	*	*
		1947806-10	PCA, ABM-300 (1040maH)	*	*	*	*	*	*	*
		1947806-20	PCA, ABM-400	*	*	*	*	*	*	*
		1950106-50	PCA, ASR-2110S/32M (C1)	*	*	*	*	*	*	*
		1950106-53	PCA, ASR-2110S/32MB(C1) LEGEND	*	*	*	*	*	*	*
		1958006-01	PCA, ASC-29320	*	*	*	*	*	*	*
		1958006-02	PCA, ASC-29320/FSC	*	*	*	*	*	*	*
		1958006-06	PCA, ASC-39320 CHNL	*	*	*	*	*	*	*
		1958006-07	PCA, ASC-29320 CHNL	*	*	*	*	*	*	*
		1958006-08	PCA, ASC-39320/DELL	*	*	*	*	*	*	*
		1958406-02	PCA, ASC-39320D/NETAPP	*	*	*	*	*	*	*
		1965200	CD ASSY, ASR/AAR v3.0 GUIDES	*	*	*	*	*	*	*
		1965200EU	CD ASSY, ASR/AAR/EFIGS 3.0 GD	*	*	*	*	*	*	*
		1967006-01	PCA, ASR-2025ZCR/64MB TEST	*	*	*	*	*	*	*
		1973500-R	ASC-29160/FSC4 RoHS SCSI CARD	*	*	*	*	*	*	*
		1983800-R	ASC-29160LP/FSC RoHS HST ADAPTER	*	*	*	*	*	*	*
		1991300-R	ABM-400 RoHS RAID MODULE	*	*	*	*	*	*	*
		1993500EU	CD ASSY,ASR U320/EFIGS v1.0 GD	*	*	*	*	*	*	*
		2001406-00PT/B	PCA, ASR-3225S	*	*	*	*	*	*	*
		2004806-01	PCA, ASC-39320D/HPQ NF	*	*	*	*	*	*	*
		2013500EU	CD ASSY, ASR-201xS GUIDE/EU	*	*	*	*	*	*	*
		2013500JA	CD ASSY, ASR-201XS GUIDE/JA	*	*	*	*	*	*	*
		2014406-00	PCA, AAR-1210SA	*	*	*	*	*	*	*
		2020200	CD ASSY, U320 SCSI/HSTRD/GD	*	*	*	*	*	*	*
		2020200EU	CD ASSY, U320/EU SCSI/HSTRD/GD	*	*	*	*	*	*	*

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		2020200JA	CD ASSY, U320/JA SCSI/HSTRD/GD	*	*	*	*	*	*	*
		2032400	ASR-3225S/128MB-B RAID CONT	*	*	*	*	*	*	*
		2032600	ASR-3225S/256MB-B RAID CONT	*	*	*	*	*	*	*
		2041406-00	PCA, ASC-29320A	*	*	*	*	*	*	*
		2041406-01	PCA, ASC-29320A/FUJITSU	*	*	*	*	*	*	*
		2041506-00	PCA, ASC-29320ALP	*	*	*	*	*	*	*
		2041506-01	PCA, ASC-29320ALP FMS	*	*	*	*	*	*	*
		2041506-02	PCA, ASC-29320ALP/NEC	*	*	*	*	*	*	*
		2041506-03	PCA, ASC-29320ALP/STR	*	*	*	*	*	*	*
		2044900	CD ASSY, AAR-1200A v1.3 & GD	*	*	*	*	*	*	*
		2044900EU	CD ASSY, 1200A/EU v1.3 & GD	*	*	*	*	*	*	*
		2044900JA	CD ASSY, 1200A/JA v1.3 & GD	*	*	*	*	*	*	*
		2047300-R	ASR-2120S/64/HPWS RoHS RD CONT	*	*	*	*	*	*	*
		2059600-R	ASR-2120S/64/HTCHI RoHS RD CON	*	*	*	*	*	*	*
		2064306-71	PCA, ASR-2020S/128MB IBM WS RE	*	*	*	*	*	*	*
		2064306-72	PCA, ASR-2020S/128MB IBM WS -2	*	*	*	*	*	*	*
		2065106-00	PCA, ASR-3225S RESPIN	*	*	*	*	*	*	*
		2066400-E	ASR-3225S/128MB-B RAID RoHSE	*	*	*	*	*	*	*
		2069906-20	PCA, 2410SA/64MB/100/W/LED CON	*	*	*	*	*	*	*
		2071406-00	PCA, ASC-39320A	*	*	*	*	*	*	*
		2071406-01	PCA, ASC-39320A/DELL	*	*	*	*	*	*	*
		2071406-02	PCA, ASC-39320A/DELL FMS	*	*	*	*	*	*	*
		2071406-03	PCA, ASC-39320A/DELL RoHS	*	*	*	*	*	*	*
		2071406-04	PCA, ASC-39320A/DELL RoHS FMS	*	*	*	*	*	*	*
		2071606-00	PCA, ASR-2230SLP/128MB	*	*	*	*	*	*	*
		2071606-20	PCA, ASR-2230SLP/256MB	*	*	*	*	*	*	*
		2071606-40	PCA, ASR-2130SLP/128MB	*	*	*	*	*	*	*
		2071606-60	PCA, ASR-2130SLP/256MB	*	*	*	*	*	*	*
		2071700-R	ASC-39320A RoHS SCSI CARD	*	*	*	*	*	*	*
		2071906-00	PCA, GDT8123RZ	*	*	*	*	*	*	*
		2071906-10	PCA, GDT8523RZ	*	*	*	*	*	*	*
		2071906-20	PCA, GDT8623RZ	*	*	*	*	*	*	*
		2071906-30	PCA, SRCU32U - BISBEE	*	*	*	*	*	*	*
		2072100-R	ASC-29320A RoHS SCSI CARD	*	*	*	*	*	*	*
		2072200-R	ASC-29320ALP RoHS SCSI CARD	*	*	*	*	*	*	*
		2072406-00	PCA, GDT8500RZ	*	*	*	*	*	*	*
		2072406-10	PCA, SRCZCR - CALDWELL	*	*	*	*	*	*	*
		2072606-00	PCA, GDT8114RZ	*	*	*	*	*	*	*
		2072606-10	PCA, GDT8514RZ	*	*	*	*	*	*	*
		2072606-11	PCA, GDT8514RZ RoHS (-10)	*	*	*	*	*	*	*
		2072606-20	PCA, SRCU42L - CHILITO	*	*	*	*	*	*	*
		2073006-00	PCA, GDT8124RZ	*	*	*	*	*	*	*
		2073006-20	PCA, GDT8524RZ	*	*	*	*	*	*	*
		2073006-30	PCA, GDT8524RZ+	*	*	*	*	*	*	*
		2073106-00	PCA, GDT8543RZ	*	*	*	*	*	*	*
		2073106-10	PCA, GDT8643RZ	*	*	*	*	*	*	*
		2073206-00	PCA, PATA-TO-SATA CONVERTER	*	*	*	*	*	*	*
		2073306-00	PCA, GDT8522RZ	*	*	*	*	*	*	*
		2073306-10	PCA, GDT8622RZ	*	*	*	*	*	*	*
		2073406-00	PCA, GDT8546RZ	*	*	*	*	*	*	*
		2073406-10	PCA, SRCS14L - TAFT	*	*	*	*	*	*	*
		2073606-00	PCA, INT LVDS SE TERM CARD	*	*	*	*	*	*	*

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		2073706-00	PCA, SCSI BRACKET CARD	*	*	*	*	*	*	*
		2073806-00	PCA, ICP ELEV CONN CARD BLUE	*	*	*	*	*	*	*
		2073806-10	PCA, ICP ELEV CONN CARD GREEN	*	*	*	*	*	*	*
		2079206-00	PCA, ASR-2020ZCR/64MB	*	*	*	*	*	*	*
		2079206-32	PCA, ASR-2020ZCR-B/64MB/HIT	*	*	*	*	*	*	*
		2079206-40	PCA, ASR-2020ZCR-B/128MB	*	*	*	*	*	*	*
		2079206-50	PCA, ASR-2020ZCR-B/128/FSC	*	*	*	*	*	*	*
		2080000-00	GAL, ICP RAIDYNE	*	*	*	*	*	*	*
		2080200-R	ICP GDT8546RZ RoHS RAID CONT	*	*	*	*	*	*	*
		2080406-00	PCA, GDT8586RZ	*	*	*	*	*	*	*
		2083106-00	PCA, AAR-2610SA/64MB/HP	*	*	*	*	*	*	*
		2084300	AAR-2410SA/64MB W/LED RD CON	*	*	*	*	*	*	*
		2084500	AAR-2410SA/64MB/100 W/LED RC	*	*	*	*	*	*	*
		2084800	ICP SRCZCR RD CONT - CALDWELL	*	*	*	*	*	*	*
		2085400	AAR-2410SA W/LED PACK SUBASSY	*	*	*	*	*	*	*
		2085400EU	AAR-2410SA/EU W/LED PK SUBASSY	*	*	*	*	*	*	*
		2085400JA	AAR-2410SA/JA W/LED PK SUBASSY	*	*	*	*	*	*	*
		2089900-R	ICP GDT8114RZ RoHS RAID CNTRLR	*	*	*	*	*	*	*
		2090000-R	ICP GDT8514RZ RoHS RAID CNTRLR	*	*	*	*	*	*	*
		2091806-00	PCA, ICP FRU ADAPTER	*	*	*	*	*	*	*
		2095000	ICP BATTERY BACK UP ASSY (BUY)	*	*	*	*	*	*	*
		2103500-R	ASR-2020ZCR/64MB RoHS RD CNTRL	*	*	*	*	*	*	*
		2103700-R	ASR-2020ZCR/128M RoHS RD CNTRL	*	*	*	*	*	*	*
		2104100-R	ASC-39160 HP/GE HPSD RoHS H/A	*	*	*	*	*	*	*
		2127600-E	ASR-2020S/128-B IBM RD-2 RoHSE	*	*	*	*	*	*	*
		2137100-R	ASR-2025ZCR/64MB RoHS RD CNTRL	*	*	*	*	*	*	*
		2142306-01	PCA, ASC-29320ALP/KENDAL	*	*	*	*	*	*	*
		2142306-02	PCA, ASC-29320ALP CHNL	*	*	*	*	*	*	*
		2144400-R	ASC-29320ALP/NEC RoHS SCSI CRD	*	*	*	*	*	*	*
		2145000-R	ATB-100/256 IBM RD MODULE RoHS	*	*	*	*	*	*	*
		2149600-R	ASR-2230SLP/128 RoHS RD CNTRL	*	*	*	*	*	*	*
		2149800-R	ASR-2230SLP/256 RoHS RD CNTRL	*	*	*	*	*	*	*
		2150000-R	ASR-2130SLP/128 RoHS RD CNTRL	*	*	*	*	*	*	*
		2150200-R	ASC-29320A/FJTSU RoHS SCSI CRD	*	*	*	*	*	*	*
		2164306-00-A	PCA, ICP9014RO/256MB	*	*	*	*	*	*	*
		2164306-10-A	PCA, ICP9024RO/256MB	*	*	*	*	*	*	*
		2167200-R	ASC-29320ALP KNDL RoHS CRD HI	*	*	*	*	*	*	*
		2167300-R	ASC-29320ALP KNDL RoHS CRD LO	*	*	*	*	*	*	*
		2170800-R	ASR-2130SLP/256 RoHS RD CNTRL	*	*	*	*	*	*	*
		2178300-R	ASR-2120S/64MB RoHS RAID CNTRL	*	*	*	*	*	*	*
		2179800-R	ASC-29320ALP SCSI CRD RoHSCHNL	*	*	*	*	*	*	*
		2180500-R	ASC-48300 I2C RoHS HostRD CRD	*	*	*	*	*	*	*
		2180600-R	ICP9014RO/256 RoHS RAID CNTRL	*	*	*	*	*	*	*
		2180700-R	ICP9024RO/256 RoHS RAID CNTRL	*	*	*	*	*	*	*
		2197100-R	ASR-2025ZCR/64/HIT RoHS RAID C	*	*	*	*	*	*	*
		2197300-R	ASR-2020ZCR/64/HIT RoHS RAID C	*	*	*	*	*	*	*
		2208500-R	ASC-29160LP/NEC RoHS HST ADPTR	*	*	*	*	*	*	*
		2224300-R	ASC-44300 RoHS HostRD CRD	*	*	*	*	*	*	*
		39J0456	ZENITH-R PCA ASSY (OMAHA)	*	*	*	*	*	*	*
		513768-00	ERRATA, SRCU42L C19624-001	*	*	*	*	*	*	*
		916506-02	PCA, AHA-2940U/JA	*	*	*	*	*	*	*
		917306-08	PCA, AHA-2940UWS4	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		917306-44	PCA, AHA-2940UW/S1.32	*	*	*	*	*	*	*
		917306-58	PCA, AHA-2940UW/99	*	*	*	*	*	*	*
		917306-59	PCA, AHA-2940UW/NEC	*	*	*	*	*	*	*
		967106-00	PCA, AHA-2940AU	*	*	*	*	*	*	*
		97P6098	DOUBLOON PCA ASSY (OMAHA)	*	*	*	*	*	*	*
		991506-00	PCA, AHA-2944UW	*	*	*	*	*	*	*
		991506-10	PCA, AHA-2944UW/FUJITSU	*	*	*	*	*	*	*
		BM-1035-04-1D	SX4055U2-2 BOM	*	*	*	*	*	*	*
		BM-1035-05-2B	SX4055U2-2 BOM	*	*	*	*	*	*	*
		BM-1035-05-3A	SX4055U2-2 BOM (1080-ES2)	*	*	*	*	*	*	*
		BM-1037-05-2A	SX4055U2-2 BOM (COMPAQ)	*	*	*	*	*	*	*
		BM-1040-05-1C	BB4050 BOM (TANTALUM)	*	*	*	*	*	*	*
		BM-1040-05-2D	BB4050 BOM	*	*	*	*	*	*	*
		BM-1050-06-3C	PM3755U2B BOM	*	*	*	*	*	*	*
		BM-1050-06-6A	PM3755U2B BOM (1080-ES3)	*	*	*	*	*	*	*
		BM-1050-06-6B	PM3755U2B BOM (1080-ES3)	*	*	*	*	*	*	*
		BM-1051-06-2A	PM3755U2B BOM (COMPAQ) UNIQUE	*	*	*	*	*	*	*
		BM-1051-06-2B	PM3755U2B BOM (COMPAQ) UNIQUE	*	*	*	*	*	*	*
		BM-1060-01-2A	DM4050-16 BOM	*	*	*	*	*	*	*
		BM-1065-01-2A	DM4050-64 BOM	*	*	*	*	*	*	*
		BM-1185-01-2A	ABM-100 BOM	*	*	*	*	*	*	*
		BM-1230-03-1D	PM3757U2 UART BOM	*	*	*	*	*	*	*
		BM-1260-01-1C	DM4070-64 BOM	*	*	*	*	*	*	*
		BM-1270-01-1B	DM4070-32 BOM	*	*	*	*	*	*	*
		BM-1290-03-3A	ASR-3200S BOM	*	*	*	*	*	*	*
		BM-1320-02-2B	ASR-2100S BOM	*	*	*	*	*	*	*
		BM-1320-02-3A	ASR-2100S BOM	*	*	*	*	*	*	*
		HA-1050-05-1E	PM3755U2B H/W ASSY	*	*	*	*	*	*	*
		HA-1050-06-3C	PM3755U2B H/W ASSY 1080-ES2	*	*	*	*	*	*	*
		PAK-00195-01-A	SLV, ICP90X4RO KIT	*	*	*	*	*	*	*
		PCA-00193-01-B	ICP5085BR (MARAUDER-E)	*	*	*	*	*	*	*
		TA-0945-BUL	PM3334UW + SX4030/1UW	*	*	*	*	*	*	*
		TA-1011-STR	PM3334UW+SM4000/4+SX4030/2W	*	*	*	*	*	*	*
		TA-1242-ACE	ADAPTEC BATTERY MODULE 100 KIT	*	*	*	*	*	*	*
		TCA-00168-42-C	ICP9087MA/256MB+BBU ALRM RoHS	*	*	*	*	*	*	*
		UD-0030-01A	SCSI RAID FAM SW (CD) COMPAQ	*	*	*	*	*	*	*
402	FINC	756114	AIC-8110X REV B0 (4 PORT)	*	*	*	*	*	*	*
		756511	AIC-6350TR REV D	*	*	*	*	*	*	*
		756611	AIC-7865T REV C	*	*	*	*	*	*	*
		756918	AIC-8120X REV B2 (8 PORT)	*	*	*	*	*	*	*
		757211	AIC-8210W REV A	*	*	*	*	*	*	*
		758014	AIC-8130H REV C (4 PORT)	*	*	*	*	*	*	*
		758024	AIC-8130HR REV C (4 PORT)	*	*	*	*	*	*	*
		758318	AIC-8140H REV B2 (8 PORT)	*	*	*	*	*	*	*
		759111	AIC-8210W REV A1	*	*	*	*	*	*	*
		759112	AIC-8210WR REV A1	*	*	*	*	*	*	*
	RAWB	1496242-00	BRACKET, AAR-2410SA LP LOW	*	*	*	*	*	*	*
		1497681-00	LABEL, PCA VERSION "-80"	*	*	*	*	*	*	*
		17160	CONN, 7P SATA M RA SHRD BLK SM	*	*	*	*	*	*	*
		17161	CONN, 7P SATA M RA SHRD BLU SM	*	*	*	*	*	*	*
		17215	IC, PM8380 SATA/SAS MX/DMX BGA	*	*	*	*	*	*	*
		2129707-00	PCB, AAR-2820SA	*	*	*	*	*	*	*

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		2141207-00	PCB, AAR-1420SA	*	*	*	*	*	*	*
		2158000UN	CD ASSY, SCSI/SATA 2.0zi GD/UN	*	*	*	*	*	*	*
		513943-00	LBL, AAR-2020SA PCBA	*	*	*	*	*	*	*
		513945-00	SLV/BOX, AAR-21610SA KIT	*	*	*	*	*	*	*
		513945-00EU	SLV, AAR-21610SA/EU KIT	*	*	*	*	*	*	*
		513945-00JA	SLV/BOX, AAR-21610SA/JA KIT	*	*	*	*	*	*	*
		513946-00	SLV/BOX, AAR-2810SA KIT	*	*	*	*	*	*	*
		513946-00EU	SLV, AAR-2810SA/EU KIT	*	*	*	*	*	*	*
		513946-00JA	SLV/BOX, AAR-2810SA/JA KIT	*	*	*	*	*	*	*
		513947-00	SLV, AAR-2020SA KIT	*	*	*	*	*	*	*
		513976-03EU	GUIDE, SCSI/SATA/EU S/T/L QKIN	*	*	*	*	*	*	*
		513987-00	LBL, ASR-2025ZCR SA TO ZCR LBL	*	*	*	*	*	*	*
		CDA-00016-01JA-A	CD ASSY,SCSI/SATA/JA S/T/Lv2.0	*	*	*	*	*	*	*
		CDA-00027-01JA-A	CD ASSY, 1420SA/JA 2.12 DR/ASM	*	*	*	*	*	*	*
		CON-00174-01-A	RECEPT,SATA,22PIN,R/A,SMD	*	*	*	*	*	*	*
		ICS-00227-01-A	SS1200, SATA2 MUX, A-A, BGA161	*	*	*	*	*	*	*
		LBL-00092-01-A	LBL, AAR-2610SA/HP -A PCA LBL	*	*	*	*	*	*	*
		LBL-00111-01-A	AAR-2420SA PCBA	*	*	*	*	*	*	*
		LBL-00112-01-A	AAR-2620SA PCBA	*	*	*	*	*	*	*
		MAN-00045-01-A	GUIDE, AAR-1420SA QUICK INSTAL	*	*	*	*	*	*	*
		MAN-00045-01EU-A	GUIDE, AAR-1420SA/EU QK INSTL	*	*	*	*	*	*	*
		MAN-00045-01JA-A	GUIDE, AAR-1420SA/JA QK INSTAL	*	*	*	*	*	*	*
		MAN-00063-01-A	GUIDE, SATA/SCSI RD QKINSTL HD	*	*	*	*	*	*	*
		MAN-00063-01JA-A	GUIDE, SATA/SCSI RD QIG/JA HD	*	*	*	*	*	*	*
		PAK-00197-01-A	SLV, AAR-1420SA KIT	*	*	*	*	*	*	*
		PAK-00197-01EU-A	SLV, AAR-1420SA/EU KIT	*	*	*	*	*	*	*
		PAK-00197-01JA-A	SLV, AAR-1420SA/JA KIT	*	*	*	*	*	*	*
		PAK-00207-01-A	SLV, AAR-2025SA KIT	*	*	*	*	*	*	*
		PAK-00209-01-A	CLAMSHELL, AAR-2X20SA	*	*	*	*	*	*	*
		PAK-00245-01-A	SLV, AAR-2820SA KIT	*	*	*	*	*	*	*
		PCB-00182-01-A	MSTR FILE, ACTV-ACTV SATA MUX	*	*	*	*	*	*	*
		PCB-00229-01-A	MSTR FILE, AAR-2420SA/HP	*	*	*	*	*	*	*
	RAWB			*	*	*	*	*	*	*
	Total									
	WIPB	1967006-10	PCA, AAR-2025SA/64MB PCI	*	*	*	*	*	*	*
		2042506-00	PCA, AAR-1210SA RESPIN	*	*	*	*	*	*	*
		2048700	AAR-2410SA/64MB RAID CONTRL	*	*	*	*	*	*	*
		2050606-00	PCA, AAR-2810SA/64MB	*	*	*	*	*	*	*
		2050606-02	PCA, AAR-2810SA/64MB	*	*	*	*	*	*	*
		2050606-40	PCA, AAR-21610SA/64MB	*	*	*	*	*	*	*
		2050606-42	PCA, AAR-21610SA/64MB	*	*	*	*	*	*	*
		2056706-04	PCA, AAR-2610SA/DELL4	*	*	*	*	*	*	*
		2056706-05	PCA, AAR-2610SA/DELL5	*	*	*	*	*	*	*
		2069906-00	PCA, AAR-2410SA/64MB W/LED CON	*	*	*	*	*	*	*
		2069906-02	PCA, AAR-2410SA/64MB/LED/IBM	*	*	*	*	*	*	*
		2069906-03	PCA, AAR-2410SA/64M W/LED CON	*	*	*	*	*	*	*
		2069906-05	PCA, 2410SA/64MB W/LED/HP	*	*	*	*	*	*	*
		2069906-06	PCA, 2410SA/64MB/HITACHI W/LED	*	*	*	*	*	*	*
		2069906-07	PCA, 2410SA/64M W/LED CON (US)	*	*	*	*	*	*	*
		2069906-08	PCA, 2410SALP/64MB/HP W/LED	*	*	*	*	*	*	*
		2079206-80	PCA, AAR-2020SA/64MB PCI	*	*	*	*	*	*	*
		2083500-R	AAR-2610SA/64/HP RoHS RD CNTR	*	*	*	*	*	*	*

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		2084300-R	AAR-2410SA/64 LED RoHS RD CON	*	*	*	*	*	*	*
		2124700-R	AAR-2020SA/64MB RoHS RAID CNTR	*	*	*	*	*	*	*
		2129706-37-D	PCA, AAR-2820SA/128+B ALM RoHS	*	*	*	*	*	*	*
		2141206-00	PCA, AAR-1420SA	*	*	*	*	*	*	*
		2141206-01	PCA, AAR-1420SA/HP	*	*	*	*	*	*	*
		2141206-03	PCA, AAR-1420SA/HP RoHS (-01)	*	*	*	*	*	*	*
		2147500-R	AAR-2410SA/64 W/LED/HP RoHS RD	*	*	*	*	*	*	*
		2156200-R	AAR-2410SA/64/HTCHI LEDRoHS RC	*	*	*	*	*	*	*
		2157400-R	AAR-2025SA/64M PCI RoHS RD CNT	*	*	*	*	*	*	*
		2178200-R	AAR-2410SA/64M W/LED RoHS RAID	*	*	*	*	*	*	*
		2184900-R	AAR-1420SA RoHS RAID CONTROL	*	*	*	*	*	*	*
		PCA-00229-01-A	AAR-2420SA/HP ROHS	*	*	*	*	*	*	*
		TCA-2129706-42-D	AAR-2820SA/256+BU ALRM RC RoHS	*	*	*	*	*	*	*
	WIPS	TCA-2129706-37-D	AAR-2820SA/128+BU ALRM RC RoHS	*	*	*	*	*	*	*
403	FINC	757311	AIC-9580F REV A	*	*	*	*	*	*	*
		757911	AIC-9410W REV B	*	*	*	*	*	*	*
		757912	AIC-9410WR REV B	*	*	*	*	*	*	*
		759011	AIC-9410W REV B1	*	*	*	*	*	*	*
		759012	AIC-9410WR REV B1	*	*	*	*	*	*	*
		759020	AIC-9405WR REV B1	*	*	*	*	*	*	*
	RAWB	14627	IC, L80220/H 100TX/10T PLCC	*	*	*	*	*	*	*
404	RAWB	1497354-00	BRACKET, ASC-48300 LP	*	*	*	*	*	*	*
		1497355-00	BRACKET, ASC-48300 FH	*	*	*	*	*	*	*
		1497391-00	CABLE, SAS EXT 4X 3.0G 1M	*	*	*	*	*	*	*
		1497392-00	CABLE, SAS EXT 4X 3.0G 2M	*	*	*	*	*	*	*
		1497393-00	(OBS)CABLE, SAS EXT 4X 3.0G 4M	*	*	*	*	*	*	*
		1497394-00	(OBS)CABLE, SAS EXT 4X 3.0G 8M	*	*	*	*	*	*	*
		1497395-00	CABLE, SAS 4X-4 1X 3.0G .5M	*	*	*	*	*	*	*
		1497396-00	CABLE, SAS 4X-4 1X 3.0G 1M	*	*	*	*	*	*	*
		1497397-00	CABLE, SAS 4X-4X 3.0G .5M	*	*	*	*	*	*	*
		1497398-00	CABLE, SAS 4X-4X 3.0G 1M	*	*	*	*	*	*	*
		1497620-00	SCD, 1800MAH LION CRU BAT ASSY	*	*	*	*	*	*	*
		1497665-00	CABLE, SAS EX 4X 3G 2M ST-THRU	*	*	*	*	*	*	*
		1497695-00	CABLE, SAS 4X-4 1X.5M ST-THRU	*	*	*	*	*	*	*
		1497776-00	CABLE, SAS 4X-4 1X 1M ST THRU	*	*	*	*	*	*	*
		2104007-00	PCB, ASC-48300	*	*	*	*	*	*	*
		2129407-00	PCB, ASR-4800SAS	*	*	*	*	*	*	*
		2129507-00	PCB, ASR-4805SAS	*	*	*	*	*	*	*
		513994-00	LBL, ASR-4005SAS IBM BATT FRU	*	*	*	*	*	*	*
		CDA-00026-01-A	CD ASSY, ASC-48300 v3 ASM	*	*	*	*	*	*	*
		CDA-00046-01-A	CD ASSY, SATA/SAS STG MGR v4GD	*	*	*	*	*	*	*
		CDA-00047-01-A	CD ASSY, SATA/SAS DRVR/DOC v4	*	*	*	*	*	*	*
		CON-00159-01-A	RECPT,SAS,RT ANGLE,8.22MM HIGH	*	*	*	*	*	*	*
		CON-00173-01-A	PLUG,SAS,29PIN,R/A,SMD	*	*	*	*	*	*	*
		CON-00178-01-A	RECEPT+SHELL, 1X INT MINI SAS	*	*	*	*	*	*	*
		CON-00179-01-A	RECEPTACLE,1X EXT MINI SAS,26P	*	*	*	*	*	*	*
		CON-00187-01-A	GUIDE CAGE,2X EXT MINI SAS	*	*	*	*	*	*	*
		CON-00187-02-A	GUIDE CAGE,2X EXT MINI SAS,UNI	*	*	*	*	*	*	*
		CON-00188-04-A	GUIDE CAGE,1X EXT SAS UNI	*	*	*	*	*	*	*
		CON-00192-01-A	RECPT,SAS,29PIN,VERT,SMD	*	*	*	*	*	*	*
		CON-00193-01-A	GUIDE CAGE,4X EXT PCI SAS UNI	*	*	*	*	*	*	*
		ICS-00192-01-A	VSC7153 SAS XPNDR 24 PORT SBGA	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		ICS-00199-01-A	PM8388 SAS EDGE EXP,24PORT,3G	*	*	*	*	*	*	*
		LBL-00163-01-A	LBL, ASR-4005SAS IBM 2AHBATFRU	*	*	*	*	*	*	*
		MAN-00053-01-A	FLYER, ASC-48300 CABLES	*	*	*	*	*	*	*
		MAN-00058-01-A	GUIDE, ASC-48300 QUICK INSTALL	*	*	*	*	*	*	*
		PAK-00196-01-A	SLV, ASC-48300 KIT	*	*	*	*	*	*	*
		PAK-00256-01JA-A	SLV, ASR-4800SAS/JA KIT	*	*	*	*	*	*	*
		PAK-00257-01JA-A	SLV, ASR-4805SAS/JA KIT	*	*	*	*	*	*	*
		PCB-00175-01-A	MSTR FILE, ASR-4805SAS RESPIN	*	*	*	*	*	*	*
		PCB-00175-01-B	MSTR FILE, ASR-4805SAS RESPIN	*	*	*	*	*	*	*
		PCB-00194-01-A	MSTR FILE, SAS-DE-MUX CARD	*	*	*	*	*	*	*
		PCB-00226-01-A	MSTR FILE, ASC-58300	*	*	*	*	*	*	*
	WIPB	1967006-03	PCA, ASR-2025ZCR/64MB/HIT	*	*	*	*	*	*	*
		2104006-00	PCA, ASC-48300	*	*	*	*	*	*	*
		2104006-00PT/A	PCA, ASC-48300	*	*	*	*	*	*	*
		2129406-01-D	PCA, ASR-4800SAS (I2C)	*	*	*	*	*	*	*
		2137300	ASR-4000SAS KIT	*	*	*	*	*	*	*
		2137300EU	ASR-4000SAS/EFIGS KIT	*	*	*	*	*	*	*
		2137300JA	ASR-4000SAS/JA KIT	*	*	*	*	*	*	*
		2137400	ASR-4000SAS 50-PK	*	*	*	*	*	*	*
		2138306-00	PCA, ASR-4005SAS/256MB	*	*	*	*	*	*	*
		ASM-00498-01-A	ASR-4005SAS/256-B PIV RoHSE RC	*	*	*	*	*	*	*
		ASM-00498-03-A	ASR-4005SAS/256-B 3U RoHSE RC	*	*	*	*	*	*	*
		PCA-00115-01-C	ALTEVO SAS MIDPLANE	*	*	*	*	*	*	*
		PCA-00142-01-C	MIDWAY SAS RAID CNTRLR (ENZO)	*	*	*	*	*	*	*
		PCA-00175-01-B	ASR-4805SAS I2C RESPIN	*	*	*	*	*	*	*
		TCA-00167-01-B	SAS 24port JBOD IO, TESTED	*	*	*	*	*	*	*
405	FINC	755311	AIC-7211W REV A2	*	*	*	*	*	*	*
		757111	AIC-7220W REV A1 (w/o IP SEC)	*	*	*	*	*	*	*
	RAWB	PAK-00255-01-A	CLAMSHELL, ASR480XSAS/ICPX085	*	*	*	*	*	*	*
406	RAWB	1492794-00	BRACKET, AEA-7110C	*	*	*	*	*	*	*
		1495989-00	BOX,17.95"X12.36"X8.58" MASTER	*	*	*	*	*	*	*
		1495991-00	BOX, 11.65"X7.64"X1.54" KRAFT	*	*	*	*	*	*	*
		1497789-00	BRACKET, VEGA II Cu FH 1 CH	*	*	*	*	*	*	*
		1497791-00	BRACKET, VEGA II Cu FH 2 CH	*	*	*	*	*	*	*
		1497793-00	BRACKET, VEGA II OP FH 1 CH	*	*	*	*	*	*	*
		1497795-00	BRACKET, VEGA II OP FH 2 CH	*	*	*	*	*	*	*
		15501	LED, GRN DUAL RA .1/3 2MA T1	*	*	*	*	*	*	*
		15642	RES, CHIP 5.1K 5% 1/16W 0603	*	*	*	*	*	*	*
		15661	IC, 1MX16X4 SDRAM 133M 7E TSOP	*	*	*	*	*	*	*
		15681	RES, CHIP 9.31K 1% 1/16W 0603	*	*	*	*	*	*	*
		15682	RES, CHIP 324 1% 1/16W 0603	*	*	*	*	*	*	*
		15815	RES, CHIP 47.5 1% 1/16W 0603	*	*	*	*	*	*	*
		15846	RES, CHIP 191K 1% 1/10W 0805	*	*	*	*	*	*	*
		15877	IC, 80312 I/O COMPANION HLPBGA	*	*	*	*	*	*	*
		15987	CAP, CHIP 20PF 50V NPO 0603	*	*	*	*	*	*	*
		16033	RES NTWK, CHIP 8X22 5% 3816	*	*	*	*	*	*	*
		16042	IC, 80200 I/O PROCSR 400M PBGA	*	*	*	*	*	*	*
		16043	OSC, 66.666MHZ 3.3V TS 7050	*	*	*	*	*	*	*
		16045	MOD, 2X5 GB OPT XCVR SFF SW LC	*	*	*	*	*	*	*
		16054	RES, CHIP 56K 5% 1/16W 0603	*	*	*	*	*	*	*
		16081	IC, 88E1011S GIG PHY SRDS FBGA	*	*	*	*	*	*	*
		16088	RES, CHIP 71.5K 1% 1/10W 0805	*	*	*	*	*	*	*

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		16120	RES, CHIP 3.83K 1% 1/16W 0402	*	*	*	*	*	*	*
		16121	RES, CHIP 49.9 1% 1/16W 0402	*	*	*	*	*	*	*
		16129	RES, CHIP 10K 5% 1/16W 0402	*	*	*	*	*	*	*
		16134	RES, CHIP 24 5% 1/16W 0402	*	*	*	*	*	*	*
		16135	RES, CHIP 27 5% 1/16W 0402	*	*	*	*	*	*	*
		16137	RES, CHIP 47K 5% 1/16W 0402	*	*	*	*	*	*	*
		16152	CONN, RJ45 8P GB W/MAG SHIELD	*	*	*	*	*	*	*
		16279	RES, CHIP 45.3 1% 1/16W 0603	*	*	*	*	*	*	*
		16417	IC, CY22381 3PLL P CLK GEN SO	*	*	*	*	*	*	*
		16524	IC, 74ALVCH16373 16 LTCH TSSOP	*	*	*	*	*	*	*
		16539	RES, CHIP 15.0K 1% 1/16W 0603	*	*	*	*	*	*	*
		16540	CAP, CHIP 68PF 50V NPO 0603	*	*	*	*	*	*	*
		16544	IC, MAX3232 250KB 2RS232 TSSOP	*	*	*	*	*	*	*
		16548	DIO, STPS1L30 20V1A .3V SB SMA	*	*	*	*	*	*	*
		16551	CONN, RJ45 8P GB W/MAG TAB UP	*	*	*	*	*	*	*
		16570	IC, 24C04 4K SER EEPROM DIP	*	*	*	*	*	*	*
		16572	RES, CHIP 120 5% 1/16W 0402	*	*	*	*	*	*	*
		16622	RES, CHIP 56 5% 1/16W 0402	*	*	*	*	*	*	*
		16633	CONN, 1X7X.1" M FRCTN-LOCK PTH	*	*	*	*	*	*	*
		16693	RES, CHIP 4.7 5% 1/16W 0603	*	*	*	*	*	*	*
		16805	IC, 74ALVC04 HEX INVRTR TSSOP	*	*	*	*	*	*	*
		16810	CAP, CHIP 1UF 6.3V X5R 0402	*	*	*	*	*	*	*
		16812	TRANS, FDT439 NMOSFET 2.5V SOT	*	*	*	*	*	*	*
		16813	RES, CHIP 47.5 1% 1/16W 0402	*	*	*	*	*	*	*
		16814	RES, CHIP 2.26K 1% 1/16W 0603	*	*	*	*	*	*	*
		16827	CONN, 2XRJ45 GBE CICADA G/Y+G	*	*	*	*	*	*	*
		16844	IC, LT1767 SW REG SD 1.5A MSOP	*	*	*	*	*	*	*
		16861	RES, CHIP 820 5% 1/16W 0603	*	*	*	*	*	*	*
		16896	IC, TPS64202 VR SW SD ADJ SOT	*	*	*	*	*	*	*
		16897	CAP, CHIP 82PF 50V NPO 0603	*	*	*	*	*	*	*
		16898	RES, CHIP 0.033 1% 1/4W 1206	*	*	*	*	*	*	*
		16899	RES, CHIP 680K 1% 1/16W 0603	*	*	*	*	*	*	*
		16900	RES, CHIP 300K 1% 1/16W 0603	*	*	*	*	*	*	*
		16901	RES, CHIP 665K 1% 1/16W 0603	*	*	*	*	*	*	*
		16902	RES, CHIP 470K 1% 1/16W 0603	*	*	*	*	*	*	*
		16903	RES, CHIP 2.2M 1% 1/16W 0603	*	*	*	*	*	*	*
		16906	XTAL, 25MHZ 15/30PPM 18PF 7050	*	*	*	*	*	*	*
		16922	CONN, 2X26X.025X3 M STRDLMT SM	*	*	*	*	*	*	*
		16926	IC, 74LVC2G14 INV SCHMT 2X SOT	*	*	*	*	*	*	*
		16927	TRANS, BCP69 PNP PWR L-HFE SOT	*	*	*	*	*	*	*
		16928	TRANS, BCP69-16 PNP M-HFE SOT	*	*	*	*	*	*	*
		16933	CONN, SFP CAGE 15PIN 3CLIP PTH	*	*	*	*	*	*	*
		16935	OSC, 106.25MHZ 50PPM 3.3V 7050	*	*	*	*	*	*	*
		16937	FERRITE, CHIP Z1K .1A GHZ 0603	*	*	*	*	*	*	*
		16938	FERRITE, CHIP Z1K .5A GHZ 0805	*	*	*	*	*	*	*
		16944	BOX, CODING PCB/BACKPLANE PTH	*	*	*	*	*	*	*
		16945	KEY, CODING BLACK 8 SETTINGS	*	*	*	*	*	*	*
		16955	IC, 512KX18 SSRAM 6.5NS TQFP	*	*	*	*	*	*	*
		16956	FERRITE, CHIP Z100 3A 1206	*	*	*	*	*	*	*
		16957	CAP, CHIP 220UF16V TA LE 7343H	*	*	*	*	*	*	*
		16965	IC, 88E1111 GBE PHY XCVR TFBGA	*	*	*	*	*	*	*
		16966	IC, ISP2312 FC>PCIA CTRLR PBGA	*	*	*	*	*	*	*

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		16967	CONN, RJ45 8P GBE GRN+YEL LED	*	*	*	*	*	*	*
		16970	STANDOFF, SS 4.5MM HEX M3X6MM	*	*	*	*	*	*	*
		17008	IC, LC4064V CPLD 3.3V 7.5 TQFP	*	*	*	*	*	*	*
		17012	OSC, 18.432MHZ 3.3V TS 7550	*	*	*	*	*	*	*
		17027	DIMM, 128MX72 DDR PC2100 1.25H	*	*	*	*	*	*	*
		17030	CONN, 2X5X3MM M VERT BATTERY TH	*	*	*	*	*	*	*
		17047	IC, LD29300 1.8V3A LDOVR P2PK5	*	*	*	*	*	*	*
		17048	IC, 28F640J3C FLASH 120NS TSOP	*	*	*	*	*	*	*
		513403-00	SLV, ASA-7211F KIT	*	*	*	*	*	*	*
		513403-00JA	SLV, ASA-7211F/JA KIT	*	*	*	*	*	*	*
		513404-00	SLV, ASA-7211C KIT	*	*	*	*	*	*	*
		513404-00JA	SLV, ASA-7211C/JA KIT	*	*	*	*	*	*	*
		513593-00	FLYER, ASA-7211 CABLES	*	*	*	*	*	*	*
	WIPB	1944806-00	PCA, ASA-7211C	*	*	*	*	*	*	*
		1944806-01	PCA, ASA-7211F	*	*	*	*	*	*	*
407	RAWB	1491640-00	DISK ASSY, EZSCSI v5.0d	*	*	*	*	*	*	*
		1491640-00JA	DISK ASSY, EZSCSI/JA 5.0d/J	*	*	*	*	*	*	*
		1491644-00JA	DISK ASSY, EZSCSI DE/JA v5.01J	*	*	*	*	*	*	*
		1491645-00JA	DISK ASSY,EZ/JAPCAT/NECv5.0d/J	*	*	*	*	*	*	*
		1491648-00FR	DISK ASSY, EZSCSI/FR v5.0a	*	*	*	*	*	*	*
		1491648-00GE	DISK ASSY, EZSCSI/GE v5.0a	*	*	*	*	*	*	*
		1491648-00IT	DISK ASSY, EZSCSI/IT v5.0a	*	*	*	*	*	*	*
		1491892-00EU	DISK, EZSCSI/EU 5.0dd 95/98/NT	*	*	*	*	*	*	*
		1496829-00	BAG, 6" X 8" ZIPLOCK	*	*	*	*	*	*	*
		1807900	MEDIA PAK, EZ 5.0C/FMS 3.01S13	*	*	*	*	*	*	*
		2041707-00	PCB, ATB-100 GREEN	*	*	*	*	*	*	*
		494045-00IT	SCD, IT S/W POLYBAG w/NOTICE	*	*	*	*	*	*	*
		510968-00	GUIDE, EZSCSI v4.0 QCK REF OEM	*	*	*	*	*	*	*
		511595-00	CARD, SPG KIT GENERIC REG	*	*	*	*	*	*	*
		511619-00	SLEEVE, EZ-SCSI v5.0 S/W	*	*	*	*	*	*	*
		511619-00JA	SLV/BOX, EZSCSI/JA v5.0J KIT	*	*	*	*	*	*	*
		511623-00	GUIDE, EZ-SCSI v5.0 QUICK REF	*	*	*	*	*	*	*
		511689-00	GUIDE, EZSCSI v5.0 USER'S(BOM)	*	*	*	*	*	*	*
		511689-00GE	GUIDE, EZSCSI/GE 5.0 USER(BOM)	*	*	*	*	*	*	*
		511689-00JA	GUIDE, EZSCSI/JA5.0J USER(BOM)	*	*	*	*	*	*	*
		511846-00	CARD, EZ-SCSI v5.0 DISK REPLC	*	*	*	*	*	*	*
		511846-00JA	CARD, EZ-SCSI/JA 5.0J DISK RPL	*	*	*	*	*	*	*
		512438-03	GUIDE, EZ-SCSI v5.01 USER HRD	*	*	*	*	*	*	*
		512438-03JA	GUIDE, EZ-SCSI/JAv5.01J UG HRD	*	*	*	*	*	*	*
		512554-00JA	LBL, EZSCSI 5.01/JA CAUTION	*	*	*	*	*	*	*
	RAWS	513961-00	LBL, ATB-100 IBM BATTERY FRU	*	*	*	*	*	*	*
	WIPB	1693300	EZ-SCSI v5.0 CD-ROM ASSY	*	*	*	*	*	*	*
		1693300FR	EZ-SCSI/FR v5.0 CD-ROM ASSY	*	*	*	*	*	*	*
		1693300GE	EZ-SCSI/GE v5.0 CD-ROM ASSY	*	*	*	*	*	*	*
		1693300IT	EZ-SCSI/IT v5.0 CD-ROM ASSY	*	*	*	*	*	*	*
		1760000JA	EZ-SCSI/JA v5.0J CD-ROM ASSY	*	*	*	*	*	*	*
		1845000	CD ASSY, EZ-SCSI DE v5.01	*	*	*	*	*	*	*
		1845000JA	CD ASSY, EZ-SCSI DE/JA v5.01J	*	*	*	*	*	*	*
		1859300EU	CD ASSY, EZSCSI/EU v5.0 & USER	*	*	*	*	*	*	*
		2041706-21	PCA, ATB-100/256MB IBM	*	*	*	*	*	*	*
439	FINC	748211	AIC-6915P REV B	*	*	*	*	*	*	*
		748212	AIC-6915PR REV B	*	*	*	*	*	*	*

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	RAWB	10350	BAG, PLASTIC 5x8 (CLEAR)	*	*	*	*	*	*	*
		11254	SWITCH, 8-POS SPST DIP	*	*	*	*	*	*	*
		11622	CAP, 47UF 16V 20% AL ELEC RAD	*	*	*	*	*	*	*
		11916	CAP, 47UF 16V AL H5.0 RAD	*	*	*	*	*	*	*
		12522	RES, CHIP 15 5% 1/10W 0805	*	*	*	*	*	*	*
		12835	DIO, BAT54 SHTK BAR 30V.2A SOT	*	*	*	*	*	*	*
		12987	RES, CHIP 130 1% 1/10W 0805	*	*	*	*	*	*	*
		12989	RES, CHIP 332 1% 1/10W 0805	*	*	*	*	*	*	*
		12990	RES, CHIP 365 1% 1/10W 0805	*	*	*	*	*	*	*
		12991	RES, CHIP 634 1% 1/10W 0805	*	*	*	*	*	*	*
		12992	RES, CHIP 57.6 1% 1/10W 0805	*	*	*	*	*	*	*
		12994	FERRITE CHIP, EMI FLT Z47 3051	*	*	*	*	*	*	*
		12996	OSC, XTAL TTL CLK 25MHZ 1/2 3S	*	*	*	*	*	*	*
		12997	CONN, RJ45 8-PIN RA SHLD CAT 5	*	*	*	*	*	*	*
		12998	IC, CY7B951 CLK RCVRY SO-24	*	*	*	*	*	*	*
		13006	MODULE, OPTICAL 9-PIN ATM XCVR	*	*	*	*	*	*	*
		13044	RES, CHIP 4.02K 1% 1/10W 0805	*	*	*	*	*	*	*
		13046	RES, CHIP 8.06K 1% 1/10W 0805	*	*	*	*	*	*	*
		13103	RES, CHIP 49.9 1% 1/10W 0805	*	*	*	*	*	*	*
		13148-R	DIODE, SHTK BARR 20V 3A SMC	*	*	*	*	*	*	*
		13151	RES, CHIP 750 0.5% 1/10W 0805	*	*	*	*	*	*	*
		13153	IC, MAX857(SO.12)5V DC-DC CVTR	*	*	*	*	*	*	*
		13167	IC, MAX233(DIP20) 2xRS232 XCVR	*	*	*	*	*	*	*
		13279	RES, CHIP 27 5% 1/10W 0805	*	*	*	*	*	*	*
		13406	OSC, XTAL TTL CLK 25MHZ SOJ	*	*	*	*	*	*	*
		13429	RES, CHIP 1.5K 5% 1/10W 0805	*	*	*	*	*	*	*
		13433	RES, CHIP 412 1% 1/10W 0805	*	*	*	*	*	*	*
		13440	RES, CHIP 560 5% 1/10W 0805	*	*	*	*	*	*	*
		13496	DIODE, MBRS140T3 SB 1A 40V SMB	*	*	*	*	*	*	*
		13549	CAP, CHIP 27PF 50V NPO 0805	*	*	*	*	*	*	*
		13550	FERRITE CHIP, EMI FLT Z1K 0805	*	*	*	*	*	*	*
		13556	RES, CHIP 147 1% 1/10W 0805	*	*	*	*	*	*	*
		13610	RES, CHIP 511 1% 1/10W 0805	*	*	*	*	*	*	*
		13672	BRACKET, ANA-5945	*	*	*	*	*	*	*
		13674	IC, 29F080(TSOP1)FLASH 150NS	*	*	*	*	*	*	*
		13697	IC, 32KX32 SSRAM 1MB 10NS TQFP	*	*	*	*	*	*	*
		13698	IC, 74LCX245(SSOP)3V BUS XCVR	*	*	*	*	*	*	*
		13699	LED, GRN RA MT .200HT T1	*	*	*	*	*	*	*
		13709	IC, LM339(SO) QUAD COMPARATOR	*	*	*	*	*	*	*
		13735	RES NTWK, CHIP 4X51 5% 3216	*	*	*	*	*	*	*
		13736	RES NTWK, CHIP 2X51 5% 1616	*	*	*	*	*	*	*
		13743	CAP, CHIP 47UF 16V AL 636355	*	*	*	*	*	*	*
		13744	XFMR, PULSE 100UH 1:1:1 SM16	*	*	*	*	*	*	*
		13749	CAP, SPARK-GAP .75PF 1KV .25LS	*	*	*	*	*	*	*
		13750	LED, GRN(TOP)+YEL RA .1/3 T1	*	*	*	*	*	*	*
		13751	IC, PM7213 DC-DC 5V>9V DIP.6	*	*	*	*	*	*	*
		13752	IC, MC33269(SO)LDO VR 3.3	*	*	*	*	*	*	*
		13753	IC, 83C92 ETHERNET XCVR PLCC	*	*	*	*	*	*	*
		13757	SOCKET, 32-P DIP DUAL BEAM	*	*	*	*	*	*	*
		13759	CONN, BNC RA F PCB/PANEL 50OHM	*	*	*	*	*	*	*
		13760	CONN, RJ45 RA CAT5 UNSHLD	*	*	*	*	*	*	*
		13766	IC, 93C46(DIP) 1K SER EEPROM	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		13770	RES, CHIP 39.2 1% 1/10W 0805	*	*	*	*	*	*	*
		13773	RES, CHIP 806 1% 1/10W 0805	*	*	*	*	*	*	*
		13775	CAP: 0.022UF 10% 50V X7R 0805	*	*	*	*	*	*	*
		13805	RES, CHIP 78.7 1% 1/10W 0805	*	*	*	*	*	*	*
		13806	IC, 74FCT273T(SO) OCT D F/F	*	*	*	*	*	*	*
		13814	RES, CHIP 4.7 5% 1/10W 0805	*	*	*	*	*	*	*
		13822	CAP: 1500PF 10% 50V X7R 0805	*	*	*	*	*	*	*
		13836	XTAL, 32.768KHZ WATCH SMD8737	*	*	*	*	*	*	*
		13854	RES, CHIP 2.37K 1% 1/10W 0805	*	*	*	*	*	*	*
		13866	RES, CHIP 24.9 1% 1/10W 0805	*	*	*	*	*	*	*
		13881	IC, DP83223(PLCC)100BASE XCVR	*	*	*	*	*	*	*
		13892	IC, DP83840A PHY 10/100 PQFP	*	*	*	*	*	*	*
		13920	CAP, CHIP 36PF 50V NPO 0805	*	*	*	*	*	*	*
		13922	RES, CHIP 10 1% 1/10W 0805	*	*	*	*	*	*	*
		13923	RES, CHIP 10.5 1% 1/10W 0805	*	*	*	*	*	*	*
		13925	OSC, XTAL TTL CLK 20MHZ HS 50P	*	*	*	*	*	*	*
		13927	RES, CHIP 48.7 1% 1/10W 0805	*	*	*	*	*	*	*
		13929	XFMR, 10/100BASE-T 83840 SM16	*	*	*	*	*	*	*
		13954	LED, GRN RA MT .2HT T1 1MA	*	*	*	*	*	*	*
		13955	LED, YEL RA MT .2HT T1 2MA	*	*	*	*	*	*	*
		13956	CAP, CHIP 1000PF 1KV X7R 1812	*	*	*	*	*	*	*
		13957	CAP, CHIP .01UF 1KV X7R 1812	*	*	*	*	*	*	*
		13986	IC, 93C46 1K 64X16 SEEPROM SO	*	*	*	*	*	*	*
		14002	BRACKET, ANA-6911A PLAN C CMBO	*	*	*	*	*	*	*
		14003	BRACKET, ANA-6911A PLAN C	*	*	*	*	*	*	*
		14016	RES, CHIP 7.87 1% 1/10W 0805	*	*	*	*	*	*	*
		14032	RES, CHIP 16.9K 1% 1/16W 0603	*	*	*	*	*	*	*
		14034	OSC, XTAL CLK 16MHZ SOJ4 50PPM	*	*	*	*	*	*	*
		14035	OSC, XTAL CLK 19.44MHZ S0J4 50	*	*	*	*	*	*	*
		14089	IC, 64KX32 SSRAM 10NS TQFP	*	*	*	*	*	*	*
		14099	CONN, 15-PIN D-SUB RCPT RA	*	*	*	*	*	*	*
		14102	HEADER, 2-PIN SIP SHD .098" CS	*	*	*	*	*	*	*
		14103	SLIDE LATCH, METAL 1.72"X.144"	*	*	*	*	*	*	*
		14104	SCREW, SLIDE LATCH .172"X.421"	*	*	*	*	*	*	*
		14105	BRACKET, PCI 6911A AUI	*	*	*	*	*	*	*
		14111	IC, 74AC02(SO)QUAD 2-IN NOR	*	*	*	*	*	*	*
		14151	LED, Y/G(TOP)+YEL RA .1/3 T1	*	*	*	*	*	*	*
		14155	RES, CHIP 0.1 OHM 1% 1W 2512	*	*	*	*	*	*	*
		14164	RES, CHIP 560 5% 1/4W 1210	*	*	*	*	*	*	*
		14166	RES, CHIP 39K 5% 1/10W 0805	*	*	*	*	*	*	*
		14170	DIO, 5231B 5.1V .5W ZNR SOD123	*	*	*	*	*	*	*
		14173	DIO, 5234B 6.2V .5W ZNR SOD123	*	*	*	*	*	*	*
		14184	IC, 24C16(SO)16K 2.5 SER EEPROM	*	*	*	*	*	*	*
		14193	IC, UCC3916(SO) SCSI CKT PRTCT	*	*	*	*	*	*	*
		14200	CAP, CHIP 68UF 20V TANT 7343H	*	*	*	*	*	*	*
		14201	RES, CHIP 200 5% 1/10W 0805	*	*	*	*	*	*	*
		14204	CAP: 56PF 5% 50V NPO 0805	*	*	*	*	*	*	*
		14210	IND, CHIP .56UH 10% 0.4A 1008	*	*	*	*	*	*	*
		14255	XTAL, 12MHZ P-RES HC49SM	*	*	*	*	*	*	*
		14262	CONN, 8 POS HSSDC RCPT RA SMT	*	*	*	*	*	*	*
		14290	CAP, CHIP 22UF 35V TANT 7343H	*	*	*	*	*	*	*
		14298	CAP: 47PF 5% 50V NPO 0805	*	*	*	*	*	*	*

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		14323	CAP, CHIP .022UF 25V X7R 0603	*	*	*	*	*	*	*
		14331	RES, CHIP 3.9 5% 1/10W 0805	*	*	*	*	*	*	*
		14332	RES, CHIP 75 1% 1/10W 0805	*	*	*	*	*	*	*
		14334	FERRITE, CHIP Z26 0.5A 1206	*	*	*	*	*	*	*
		14336	IC, 74ACT04(SO) HEX INVERTER	*	*	*	*	*	*	*
		14339	RES NTWK, 9X2.7K 2% SIP10	*	*	*	*	*	*	*
		14341	RES NTWK, 5X200 2% SIP6	*	*	*	*	*	*	*
		14343	OSC, HCMOS CLK 20MHZ 50PPM FS	*	*	*	*	*	*	*
		14344	OSC, HCMOS CLK 25MHZ 50PPM FS	*	*	*	*	*	*	*
		14366	RES, CHIP 20 5% 1W 2512	*	*	*	*	*	*	*
		14388	RES, CHIP 15.0 1% 1/10W 0805	*	*	*	*	*	*	*
		14389	RES, CHIP 34.8 1% 1/10W 0805	*	*	*	*	*	*	*
		14390	MOD, MAG 100BASE-TX 80220 SM16	*	*	*	*	*	*	*
		14405	BAT, CF/LI BR1225 3V.048AH VMT	*	*	*	*	*	*	*
		14415	RES, CHIP 287 1% 1/16W 0603	*	*	*	*	*	*	*
		14416	IC, HDMP0451 PORT BYPASS PQFP	*	*	*	*	*	*	*
		14418	XTAL, 25MHZ P-RES 30PPM 49SM	*	*	*	*	*	*	*
		14423	IND, CHIP 4.7UH 10% 0.65A 4532	*	*	*	*	*	*	*
		14428	RES, CHIP .075 OHM 5% 1W 2512	*	*	*	*	*	*	*
		14489	TRANS, SI3441DV P-MOSFET TSOP6	*	*	*	*	*	*	*
		14494	LED, YEL(TOP)+YEL RA .1/3 T1	*	*	*	*	*	*	*
		14574	CAP, CHIP .22UF 16V X7R 0805	*	*	*	*	*	*	*
		14575	CAP, CHIP .33UF 16V X7R 0805	*	*	*	*	*	*	*
		14589	BRACKET, ANA-62022	*	*	*	*	*	*	*
		14615	RES, CHIP 127 1% 1/16W 0603	*	*	*	*	*	*	*
		14637	CAP, CHIP .01UF 630V X7R 1206	*	*	*	*	*	*	*
		14649-R	RES, CHIP 511 1% 1/16W 0603	*	*	*	*	*	*	*
		14731	BRACKET, PCI ANA-62011/TX	*	*	*	*	*	*	*
		14734	IC, 24C04A 4K SER EEPROM SO	*	*	*	*	*	*	*
		14764	CONN, RJ45 4X 8P RA C5 S P&PCG	*	*	*	*	*	*	*
		14765	CONN, RJ45 4X 8P RA C5 S PCGND	*	*	*	*	*	*	*
		14840	BRACKET, ANA-64044	*	*	*	*	*	*	*
		14842	DELAY LINE, 20NS 5-T SI SO	*	*	*	*	*	*	*
		14847	IC, 21154AB PCI BRDG33MHZ PBGA	*	*	*	*	*	*	*
		14855	BRACKET, ANA-62011/TX NRW TABS	*	*	*	*	*	*	*
		14857	IC, 21143PD PCI LAN CNTLR PQFP	*	*	*	*	*	*	*
		14860	SHROUD, SUPPORT 30MMX10MMX24MM	*	*	*	*	*	*	*
		1490174-00	CABLE, FST 50HD/DB25 EXT 2M	*	*	*	*	*	*	*
		1490175-00	CABLE, FST DB25/DB25 EXT 2M	*	*	*	*	*	*	*
		1490176-00	CABLE, ULTRA 50HD/50HD EXT 2M	*	*	*	*	*	*	*
		1490177-00	CABLE, ULTRA 50HD/50LD EXT 2M	*	*	*	*	*	*	*
		1490178-00	CABLE, ULTRA 68HD/50HD EXT 2M	*	*	*	*	*	*	*
		1490179-00	CABLE, ULTRA 68HD/50LD EXT 2M	*	*	*	*	*	*	*
		1490573-04	CABLE, EX 68V/68V U160 1M U320	*	*	*	*	*	*	*
		1490574-01	CABLE, EX 68V/68H LVD 4M	*	*	*	*	*	*	*
		1490834-00	CABLE, IN 68P3CN .76M U160 TRM	*	*	*	*	*	*	*
		1491181-00	SCD, CABLE, LVD, SCSI, TWST PR	*	*	*	*	*	*	*
		1491697-00	DISK ASSY, ANA-69XX v3.0	*	*	*	*	*	*	*
		1491698-00	DISK ASSY, DURALINK v3.0	*	*	*	*	*	*	*
		1492363-00	BRACKET, AFC-9210 SFP LP	*	*	*	*	*	*	*
		1492427-00	BRACKET, AFC-9210 SFP STD	*	*	*	*	*	*	*
		1492479-00	SCD, CBLF/C HSSDC-DB9 30AWG 3M	*	*	*	*	*	*	*

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		1492480-00	SCD, CBL F/C SC DPLX50/125 10M	*	*	*	*	*	*	*
		1492662-00	BOX, 15"X10 9/16"X8 1/2" RSC	*	*	*	*	*	*	*
		1492690-00	DISK ASSY, 9110G NT/W2K v1.0	*	*	*	*	*	*	*
		1492690-40	DISK ASSY, 9110G NT/W2Kv1.0wDS	*	*	*	*	*	*	*
		1492700-00	BRACKET, AFC-9210 HSSDC STD	*	*	*	*	*	*	*
		1492701-00	BRACKET, AFC-9210 HSSDC LP	*	*	*	*	*	*	*
		1493051-00	SCD,CBL EX LC-LC 5M DUP 50/125	*	*	*	*	*	*	*
		1493214-00	SCD, MOLDED PULP TRAY	*	*	*	*	*	*	*
		1493703-40	DISK ASSY, FIBRE CHNL DVRS wDS	*	*	*	*	*	*	*
		1493750-00	BRACKET, LP PALOMINO	*	*	*	*	*	*	*
		1493777-00	BRACKET, ANA-64044LV	*	*	*	*	*	*	*
		1494265-00	SCD, CABLE EX RS232 2M	*	*	*	*	*	*	*
		14943	RES, CHIP 5.1 5% 1/16W 0603	*	*	*	*	*	*	*
		1494349-00	BRACKET, ASA-7211	*	*	*	*	*	*	*
		1494349-01	BRACKET, ASA-7211 CU	*	*	*	*	*	*	*
		1494349-02	BRACKET, ASA-7211 OP	*	*	*	*	*	*	*
		1494563-00	SCD, ANA6911A/AUI HP ADPTR CAP	*	*	*	*	*	*	*
		1494704-00	CABLE, IN 68LP5CN RND U320 TRM	*	*	*	*	*	*	*
		1494724-00	BRACKET, ANA-7711F	*	*	*	*	*	*	*
		1494783-00	SCD, CABLE 68V-H 2M IN LN TRM	*	*	*	*	*	*	*
		1494784-00	SCD, CABLE 68V 2M IN LN TRM	*	*	*	*	*	*	*
		1495063-00	BRACKET, ANA-7711LP	*	*	*	*	*	*	*
		1495064-00	BRACKET, ANA-7711LP FULL HT	*	*	*	*	*	*	*
		14953	CAP, CHIP 10UF 20V TANT 3528	*	*	*	*	*	*	*
		1495310-00	SCD, CABLE EX RS232 NULL M 2M	*	*	*	*	*	*	*
		1495374-00	SCD,ASA-7211/ANA-7711 CLAMSHEL	*	*	*	*	*	*	*
		1495636-00	CABLE, IN 68P3CN RND U320 TRM	*	*	*	*	*	*	*
		1495727-00	CABLE, 68P HD INT/EXT U320	*	*	*	*	*	*	*
		1495815-00	SCD, CABLE UTP-PTCH5e-RJ45 7'	*	*	*	*	*	*	*
		1496066-00	BRACKET, VEGA 2 OPTICAL	*	*	*	*	*	*	*
		1496254-00	BRACKET, LP SNGL STK FULL RIB	*	*	*	*	*	*	*
		1496280-00	CABLE, IN 68LP 2CN U320 1M	*	*	*	*	*	*	*
		1496357-00	BOX, 7 1/2" X 4 3/4" X 2" KIT	*	*	*	*	*	*	*
		1496384-00	BOX, 14.8" x10.63" x9.65" MSTR	*	*	*	*	*	*	*
		1496489-00	SCD, CABLE SATA POWER	*	*	*	*	*	*	*
		1496972-00	BOX, 22.09"x 18.82"x 2.76" KIT	*	*	*	*	*	*	*
		1497017-00	BRACKET, VEGA II COPPER FL HT	*	*	*	*	*	*	*
		14973	IC, QS3125 QUAD BUS SW QSOP	*	*	*	*	*	*	*
		1497546-00	SCD, CBL MEDIA READER RECP5PIN	*	*	*	*	*	*	*
		1497573-00	BOX, 9" X 7" X 2 1/2" KIT	*	*	*	*	*	*	*
		14976	RES, CHIP .2 OHM 1% .5W 2010	*	*	*	*	*	*	*
		1497768-00	SCD, IC21143PD ANA-6911A/TX HP	*	*	*	*	*	*	*
		14988	IC, LM317 ADJ VR 1A SOT	*	*	*	*	*	*	*
		14996	LED, GRN DUAL RA .1/.3 T1	*	*	*	*	*	*	*
		15210	IC, 74AHC08 QUAD 2-IN AND SO	*	*	*	*	*	*	*
		15223	RES NTWK, CHIP 8X100 5% 4021	*	*	*	*	*	*	*
		15230-R	RES, CHIP 36 5% 1/16W 0603	*	*	*	*	*	*	*
		15332	IC, LT1118CST-2.5 VREG SOT-223	*	*	*	*	*	*	*
		15345-R	RES, CHIP .02 OHM 1% 1/4W 1206	*	*	*	*	*	*	*
		15354	IC, 21154BE PCI BRDG66MHZ PBGA	*	*	*	*	*	*	*
		15359	BRACKET, ANA-64044 SHIELDED	*	*	*	*	*	*	*
		15379-R	RES NTWK, CHIP 8X2.7K 5% 6431	*	*	*	*	*	*	*

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		15409-R	OSC, CER SMD 66MHZ 3.3V 7550	*	*	*	*	*	*	*
		15417-R	CAP, CHIP 10UF 10V X7R 1210	*	*	*	*	*	*	*
		15469	HEATSINK, SLIM LINE BGA /CLIP	*	*	*	*	*	*	*
		15470	RES, CHIP 20 5% 1/16W 0603	*	*	*	*	*	*	*
		15474	CONN, 20-P RCPT FC HD RA	*	*	*	*	*	*	*
		15475	FERRITE, CHIP Z31 1.5A 1210	*	*	*	*	*	*	*
		15476	IND, CHIP 1UH 10% 0.4A 1210	*	*	*	*	*	*	*
		15477	CKT PROTECT, 2.5AMP SMD250	*	*	*	*	*	*	*
		15480	IC, 39SF010 FLSH 1M 70/90 PLCC	*	*	*	*	*	*	*
		15481	IC, HDMP1536A XCVR FC PQFP	*	*	*	*	*	*	*
		15483	CONN, ASSY MEDIA CONV MOD FC	*	*	*	*	*	*	*
		15485	IC, HPFC5166A TACHYON FC PBGA	*	*	*	*	*	*	*
		15491	MODULE, IBM GBIC LASER XCVR FC	*	*	*	*	*	*	*
		15500	IC, 64KX36 SSRAM 7.5NS FT TQFP	*	*	*	*	*	*	*
		15502	OSC, CER SMD106.25MHZ 3.3V7550	*	*	*	*	*	*	*
		15508	IC, HPFC5200C TACHYON XL2 PBGA	*	*	*	*	*	*	*
		15516	IC, HDMP2630 2.125 GBPS MQFP	*	*	*	*	*	*	*
		15518	IND, CHIP 10UH 10% 140MA 1210	*	*	*	*	*	*	*
		15522	RES, CHIP 47 5% 1/16W 0603	*	*	*	*	*	*	*
		15523	RES, CHIP 130 5% 1/16W 0603	*	*	*	*	*	*	*
		15524	TRANS, BC856A PNP GP SOT23	*	*	*	*	*	*	*
		15525	TRANS, BC850B NPN GP SOT23	*	*	*	*	*	*	*
		15535	OSC, PECL 106.25MHZ 50PPM SOJ	*	*	*	*	*	*	*
		15540	BRACKET, AFC-9110G	*	*	*	*	*	*	*
		15553-R	HEADER, 2-PIN DIP, HT	*	*	*	*	*	*	*
		15560	CONN, 2x10X.8 F RA SFP EDGE SM	*	*	*	*	*	*	*
		15561	CONN, SFP CAGE LOW FC XCVR PTH	*	*	*	*	*	*	*
		15562	CCONN, SFP CAGE TOP FC XCVR PT	*	*	*	*	*	*	*
		15594-R	LED, CHIP GRN TOP 3216	*	*	*	*	*	*	*
		15604	(OBS) MOD, GBIC COPPER PASSIVE	*	*	*	*	*	*	*
		15606	CONN, 8 POS HSSDC RCPT RA EXT	*	*	*	*	*	*	*
		15634	RES, CHIP 174K 1% 1/16W 0603	*	*	*	*	*	*	*
		15638	TRANS, FDC638 PMOSFET 2.5 SOT6	*	*	*	*	*	*	*
		15657	IC, LT1585CM ADJ VR 4.6A DDPK	*	*	*	*	*	*	*
		15659	IC, MAX6336 UP RESET LW SOT143	*	*	*	*	*	*	*
		15663	OSC, 133MHZ 3.3V TS ULJIT 7050	*	*	*	*	*	*	*
		15689	CAP, CHIP 100PF 2KV NPO 1206	*	*	*	*	*	*	*
		15804	MOD, 2G SW XCVR 2LC SER ID SFP	*	*	*	*	*	*	*
		15814	HDR, 1X8 VERTCAL .100P SMD	*	*	*	*	*	*	*
		15858	CABLE, FIBRE CHNL LC-LC 10M	*	*	*	*	*	*	*
		15864	MOD, XFMR 10/100 BASE-T SMT16	*	*	*	*	*	*	*
		15870	RES, CHIP 18 5% 1/16W 0603	*	*	*	*	*	*	*
		15878-R	LED, SINGLE YELLOW SM 1206	*	*	*	*	*	*	*
		15900	TRANS, 1N02 NMFET 750MA 20VSOT	*	*	*	*	*	*	*
		15903	TRANS, MMJT9435 PNP BIPOLR SOT	*	*	*	*	*	*	*
		15904	FERRITE, CHIP EMI Z600 .2A0603	*	*	*	*	*	*	*
		15905	CAP, CHIP 150UF 16V TA LE 7343	*	*	*	*	*	*	*
		15907	CAP, CHIP 150UF 10V TA LE 7343	*	*	*	*	*	*	*
		15908	CAP, CHIP 68UF 10V TA LE 7343	*	*	*	*	*	*	*
		15913	IC, 28F640J3A FLASH 120NS TSOP	*	*	*	*	*	*	*
		15918	HDR, 15PIN X2 SHRD .050 PITCH	*	*	*	*	*	*	*
		15938	IC, L80223 10/100TX/FX PHYLQFP	*	*	*	*	*	*	*

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		15939	RES, CHIP 121 1% 1/16W 0603	*	*	*	*	*	*	*
		15944	RES, CHIP 82.5 1% 1/16W 0603	*	*	*	*	*	*	*
		15945	CAP, CHIP 33UF 8V AL LE 7343	*	*	*	*	*	*	*
		15967-R	RES, CHIP 40.2K 1% 1/16W 0603	*	*	*	*	*	*	*
		15992	RES, CHIP 4.87K 1% 1/16W 0603	*	*	*	*	*	*	*
		15993	RES, CHIP 4.12K 1% 1/16W 0603	*	*	*	*	*	*	*
		15995	RES, CHIP 3.48K 1% 1/16W 0603	*	*	*	*	*	*	*
		16006	IC, 24LC256 2-W SEEPROM 3V SO	*	*	*	*	*	*	*
		16036	HDR, 2X15X.05 V SHR W/LTCH SMT	*	*	*	*	*	*	*
		16051-R	HEADER, 2-PIN DIP RA HT	*	*	*	*	*	*	*
		16067-R	IC, 32KX8 3.3V NVSRAM 45 SO32	*	*	*	*	*	*	*
		16069-R	IND, 3.3UH 20% 4.5A LP SMT	*	*	*	*	*	*	*
		16078-R	DIODE, MBR0520L .5A 20V SB SOD	*	*	*	*	*	*	*
		16103	OSC, 18.432MHZ CMOS 3.3V SOJ4	*	*	*	*	*	*	*
		16117	RES, CHIP 2.74K 1% 1/16W 0402	*	*	*	*	*	*	*
		16123	RES, CHIP 4.87K 1% 1/16W 0402	*	*	*	*	*	*	*
		16126	RES, CHIP 82.5 1% 1/16W 0402	*	*	*	*	*	*	*
		16131	RES, CHIP 15 5% 1/16W 0402	*	*	*	*	*	*	*
		16133-R	RES, CHIP 22 5% 1/16W 0402	*	*	*	*	*	*	*
		16137-R	RES, CHIP 47K 5% 1/16W 0402	*	*	*	*	*	*	*
		16139-R	RES, CHIP 5.1K 5% 1/16W 0402	*	*	*	*	*	*	*
		1619607-00	PCB, ANA-6911A/TX	*	*	*	*	*	*	*
		16207	MOD, 1X9 1GBE OPT PHY XCVR SC	*	*	*	*	*	*	*
		16214-R	RES, CHIP 2.49K 1% 1/16W 0402	*	*	*	*	*	*	*
		16222-R	BUZZER, ELECTROMAGNETIC SMT	*	*	*	*	*	*	*
		16223	IC, LT1763-1.5 VR LDO 500MA SO	*	*	*	*	*	*	*
		16229	IC, 24CW02 2K SER EEPROM DIP	*	*	*	*	*	*	*
		16244-R	IC, LT1962 LDO VR 3.3V .3A MS8	*	*	*	*	*	*	*
		16251-R	IC, CDCV304 PCIX CLKBUF TSSOP8	*	*	*	*	*	*	*
		16266-R	HDR, 3-P 2.5MM STAGRD VERT PTH	*	*	*	*	*	*	*
		16288	IC, 74AHC1G32 2-IN OR SOT353	*	*	*	*	*	*	*
		16298	CAP, CHIP 47UF 20V TA LE 7343	*	*	*	*	*	*	*
		16299	CHOKER, COM MODE 4X4 Z80 130604	*	*	*	*	*	*	*
		16313-R	RES, CHIP 3.01K 1% 1/16W 0402	*	*	*	*	*	*	*
		16314-R	RES, CHIP 1.0M 5% 1/16W 0402	*	*	*	*	*	*	*
		16315-R	RES, CHIP 1.0K 5% 1/16W 0402	*	*	*	*	*	*	*
		16324	IC, MAX3225 2XRS232 XCVR TSSOP	*	*	*	*	*	*	*
		16331	IC, LT1963 LDO VR 1.5V1.5A SOT	*	*	*	*	*	*	*
		16332	IC, LT1764A LDO VR 3.3V3A DDPK	*	*	*	*	*	*	*
		16373	CONN, RJ45 8P GB W/INT MAG	*	*	*	*	*	*	*
		16410-R	RES, CHIP 220 5% 1/16W 0402	*	*	*	*	*	*	*
		16437	IC, 8MX16 SDRAM 133MHZ 3 TSOP2	*	*	*	*	*	*	*
		16445-R	RES, CHIP 47 5% 1/16W 0402	*	*	*	*	*	*	*
		16502	IC, LC4256V CPLD 3.3V 7.5 TQFP	*	*	*	*	*	*	*
		16503	CAP, 4X.001UF 25V X7R 3216-8	*	*	*	*	*	*	*
		16504	CAP, 4X.01UF 25V X7R 3216-8	*	*	*	*	*	*	*
		16505	CAP, 4X.1UF 16V X7R 3216-8	*	*	*	*	*	*	*
		16506	TRANS, FDS6894A 2X N-MOSFET SO	*	*	*	*	*	*	*
		16508	TRANS, FDS6898A DUAL N-FET SO8	*	*	*	*	*	*	*
		16523	CAP, CHIP 22UF 6.3V X5R 1206	*	*	*	*	*	*	*
		16526	CAP, CHIP 220UF6.3V TA LE 7343	*	*	*	*	*	*	*
		16527	IND, CHIP 1UH 20% 11A 656930	*	*	*	*	*	*	*

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		16528	IND, CHIP 10UH 20% 3A 656930	*	*	*	*	*	*	*
		16529	RES NTWK, 8X56 5% 1/16W 3816	*	*	*	*	*	*	*
		16538	RES, CHIP 12.1K 1% 1/10W 0603	*	*	*	*	*	*	*
		16552	LED, GRN 3X RA .07/.2/.33 DIN	*	*	*	*	*	*	*
		16568	IC, 74LVC1G07 BUFR O/D SC70	*	*	*	*	*	*	*
		16572-R	RES, CHIP 120 5% 1/16W 0402	*	*	*	*	*	*	*
		16574	HEATSINK, HAD03501 W/THERMAL	*	*	*	*	*	*	*
		16625-R	IC, 74CBTLV3245A 8-BIT SW QSOP	*	*	*	*	*	*	*
		16634	IC, 74LVC1G32 OR GATE SC70	*	*	*	*	*	*	*
		16635-R	IC, LP 2995 DDR TERM REG SO-8	*	*	*	*	*	*	*
		16653-R	RES NTWK, CHIP 4X22 5% 2010	*	*	*	*	*	*	*
		16660-R	RES NTWK, CHIP 4X47 5% 2010	*	*	*	*	*	*	*
		16669	IC, 4MX16X4 DDR SDRAM 6T TSOP	*	*	*	*	*	*	*
		16692	RES, CHIP 1.8 5% 1/16W 0603	*	*	*	*	*	*	*
		16727	IC, LC4384V CPLD 3.3V 7.5 TQFP	*	*	*	*	*	*	*
		16731-R	IC, 8MX16X4 DDR SDRAM LP TSOP	*	*	*	*	*	*	*
		16736	CONN, IB/SAS F 4X RA SCRWLK SM	*	*	*	*	*	*	*
		16740-R	IC, LTC4064 4V BAT CHRGR MSOP	*	*	*	*	*	*	*
		16816-R	IC, 4MX16X4 DDR266B LP TSOP	*	*	*	*	*	*	*
		16918	IC, 82546EB GBE CNTLR 2C PBGA	*	*	*	*	*	*	*
		16923	CAP, CHIP 100UF 6.3V X5R 1210	*	*	*	*	*	*	*
		16971	CONN, 32P SAS M RA X4 INT PTH	*	*	*	*	*	*	*
		16981-R	RES, CHIP 6.04K 1% 1/16W 0402	*	*	*	*	*	*	*
		16989-R	OSC, 25MHZ 50PPM 3.3V 3S 7050	*	*	*	*	*	*	*
		17001-R	IC, 74AUC1G66 SW ANLG SC70	*	*	*	*	*	*	*
		17002	RES, CHIP 100K 1% 1/16W 0402	*	*	*	*	*	*	*
		1700707-00	PCB, ANA-62011/TX	*	*	*	*	*	*	*
		17029	LED, YEL/GRN RA T1 .125H PTH	*	*	*	*	*	*	*
		17032	RES, CHIP 1.40K 1% 1/16W 0603	*	*	*	*	*	*	*
		17034	RES, CHIP 38.3K 1% 1/16W 0603	*	*	*	*	*	*	*
		17035	CAP, CHIP 1UF 25V X5R 0805	*	*	*	*	*	*	*
		17036	CAP, CHIP 47UF 25V TA 7343H	*	*	*	*	*	*	*
		17037	CAP, CHIP 0.1UF 25V X5R 0603	*	*	*	*	*	*	*
		17038	IND, CHIP 8.2UH 20% 4A 656930	*	*	*	*	*	*	*
		17039	IC, 24C04 4K SEEPROM 1.8V SO	*	*	*	*	*	*	*
		17040	TRANS, SI4804 N+N-MOSFET SO8	*	*	*	*	*	*	*
		17041	RES, CHIP 5.11K 1% 1/16W 0603	*	*	*	*	*	*	*
		17042	RES, CHIP 110K 1% 1/16W 0603	*	*	*	*	*	*	*
		17043	RES, CHIP 30.9K 1% 1/16W 0603	*	*	*	*	*	*	*
		17050	CAP, CHIP .47UF 10V X5R 0603	*	*	*	*	*	*	*
		17051	CONN, RJ45 8P GBE GRN+GRN LED	*	*	*	*	*	*	*
		17061	IC, 29LV008BT FLSH 90NS TSOP	*	*	*	*	*	*	*
		17065	IC, 82545GM GBE CNTLR 1C TFBGA	*	*	*	*	*	*	*
		17086	STANDOFF, NYLON 6MM DUAL LOCK	*	*	*	*	*	*	*
		17089	IC, LTC2923 PS TRACK CTLR MSOP	*	*	*	*	*	*	*
		17094	TRANS, SI4408 N-MOSFET SO8	*	*	*	*	*	*	*
		17159	IC, MIC49300 LDO VR 1.2V 3A S5	*	*	*	*	*	*	*
		17160-R	CONN, 7P SATA M RA SHRD BLK SM	*	*	*	*	*	*	*
		17161-R	CONN, 7P SATA M RA SHRD BLU SM	*	*	*	*	*	*	*
		17166	RES, CHIP 10.5K 1% 1/16W 0402	*	*	*	*	*	*	*
		17169	CAP, CHIP 1500PF 50V X7R 0603	*	*	*	*	*	*	*
		17170	CAP, CHIP 47UF 6.3V X5R 1206	*	*	*	*	*	*	*

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		17171	CAP, CHIP 22UF 10V X5R 1210	*	*	*	*	*	*	*
		17175	IC, LP2996 DDR TERM REG SO8	*	*	*	*	*	*	*
		17176	RES, CHIP 40.2 0.5% 1/16W 0402	*	*	*	*	*	*	*
		17177	CAP, CHIP 22UF 25V X5R 2220	*	*	*	*	*	*	*
		17178	IC, TPS60205 DC CNVTR 3.3V SO	*	*	*	*	*	*	*
		17179	RES, CHIP .004 OHM 1% 1W 2512	*	*	*	*	*	*	*
		17180	CAP, CHIP 150UF 4V TA-P 734319	*	*	*	*	*	*	*
		17181	IND, CHIP 2.7UH 7A SHLD 125125	*	*	*	*	*	*	*
		17182	RES, CHIP 63.4K 1% 1/16W 0402	*	*	*	*	*	*	*
		17184	IND, CHIP 1.5UH 9A SHLD 6570	*	*	*	*	*	*	*
		17185	RES, CHIP 73.2K 1% 1/16W 0603	*	*	*	*	*	*	*
		17186	IND, CHIP 4.7UH 5.5A SHLD 6570	*	*	*	*	*	*	*
		17188	SCREW, M2X4MM PNHD PHIL STL	*	*	*	*	*	*	*
		17189	IC, VSC8211 GBE PHY 1PORT LBGA	*	*	*	*	*	*	*
		17193	IC, 24C04 4K SEEPROM 2.7V SO	*	*	*	*	*	*	*
		17195	CONN, 6X20S+2P F RA VHDM DG PF	*	*	*	*	*	*	*
		17196	CONN, RJ45 8P GBE G+G/Y LED TH	*	*	*	*	*	*	*
		17197	RES, CHIP 2.26K 1% 1/16W 0402	*	*	*	*	*	*	*
		17198	RES, CHIP 4.02K 1% 1/16W 0402	*	*	*	*	*	*	*
		17199	RES, CHIP 5.90K 1% 1/16W 0402	*	*	*	*	*	*	*
		17200	RES, CHIP 8.25K 1% 1/16W 0402	*	*	*	*	*	*	*
		17201	RES, CHIP 12.1K 1% 1/16W 0402	*	*	*	*	*	*	*
		17203	RES, CHIP 22.6K 1% 1/16W 0402	*	*	*	*	*	*	*
		17204	LED, GRN DUAL RA .1/.25 SIP	*	*	*	*	*	*	*
		17205	LED, GRN 4X(2X3)RA .12/+1(3X)	*	*	*	*	*	*	*
		17206	IC, 29W640 FLSH 3V TOP 90 TSOP	*	*	*	*	*	*	*
		17207	RES, CHIP .01 OHM 1% 1W 2512	*	*	*	*	*	*	*
		17208	DIMM, 32MX72 DDR2 400M UBF1.2	*	*	*	*	*	*	*
		17209	IC, 80314 IOP NO SRAM B1 HSBGA	*	*	*	*	*	*	*
		17214	CONN, RJ45 8P F RA LP SHLD SM	*	*	*	*	*	*	*
		17216	IC, 74ALVCH16373 16B LTCH BGA	*	*	*	*	*	*	*
		17218	RES, CHIP 24.9 1% 1/4W TF 0805	*	*	*	*	*	*	*
		17218-R	RES, CHIP 24.9 1% 1/4W TF 0805	*	*	*	*	*	*	*
		17219	MOD, MAG S558-5999-BA GBE SM24	*	*	*	*	*	*	*
		17220	MOD, MAG RD-SDIH-009 GBE SM24	*	*	*	*	*	*	*
		17221	IC, LTC3708 2PHASE SW REG QFN	*	*	*	*	*	*	*
		17223	IC, 74ALVC32 4X 2-IN OR TVSOP	*	*	*	*	*	*	*
		17224	IC, 16C2550 2X UART+FIFO TQFP	*	*	*	*	*	*	*
		17225	RES, CHIP 59.0K 1% 1/16W 0402	*	*	*	*	*	*	*
		17226	RES, CHIP 15.0K 1% 1/16W 0402	*	*	*	*	*	*	*
		17227	RES, CHIP 187K 1% 1/16W 0402	*	*	*	*	*	*	*
		17228	IC, 74TVC3010 10B V CLMP TSSOP	*	*	*	*	*	*	*
		17229	CONN, 1X14X.1 M VERT B2B.6 PTH	*	*	*	*	*	*	*
		17231	CAP, CHIP 10UF 10V X5R LP 1210	*	*	*	*	*	*	*
		17232	CONN, 3P F RA STEREO 3.5MM PTH	*	*	*	*	*	*	*
		17233	IC, MAX6375 2.32V V DET SC70	*	*	*	*	*	*	*
		17234	RES CHIP .22 OHM 1% .5W 2012	*	*	*	*	*	*	*
		17235	RES CHIP 1.96K 1% 1/10W 0805	*	*	*	*	*	*	*
		17236	RES CHIP 120 5% 1/16W 0603	*	*	*	*	*	*	*
		17237	RES CHIP 2.05K 1% 1/10W 0805	*	*	*	*	*	*	*
		17238	RES CHIP 24.9K .1% 1W TF 0805	*	*	*	*	*	*	*
		17239	RES CHIP 3.0K 5% 1/16W 0603	*	*	*	*	*	*	*

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		17240	RES CHIP 3.24K 1% 1/10W 0805	*	*	*	*	*	*	*
		17241	RES CHIP 30.1K 1% 1/10W 0805	*	*	*	*	*	*	*
		17242	RES CHIP 36.5K 1% 1/10W 0805	*	*	*	*	*	*	*
		17243	RES CHIP 392K 1% 1/10W 0805	*	*	*	*	*	*	*
		17244	RES CHIP 49.9K .1%.1W TF 0805	*	*	*	*	*	*	*
		17245	RES CHIP 5.62K 1% 1/10W 0805	*	*	*	*	*	*	*
		17246	RES CHIP 6.04K 1% 1/10W 0805	*	*	*	*	*	*	*
		17247	RES CHIP 60.4K 1% 1/10W 0805	*	*	*	*	*	*	*
		17248	THERMISTOR 10K 1% NTC 0805	*	*	*	*	*	*	*
		17249	CAP CHIP .1UF 5% 16V X7R 0603	*	*	*	*	*	*	*
		17250	CAP CHIP .01UF 5%50V X7R 0603	*	*	*	*	*	*	*
		17251	CAP CHIP 100UF 10V TA-P 7343	*	*	*	*	*	*	*
		17252	CAP CHIP 2.2UF 6.3V X5R 0805	*	*	*	*	*	*	*
		17253	CAP CHIP 330UF 10V TA-P 7343	*	*	*	*	*	*	*
		17254	CAP CHIP 2.2UF 10V X7R 1206	*	*	*	*	*	*	*
		17255	CAP CHIP 10UF 25V X5R 1206	*	*	*	*	*	*	*
		17256	CONN 2X30X.05 M VERT SHRD SMT	*	*	*	*	*	*	*
		17257	CONN 1X3X2.5 M RA SHRD FL PTH	*	*	*	*	*	*	*
		17259	IND CHIP 150UH 20% 2A DO3340P	*	*	*	*	*	*	*
		17260	IND CHIP 2.7UH20% 1.3A 1008PS	*	*	*	*	*	*	*
		17261	IC MAX662A 12V 30MA CNVRTR SO	*	*	*	*	*	*	*
		17262	DIO 5242B 12V .225W ZNR SOT23	*	*	*	*	*	*	*
		17263	RES, CHIP 475 1% 1/16W 0603	*	*	*	*	*	*	*
		17264	IC, ICS9DB104 DIFF BFR TSSOP	*	*	*	*	*	*	*
		17265	IC MAX8867 LDO VR 3.3V SOT	*	*	*	*	*	*	*
		17266	IC 74ALVC08 4X 2-IN AND SO	*	*	*	*	*	*	*
		17267	IC 29W320 FLSH 3V TOP 90 TSOP	*	*	*	*	*	*	*
		17268	IC DS1811 RESET 5V W/OD SOT	*	*	*	*	*	*	*
		17269	IC 74AC10 3X 3-IN NAND SO	*	*	*	*	*	*	*
		17270	IC CDCV855 CLK DRVR 2.5 TSSOP	*	*	*	*	*	*	*
		17271	IC MAX996 4X CMPRTR HS SO	*	*	*	*	*	*	*
		17273	IC MAX8881 LDO VR 2.5V.2A SOT	*	*	*	*	*	*	*
		17274	IC LM385 V REF 1.2V 1% SO	*	*	*	*	*	*	*
		17275	IC LMV931 OP AMP RRIO 1.8 SOT	*	*	*	*	*	*	*
		17276	IC 74LCX38 4X 2-IN NAND OD SO	*	*	*	*	*	*	*
		17277	IC MAX8214 5X V CMPRTR 1% SO	*	*	*	*	*	*	*
		17279	XTAL, 7.3728MHZ 50PPM 0612-4	*	*	*	*	*	*	*
		17280	IC, 74CBT3126 4X FET SW QSOP	*	*	*	*	*	*	*
		17281	SW, SPST NO RA TACT 6MM SQ PTH	*	*	*	*	*	*	*
		17282	CONN, 1X5X.1 F RA EDGE PTH	*	*	*	*	*	*	*
		17284	IC, TPS40009 SYN BUCK VR PSOP	*	*	*	*	*	*	*
		17288	CONN 2X90X.025 M VERT 5MM SM	*	*	*	*	*	*	*
		17289	CAP CHIP 100UF16V AL-P 101008	*	*	*	*	*	*	*
		17290	TRANS SI4410 N-MOSFET 30V SO	*	*	*	*	*	*	*
		17291	LED CHIP YEL HSMY TOP 3216	*	*	*	*	*	*	*
		1891400	CD ASSY, DURALINKv5.1 USERv5.2	*	*	*	*	*	*	*
		1906000	CD ASSY, FC FAILOVER v1.0 &USR	*	*	*	*	*	*	*
		1909107-00	PCB, ANA-64044LV	*	*	*	*	*	*	*
		1925307-00	PCB, ANA-64022LV	*	*	*	*	*	*	*
		1944807-00	PCB, ASA-7211	*	*	*	*	*	*	*
		1969007-00	PCB, ANA-7711	*	*	*	*	*	*	*
		1988907-00	PCB, ANA-7711C	*	*	*	*	*	*	*

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		2033407-00	PCB, VEGA II MULE BOARD	*	*	*	*	*	*	*
		2066100	CD ASSY, ANA-7711C/F v1.01	*	*	*	*	*	*	*
		2085200	CD ASSY, ANA-7711C/F v1.11	*	*	*	*	*	*	*
		2102700	CD ASSY, ASA-7211C/F v1.2/GD	*	*	*	*	*	*	*
		2102700JA	CD ASSY, ASA-7211C/F/JAv1.2/GD	*	*	*	*	*	*	*
		2150307-00	PCB, HIMALIA	*	*	*	*	*	*	*
		2160207-00	PCB, MYNAH	*	*	*	*	*	*	*
		298695-001	COMPAQ OUTER SHIPPER	*	*	*	*	*	*	*
		490991-22	LABEL, .125" X 1.50" WHT POLY	*	*	*	*	*	*	*
		490991-40	LABEL, 1" X 0.38" WHITE POLY	*	*	*	*	*	*	*
		491041-00	CORRUGATED PAD, 5 PC KIT MSTR	*	*	*	*	*	*	*
		491043-00	BOX, RSC 27 X 9.5 X 9.5 W/LOGO	*	*	*	*	*	*	*
		491044-00	INSERT, 25 PC BULK CARTON	*	*	*	*	*	*	*
		491045-00	FOAM, 25 PC BULK CARTON	*	*	*	*	*	*	*
		491732-00	BOX, BULK PACK 27X15 W/LOGO	*	*	*	*	*	*	*
		493564-00	CABLE, 50P SCSI RIBBON 5 CONN	*	*	*	*	*	*	*
		493659-00	INSERT, ANA-5XXX 5PC WITH S/W	*	*	*	*	*	*	*
		493660-00	FOAM, ANA-5XXX 5PC wS/W TOP	*	*	*	*	*	*	*
		493661-00	FOAM, ANA-5XXX 5PC wS/W BOTTOM	*	*	*	*	*	*	*
		493992-00	CABLE, 68P ULTRASCSI 3 CONN	*	*	*	*	*	*	*
		493999-00	(OBS)CABLE,68PSCSI5CONNW/TMNTR	*	*	*	*	*	*	*
		494045-00FR	SCD, FR POLYBAG w/NOTICE	*	*	*	*	*	*	*
		494045-00GE	SCD, GE POLYBAG w/NOTICE	*	*	*	*	*	*	*
		494045-00JA	SCD, S/W POLYBAG w/NOTICE JPN	*	*	*	*	*	*	*
		495201-00	SCD, IU CONVERTER KIT	*	*	*	*	*	*	*
		496201-00	BOX, RSC 14" X 14" X 11"	*	*	*	*	*	*	*
		496716-00	LABEL, ANA-6911A/TX HP LOGO	*	*	*	*	*	*	*
		496948-00	CARD, ANA REG/WAR	*	*	*	*	*	*	*
		496980-00	BOX, 5 PC VAR KIT MASTER	*	*	*	*	*	*	*
		497024-00	SCD, CABLE BLISTER PACK	*	*	*	*	*	*	*
		497428-00	FOAM, 12"X11-7/8"X1/2" TOP	*	*	*	*	*	*	*
		497431-00	FOAM, 12" X 11-7/8"X 1" BOTTOM	*	*	*	*	*	*	*
		497432-00	INSERT, 12" X 6-5/8" 10 PACK	*	*	*	*	*	*	*
		497461-00	CABLE, 68P RBN 3CONN PVC	*	*	*	*	*	*	*
		497462-00	CABLE, 50P RBN 3CONN PVC	*	*	*	*	*	*	*
		498410-00	SCD, 50 PIN TERMINATOR BLOCK	*	*	*	*	*	*	*
		498583-00	CABLE, 68P 5 CONN W/TERM LAMIN	*	*	*	*	*	*	*
		499110-00	TERMINATOR, EXT 68P ACTIVE	*	*	*	*	*	*	*
		499629-00	INSERT, 10 PACK ESD BAG BULK	*	*	*	*	*	*	*
		499630-00	FOAM, 12X12X1 TOP & BOTTOM	*	*	*	*	*	*	*
		510894-00	CARD, S/W PKG LICENSE AGREEMNT	*	*	*	*	*	*	*
		510894-00FR	CARD, FR S/W LICENSE AGREEMENT	*	*	*	*	*	*	*
		510894-00GE	CARD, GE S/W LICENSE AGREEMENT	*	*	*	*	*	*	*
		510894-00IT	CARD, IT S/W LICENSE AGREEMENT	*	*	*	*	*	*	*
		510894-00SP	CARD, SP S/W LICENSE AGREEMENT	*	*	*	*	*	*	*
		510967-00JA	CARD, ACK/INT3-T/JA HANGTAG	*	*	*	*	*	*	*
		511225-00	CARD, LICENSE AGREE 10 PACK	*	*	*	*	*	*	*
		511225-00JA	CARD, LIC AGREE 10 PACK JAPAN	*	*	*	*	*	*	*
		511247-00	LABEL, LOCALIZED RETN ADDRESS	*	*	*	*	*	*	*
		511308-00JA	CARD, ACK-ASI-N/JA HANGTAG	*	*	*	*	*	*	*
		511472-00	USER GUIDE, PCI ENET/FAST ADPT	*	*	*	*	*	*	*
		511482-00	CARD, REG/READ ME FIRST	*	*	*	*	*	*	*

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		511595-00FR	CARD, FR SPG KIT GENERIC REG	*	*	*	*	*	*	*
		511650-00	USER GUIDE, DURALINK FAILOVER	*	*	*	*	*	*	*
		511651-00	USER GUIDE, DURALINK PORT AGR	*	*	*	*	*	*	*
		511830-00	CARD, SCSI CABLE USE	*	*	*	*	*	*	*
		511859-00	CARD, S/W LIC DURLINK FULFILL	*	*	*	*	*	*	*
		511859-00JA	CARD, S/W LIC DRLNK FULFILL JA	*	*	*	*	*	*	*
		511881-00	CARD, ACK-SS26-50HD BLSTR PACK	*	*	*	*	*	*	*
		511964-00	GUIDE, DURALNK SVRMGR USR(BOM)	*	*	*	*	*	*	*
		511971-00JA	GUIDE, PCI ETHRNT/JA USER(BOM)	*	*	*	*	*	*	*
		512014-00	SLV, ANA-62011 SGL KIT	*	*	*	*	*	*	*
		512014-00JA	SLV/BOX, ANA-62011/JA SGL KIT	*	*	*	*	*	*	*
		512016-00	SLV, ANA-62022 SGL KIT	*	*	*	*	*	*	*
		512016-00JA	SLEEVE/BOX, ANA-62022/JA KIT	*	*	*	*	*	*	*
		512017-00	SLV, ANA-62044 SGL KIT	*	*	*	*	*	*	*
		512017-00JA	SLEEVE/BOX, ANA-62044/JA KIT	*	*	*	*	*	*	*
		512019-00	CARD, RMF/REG ANA6XXXX SGL KIT	*	*	*	*	*	*	*
		512066-00	LABEL, WIN 98 READY	*	*	*	*	*	*	*
		512066-00JA	LABEL, JA WIN 98 READY	*	*	*	*	*	*	*
		512195-00	LBL, C-TICK N279 HP LBL	*	*	*	*	*	*	*
		512197-00	SLEEVE/BOX, 6911A/TX, TXC SGL	*	*	*	*	*	*	*
		512205-00	LABEL, ANA-6911A/TXC PROD ID	*	*	*	*	*	*	*
		512385-00	CARD, 10 PK CABLE PROMO	*	*	*	*	*	*	*
		512459-03JA	GUIDE, 29160/JA USER REF HRD	*	*	*	*	*	*	*
		512585-03	GUIDE, GOBACK PRO SUPPLMT HRD	*	*	*	*	*	*	*
		512594-00	CARD, HANG TAG 4"x 4"	*	*	*	*	*	*	*
		512595-00	CARD, HANG TAG 4"x 5"	*	*	*	*	*	*	*
		512596-00	CARD, HANG TAG 4"x 8"	*	*	*	*	*	*	*
		512597-00	CARD, HANG TAG 4"x 9"	*	*	*	*	*	*	*
		512601-00	CARD, HANG TAG 4" x 5 1/2"	*	*	*	*	*	*	*
		512644-03	GUIDE, AFC-9110G INSTALL HRD	*	*	*	*	*	*	*
		512645-05	CD ASSY, AFC-9110G USER GUIDE	*	*	*	*	*	*	*
		512654-00	LBL, AFC-9110G BSMI	*	*	*	*	*	*	*
		512672-00	CARD, AFC-9110G REG/READ ME	*	*	*	*	*	*	*
		512742-03	GUIDE, AFC-9210 INSTALL HRD	*	*	*	*	*	*	*
		512745-03	GUIDE, FC INSPECTOR USER HRD	*	*	*	*	*	*	*
		512789-00	LBL, 6911ATX/HP P/N (ON BRKT)	*	*	*	*	*	*	*
		512794-05	GUIDE,9210LP USRRF/INSTLCDASSY	*	*	*	*	*	*	*
		512797-00	CARD, AFC-9210 REG/README	*	*	*	*	*	*	*
		512798-00	FLYER, AFC-9210 PROMO CARD	*	*	*	*	*	*	*
		512899-00	SLV, ANA-64044 KIT	*	*	*	*	*	*	*
		512908-00JA	CARD, UNIFI REG/WAR JA	*	*	*	*	*	*	*
		512939-00	FLYER, iSCSI READY	*	*	*	*	*	*	*
		512939-00JA	FLYER, iSCSI READY/JA	*	*	*	*	*	*	*
		513193-03	GUIDE, ASA-7211 INSTALL	*	*	*	*	*	*	*
		513193-03JA	GUIDE, ASA-7211/JA INSTALL	*	*	*	*	*	*	*
		513274-00	LBL, 29160 KOREAN MIC	*	*	*	*	*	*	*
		513297-00	SLV, ANA-7711F KIT	*	*	*	*	*	*	*
		513320-00	SLV, ANA-64044LV KIT	*	*	*	*	*	*	*
		513345-00	SLV, ANA-64022LV KIT	*	*	*	*	*	*	*
		513426-00	SLV, ANA-7711C KIT	*	*	*	*	*	*	*
		513559-00JA	CARD, ACK-1420A/JA SAFTY WARN	*	*	*	*	*	*	*
		513591-00JA	LBL, ANA-7711C&F/JA SUPPORT	*	*	*	*	*	*	*

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		513595-03	GUIDE, ANA-7711 GETTING START	*	*	*	*	*	*	*
		513596-00	FLYER, ANA-7711 CABLES	*	*	*	*	*	*	*
		513655-00	LBL, WIND SERVER 2003 DR INCL	*	*	*	*	*	*	*
		513976-03	GUIDE, SCSI/SATA RD S/T/L QKIN	*	*	*	*	*	*	*
		513988-00	LABEL, IBM BATT WRAP AROUND	*	*	*	*	*	*	*
		ASM-00440-01-A	HEATSINK, BLUE, W/FAN 12V 40MM	*	*	*	*	*	*	*
		AUD-00003-01-A	BUZZER:2.44KHZ,3V,8.5x8.5x3MM	*	*	*	*	*	*	*
		BAT-00011-01-A	SCD, 2.0AH Li ION CRU BAT ASSY	*	*	*	*	*	*	*
		BAT-00012-01-A	BATTERY PACK, BIREME-FTRSS-SKF	*	*	*	*	*	*	*
		CAP-00095-01-A	CAP: 0.68UF 16V TANT 3216	*	*	*	*	*	*	*
		CAP-00104-01-A	120UF,20%,6.3V,AL POLYMER,7343	*	*	*	*	*	*	*
		CAP-00105-01-A	47UF,20%,6.3V,X5R,1210	*	*	*	*	*	*	*
		CAP-00107-01-A	CAP: 0.15UF 10% 10V X5R 0603	*	*	*	*	*	*	*
		CAP-00108-01-A	CAP: 4.7UF 10% 10V X5R 0805	*	*	*	*	*	*	*
		CAP-00113-01-A	2.2UF 10% 6.3V 0603 X5R	*	*	*	*	*	*	*
		CAP-00114-01-A	22UF, 20%, 4V, TANT, 0805	*	*	*	*	*	*	*
		CAP-00115-01-A	560PF, 10%, 50V, X7R, 0402	*	*	*	*	*	*	*
		CAP-00116-01-A	1500PF, 10%, 50V, X7R, 0402	*	*	*	*	*	*	*
		CAP-00117-01-A	4.7NF, 10%, 25V, X7R, 0402	*	*	*	*	*	*	*
		CAP-00118-01-A	2.2NF, 5%, 50V, X7R, 0402	*	*	*	*	*	*	*
		CAP-00119-01-A	SCD, CAP 0.1UF 10V X5R0402 IBM	*	*	*	*	*	*	*
		CAP-00120-01-A	SCD, CAP 100UF 6.3VX5R 1210IBM	*	*	*	*	*	*	*
		CAP-00121-01-A	SCD, CAP 220UF 10V T 7343H IBM	*	*	*	*	*	*	*
		CAP-00122-01-A	SCD, CAP 10UF 25V X5R 1210 IBM	*	*	*	*	*	*	*
		CBL-00017-01-A	SCD, CABLE LED	*	*	*	*	*	*	*
		CBL-00018-01-A	CABLE, U320 5CN TRM	*	*	*	*	*	*	*
		CBL-00031-01-A	CABLE, BATTERY JUMPER BIREME	*	*	*	*	*	*	*
		CBL-00044-01-A	CABLE, I2C 3P F 1M	*	*	*	*	*	*	*
		CBL-00052-01-A	CABLE, X4-4SNGL PRT 1M+PWR	*	*	*	*	*	*	*
		CBL-00053-01-A	CABLE, X4-4SNGL PRT .5M+PWR	*	*	*	*	*	*	*
		CDA-00051-01-A	CD ASSY, USB2CONN v1.9 DRV/GD	*	*	*	*	*	*	*
		CON-00152-01-A	2X4X.050" F SKT VERT H.240" SM	*	*	*	*	*	*	*
		CON-00153-01-A	2X90X.025" F VERT H10MM B2B SM	*	*	*	*	*	*	*
		CON-00160-01-A	RECPT,2X20,25MIL,VERT,SMD	*	*	*	*	*	*	*
		CON-00162-01-A	RECPT,FFC,6P,ZIF,VERT,SMD	*	*	*	*	*	*	*
		CON-00163-01-A	CONN, 8-P ULTR MINI SRL RA SMT	*	*	*	*	*	*	*
		CON-00164-01-A	CRDEDGE,PCI EXPRESS,X16,STRDLE	*	*	*	*	*	*	*
		CON-00169-01-A	SKT,BGA,676X1MM,31MM SQ	*	*	*	*	*	*	*
		CON-00175-01-A	ECEPT,GUIDE PIN,FUTUREBUS+	*	*	*	*	*	*	*
		CON-00176-01-A	HOUSING,GUIDE PIN,FUTUREBUS+	*	*	*	*	*	*	*
		CON-00177-01-A	GUIDE PIN & SCREW, 4.57X20MM	*	*	*	*	*	*	*
		CON-00182-01-A	HEADER,MICRO-FIT,6PIN,RA,SMT	*	*	*	*	*	*	*
		CON-00183-01-A	HEADER,MICRO-FIT,8PIN,RA,TH	*	*	*	*	*	*	*
		CON-00185-01-A	HDR,2X12,SHROUDED,2MM,SMT	*	*	*	*	*	*	*
		CON-00186-01-A	SOCKET,240PIN,DDR2,1.8V,VERT	*	*	*	*	*	*	*
		CON-00189-01-A	HDR,1X4,0.1",RA,SHROUDED,THRU	*	*	*	*	*	*	*
		CON-00190-01-A	RECPT, 2X100X.635MM VERT SMT	*	*	*	*	*	*	*
		CON-00191-01-A	1PLUG, 2X100X.635MM VERT SMT	*	*	*	*	*	*	*
		CON-00195-01-A	PLUG,2X30X.05 M,VERT,SHRD,SMT	*	*	*	*	*	*	*
		CON-00196-01-A	CRDEDGE,PCI EXPRESS,X16	*	*	*	*	*	*	*
		CON-00197-01-A	PLUG,20P,0.635MM,STKG,10MM,SMT	*	*	*	*	*	*	*
		CON-00198-01-A	RCPT,20P,0.635MM,STKG,10MM,SMT	*	*	*	*	*	*	*

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		DIO-00021-01-A	ZENER 4.7V .5W SOD123	*	*	*	*	*	*	*
		DIO-00022-01-A	SCHOTTKY,2A,30V,SMA	*	*	*	*	*	*	*
		GEN-00210-01-A	HOLDER, BATTERY HORZ CR2032 SM	*	*	*	*	*	*	*
		HDW-00047-02-A	SCREW M2X5 PH/PN	*	*	*	*	*	*	*
		HDW-00068-01-A	IBM TIE WRAP - 01R1482	*	*	*	*	*	*	*
		HDW-00081-01-A	STANDOFF, HEX4-40 .906"	*	*	*	*	*	*	*
		HDW-00098-01-A	RIVET, SNAP NYL6 D.126 BLUE	*	*	*	*	*	*	*
		HDW-00101-01-A	IBM SLIDE LOCK HANDLE 01R1496	*	*	*	*	*	*	*
		HDW-00106-01-A	STANDOFF, M3 X 6MM HEX NYLON	*	*	*	*	*	*	*
		ICS-00164-01-A	ICS843001, CLK GEN, FC, TSSOP8	*	*	*	*	*	*	*
		ICS-00181-01-A	IC, LTC3406-1.8 TSOT REG STPDN	*	*	*	*	*	*	*
		ICS-00185-01-A	IC 74LVC1G66 SW ANALOG SC70	*	*	*	*	*	*	*
		ICS-00185-01-A-R	IC 74LVC1G66 SW ANALOG SC70	*	*	*	*	*	*	*
		ICS-00186-01-A	IC AAT3562 RESET MNTR 2.7V SOT	*	*	*	*	*	*	*
		ICS-00186-01-A-R	IC AAT3562 RESET MNTR 2.7V SOT	*	*	*	*	*	*	*
		ICS-00188-01-A	80331 I/O PRCSR 500M D0 FCBGA	*	*	*	*	*	*	*
		ICS-00189-01-A	74AUC1G08 2 INPUT AND SC-70	*	*	*	*	*	*	*
		ICS-00190-01-A	IC 512MX16 FLASH 3.3V TFBGA	*	*	*	*	*	*	*
		ICS-00194-01-A	64460 POWER PC SYS CNTRLR	*	*	*	*	*	*	*
		ICS-00195-01-A	16Mx16 DDR2-400 SDRAM,84 FBGA	*	*	*	*	*	*	*
		ICS-00196-01-A	BUFFER,REG,25BIT,SSTL_18,96BGA	*	*	*	*	*	*	*
		ICS-00197-01-A	CLK DRIVER,DIFF,1:10,52P VFBGA	*	*	*	*	*	*	*
		ICS-00198-01-A	32Mx16 DDR2-400 SDRAM,84 FBGA	*	*	*	*	*	*	*
		ICS-00203-01-A	129LV160:16MBIT EEPROM,3.3V,BG	*	*	*	*	*	*	*
		ICS-00204-01-A	29LV320:32MBIT EEPROM,3.3V,BGA	*	*	*	*	*	*	*
		ICS-00205-01-A	XC95288XL-10 CPLD FPBGA256	*	*	*	*	*	*	*
		ICS-00208-01-A	PEX8114, PCI-E TO PCI-X BRIDGE	*	*	*	*	*	*	*
		ICS-00209-01-A	PEX8516, PCI-E SWITCH,312BGA	*	*	*	*	*	*	*
		ICS-00210-01-A	TPS54810, SWITCHING REG,8A	*	*	*	*	*	*	*
		ICS-00216-01-A	TPS62000, SWITCHING REG, 0.6A	*	*	*	*	*	*	*
		ICS-00219-01-A	SCD, 29LVO17-70/90/120UF3VTSOP	*	*	*	*	*	*	*
		ICS-00220-01-A	TPS60205,DC/DC,3.3V,.1A,MSOP10	*	*	*	*	*	*	*
		ICS-00222-01-A	BQ24100,LI-ION CHARGER&DC-DC	*	*	*	*	*	*	*
		ICS-00223-01-A	ICS557-01, PCI-E CLOCK, SOIC8	*	*	*	*	*	*	*
		ICS-00225-01-A	L6932, REGULATOR, ADJ, 2A, SO8	*	*	*	*	*	*	*
		ICS-00229-01-A	ICS93716,DDR CLK DRV,HEX,TSSOP	*	*	*	*	*	*	*
		ICS-00236-01-A	STK14CA8, NVSRAM,128KX8,48SSOP	*	*	*	*	*	*	*
		ICS-00238-01-A	95160, SERIAL EEPROM,16K,SO-8	*	*	*	*	*	*	*
		ICS-00239-01-A	25P80, SPI FLASH EE,8MBIT,SO-8	*	*	*	*	*	*	*
		ICS-00243-01-A	SDRAM,32MX16,DDR2-533,84FBGA	*	*	*	*	*	*	*
		ICS-00244-01-A	ICS342-17, CLK SYNTH (SQUIB)	*	*	*	*	*	*	*
		ICS-00245-01-A	80333,I/O PROC,500MHZ,A0,829BG	*	*	*	*	*	*	*
		ICS-00246-01-A	80333,I/O PROC,800MHZ,A0,829BG	*	*	*	*	*	*	*
		ICS-00247-01-A	MAX8511,REGULATOR,2.5V,120MA	*	*	*	*	*	*	*
		ICS-00249-01-A	VOLTAGE REG,3.3V,150MA,SOT23-5	*	*	*	*	*	*	*
		ICS-00250-01-A	LTC3828,DUAL BUCK DC/DC,32QFN	*	*	*	*	*	*	*
		ICS-00251-01-A	MIC49150, VR, LV ADJ LDO,MSOP8	*	*	*	*	*	*	*
		ICS-00252-01-A	TPS79901, VR,ADJ,0.2A,SOT23-5	*	*	*	*	*	*	*
		ICS-00254-01-A	IC, ICS670-03 CLK MULTPLR SOIC	*	*	*	*	*	*	*
		ICS-00256-01-A	SDRAM,16MX16,DDR2-533,84FBGA	*	*	*	*	*	*	*
		ICS-00257-01-A	ICS345-33,CLK SYNTH,TRP,20SSOP	*	*	*	*	*	*	*
		ICS-00258-01-A	SRAM,512kX36,SYNC,SCD,167MHZ	*	*	*	*	*	*	*

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		ICS-00259-01-A	ISL6123 PWR SUPPL SEQ 24QFN	*	*	*	*	*	*	*
		ICS-00260-02-A	SDRAM,128MX8,DDR2-667,LO POWER	*	*	*	*	*	*	*
		ICS-00261-01-A	ICS9FG108,PROG,FTG,48TSSOP	*	*	*	*	*	*	*
		ICS-00264-01-A	SCD, IC LTC1422 HOTSWP SO8 IBM	*	*	*	*	*	*	*
		ICS-00265-01-A	BUFFER,FANOUT,3.3V/2.5V,SOIC-8	*	*	*	*	*	*	*
		ICS-00269-01-A	PWRPC750GX,D1.2,800MHZ,BGA292	*	*	*	*	*	*	*
		ICS-00271-01-A	SCD, 8Mx16x4 DDR SDRAM IBM	*	*	*	*	*	*	*
		ICS-00301-01-A	IC, TPS64203 VR SW SD ADJ SOT	*	*	*	*	*	*	*
		ICS-PDS39-01-B	DUAL UART,64B FIFO,LQFP	*	*	*	*	*	*	*
		LBL-00096-01-A	LABEL, PCA VERSION "-73"	*	*	*	*	*	*	*
		LBL-00097-01-A	LABEL, PCA VERSION "-74"	*	*	*	*	*	*	*
		LBL-00103-01-A	CAPACITY STARBURST 1.5" LABEL	*	*	*	*	*	*	*
		LBL-00128-01-A	LBL, ROHS BOARD LABEL	*	*	*	*	*	*	*
		LBL-00129-01-A	LBL, ROHSE BOARD LABEL	*	*	*	*	*	*	*
		MAG-00026-01-A	INDUCTOR,EMI,1KOHM@100MHZ,0402	*	*	*	*	*	*	*
		MAG-00027-01-A	IND,PWR,2.2UH,12A,22A SAT	*	*	*	*	*	*	*
		MAG-00029-01-A	IND: 2.2UH 10% 0805	*	*	*	*	*	*	*
		MAG-00032-01-A	IND, CHIP 15UH 20% 0.31A SMT	*	*	*	*	*	*	*
		MAG-00033-01-A	IND, CHIP 10UH 20% 1.84A SMT	*	*	*	*	*	*	*
		MAG-00034-01-A	IND: 0.27UH 2% 110MA 0603	*	*	*	*	*	*	*
		MAG-00035-01-A	INDUCTOR,0.8UH,14.8A,12X10.5MM	*	*	*	*	*	*	*
		MAG-00036-01-A	INDUCTOR,2.2UH,20A,13.2X12.9MM	*	*	*	*	*	*	*
		MAG-00037-01-A	SCD, FERRITE Z120 3A 1206 IBM	*	*	*	*	*	*	*
		MAG-00038-01-A	FERRITE, CHIP Z1K 400MA 0603	*	*	*	*	*	*	*
		MAN-00069-01-A	FLYER, TIE WRAP INSTALL - IBM	*	*	*	*	*	*	*
		MAN-00105-01-A	GUIDE, ASE-335 QUICK INSTALL	*	*	*	*	*	*	*
		MEC-00243-01-A	BRACKET, MARAUDER-X	*	*	*	*	*	*	*
		MEC-00244-01-A	HEATSINK, AL, 30X30X10MM HIGH	*	*	*	*	*	*	*
		MEC-00293-01-A	Bracket, Tiller PCI	*	*	*	*	*	*	*
		OSC-00018-01-A	XTAL, 28.636MHZ 33PF 0603 SMD	*	*	*	*	*	*	*
		OSC-00019-01-A	XTAL, 32MHZ 10PF 0603 4P SMD	*	*	*	*	*	*	*
		OSC-00020-01-A	XTAL, 24MHZ 12PF 0603 4P SMD	*	*	*	*	*	*	*
		OSC-00021-01-A	XTAL,32.768KHZ,12.5PF,DT38	*	*	*	*	*	*	*
		OSC-00025-01-A	XTAL,50MHZ,3.2X2.5MM,50PPM,4PN	*	*	*	*	*	*	*
		PCA-00130-01-A	512MB SODIMM PC2100 ECC CL=2	*	*	*	*	*	*	*
		PCA-00209-01-A	1GB DIMM PC3200 128mx72 ROHS	*	*	*	*	*	*	*
		PCB-00149-01-B	MSTR FILE, CALLISTO RESPIN	*	*	*	*	*	*	*
		PCB-00157-01-A	MSTR FILE, EUROPA 2	*	*	*	*	*	*	*
		PCB-00158-01-A	MSTR FILE, TOE DAUGHTER CARD	*	*	*	*	*	*	*
		PCB-00163-01-B	MSTR FILE, AURORA MULE BOARD	*	*	*	*	*	*	*
		PCB-00184-01-A	MSTR FILE, SQUIB PCI ADAPTER	*	*	*	*	*	*	*
		PCB-00193-01-B	MSTR FILE, ICP5085BR	*	*	*	*	*	*	*
		PCB-00212-01-A	MSTR FILE, ATB-205	*	*	*	*	*	*	*
		PCB-500554-01-K	RAW PCB, 1G LS	*	*	*	*	*	*	*
		PMF-00074-01-A	INSULATOR, EUROPA	*	*	*	*	*	*	*
		RES-00006-AR-A	RES:47.5K,1%, .063W,0603	*	*	*	*	*	*	*
		RES-00006-E9-A	RES: 340, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-S8-A	RES:5.90K,1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-T8-A	RES:7.50K,1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-U2-A	RES:8.25K,1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-W2-A	RES:13.3K,1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-X0-A	RES:16.2K,1%,.063W,0603	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		RES-00007-AF-A	RES: 37.4K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-AG-A	RES: 38.3K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-DH-A	RES: 221K 1% 0.0625W 0402	*	*	*	*	*	*	*
		RES-00007-EK-A	RES: 412K 1% 0.0625W 0402	*	*	*	*	*	*	*
		RES-00007-S1-A	RES: 4.99K 1% 0.0625W 0402	*	*	*	*	*	*	*
		RES-00007-U7-A	RES: 9.31K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-V3-A	RES: 10.7K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-V7-A	RES: 11.8K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-X6-A	RES: 18.7K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-Y7-A	RES: 24.3K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00008-40-A	RES: 390, 5%, .063W, 0402	*	*	*	*	*	*	*
		RES-00008-56-A	RES: 1.8K, 5%, 0.0625W, 0402	*	*	*	*	*	*	*
		RES-00008-85-A	RES: 30K 5% 0.0625W 0402	*	*	*	*	*	*	*
		RES-00008-C3-A	RES: 1OHM 5% 0.0625W 0402	*	*	*	*	*	*	*
		RES-00046-01-A	RES:0.017,1%,0.25W,1206	*	*	*	*	*	*	*
		RES-00048-01-A	RES: 1KX8, 5%, .031W, 1206	*	*	*	*	*	*	*
		RES-00074-01-A	SCD, RES 0.005 1% 1W 2512 IBM	*	*	*	*	*	*	*
		RES-PDS04-G2-A	RES:0.01 OHM,1%,0.5W,1206	*	*	*	*	*	*	*
		RES-PDS04-G4-A	RES:0.015 OHM,1%,0.5W,1206	*	*	*	*	*	*	*
		TRN-00021-01-A	SI7336A NCH MOS,30V,30A,PWRPAK	*	*	*	*	*	*	*
		TRN-00022-01-A	SI7390 NCH MOS,30V,15A,PWRPAK	*	*	*	*	*	*	*
RAWS		CBL-200101-006	POWER CORD JAP AC, 2M	*	*	*	*	*	*	*
		CBL-200104-006	PWR CRD,2.5M,IEC C13-C14	*	*	*	*	*	*	*
		CBL-SFPHSDC-2.0STR	FC CU CABLE, SFP, 2M, STRATUS	*	*	*	*	*	*	*
		HDW-00028-01-A	SCREW, 6-32 X .19 PH/PN	*	*	*	*	*	*	*
WIPB		1619606-02	PCA, ANA-6911A/TX HP OSSD	*	*	*	*	*	*	*
		1669600	ANA-6911A/AUI HP NTWRK ADAPTER	*	*	*	*	*	*	*
		1700706-00	PCA, ANA-62011/TX	*	*	*	*	*	*	*
		1861206-00	PCA, AFC-9110G	*	*	*	*	*	*	*
		1864206-01	PCA, AFC-9210C/LPC	*	*	*	*	*	*	*
		1864206-02	PCA, AFC-9210/LP	*	*	*	*	*	*	*
		1909106-00	PCA, ANA-64044LV	*	*	*	*	*	*	*
		1925306-00	PCA, ANA-64022LV	*	*	*	*	*	*	*
		1926000	CD ASSY, DL5.1a wDS/USR62X/64X	*	*	*	*	*	*	*
		1929800	CD ASSY, ASR/AAR v1.1/GUIDES	*	*	*	*	*	*	*
		1937703-00	BC2015/3B0A/162/0079112/STD2/1	*	*	*	*	*	*	*
		1969006-00	PCA, ANA-7711F	*	*	*	*	*	*	*
		1988906-00	PCA, ANA-7711C	*	*	*	*	*	*	*
		2011717-00	BC2010/3B0A/162/0079112/STD2/1	*	*	*	*	*	*	*
		2012900	CD ASSY,DURALINK64 v5.2 wDS/GD	*	*	*	*	*	*	*
		2073606-01	PCA,INT LVDS SETRM CRD RoHS 00	*	*	*	*	*	*	*
		2092006-00-D	PCA, METIS	*	*	*	*	*	*	*
		2101006-00-C	PCA, THEBE SR	*	*	*	*	*	*	*
		2127506-00	PCA, T-CARD	*	*	*	*	*	*	*
		492236-00	(OBS)SCD, LOW DENSITY 3FT CBL	*	*	*	*	*	*	*
		492238-00	SCD, 5 POSITION SCSI CABLE	*	*	*	*	*	*	*
		MAN-00088-01-A	CARD, WEEE NOTIFICATION	*	*	*	*	*	*	*
		PCA-00149-01-B	CALLISTO RESPIN FIBRE CHAN 733	*	*	*	*	*	*	*
		PCA-00149-11-B	CALLISTO RESPIN ISCSI 733	*	*	*	*	*	*	*
		PCA-00181-01-A	SKIFF4V (BIREME)	*	*	*	*	*	*	*
		PCA-00195-01-A	TILLER (KNORR)	*	*	*	*	*	*	*
		PCA-00196-01-A	VATHMAL (KNORR)	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		TCA-00150-01-A	THESE SR RESPIN TEST CIR ASSY	*	*	*	*	*	*	*
		TCA-00181-01-A	SKIFF-4V TEST CIRCUIT ASSY	*	*	*	*	*	*	*
440	RAWB	RES-00006-E8-A	RES: 332, 1%, .063W, 0603	*	*	*	*	*	*	*
	RAWS	ASM-00089-19-B	ENZO FC IO CAN ASSY TOOL-LESS	*	*	*	*	*	*	*
		GEN-00162-08-A	LBL, 146GB FC DRV - AVID	*	*	*	*	*	*	*
		ICS-PDS46-01-A	HEX FC PBC W/2 RPTR/RTMR	*	*	*	*	*	*	*
		LBL-00016-09-A	LABEL, FIBRE 300GB BLUE ALTEVO	*	*	*	*	*	*	*
		LBL-00016-10-A	LABEL, FIBRE 300GB BLAK ALTEVO	*	*	*	*	*	*	*
		LBL-00067-01-A	AES-1700 FC BZL LBL DS400	*	*	*	*	*	*	*
		LBL-00091-01-A	300GB SANBLOC FC DRV - GRAY	*	*	*	*	*	*	*
		LBL-00091-02-A	300GB SANBLOC FC DRV - BLU	*	*	*	*	*	*	*
		LBL-00091-04-A	300GB SANBLOC FC DRV COOLGRAY	*	*	*	*	*	*	*
		LBL-00107-01-A	LABEL, RACK, FS6500	*	*	*	*	*	*	*
		LBL-00109-01-A	LABEL, RACK, FS7500	*	*	*	*	*	*	*
		MAN-FC2002-002	2GB USER GUIDE, ACER	*	*	*	*	*	*	*
	WIPB	PCA-BXF204-02-C	2GB IO CU/CU-EL	*	*	*	*	*	*	*
		PCA-BXF206-06-A	2GB LS, FUJ SIEM	*	*	*	*	*	*	*
		PCA-BXF206-07-B	2GB SANBLOC LS, XIOTECH	*	*	*	*	*	*	*
		PCA-BXF206-08-A	2GB LS, ACER	*	*	*	*	*	*	*
	WIPS	2091706-01-G	PCA, CALLISTO FIBRE CHAN 733	*	*	*	*	*	*	*
		ASM-00044-02-A	2GB OPT/CU IO MODULE, EL	*	*	*	*	*	*	*
		ASM-00045-02-A	2GB OPT/OPT IO MODULE, E	*	*	*	*	*	*	*
		ASM-00087-02-A	2U EMPTY CAR/SHLD GRAY	*	*	*	*	*	*	*
		ASM-00089-14-A	MIDWAY FC / HANDLE BASE ASSY	*	*	*	*	*	*	*
		ASM-00101-01-A	2U ES CANISTER ASSY	*	*	*	*	*	*	*
		ASM-00138-01-A	2U RACK MOUNT KIT	*	*	*	*	*	*	*
		ASM-00145-01-A	2U 2X IO BLANK ASSY	*	*	*	*	*	*	*
		ASM-00159-01-A	2U ES MODULE ASSY, 10 P	*	*	*	*	*	*	*
		ASM-00196-01-A	2U DRIVE CARRIER, BLANK	*	*	*	*	*	*	*
		ASM-00268-01-B	AES-1700 FC RAID CONT MOD	*	*	*	*	*	*	*
		ASM-00268-01-C	AES-1700 FC RAID CONT MOD	*	*	*	*	*	*	*
		ASM-00270-01-B	AES-1700 FC I/O CANST ASSY	*	*	*	*	*	*	*
		ASM-00270-01-C	AES-1700 FC I/O CANST ASSY	*	*	*	*	*	*	*
		ASM-00288-01-A	AES-1700 FC FRNT BZL SUB	*	*	*	*	*	*	*
		ASM-00295-01-B	AES-1700 FC RAID MOD W/O MEM	*	*	*	*	*	*	*
		ASM-00297-01-B	AES-1700 FC I/O ASSY W/OMEMBAT	*	*	*	*	*	*	*
		ASM-00382-02-A	SANbloc 5000F-SR SGL FC SHELF	*	*	*	*	*	*	*
		EMA-BXF110-03-D	2GB LS ASSY, (BLACK)-EL	*	*	*	*	*	*	*
		EMA-BXF110-04-A	ASSY, 2GB LS	*	*	*	*	*	*	*
		EMA-BXF110-06-B	ASSY, 2GB LS	*	*	*	*	*	*	*
		EMA-BXF111-02-D	ASSY LS BLU BOXSTORE 1GB	*	*	*	*	*	*	*
		MEC-00009-15-B	FFX2 CAN/BHD, NON-E	*	*	*	*	*	*	*
		MEC-BXF102-04-A	ASSEMBLY, DRIVE CARRIER	*	*	*	*	*	*	*
		PAK-00046-02-B	2U,SHELF SINGLE, AVID	*	*	*	*	*	*	*
		PAK-00046-03-B	2U,SHELF SINGLE, PILLAR	*	*	*	*	*	*	*
		PAK-00048-01-B	2U,DRIVES,6 PK	*	*	*	*	*	*	*
		PAK-00049-01-A	2U,DRIVES,12 PACK.	*	*	*	*	*	*	*
		PAK-00049-01-B	2U,DRIVES,12 PK	*	*	*	*	*	*	*
		PAK-00050-01-A	2U, FRU,SINGLE.(UNIV)	*	*	*	*	*	*	*
		PAK-00051-01-A	2U, RAIL-KIT,UNIV.	*	*	*	*	*	*	*
		PAK-00052-01-A	2U,FRU, MULTI-PAK	*	*	*	*	*	*	*
		PAK-00058-01-A	2U,PAK48B,6PK,ENCAPS	*	*	*	*	*	*	*

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		PAK-00059-01-A	2U,PAK48B,6PK,CARTON	*	*	*	*	*	*	*
		PAK-00087-01-A	2U, TOWER	*	*	*	*	*	*	*
		PAK-00088-01-A	2U, 4PK, DRV BLANK	*	*	*	*	*	*	*
		PAK-00114-01-A	2U, RAIL KIT PAK, GENER	*	*	*	*	*	*	*
		PCA-00058-02-B	ASSY - PDS 2U FC BACKPLANE	*	*	*	*	*	*	*
		PCA-BXF205-01-A	2GB IO OPT/CU-EL	*	*	*	*	*	*	*
		PWR-00012-01-B	POWER SUPPLY, JUPITER	*	*	*	*	*	*	*
		PWR-00012-01-C	POWER SUPPLY, JUPITER	*	*	*	*	*	*	*
441	RAWB	1496923-00	BOX, AES-iSA1500 MASTER	*	*	*	*	*	*	*
		1496924-00	FOAM SET, 1U ENDCAP	*	*	*	*	*	*	*
		1496925-00	FOAM SET, 4 HDD	*	*	*	*	*	*	*
		1496926-00	INSERT, AES-iSA1500	*	*	*	*	*	*	*
		1496927-00	BOX, AES-iSA1500 INNER W/INSRT	*	*	*	*	*	*	*
		1496928-00	BAG, 39 1/3"x54 2/3"ANTISTATIC	*	*	*	*	*	*	*
		1496965-00	BOX, 18.9"x2.56"x1.77" BEZEL	*	*	*	*	*	*	*
		1497300-00	SCD, CABLE I2C 3-4P 26AWG .58M	*	*	*	*	*	*	*
		16795	IOTH BD, SUPERMICRO X5DPR-IG21	*	*	*	*	*	*	*
		16796	CHASSIS, SUPERMICRO 813T 4SATA	*	*	*	*	*	*	*
		16797	DIMM, 64MX72 DDR266B ECC 1.12H	*	*	*	*	*	*	*
		16798	PLUG IN, 128MB FL5H DISK 40PIN	*	*	*	*	*	*	*
		16799	HT SINK, SNK-0039 1U 89X78X26	*	*	*	*	*	*	*
		16800	PLUG IN, RISER CARD 1U 3.3V LP	*	*	*	*	*	*	*
		16802	RETAINER, HT SINK SKT-120	*	*	*	*	*	*	*
		16847	IC, 80532 CPU XEON 1.6G FCPGA	*	*	*	*	*	*	*
		16848	PLUG IN, PRO/100S 10/100EN NIC	*	*	*	*	*	*	*
		16849	BEZEL, FRONT SUPERMICRO 813T	*	*	*	*	*	*	*
		16870	IC, 80532 CPU CELRON2.0G FCPGA	*	*	*	*	*	*	*
		16891	CONN, RJ45 8P M PLUG RND CABLE	*	*	*	*	*	*	*
		16895	DIMM, 64MX72 PC2100 ECC UBF LP	*	*	*	*	*	*	*
		16943	CARRIER, DRIVE CSE-PT39B	*	*	*	*	*	*	*
		2079300	CD ASSY, iSA1500 v1.0 GUIDE	*	*	*	*	*	*	*
		513675-03JA	GUIDE, SA iSA1500/JA QK START	*	*	*	*	*	*	*
		513740-00	LBL, WARNING HDD PACKAGING	*	*	*	*	*	*	*
		513742-00	LBL, BEZEL iSA1500	*	*	*	*	*	*	*
		513808-00	LABEL, RJ45 RMV FOR MULTIPLE	*	*	*	*	*	*	*
		513864-00	LBL, BLACK BEZEL ESA/iSA1500	*	*	*	*	*	*	*
		513879-00	LBL, iSA1500 COMPLIANCE LABEL	*	*	*	*	*	*	*
	RAWS	16794	HDD, MAXTOR 250GB 3.5" SATA	*	*	*	*	*	*	*
		16866	MOTH BD, SUPERMICRO P4SCE-0	*	*	*	*	*	*	*
		16867	CHASSIS, SUPERMICRO CSE-813M	*	*	*	*	*	*	*
		16868	HT SINK, SNK-0032 1U P4 478PIN	*	*	*	*	*	*	*
		16869	RETAINER, HT SINK SKT-0115	*	*	*	*	*	*	*
		16879	PLUG IN, RISER CARD 32 BIT 1U	*	*	*	*	*	*	*
		2154000	CD ASSY, iSA1500 v1.1B32 GUIDE	*	*	*	*	*	*	*
		2154000JA	CD ASSY, iSA1500/JA v1.1B32 GD	*	*	*	*	*	*	*
		BAT-00004-01-A	1800MAH 4.2V LION BAT ISA4500	*	*	*	*	*	*	*
		LBL-00066-01-A	AES-1701 ISCSI BZL LBL DS300	*	*	*	*	*	*	*
		LBL-00076-01-A	CALLISTO, BAT BKT TOUCH LABEL	*	*	*	*	*	*	*
		LBL-00082-01-A	LABEL, RACK, ISA4500	*	*	*	*	*	*	*
	WIPS	2091706-11-G	PCA, CALLISTO ISCSI 733	*	*	*	*	*	*	*
		ASM-00269-01-B	AES-1701 ISCSI RAID CONT MOD	*	*	*	*	*	*	*
		ASM-00269-01-C	AES-1701 ISCSI RAID CONT MOD	*	*	*	*	*	*	*

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		ASM-00271-01-B	AES-1701 ISCSI I/O CANST ASSY	*	*	*	*	*	*	*
		ASM-00271-01-C	AES-1701 ISCSI I/O CANST ASSY	*	*	*	*	*	*	*
		ASM-00289-01-A	AES-1701 ISCSI FRNT BZL SUB	*	*	*	*	*	*	*
		ASM-00296-01-B	AES-1701 ISCSI RD MOD W/O MEM	*	*	*	*	*	*	*
		ASM-00309-01-B	AES-1701 ISCSI-RL RAID CON MOD	*	*	*	*	*	*	*
		ASM-00310-01-B	AES-1701-RL ISCSI RD MD W/OMEM	*	*	*	*	*	*	*
442	RAWS	ICS-00175-01-A	SAS EDGE EXPANDER,12PORT	*	*	*	*	*	*	*
		LBL-00095-01-A	2U CARRIER LBL, SAS, 73GB GRAY	*	*	*	*	*	*	*
		LBL-00095-02-A	2U CARRIER LBL, SAS, 73GB BLK	*	*	*	*	*	*	*
		LBL-00095-03-A	2U CARRIER LBL, SAS 146GB GRAY	*	*	*	*	*	*	*
		LBL-00095-04-A	2U CARRIER LBL, SAS, 146GB BLK	*	*	*	*	*	*	*
		LBL-00095-05-A	2U CARRIER LBL, SAS 300GB GRAY	*	*	*	*	*	*	*
		LBL-00095-06-A	2U CARRIER LBL, SAS, 300GB BLK	*	*	*	*	*	*	*
		LBL-00095-07-A	2U CARRIER LBL, SAS, 36GB GRAY	*	*	*	*	*	*	*
		LBL-00095-08-A	2U CARRIER LBL, SAS, 36GB BLK	*	*	*	*	*	*	*
		PCB-00115-01-B	SAS MIDPLANE BARE ETCH	*	*	*	*	*	*	*
		PCB-00167-01-A	MSTR FILE, SAS 24port JBOD IO	*	*	*	*	*	*	*
	WIPS	ASM-00089-18-A	SAS 24 PORT I/O HNDL ASSY TOOL	*	*	*	*	*	*	*
		ASM-00089-18-B	SAS 24 PORT, I/O HANDLE ASSY	*	*	*	*	*	*	*
		ASM-00372-01-A	MIDWAY SAS RAID CARD ASSY	*	*	*	*	*	*	*
		ASM-00524-01-A	SAS 24-PORT I/O PROG PROCESSOR	*	*	*	*	*	*	*
		TCA-00115-01-A	ALTEVO SAS MIDPLANE, TESTED	*	*	*	*	*	*	*
		TCA-00115-01-C	ALTEVO SAS MIDPLANE, TESTED	*	*	*	*	*	*	*
		TCA-00167-01-A	SAS 24port JBOD IO, TESTED	*	*	*	*	*	*	*
443	RAWS	ASA-LBL-3178	AVID DRIVE 18GB LABEL	*	*	*	*	*	*	*
		LBL-00015-09-A	LABEL, SCSI 300GB WINE ALTEVO	*	*	*	*	*	*	*
		LBL-00015-10-A	LABEL, SCSI 300GB BLAK ALTEVO	*	*	*	*	*	*	*
		LBL-00022-05-A	LABEL, SCSI, 300GB AVID ALETVO	*	*	*	*	*	*	*
		LBL-00090-01-A	300GB U-BLOC SCSI DRV - GRAY	*	*	*	*	*	*	*
		LBL-00090-03-A	300GB U-BLOC SCSI DRV - WINE	*	*	*	*	*	*	*
		LBL-00090-04-A	300GB U-BLOC SCSI DRV COOLGRAY	*	*	*	*	*	*	*
		MAN-00035-01-A	GUIDE,U320/IBM SCSI CNTRL2 INS	*	*	*	*	*	*	*
	WIPS	MEC-BXG106-01-A	ASSY, DRV CARRIER BLANK	*	*	*	*	*	*	*
		MEC-BXG106-03-A	ASSY, DRV CARRIER BLANK	*	*	*	*	*	*	*
		MEC-BXG106-04-A	ASSY, DRV CARRIER BLANK	*	*	*	*	*	*	*
444	RAWB	17044	BUMPER, PU .81SQX.3 BLK ADHSV	*	*	*	*	*	*	*
		513811-03JA	GUIDE, FILE SAVER QK START/JA	*	*	*	*	*	*	*
	RAWS	BAT-00006-01-A	AES-xS6500 3.7V 7.2AH LION BAT	*	*	*	*	*	*	*
		LBL-00053-01-A	AES-170X 3 PERSON LIFT LABEL	*	*	*	*	*	*	*
		LBL-00068-01-A	AES-170X BEZEL FRU LABEL COMBO	*	*	*	*	*	*	*
		LBL-00072-01-A	AES-170X DUAL LINE SAFETY LBL	*	*	*	*	*	*	*
		LBL-00078-01-A	LABEL, AEX-170X OVERHEAT WARN	*	*	*	*	*	*	*
		MAN-00013-01-A	CARD, AES-170X REMOTE MIR LIC	*	*	*	*	*	*	*
		MAN-00014-01-A	FLYER, AES-170X CONTENTS	*	*	*	*	*	*	*
		MAN-00015-01-A	CARD, AES-170X FLASHCOPY LIC	*	*	*	*	*	*	*
		MAN-00016-01-A	CARD, AES-170X JBOD EXPAND LIC	*	*	*	*	*	*	*
		MAN-00017-01-A	AES-170X RACK INSTL INSTRUCT	*	*	*	*	*	*	*
		MAN-00018-01-A	AES-170X RACKMOUNT TEMPLATE	*	*	*	*	*	*	*
		MAN-00019-01-A	FLYER, AES-170X SAFETY INFORM	*	*	*	*	*	*	*
		MAN-00020-01-A	MANUAL, AES-1701 PWR SPLY OPT	*	*	*	*	*	*	*
		MAN-00021-01-A	FLYER, AES-170X TECH UPDATE	*	*	*	*	*	*	*
		MAN-00022-01-A	GUIDE, AES-170X QUICK INST HRD	*	*	*	*	*	*	*

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		MAN-00022-03-A	GUIDE, AES-170X DUAL QK IN HRD	*	*	*	*	*	*	*
		MAN-00044-02-A	FLYER, AES-170X DUAL FW UPGRAD	*	*	*	*	*	*	*
		PAK-00135-01-A	AES-170X PALLET	*	*	*	*	*	*	*
		PAK-00136-01-A	AES-170X FRONT BEZEL BOX	*	*	*	*	*	*	*
		PAK-00137-01-A	FOAM, AES-170X FRONT BEZEL	*	*	*	*	*	*	*
		PAK-00156-01-A	BOX, AES-170X BATTERY FRU	*	*	*	*	*	*	*
		PAK-00158-01-A	FOAM, AES-170X BATTERY FRU CTR	*	*	*	*	*	*	*
		PAK-00169-01-A	INSERT, AES-170X FRONT BEZEL	*	*	*	*	*	*	*
		PAK-00170-01-A	BOX, AES-170X PSU/7 HDD FRU	*	*	*	*	*	*	*
		PAK-00171-01-A	INSERT, AES-170X PSU/7 HDD FRU	*	*	*	*	*	*	*
		PAK-00172-01-A	FOAM, AES-170X PSU/7 HDD TOP	*	*	*	*	*	*	*
	WIPS	ASM-00266-01-A	AES-170X CHASSIS BEZEL ASSY	*	*	*	*	*	*	*
		ASM-00286-01-A	AES-170X ACCESSORY KIT SUBASSY	*	*	*	*	*	*	*
		ASM-00287-01-A	AES-170X RAIL KIT SUB ASSY	*	*	*	*	*	*	*
		ASM-00348-01-A	AES-xS6500 ENZO SS MODULE ASSY	*	*	*	*	*	*	*
		PAK-00143-01-A	AES-170X MSTR BOX ASSY W/O CAR	*	*	*	*	*	*	*
445	RAWB	CAP-00079-01-A	22PF,5%,50V,C0G,0402	*	*	*	*	*	*	*
		ICS-00087-01-A	256KX16 EE,55NS,3.3V,ALL	*	*	*	*	*	*	*
	RAWS	0130-00674-01	AVID WARRANTY CARD R000	*	*	*	*	*	*	*
		0130-05333-01	INSTALL STANDALONE MAN	*	*	*	*	*	*	*
		CAB-BXF203-01-A	RS232 CABLE DB9F	*	*	*	*	*	*	*
		DRV-00003-01-A	CHEETAH 5 36LD 10K U160	*	*	*	*	*	*	*
		DRV-00006-01-A	CHEETAH 5 73LP 10K U160.	*	*	*	*	*	*	*
		DRV-00007-01-A	CHEETAH 5 73LP 10K FCAL	*	*	*	*	*	*	*
		DRV-00008-01-A	CHEETAH 5 36LD 10K FCAL	*	*	*	*	*	*	*
		DRV-00011-01-A	SEAGATE BARRACUDA 180GB	*	*	*	*	*	*	*
		DRV-00025-01-A	CHEETAH 10K.6 U320 146GB	*	*	*	*	*	*	*
		DRV-00026-01-A	CHEETAH 10K.6 U320 73GB	*	*	*	*	*	*	*
		DRV-00027-01-A	CHEETAH 10K.6 U320 36GB	*	*	*	*	*	*	*
		DRV-00028-01-A	CHEETAH 10K.6 FC 146GB	*	*	*	*	*	*	*
		DRV-00029-01-A	CHEETAH 10K.6 FC 73GB	*	*	*	*	*	*	*
		DRV-00030-01-A	CHEETAH 10K.6 FC 36GB	*	*	*	*	*	*	*
		DRV-00032-01-A	CHEETAH 15K.3 FC 73GB	*	*	*	*	*	*	*
		DRV-00033-01-A	CHEETAH 15K.3 FC 36GB	*	*	*	*	*	*	*
		DRV-00034-01-A	CHEETAH 15K.3 FC 18GB	*	*	*	*	*	*	*
		DRV-00035-01-A	CHEETAH 15K.3 U320 73GB	*	*	*	*	*	*	*
		DRV-00036-01-A	CHEETAH 15K.3 U320 36GB	*	*	*	*	*	*	*
		DRV-00039-01-A	DAYTONA FC 146GB	*	*	*	*	*	*	*
		DRV-00040-01-A	DAYTONA FC 73GB	*	*	*	*	*	*	*
		DRV-00044-01-A	DAYTONA U320 146GB	*	*	*	*	*	*	*
		DRV-00045-01-A	DAYTONA U320 73GB	*	*	*	*	*	*	*
		DRV-00049-01-A	DIAMONDMAX +9 200GB SATA	*	*	*	*	*	*	*
		DRV-00052-01-A	MAXLINE II+ 250GB SATA	*	*	*	*	*	*	*
		DRV-00057-01-A	CUDA 7200.7 SATA 160GB	*	*	*	*	*	*	*
		DRV-00058-01-A	CUDA 7200.7 SATA 80GB	*	*	*	*	*	*	*
		DRV-00062-01-A	DESKSTAR 250GB SATA	*	*	*	*	*	*	*
		DRV-00065-01-A	CHEETAH 15K.4 U320 146GB	*	*	*	*	*	*	*
		DRV-00066-01-A	CHEETAH 15K.4 U320 73GB	*	*	*	*	*	*	*
		DRV-00067-01-A	CHEETAH 15K.4 U320 36GB	*	*	*	*	*	*	*
		DRV-00068-01-A	CHEETAH 10K.7 U320 300GB	*	*	*	*	*	*	*
		DRV-00069-01-A	CHEETAH 10K.7 U320 146GB	*	*	*	*	*	*	*
		DRV-00070-01-A	CHEETAH 10K.7 U320 73GB	*	*	*	*	*	*	*

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		DRV-00071-01-A	DESKSTAR 7K400 SATA 400GB	*	*	*	*	*	*	*
		DRV-00072-01-A	MAP 10K 147GB U320	*	*	*	*	*	*	*
		DRV-00075-01-A	CHEETAH 10K.7 FC 300GB	*	*	*	*	*	*	*
		DRV-00076-01-A	CHEETAH 10K.7 FC 146GB	*	*	*	*	*	*	*
		DRV-00077-01-A	CHEETAH 10K.7 FC 73GB	*	*	*	*	*	*	*
		DRV-00078-01-A	CHEETAH 15K.4 FC 146GB	*	*	*	*	*	*	*
		DRV-00079-01-A	CHEETAH 15K.4 FC 73GB	*	*	*	*	*	*	*
		DRV-00079-01-B	CHEETAH 15K.4 FC 73GB RoHS	*	*	*	*	*	*	*
		DRV-00080-01-A	CHEETAH 15K.4 FC 36GB	*	*	*	*	*	*	*
		DRV-00081-01-A	HITACHI 10K300 U320 300GB	*	*	*	*	*	*	*
		DRV-00082-01-A	HITACHI 10K300 U320 147GB	*	*	*	*	*	*	*
		DRV-00083-01-A	HITACHI 10K300 U320 73GB	*	*	*	*	*	*	*
		DRV-00085-01-A	HITACHI 10K300 FC 147GB	*	*	*	*	*	*	*
		DRV-00086-01-A	HITACHI 10K300 FC 73GB	*	*	*	*	*	*	*
		DRV-00088-01-A	CHEETAH 15K.4 SAS 36GB	*	*	*	*	*	*	*
		DRV-00092-01-A	AVID CHEETAH 10K.7 U320 300GB	*	*	*	*	*	*	*
		DRV-00093-01-A	AVID CHEETAH 10K.7 U320 146GB	*	*	*	*	*	*	*
		DRV-00094-01-A	1VID CHEETAH 10K.7 U320 73GB	*	*	*	*	*	*	*
		DRV-00095-01-A	AVID CHEETAH 10K.7 FC 146GB	*	*	*	*	*	*	*
		DRV-00096-01-A	AVID CHEETAH 10K.7 FC 73GB	*	*	*	*	*	*	*
		DRV-00100-01-A	Hitachi T7K250 SATA 160GB	*	*	*	*	*	*	*
		DRV-00101-01-A	Hitachi 7K500 SATA 500GB	*	*	*	*	*	*	*
		DRV-00107-01-A	WD 250GB PATA WD2500SB-01KBC0	*	*	*	*	*	*	*
		GEN-00032-01-A	LBL 180GB G5 DRV AVID	*	*	*	*	*	*	*
		GEN-00048-01-A	LABEL, 36GB 10K DRIVE	*	*	*	*	*	*	*
		GEN-00055-01-A	LABEL, DRV CARRIER SOLID	*	*	*	*	*	*	*
		GEN-00162-02-A	LBL, 146GB FC DRV - BLUE	*	*	*	*	*	*	*
		GEN-00168-02-A	LABEL AVID DRV 73 LVD	*	*	*	*	*	*	*
		GEN-00168-03-A	LABEL AVID DRV 36 LVD	*	*	*	*	*	*	*
		HDA-07N3230S	IBM DRIVE 36GB 10K RPM RS80D	*	*	*	*	*	*	*
		HDA-07N3240S	IBM DRIVE 18GB 10K RPM RS80D	*	*	*	*	*	*	*
		HDA-ST136403LC	SEAGATE 36GB 10K RPM LVD R0002	*	*	*	*	*	*	*
		HDA-ST150176LC	SEAGATE 50GB 7200K RPM R0002	*	*	*	*	*	*	*
		HDA-ST318275LC	SEAGATE 18GB LVD BARA 3 R0001	*	*	*	*	*	*	*
		HDA-ST39102LC	9GB SEAGATE DRIVE R0004	*	*	*	*	*	*	*
		HDA-ST-9N7004-048	SEAGATE 36GB 10K UNIQUE RNA00	*	*	*	*	*	*	*
		HDA-ST-9N7004-060	SEAGATE 520BPS 36GB 10K R000	*	*	*	*	*	*	*
		HDA-ST-9N9001-002	SEAGATE DRIVE 18GB 10K R0002	*	*	*	*	*	*	*
		HDA-ST-9R7004-044	SEAGATE 18GB 10K UNIQUE RNA00	*	*	*	*	*	*	*
		HDW-00026-01-A	SPRING, DRIVE CARRIER	*	*	*	*	*	*	*
		HDW-00036-01-A	DRIVE SCREWS, PACK X 60	*	*	*	*	*	*	*
		HDW-200107-003	RIVET 1/8" X .188" CK	*	*	*	*	*	*	*
		HDW-200134-001	SCREW 6-32X1/4" PH/CK	*	*	*	*	*	*	*
		HDW-300022	SCREW 8-32X.25" PH/CK	*	*	*	*	*	*	*
		HDW-300039	SCREW 10-32X.25" PH/PN	*	*	*	*	*	*	*
		HDW-300043	SCREW 10-32UNFX.5" PH/CK	*	*	*	*	*	*	*
		HDW-300044	WASHER, CONICAL #10	*	*	*	*	*	*	*
		HDW-300052	SCREW 10-32X.75" PH/TR	*	*	*	*	*	*	*
		HDW-300066	SCREW, 10-32X.31" PH/TR	*	*	*	*	*	*	*
		LBL-BXG302-01-A	LABEL, 18GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG302-02-A	LABEL, 18GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG303-01-A	LABEL, 36GB DRV CARRIER	*	*	*	*	*	*	*

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		LBL-BXG303-02-A	LABEL, 36GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG303-04-A	LABEL, 36GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG303-08-A	LABEL, 36GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG304-01-A	LABEL, DRIVE BLANK	*	*	*	*	*	*	*
		LBL-BXG313-01-A	LABEL, 73GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG313-02-A	LABEL, 73GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG313-04-A	LABEL, 73GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG313-08-A	LABEL, 73GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG314-02-A	LABEL, 146GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-BXG314-08-A	LABEL, 146GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR005-01-B	LABEL, 18GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR005-03-B	LABEL, 18GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR006-01-B	LABEL, 36GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR006-03-B	LABEL, 36GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR006-04-B	LABEL, 36GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR007-01-B	LABEL, 73GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR007-03-B	LABEL, 73GB DRV CARRIER	*	*	*	*	*	*	*
		LBL-CAR007-04-B	LABEL, 73GB DRV CARRIER	*	*	*	*	*	*	*
		MAN-0012-UG	DISK DRIVE HANDLING INST	*	*	*	*	*	*	*
		MEC-00190-01-A	7DRIVE OUTER BEZEL	*	*	*	*	*	*	*
		MEC-BXG310-01-B	BEZEL, DRIVE CARRIER	*	*	*	*	*	*	*
		MEC-BXG347-01-A	KEY, DRIVE CARRIER	*	*	*	*	*	*	*
		PMF-00010-01-A	CAM, DRIVE CARRIER	*	*	*	*	*	*	*
		PMF-00011-01-A	LIGHTPIPE, DRIVE CARRIER	*	*	*	*	*	*	*
		PMF-00012-01-A	BEZEL, DRIVE CARRIER	*	*	*	*	*	*	*
		PMF-00027-01-B	DRIVE LOCKOUT, ADAPTEC	*	*	*	*	*	*	*
	WIPS	ASM-00195-03-B	PDS 250G 7200 DSATA REAR, HGST	*	*	*	*	*	*	*
		ASM-00354-01-A	DRV 2U BLU 36GB 15K4 SAS SGATE	*	*	*	*	*	*	*
		EMA-XJ500-218-A	JAG DRIVE SCSI I/O	*	*	*	*	*	*	*
		MEC-BXG106-02-A	ASSY, DRV CARRIER BLANK	*	*	*	*	*	*	*
		PAK-00020-02-C	7 X DRIVE PACK BLANK	*	*	*	*	*	*	*
		PAK-00024-02-A	PACK, 2GB DRIVE SNG UNBR	*	*	*	*	*	*	*
		PAK-ASA008-C	AVID 40 DRIVE PACK	*	*	*	*	*	*	*
446	RAWB	2139000	CD ASSY, ESA1500 v1.1/GUIDE	*	*	*	*	*	*	*
		2144200JA	CD ASSY, ESA1500/JA v1.2/GUIDE	*	*	*	*	*	*	*
	RAWS	2144200	CD ASSY, ESA1500 v1.2/GUIDE	*	*	*	*	*	*	*
		LBL-00080-01-B	LBL, AES-170X REG COMPLY WEEE	*	*	*	*	*	*	*
	WIPS	ASM-00453-01-A	ASE-335 BEIGE ENCLOSURE	*	*	*	*	*	*	*
		ASM-00453-02-A	ASE-335 BLACK ENCLOSURE	*	*	*	*	*	*	*
479	RAWB	1494042-00	SCD, ADS SCSI TERMINATOR	*	*	*	*	*	*	*
		1495264-00	BOX, 12" X 10.5" X 3" KRAFT	*	*	*	*	*	*	*
		1495265-00	BOX,15 15/32X12 7/16X11 7/32MS	*	*	*	*	*	*	*
		1495266-00	INSERT, ADS-U160 CLSTR KIT	*	*	*	*	*	*	*
		1496666-00	BAG, 9" x 23.5" STATIC SHIELD	*	*	*	*	*	*	*
		1496667-00	FOAM, 17.1"x 5.5"x 0.75"	*	*	*	*	*	*	*
		1496668-00	BOX, 18.5"x 6.14"x 4.13" KIT	*	*	*	*	*	*	*
		1496669-00	BOX, 21.9"x 19.1"x 7" MSTR	*	*	*	*	*	*	*
		16119	RES, CHIP 3.48K 1% 1/16W 0402	*	*	*	*	*	*	*
		16122	RES, CHIP 4.12K 1% 1/16W 0402	*	*	*	*	*	*	*
		16156	RES, CHIP 13.0K 1% 1/16W 0402	*	*	*	*	*	*	*
		16682	CONN, 2X7X.1 M VERT .230H SMT	*	*	*	*	*	*	*
		16732	SKT, 200P DDR SODIMM 2.5V 5.2H	*	*	*	*	*	*	*

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		16749	IC, MAX7311 I/O XPNDR I2C SSOP	*	*	*	*	*	*	*
		16750	IC, M41ST84W SER RTC W/I2C SO	*	*	*	*	*	*	*
		16751	IC, TMP101 TEMP SENSOR I2C SOT	*	*	*	*	*	*	*
		16765	IC, ICS574 QUAD CLK BUFFER SO	*	*	*	*	*	*	*
		16766	IC, ICS670-01 CLK MULTIPLR SO	*	*	*	*	*	*	*
		16775	IC, 3303 2:1 MUX/DEMUX SW SOT	*	*	*	*	*	*	*
		16808	IC, 28F640 FLSH 120NS 3.3V BGA	*	*	*	*	*	*	*
		16831	OSC, 66MHZ HCMOS3.3V 50PPM7550	*	*	*	*	*	*	*
		16842	CONN, 1X5X.1 M RA HT PTH	*	*	*	*	*	*	*
		16857	OSC, 32.768KHZ 3V TS SOJ4	*	*	*	*	*	*	*
		16858	SKT, 184P DIMM DDR LP 25* PTH	*	*	*	*	*	*	*
		16859	RES, CHIP 10 1% 1/16W 0402	*	*	*	*	*	*	*
		16919	CONN, 2X40X.05 F RA 2.5HDD PTH	*	*	*	*	*	*	*
		16946	IC, H8S/2166 UC 33MHZ 3.3 TQFP	*	*	*	*	*	*	*
		16962	IC, UPD720101 USB2.0 FBGA	*	*	*	*	*	*	*
		16981	RES, CHIP 6.04K 1% 1/16W 0402	*	*	*	*	*	*	*
		16992	CONN, 2X7X2MM M RA SHRD PTH	*	*	*	*	*	*	*
		16993	CONN, 2X100X.635 F VERT SMT	*	*	*	*	*	*	*
		16994	IC, MAX3483 RS485/422 XCVR SO	*	*	*	*	*	*	*
		16995	CONN, 1X2 POWER M RA PRESS FIT	*	*	*	*	*	*	*
		16996	IC, PCA9515 I2C BUS RPTR 2C SO	*	*	*	*	*	*	*
		16998	IC, 16224 12/24 MUX SW 3V QSOP	*	*	*	*	*	*	*
		17004	RES, CHIP 34.8K 1% 1/16W 0402	*	*	*	*	*	*	*
		17005	RES, CHIP 66.5K 1% 1/16W 0402	*	*	*	*	*	*	*
		17006	IC, PI3VT3245 8B LV XLTR TSSOP	*	*	*	*	*	*	*
		17013	CONN, 6X10X2MM F RA VHDM PF	*	*	*	*	*	*	*
		17014	CONN, 2X40X1.27 F RA SCA2 SMT	*	*	*	*	*	*	*
		17015	CONN, 2X6 F VERT MZZN 6.5H SM	*	*	*	*	*	*	*
		17017	IC, ISL6115 HOT SWAP CTRLR SO	*	*	*	*	*	*	*
		17018	TRANS, IRL3713 NMSFET PWR DDPK	*	*	*	*	*	*	*
		17020	TRANS, MMBT6427 NPN DRLGTN SOT	*	*	*	*	*	*	*
		17021	DIO, 1SS380 SW LO LEAKG SOD323	*	*	*	*	*	*	*
		17025	IC, MAX6315 UP RESET OD SOT	*	*	*	*	*	*	*
		17049	CONN, 2XRJ45 GBE CICADA G+G	*	*	*	*	*	*	*
		17053	IC, LT1963A LDO VR ADJ 1.5A Q5	*	*	*	*	*	*	*
		17054	IC, LTC3736 SW VR SD QFN	*	*	*	*	*	*	*
		17056	TRANS, SI7540 N+P-MOSFET SO8D	*	*	*	*	*	*	*
		17057	IC, LTC3728LX 2 SD SW REG QFN	*	*	*	*	*	*	*
		17062	IC, LTC3412 VR SW SD 3A TSSOP	*	*	*	*	*	*	*
		17063	OSC, 37.5MHZ 3.3V TS 7050	*	*	*	*	*	*	*
		17064	IC, FLASH DISK 64MB 3.3V BGA69	*	*	*	*	*	*	*
		17070	IC, LM75 TEMP SENSR I2C 3.3 SO	*	*	*	*	*	*	*
		17095	RES, CHIP 88.7K 1% 1/16W 0603	*	*	*	*	*	*	*
		17097	SKT, 240P RA DDR2 DIMM 1.8 PTH	*	*	*	*	*	*	*
		17100	IC, LT1764A LDO VR ADJ 3A DDPK	*	*	*	*	*	*	*
		17102	HOLDER, BATTERY CR2032 VERT TH	*	*	*	*	*	*	*
		17103	CAP, 1F 5.5V EDL D21.5X8 PTH	*	*	*	*	*	*	*
		17104	IC, PCA9557 8BIT I2C XPNDR SO	*	*	*	*	*	*	*
		17105	CONN, 10PX.5 F VERT FFC ZIP SM	*	*	*	*	*	*	*
		17106	IC, MIC29752 LDO ADJ7.5A TO247	*	*	*	*	*	*	*
		17108	CAP, CHIP 10UF 16V X5R 1206	*	*	*	*	*	*	*
		17109	IND, CHIP 1.0UH 6.8A DO3316	*	*	*	*	*	*	*

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		17110	TRANS, FDS6680A NMOSFET 30V SO	*	*	*	*	*	*	*
		17111	IC, LT1767 VR SW ADJ1.5A MSOPE	*	*	*	*	*	*	*
		17112	IC, MAX8585 OR-ING CTRLR UMAX	*	*	*	*	*	*	*
		17114	TRANS, SI3457BDV P-MOSFET TSOP	*	*	*	*	*	*	*
		17115	FUSE, 3.5A 32V VERY FAST 0603	*	*	*	*	*	*	*
		17116	LED, RED/GRN RA T1 CC RDL5	*	*	*	*	*	*	*
		17117	RES NTWK, CHIP 4X33 5% 2010	*	*	*	*	*	*	*
		17118	RES, CHIP .008 OHM 1% 1W 2512	*	*	*	*	*	*	*
		17124	LED, CHIP AMBER TOP 080504	*	*	*	*	*	*	*
		17125	LED, CHIP BLUE TOP 080504	*	*	*	*	*	*	*
		17126	SWITCH, SPST PUSHBTTN NO 4628	*	*	*	*	*	*	*
		17127	IND, CHIP .56UH 5% .24A 1008	*	*	*	*	*	*	*
		17128	IC, 82546GB GBE CNTLR 2C PBGA	*	*	*	*	*	*	*
		17130	IC, 74LVC1G17 SCHMT BUFRR SOT	*	*	*	*	*	*	*
		17132	CONN, 2X100X.635 M VERT SMT	*	*	*	*	*	*	*
		17134	LED, CHIP GREEN TOP 080504	*	*	*	*	*	*	*
		17136	150UF, 20%, 10V, TA-POLY, 7343	*	*	*	*	*	*	*
		17137	IC, LTC1694 I2C ACCLRRR TSOT23	*	*	*	*	*	*	*
		17138	CONN, 4P+24S+4P F VRT+GUIDE PF	*	*	*	*	*	*	*
		17139	CONN, 6X10X2 M VRT VHDM+KEY PF	*	*	*	*	*	*	*
		17140	CONN, 1X2X.25 F VERT POWER PF	*	*	*	*	*	*	*
		17141	CONN, 1X6X.1 M VERT .230H PTH	*	*	*	*	*	*	*
		17143	CONN, 1X10X.5 F RA FFC LIF SM	*	*	*	*	*	*	*
		17146	RES, CHIP 825 1% 1/16W 0402	*	*	*	*	*	*	*
		17151	RES, CHIP 205K 1% 1/16W 0402	*	*	*	*	*	*	*
		17152	RES, CHIP 60.4K 1% 1/16W 0402	*	*	*	*	*	*	*
		17153	IC, MAX3162 MULTI XCVRS SSOP	*	*	*	*	*	*	*
		2061907-00	PCB, AES-1010SATA	*	*	*	*	*	*	*
		2091707-00	PCB, CALLISTO	*	*	*	*	*	*	*
		2092007-00	PCB, METIS	*	*	*	*	*	*	*
		2101007-00	PCB, THEBE SR	*	*	*	*	*	*	*
		510889-00	GUIDE, AHA-2940U/UW INSTALL	*	*	*	*	*	*	*
		513121-03	GUIDE, ADS-6220SS/7220SS USER	*	*	*	*	*	*	*
		513246-00	CARD, ADS-U160 CLSTR RMF	*	*	*	*	*	*	*
		513247-00	CARD, U160 CLSTR WRRTY DISCLSR	*	*	*	*	*	*	*
		513743-00	LBL, BEZEL ESA1500	*	*	*	*	*	*	*
		ASM-00083-01-A	XCVR,OPTICAL,SFF,LC,2GB	*	*	*	*	*	*	*
		AUD-00002-01-A	BUZZER,2.3KHZ,3V,12X9MM	*	*	*	*	*	*	*
		BP-0001-001	2 4/3 AF CELL 2.4V 3800MAH BAT	*	*	*	*	*	*	*
		CAP-00001-01-A	0.01UF,5%,25V,X7R,0603	*	*	*	*	*	*	*
		CAP-00002-01-A	0.1UF,10%,16V,X7R,0603	*	*	*	*	*	*	*
		CAP-00003-01-A	0.01UF,5%,16V,X7R,0402	*	*	*	*	*	*	*
		CAP-00004-01-A	30PF,5%,50V,C0G,0402	*	*	*	*	*	*	*
		CAP-00006-01-A	47UF,20%,10V,TANT,6032	*	*	*	*	*	*	*
		CAP-00007-01-A	10UF,20%,10V,TANT,3528	*	*	*	*	*	*	*
		CAP-00008-01-A	0.1UF,+80/-20%,16V,0402	*	*	*	*	*	*	*
		CAP-00009-01-A	22PF,5%,50V,C0G,0603	*	*	*	*	*	*	*
		CAP-00011-01-A	10UF,20%,16V,TANT,6032	*	*	*	*	*	*	*
		CAP-00012-01-A	4.7UF,20%,25V,TANT,6032	*	*	*	*	*	*	*
		CAP-00027-01-A	0.1UF,10%,50V,X7R,0603	*	*	*	*	*	*	*
		CAP-00028-01-A	4U7,+80/-20%,16V,1206	*	*	*	*	*	*	*
		CAP-00029-01-A	47UF,10%,16V,TANT ,7343	*	*	*	*	*	*	*

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		CAP-00035-01-A	0.01UF,10%,50V,X7R,0603	*	*	*	*	*	*	*
		CAP-00036-01-A	2.2UF,10%,16V,TANT,3216	*	*	*	*	*	*	*
		CAP-00039-01-A	1NF,+/-20%,16V,X7R,0402	*	*	*	*	*	*	*
		CAP-00040-01-A	0.22UF,10%,10V,X7R,0603	*	*	*	*	*	*	*
		CAP-00041-01-A	4.7UF,20%,10V,TANT,3528	*	*	*	*	*	*	*
		CAP-00042-01-A	33UF,20%,20V,TANT,7343	*	*	*	*	*	*	*
		CAP-00043-01-A	15UF,20%,35V,TANT,7343	*	*	*	*	*	*	*
		CAP-00044-01-A	68PF,5%,50V,COG,0402	*	*	*	*	*	*	*
		CAP-00054-01-A	100PF,5%,50V,X7R,0603	*	*	*	*	*	*	*
		CAP-00064-01-A	OBS 560UF,20%,4V,8X10.5MM	*	*	*	*	*	*	*
		CAP-00076-01-A	1UF,20%,25V,TANT,3216	*	*	*	*	*	*	*
		CAP-00077-01-A	22UF,20%,16V,TANT,6032	*	*	*	*	*	*	*
		CAP-00078-01-A	10UF,10%,6.3V,X5R,1206	*	*	*	*	*	*	*
		CAP-00081-01-A	100UF,20%,20V,7343H	*	*	*	*	*	*	*
		CAP-00083-01-A	1UF,+80-20%,16V,Y5V,0805	*	*	*	*	*	*	*
		CAP-00084-01-A	OBS 680UF, 20%, 16V, RADIAL	*	*	*	*	*	*	*
		CAP-00085-01-A	0.1UF,+80/-20%,16V,0603	*	*	*	*	*	*	*
		CAP-00086-01-A	OBS 47UF,20%,10V,POLYMER AL	*	*	*	*	*	*	*
		CAP-00089-01-A	33UF,20%,10V,TANT,LO ESR	*	*	*	*	*	*	*
		CON-00002-01-A	HDR, 5X12 2MM PRESS VERT PTH	*	*	*	*	*	*	*
		CON-00006-01-A	RECPT,30PIN,PRESS,RA	*	*	*	*	*	*	*
		CON-00007-01-A	RECPT,60PIN,PRESS,RA	*	*	*	*	*	*	*
		CON-00010-01-A	RECPT,5X6,2MM,RA,SOLDER	*	*	*	*	*	*	*
		CON-00022-01-A	RECPT,40PIN,PRESS,VR	*	*	*	*	*	*	*
		CON-00022-02-A	RECPT,SCA2,40P,.145" PIN	*	*	*	*	*	*	*
		CON-00023-01-A	RECPT,SCA2,80PIN,VERT	*	*	*	*	*	*	*
		CON-00024-01-A	RECPT,68PIN,SOLDER,RA	*	*	*	*	*	*	*
		CON-00024-03-A	RECPT,68PIN,SOLDER,RA	*	*	*	*	*	*	*
		CON-00027-01-A	RECPT,MICROPAX160,RA,SLD	*	*	*	*	*	*	*
		CON-00029-01-A	RECPT 160PIN 0.025" VR SMD	*	*	*	*	*	*	*
		CON-00031-01-A	HDR,2X4,2MM,PWR,PRESS,VR	*	*	*	*	*	*	*
		CON-00032-01-A	RECPT,5PIN,.1",SOLDER,RA	*	*	*	*	*	*	*
		CON-00033-01-A	CRDEDGE,6X2PIN,SOLDER,VR	*	*	*	*	*	*	*
		CON-00036-01-A	HDR 18PIN SOLDER VR PTH	*	*	*	*	*	*	*
		CON-00044-01-A	RECPT,9PIN,SMD,VR	*	*	*	*	*	*	*
		CON-00045-01-A	RECPT 24P PRESS FIT SOLDER PTH	*	*	*	*	*	*	*
		CON-00046-01-A	HDR, 72PIN PRESS FIT VR PTH	*	*	*	*	*	*	*
		CON-00052-01-A	SOCKET,8PIN,DIP,0.3",SLD	*	*	*	*	*	*	*
		CON-00056-01-A	HDR,2X5,0.1",SMD,VERT	*	*	*	*	*	*	*
		CON-00057-02-A	RECPT,8PIN,HSSDC,SMD,RA	*	*	*	*	*	*	*
		CON-00058-01-A	SOCKET, 48PIN SMD TSOP	*	*	*	*	*	*	*
		CON-00060-01-A	RECPT, HS 5X12 2MM RA PRS	*	*	*	*	*	*	*
		CON-00064-01-A	HDR,2PIN,SOLDER,VERT,.1"	*	*	*	*	*	*	*
		CON-00071-01-A	RECPT, SCA2 80P VERT 4.6MM TH	*	*	*	*	*	*	*
		CON-00072-01-A	HDR, 168PIN PRESS FIT VR PTH	*	*	*	*	*	*	*
		CON-00073-01-A	RECPT,168PIN,SOLDER,RA	*	*	*	*	*	*	*
		CON-00074-01-A	SOCKET, 20 PIN, PLCC,	*	*	*	*	*	*	*
		CON-00079-01-A	SKT,8PIN,PF,DIL	*	*	*	*	*	*	*
		CON-00082-01-A	RECPT,HS,5X6,2MM,PRS,RA	*	*	*	*	*	*	*
		CON-00083-01-A	HDR, HS 5X6 2MM PRS VERT PTH	*	*	*	*	*	*	*
		CON-00084-01-A	RECPT, SATA 22PIN VRT SMD	*	*	*	*	*	*	*
		CON-00085-01-A	RECPT,PWR,32PIN,PRESS,VE	*	*	*	*	*	*	*

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		CON-00086-01-A	HDR, 5X6 2MM PRESS FIT VERT TH	*	*	*	*	*	*	*
		CON-00107-01-A	AUDIO JACK, 3PIN RA ST PTH	*	*	*	*	*	*	*
		CON-00109-01-A	HDR, 50PIN CF CARD SMD	*	*	*	*	*	*	*
		CON-00113-01-A	PLUG, SCA2 40PIN VERT PTH	*	*	*	*	*	*	*
		CON-00114-01-A	RECPT,SATA,22PIN,VERT,TH	*	*	*	*	*	*	*
		CON-00116-01-A	HDR,6X12,2MM,VRT,PRESS	*	*	*	*	*	*	*
		CON-00117-01-A	RECPT, 6X12 2MM RA PRESS PTH	*	*	*	*	*	*	*
		CON-00118-01-A	RECPT,FFC,10P,VERT,SMD	*	*	*	*	*	*	*
		CON-00121-01-A	CRDEDG,SFP,SMD,20PIN	*	*	*	*	*	*	*
		CON-00122-01-A	CAGE,SFP,PRESSFIT,15PIN	*	*	*	*	*	*	*
		CON-00123-01-A	SKT, HM 200PIN RA PRESS FIT TH	*	*	*	*	*	*	*
		CON-00124-01-A	RECPT, USHD 68PIN VERT PTH	*	*	*	*	*	*	*
		CON-00127-01-A	SOCKET, 92P EDGE PTH	*	*	*	*	*	*	*
		CON-00128-01-A	HDR, HM 200P VRT PF HSWOP	*	*	*	*	*	*	*
		CON-00130-01-A	HDR, 2PIN SOLDER RA PTH	*	*	*	*	*	*	*
		CON-00132-01-A	RECPT, 20PIN 2MM ST VERT PTH	*	*	*	*	*	*	*
		CON-00133-01-A	HDR, 40PIN 0.1" ST VERT PTH	*	*	*	*	*	*	*
		CON-00133-02-A	HDR, 10PIN 0.1" ST VERT PTH	*	*	*	*	*	*	*
		CON-00135-01-A	RECPT,6X12,2MM,RA,SOLDER	*	*	*	*	*	*	*
		DIO-00001-01-A	RECT,SCHOTTKY,2A,40V,SMB	*	*	*	*	*	*	*
		DIO-00002-01-A	SWT,2MA,30V,SOT23	*	*	*	*	*	*	*
		DIO-00004-01-A	SWT,50MA,75V,SOT-23	*	*	*	*	*	*	*
		DIO-00008-01-A	POW,30A,100V,SMA	*	*	*	*	*	*	*
		DIO-00012-01-A	SCHTKY, 200MA 70V SOT23	*	*	*	*	*	*	*
		DIO-00013-01-A	RECTIFIER, 5A 30V DO-201AD	*	*	*	*	*	*	*
		DIO-00014-01-A	RECTIFIER, 15A 30V DO-35	*	*	*	*	*	*	*
		DIO-00016-01-A	SCHTKY, 1.1A 50V DO-41	*	*	*	*	*	*	*
		DIO-00017-01-A	ZENER,5.6V,3 PIN SOT23	*	*	*	*	*	*	*
		DIO-00018-01-A	SCHTKY, 1A 40V SOT23	*	*	*	*	*	*	*
		EMC-CAR301-01-B	CARRERA SWIMSUIT	*	*	*	*	*	*	*
		FAS-GEN300-01-A	SCREW 4-40X.312" PH/PN	*	*	*	*	*	*	*
		FAS-GEN301-01-A	NUT, KEP 4-40	*	*	*	*	*	*	*
		FAS-GEN308-01	SCREW 4-40X.312" PH/CK	*	*	*	*	*	*	*
		FUS-00001-01-A	FUSE,RESETABLE,1.1A,SMD	*	*	*	*	*	*	*
		GEN-00080-01-A	LABEL BARCODE 1.5"X0.25"	*	*	*	*	*	*	*
		GEN-00122-01-A	SWITCH, ID SELECTOR	*	*	*	*	*	*	*
		GEN-00123-01-A	HEADER, RIGHT ANGLE	*	*	*	*	*	*	*
		HDW-00002-01-A	CONN, ALIGNMENT PIN 33.3MM	*	*	*	*	*	*	*
		HDW-00003-01-A	CAP, KEY, BLACK	*	*	*	*	*	*	*
		HDW-00008-01-A	SCREW 2-56 X .375" PH/PN	*	*	*	*	*	*	*
		HDW-00009-01-A	NUT, 2-56	*	*	*	*	*	*	*
		HDW-00019-01-A	NUT,PCB,SOLDERED,#6-32	*	*	*	*	*	*	*
		HDW-00037-01-A	RIVET, PLAS SNAP .125DIA	*	*	*	*	*	*	*
		HDW-502505-006	SCREW M2.5X6 PZ/PN	*	*	*	*	*	*	*
		HDW-NSR004	RIVET SNAP FIT XL500	*	*	*	*	*	*	*
		ICS-00004-01-A	SCSI TERMINATOR,9LINE	*	*	*	*	*	*	*
		ICS-00006-01-A	IC, A4 ASIC 144PIN QFP	*	*	*	*	*	*	*
		ICS-00008-02-A	16V8 PAL,15NS,5V,20TSSOP	*	*	*	*	*	*	*
		ICS-00009-01-A	QUAD 2 INPUT NOR,O.C.	*	*	*	*	*	*	*
		ICS-00010-01-A	MOSFET SWITCH,16 LINE	*	*	*	*	*	*	*
		ICS-00016-01-A	IC, FC LINK REPLICATOR 1G SSOP	*	*	*	*	*	*	*
		ICS-00017-01-A	IC, DUAL FC W/RP&RT 64P TQFP	*	*	*	*	*	*	*

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		ICS-00018-01-A	I2C THERMOMETER,+/-1C	*	*	*	*	*	*	*
		ICS-00019-01-A	IC, FPGA 5KGATE 3.3V 100P VQFP	*	*	*	*	*	*	*
		ICS-00020-01-A	IC, 55K SERIAL PROM 3.3V DIP	*	*	*	*	*	*	*
		ICS-00021-01-A	UP SUPERVISOR,3.3V	*	*	*	*	*	*	*
		ICS-00022-01-A	IC, FC 6PORT BYPASS W/RP&RT QF	*	*	*	*	*	*	*
		ICS-00023-01-A	32 BIT RISC MICROCNTRLR	*	*	*	*	*	*	*
		ICS-00024-01-A	GAL,16V8,10NS,20PLCC	*	*	*	*	*	*	*
		ICS-00025-01-A	SRAM,64KX16,15NS,LV,TSOP	*	*	*	*	*	*	*
		ICS-00027-01-A	3.3V, 800MA,REGULATOR	*	*	*	*	*	*	*
		ICS-00029-01-A	256KX16 EEPROM,55NS,3.3V	*	*	*	*	*	*	*
		ICS-00030-01-A	UP SUPERVISOR,5V	*	*	*	*	*	*	*
		ICS-00031-01-A	IC, SINGLE CMOS INVERTER SOT23	*	*	*	*	*	*	*
		ICS-00032-01-A	2-INPUT AND GATE,CMOS	*	*	*	*	*	*	*
		ICS-00033-01-A	IC, 2 I/P XOR GATE CMOS SOT23	*	*	*	*	*	*	*
		ICS-00034-01-A	4KBIT EEPROM,I2C,8SOIC	*	*	*	*	*	*	*
		ICS-00035-01-A	SINGLE CMOS BUFFR,3STATE	*	*	*	*	*	*	*
		ICS-00036-01-A	16 BIT TRANSPRNT DLATCH	*	*	*	*	*	*	*
		ICS-00038-01-A	LVD/SE,36PIN,SSOP	*	*	*	*	*	*	*
		ICS-00048-01-A	IC, QUAD 2I/P NAND 14P DIL SO	*	*	*	*	*	*	*
		ICS-00056-01-A	NAND,QUAD,14PIN,SOIC	*	*	*	*	*	*	*
		ICS-00062-01-A	VREG,2.5V,SOT23-5	*	*	*	*	*	*	*
		ICS-00063-01-A	IC, PLD BGA,3.3V,SMD	*	*	*	*	*	*	*
		ICS-00065-01-A	SERPROM,8PIN,TH	*	*	*	*	*	*	*
		ICS-00067-01-A	FPGA,3V3,144PIN,TQFP,SMD	*	*	*	*	*	*	*
		ICS-00068-01-A	OCTAL BUFFER,20 PIN, SMD	*	*	*	*	*	*	*
		ICS-00069-01-A	HEXINV,14PIN,SOIC,SMD	*	*	*	*	*	*	*
		ICS-00070-01-A	IC, U160 SCSI EXPANDER C1	*	*	*	*	*	*	*
		ICS-00071-01-A	IC: 16BIT, 40 PIN, QVSO	*	*	*	*	*	*	*
		ICS-00072-01-A	HEX FC PBC W/2 RPTR/RTMR	*	*	*	*	*	*	*
		ICS-00072-02-A	HEX FC PBC W/2 RPTR/RTMR	*	*	*	*	*	*	*
		ICS-00073-01-A	REGULATOR,2.5V,3.0A,SMT	*	*	*	*	*	*	*
		ICS-00074-01-A	CPLD,3.2KGATE,3.3V,TQFP	*	*	*	*	*	*	*
		ICS-00075-01-A	ASIC, BOLENO 144P 20X20MM LQFP	*	*	*	*	*	*	*
		ICS-00076-01-A	HEX SCHMITT INV,SOIC-14	*	*	*	*	*	*	*
		ICS-00080-01-A	HEX D FLIP-FLOP,TSSOP-16	*	*	*	*	*	*	*
		ICS-00081-01-A	REGULATOR,2.5V,1.5A,SMT	*	*	*	*	*	*	*
		ICS-00082-01-A	UP RESET,2.63V,SOT23,SMD	*	*	*	*	*	*	*
		ICS-00084-01-A	SCSI EXP,U320,272P,PBGA	*	*	*	*	*	*	*
		ICS-00085-01-A	GAL,3.3V,28PIN,PLCC	*	*	*	*	*	*	*
		ICS-00086-01-A	2-INPUT OR GATE,CMOS,SMT	*	*	*	*	*	*	*
		ICS-00089-01-A	QUAD,2-INPT,XOR GTE,14P	*	*	*	*	*	*	*
		ICS-00090-01-A	QUAD,2-INPT,AND GTE,14P	*	*	*	*	*	*	*
		ICS-00091-01-A	QUAD COMP,14P,SOIC,SMD	*	*	*	*	*	*	*
		ICS-00093-01-A	512KX16 EE,70NS,3.3V,BTM	*	*	*	*	*	*	*
		ICS-00101-01-A	QUAD,2 INP, AND,14P,SOIC	*	*	*	*	*	*	*
		ICS-00104-01-A	HEX SCHMT TRIG,14P, SOIC	*	*	*	*	*	*	*
		ICS-00111-01-A	IC, NON-INV CMOS DRVR 8PIN SO	*	*	*	*	*	*	*
		ICS-00112-01-A	IC, SYN BUCK CNTR 16PIN SOP	*	*	*	*	*	*	*
		ICS-00113-01-A	IC, R232 DRV/REC 16PIN DIP	*	*	*	*	*	*	*
		ICS-00115-01-A	D-TYPE LATCH,20P,SOIC	*	*	*	*	*	*	*
		ICS-00136-01-A	2KBIT EEPROM,I2C,8SOIC	*	*	*	*	*	*	*
		ICS-00139-01-A	RS232,1 DRV/1 REC,UMAX10	*	*	*	*	*	*	*

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		ICS-00143-01-A	2 SATA TO ATA/SATA,100P	*	*	*	*	*	*	*
		ICS-00144-01-A	UP RESET,4.38V,SOT23,3P	*	*	*	*	*	*	*
		ICS-00144-02-A	UP RESET,2.93V,SOT23,3P	*	*	*	*	*	*	*
		ICS-00145-01-A	D-TYPE FF, DUAL,SOIC14	*	*	*	*	*	*	*
		ICS-00147-01-A	IC, VOLT REG 0.5A 8PIN DIP	*	*	*	*	*	*	*
		ICS-00148-01-A	IC, UP RESET 3.08V SC70	*	*	*	*	*	*	*
		ICS-00148-02-A	IC, UP RESET 4.63V SC70	*	*	*	*	*	*	*
		ICS-00149-01-A	CPLD,100 PIN TQFP,3.3V	*	*	*	*	*	*	*
		ICS-00150-01-A	TIMER,DELAY,W/OSCILLATOR	*	*	*	*	*	*	*
		ICS-00151-01-A	VREG,3.3V,5A,7VMAX,TO263	*	*	*	*	*	*	*
		ICS-00152-01-A	I2C BUS REPEATER,8P SOIC	*	*	*	*	*	*	*
		ICS-00154-01-A	4KBIT EE,I2C,1.8V,8SOIC	*	*	*	*	*	*	*
		ICS-00156-01-A	VOLT REG,3.3V,3PIN, SMD	*	*	*	*	*	*	*
		ICS-00159-01-A	IC, DLATCH 16BIT BUSHOLD RES	*	*	*	*	*	*	*
		ICS-00160-01-A	IC, VOLT REG 1.8V 150MA SOT23	*	*	*	*	*	*	*
		ICS-00161-01-A	MUX,SATA,2:1,TQFP,48PIN	*	*	*	*	*	*	*
		ICS-00162-01-A	IC, BOOST CNTR 6PIN SOT23	*	*	*	*	*	*	*
		ICS-00166-01-A	REG,ADJ,LO DROP,3A,TO263	*	*	*	*	*	*	*
		JMP-00001-01-A	2PIN JUMPER 0.1"	*	*	*	*	*	*	*
		LBL-00001-01-A	LABEL: PCA P/N & S/N	*	*	*	*	*	*	*
		LBL-00014-11-A	LABEL, SATA, 400GB GRY	*	*	*	*	*	*	*
		LBL-00014-12-A	LABEL, SATA, 400GB BLK	*	*	*	*	*	*	*
		LBL-00033-01-A	LABEL, TOWER, FS4050	*	*	*	*	*	*	*
		LBL-00036-01-A	LABEL, RACK, FC4100	*	*	*	*	*	*	*
		LBL-00037-01-A	LABEL, RACK, FS4100	*	*	*	*	*	*	*
		LBL-00038-01-A	LABEL, RACK, FC4500	*	*	*	*	*	*	*
		LBL-00039-01-A	LABEL, RACK, FS4500	*	*	*	*	*	*	*
		LBL-00040-01-A	LABEL, RACK, FS4050	*	*	*	*	*	*	*
		LBL-00041-01-A	LABEL, RACK, SC4100	*	*	*	*	*	*	*
		LBL-00042-01-A	LABEL, RACK, SS4103	*	*	*	*	*	*	*
		LBL-00044-01-A	LABEL, CARRIER 250, ADIC	*	*	*	*	*	*	*
		LBL-00051-01-A	LABEL, 5"X3.5" WHT POLY	*	*	*	*	*	*	*
		LBL-00052-01-A	LABEL, 4"X1.25" WHT POLY	*	*	*	*	*	*	*
		LBL-00100-01-A	2U, ES ID BLANK	*	*	*	*	*	*	*
		LBL-DSA001	LABEL BARCODE XL600 TYPE	*	*	*	*	*	*	*
		LED-00004-01-A	LED,GRN,12.3MCD,RA,THRU	*	*	*	*	*	*	*
		LED-00005-01-A	LED,QUAD,GGYG,RA,THRU	*	*	*	*	*	*	*
		LED-00006-01-A	LED,YLW,12.3MCD,RA,THRU	*	*	*	*	*	*	*
		LED-00009-01-A	LED,GRN,20MCD,RA,THRU	*	*	*	*	*	*	*
		LED-00014-01-A	LED,Y/G,10MCD,VERT,SMD	*	*	*	*	*	*	*
		LED-00015-01-A	LED,GRN,25MCD,VERT,SMD	*	*	*	*	*	*	*
		LED-00018-01-A	LED,A,6.3MCD,VERT,SMD	*	*	*	*	*	*	*
		LED-00019-01-A	LED,TRI,GRN,RA,THRU	*	*	*	*	*	*	*
		LED-00021-01-A	LED,ORG,10MCD,VERT,SMD	*	*	*	*	*	*	*
		LED-00022-01-A	LED,DUAL,YG,RA,THRUHOLE	*	*	*	*	*	*	*
		LED-00025-01-A	LED,Y/G,VERT,SMD,0606	*	*	*	*	*	*	*
		LED-00026-01-A	LED,GRN,VERT,SMD,0402	*	*	*	*	*	*	*
		LED-00027-01-A	LED,YLW,VERT,SMD,0402	*	*	*	*	*	*	*
		LED-00030-01-A	LED,YLW,20MCD,RA,THRU	*	*	*	*	*	*	*
		LED-00031-01-A	LED,GRN,VERT,SMD,0603	*	*	*	*	*	*	*
		LED-00032-01-A	LED,YLW,VERT,SMD,0603	*	*	*	*	*	*	*
		MAG-00001-01-A	INDUCTOR,EMI,1.5A,SMD	*	*	*	*	*	*	*

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		MAG-00003-01-A	INDUCTOR, 120UH, 2A, AXIAL	*	*	*	*	*	*	*
		MAG-00011-01-A	INDUCTOR, 3.3UH 20% HRZ SMD	*	*	*	*	*	*	*
		MAG-00012-01-A	INDUCTOR, 1.8UH 20% 16.8A SMD	*	*	*	*	*	*	*
		MAG-00016-01-A	INDUCTOR, 100UH 10% RADIAL	*	*	*	*	*	*	*
		MEC-BXF303-01-E	BEZEL, SWITCH GUIDE	*	*	*	*	*	*	*
		MEC-BXG302-01-D	GUIDE, SWITCH CARRIER	*	*	*	*	*	*	*
		MEC-BXG325-01-A	FORMEX SHEET	*	*	*	*	*	*	*
		MEC-BXG329-01-B	I/O BOARD GUIDE, BOXT	*	*	*	*	*	*	*
		ML-000542	LABEL, BLANK 1.75" X	*	*	*	*	*	*	*
		OSC-00002-01-A	XTAL OSC, 40MHZ, 5X7MM, 4P	*	*	*	*	*	*	*
		OSC-00003-01-A	XTAL, 16MHZ, 5X7MM, 2PIN	*	*	*	*	*	*	*
		OSC-00004-01-A	XTAL OSC, 106.25MHZ, 5X7MM	*	*	*	*	*	*	*
		OSC-00007-01-A	XTAL OSC, 16MHZ, 5X7MM, 4P	*	*	*	*	*	*	*
		OSC-00012-01-A	XTAL, 25MHZ, 18PF, 5X7MM, 2P	*	*	*	*	*	*	*
		OSC-00015-01-A	XTAL OSC, 40MHZ, 3.3V, 5X7	*	*	*	*	*	*	*
		PAK-00266-01-A	BOX, 12.6" X 12.4" X 8.7" MSTR	*	*	*	*	*	*	*
		PCB-00023-01-E	LAMBO ES BOARD RAW ETCH r02	*	*	*	*	*	*	*
		PCB-00030-01-D	SGL SATA BKPLN, RAW ETCH	*	*	*	*	*	*	*
		PCB-00046-01-B	ALTEVO FC BACKPLANE	*	*	*	*	*	*	*
		PCB-00047-01-C	ALTEVO LIO	*	*	*	*	*	*	*
		PCB-00050-01-B	RAW ETCH MARVELL MUX BRD	*	*	*	*	*	*	*
		PCB-00091-01-D	PCB, W/MAXIM MUX, PDS12 w/ICT	*	*	*	*	*	*	*
		PCB-00092-01-D	PCB, W/MAXIM MUX, PDS13 w/ICT	*	*	*	*	*	*	*
		PCB-500457-01-B	RAW PRINTED CIRCUIT FAB r6.0	*	*	*	*	*	*	*
		PCB-500460-01-A	BARE ETCH 500460_V3 r3.0	*	*	*	*	*	*	*
		PCB-500464-01-A	CERA, DMB JNR, BRE ETCH r2.0	*	*	*	*	*	*	*
		PCB-500467-01-A	CARRERA MUTE BARE ETCH r1.0	*	*	*	*	*	*	*
		PCB-500551-01-D	BOXT ID SWITCH BARE ETCH	*	*	*	*	*	*	*
		PCB-500553-01-G	BARE ETCH PCB, 1G IO	*	*	*	*	*	*	*
		PCB-500558-01-F	FFX1 DA BOARD - RAW ETCH	*	*	*	*	*	*	*
		PCB-500563-01-L	1ARE PCB, 2G I/O1	*	*	*	*	*	*	*
		PCB-500564-01-H	RAW PCB, 2G LS	*	*	*	*	*	*	*
		PCB-50466-01-B	DUAL U BUS, BARE ETCH r3.0	*	*	*	*	*	*	*
		PCB-50474-01-D	ALTEVO U320 MIDPLANE PCB	*	*	*	*	*	*	*
		PCB-50475-01-F	ALTEVO SCSI I/O BOARD	*	*	*	*	*	*	*
		PCB-50477-01-B	ALTEVO U320 JOINER PCB	*	*	*	*	*	*	*
		PCB-BXF300-01-D	BOXSTER BP BARE ETCH	*	*	*	*	*	*	*
		PCB-BXF300-01-G	BOXSTER BARE ETCH	*	*	*	*	*	*	*
		PMF-00014-01-B	LS MODULE LED DIVIDER	*	*	*	*	*	*	*
		PMF-00019-01-B	2U SL SATA FORMEX SHIELD	*	*	*	*	*	*	*
		PMF-00021-01-B	SHIELD, FORMEX, 2U DL SATA	*	*	*	*	*	*	*
		PMF-00038-01-A	SHIELD, 2U 13DR DL SATA	*	*	*	*	*	*	*
		PMF-00038-01-B	SHIELD, 2U, 13DR, DL SATA	*	*	*	*	*	*	*
		PMF-00040-01-A	SHIELD, FORMEX, 2U SCSI	*	*	*	*	*	*	*
		PMF-00041-01-A	SHIELD, FORMEX, 2U FC	*	*	*	*	*	*	*
		PMF-00041-01-B	SHIELD, FORMEX, 2U FC	*	*	*	*	*	*	*
		PMF-00045-01-A	TAPE, KAPTON, 1/2-INCH	*	*	*	*	*	*	*
		RES-00001-01-A	RES:0 OHM, 1206, 2A	*	*	*	*	*	*	*
		RES-00001-02-A	RES:10, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-19-A	RES:51, 5%, 0.25W, 1206	*	*	*	*	*	*	*
		RES-00001-26-A	RES:100, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-44-A	RES:560, 5%, .125W, 1206	*	*	*	*	*	*	*

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		RES-00001-50-A	RES:1K , 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-66-A	RES:4.7K, 5%, .125W,1206	*	*	*	*	*	*	*
		RES-00001-74-A	RES:10K, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-86-A	RES:33K, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-94-A	RES:68K, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-98-A	RES:100K, 5%, .125W,1206	*	*	*	*	*	*	*
		RES-00001-C3-A	RES:2.2, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-C4-A	RES:4.7, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00002-22-A	RES:68, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-38-A	RES:330, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-50-A	RES:1K, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-56-A	RES:1.8K, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-60-A	RES:2.7K, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-62-A	RES:3.3K, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-66-A	RES:4.7K, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-74-A	RES:10K, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00002-81-A	RES:20K, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00003-01-A	RES: 0 OHM, 0603,1A	*	*	*	*	*	*	*
		RES-00003-06-A	RES: 15, 5%, 0.1W, 0603	*	*	*	*	*	*	*
		RES-00003-12-A	RES: 27, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-14-A	RES:33, 5%, 0.1W, 0603	*	*	*	*	*	*	*
		RES-00003-22-A	RES: 68, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-26-A	RES:100, 5%, .063W, 0603	*	*	*	*	*	*	*
		RES-00003-29-A	RES: 130, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-30-A	RES:150, 5%, .063W, 0603	*	*	*	*	*	*	*
		RES-00003-36-A	RES: 270, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-38-A	RES: 330, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-40-A	RES: 390, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-50-A	RES:1K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-00003-56-A	RES: 1.8K, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-58-A	RES: 2.2K, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-62-A	RES: 3.3K, 5%, .063W, 0603	*	*	*	*	*	*	*
		RES-00003-66-A	RES: 4.7K, 5%, .063W, 0603	*	*	*	*	*	*	*
		RES-00003-68-A	RES: 5.6K, 5%, .063W, 0603	*	*	*	*	*	*	*
		RES-00003-74-A	RES:10K, 5%, .063W, 0603	*	*	*	*	*	*	*
		RES-00003-81-A	RES: 20K, 5%, .1W, 0603	*	*	*	*	*	*	*
		RES-00003-98-A	RES: 100K, 5%, .063W, 0603	*	*	*	*	*	*	*
		RES-00005-K4-A	RES: 1K, 1%, .1W, 0805	*	*	*	*	*	*	*
		RES-00005-N7-A	RES: 2.21K, 1%, .1W, 0805	*	*	*	*	*	*	*
		RES-00005-Q0-A	RES: 3.01K, 1%, .1W, 0805	*	*	*	*	*	*	*
		RES-00006-01-A	RES: 0 OHM, 0603, 1A	*	*	*	*	*	*	*
		RES-00006-02-A	RES:10, 1%, 0.1W, 0603	*	*	*	*	*	*	*
		RES-00006-35-A	RES:22.1, 1%, .063W,0603	*	*	*	*	*	*	*
		RES-00006-48-A	RES:30.1, 1%, .063W,0603	*	*	*	*	*	*	*
		RES-00006-59-A	RES: 6.04K, 1%, 0.1W, 0603	*	*	*	*	*	*	*
		RES-00006-64-A	RES: 44.2, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-70-A	RES:51.1, 1%, .063W,0603	*	*	*	*	*	*	*
		RES-00006-82-A	RES:68.1,1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-98-A	RES:100, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-A9-A	RES:130, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-AD-A	RES:35.7K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-00006-B3-A	RES:143, 1%, .063W, 0603	*	*	*	*	*	*	*

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		RES-00006-B5-A	RES:150, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-BQ-A	RES:82.5K, 1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-BY-A	RES:100K, 1%, .063W,0603	*	*	*	*	*	*	*
		RES-00006-DH-A	RES:221K, 1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-K4-A	RES: 1K, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-N3-A	RES:2.00K, 1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-N7-A	RES:2.21K, 1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-Q4-A	RES:3.32K, 1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-R9-A	RES:4.75K, 1%,.063W,0603	*	*	*	*	*	*	*
		RES-00006-V0-A	RES:10K, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-W4-A	RES:14K, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-X9-A	RES:20K, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-Y3-A	RES:22.1K, 1%,.063W,0603	*	*	*	*	*	*	*
		RES-00007-01-A	RES:0 OHM, 0402, 1A	*	*	*	*	*	*	*
		RES-00007-35-A	RES:22.1,1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-48-A	RES:30.1, 1%, .063W,0402	*	*	*	*	*	*	*
		RES-00007-52-A	RES:33.2, 1%, .063W,0402	*	*	*	*	*	*	*
		RES-00007-82-A	RES:68.1, 1%, .063W,0402	*	*	*	*	*	*	*
		RES-00007-98-A	RES:100, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-A9-A	RES:130, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-B5-A	RES:150, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-BQ-A	RES:82.5K, 1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-BY-A	RES:100K, 1%,.063W, 0402	*	*	*	*	*	*	*
		RES-00007-C9-A	RES:210, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-E8-A	RES:332, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-G3-A	RES:475, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-G6-A	RES:511, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-K4-A	RES:1K, 1%, .063W, 0402	*	*	*	*	*	*	*
		RES-00007-N7-A	RES:2.21K, 1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-Q4-A	RES:3.32K, 1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-R9-A	RES:4.75K, 1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-V0-A	RES:10K, 1%, .063W,0402	*	*	*	*	*	*	*
		RES-00007-V8-A	RES:12.1K,1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-W4-A	RES:14K, 1%, .063W,0402	*	*	*	*	*	*	*
		RES-00007-X9-A	RES:20K, 1%, .063W,0402	*	*	*	*	*	*	*
		RES-00014-01-A	RES:10KX4,5%,.063W,1206	*	*	*	*	*	*	*
		RES-00015-01-A	RES:4.7KX4,5%,.063W,1206	*	*	*	*	*	*	*
		RES-00016-01-A	RES:1KX4,5%,.063W,1206	*	*	*	*	*	*	*
		RES-00017-01-A	RES:100X4,5%,.063W,1206	*	*	*	*	*	*	*
		RES-00018-01-A	RES:3K3X4,5%,0.063W,1206	*	*	*	*	*	*	*
		RES-00020-01-A	RES:3K3X4,5%,0.063W,1206	*	*	*	*	*	*	*
		RES-00034-01-A	RES:0.015,1%,0.5W,2512	*	*	*	*	*	*	*
		SWT-00004-01-A	SWITCH,SPST(N.O.),THRUHO	*	*	*	*	*	*	*
		SWT-00019-01-A	SWITCH,4POS,DIP,SMD	*	*	*	*	*	*	*
		SWT-BXF300-01-A	BOXSTORE SWITCH	*	*	*	*	*	*	*
		TRN-00001-01-A	NPN SIGNAL TRANS SOT23	*	*	*	*	*	*	*
		TRN-00002-01-A	PNP SIGNAL TRANS SOT23	*	*	*	*	*	*	*
		TRN-00007-01-A	TRANS, FDB7030BL N-MOSFET SOT	*	*	*	*	*	*	*
		TRN-00008-01-A	TRAN, MMBT3904L NPN GP SOT23	*	*	*	*	*	*	*
		TRN-00009-01-A	TRAN, MMBT2222L NPN GP SOT23	*	*	*	*	*	*	*
		TRN-00012-01-A	PCH,MOS,PWR,SOT23	*	*	*	*	*	*	*
		TRN-00013-01-A	PNP POWER TRANS SOT223	*	*	*	*	*	*	*

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		TRN-00014-01-A	PNP,SWITCHING,0.6A,SOT23	*	*	*	*	*	*	*
		TRN-00015-01-A	TRANS,IRLL2703 N-MOSFET SOT	*	*	*	*	*	*	*
		TRN-00016-01-A	TRANS,FDC633N N-MOSFET SOT	*	*	*	*	*	*	*
	RAWS	0M427	LABEL,WARN,DELL PV660F RA00	*	*	*	*	*	*	*
		1497022-00	SCD,CLAM EUROLOGIC P3 BKPLNE	*	*	*	*	*	*	*
		1497481-00	SCD,250GB SATA DRIVE - MAXTOR	*	*	*	*	*	*	*
		16558	IC,MAX4372F I-SENSE AMP SOT23	*	*	*	*	*	*	*
		16652	RES NTWK,CHIP 4X10 5% 2010	*	*	*	*	*	*	*
		16711	IC,EL7558D ADJ 8A SW REG HSOP	*	*	*	*	*	*	*
		16720	IC,L6932 ULDO VR 2.5V 2A SO	*	*	*	*	*	*	*
		16764	IC,74LVC2G74 D-FF W/CLR VSSOP	*	*	*	*	*	*	*
		16819	IC,XC2V500-5 FPGA 456PGA	*	*	*	*	*	*	*
		16979	IC,XC2VP7-5 FPGA 456BGA	*	*	*	*	*	*	*
		16987	IC,CX25842 VIDEO DECODER TQFP	*	*	*	*	*	*	*
		16988	IC,XCCACE ACE CTRLR TQFP-144	*	*	*	*	*	*	*
		17000	IC,ICS501 PLL CLK MLTPLR SO	*	*	*	*	*	*	*
		17003	RES,CHIP 124K 1% 1/16W 0402	*	*	*	*	*	*	*
		17022	IC,74LVC07 HEX BFR OPN DRN SO	*	*	*	*	*	*	*
		17069	CONN,2X5X.1 M RA .230L PTH	*	*	*	*	*	*	*
		17092	IC,LT1767 VR SW 3.3V1.5A MSOP	*	*	*	*	*	*	*
		17099	IC,XC95288XL-6 CPLD FPBGA	*	*	*	*	*	*	*
		17107	IC,PCA9535 16BIT I2C XPNDR SO	*	*	*	*	*	*	*
		17119	TRANS,FDS6982S N+N-MOSFET SO	*	*	*	*	*	*	*
		17129	80331,I/O PROC,800MHZ,D0,829BG	*	*	*	*	*	*	*
		17131	CONN,2X6 M VERT MZZN 6.5H SMT	*	*	*	*	*	*	*
		17148	RES,CHIP 100 1% 1/16W 0402	*	*	*	*	*	*	*
		17156	THERMISTOR,CHIP 10K 5% 0603	*	*	*	*	*	*	*
		2006100	SCD,ADS-6320SS 2U RACK	*	*	*	*	*	*	*
		20GXR	MOON LS CAM RA03	*	*	*	*	*	*	*
		2F620	LS BEZEL RA01	*	*	*	*	*	*	*
		30CUX	LS BEZEL LABEL R000	*	*	*	*	*	*	*
		494045-00	SCD,POLYBAG W/LICENSE NOTICE	*	*	*	*	*	*	*
		49JYW	MOON KEYING BEZEL RA01	*	*	*	*	*	*	*
		513895-00	LABEL,ESA1500 COMPLIANCE	*	*	*	*	*	*	*
		513896-00	CARD,ESA1500/1.0TB RAIN LIC	*	*	*	*	*	*	*
		513897-00	CARD,ESA1500/1.0TB USER LIC	*	*	*	*	*	*	*
		513929-00	CARD,iSA1500/1.0TB SNPSHT LIC	*	*	*	*	*	*	*
		513930-00	CARD,iSA1500/1.0TB SYNC LIC	*	*	*	*	*	*	*
		5E864	DELL 2GB IO LABEL	*	*	*	*	*	*	*
		5F019	LS LIGHTPIPE RA01	*	*	*	*	*	*	*
		70715060-001	CCA,BACKPLANE,12000	*	*	*	*	*	*	*
		70800154-001	DRIVE,HARD,160GB,7200 RPM,WD	*	*	*	*	*	*	*
		70800156-001	HDD,250GB,7200RPM,WD	*	*	*	*	*	*	*
		70800180-001	HDD,80GB,7200RPM,WD (FDB)	*	*	*	*	*	*	*
		70800203-001	250GB HDD RAID EDITION	*	*	*	*	*	*	*
		70800208-001	HDD,WD,120GB,XL-80	*	*	*	*	*	*	*
		70800209-001	HDD,WD,80GB,WD5800JB-50JJCO	*	*	*	*	*	*	*
		ASA-LBL-3046	LABEL AVID ENCLOSURE	*	*	*	*	*	*	*
		ASA-LBL-3179	DECAL,BEZEL 36GB AVID G5	*	*	*	*	*	*	*
		ASA-LBL-3180	DECAL,BEZEL 73GB AVID G5	*	*	*	*	*	*	*
		ASA-LBL-BSMI	LBL,AVID BSMI P/N	*	*	*	*	*	*	*
		ASM-00042-02-C	FFX2 CONTROLLER, REFRESH	*	*	*	*	*	*	*

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		ASM-00137-01-B	PDS DRIVE HNDL/BASE ASSY	*	*	*	*	*	*	*
		ASM-00142-01-A	HEATSINK W/FAN, P3, LOW	*	*	*	*	*	*	*
		ASM-00146-01-A	10/100/1000 ENET PCI ASY	*	*	*	*	*	*	*
		ASM-00209-01-A	TAPE DRWG FOR PCA-00030	*	*	*	*	*	*	*
		ASM-00231-01-A	HEATSINK,23MM BGA,5 FIN	*	*	*	*	*	*	*
		ASM-00259-01-A	HEATSINK,27MM SQ. X 18MM HIGH	*	*	*	*	*	*	*
		ASM-PDS01-01-A	HEATSINK,23MM,BGA,T411	*	*	*	*	*	*	*
		AUD-00001-01-A	BUZZER,2.3KHZ,5V,12X9MM	*	*	*	*	*	*	*
		BAT-00001-01-A	BAT, LI/MNO2 3V .035AH CR1220	*	*	*	*	*	*	*
		BAT-00002-01-A	AES-170X 3.7V 7.2AH LI-ION BAT	*	*	*	*	*	*	*
		BAT-1.2AH6V-001	BATT,1.2AH 6V RECH.LEAD/	*	*	*	*	*	*	*
		BAT-BXF200-01-A	BATTERY PACK, BOXSTORE R000	*	*	*	*	*	*	*
		BAT-XL5301-00-A	BATTERY,AVED GENERATION	*	*	*	*	*	*	*
		CAB-BXF200-01-A	CABEL BATTERY, BOXSTORE RA02	*	*	*	*	*	*	*
		CAB-BXF201-02-A	BBU RESISTOR ASSY	*	*	*	*	*	*	*
		CAB-BXF202-01-A	3-PIN NULL MODEM CABLE, R000	*	*	*	*	*	*	*
		CAB-BXF203-02-A	FFX2 RS232 CABLE DB9F	*	*	*	*	*	*	*
		CAP-00052-01-A	100PF,5%,50V,C0G,0402	*	*	*	*	*	*	*
		CAP-00087-01-A	330UF,20%,10V,POLYMER AL	*	*	*	*	*	*	*
		CAP-00091-01-A	4.7UF,10%,6.3V,X5R,0805	*	*	*	*	*	*	*
		CAP-00092-01-A	680UF,20%,4V,TANT POLYMR,7343H	*	*	*	*	*	*	*
		CAP-00093-01-A	0.1UF,10%,16V,X5R,0402	*	*	*	*	*	*	*
		CAP-00094-01-A	0.047UF,10%,16V,X5R,0402	*	*	*	*	*	*	*
		CAP-PDS01-01-A	1UF,10%,10V,X5R,0603	*	*	*	*	*	*	*
		CAP-PDS02-01-A	1.5PF,0.1PF,50V,C0G,0603	*	*	*	*	*	*	*
		CAP-PDS03-01-A	10UF,10%,6.3V,X5R,0805	*	*	*	*	*	*	*
		CAP-PDS04-01-A	47UF,10%,6.3V,X5R,1812	*	*	*	*	*	*	*
		CAP-PDS05-01-A	470UF,20%,6.3V,TANT,7343	*	*	*	*	*	*	*
		CAP-PDS06-01-A	0.22UF,10%,16V,X7R,0805	*	*	*	*	*	*	*
		CAP-PDS07-01-A	1UF,10%,35V,TANT,3528	*	*	*	*	*	*	*
		CAP-PDS08-01-A	68UF,20%,6.3V,TANT,6032	*	*	*	*	*	*	*
		CAP-PDS09-01-A	4.7UF,20%,25V,X7R,1210	*	*	*	*	*	*	*
		CAP-PDS10-01-A	33UF,20%,6.3V,TANT,3528	*	*	*	*	*	*	*
		CAP-PDS11-01-A	22UF,20%,6.3V,TANT,3528	*	*	*	*	*	*	*
		CAP-PDS12-01-A	10UF,20%,16V,TANT,3528	*	*	*	*	*	*	*
		CAP-PDS13-01-A	470PF,10%,50V,X7R,0603	*	*	*	*	*	*	*
		CAP-PDS14-01-A	470PF,5%,50V,C0G,0603	*	*	*	*	*	*	*
		CAP-PDS15-01-A	2400PF,50V,DCBLOCK,0805	*	*	*	*	*	*	*
		CAP-PDS16-01-A	3300PF,10%,50V,X7R,0603	*	*	*	*	*	*	*
		CAP-PDS17-01-A	2.2UF,10%,10V,X5R,0805	*	*	*	*	*	*	*
		CAP-PDS18-01-A	0.1UF,10%,10V,X5R,0402	*	*	*	*	*	*	*
		CAP-PDS19-01-A	0.47UF,10%,25V,X7R,1206	*	*	*	*	*	*	*
		CAP-PDS20-01-A	10UF,+80%-20%,10VY5V1206	*	*	*	*	*	*	*
		CAP-PDS21-01-A	4.7UF,+80%-20%10VY5V1206	*	*	*	*	*	*	*
		CAP-PDS22-01-A	10UF,20%,6.3V,TANT,3528	*	*	*	*	*	*	*
		CAP-PDS23-01-A	4.7UF,20%,16V,TANT,6032	*	*	*	*	*	*	*
		CAP-PDS24-01-A	100UF,20%,16V,TANT,7343	*	*	*	*	*	*	*
		CAP-PDS25-01-A	120PF,5%,50V,C0G,0603	*	*	*	*	*	*	*
		CAP-PDS26-01-A	0.022UF,10%,16V,X7R,0402	*	*	*	*	*	*	*
		CAP-PDS27-01-A	2.2UF,10%,16V,TANT,3216	*	*	*	*	*	*	*
		CAP-PDS28-01-A	22PF,5%,50V,C0G,0603	*	*	*	*	*	*	*
		CAP-PDS29-01-A	0.1UF,10%,16V,X7R,0603	*	*	*	*	*	*	*

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		CAP-PDS30-01-A	1000PF,10%,50V,X7R,0603	*	*	*	*	*	*	*
		CAP-PDS31-01-A	0.01UF,10%,50V,X7R,0603	*	*	*	*	*	*	*
		CAP-PDS32-01-A	10UF,20%,25V,TANT,6032	*	*	*	*	*	*	*
		CAP-PDS33-01-A	100PF,5%,50V,C0G,0603	*	*	*	*	*	*	*
		CAP-PDS34-01-A	0.01UF,10%,16V,X7R,0402	*	*	*	*	*	*	*
		CB-IHS-400-6U	CABLE,HOST ULT.3U CONT	*	*	*	*	*	*	*
		CBL-00006-01-A	2U 13TH DRV LED HARNESS	*	*	*	*	*	*	*
		CBL-00007-01-A	FFC,0.5MM,10 COND,10"	*	*	*	*	*	*	*
		CBL-00012-01-A	CABLE, RS232 - FS4100	*	*	*	*	*	*	*
		CBL-00012-02-A	CABLE, RS232 - FS4500	*	*	*	*	*	*	*
		CBL-00012-03-A	CABLE,RS232,DB-9 TO 3.5MM PLUG	*	*	*	*	*	*	*
		CBL-00012-04-A	CABLE,RS232,DB-9 - 3.5MM METAL	*	*	*	*	*	*	*
		CBL-00014-02-A	POWER CORD, IBM INT'L, 3M RoHS	*	*	*	*	*	*	*
		CBL-00015-01-A	AES-170X ETHER WRAP PLUG RoHS	*	*	*	*	*	*	*
		CBL-00045-01-A	CABLE, DRIVE ACTIVITY 4P F 1M	*	*	*	*	*	*	*
		CBL-200101-002	POWER CORD,AC 2M USA	*	*	*	*	*	*	*
		CBL-200101-003	POWER CORD,AC 2M EURO	*	*	*	*	*	*	*
		CBL-200101-004	POWER CHORD,UK 2M BLACK	*	*	*	*	*	*	*
		CBL-200102-002	CABLE, 1.0M MAINS	*	*	*	*	*	*	*
		CBL-200102-004	CABLE, 2.0M MAINS	*	*	*	*	*	*	*
		CBL-202403-100	CBL ASY,18AWG BRN UL1015	*	*	*	*	*	*	*
		CBL-415M410M-0.5	68W MALE ULT TO 68W MALE	*	*	*	*	*	*	*
		CBL-510M510M-04	CABLE	*	*	*	*	*	*	*
		CBL-520M620M-02	68PIN(SCREW) 68PIN UHDCI	*	*	*	*	*	*	*
		CBL-520M620M-04	68PIN (SCREW) 68PIN	*	*	*	*	*	*	*
		CBL-DB9MDB9M-03	FCAL CABEL, NON-EQ DB9 RA01	*	*	*	*	*	*	*
		CDA-00001-02-A	CD ASSY, AES-170X APPS 7.21 SW	*	*	*	*	*	*	*
		CDA-00001-03-A	CD ASSY, AES-170X APPS 7.22 SW	*	*	*	*	*	*	*
		CDA-00002-05-A	CD ASSY, AES-170X SUPT 4.1 FW	*	*	*	*	*	*	*
		CDA-00003-02-A	CD ASSY, AES-170X DOCS V1.1	*	*	*	*	*	*	*
		CDA-00003-03-A	CD ASSY, AES-170X DOCS V1.2	*	*	*	*	*	*	*
		CDA-00005-01-A	CD ASSY, SERVERAID 7.10b APPL	*	*	*	*	*	*	*
		CDA-00006-01-A	CD ASSY, SERVERAID 7.10b SUPRT	*	*	*	*	*	*	*
		CON-00001-01-A	HDR,5X6,2MM,PRESS,VERT	*	*	*	*	*	*	*
		CON-00003-01-A	HDR,5X24,2MM,PRESS,VERT	*	*	*	*	*	*	*
		CON-00051-01-A	RECPT,PWR,30PIN,SOLDER,V	*	*	*	*	*	*	*
		CON-00064-02-A	2DR,2PIN,0.12" TAILS	*	*	*	*	*	*	*
		CON-00134-01-A	RECPT,SAS,29PIN,VERT,SMD	*	*	*	*	*	*	*
		CON-00137-01-A	PLUG,156PIN,25MIL,VRT,SM	*	*	*	*	*	*	*
		CON-00140-01-A	RECPT,SAS,4X,RT ANGLE	*	*	*	*	*	*	*
		CON-00141-01-A	HDR,2X7,0.1",SHROUDED,SM	*	*	*	*	*	*	*
		CON-00142-01-A	HDR,2X8,0.1",SHROUDED,SM	*	*	*	*	*	*	*
		CON-00143-01-A	HDR,2X25,.05"X.1",VRT,SM	*	*	*	*	*	*	*
		CON-00144-01-A	RECPT,USB,TYPE B,RIGHT ANGLE	*	*	*	*	*	*	*
		CON-00156-01-A	RECPT,2X5,.05",VERT,SMD,KEYED	*	*	*	*	*	*	*
		CON-00157-01-A	HDR,2X5,.05",VERT,SMD,KEYED	*	*	*	*	*	*	*
		CON-00158-01-A	JACK,RJ45,W/MAG&LEDS(Y&O/G)	*	*	*	*	*	*	*
		CON-00180-01-A	RECEPT,HOUSING,MICRO-FIT,6-POS	*	*	*	*	*	*	*
		CON-00181-01-A	TERMINAL,FEMALE,WIRE,MICRO-FIT	*	*	*	*	*	*	*
		CON-PDS01-01-A	RECPT,RA,HSSDC2,7P,FC	*	*	*	*	*	*	*
		CON-PDS02-01-A	RCPT,SATA,22P,VRT,EXT HT	*	*	*	*	*	*	*
		CON-PDS03-01-A	HDR,2X3X.1,VERT,SMT	*	*	*	*	*	*	*

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		CON-PDS04-01-A	HDR,2X3X.1,VERT,PTH	*	*	*	*	*	*	*
		CON-PDS07-01-A	RECPT,HS,5X6,2MM,PRS,RA	*	*	*	*	*	*	*
		CON-PDS08-01-A	AUDIO JACK,3PIN,RA,STEREO	*	*	*	*	*	*	*
		CON-PDS09-01-A	CONN,HDR,1X10,SMD FOR RBN CBL	*	*	*	*	*	*	*
		CON-PDS10-01-A	CONN,PLUG,VERTICAL,SCA2,40P	*	*	*	*	*	*	*
		CON-PDS11-01-A	HDR,8PIN,SOLDER,VERT	*	*	*	*	*	*	*
		DIO-PDS01-01-A	ZENER,18V,5%,0.35W,SOT23	*	*	*	*	*	*	*
		DIO-PDS02-01-A	ZENER,8.2V,5%,0.35W,SOT23	*	*	*	*	*	*	*
		DIO-PDS03-01-A	SCHOTTKY,1A,20V,SMA	*	*	*	*	*	*	*
		DRV-00007-03-A	73LP CH5 10K 520BPS FCAL	*	*	*	*	*	*	*
		DRV-00010-01-A	CHEETAH X15 18LD 15K FC	*	*	*	*	*	*	*
		DRV-00037-01-A	CHEETAH 15K.3 U320 18GB	*	*	*	*	*	*	*
		DRV-00046-01-A	DAYTONA U320 36GB	*	*	*	*	*	*	*
		DRV-00047-01-A	CUDA V SATA 120GB	*	*	*	*	*	*	*
		DRV-00048-01-A	DIAMONDMAX +9 160GB SATA	*	*	*	*	*	*	*
		DRV-00059-01-A	CUDA 7200.7 SATA 120GB	*	*	*	*	*	*	*
		DRV-00064-01-A	DESKSTAR 160GB SATA	*	*	*	*	*	*	*
		DRV-00105-01-A	SABRE PATA MAXTOR 250GB-SNAP	*	*	*	*	*	*	*
		DRV-00111-01-A	HITACHI 15K147 4GFC 73GB RoHS	*	*	*	*	*	*	*
		EL-PDU-1500B-1	PDU 19" 2U 100V-240V	*	*	*	*	*	*	*
		ELRC+5540-002	ADAPTOR UW S.E. 40MB/SEC	*	*	*	*	*	*	*
		ELRC+5560-002	ADAPTOR UW DIFF 40MB/SEC	*	*	*	*	*	*	*
		ELRC-3101U	IFT ULTRA WIDE SCSI RAID R121U	*	*	*	*	*	*	*
		ELRC-9051UWD	IFT ULTRA WIDE DIFF SCSI R000	*	*	*	*	*	*	*
		ELRC-9051UWS	IFT ULTRA WIDE SE SCSI R000	*	*	*	*	*	*	*
		EMA-BXG100-01-C	DELL BOXSTORE PORSCHE	*	*	*	*	*	*	*
		EMA-BXG100-01-D	DELL BOXSTORE PORSCHE	*	*	*	*	*	*	*
		EMA-BXG100-02-D	POWER SUPPLY - EUR	*	*	*	*	*	*	*
		EMA-XL6200-01-C	XL600 ACM ASSEMBLY (NMB)	*	*	*	*	*	*	*
		EMI-GEN300-01-B	EMI STRIP, SMALL, .17"	*	*	*	*	*	*	*
		EMI-GEN300-02-B	EMI STRIP, SMALL, .54"	*	*	*	*	*	*	*
		EMI-GEN300-03-B	EMI STRIP, SMALL, .92"	*	*	*	*	*	*	*
		EMI-GEN300-06-B	EMI STRIP, SMALL, 4.28"	*	*	*	*	*	*	*
		EMI-GEN300-09-B	EMI STRIP, SMALL, 3.91"	*	*	*	*	*	*	*
		EMI-GEN304-01-A	EMI STRIP, ROUNDED, 4.2"	*	*	*	*	*	*	*
		FAN-BL12V13W	FAN, ASSY BLWR 12V 13W	*	*	*	*	*	*	*
		FAS-BXG300-01-A	SCREW M3X10 T/BT	*	*	*	*	*	*	*
		FAS-BXG300-02-A	SCREW, M3X15 T/PN	*	*	*	*	*	*	*
		FAS-BXG301-01-A	SCREW M3X12 T/PN	*	*	*	*	*	*	*
		FAS-BXG302-01-A	SCREW M3X8 T/CSK	*	*	*	*	*	*	*
		FAS-BXG302-02-A	SCREW, M3X8 T/CK	*	*	*	*	*	*	*
		FAS-BXG303-01-A	SCREW 6-32X.375" T/PN	*	*	*	*	*	*	*
		FAS-BXG305-01-A	SCREW M3X6 T/TR	*	*	*	*	*	*	*
		FAS-GEN300-02-A	SCREW 4-40X.375" PH/PN	*	*	*	*	*	*	*
		FAS-GEN300-03-A	SCREW 4-40X.187" PH/PN	*	*	*	*	*	*	*
		FAS-GEN300-04-A	SCREW 4-40X.125" PH/PN	*	*	*	*	*	*	*
		FAS-GEN300-05-A	SCREW 4-40X.500" PH/PN	*	*	*	*	*	*	*
		FAS-GEN302-01-A	SCREW 4-20X.375" PH/PN	*	*	*	*	*	*	*
		FAS-GEN302-02-A	SCREW 4-20X.5" PH/PN	*	*	*	*	*	*	*
		FAS-GEN303-01-A	SCREW 6.32X.250" PH/CK	*	*	*	*	*	*	*
		FAS-GEN304-01-A	SCREW 2-56X.187" PH/PN	*	*	*	*	*	*	*
		FAS-GEN309-01-A	SCREW M3X8 T/PN	*	*	*	*	*	*	*

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		FUS-00004-01-A	FUSE,3A,VERY FAST,1206	*	*	*	*	*	*	*
		FUS-00005-01-A	FUSE,5A,VERY FAST,1206	*	*	*	*	*	*	*
		FWR-00041-01-A	XIOTECH IMPREZA E2 FILE	*	*	*	*	*	*	*
		GBIC-HSSDC-1	GBIC - COPPER HSSDC	*	*	*	*	*	*	*
		GEN-00005-01-A	2GB, 0.3 METER, CU CABLE	*	*	*	*	*	*	*
		GEN-00005-02-A	2GB, 1 METER, CU CABLE	*	*	*	*	*	*	*
		GEN-00005-03-A	2GB, 3 METER, CU CABLE	*	*	*	*	*	*	*
		GEN-00005-04-A	2GB, 6 METER, CU CABLE	*	*	*	*	*	*	*
		GEN-00006-01-A	2GB, 10 METER, OPT CABLE	*	*	*	*	*	*	*
		GEN-00006-02-A	2GB, 30 METER, OPT CABLE	*	*	*	*	*	*	*
		GEN-00006-05-A	2GB, 150 M, OPT CABLE	*	*	*	*	*	*	*
		GEN-00006-06-A	2GB, 0.3 M, OPT CABLE	*	*	*	*	*	*	*
		GEN-00006-07-A	2GB, 0.5 M, OPT CABLE	*	*	*	*	*	*	*
		GEN-00008-01-A	LED KEYING LABEL	*	*	*	*	*	*	*
		GEN-00009-01-A	LED BLANK KEYING LABEL	*	*	*	*	*	*	*
		GEN-00023-01-A	LABEL, MODEL NAME	*	*	*	*	*	*	*
		GEN-00023-02-A	LABEL, MODEL NAME	*	*	*	*	*	*	*
		GEN-00023-03-A	LABEL, MODEL NAME	*	*	*	*	*	*	*
		GEN-00024-01-A	LABEL, LOGO	*	*	*	*	*	*	*
		GEN-00025-01-A	POWER CHORD AC 2M BLK SA	*	*	*	*	*	*	*
		GEN-00033-01-A	POWER CORD AC 2M BLK AUS	*	*	*	*	*	*	*
		GEN-00044-01-A	LABEL, DRV CARRIER BLANK	*	*	*	*	*	*	*
		GEN-00045-01-A	LABEL, 2GB LOGO	*	*	*	*	*	*	*
		GEN-00046-01-A	LABEL, SYSTEM ID	*	*	*	*	*	*	*
		GEN-00047-01-A	LABEL, LS MODULE	*	*	*	*	*	*	*
		GEN-00047-06-A	LABEL, LS MODULE	*	*	*	*	*	*	*
		GEN-00049-01-A	LABEL, 36GB 15K DRIVE	*	*	*	*	*	*	*
		GEN-00050-01-A	LABEL, 73GB 10K DRIVE	*	*	*	*	*	*	*
		GEN-00051-01-A	LABEL, BBU MANUFACTURE	*	*	*	*	*	*	*
		GEN-00052-01-A	LABEL, FAN TRAY WARNING	*	*	*	*	*	*	*
		GEN-00053-01-A	LABEL, HANDLE WARNING	*	*	*	*	*	*	*
		GEN-00054-01-A	LABEL, NAME LOGO	*	*	*	*	*	*	*
		GEN-00063-01-A	LABEL, AVID MEDIARRAY II	*	*	*	*	*	*	*
		GEN-00067-01-A	LABEL, ESD RE-USEABLE	*	*	*	*	*	*	*
		GEN-00071-01-A	LABEL BARCODE 4" X 0.5"	*	*	*	*	*	*	*
		GEN-00073-01-A	LABEL COMPOSITE 105X69	*	*	*	*	*	*	*
		GEN-00075-04-A	EMI STRIP, 98-918 X 42	*	*	*	*	*	*	*
		GEN-00075-05-A	EMI STRIP, 98-918 X 21	*	*	*	*	*	*	*
		GEN-00076-01-A	EMI STRIP, 97-915 X 5	*	*	*	*	*	*	*
		GEN-00078-01-A	EMI STRIP, 77-030	*	*	*	*	*	*	*
		GEN-00115-01-A	2GB, 0.6 METER, CU CABLE	*	*	*	*	*	*	*
		GEN-00116-01-A	OPT CONNECTOR DUST COVER	*	*	*	*	*	*	*
		GEN-00117-01-B	LABEL - 30X5 THERMAL WHT	*	*	*	*	*	*	*
		GEN-00118-01-B	LABEL 19X60 THERMAL WHT	*	*	*	*	*	*	*
		GEN-00139-01-B	LABEL, XIOTECH LOGO	*	*	*	*	*	*	*
		GEN-00139-02-A	LABEL, XIOTECH LOGO, NEW	*	*	*	*	*	*	*
		GEN-00154-01-A	LABEL - 70MM X 105MM WHT	*	*	*	*	*	*	*
		GEN-00155-01-A	LABEL, 146GB 10K DRIVE	*	*	*	*	*	*	*
		GEN-00156-01-A	LABEL, 146GB 15K DRIVE	*	*	*	*	*	*	*
		GEN-00162-01-A	LBL, 146GB FC DRV - BLK	*	*	*	*	*	*	*
		GEN-00162-04-A	LBL, 146GB FC DRV - ACER	*	*	*	*	*	*	*
		GEN-00164-01-A	LBL, 146GB SC DRV - BLK	*	*	*	*	*	*	*

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		GEN-00164-03-A	LBL, 146GB SC DRV - WINE	*	*	*	*	*	*	*
		GEN-00164-04-A	LBL, 146GB SC DRV - GREY	*	*	*	*	*	*	*
		GEN-00164-08-A	LBL, 146GB SC DRV - AVID	*	*	*	*	*	*	*
		GEN-00166-01-A	LABEL, XIOTECH FAN/PS	*	*	*	*	*	*	*
		GEN-00168-01-A	LABEL AVID DRV 146 LVD	*	*	*	*	*	*	*
		GEN-00183-01-A	LABEL, 73GB 15K DRIVE	*	*	*	*	*	*	*
		GEN-00208-01-A	HANG TAG 512597-00 4" X 8"	*	*	*	*	*	*	*
		GEN-00209-01-A	GASKET,EMI,ELASTOMERIC,CUSTOM	*	*	*	*	*	*	*
		HDA-07N3250S	IBM DRIVE 9GB 10K RPM RS80D	*	*	*	*	*	*	*
		HDA-ST118202LC	18GB SEAGATE DRIVE R0004	*	*	*	*	*	*	*
		HDA-ST-9L8004-047	SEAGATE 18GB 10K UNIQUE RF304	*	*	*	*	*	*	*
		HDA-ST-9N7006-001	SEAGATE 36K FIBRE DRIVE R0001	*	*	*	*	*	*	*
		HDA-ST-9N8006-001	SEAGATE 73GB RPM LVD R0001	*	*	*	*	*	*	*
		HDW-00020-01-A	CAP,BLK VINYL,1/16"X5/8"	*	*	*	*	*	*	*
		HDW-00021-01-A	CLIP,LED,3MM,PANEL MOUNT	*	*	*	*	*	*	*
		HDW-00023-01-A	SCR, PHL PAN, M3 X 5 LG	*	*	*	*	*	*	*
		HDW-00027-01-A	STNDF, 4-40 X .31 HEX	*	*	*	*	*	*	*
		HDW-00031-01-A	STANDOFF, PLASTIC, HEX	*	*	*	*	*	*	*
		HDW-00032-01-A	TAPE, ELECTRICAL 5/8"	*	*	*	*	*	*	*
		HDW-00034-09-A	SCREW, 4-40 X1.00" PH/CK	*	*	*	*	*	*	*
		HDW-00042-01-A	CAP,BLK VINYL,1/16"X7/16	*	*	*	*	*	*	*
		HDW-00045-01-A	PIN,GUIDE,32X2.6MM	*	*	*	*	*	*	*
		HDW-00046-01-A	KEY,CODING,BLACK	*	*	*	*	*	*	*
		HDW-00047-01-A	SCREW M2X8 PH/PN	*	*	*	*	*	*	*
		HDW-00051-01-A	SCR, 10-32 X .50 LG, LOC PN	*	*	*	*	*	*	*
		HDW-00054-01-A	JACKSCREW, M2.5X4.2	*	*	*	*	*	*	*
		HDW-00055-01-A	SCREW, M3X4MM PANHD PHIL SST	*	*	*	*	*	*	*
		HDW-00056-01-A	STANDOFF, NYLON 6MM DUAL LOCK	*	*	*	*	*	*	*
		HDW-00057-01-A	IBM M6 CAGE NUT FOR AES-170X	*	*	*	*	*	*	*
		HDW-00058-01-A	IBM M6 SCREW, HEX HEAD	*	*	*	*	*	*	*
		HDW-00059-01-A	IBM C-CLIP FOR AES-170X	*	*	*	*	*	*	*
		HDW-00060-01-A	SPACER 8.0D X 3.2ID X 6MM ALUM	*	*	*	*	*	*	*
		HDW-00061-01-A	SCREW M2.5X.45 X 4 LONG, PH/PN	*	*	*	*	*	*	*
		HDW-00062-01-A	STANDOFF,6MM LONG,2.5MM THREAD	*	*	*	*	*	*	*
		HDW-00064-01-A	IBM M5 X 0.8 HEX SCREW 54G2882	*	*	*	*	*	*	*
		HDW-00066-01-A	SCREW, 6-32 X 0.5 SLOT FLAT HD	*	*	*	*	*	*	*
		HDW-00067-01-A	SPACER 6.0D X 3.2ID X 6MM NYL N	*	*	*	*	*	*	*
		HDW-00078-01-A	RIVET NYLON MYNAH IBM 97P3748	*	*	*	*	*	*	*
		HDW-00079-01-A	RETAINER SNAP-IN IBM 53P1797	*	*	*	*	*	*	*
		HDW-00097-01-A	CLIP, THERMAL, TO-220	*	*	*	*	*	*	*
		HDW-00102-01-A	STANDOFF, M3 x 10mm FEMALE	*	*	*	*	*	*	*
		HDW-00103-01-A	STANDOFF, M3 x 10mm M/F	*	*	*	*	*	*	*
		HDW-100012	BAG,SELF-SEAL 2.25"SQ	*	*	*	*	*	*	*
		HDW-300001	SCREW, 6-32 X .375 HEX H RA01	*	*	*	*	*	*	*
		HDW-300002	SCREW 4-40X.25" PH/CK RA01	*	*	*	*	*	*	*
		HDW-300007	SCREW 6-32X.25 PH/CK	*	*	*	*	*	*	*
		HDW-300014	SCREW 4-40X.25" PH/PN	*	*	*	*	*	*	*
		HDW-300022-02-A	SCREW 8-32X.31" PH/CK	*	*	*	*	*	*	*
		HDW-300030	SCREW 6-32X.38" PH/CK	*	*	*	*	*	*	*
		HDW-300031	SCREW 10-32X.38" PH/PN	*	*	*	*	*	*	*
		HDW-300032	SCREW 6-32X.25" PH/PN	*	*	*	*	*	*	*
		HDW-300034	SPEEDNUT 10-32	*	*	*	*	*	*	*

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		HDW-300041	SCREW 6-32X.38" PH/PN RA01	*	*	*	*	*	*	*
		HDW-300045	CAGE NUT 10-32UNF	*	*	*	*	*	*	*
		HDW-300053	SCREW 4-40X.19" PH/CK	*	*	*	*	*	*	*
		HDW-300053-02-A	SCREW 4-40X.150" PH/CK	*	*	*	*	*	*	*
		HDW-502002-001	JACKSCREW M2X6	*	*	*	*	*	*	*
		HDW-502007-001	M2 JACKSCREW FOR VHDCI C RA01	*	*	*	*	*	*	*
		HDW-503006-010	SCREW M3X10 T/PN	*	*	*	*	*	*	*
		HDW-503007-012	SCREW M3X12 PZ/CK	*	*	*	*	*	*	*
		HDW-504001-003	NUT M4 NYLOCK	*	*	*	*	*	*	*
		HDW-504005-008	SCREW M4X8 PZ/PN	*	*	*	*	*	*	*
		HDW-504016-008	SCREW M4X8 T/PN	*	*	*	*	*	*	*
		HDW-603007-030	SCREW KC30X30 T/PN	*	*	*	*	*	*	*
		HDW-GBP006	LOCTITE THREADLOCKER	*	*	*	*	*	*	*
		HDW-GBP008	LOCTITE INSTANT ADHESIVE	*	*	*	*	*	*	*
		HDW-PDS01-01-A	BRKT,STIFFENER,MUDFLAP	*	*	*	*	*	*	*
		HDW-PDS03-01-A	STANDOFF,PLASTIC,HEX,.375L	*	*	*	*	*	*	*
		ICS-00015-01-A	I2C SERIAL EEPROM,16KBIT	*	*	*	*	*	*	*
		ICS-00167-01-A	SAS EDGE EXPANDER,12PORT	*	*	*	*	*	*	*
		ICS-00168-01-A	SHIFT REG,8BIT,W/LATCHES	*	*	*	*	*	*	*
		ICS-00169-01-A	I2C BACKPLANE CONTROLLER	*	*	*	*	*	*	*
		ICS-00170-01-A	4MBIT FLASH EE,SPI,3.3V	*	*	*	*	*	*	*
		ICS-00171-01-A	128KX8 SRAM,70NS,3.3V,SO	*	*	*	*	*	*	*
		ICS-00173-01-A	REG,1.5V&ADJ,500MA,UMAX	*	*	*	*	*	*	*
		ICS-00174-01-A	REG,SWITCHING,2.5V,6A	*	*	*	*	*	*	*
		ICS-00176-01-A	MICROCONTROLLER,H8S/2166,144QFP	*	*	*	*	*	*	*
		ICS-00177-01-A	USB MICROCONTROLLER, 128 PQFP	*	*	*	*	*	*	*
		ICS-00178-01-A	HEX BUFFER,OPEN D,SOIC,14 PIN	*	*	*	*	*	*	*
		ICS-00180-01-A	64KBIT EE,I2C,2.5V,8SOIC	*	*	*	*	*	*	*
		ICS-00184-01-A	REGULATOR,ADJ,1.5A,SOT223	*	*	*	*	*	*	*
		ICS-00240-01-A	ICS345,CLK SYNTH,TRIPLE,20SSOP	*	*	*	*	*	*	*
		ICS-PDS01-01-A	DUAL RS232 XCVR,SSOP20	*	*	*	*	*	*	*
		ICS-PDS02-01-A	UP WATCHDOG TIMER,SOT23-8	*	*	*	*	*	*	*
		ICS-PDS03-01-A	I2C TEMP SNSR,WATCHDOG,SO	*	*	*	*	*	*	*
		ICS-PDS04-01-A	SATA CTRLR,PCIX>8P,B2,BGA	*	*	*	*	*	*	*
		ICS-PDS05-01-A	PCIX CLK GENERATOR,TSSOP	*	*	*	*	*	*	*
		ICS-PDS06-01-A	INVRTR W/SCHMT IN,SC70-5	*	*	*	*	*	*	*
		ICS-PDS07-01-A	2-IN AND GATE,SC70-5	*	*	*	*	*	*	*
		ICS-PDS08-01-A	2-IN OR GATE,SC70-5	*	*	*	*	*	*	*
		ICS-PDS09-01-A	QUAD BUS SW,ACTV LOW,SO	*	*	*	*	*	*	*
		ICS-PDS10-01-A	D-FF,W/PRESET,CLR,US8	*	*	*	*	*	*	*
		ICS-PDS11-01-A	PWM SYNCH BUCK CTRLR,SO8	*	*	*	*	*	*	*
		ICS-PDS12-01-A	BUCK REG,ADJ,1.5A,SSOP20	*	*	*	*	*	*	*
		ICS-PDS13-01-A	COMPARATOR W/VREF,SC70-5	*	*	*	*	*	*	*
		ICS-PDS14-01-A	HOT SWAP CTRLR,2 CH,TSSOP	*	*	*	*	*	*	*
		ICS-PDS15-01-A	QUAD V SUPRVSR,SOT23-6	*	*	*	*	*	*	*
		ICS-PDS16-01-A	ULTRA LOW I,LDO,.15A,SOT	*	*	*	*	*	*	*
		ICS-PDS17-01-A	8 BIT I2C+SMB I/O,TSSOP	*	*	*	*	*	*	*
		ICS-PDS18-01-A	BUFFER W/3STATE,SC70-5	*	*	*	*	*	*	*
		ICS-PDS19-01-A	DUAL 2G FC>PCIX CTRLR,BGA	*	*	*	*	*	*	*
		ICS-PDS20-01-A	DUAL REG DDR TERM,MSOP10	*	*	*	*	*	*	*
		ICS-PDS21-01-A	I2C HOT SWAP BUFFR,MSOP8	*	*	*	*	*	*	*
		ICS-PDS22-01-A	BUFFR W/SCHMT IN,SC70-5	*	*	*	*	*	*	*

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		ICS-PDS23-01-A	SSRAM,256KX18,7.5NS,TQFP	*	*	*	*	*	*	*
		ICS-PDS24-01-A	FRAM,32KX8,3.3V,SO28	*	*	*	*	*	*	*
		ICS-PDS25-01-A	3-IN AND GATE,SC70-5	*	*	*	*	*	*	*
		ICS-PDS26-01-A	DUAL DIFF CMPARTR,SO8	*	*	*	*	*	*	*
		ICS-PDS27-01-A	2-IN NAND GATE,SC70-5	*	*	*	*	*	*	*
		ICS-PDS28-01-A	TIMER,SO8	*	*	*	*	*	*	*
		ICS-PDS29-01-A	1.5GBPS SATA MUX/BFR,QFN*NOTE	*	*	*	*	*	*	*
		ICS-PDS30-01-A	VREG,LDO,3.3V,.5A,MSOP8	*	*	*	*	*	*	*
		ICS-PDS31-01-A	ANLG SW,2BIT BUS,US8	*	*	*	*	*	*	*
		ICS-PDS32-01-A	RS422 RCVR,SOT23-5	*	*	*	*	*	*	*
		ICS-PDS33-01-A	RS422 XMTR,2.5MBPS,SOT23	*	*	*	*	*	*	*
		ICS-PDS34-01-A	SDRAM DDR 16MBX8,TSOP	*	*	*	*	*	*	*
		ICS-PDS35-01-A	2-IN NONINV MUX,SC70-6	*	*	*	*	*	*	*
		ICS-PDS36-01-A	POST AMP,3.2GBPS,MSOP10	*	*	*	*	*	*	*
		ICS-PDS37-01-A	RESET,ACTV LO,OD,SC70-3	*	*	*	*	*	*	*
		ICS-PDS38-01-A	IO PRCSR400MHZ,REVB1,BGA	*	*	*	*	*	*	*
		ICS-PDS41-01-A	D-TYPE LATCH,20P,TSSOP	*	*	*	*	*	*	*
		ICS-PDS42-01-A	FLASH,4MB,110NS,TSOP56	*	*	*	*	*	*	*
		ICS-PDS43-01-A	UC,8BIT W/64KB FLSH,SOFP	*	*	*	*	*	*	*
		ICS-PDS44-01-A	UC,8BIT W/1KB FLSH,SO8	*	*	*	*	*	*	*
		ICS-PDS47-01-A	2KBIT EEPROM,I2C,8SOIC	*	*	*	*	*	*	*
		LBL-00002-02-A	SNFORM-CCMM000YFPXXX	*	*	*	*	*	*	*
		LBL-00003-01-A	P/N, FORMAT - XXXR VZ.Z	*	*	*	*	*	*	*
		LBL-00006-01-A	LABEL, SHF, RT, BLK, ALT	*	*	*	*	*	*	*
		LBL-00006-03-A	LABEL, SHF, RT, GRY, ALT	*	*	*	*	*	*	*
		LBL-00006-04-A	LABEL, SHF, RT, BLU, ALT	*	*	*	*	*	*	*
		LBL-00006-05-A	LABEL, SHF, RT,WINE, ALT	*	*	*	*	*	*	*
		LBL-00007-01-A	LABEL, SHF, LT, BLK	*	*	*	*	*	*	*
		LBL-00007-03-A	LABEL, SHF, LT, GRY	*	*	*	*	*	*	*
		LBL-00007-04-A	LABEL, SHF, LT, BLUE	*	*	*	*	*	*	*
		LBL-00007-05-A	LABEL, SHF, LT, WINE	*	*	*	*	*	*	*
		LBL-00007-06-A	LABEL, SHF, LT, AVID	*	*	*	*	*	*	*
		LBL-00011-01-A	LABEL, SHF, RT, BLK, GEN	*	*	*	*	*	*	*
		LBL-00011-04-A	LABEL, SHF, RT,WINE, GEN	*	*	*	*	*	*	*
		LBL-00012-01-A	LABEL, TOWER, BLK, ALT	*	*	*	*	*	*	*
		LBL-00014-01-A	LABEL, SATA, 120GB GRY	*	*	*	*	*	*	*
		LBL-00014-02-A	LABEL, SATA, 160GB GRY	*	*	*	*	*	*	*
		LBL-00014-03-A	LABEL, SATA, 200GB GRY	*	*	*	*	*	*	*
		LBL-00014-04-A	LABEL, SATA, 250GB GRY	*	*	*	*	*	*	*
		LBL-00014-06-A	LABEL, SATA, 160GB BLK	*	*	*	*	*	*	*
		LBL-00014-07-A	LABEL, SATA, 200GB BLK	*	*	*	*	*	*	*
		LBL-00014-08-A	LABEL, SATA, 250GB BLK	*	*	*	*	*	*	*
		LBL-00014-09-A	LABEL, SATA, 80GB GRY	*	*	*	*	*	*	*
		LBL-00014-10-A	LABEL, SATA, 80GB BLK	*	*	*	*	*	*	*
		LBL-00014-14-A	LABEL, SATA, 500GB BLK	*	*	*	*	*	*	*
		LBL-00015-01-A	LABEL, SCSI, 18GB WINE	*	*	*	*	*	*	*
		LBL-00015-02-A	LABEL, SCSI, 36GB WINE	*	*	*	*	*	*	*
		LBL-00015-03-A	LABEL, SCSI, 73GB WINE	*	*	*	*	*	*	*
		LBL-00015-04-A	LABEL, SCSI, 146GB WINE	*	*	*	*	*	*	*
		LBL-00015-07-A	LABEL, SCSI, 73GB BLK	*	*	*	*	*	*	*
		LBL-00015-08-A	LABEL, SCSI, 146GB BLK	*	*	*	*	*	*	*
		LBL-00016-01-A	LABEL, FIBRE, 18GB BLUE	*	*	*	*	*	*	*

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		LBL-00016-02-A	LABEL, FIBRE, 36GB BLUE	*	*	*	*	*	*	*
		LBL-00016-03-A	LABEL, FIBRE, 73GB BLUE	*	*	*	*	*	*	*
		LBL-00016-04-A	LABEL, FIBRE, 146GB BLUE	*	*	*	*	*	*	*
		LBL-00016-05-A	LABEL, FIBRE, 18GB BLK	*	*	*	*	*	*	*
		LBL-00016-06-A	LABEL, FIBRE, 36GB BLK	*	*	*	*	*	*	*
		LBL-00016-07-A	LABEL, FIBRE, 73GB BLK	*	*	*	*	*	*	*
		LBL-00016-08-A	LABEL, FIBRE, 146GB BLK	*	*	*	*	*	*	*
		LBL-00018-02-A	ALTEVO COMP LABEL, SINGA	*	*	*	*	*	*	*
		LBL-00018-02-B	ALTEVO COMP LABEL, SINGA WEEE	*	*	*	*	*	*	*
		LBL-00019-01-A	LABEL, TOWER, BLK, BOT	*	*	*	*	*	*	*
		LBL-00019-02-A	LABEL, TOWER, GRY, BOT	*	*	*	*	*	*	*
		LBL-00019-03-A	LABEL, TOWER, BLUE, BOT	*	*	*	*	*	*	*
		LBL-00019-05-A	LABEL, TOWER, AVID, BOT	*	*	*	*	*	*	*
		LBL-00020-02-A	ALT TOWER COMP LBL, SING	*	*	*	*	*	*	*
		LBL-00021-01-A	LABEL, LASER WARNING	*	*	*	*	*	*	*
		LBL-00022-01-A	LABEL, SCSI, 18GB AVID	*	*	*	*	*	*	*
		LBL-00022-02-A	LABEL, SCSI, 36GB AVID	*	*	*	*	*	*	*
		LBL-00022-03-A	LABEL, SCSI, 73GB AVID	*	*	*	*	*	*	*
		LBL-00022-04-A	LABEL, SCSI, 146GB AVID	*	*	*	*	*	*	*
		LBL-00023-01-A	LABEL, SHF, RT,AVID	*	*	*	*	*	*	*
		LBL-00025-01-A	LABEL, TOWER, TOP, AVID	*	*	*	*	*	*	*
		LBL-00027-01-A	LABEL, 1.5 I/O, PDS	*	*	*	*	*	*	*
		LBL-00028-02-A	ALT COMP LBL, PDS, SING	*	*	*	*	*	*	*
		LBL-00028-02-B	ALT COMP LBL, PDS, SING WEEE	*	*	*	*	*	*	*
		LBL-00043-01-A	LABEL, LEFT RACK, ADIC	*	*	*	*	*	*	*
		LBL-00045-01-A	LABEL, SHF, LT, CIPRICO	*	*	*	*	*	*	*
		LBL-00046-01-A	LABEL, SHF, RT, CIPRICO	*	*	*	*	*	*	*
		LBL-00047-01-A	LABEL, BATTERY WARNING	*	*	*	*	*	*	*
		LBL-00050-01-A	LABEL, RACK, FS4400	*	*	*	*	*	*	*
		LBL-00055-01-A	PROP 65 WARNING LBL 513734-00	*	*	*	*	*	*	*
		LBL-00056-01-A	LABEL, SHF, RT, XIOTECH	*	*	*	*	*	*	*
		LBL-00057-01-A	LABEL, SHF, LT, XIOTECH	*	*	*	*	*	*	*
		LBL-00058-01-A	LABEL, I/O SLOT, XIOTECH UPPER	*	*	*	*	*	*	*
		LBL-00059-01-A	LABEL, I/O SLOT, XIOTECH LOWER	*	*	*	*	*	*	*
		LBL-00060-01-A	LABEL, UPC 1.5" X 1" WHT POLY	*	*	*	*	*	*	*
		LBL-00061-01-A	LABEL, UPC/TSID COMBO	*	*	*	*	*	*	*
		LBL-00062-01-A	IBM TAMPER PROOF LABEL	*	*	*	*	*	*	*
		LBL-00063-01-A	LABEL, SN/REV COMBO WHT POLY	*	*	*	*	*	*	*
		LBL-00064-01-A	LABEL, 0.25" X 1.55" WHT POLY	*	*	*	*	*	*	*
		LBL-00065-01-A	LBL BLANK, PRODUCT/BIOS COMBO	*	*	*	*	*	*	*
		LBL-00073-01-A	LABEL, ENCLOSURE EAR, BLACK	*	*	*	*	*	*	*
		LBL-00074-01-A	LABEL, 2.56" X 1.10 WHT POLY	*	*	*	*	*	*	*
		LBL-00075-01-A	JUPITER, IO / PS HANDLE LABEL	*	*	*	*	*	*	*
		LBL-00081-01-A	LABEL, 1.5" CLEAR POLY SEALER	*	*	*	*	*	*	*
		LBL-00083-01-A	LABEL, 2.75" X 0.75" WHT POLY	*	*	*	*	*	*	*
		LBL-00084-01-A	LABEL, IBM MEMORY MODULE STOCK	*	*	*	*	*	*	*
		LBL-00085-01-A	LABEL, 1.5" TMPR PRF CLR VOID	*	*	*	*	*	*	*
		LBL-00086-01-A	LABEL, 1.18" X 0.40" WHY POLY	*	*	*	*	*	*	*
		LBL-00087-01-A	LABEL, 2" X 0.5" HI TEMP WHT	*	*	*	*	*	*	*
		LBL-00088-01-A	LBL, TAIWAN BAT RECYCLE16x16mm	*	*	*	*	*	*	*
		LBL-00095-09-A	2U CARRIER LBL, SAS, 36GB BLUE	*	*	*	*	*	*	*
		LBL-00102-01-A	ALTEVO COMP LABEL, CIPRICO	*	*	*	*	*	*	*

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		LBL-00106-01-A	LABEL, RACK, SS5100	*	*	*	*	*	*	*
		LBL-00115-01-A	LBL, PB FREE ROHS PCA MARKING	*	*	*	*	*	*	*
		LBL-00118-01-A	LABEL, WEEE MARKING	*	*	*	*	*	*	*
		LBL-51-112716	LABEL SIZE 4X6.5 INCHES	*	*	*	*	*	*	*
		LBL-ASA001	LABEL, MEDIADOCK ES MODU RA03	*	*	*	*	*	*	*
		LBL-BXG300-02-B	LABEL, SHELF PRODUCT	*	*	*	*	*	*	*
		LBL-BXG301-02-B	LABEL, TOWER PRODUCT	*	*	*	*	*	*	*
		LBL-BXG302-04-A	LABEL,18F ACER COOL GREY	*	*	*	*	*	*	*
		LBL-BXG304-02-A	LABEL, BOXSTORE CARRIER R000	*	*	*	*	*	*	*
		LBL-BXG305-01-A	LABEL, LS MODULE	*	*	*	*	*	*	*
		LBL-BXG305-02-A	LABEL, LS MODULE	*	*	*	*	*	*	*
		LBL-BXG305-04-A	LABEL, LS MODULE	*	*	*	*	*	*	*
		LBL-BXG305-08-A	LABEL, LS MODULE	*	*	*	*	*	*	*
		LBL-BXG306-01-A	LABEL, LS BLANK	*	*	*	*	*	*	*
		LBL-BXG306-02-A	LABEL, LS BLANK	*	*	*	*	*	*	*
		LBL-BXG307-01-A	LABEL, TOWER BLANK	*	*	*	*	*	*	*
		LBL-BXG307-02-A	LABEL, TOWER BLANK	*	*	*	*	*	*	*
		LBL-BXG307-03-A	LABEL, TOWER BLANK	*	*	*	*	*	*	*
		LBL-BXG308-02-A	LABEL, COMPLIANCE	*	*	*	*	*	*	*
		LBL-BXG308-03-A	LABEL, COMPLIANCE ACER	*	*	*	*	*	*	*
		LBL-BXG308-03-C	LABEL, COMPLIANCE ACER WEEE	*	*	*	*	*	*	*
		LBL-BXG308-05-A	LABEL, COMPLIANCE	*	*	*	*	*	*	*
		LBL-BXG308-05-C	LABEL, COMPLIANCE WEEE	*	*	*	*	*	*	*
		LBL-BXG308-07-B	LABEL, COMP, SING WEEE	*	*	*	*	*	*	*
		LBL-BXG309-02-A	LABEL, 2GB TOWER	*	*	*	*	*	*	*
		LBL-BXG310-02-A	LABEL, 2GB SHELF	*	*	*	*	*	*	*
		LBL-BXG310-08-A	LABEL, 2GB SHELF	*	*	*	*	*	*	*
		LBL-BXG311-01-A	LABEL, CURRENT LEAKAGE	*	*	*	*	*	*	*
		LBL-BXG312-01-A	LABEL, FC2000 CAB USA	*	*	*	*	*	*	*
		LBL-BXG312-02-A	LABEL, FC2000 CAB EUR	*	*	*	*	*	*	*
		LBL-CAR001-01-B	LABEL, LED MODULE	*	*	*	*	*	*	*
		LBL-CAR001-03-B	LABEL, LED MODULE	*	*	*	*	*	*	*
		LBL-CAR001-04-B	LABEL, LED MODULE	*	*	*	*	*	*	*
		LBL-CAR002-03-B	LABEL, SHELF PRODUCT	*	*	*	*	*	*	*
		LBL-CAR003-03-B	LABEL, TOWER PRODUCT	*	*	*	*	*	*	*
		LBL-DSA006	LABEL, SCSI MANAGEMENT M RA02	*	*	*	*	*	*	*
		LBL-DSKTAMP	LBL, WARRANTY VOID,*15MM	*	*	*	*	*	*	*
		LBL-EARTH-2	LABEL, EARTH LOCATION	*	*	*	*	*	*	*
		LBL-EB51-112716	160MM X 100MM WHITE LBL	*	*	*	*	*	*	*
		LBL-ESD001	LABEL,ESD WARNING RA01	*	*	*	*	*	*	*
		LBL-HIPOT	47X23MM 34X11MM SILVER	*	*	*	*	*	*	*
		LBL-OSREG-A	LABEL SHELF OPERATING	*	*	*	*	*	*	*
		LBL-PAKEIA	LABEL PACKING EIA BLANK	*	*	*	*	*	*	*
		LBL-PID003	LABEL,PROD.ID& UL RATING	*	*	*	*	*	*	*
		LBL-PID004-NAR	LABEL BLANK 52X20 HORIZ,	*	*	*	*	*	*	*
		LBL-ST4002	LABEL,STL FRONT BLANK	*	*	*	*	*	*	*
		LBL-ST4002-36F	LABEL, SHUTTLE FRONT	*	*	*	*	*	*	*
		LBL-ST4002-73F	LABEL, SHUTTLE, FRONT	*	*	*	*	*	*	*
		LED-00007-01-A	LED,TRI,YGG,RA,THRUHOLE	*	*	*	*	*	*	*
		LED-00008-01-A	LED,TRI,YYG,RA,THRUHOLE	*	*	*	*	*	*	*
		LED-00033-01-A	LED,BLUE,VERT,SMD,0603	*	*	*	*	*	*	*
		LED-00034-01-A	LED,GREEN,VERT,SMD,0603	*	*	*	*	*	*	*

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		LED-00035-01-A	LED,AMBER,VERT,SMD,0603	*	*	*	*	*	*	*
		LED-00038-01-A	LED CHIP GRN HSMG TOP 3216	*	*	*	*	*	*	*
		LED-PDS34-01-A	LED,YEL/GRN,RA,.450H,TH	*	*	*	*	*	*	*
		LED-PDS35-01-A	LED,DUAL,YG,RA,THRUHOLE	*	*	*	*	*	*	*
		M1390	DBP MALE TO DB25 MALE AD	*	*	*	*	*	*	*
		MAG-00017-01-A	INDUCTOR,PWR,0.68UH,10A	*	*	*	*	*	*	*
		MAG-00019-01-A	INDUCTOR,PWR,2.3UH,22A	*	*	*	*	*	*	*
		MAG-00020-01-A	INDUCTOR,EMI,6A,EIA1206	*	*	*	*	*	*	*
		MAG-PDS19-01-A	INDUCTOR,3.3UH,5A,SMD	*	*	*	*	*	*	*
		MAG-PDS20-01-A	INDUCTOR,2.7UH,11.5A,SMD	*	*	*	*	*	*	*
		MAG-PDS21-01-A	INDUCTOR,22UH,2A,SMD	*	*	*	*	*	*	*
		MAG-PDS22-01-A	INDCTR,1UH,10%,.38A,1210	*	*	*	*	*	*	*
		MAG-PDS23-01-A	FERRITE BD,Z1K,.1A,0603	*	*	*	*	*	*	*
		MAG-PDS24-01-A	FERRITE BD,Z70,.2A,1206	*	*	*	*	*	*	*
		MAG-PDS25-01-A	FERRITE BD,Z1K,.5A,0805	*	*	*	*	*	*	*
		MAG-PDS26-01-A	FERRITE BD,Z50,.6A,1206	*	*	*	*	*	*	*
		MAG-PDS27-01-A	FERRITE BD,Z31,.5A,1206	*	*	*	*	*	*	*
		MAN-00003-01-A	FLYER, JAPANESE SAFETY WARNING	*	*	*	*	*	*	*
		MAN-00008-UG	AVID MEDIA DOCK U320 UG	*	*	*	*	*	*	*
		MAN-00037-01-A	GUIDE, IBM SAFETY PUBLICATION	*	*	*	*	*	*	*
		MAN-00044-03-A	FLYER, AES-170X DUAL FRU UPGRD	*	*	*	*	*	*	*
		MAN-00075-01-A	FLYER, IBM WEEE COMPLY 39R5795	*	*	*	*	*	*	*
		MAN-4000-QUIK-JA	ALTEVO QUICK INSTALL GDE - JA	*	*	*	*	*	*	*
		MAN-FC2000-CD	SANBLOCS SERIES	*	*	*	*	*	*	*
		MAN-FC2000-QUIK	SANBLOCS SERIES QUICK	*	*	*	*	*	*	*
		MAN-FC2000-QUIK2	RAID QUICK INSTALL GUIDE R1.0	*	*	*	*	*	*	*
		MAN-RKIT-ACER	MANUAL, RAILKIT, INSTALL	*	*	*	*	*	*	*
		MAN-RKIT-FLEXBLOC	MANUAL, RAILKIT, INSTALL	*	*	*	*	*	*	*
		MAN-SC2100-002	USER GUIDE DOC	*	*	*	*	*	*	*
		MAN-SC2100-QUIK	QUICK INSTALL GUIDE	*	*	*	*	*	*	*
		MEC-00011-01-B	COVER, I/O CANISTER	*	*	*	*	*	*	*
		MEC-00047-01-A	SCREW FASTENER, RACK EAR	*	*	*	*	*	*	*
		MEC-00050-01-A	BEZEL, FRONT SHELF	*	*	*	*	*	*	*
		MEC-00051-01-A	BEZEL, REAR SHELF	*	*	*	*	*	*	*
		MEC-00068-01-A	BOXSTORE KEYPLATE 2 AVID	*	*	*	*	*	*	*
		MEC-00078-01-A	2U 2X PASS THRU I/O CVR	*	*	*	*	*	*	*
		MEC-00085-01-A	2U CARRIER COMPONENT CVR	*	*	*	*	*	*	*
		MEC-00116-01-A	2U RACK EAR EMI SHIELD	*	*	*	*	*	*	*
		MEC-00126-01-A	GUIDE KEY, I/O OPT SLOT	*	*	*	*	*	*	*
		MEC-00126-02-A	GUIDE KEY, 13 DRV SLOT	*	*	*	*	*	*	*
		MEC-00133-01-A	POWER CORD RETAINER	*	*	*	*	*	*	*
		MEC-00137-01-A	COVER, 1.0X PDS DRIVE	*	*	*	*	*	*	*
		MEC-00137-01-B	COVER, 1.0X PDS DRIVE	*	*	*	*	*	*	*
		MEC-00149-01-A	STDOFF, COVER SPRT(SCSI)	*	*	*	*	*	*	*
		MEC-00150-01-A	STIFFENER, MUX PCA	*	*	*	*	*	*	*
		MEC-00151-01-A	MAXIMA BATTERY BRKT	*	*	*	*	*	*	*
		MEC-00160-01-A	BRACKET, PCI MOUNTING, PRATT	*	*	*	*	*	*	*
		MEC-00197-01-A	2U 2X PRATT CONT CVR	*	*	*	*	*	*	*
		MEC-00207-01-A	AES-170X IBM HDD BLANK	*	*	*	*	*	*	*
		MEC-00217-01-A	PRATT P3 HEATSINK	*	*	*	*	*	*	*
		MEC-00218-01-A	HEATSINK, 1.25 X 1.25 X .81	*	*	*	*	*	*	*
		MEC-00219-01-A	HEATSINK, BGA	*	*	*	*	*	*	*

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		MEC-00220-01-A	HEATSINK, 1.75 X 1.75 X .157	*	*	*	*	*	*	*
		MEC-00221-01-A	HEATSINK, 1.50 X .95 X .164	*	*	*	*	*	*	*
		MEC-00222-01-A	HEATSINK, THINFIN	*	*	*	*	*	*	*
		MEC-00253-01-A	BRACKET, FORTRESS	*	*	*	*	*	*	*
		MEC-00254-01-A	COVER, FORTRESS BATTERY	*	*	*	*	*	*	*
		MEC-00256-01-A	BRACKET, BATTERY NYLON GUIDE	*	*	*	*	*	*	*
		MEC-00257-01-A	HEATSINK, CITRINE 36 x 25 mm	*	*	*	*	*	*	*
		MEC-00258-01-A	HEATSINK, SCAMP 50 x 36 mm	*	*	*	*	*	*	*
		MEC-00259-01-A	HEATSINK, POWER PC 36 x 31 mm	*	*	*	*	*	*	*
		MEC-00290-01-A	SPRING, TORSION, ORION IO, LFT	*	*	*	*	*	*	*
		MEC-00290-02-A	SPRING, TORSION, ORION IO, RT	*	*	*	*	*	*	*
		MEC-BXF303-03-A	BEZEL, SWITCH GUIDE	*	*	*	*	*	*	*
		MEC-BXG206-04-C	BOXSTOR BULKHEAD, I/O	*	*	*	*	*	*	*
		MEC-BXG207-02-G	BASE, OPTION MODULE I/O	*	*	*	*	*	*	*
		MEC-BXG303-01-A	BOXSTORE LS BLANK CARD	*	*	*	*	*	*	*
		MEC-BXG315-01-C	BOXSTOR, LS BULKHEAD	*	*	*	*	*	*	*
		MEC-BXG316-01-B	BOXSTORE LS BEZEL	*	*	*	*	*	*	*
		MEC-BXG316-06-A	BEZEL, LS	*	*	*	*	*	*	*
		MEC-BXG318-01-A	LIGHTPIPE, BOXSTORE LS	*	*	*	*	*	*	*
		MEC-BXG320-01-B	HANDLE, OPTIONS CANISTER	*	*	*	*	*	*	*
		MEC-BXG320-01-C	HANDLE, OPTIONS CANISTER	*	*	*	*	*	*	*
		MEC-BXG321-01-D	BOXSTORE COVER PLATE	*	*	*	*	*	*	*
		MEC-BXG324-01-A	COVER BOXSTOR BBU	*	*	*	*	*	*	*
		MEC-BXG326-01-B	BOXSTOR, LS BULKHEAD	*	*	*	*	*	*	*
		MEC-BXG328-01-A	REAR RAIL,BOXSTORE RACK	*	*	*	*	*	*	*
		MEC-BXG330-01-D	CAM, BOXSTORE LS BLACK	*	*	*	*	*	*	*
		MEC-BXG330-02-D	CAM, BOXSTORE LS BLUE	*	*	*	*	*	*	*
		MEC-BXG330-03-D	CAM, BOXSTORE LS WINE	*	*	*	*	*	*	*
		MEC-BXG330-04-D	CAM, LS	*	*	*	*	*	*	*
		MEC-BXG330-06-A	CAM, LS	*	*	*	*	*	*	*
		MEC-BXG331-01-A	BEZEL, BOXSTORE, SHELF -	*	*	*	*	*	*	*
		MEC-BXG331-02-A	SHELF BEZEL, PRINTED	*	*	*	*	*	*	*
		MEC-BXG332-01-B	EAR, RACK	*	*	*	*	*	*	*
		MEC-BXG334-01-A	DRIVE CARRIER BLANK	*	*	*	*	*	*	*
		MEC-BXG336-01-A	KEYPLATE, BOXSTORE	*	*	*	*	*	*	*
		MEC-BXG348-01-A	LOCK, DRIVE CARRIER	*	*	*	*	*	*	*
		MEC-BXG349-01-A	FRONT BEZEL, TOWER	*	*	*	*	*	*	*
		MEC-BXG350-01-A	FOOT, TOWER (BLACK) R 03	*	*	*	*	*	*	*
		MEC-BXG350-02-A	FOOT, TOWER (BLUE) R 03	*	*	*	*	*	*	*
		MEC-BXG350-03-A	FOOT, TOWER (WINE) R 03	*	*	*	*	*	*	*
		MEC-BXG356-01-A	FRONT RAIL,BOXSTORE RACK	*	*	*	*	*	*	*
		MEC-BXG357-01-A	REAR RAIL, BOX RACK #2	*	*	*	*	*	*	*
		MEC-BXG358-01-A	REAR RAIL, BOX RACK #1	*	*	*	*	*	*	*
		MEC-BXG359-01-A	FRONT RAIL, BOX TYPE 2	*	*	*	*	*	*	*
		MEC-BXG360-01-A	FRNT RAIL, IPEX RAIL KIT	*	*	*	*	*	*	*
		MEC-CAR301-01-C	PLATE, LED MODULE	*	*	*	*	*	*	*
		MEC-ST4007	EXTRUSION,CONT. UNIT RB01	*	*	*	*	*	*	*
		MEC-XJ500-014	SHUTTLE KEY JAGUAR	*	*	*	*	*	*	*
		MEC-XJ500-015	EMI SHIELD, JAG RC04	*	*	*	*	*	*	*
		MEC-XJ500-016	E-RING CIRCLIP JAGUAR, R000	*	*	*	*	*	*	*
		MEC-XL6009-1	LIGHT PIPE, CARRIER RA05	*	*	*	*	*	*	*
		MEC-XL6031	FOAM, CARRIER DRIVE MSTG RA03	*	*	*	*	*	*	*

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		MEM-72P16M-60	MEMORY MOD, 16MB 72 PIN R000	*	*	*	*	*	*	*
		MEM-BXF300-01-A	256 MB FFX1 DIMM UPGRADE	*	*	*	*	*	*	*
		MEM-BXF302-01-A	128MB FFX1 MEMORY 1GB	*	*	*	*	*	*	*
		MEM-VOY31-128M	128MB SDRAM VOY3100	*	*	*	*	*	*	*
		MEM-VOY31-32M	32MB S DRAM FOR VOY 3100	*	*	*	*	*	*	*
		MEM-VOY31-64M	64MB SDRAM VOY3100	*	*	*	*	*	*	*
		ML-000728	XL600 STRATUS WEIGHT	*	*	*	*	*	*	*
		OSC-00013-01-A	XTAL,26.5625MHZ,18PF,5X7	*	*	*	*	*	*	*
		OSC-00016-01-A	XTAL OSC,75MHZ,3.3V,5X7	*	*	*	*	*	*	*
		OSC-00017-01-A	XTAL,12MHZ,18PF,5X7MM,2P	*	*	*	*	*	*	*
		OSC-PDS17-01-A	XTAL,OSC,33.33MHZ,3V,5X7	*	*	*	*	*	*	*
		OSC-PDS18-01-A	XTAL,OSC,106.25MHZ,5X7	*	*	*	*	*	*	*
		OSC-PDS19-01-A	XTAL,OSC,20MHZ,3.3V,5X7	*	*	*	*	*	*	*
		PAK-00046-04-B	2U,SHELF SINGLE XIOTECH	*	*	*	*	*	*	*
		PAK-00120-01-A	BAG, ES SHIELD, 23"X9"	*	*	*	*	*	*	*
		PAK-00121-01-A	BAG, ES SHIELD, 15"X12"	*	*	*	*	*	*	*
		PAK-00122-01-A	BAG, 305X455MM, A/S, PNK	*	*	*	*	*	*	*
		PAK-00124-01-A	PAK, 12 PAK SGL DRV MSTR	*	*	*	*	*	*	*
		PAK-00125-01-A	MSTR PAK FOR 12 X 4 BLNK DC	*	*	*	*	*	*	*
		PAK-00127-01-A	AES-170X ACCESS BOX W/INSERT	*	*	*	*	*	*	*
		PAK-00128-01-A	AES-170X RAIL KIT BOX	*	*	*	*	*	*	*
		PAK-00140-01-A	ESD BAG, 6" X 13"	*	*	*	*	*	*	*
		PAK-00141-01-A	BAG, ZIPLOCK SM NON-ANTISTAT	*	*	*	*	*	*	*
		PAK-00142-01-A	BAG, ZIPLOCK MED NON-ANTISTAT	*	*	*	*	*	*	*
		PAK-00145-01-A	BAG, NON-ANTI POLY TOWER/RACK	*	*	*	*	*	*	*
		PAK-00147-01-A	BAG, 3" X 5" STATIC SHIELD	*	*	*	*	*	*	*
		PAK-00148-01-A	BAG, 6" X 13" STATIC SHIELD	*	*	*	*	*	*	*
		PAK-00149-01-A	BOX, 6.93" X 3.94" KIT	*	*	*	*	*	*	*
		PAK-00150-01-A	BOX, 6.3"X3.6"X0.98" CONV FOAM	*	*	*	*	*	*	*
		PAK-00151-01-A	BOX, 8.35" X 7.36" MSTR NOLOGO	*	*	*	*	*	*	*
		PAK-00152-01-A	BOX, IBM IO/PSU FRU KIT	*	*	*	*	*	*	*
		PAK-00153-01-A	FOAM SET, IBM IO/PSU FRU KIT	*	*	*	*	*	*	*
		PAK-00155-01-A	BAG, 22.44" X 25.20" POLY	*	*	*	*	*	*	*
		PAK-00159-01-A	FOAM, AES-170X BAT FRU TOP/BOT	*	*	*	*	*	*	*
		PAK-00161-01-A	BAG, 16" X 24" STATIC SHIELD	*	*	*	*	*	*	*
		PAK-00162-01-A	BOX, AES-170X BATTERY FRU MSTR	*	*	*	*	*	*	*
		PAK-00163-01-A	BOX, AES-170X IO/PSU FRU MSTR	*	*	*	*	*	*	*
		PAK-00165-01-A	BOX, 9 1/4"X6"X1 1/2" NO LOGO	*	*	*	*	*	*	*
		PAK-00166-01-A	FOAM, 8.25"X5.5"2X0.5" GRY PLY	*	*	*	*	*	*	*
		PAK-00167-01-A	BOX, 450 X 316 X 258 MM MSTR	*	*	*	*	*	*	*
		PAK-00168-01-A	BAG, 10" X 12" CLEAR ZIPLOCK	*	*	*	*	*	*	*
		PAK-00173-01-A	IBM TAMPER PROOF LABEL 13H6475	*	*	*	*	*	*	*
		PAK-00177-01-A	BAG, 12"x6" CLEAR NON-ANTISTAT	*	*	*	*	*	*	*
		PAK-00178-01-A	INSERT, 208x115x7mm GREY POLY	*	*	*	*	*	*	*
		PAK-00179-01-A	INSERT, AES-1701-RL EMC COVER	*	*	*	*	*	*	*
		PAK-00180-01-A	BAG, ALTEVO SHELF ANTI-STATIC	*	*	*	*	*	*	*
		PAK-00223-01-A	BOX, 20.35X6.37X12.7 MSTR	*	*	*	*	*	*	*
		PAK-00224-01-A	BOX, 24.7X10.2X12.8 MSTR	*	*	*	*	*	*	*
		PAK-00227-01-A	INSERT, 7-PK HDD U-PAD	*	*	*	*	*	*	*
		PAK-00228-01-A	INSERT, 7-PK HDD U-PAD LID	*	*	*	*	*	*	*
		PAK-00229-01-A	BOX, 14PK HDD MSTR 16.6x15x12	*	*	*	*	*	*	*
		PAK-00230-01-A	INSERT, 14-PK HDD CARTON	*	*	*	*	*	*	*

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		PAK-00238-01-A	BOX, 249 x 185 x 236 MSTR	*	*	*	*	*	*	*
		PAK-00239-01-A	FOAM, 233x175x10 TOP & BOT	*	*	*	*	*	*	*
		PAK-00240-01-A	INSERT, 5-PK DRV CARRIER BLANK	*	*	*	*	*	*	*
		PAK-00261-01-A	PKG GRP,2U FRU,SGL,UNIV noLOGO	*	*	*	*	*	*	*
		PAK-00264-01-A	FOAM, ASE-335 REAR END CAP	*	*	*	*	*	*	*
		PAK-00265-01-A	FOAM, ASE-335 FRONT END CAP	*	*	*	*	*	*	*
		PCA-00094-01-A	512 MB DIMM ON FFX2 RF	*	*	*	*	*	*	*
		PCA-00118-01-A	256MB ECC DIMM PC2700 AES-170X	*	*	*	*	*	*	*
		PCA-00119-01-A	512MB ECC DIMM PC2700 AES-170X	*	*	*	*	*	*	*
		PCA-00120-01-A	AES-170X 128MB 50-P COMP FLSH	*	*	*	*	*	*	*
		PCA-00138-01-A	512MB ECC DIMM PC2700	*	*	*	*	*	*	*
		PCA-00139-01-A	CARD, 128MB 50-P COMP FLSH	*	*	*	*	*	*	*
		PCA-00155-01-A	1GB ECC DIMM PC2700 AES-170X	*	*	*	*	*	*	*
		PCB-00063-01-A	JPTR/GANYMEDE 14DR U320	*	*	*	*	*	*	*
		PCB-00091-01-B	PCB, W/MAXIM MUX, PDS12	*	*	*	*	*	*	*
		PCB-00092-01-B	PCB, W/MAXIM MUX, PDS13	*	*	*	*	*	*	*
		PCB-00102-01-A	ACTIVE JOINER MODULE	*	*	*	*	*	*	*
		PCB-00108-01-C	PCB, PDS FS4500 RAID MODULE	*	*	*	*	*	*	*
		PCB-00109-01-B	PCB, PDS FASCIA MODULE	*	*	*	*	*	*	*
		PCB-00112-01-D	LAMBO DUAL SATA BP, 12 DR	*	*	*	*	*	*	*
		PCB-00113-01-D	PCB, DUAL SATA BP,13 DR	*	*	*	*	*	*	*
		PCB-00164-01-A	MSTR FILE, ENZO SELECT SWITCH	*	*	*	*	*	*	*
		PCB-500458-01-B	CARRERA I/O BARE ETCH r5.0	*	*	*	*	*	*	*
		PIN-GEN300-01-A	5/64 SHL PRESS PIN 1/4"	*	*	*	*	*	*	*
		PMF-00001-01-A	LIGHT PIPE	*	*	*	*	*	*	*
		PMF-00005-01-A	HENDRIX12 BP SWIMSUIT	*	*	*	*	*	*	*
		PMF-00015-01-A	2U CARRIER LIGHT PIPE	*	*	*	*	*	*	*
		PMF-00020-01-A	2U FACEPLATE, RIGHT	*	*	*	*	*	*	*
		PMF-00022-01-A	2U FACEPLATE, LEFT	*	*	*	*	*	*	*
		PMF-00027-02-B	DRIVE LOCKOUT, OEM1	*	*	*	*	*	*	*
		PMF-00028-01-B	DRIVE KEY, EUROLOGIC	*	*	*	*	*	*	*
		PMF-00046-01-A	2U CARRIER BLNK STIFNR	*	*	*	*	*	*	*
		PMF-00050-01-A	SHLD,FORMEX, 3U SCSI IBM	*	*	*	*	*	*	*
		PMF-00053-01-B	3U ENCLOSURE LIGHT PIPE	*	*	*	*	*	*	*
		PMF-00054-01-B	3U SHELF BEZEL LIGHTPIPE	*	*	*	*	*	*	*
		PMF-00055-01-A	3U SHELF BEZEL, JPTR	*	*	*	*	*	*	*
		PMF-00056-01-A	SHLD,FORMEX, 2U ALTEVO SAS	*	*	*	*	*	*	*
		PMF-00058-01-A	AES-170X POWER CORD RETAINER	*	*	*	*	*	*	*
		PMF-CAR302-01-C	LED MODULE LIGHTPIPE	*	*	*	*	*	*	*
		PWR-00002-01-A	LAMB, AC PWR SUP, NO BAT	*	*	*	*	*	*	*
		PWR-00006-01-A	LAMBORGHINI BATTERY PACK	*	*	*	*	*	*	*
		PWR-00015-01-A	POWER SUPPLY, JUPITER DELTA	*	*	*	*	*	*	*
		PWR-00016-01-A	LAMB, AC PWR SUP, DELTA	*	*	*	*	*	*	*
		R554-00	STRATUS FC USERS GUIDE	*	*	*	*	*	*	*
		RES-00001-34-A	RES:220, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-40-A	RES:390, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00001-48-A	RES:820, 5%, .125W, 1206	*	*	*	*	*	*	*
		RES-00002-26-A	RES:100, 5%, .1W, 0805	*	*	*	*	*	*	*
		RES-00006-B8-A	RES:162, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-D1-A	RES:221, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00006-E4-A	RES: 301, 1%, .063W, 0603	*	*	*	*	*	*	*
		RES-00007-69-A	RES:49.9, 1%, .063W,0402	*	*	*	*	*	*	*

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		RES-00007-BJ-A	RES:71.5K,1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-E6-A	RES:316,1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-FB-A	RES:604K,1%,1/16W,0402	*	*	*	*	*	*	*
		RES-00007-FY-A	RES:1.00M,1%,.063W,0402	*	*	*	*	*	*	*
		RES-00007-X3-A	RES:17.4K,1%,.063W,0402	*	*	*	*	*	*	*
		RES-PDS01-01-A	RES:0 OHM,1206,2A	*	*	*	*	*	*	*
		RES-PDS03-01-A	RES:0 OHM,0603,1A	*	*	*	*	*	*	*
		RES-PDS03-02-A	RES:10R,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-06-A	RES:15R,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-10-A	RES:22R,5%,.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-12-A	RES:27,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-14-A	RES:33,5%,.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-26-A	RES:100,5%,.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-28-A	RES:120,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-29-A	RES:130,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-34-A	RES:220R,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-38-A	RES:330,5%,.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-42-A	RES:470R,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-50-A	RES:1K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-54-A	RES:1K5,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-57-A	RES:2K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-60-A	RES:2.7K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-66-A	RES:4.7K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-74-A	RES:10K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-81-A	RES:20K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-98-A	RES:100K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS03-A0-A	RES:120K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS05-B4-A	RES:147,1%,0.125W,0805	*	*	*	*	*	*	*
		RES-PDS06-40-A	RES:24.9,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-52-A	RES:33R2,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-64-A	RES:44R2,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-69-A	RES:49R9,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-77-A	RES:60R4,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-83-A	RES:69R8,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-B5-A	RES:150,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-BL-A	RES:75.0K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-BN-A	RES:78.7K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-CC-A	RES:110K,5%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-E4-A	RES:301,1%,.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-FZ-A	RES:4.99R,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-G0-A	RES:442R,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-J3-A	RES:768R,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-K4-A	RES:1K,1%,.063W,0603	*	*	*	*	*	*	*
		RES-PDS06-N0-A	RES:1.87K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-N6-A	RES:2.15K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-P6-A	RES:2R74K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-Q0-A	RES:3.01K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-R9-A	RES:4.75K,1%,.063W,0603	*	*	*	*	*	*	*
		RES-PDS06-S2-A	RES:5.11K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-T8-A	RES:7.50K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-U9-A	RES:9.76K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-V0-A	RES:10K,1%,.1W,0603	*	*	*	*	*	*	*

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		RES-PDS06-V8-A	RES:12.1K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-Y6-A	RES:23.7K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS06-Z3-A	RES:28.0K,1%,0.1W,0603	*	*	*	*	*	*	*
		RES-PDS07-01-A	RES:0 OHM,0402,1A	*	*	*	*	*	*	*
		RES-PDS07-02-A	RES:10 OHM,1%,1/16W,0402	*	*	*	*	*	*	*
		RES-PDS07-BN-A	RES:78.7K,1%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS07-V0-A	RES:10K,1%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS07-Y6-A	RES:23.7K,1%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS08-10-A	RES:22R,5%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS08-14-A	RES:33R,5%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS08-23-A	RES:75R,5%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS08-54-A	RES:1.5K,5%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS08-66-A	RES:4.7K,5%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS08-98-A	RES:100K,5%,0.063W,0402	*	*	*	*	*	*	*
		RES-PDS09-FZ-A	RES:0.005 OHM,1%,2W,2512	*	*	*	*	*	*	*
		RES-PDS09-G0-A	RES:0.033 OHM,1%,1W,2512	*	*	*	*	*	*	*
		RES-PDS10-FZ-A	RES:0.025,1%,.25W,1206	*	*	*	*	*	*	*
		RES-PDS10-G0-A	RES:0.015,1%,.25W,1206	*	*	*	*	*	*	*
		RES-PDS10-G1-A	RES:20R0,1%,.25W,1206	*	*	*	*	*	*	*
		RES-PDS34-01-A	RES:0.015 OHM,1%,1W,2512	*	*	*	*	*	*	*
		SWT-00018-01-A	SWITCH,PUSHWHEEL,8 WAY	*	*	*	*	*	*	*
		SWT-00018-02-A	SWITCH,PUSHWHEEL,10 WAY	*	*	*	*	*	*	*
		SWT-00020-01-A	SWITCH,ROTARY,DIP,10 WAY,RA	*	*	*	*	*	*	*
		SWT-RSDP02	SWITCH,ROCK,DUALPOLE	*	*	*	*	*	*	*
		TAP-GEN300-01-B	TAPE, BOXSTORE BBU	*	*	*	*	*	*	*
		TER016	TERMINATOR,68W ULTRA 900	*	*	*	*	*	*	*
		TRN-00020-01-A	TRANS NTMD3P03R2 P+P-MSFET SO	*	*	*	*	*	*	*
		TRN-PDS01-01-A	N-MOSFET,30V,8.5A,PWRPAK1212-8	*	*	*	*	*	*	*
		TRN-PDS02-01-A	N-MOSFET,60V,.18A,SOT23	*	*	*	*	*	*	*
		TRN-PDS03-01-A	P-MOSFET,20V,7.3A,PWRPAK1212-8	*	*	*	*	*	*	*
		TRN-PDS04-01-A	DUAL NMOSFET,30V,6.4A,PWRPKSO8	*	*	*	*	*	*	*
		WAS-GEN300-01-A	STAR WASHER	*	*	*	*	*	*	*
		XLPSU-A2	POWER SUPPLY +CAN,220V	*	*	*	*	*	*	*
		XLPSU-AR2-A03	POWER SUPPLY XL600 RA03	*	*	*	*	*	*	*
		1936300	ADS-6200S SUB ASSY	*	*	*	*	*	*	*
		1967400	ADS-7200S SUB ASSY	*	*	*	*	*	*	*
		2016400	CD ASSY, ADS-U160 v1.0.1/USR	*	*	*	*	*	*	*
		ASA-ESM	AVID ESM MODULE R.A05	*	*	*	*	*	*	*
		ASM-00102-01-A	ASSY, ID SELECTOR	*	*	*	*	*	*	*
		PCA-00007-01-A	256 MB FFX2 DIMM	*	*	*	*	*	*	*
		PCA-00009-01-A	1GB(128MX72),3.3V,PC133,REG	*	*	*	*	*	*	*
		PCA-00017-01-A	MAXIMA PCA	*	*	*	*	*	*	*
		PCA-00018-01-A	IMPREZA PCA	*	*	*	*	*	*	*
		PCA-00018-02-A	IMPREZA PCA REWORKED DDN	*	*	*	*	*	*	*
		PCA-00023-02-E	GENERIC LAMBO ES MODULE	*	*	*	*	*	*	*
		PCA-00023-03-A	U320 LAMBO ES MODULE	*	*	*	*	*	*	*
		PCA-00030-02-A	SGL SATA BP, EL VARIANT r01	*	*	*	*	*	*	*
		PCA-00041-01-A	128 MB FFX2 DIMM	*	*	*	*	*	*	*
		PCA-00046-02-A	ALTEVO FC BACKPLANE	*	*	*	*	*	*	*
		PCA-00092-01-D	PCBA, W/MAXIM MUX, PDS13 w/ICT	*	*	*	*	*	*	*
		PCA-00102-02-A	U320 ACTIVE JOINER	*	*	*	*	*	*	*
		PCA-00112-02-A	DUAL SATA BP, EL VARIANT r01	*	*	*	*	*	*	*

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		PCA-00113-02-B	DUAL SATA BP, 13 DRIVE	*	*	*	*	*	*	*
		PCA-00123-01-C	PCA, THEBE-SR	*	*	*	*	*	*	*
		PCA-00124-01-D	PCA, METIS	*	*	*	*	*	*	*
		PCA-00164-01-A	ENZO SELECTOR SWITCH CARD	*	*	*	*	*	*	*
		PCA-10005-01-A	512MB SDRAM,ECC,PC133	*	*	*	*	*	*	*
		PCA-500430	PCB ASSY, LVD BACKPLANE	*	*	*	*	*	*	*
		PCA-500457-02-B	CARRERA BACKPLANE r6.0	*	*	*	*	*	*	*
		PCA-500458-02-B	CERA,CESM, I/O CARD	*	*	*	*	*	*	*
		PCA-500460-02-A	CERA,TESM, JOINER CARD	*	*	*	*	*	*	*
		PCA-500461-02-D	CERA,CCESM, RPETR CARD	*	*	*	*	*	*	*
		PCA-500463-02-A	CERA,DMB TERM BOARD R2.1	*	*	*	*	*	*	*
		PCA-500464-02-A	CERA, DMB JOINER BOARD r2.1	*	*	*	*	*	*	*
		PCA-500467-01-A	CARRERA MUTE MODULE r1.1	*	*	*	*	*	*	*
		PCA-500511	XL600 SHELF BACK PLANE R 12	*	*	*	*	*	*	*
		PCA-500551-01-A	SANBLOC ID SWITCH ASSM r1.5	*	*	*	*	*	*	*
		PCA-500558-C	DA-MODULE BOXSTORE R02.	*	*	*	*	*	*	*
		PCA-500559-D	HA MODULE R23.	*	*	*	*	*	*	*
		PCA-50466-01-B	USTS, DUAL U BUS BCKPLNE r3.0	*	*	*	*	*	*	*
		PCA-50474-02-A	ALTEVO U320 MID-PLANE	*	*	*	*	*	*	*
		PCA-50475-02-A	ALTEVO SCSI I/O MODULE	*	*	*	*	*	*	*
		PCA-50475-02-B	ALTEVO SCSI I/O MODULE	*	*	*	*	*	*	*
		PCA-50477-02-B	ALTEVO U320 JOINER CARD	*	*	*	*	*	*	*
		PCA-BXF200-01-D	BACKPLANE MOON BOXSTORE	*	*	*	*	*	*	*
		PCA-BXF200-02-D	BOXSTORE BACKPLANE	*	*	*	*	*	*	*
		PCA-BXF200-02-G	ELOGIC BOXSTER BACKPLANE	*	*	*	*	*	*	*
		PCA-BXF200-03-G	XIOTECH BXSTER BACKPLANE	*	*	*	*	*	*	*
		PCA-BXF200-04-G	FSC BOXSTORE BACKPLANE	*	*	*	*	*	*	*
		PCA-BXF201-01-G	1GB LS MODULE, MOON	*	*	*	*	*	*	*
		PCA-BXF201-02-F	1 GB LS MODULE, SANBLOC	*	*	*	*	*	*	*
		PCA-BXF201-04-A	1 GB LS MODULE, SANBLOC	*	*	*	*	*	*	*
		PCA-BXF202-01-D	1GB IO MODULE, MOON	*	*	*	*	*	*	*
		PCA-BXF202-02-D	1 GB IO MODULE, CU, EL	*	*	*	*	*	*	*
		PCA-BXF203-02-D	BOXSTORE I/O OPTICAL	*	*	*	*	*	*	*
		PCA-BXF205-01-C	2GB IO OPT/CU-EL	*	*	*	*	*	*	*
		PCA-BXF206-02-D	2GBLS, EL	*	*	*	*	*	*	*
		PCA-BXF207-01-C	2GB IO OPT/OPT-EL	*	*	*	*	*	*	*
	WIPS	17278	IC, XC2028 QFN48	*	*	*	*	*	*	*
		2008900	ASSY, ADS-6200S CONTROLLER	*	*	*	*	*	*	*
		2009000	ASSY, ADS-7200S CONTROLLER	*	*	*	*	*	*	*
		ASA-ENCL-KIT	MSTG ENCLOSURE ACCESSORY	*	*	*	*	*	*	*
		ASM-00039-02-A	1GB I/O COPPER, CR EL	*	*	*	*	*	*	*
		ASM-00042-02-B	FFX2 CONTROLLER, EL	*	*	*	*	*	*	*
		ASM-00043-02-A	2GB CU/CU IO MODULE, EL	*	*	*	*	*	*	*
		ASM-00050-01-A	I/O ASM BLANK	*	*	*	*	*	*	*
		ASM-00054-02-A	ASSY, ACER CCESM	*	*	*	*	*	*	*
		ASM-00055-02-A	ASSY, ACER CESM	*	*	*	*	*	*	*
		ASM-00058-01-A	ASSY, NON-BRNDDED DMB JNR	*	*	*	*	*	*	*
		ASM-00059-01-A	ASSEMBLY, DRIVE CARRIER	*	*	*	*	*	*	*
		ASM-00060-01-A	ASSEMBLY, LEFT RACK EAR	*	*	*	*	*	*	*
		ASM-00061-01-A	ASSEMBLY, RIGHT RACK EAR	*	*	*	*	*	*	*
		ASM-00062-01-A	ASSY, DRV CARRIER BLANK	*	*	*	*	*	*	*
		ASM-00078-01-A	ACM & BBU ASSEMBLY R 01	*	*	*	*	*	*	*

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		ASM-00087-01-B	2U EMPTY CAR/SHLD BLCK	*	*	*	*	*	*	*
		ASM-00087-02-B	2U EMPTY CAR/SHLD GRAY	*	*	*	*	*	*	*
		ASM-00087-03-B	2U EMPTY CAR/SHLD BLUE	*	*	*	*	*	*	*
		ASM-00087-04-B	2U EMPTY CAR/SHLD WINE	*	*	*	*	*	*	*
		ASM-00087-05-B	2U EMPTY CAR/SHLD AVID	*	*	*	*	*	*	*
		ASM-00089-04-A	SCSI IO BSE/HNDL ASSY	*	*	*	*	*	*	*
		ASM-00089-05-A	SCSI JOIN BSE/HNDL ASSY	*	*	*	*	*	*	*
		ASM-00089-06-A	FC IO BSE/HNDL ASSY	*	*	*	*	*	*	*
		ASM-00089-07-B	CIPRICO BASE/HNDLE ASSY	*	*	*	*	*	*	*
		ASM-00089-09-A	MAXIMA BASE/HNDLE ASSY	*	*	*	*	*	*	*
		ASM-00089-10-A	IMPREZA BASE/HNDLE ASSY	*	*	*	*	*	*	*
		ASM-00089-12-A	PRATT BASE/HNDLE ASSY	*	*	*	*	*	*	*
		ASM-00107-01-A	2U CAR BZL ASSY, CIPRICO	*	*	*	*	*	*	*
		ASM-00108-01-A	TOP CHASSIS ASSY, 2 BAY	*	*	*	*	*	*	*
		ASM-00108-02-C	TOP CHASSIS ASSY, DS13	*	*	*	*	*	*	*
		ASM-00108-05-A	TOP CHASIS ASSY PDS 2BAY	*	*	*	*	*	*	*
		ASM-00108-05-B	TOP CHASIS ASSY PDS 2BAY	*	*	*	*	*	*	*
		ASM-00114-01-A	ASSY, 2U TOWER	*	*	*	*	*	*	*
		ASM-00135-01-A	FFX2 ASSY WITH ETHERNET	*	*	*	*	*	*	*
		ASM-00135-01-B	FFX2 W/ RF ETHERNET CR	*	*	*	*	*	*	*
		ASM-00137-01-A	PDS DRIVE HNDL/BASE ASSY	*	*	*	*	*	*	*
		ASM-00145-02-A	2U 2X IO BLANK ASSY, TOOLLESS	*	*	*	*	*	*	*
		ASM-00164-01-A	MUX BOARD ASSY	*	*	*	*	*	*	*
		ASM-00164-02-A	MUX BOARD ASSY	*	*	*	*	*	*	*
		ASM-00168-02-B	GRY 250GB 7200 DSATA W/M	*	*	*	*	*	*	*
		ASM-00182-01-A	MAXIMA CONTROLLER ASSY	*	*	*	*	*	*	*
		ASM-00185-01-A	IMPREZA MODULE ASSY	*	*	*	*	*	*	*
		ASM-00185-01-B	IMPREZA MODULE ASSY	*	*	*	*	*	*	*
		ASM-00187-01-A	1.5 RAID CNISTR PDS ASSY	*	*	*	*	*	*	*
		ASM-00197-01-A	XCVR,OPT,SFP,FC,LC,1-2GB	*	*	*	*	*	*	*
		ASM-00198-01-A	ASSY, 2U FC LIO	*	*	*	*	*	*	*
		ASM-00232-01-A	2U EMPT CAR/SHLD CIPRICO	*	*	*	*	*	*	*
		ASM-00233-01-A	2U DRV CAR BLNK, CIPRICO	*	*	*	*	*	*	*
		ASM-00236-01-A	HNDL/BASE ASSY PDS LIO	*	*	*	*	*	*	*
		ASM-00237-01-A	HNDL/BASE ASSY PDS FC	*	*	*	*	*	*	*
		ASM-00240-01-A	PDS 12 DRIVE FIBRE SHELF	*	*	*	*	*	*	*
		ASM-00242-01-A	JPTR, FRNT CHASSIS ASSY	*	*	*	*	*	*	*
		ASM-00243-01-A	JPTR, CHASSIS ASSY	*	*	*	*	*	*	*
		ASM-00249-01-A	7DRIVE INNER BEZEL ASSY	*	*	*	*	*	*	*
		ASM-00252-01-A	JPTR, IO BATTERY ASSY	*	*	*	*	*	*	*
		ASM-00252-02-A	AES-170X BATTERY ASSEMBLY	*	*	*	*	*	*	*
		ASM-00263-01-A	JPTR IO BASE ASSY, FC	*	*	*	*	*	*	*
		ASM-00263-02-A	JPTR IO BASE ASSY, ISCSI	*	*	*	*	*	*	*
		ASM-00263-03-A	JPTR IO BASE ASSY, RL	*	*	*	*	*	*	*
		ASM-00263-04-A	JPTR IO BASE ASSY, BLANK	*	*	*	*	*	*	*
		ASM-00265-01-A	JPTR POWER SUPPLY BLANK ASSY	*	*	*	*	*	*	*
		ASM-00281-01-A	AES-170X RAIL KIT	*	*	*	*	*	*	*
		ASM-00286-02-A	AES-170X DUAL ACCES KT SUBASSY	*	*	*	*	*	*	*
		ASM-00292-01-A	XCVR,OPT,SFP,FC,LC,1-2GB	*	*	*	*	*	*	*
		ASM-00347-01-A	2U ENZO SS CANISTER ASSY	*	*	*	*	*	*	*
		ASM-00380-02-A	SANbloc 50-SR SINGLE JBOD SHLF	*	*	*	*	*	*	*
		ASM-PDS02-01-A	PDS PROG FPGA 3135-01006-01	*	*	*	*	*	*	*

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		ASM-PDS02-02-A	PDS PROG FPGA 3135-01006-01ALT	*	*	*	*	*	*	*
		ASM-PDS03-01-A	PDS PROG FLASH 3135-01007-01	*	*	*	*	*	*	*
		ASM-PDS04-01-A	PDS PROG AVR 3135-01010-00	*	*	*	*	*	*	*
		ASM-PDS05-01-A	PDS PROG ATTINY 3135-01009-00	*	*	*	*	*	*	*
		BAG-ZIPLOCK	BAG ZIPLOCK 340 X 230MM	*	*	*	*	*	*	*
		CBL-00013-01-A	EMEA POWER CORD SET - UK+EURO	*	*	*	*	*	*	*
		CDA-00001-05-A	CD ASSY, AES-170X APPS 7.24 SW	*	*	*	*	*	*	*
		CDA-00002-08-A	CD ASSY, AES-170X SUP 6.04 FW	*	*	*	*	*	*	*
		CDA-00014-01-A	SPHERAS STRG DIRECTOR v2.1.41	*	*	*	*	*	*	*
		CDA-00198-01-A	PATHPILOT BURNT & PRINTED CD	*	*	*	*	*	*	*
		CD-ESRA-JA	EXT. STORAGE DOCS/SW CD- JAPAN	*	*	*	*	*	*	*
		DSA-BLM2	3651R BLOWER MODULE RA04	*	*	*	*	*	*	*
		DSA-PBLANK	0165E POWER SUPPLY BLANK RA03	*	*	*	*	*	*	*
		EMA-BXF100-05-A	ASSEMBLY, XIOTECH SHELF	*	*	*	*	*	*	*
		EMA-BXF101-02-A	ID SELECTOR ASSY	*	*	*	*	*	*	*
		EMA-BXF104-02-A	ASSEMBLY EUROLOGIC 1GB	*	*	*	*	*	*	*
		EMA-BXF106-02-C	ASSEMBLY I/O RAID, FFX	*	*	*	*	*	*	*
		EMA-BXF107-01-A	BBU ASSEMBLY, BOXSTORE	*	*	*	*	*	*	*
		EMA-BXF108-02-A	ASSEMBLY EUROLOGIC 1GB	*	*	*	*	*	*	*
		EMA-BXF110-02-D	2GB LS ASSY, (BLUE)-EL	*	*	*	*	*	*	*
		EMA-BXF110-07-B	ASSY, 2GB LS, XIOTECH	*	*	*	*	*	*	*
		EMA-BXF110-08-B	ASSY, 2GB LS	*	*	*	*	*	*	*
		EMA-BXF111-02-A	ASSEMBLY, BOXSTORE 1GB	*	*	*	*	*	*	*
		EMA-BXF113-01-D	FFX1 RAID CONTROLLER	*	*	*	*	*	*	*
		EMA-BXF113-01-F	FFX1 RAID CONTROLLER	*	*	*	*	*	*	*
		EMA-BXG101-01-B	BOXSTORE ACM ASSY	*	*	*	*	*	*	*
		EMA-BXG101-01-D	BOXSTORE ACM ASSEMBLY	*	*	*	*	*	*	*
		EMA-CAR107-01-B	NON-BRANDED, LED ASSY	*	*	*	*	*	*	*
		EMA-XF500-207	FAN MODULE FIBRE ASSY RD01	*	*	*	*	*	*	*
		EMA-XJ500-217-A	HOST SCSI I/O CANISTER	*	*	*	*	*	*	*
		EMA-XL6002-3	FRONT SHELF ASSEMBLY RE06	*	*	*	*	*	*	*
		EMA-XL6005-1	MUSTANG 1.0" HIGH DCAR	*	*	*	*	*	*	*
		EMA-XL6007	CARRIER BLANK ASSEMBLY RBO5	*	*	*	*	*	*	*
		ESA-ESM	ES MODULE ASSEMBLY RA05	*	*	*	*	*	*	*
		GAM-FC2500-S	GAM SOFTWARE, STRATUS	*	*	*	*	*	*	*
		GAM-FC2502	GAM SOFTWARE FOR FFX2	*	*	*	*	*	*	*
		GEN-00174-01-A	IBM DAYTONA DRV KIT AVID	*	*	*	*	*	*	*
		GEN-00198-01-A	BURNT & PRINTED CD	*	*	*	*	*	*	*
		KIT-SRM001	KIT,SHELF RACKMOUNTING	*	*	*	*	*	*	*
		KIT-SRM004	KIT RACK RAIL	*	*	*	*	*	*	*
		MAN-00007-UG	SPHERAS RAIDWATCH UG	*	*	*	*	*	*	*
		MAN-4000-QUIK	ALTEVO QUICK INSTALL GDE	*	*	*	*	*	*	*
		MAN-AJM-SC2000	U320 AJM INSTRUC GUIDE	*	*	*	*	*	*	*
		MAN-FC2002-CD-C	USER GUIDE	*	*	*	*	*	*	*
		MAN-SC2100-CD	USER GUIDE	*	*	*	*	*	*	*
		MAN-SC2100-CD-A	USER GUIDE	*	*	*	*	*	*	*
		MEC-00009-01-C	BOX OPTION CAN, BLANK	*	*	*	*	*	*	*
		MEC-00009-02-B	BOX OPTION CAN, CU/CU	*	*	*	*	*	*	*
		MEC-00009-02-C	BOX OPTION CAN, CU/CU	*	*	*	*	*	*	*
		MEC-00009-03-C	BOX OPTION CAN,1GB CU/OP	*	*	*	*	*	*	*
		MEC-00009-04-C	BOX OPTION CAN,2GB CU/OP	*	*	*	*	*	*	*
		MEC-00009-05-B	BOX OPTION CAN,2GB OP/OP	*	*	*	*	*	*	*

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		MEC-00009-05-C	BOX OPTION CAN,2GB OP/OP	*	*	*	*	*	*	*
		MEC-00009-07-C	FFX2 CAN/BHD, ETHERNET	*	*	*	*	*	*	*
		MEC-00009-09-B	BOX OPTION CAN, CESM	*	*	*	*	*	*	*
		MEC-00009-09-C	BOX OPTION CAN, CESM	*	*	*	*	*	*	*
		MEC-00009-10-B	BOX OPTION CAN, TESM	*	*	*	*	*	*	*
		MEC-00009-10-C	BOX OPTION CAN, TESM	*	*	*	*	*	*	*
		MEC-00009-11-B	BOX OPTION CAN, DUMMY	*	*	*	*	*	*	*
		MEC-00009-11-C	BOX OPTION CAN, DUMMY	*	*	*	*	*	*	*
		MEC-00009-15-C	FFX2 CAN/BHD, NON-E	*	*	*	*	*	*	*
		MEC-00067-01-A	AVID/BX CARRIER ASSY	*	*	*	*	*	*	*
		MEC-BXF102-01-A	BOXSTORE BLACK CARRIER,	*	*	*	*	*	*	*
		MEC-BXF102-02-A	BOXSTORE BLUE CARRIER,	*	*	*	*	*	*	*
		MEC-BXF102-03-A	BOXSTORE WINE CARRIER,	*	*	*	*	*	*	*
		MEC-BXF103-01-A	BOXSTOR LS ASSEMBLY R 02	*	*	*	*	*	*	*
		MEC-BXF103-02-A	ASSEMBLY, BOXSTORE BLANK R.02	*	*	*	*	*	*	*
		MEC-BXF103-03-A	LS BLANK ASSY	*	*	*	*	*	*	*
		MEC-BXF103-04-A	LS BLANK ASSY	*	*	*	*	*	*	*
		MEC-BXG103-04-B	ASSEMBLY, LS BEZEL	*	*	*	*	*	*	*
		MEC-BXG104-01-A	ASSEMBLY, BOXSTORE RACK	*	*	*	*	*	*	*
		MEC-BXG109-01-A	ASSEMBLY, TOWER (BLACK)	*	*	*	*	*	*	*
		MEC-BXG109-02-A	ASSEMBLY, TOWER (BLUE)	*	*	*	*	*	*	*
		MEC-BXG109-03-A	ASSEMBLY, TOWER (WINE)	*	*	*	*	*	*	*
		MEC-BXG111-01-A	ASM,BOX LS BEZEL BLACK	*	*	*	*	*	*	*
		MEC-BXG111-04-A	ASSY, LS BEZEL/BACKET	*	*	*	*	*	*	*
		MEC-BXG111-06-A	ASSY, LS BEZEL	*	*	*	*	*	*	*
		MEC-BXG113-01-A	ASIAN, RACK MOUNT KIT	*	*	*	*	*	*	*
		MEC-BXG200-01-B	ASSY, SHELF HALF	*	*	*	*	*	*	*
		MEC-BXG201-01-C	ASSY, PLENUM	*	*	*	*	*	*	*
		MEC-BXG203-01-B	ASSY, COVER PANEL	*	*	*	*	*	*	*
		MEC-BXG204-01-B	CAM, BOXSTORE CARRIER, BLK	*	*	*	*	*	*	*
		MEC-BXG204-02-B	CAM, BOXSTORE CARRIER, BLUE	*	*	*	*	*	*	*
		MEC-BXG204-03-B	CAM, BOXSTORE CARRIER, WINE	*	*	*	*	*	*	*
		MEC-BXG204-04-B	CAM, BOXSTORE CARRIER, GRAY	*	*	*	*	*	*	*
		MEC-BXG206-14-A	FFX2 NON-ETHERNET BLKHD	*	*	*	*	*	*	*
		MEC-BXG211-03-A	FFX2 NON-PEM ASSY	*	*	*	*	*	*	*
		MEC-XL6010	CAM, LOCK RC02	*	*	*	*	*	*	*
		PAK-00001-01-A	FRU PACKAGING	*	*	*	*	*	*	*
		PAK-00003-01-A	200 X 300 RESEALABLE BAG	*	*	*	*	*	*	*
		PAK-00004-01-A	BAG, 6" * 9" ZIP LOCK	*	*	*	*	*	*	*
		PAK-00009-01-A	CD ROM ENVELOPE	*	*	*	*	*	*	*
		PAK-00012-01-A	SANBLOC RACK KIT CARTON	*	*	*	*	*	*	*
		PAK-00017-01-A	235 X 180 MM STATIC BAG	*	*	*	*	*	*	*
		PAK-00019-01-A	BAG, ES SHIELD, 180X325	*	*	*	*	*	*	*
		PAK-00024-01-A	PACK, 2GB DRIVE SNG AVID	*	*	*	*	*	*	*
		PAK-00025-01-A	PACK, 2GB DRIVE X4 AVID	*	*	*	*	*	*	*
		PAK-00028-01-A	PACK, 2GB DRV 16X4 AVID	*	*	*	*	*	*	*
		PAK-00029-01-A	PACK, BOXT AVID SHELF X6	*	*	*	*	*	*	*
		PAK-00032-01-A	30 X DRIVE PACK	*	*	*	*	*	*	*
		PAK-00044-01-A	CARRIER PACKAGING 45	*	*	*	*	*	*	*
		PAK-00046-01-B	2U,SHELF SINGLE ADAPTEC	*	*	*	*	*	*	*
		PAK-00056-01-A	PACK,,RAIL-KIT,ASIAN	*	*	*	*	*	*	*
		PAK-00078-01-A	2U, PAK52, CARTON	*	*	*	*	*	*	*

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		PAK-00081-01-A	2U, PAK49B,12PK,CARTON	*	*	*	*	*	*	*
		PAK-00090-01-A	SHELF, D/W LID & BASE	*	*	*	*	*	*	*
		PAK-00091-01-A	SHELF, D/W SLEEVE	*	*	*	*	*	*	*
		PAK-00110-01-A	2U, OUTER PAK, GENERIC	*	*	*	*	*	*	*
		PAK-00110-02-A	2U, OUTER PAK, AVID	*	*	*	*	*	*	*
		PAK-00111-01-A	2U, BOX, ACCESSORY	*	*	*	*	*	*	*
		PAK-ASA003-B	CARTON,DRIVE,INDIV AVID	*	*	*	*	*	*	*
		PAK-ASA005	BOX D-CONTAINER, AVID R000	*	*	*	*	*	*	*
		PAK-BAG003	BAG A/S POLY PINK 'TWR'	*	*	*	*	*	*	*
		PAK-BAG006	BAG POLY PINK TOWER/RACK	*	*	*	*	*	*	*
		PAK-BAG007	BAG SELF SEAL CLEAR ZIPL	*	*	*	*	*	*	*
		PAK-BXG105-01-A	BAG S/S 380MM X 175MM	*	*	*	*	*	*	*
		PAK-BXG108-02-A	PACK, ACER FLEXIBLOC SHELF	*	*	*	*	*	*	*
		PAK-BXG108-04-A	PACK, BOXSTORE SHELF - GENERIC	*	*	*	*	*	*	*
		PAK-BXG108-05-A	PACK, AVID FLEXIBLOC SHELF	*	*	*	*	*	*	*
		PAK-BXG108-06-A	PAK FLEXIBLOC SHELF NO-LOGO	*	*	*	*	*	*	*
		PAK-BXG109-02-A	PACK, DRIVE X14 BOX UNBR	*	*	*	*	*	*	*
		PAK-BXG110-01-A	BAG, 10" X 13" X 50 MICR	*	*	*	*	*	*	*
		PAK-BXG112-01-A	BOXSTORE TOWER PACK	*	*	*	*	*	*	*
		PAK-DSA003	BOX, ESM/IO 9 SLOTS	*	*	*	*	*	*	*
		PAK-XL5017	XL500 10-PACK DRIVES PE	*	*	*	*	*	*	*
		PATH-FC2500-A	SPHERAS SOFTWARE	*	*	*	*	*	*	*
		PCA-00017-01-B	MAXIMA PCA	*	*	*	*	*	*	*
		PCA-00018-01-B	IMPREZA PCA	*	*	*	*	*	*	*
		PCA-00020-01-A	CONVERTER,DC/DC,1.8V,10A,VIN=5	*	*	*	*	*	*	*
		PCA-00047-02-A	LAMBO FC LIO - GENERIC	*	*	*	*	*	*	*
		PCA-00050-01-A	MARVELL SATA MUX BOARD	*	*	*	*	*	*	*
		PCA-00063-02-A	GANYMEDE U320 MIDPLANE	*	*	*	*	*	*	*
		PCA-00091-01-B	PCBA, W/MAXIM MUX, PDS12	*	*	*	*	*	*	*
		PCA-00092-01-B	PCBA, W/MAXIM MUX, PDS13	*	*	*	*	*	*	*
		PCA-00108-01-C	PDS FS4500 RAID MODULE W/ICT	*	*	*	*	*	*	*
		PCA-00109-01-B	PDS FASCIA MODULE	*	*	*	*	*	*	*
		PCA-00113-02-C	DUAL SATA BP, 13 DRIVE	*	*	*	*	*	*	*
		PCA-00144-01-A	MODULE, MEMORY 256KB NVSRAM	*	*	*	*	*	*	*
		PCA-00163-01-B	AURORA MULE BOARD	*	*	*	*	*	*	*
		PCA-500460-03-A	ACER,TESM, JOINER CARD R1.5.	*	*	*	*	*	*	*
		PCA-500510	ES MODULE R 06	*	*	*	*	*	*	*
		PWR-00010-01-A	BAT,LI-ION,3.6V@5.4AHR	*	*	*	*	*	*	*
		PWR-00012-01-A	POWER SUPPLY, JUPITER	*	*	*	*	*	*	*
		XL501-C-SH	MAIN ASSEMBLY XL500 RA01	*	*	*	*	*	*	*
		XL6-ESM-BA	SCSI REPEATER MODULE RA02	*	*	*	*	*	*	*
		XLACM-AA	ELEC-MEC.ASSY,FAN BLOWER	*	*	*	*	*	*	*
		XLCAR-AC-2K	CARRIER, DRIVE GENERIC	*	*	*	*	*	*	*
		XLCAR-FC-2K1	CARRIER FC DRIVE EMPTY	*	*	*	*	*	*	*
		XLCAR-NF2-72-GEN	CARRIER 72GB LOW PROFILE	*	*	*	*	*	*	*
		XLFBLANK-A	9065E FANBLANK REF RA00	*	*	*	*	*	*	*
		XLPSU-NR3-C	POWER SUPPLY NETAPPS RC03	*	*	*	*	*	*	*
		XLRDC-CF	CHAPARRAL GOLDENGATE RE00	*	*	*	*	*	*	*
		XLRDC-CS	CHAPARRAL SKYWAY RAID RE00	*	*	*	*	*	*	*
480	RAWB	1495645-00	BRACKET, AVC-2010	*	*	*	*	*	*	*
		1496012-00	BRACKET, AVC-2410	*	*	*	*	*	*	*
		1496213-00	SCD, AVC-2310/2410 REMOTE CNTL	*	*	*	*	*	*	*

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		1497107-00	BRACKET, AVC-2410 W/O IR	*	*	*	*	*	*	*
		1497558-00	SCD, AVC-3610 BEANBAG MCU TQFP	*	*	*	*	*	*	*
		1497559-00	SCD, CBL S-VIDEO 6 FT	*	*	*	*	*	*	*
		1497561-00	SCD, CBL FM F-MALE 10 FT	*	*	*	*	*	*	*
		1497562-00	SCD, CBL TV F-MALE 6 FT	*	*	*	*	*	*	*
		1497563-00	SCD, CBL TV F-MALE 1 FT	*	*	*	*	*	*	*
		1497564-00	SCD, SPLITTER TV NTSC F-CONN	*	*	*	*	*	*	*
		1497632-00	BOX,9.25" X 6" X 1.5" W/O LOGO	*	*	*	*	*	*	*
		1497639-00	HOUSING, AVC-3610 TOP	*	*	*	*	*	*	*
		1497644-00	SIDE TRIM, AVC-3610	*	*	*	*	*	*	*
		1497648-00	SCD, CBL INT ANT F-TYPE	*	*	*	*	*	*	*
		1497652-00	ASSY, STAND/FOOT AVC-3610	*	*	*	*	*	*	*
		1497661-00	SHIELD, AVC-3610	*	*	*	*	*	*	*
		1497662-00	LBL BLANK, AVC-3610 PRDT LBL	*	*	*	*	*	*	*
		1497715-00	INSERT, 17.7" x 14.6" AVC3610	*	*	*	*	*	*	*
		2006807-00	PCB, AVC-2210/2310	*	*	*	*	*	*	*
		2006907-00	CB, AVC-2010	*	*	*	*	*	*	*
		2042407-00	PCB, AVC-2410	*	*	*	*	*	*	*
		2064600EU	CD ASSY, AVC-1100/EU v1.3/GD	*	*	*	*	*	*	*
		2064700EU	CD ASSY, AVC-2010/EU v1.2 GD	*	*	*	*	*	*	*
		2064700JA	CD ASSY, AVC-2010/JA v1.2 GD	*	*	*	*	*	*	*
		2064900EU	CD ASSY, AVC2210/EU DVDv1.2 GD	*	*	*	*	*	*	*
		2064900JA	CD ASSY, AVC2210/JA DVDv1.2 GD	*	*	*	*	*	*	*
		2065000EU	CD ASSY, AVC-2310/EU TVv1.2 GD	*	*	*	*	*	*	*
		2065000JA	CD ASSY, AVC-2310/JA TVv1.2 GD	*	*	*	*	*	*	*
		2068200EU	CD ASSY, AVC-2410/EU v1.2 GD	*	*	*	*	*	*	*
		2068200JA	CD ASSY, AVC-2410/JA v1.2 GD	*	*	*	*	*	*	*
		2111800	CD ASSY, AVC-1200 USB v1.0/GD	*	*	*	*	*	*	*
		2118400	CD ASSY, AVC-2310 TV v1.3 GD	*	*	*	*	*	*	*
		2118600	CD ASSY, AVC-2410 v1.3 GD	*	*	*	*	*	*	*
		2128207-00	PCB, AVC-3610	*	*	*	*	*	*	*
		513176-00	SLV, AVC-1100 VIDEO CD USB KIT	*	*	*	*	*	*	*
		513544-03	GUIDE, AVC-2210 QUICK START	*	*	*	*	*	*	*
		513544-03EU	GUIDE, AVC-2210/EU QUICK START	*	*	*	*	*	*	*
		513544-03JA	GUIDE, AVC-2210/JA QUICK START	*	*	*	*	*	*	*
		513547-03	GUIDE, AVC-2310 QUICK START	*	*	*	*	*	*	*
		513547-03EU	GUIDE, AVC-2310/EU QUICK START	*	*	*	*	*	*	*
		513547-03JA	GUIDE, AVC-2310/JA QUICK START	*	*	*	*	*	*	*
		513547-03NK	GUIDE, AVC-2310/NK QUICK START	*	*	*	*	*	*	*
		513604-00	SLV, AVC-2210 VIDEO DVD USB	*	*	*	*	*	*	*
		513604-00ENFR	SLV, AVC-2210/ENFR	*	*	*	*	*	*	*
		513604-00GE	SLV, AVC-2210/GE	*	*	*	*	*	*	*
		513604-00ITSP	SLV, AVC-2210/ITSP	*	*	*	*	*	*	*
		513604-00JA	SLV, AVC-2210/JA KIT	*	*	*	*	*	*	*
		513605-00	SLV, AVC-2310 VIDEO TV USB	*	*	*	*	*	*	*
		513605-00ENFR	SLV, AVC-2310/ENFR	*	*	*	*	*	*	*
		513605-00GE	SLV, AVC-2310/GE	*	*	*	*	*	*	*
		513605-00ITSP	SLV, AVC-2310/ITSP	*	*	*	*	*	*	*
		513605-00JA	SLV, AVC-2310/JA KIT	*	*	*	*	*	*	*
		513605-00UK	SLV, AVC-2310/UK	*	*	*	*	*	*	*
		513613-03	GUIDE, AVC-2010 QUICK START	*	*	*	*	*	*	*
		513613-03EU	GUIDE, AVC-2010/EU QUICK START	*	*	*	*	*	*	*

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		513613-03JA	GUIDE, AVC-2010/JA QUICK START	*	*	*	*	*	*	*
		513615-03	GUIDE, AVC-2410 QUICK START	*	*	*	*	*	*	*
		513615-03EU	GUIDE, AVC-2410/EU QUICK START	*	*	*	*	*	*	*
		513615-03JA	GUIDE, AVC-2410/JA QUICK START	*	*	*	*	*	*	*
		513615-03NK	GUIDE, AVC-2410/NK QUICK START	*	*	*	*	*	*	*
		513625-00	SLV, AVC-2410 VIDEO TV PCI	*	*	*	*	*	*	*
		513625-00ENFR	SLV, AVC-2410/ENFR KIT	*	*	*	*	*	*	*
		513625-00GE	SLV, AVC-2410/GE KIT	*	*	*	*	*	*	*
		513625-00ITSP	SLV, AVC-2410/ITSP KIT	*	*	*	*	*	*	*
		513625-00JA	SLV, AVC-2410/JA KIT	*	*	*	*	*	*	*
		513625-00UK	SLV, AVC-2410/UK KIT	*	*	*	*	*	*	*
		513630-00	SLV, AVC-2010 KIT	*	*	*	*	*	*	*
		513630-00ENFR	SLV, AVC-2010/ENFR KIT	*	*	*	*	*	*	*
		513630-00GE	SLV, AVC-2010/GE KIT	*	*	*	*	*	*	*
		513630-00ITSP	SLV, AVC-2010/ITSP KIT	*	*	*	*	*	*	*
		513630-00JA	SLV, AVC-2010/JA KIT	*	*	*	*	*	*	*
		513664-03	GUIDE, AVC-1100 GET STARTED	*	*	*	*	*	*	*
		513664-03EU	GUIDE, AVC-1100/EU GET STARTED	*	*	*	*	*	*	*
		513875-03	GUIDE, AVC-1200 QUICKSTART	*	*	*	*	*	*	*
		513875-03NK	GUIDE, AVC-1200/NK QUICKSTART	*	*	*	*	*	*	*
		513881-00	SLV, AVC-1200 VIDEO CD USB	*	*	*	*	*	*	*
		LBL-00117-01-A	LABEL, AVC-3610 CERT	*	*	*	*	*	*	*
		LBL-00132-01-A	LBL, AVC-3610 SYS REQUIREMENTS	*	*	*	*	*	*	*
		MAN-00110-01-A	GUIDE, AFW-8300A INSTALL	*	*	*	*	*	*	*
		PMF-00077-01-A	HOUSING, AVC-3610 TOP RETAIL	*	*	*	*	*	*	*
	WIPB	1497650-00	ASSY, BOT HOUSING/FT AVC-3610	*	*	*	*	*	*	*
		1497651-00	ASSY, FRONT BEZEL/LP AVC-3610	*	*	*	*	*	*	*
		1497777-00	ASSY, BCK TRIM/ F CBL AVC-3610	*	*	*	*	*	*	*
		2003100	CD ASSY, AVC-2200 v1.0/GD	*	*	*	*	*	*	*
		2003400	CD ASSY, AVC-2000 v1.0/GD	*	*	*	*	*	*	*
		2006806-00	PCA, AVC-2310	*	*	*	*	*	*	*
		2006806-01	PCA, AVC-2310/EU	*	*	*	*	*	*	*
		2006806-02	PCA, AVC-2310/JA	*	*	*	*	*	*	*
		2006806-03	PCA, AVC-2210	*	*	*	*	*	*	*
		2006906-00	PCA, AVC-2010	*	*	*	*	*	*	*
		2042406-00	PCA, AVC-2410	*	*	*	*	*	*	*
		2042406-02	PCA, AVC-2410/JA	*	*	*	*	*	*	*
		2052200	AVC-2310 NTSC VIDEO CONVERTER	*	*	*	*	*	*	*
		2128206-01	PCA, AVC-3610/HP	*	*	*	*	*	*	*
		2128206-03	PCA, AVC-3610	*	*	*	*	*	*	*
		2142600-R	AVC-3610/HP NTSC RoHSVDO CNVTR	*	*	*	*	*	*	*
		ASM-00367-01-A	SCD, AVC-3610 CABLE ACCSSRY	*	*	*	*	*	*	*
		ASM-00485-01-A	ASSY, AVC-3610 BOTTOM/FTRTL	*	*	*	*	*	*	*
		ASM-00486-01-A	ASSY, 3610 FRNT BEZEL/LP RTL	*	*	*	*	*	*	*
		ASM-00487-01-A	SCD, AVC-3610 REMOTE CONTROL	*	*	*	*	*	*	*
		CDA-00039-01-A	CD ASSY, AVC3610 VIDEO DUOv1.0	*	*	*	*	*	*	*
481	FINC	738711	AIC-6350T REV A	*	*	*	*	*	*	*
		748811	AIC-6350BT	*	*	*	*	*	*	*
		1490209-00	LBL, APA-1480B KIT PROD LBL	*	*	*	*	*	*	*
		1490210-00	LBL, APA-1460D KIT PROD LBL	*	*	*	*	*	*	*
		1490910-00	LABEL, APA-1460C/IOMGJAZ PROD	*	*	*	*	*	*	*
		1491441-00	LBL, APD-1480A MAC KIT PRODUCT	*	*	*	*	*	*	*

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		1491634-00JA	DISK ASSY, 2910C SCSI v1.5	*	*	*	*	*	*	*
		1491638-00	DISK ASSY,EZSCSI DOS/WIN v5.0D	*	*	*	*	*	*	*
		1491639-00	DISK ASSY, 7800 FMS LITE v3.03	*	*	*	*	*	*	*
		1491719-00	DISK ASSY, 1460 v1.01	*	*	*	*	*	*	*
		1491720-00JA	DISK ASSY, WIN FUJI v2.0	*	*	*	*	*	*	*
		1491722-00	DISK ASSY, SLIMSCv2.X/1460v1.0	*	*	*	*	*	*	*
		1491723-00JA	DISK ASSY,SLIMSCSI v2.xJ/v1.1J	*	*	*	*	*	*	*
		1491724-00JA	DISK ASSY, EZ/JA v5.0eJ SE	*	*	*	*	*	*	*
		1491725-00	DISK ASSY, 1480X/v1.0/1.22	*	*	*	*	*	*	*
		1491726-00EU	DISK ASSY, 1480A/EFIGS v1.21	*	*	*	*	*	*	*
		1491734-00JA	DISK ASSY, 2910C/SCSISEL v1.0J	*	*	*	*	*	*	*
		1492411-00	BRACKET, LOW PRO 50HD 1.168	*	*	*	*	*	*	*
		1492441-00	INSERT, APA-1480A/JA NEC	*	*	*	*	*	*	*
		1492924-00	DISK ASSY, 2915LP SCSI 2.57.4	*	*	*	*	*	*	*
		1492925-40	DISK ASSY,29XXLP U160WN1.13wDS	*	*	*	*	*	*	*
		1495024-00JA	DISK ASSY,2915/30LPJADR1.3woDS	*	*	*	*	*	*	*
		1497139-00	CLAMSHELL, AUA/AFW	*	*	*	*	*	*	*
		1497147-00	TRAY, AFW-4300 CLAMSHELL	*	*	*	*	*	*	*
		1635307-00	PCB, AVA-2902E/2902I	*	*	*	*	*	*	*
		1638007-00	PCB, APA-1425/50/60B	*	*	*	*	*	*	*
		1640907-00	PCB, AVA-2904	*	*	*	*	*	*	*
		1686807-00	PCB, AHA-2910C/15C/20C/30C	*	*	*	*	*	*	*
		1701607-00	PCB, APA-1450C/60C	*	*	*	*	*	*	*
		1778407-00	PCB, AVA-2906	*	*	*	*	*	*	*
		1823907-00	PCB, APA-1480B	*	*	*	*	*	*	*
		1869107-00	PCB, AVA-2915/30LP	*	*	*	*	*	*	*
		1873600	CD ASSY, 1480 SLIMSCSI v1.2	*	*	*	*	*	*	*
		1873600EU	CD ASSY, 1480 SLIMSCSI/EU v1.2	*	*	*	*	*	*	*
		1873600JA	CD ASSY, 1480SLIMSCSI/JA v1.2J	*	*	*	*	*	*	*
		1893700	CD ASSY, APD-29160 MAC v1.0	*	*	*	*	*	*	*
		1893700EU	CD ASSY, APD-29160 MAC/EU v1.0	*	*	*	*	*	*	*
		1916800	CD ASSY, 2930CU PD4.4/USRv6.0	*	*	*	*	*	*	*
		1916800EU	CD ASSY, 2930CU/EUPD4.4/USR6.0	*	*	*	*	*	*	*
		1916800JA	CD ASSY,2930CU-TSTJA4.4/USR6.0	*	*	*	*	*	*	*
		1962400JA	CD ASSY, AHA-2930U/JA PD6.0/GD	*	*	*	*	*	*	*
		1983900EU	CD ASSY, 29160 MAC/EU v2.0/GD	*	*	*	*	*	*	*
		1987700EU	CD ASSY,PD39160/EU SRAID/GD2.0	*	*	*	*	*	*	*
		1987700JA	CD ASSY,PD39160/JA SRD/GD v2.0	*	*	*	*	*	*	*
		2086507-00	PCB, AFW-2100/4300C	*	*	*	*	*	*	*
		2116300	CD ASSY, 2210 WIN/XP-00' v1.3	*	*	*	*	*	*	*
		491313-01	BOX, AHA-15XX KIT (KRAFT)	*	*	*	*	*	*	*
		491355-00	BOX, DISTI AHA-15XX	*	*	*	*	*	*	*
		492984-00	INSERT, APA-1460/80 CARD	*	*	*	*	*	*	*
		493770-00	SCD, AHA-1530P/COMPAQ KIT BOX	*	*	*	*	*	*	*
		494251-00	TRAY, AHA-2910A/AI CONDUCTIVE	*	*	*	*	*	*	*
		494304-00	(OBS)CABLE,50PSCSI3CONN W/TERM	*	*	*	*	*	*	*
		494984-00	TRAY, AHA-2930U,2940AU CONDUCT	*	*	*	*	*	*	*
		495274-00	BOX, APA-1460/1460A/1480A MSTR	*	*	*	*	*	*	*
		495376-00	INSERT, APA-1460/IOMEGA	*	*	*	*	*	*	*
		495986-00	ADAPTER, DB25 M TO 50P SCSI	*	*	*	*	*	*	*
		496991-00	LABEL, APA-1460B KIT PROD LBL	*	*	*	*	*	*	*
		511288-00JA	USER'S GUIDE, APA-1460A/J97	*	*	*	*	*	*	*

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		511332-00	CARD, APA FREE CABLE OFFER	*	*	*	*	*	*	*
		511332-00FR	CARD, FR FREE CABLE OFFER	*	*	*	*	*	*	*
		511332-00GE	CARD, GE FREE CABLE OFFER	*	*	*	*	*	*	*
		511332-00IT	CARD, IT FREE CABLE OFFER	*	*	*	*	*	*	*
		511332-00SP	CARD, SP FREE CABLE OFFER	*	*	*	*	*	*	*
		511339-00EU	GUIDE, APA-1460/EU INST	*	*	*	*	*	*	*
		511444-00	INSTALL GUIDE, AVA-2902E/I	*	*	*	*	*	*	*
		511460-00JA	SLV/BOX, AHA-2930U/JA RTL KIT	*	*	*	*	*	*	*
		511475-00	SLEEVE, APA-1480 KIT	*	*	*	*	*	*	*
		511475-00EU	SLEEVE, APA-1480A/EFIGS	*	*	*	*	*	*	*
		511482-00EU	CARD, EU REG/READ ME FIRST	*	*	*	*	*	*	*
		511537-00	GUIDE, APA-1480 USER'S (BOM)	*	*	*	*	*	*	*
		511537-00EU	USER GUIDE, APA-1480A	*	*	*	*	*	*	*
		511591-00	INSTALL GUIDE, AVA-2904E	*	*	*	*	*	*	*
		511599-00	INSTALL GUIDE, APA-1425/50/60	*	*	*	*	*	*	*
		511604-00	SLEEVE, APA-1460 SCSI KIT	*	*	*	*	*	*	*
		511604-00EU	SLEEVE, APA-1460B/EFIGS KIT	*	*	*	*	*	*	*
		511605-00	USER'S GUIDE, APA-1460 (BOM)	*	*	*	*	*	*	*
		511605-00JA	GUIDE, 1460D/JA USER'S (BOM)	*	*	*	*	*	*	*
		511606-00	CARD, APA REG/README	*	*	*	*	*	*	*
		511606-00FR	CARD, FR APA REG/README	*	*	*	*	*	*	*
		511606-00GE	CARD, GE APA REG/README	*	*	*	*	*	*	*
		511606-00IT	CARD, IT APA REG/README	*	*	*	*	*	*	*
		511606-00SP	CARD, SP APA REG/README	*	*	*	*	*	*	*
		511623-00FR	GUIDE, EZSCSI 5.0 FR QCK REF	*	*	*	*	*	*	*
		511623-00GE	GUIDE, EZSCSI 5.0 GE QCK REF	*	*	*	*	*	*	*
		511623-00IT	GUIDE, EZSCSI 5.0 IT QCK REF	*	*	*	*	*	*	*
		511623-00JA	GUIDE, EZSC/JA v5.0J QCK REF	*	*	*	*	*	*	*
		511623-00SP	GUIDE, EZSCSI 5.0 SP QCK REF	*	*	*	*	*	*	*
		511691-00	INSTALL GUIDE, AHA-2910C	*	*	*	*	*	*	*
		511691-00JA	GUIDE, AHA-2910C/JA INSTALL	*	*	*	*	*	*	*
		511724-00	INSTALL GUIDE, AHA-2915C	*	*	*	*	*	*	*
		511733-00	INSTALL GUIDE, AHA-2930C	*	*	*	*	*	*	*
		511837-00JA	SLV/BOX, 2910C/JA KIT	*	*	*	*	*	*	*
		511948-00JA	GUIDE, AHA-2910C/JA USERS(BOM)	*	*	*	*	*	*	*
		511954-00FR	FLYER, MAC/FR PRODUCT SOLUTION	*	*	*	*	*	*	*
		511954-00GE	FLYER, MAC/GE PRODUCT SOLUTION	*	*	*	*	*	*	*
		512088-00	CARD, ORDER EZSCSI v5.0	*	*	*	*	*	*	*
		512089-00	GUIDE, QUICK INSTALL AHA-2930U	*	*	*	*	*	*	*
		512089-00FR	GUIDE, AHA-2930U/FR INSTALL	*	*	*	*	*	*	*
		512089-00GE	GUIDE, AHA-2930U/GE INSTALL	*	*	*	*	*	*	*
		512089-00IT	GUIDE, AHA-2930U/IT INSTALL	*	*	*	*	*	*	*
		512089-00JA	GUIDE, AHA-2930U/JA INSTAL	*	*	*	*	*	*	*
		512089-00SP	GUIDE, AHA-2930U/SP INSTALL	*	*	*	*	*	*	*
		512090-00	GUIDE, REF 2930U w/WAR-LIC BOM	*	*	*	*	*	*	*
		512090-00JA	GUIDE, AHA-2930U/JA USER (BOM)	*	*	*	*	*	*	*
		512183-00EU	SLV/BOX, AHA-2930U MAC/EU KIT	*	*	*	*	*	*	*
		512183-00JA	SLV/BOX, AHA-2930U MAC/JA KIT	*	*	*	*	*	*	*
		512184-00	CARD, GENERIC MAC README FIRST	*	*	*	*	*	*	*
		512184-00FR	CARD, FR GEN MAC REG/RDME	*	*	*	*	*	*	*
		512184-00GE	CARD, GE GEN MAC REG/RDME	*	*	*	*	*	*	*
		512184-00IT	CARD, IT GEN MAC REG/RDME	*	*	*	*	*	*	*

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		512184-00SP	CARD, SP GEN MAC REG/RDME	*	*	*	*	*	*	*
		512184-00UK	CARD, UK GEN MAC REG/RDME	*	*	*	*	*	*	*
		512193-00	GUIDE, AHA-2930U MAC INSTALL	*	*	*	*	*	*	*
		512193-00FR	GUIDE, 2930CU MAC/FR INSTALL	*	*	*	*	*	*	*
		512193-00GE	GUIDE, 2930CU MAC/GE INSTALL	*	*	*	*	*	*	*
		512193-00IT	GUIDE, 2930CU MAC/IT INSTALL	*	*	*	*	*	*	*
		512193-00SP	GUIDE, AHA-2930U MAC/SP INSTAL	*	*	*	*	*	*	*
		512213-00JA	CARD, README HOW TO INSTL DRVR	*	*	*	*	*	*	*
		512219-00JA	SLV/BOX, APA-1460D-H/JA RTL	*	*	*	*	*	*	*
		512220-00JA	SLV/BOX, APA-1460D-L/JA RTL	*	*	*	*	*	*	*
		512276-00	FLYER, AHA-2930U MAC	*	*	*	*	*	*	*
		512276-00FR	FLYER, AHA-2930U MAC/FR	*	*	*	*	*	*	*
		512276-00GE	FLYER, AHA-2930U MAC/GE	*	*	*	*	*	*	*
		512276-00IT	FLYER, AHA-2930U MAC/IT	*	*	*	*	*	*	*
		512276-00SP	FLYER, AHA-2930U MAC/SP	*	*	*	*	*	*	*
		512284-00	INSTALL GUIDE, AVA-2903B	*	*	*	*	*	*	*
		512296-00	FLYER, MACINTOSH PRODUCT LINE	*	*	*	*	*	*	*
		512296-00SP	FLYER, MAC/SP PRODUCT LINE	*	*	*	*	*	*	*
		512367-00EU	SLV, APD-39160 MAC/EU KIT	*	*	*	*	*	*	*
		512371-00	CARD, MAC S/W LICENSE & WARR	*	*	*	*	*	*	*
		512371-00FR	CARD, MAC/FR S/W LIC & WARR	*	*	*	*	*	*	*
		512371-00GE	CARD, MAC/GE S/W LIC & WARR	*	*	*	*	*	*	*
		512371-00IT	CARD, MAC/IT S/W LIC & WARR	*	*	*	*	*	*	*
		512371-00SP	CARD, MAC/SP S/W LIC & WARR	*	*	*	*	*	*	*
		512371-00UK	CARD, MAC/UK S/W LIC & WARR	*	*	*	*	*	*	*
		512372-00FR	GUIDE, AHA-3960D MAC/FR INSTAL	*	*	*	*	*	*	*
		512372-00GE	GUIDE, AHA-3960D MAC/GE INSTAL	*	*	*	*	*	*	*
		512372-00IT	GUIDE, AHA-3960D MAC/IT INSTAL	*	*	*	*	*	*	*
		512372-00SP	GUIDE, AHA-3960D MAC/SP INSTAL	*	*	*	*	*	*	*
		512384-00	ADDENDUM, AVA-2903B/EPSON	*	*	*	*	*	*	*
		512426-00	SLV, APD-29160N MAC	*	*	*	*	*	*	*
		512426-00EU	SLV/BOX, APD-29160N MAC/EU	*	*	*	*	*	*	*
		512428-03FR	GUIDE, 29160N MAC/FR INSTL HRD	*	*	*	*	*	*	*
		512428-03GE	GUIDE, 29160N MAC/GE INSTL HRD	*	*	*	*	*	*	*
		512428-03IT	GUIDE, 29160N MAC/IT INSTL HRD	*	*	*	*	*	*	*
		512428-03SP	GUIDE, 29160N MAC/SP INSTL HRD	*	*	*	*	*	*	*
		512431-03	GUIDE, 7800 LITE v3.03 USR HRD	*	*	*	*	*	*	*
		512489-03	GUIDE, APD-1480 PWRDMN INSTALL	*	*	*	*	*	*	*
		512489-03FR	GUIDE, APD-1480/FR INSTALL	*	*	*	*	*	*	*
		512489-03GE	GUIDE, APD-1480/GE INSTALL	*	*	*	*	*	*	*
		512489-03IT	GUIDE, APD-1480/IT INSTALL	*	*	*	*	*	*	*
		512489-03SP	GUIDE, APD-1480/SP INSTALL	*	*	*	*	*	*	*
		512489-03UK	GUIDE, APD-1480/UK INSTALL	*	*	*	*	*	*	*
		512491-00	SLV, APD-1480 MAC KIT	*	*	*	*	*	*	*
		512491-00EU	SLV, APD-1480 MAC/EU KIT	*	*	*	*	*	*	*
		512497-00	CARD, APD-1480 MAC READ ME	*	*	*	*	*	*	*
		512497-00FR	CARD, APD-1480 MAC/FR READ ME	*	*	*	*	*	*	*
		512497-00GE	CARD, APD-1480 MAC/GE READ ME	*	*	*	*	*	*	*
		512497-00IT	CARD, APD-1480 MAC/IT READ ME	*	*	*	*	*	*	*
		512497-00SP	CARD, APD-1480 MAC/SP READ ME	*	*	*	*	*	*	*
		512497-00UK	CARD, APD-1480 MAC/UK READ ME	*	*	*	*	*	*	*
		512508-00	CARD, APD CABLE OFFER	*	*	*	*	*	*	*

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		512508-00FR	CARD, APD-1480/FR CABLE OFFER	*	*	*	*	*	*	*
		512508-00GE	CARD, APD-1480/GE CABLE OFFER	*	*	*	*	*	*	*
		512508-00IT	CARD, APD-1480/IT CABLE OFFER	*	*	*	*	*	*	*
		512508-00SP	CARD, APD-1480/SP CABLE OFFER	*	*	*	*	*	*	*
		512508-00UK	CARD, APD-1480/UK CABLE OFFER	*	*	*	*	*	*	*
		512523-03JA	GUIDE, 1480 PD/JA INSTL (2000)	*	*	*	*	*	*	*
		512566-00JA	SLV, APA-1480/JA	*	*	*	*	*	*	*
		512567-00JA	CARD, UNIFICATION REG WAR/JA	*	*	*	*	*	*	*
		512573-03JA	GUIDE, APA-1480/JA USER'S	*	*	*	*	*	*	*
		512670-05JA	GUIDE, 2915LP/JA USRREF CDASSY	*	*	*	*	*	*	*
		512681-00JA	SLV/BOX, AVA-2915LP/JA KIT	*	*	*	*	*	*	*
		512693-00	LBL, AHA-2910C BSMI	*	*	*	*	*	*	*
		512699-00JA	SLV/BOX, AVA-2930LP/JA KIT	*	*	*	*	*	*	*
		512722-00	SLV, APD-29160 MAC	*	*	*	*	*	*	*
		512722-00EU	SLV/BOX, APD-29160 MAC/EU	*	*	*	*	*	*	*
		512725-05JA	GUIDE, 2930LP/JA USRREF CDASSY	*	*	*	*	*	*	*
		512727-00	LBL, APD-29160 MAC	*	*	*	*	*	*	*
		512731-00EU	SLV/BOX, AVA-2904/EU KIT	*	*	*	*	*	*	*
		512733-03EU	GUIDE, 2904/EFIGS QK INSTL HRD	*	*	*	*	*	*	*
		512849-05EU	GUIDE, 2904/EFIGS INSTL CDASSY	*	*	*	*	*	*	*
		512906-00	FLYER, DESKTOP PRODUCTS IN-BOX	*	*	*	*	*	*	*
		513045-03	GUIDE, AHA2930 PWRDMNINSTALHRD	*	*	*	*	*	*	*
		513045-03JA	GUIDE, AHA2930/JA PD INSTALHRD	*	*	*	*	*	*	*
		513047-03JA	GUIDE, 2906/JA MAC/PCINSTLHRD	*	*	*	*	*	*	*
		513049-03	GUIDE, APD U160 INSTALL HRD	*	*	*	*	*	*	*
		513049-03EU	GUIDE, APD U160/EU INSTALL HRD	*	*	*	*	*	*	*
		513049-03JA	GUIDE, APD U160/JA INSTALL HRD	*	*	*	*	*	*	*
		513072-00	SLV, AVA-2906 PC/MAC KIT	*	*	*	*	*	*	*
		513072-00JA	SLV, AVA-2906 MAC/JA KIT	*	*	*	*	*	*	*
		513077-00	SLV, AHA-2930U MAC	*	*	*	*	*	*	*
		513077-00JA	SLV, AHA-2930U/JA MAC	*	*	*	*	*	*	*
		513097-00	SLV, APD-29160	*	*	*	*	*	*	*
		513097-00EU	SLV, APD-29160 MAC/EU	*	*	*	*	*	*	*
		513097-00JA	SLV, APD-29160 MAC/JA KIT	*	*	*	*	*	*	*
		513099-00	SLV, APD-29160N	*	*	*	*	*	*	*
		513099-00EU	SLV, APD-29160N MAC/EU	*	*	*	*	*	*	*
		513099-00JA	SLV, APD-29160N MAC/JA KIT	*	*	*	*	*	*	*
		513101-00	SLV, APD-39160	*	*	*	*	*	*	*
		513101-00EU	SLV, APD-39160 MAC/EU	*	*	*	*	*	*	*
		513101-00JA	SLV, APD-39160/JA	*	*	*	*	*	*	*
		513153-03	GUIDE, AHA-2930CU INSTALL HRD	*	*	*	*	*	*	*
		513153-03EU	GUIDE, AHA-2930CU/EU INSTL HRD	*	*	*	*	*	*	*
		513155-00	SLV, AHA-2930U KIT	*	*	*	*	*	*	*
		513155-00EU	SLV, AHA-2930U/EU KIT	*	*	*	*	*	*	*
		513305-00JA	CARD, UNIFI REG/WAR JA 2YR	*	*	*	*	*	*	*
		513550-00JA	LABEL, AHA-2930/JA TOAST v5.X	*	*	*	*	*	*	*
		513611-00	LBL, AVA-2902BE CAUTION	*	*	*	*	*	*	*
		513886-03	GUIDE, 2210 WIN/XP-00' QKSTART	*	*	*	*	*	*	*
		513986-00EU	CARD, APA/EU CABLE OFFER	*	*	*	*	*	*	*
		931606-00	BIOS, AHA-1520B/IOMEGA	*	*	*	*	*	*	*
	WIPB	01-30170-000-00	HCA-302 NEC CABLES (BULK)	*	*	*	*	*	*	*
		1635306-05	PCA, AVA-2902BE	*	*	*	*	*	*	*

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		1638006-03	PCA, APA-1460B/FUJITSU	*	*	*	*	*	*	*
		1640906-00	PCA, AVA-2904	*	*	*	*	*	*	*
		1640906-04	PCA, AVA-2904 (99)	*	*	*	*	*	*	*
		1640906-06	PCA, AVA-2904BE	*	*	*	*	*	*	*
		1686806-01	PCA, AHA-2915C	*	*	*	*	*	*	*
		1686806-03	PCA, AHA-2930C	*	*	*	*	*	*	*
		1686806-05	PCA, AHA-2930CU	*	*	*	*	*	*	*
		1686806-08	PCA, AHA-2930CU MAC	*	*	*	*	*	*	*
		1686806-12	PCA, AHA-2910C (99)	*	*	*	*	*	*	*
		1701606-03	PCA, APA-1460D	*	*	*	*	*	*	*
		1778406-00	PCA, AVA-2906	*	*	*	*	*	*	*
		1807400-R	APA-1460D SSCSI RoHS CARD ASSY	*	*	*	*	*	*	*
		1809606-09	PCA, APD-29160 MAC	*	*	*	*	*	*	*
		1817206-04	PCA, APD-39160 MAC	*	*	*	*	*	*	*
		1823906-00	PCA, APA-1480B	*	*	*	*	*	*	*
		1824706-01	PCA, APD-29160N MAC	*	*	*	*	*	*	*
		1828100EU	CD-ASSY, EZ/EUv5.0w2930U/EUREF	*	*	*	*	*	*	*
		1828700-R	APA-1480B SSCSI RoHS CARD ASSY	*	*	*	*	*	*	*
		1845400-00	APA-1460CF CASE ASSEMBLY	*	*	*	*	*	*	*
		1848300	CD ASSY, APD-29160N MAC v1.0	*	*	*	*	*	*	*
		1848300EU	CD ASSY, APD29160N MAC/EU v1.0	*	*	*	*	*	*	*
		1857000EU	CD ASSY, 2930CU/EU PWRDMN v4.2	*	*	*	*	*	*	*
		1857300JA	CD ASSY, 1460 WIN CE/JA v2.12J	*	*	*	*	*	*	*
		1860900	CD ASSY, 2906 MAC SCSI v1.2	*	*	*	*	*	*	*
		1869106-00	PCA, AVA-2915LP	*	*	*	*	*	*	*
		1869106-01	PCA, AVA-2930LP	*	*	*	*	*	*	*
		1869106-02	PCA, AVA-2915LP KIT	*	*	*	*	*	*	*
		1869106-03	PCA, AVA-2930LP KIT	*	*	*	*	*	*	*
		1888400-R	AVA-2915LP RoHS VALUE ADAPTER	*	*	*	*	*	*	*
		1888600-R	AVA-2930LP RoHS VALUE ADAPTER	*	*	*	*	*	*	*
		1892200-R	AVA-2915LP RoHS VALUE ADAPTER	*	*	*	*	*	*	*
		1892300-R	AVA-2930LP RoHS VALUE ADAPTER	*	*	*	*	*	*	*
		1962400	CD ASSY, AHA-2930U PD v6.0/GD	*	*	*	*	*	*	*
		1969700	CD ASSY, 2906MAC/PC SCSI2.0/GD	*	*	*	*	*	*	*
		1969700EU	CD ASSY, 2906MAC/EU SCSI2.0/GD	*	*	*	*	*	*	*
		1983900	CD ASSY, APD-29160 MAC v2.0/GD	*	*	*	*	*	*	*
		1983900JA	CD ASSY, 29160/JA MAC v2.0/GD	*	*	*	*	*	*	*
		1984000	CD ASSY, APD-29160N MACv2.0/GD	*	*	*	*	*	*	*
		1984000EU	CD ASSY, 29160N MAC/EU v2.0/GD	*	*	*	*	*	*	*
		1984000JA	CD ASSY, 29160N MAC/JA v2.0/GD	*	*	*	*	*	*	*
		1985200	CD ASSY, AHA-2930U v2.0/GD	*	*	*	*	*	*	*
		1985200EU	CD ASSY, AHA-2930U/EU v2.0/GD	*	*	*	*	*	*	*
		1987700	CD ASSY, PD39160 SRAID/GD v2.0	*	*	*	*	*	*	*
		1989100	USB2-Xchange ADAPTER ASSEMBLY	*	*	*	*	*	*	*
		513870-00	ERRATA, AVC-2010/2210 S/W INFO	*	*	*	*	*	*	*
482	RAWB	13630	CKT PROTECT, 1.5AMP SMD150	*	*	*	*	*	*	*
		14573	ADAPTER, EXT 68PHDF-50PHDM NRW	*	*	*	*	*	*	*
		1492960-00	CABLE, EX 1394 6-4 2M S400	*	*	*	*	*	*	*
		1493165-00	BRACKET, AUA-3100LP LP	*	*	*	*	*	*	*
		1493210-00	BRACKET, AUA-3100LP STD	*	*	*	*	*	*	*
		1493487-00	BRACKET, AUA-5100	*	*	*	*	*	*	*
		1493931-00	INSERT, AUH-4000/7000 STD	*	*	*	*	*	*	*

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		1493932-00	INSERT, AUH-4000/7000 PIC FR	*	*	*	*	*	*	*
		1493934-00	FRAME, AUH-4000/7000 STAND	*	*	*	*	*	*	*
		1493951-00	SCD, CBL EX PWR USB/1394	*	*	*	*	*	*	*
		1493953-00	BRACKET, AUA-2000 STD	*	*	*	*	*	*	*
		1493954-00	BRACKET, AUA-2000LP LP	*	*	*	*	*	*	*
		1493970-00	CLAMSHELL, AUH-4000/7000+ FRONT	*	*	*	*	*	*	*
		1493970-01	CLAMSHELL, AUH-4000/7000+ REAR	*	*	*	*	*	*	*
		1494011-00	LBL, AUH-4000/7000 PRODUCT	*	*	*	*	*	*	*
		1494402-00	CLAMSHELL, AUH-4000	*	*	*	*	*	*	*
		1494475-00	INSERT, CLAMSHELL SUP KIT BOX	*	*	*	*	*	*	*
		1494476-00	INSERT, PWR ADPTR SUP KIT BOX	*	*	*	*	*	*	*
		1494477-00	INSERT, PARTITION KIT BOX	*	*	*	*	*	*	*
		1494507-00	INSERT, MSTR BOX STD	*	*	*	*	*	*	*
		1494510-00	INSERT, MSTR BOX PLUS	*	*	*	*	*	*	*
		1494832-00	BOX, AUH-4000 BUNDLE KIT	*	*	*	*	*	*	*
		1495080-00	BRACKET, AUA-4000	*	*	*	*	*	*	*
		1495168-00	SCD, AUH-4100 CLAMSHELL	*	*	*	*	*	*	*
		1495475-00	SCD, AUH-4100 NOTEBOOK HUB	*	*	*	*	*	*	*
		1495495-00	SLV, AUH-4100 INTERNAL	*	*	*	*	*	*	*
		1495495-00ENFR	SLV, AUH-4100/ENFR INTERNAL	*	*	*	*	*	*	*
		1495495-00GE	SLV, AUH-4100/GE INTERNAL	*	*	*	*	*	*	*
		1495495-00ITSP	SLV, AUH-4100/ITSP INTERNAL	*	*	*	*	*	*	*
		1495495-00JA	SLV, AUH-4100/JA INTERNAL	*	*	*	*	*	*	*
		1495496-00	SLV, AUH-4000+ INTERNAL	*	*	*	*	*	*	*
		1495496-00JA	SLV, AUH-4000+/JA INTERNAL	*	*	*	*	*	*	*
		1495497-00	SLV, AUH-7000+ INTERNAL	*	*	*	*	*	*	*
		1495497-00ENFR	SLV, AUH-7000+ENFR INTERNAL	*	*	*	*	*	*	*
		1495497-00JA	SLV, AUH-7000+/JA INTERNAL	*	*	*	*	*	*	*
		1495498-00	SCD, AUH-4000/7000+ CLAMSHELL	*	*	*	*	*	*	*
		1496041-00	INSERT, AFW-4300V CLAMSHELL	*	*	*	*	*	*	*
		1496417-00	DISK ASSY, ASH-1205SA DRV v1.0	*	*	*	*	*	*	*
		1496417-00EU	DISK ASSY, 1205SA/EU DRV v1.0	*	*	*	*	*	*	*
		1496417-00JA	DISK ASSY, 1205SA/JA DRV v1.0	*	*	*	*	*	*	*
		1496461-00	CLAMSHELL, AFW-4300V	*	*	*	*	*	*	*
		1496494-00	SCD, AUH-2000 HUB2 USB 2.0	*	*	*	*	*	*	*
		1496495-00	SCD, AUH-4400 HUB4 USB2.0	*	*	*	*	*	*	*
		1496503-00	CLAMSHELL, AUH-2000	*	*	*	*	*	*	*
		1496766-00	CLAMSHELL, AUH-4400	*	*	*	*	*	*	*
		1497140-00	TRAY, AUA5100/4000 CLAMSHELL	*	*	*	*	*	*	*
		1497517-00	SCD, AUA-7500 MEDIA READER	*	*	*	*	*	*	*
		16018	THERMAL PAD 13X13MM	*	*	*	*	*	*	*
		16019	THERMAL PAD 7X8MM	*	*	*	*	*	*	*
		16641	ADAPTER, PLUG USA TO EURO	*	*	*	*	*	*	*
		16643	ADAPTER, PLUG USA TO UK	*	*	*	*	*	*	*
		16910	CONN, 1394 6-PIN SMT	*	*	*	*	*	*	*
		16911	IC, FW323-06 1394PHY/LINK TQFP	*	*	*	*	*	*	*
		17183	IC, LTC4053 LI USB CHRGR MSOP	*	*	*	*	*	*	*
		1890700	CD ASSY, AFW-4300 S/W & GUIDE	*	*	*	*	*	*	*
		1890700EU	CD ASSY, AFW-4300/EFIGS S/W&GD	*	*	*	*	*	*	*
		1893200	CD ASSY, USB-Xchange v1.2	*	*	*	*	*	*	*
		1893200EU	CD ASSY, USB-Xchg/EFIGS v1.2	*	*	*	*	*	*	*
		1919500JA	CD ASSY, USB-Xchg/JA v1.3J	*	*	*	*	*	*	*

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		1920600UN	CD ASSY, 4300/EFIGSJAS/W&GD1.1	*	*	*	*	*	*	*
		1921400	CD ASSY, USB2CONN DVR & GD 1.0	*	*	*	*	*	*	*
		1921400EU	CD ASSY, USB2CONN/EU DVR&GD1.0	*	*	*	*	*	*	*
		1921400JA	CD ASSY, USB2CONN DR&GD/JA 1.0	*	*	*	*	*	*	*
		1922207-00	PCB, AUH-4000/7000	*	*	*	*	*	*	*
		1924600	CD ASSY, USB2CONN DVR & GD 1.1	*	*	*	*	*	*	*
		2012007-00	PCB, AUA-4X00B/5X00B	*	*	*	*	*	*	*
		2019707-00	PCB, AUA-2X00B/3X00B	*	*	*	*	*	*	*
		2052600EU	CD ASSY, ASH-1205SA/EU v1.0	*	*	*	*	*	*	*
		2052600JA	CD ASSY, ASH-1205SA/JA v1.0	*	*	*	*	*	*	*
		2054200EU	CD ASSY, FCONNPLUS/EU 1.5/GD	*	*	*	*	*	*	*
		2054500	CD ASSY, DVPICS PLUS v1.4	*	*	*	*	*	*	*
		2058100	CD ASSY, AUA-1411 DVR v1.0 GD	*	*	*	*	*	*	*
		2062600JA	CD ASSY, 3020/JA DVR v1.7/GD	*	*	*	*	*	*	*
		2062600UN	CD ASSY, 3020/UN DVR v1.7/GD	*	*	*	*	*	*	*
		2062700JA	CD ASSY, AUA-1411/JA DR v1.1GD	*	*	*	*	*	*	*
		2062700UN	CD ASSY, AUA-1411/UN DR v1.1GD	*	*	*	*	*	*	*
		2063600EU	CD ASSY, 4300/EU S/W & GD v1.4	*	*	*	*	*	*	*
		2071500	CD ASSY, AFW-8300 v1.0/GD	*	*	*	*	*	*	*
		2071500EU	CD ASSY, AFW-8300/EU v1.0/GD	*	*	*	*	*	*	*
		2079900EU	CD ASSY, 1411/EU DVRv1.1-CBLGD	*	*	*	*	*	*	*
		2082500EU	CD ASSY, AFW-1430A/EU v1.3 GD	*	*	*	*	*	*	*
		2092500EU	CD ASSY, 1430A/EUv1.3 GD NOSNC	*	*	*	*	*	*	*
		2118500	CD ASSY, 2010 WIN/XP-00'v1.3.1	*	*	*	*	*	*	*
		2127800	CD ASSY, USBw/oCNTLv1.0 DRV/GD	*	*	*	*	*	*	*
		2128300	CD ASSY, AUA-1422 v1.0/GD	*	*	*	*	*	*	*
		2128400	CD ASSY, ASH-1233Cs v1.0 DRV/GD	*	*	*	*	*	*	*
		2128600	CD ASSY, AUA-7500 v1.0/GD	*	*	*	*	*	*	*
		2130100	CD ASSY, AFW-4300C v1.0/GUIDE	*	*	*	*	*	*	*
		2132800	CD ASSY, AUA3020 DRONLYv1.0/GD	*	*	*	*	*	*	*
		511422-00EU	GUIDE, AVA-2904 INSTALL	*	*	*	*	*	*	*
		512208-00FR	GUIDE, AVA-2906 MAC/FR INSTALL	*	*	*	*	*	*	*
		512208-00GE	GUIDE, AVA-2906 MAC/GE INSTALL	*	*	*	*	*	*	*
		512208-00IT	GUIDE, AVA-2906 MAC/IT INSTALL	*	*	*	*	*	*	*
		512208-00JA	GUIDE, AVA-2906 MAC/JA INSTALL	*	*	*	*	*	*	*
		512618-00	CARD, USB-Xchange INSERT	*	*	*	*	*	*	*
		512619-00	SLV, USB-Xchange KIT	*	*	*	*	*	*	*
		512619-00EU	SLV, USB-Xchange/EFIGS KIT	*	*	*	*	*	*	*
		512619-00JA	SLV, USB-Xchange/JA KIT	*	*	*	*	*	*	*
		512620-00	CARD, USB-Xchange REGISTRATION	*	*	*	*	*	*	*
		512620-00FR	CARD, USB-XCHG/FR REG/RMF	*	*	*	*	*	*	*
		512620-00GE	CARD, USB-XCHG/GE REG/RMF	*	*	*	*	*	*	*
		512620-00IT	CARD, USB-XCHG/IT REG/RMF	*	*	*	*	*	*	*
		512620-00SP	CARD, USB-XCHG/SP REG/RMF	*	*	*	*	*	*	*
		512620-00UK	CARD, USB-XCHG/INT'L REG/RMF	*	*	*	*	*	*	*
		512640-00JA	CARD, USB/JA READ ME FIRST	*	*	*	*	*	*	*
		512669-03	GUIDE, AVA-29XXLP INSTAL HRD	*	*	*	*	*	*	*
		512669-03JA	GUIDE, AVA-29XXLP/JA INSTL HRD	*	*	*	*	*	*	*
		512704-03	GUIDE, AFW-4300 INSTALL HRD	*	*	*	*	*	*	*
		512704-03EU	GUIDE, AFW-4300/EU INSTALL HRD	*	*	*	*	*	*	*
		512704-03FR	GUIDE, AFW-4300/FR INSTALL HRD	*	*	*	*	*	*	*
		512704-03GE	GUIDE, AFW-4300/GE INSTALL HRD	*	*	*	*	*	*	*

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		512704-03IT	GUIDE, AFW-4300/IT INSTALL HRD	*	*	*	*	*	*	*
		512704-03SP	GUIDE, AFW-4300/SP INSTALL HRD	*	*	*	*	*	*	*
		512704-03UK	GUIDE, AFW-4300/UK INSTALL HRD	*	*	*	*	*	*	*
		512712-00	SLV/BOX, AFW-4300A KIT	*	*	*	*	*	*	*
		512712-00EU	SLV/BOX, AFW-4300/EU KIT	*	*	*	*	*	*	*
		512822-03	GUIDE, AUA-3100LP INSTALL HRD	*	*	*	*	*	*	*
		512822-03FR	GUIDE, AUA-3100LP/FR INSTL HRD	*	*	*	*	*	*	*
		512822-03GE	GUIDE, AUA-3100LP/GE INSTL HRD	*	*	*	*	*	*	*
		512822-03IT	GUIDE, AUA-3100LP/IT INSTL HRD	*	*	*	*	*	*	*
		512822-03SP	GUIDE, AUA-3100LP/SP INSTL HRD	*	*	*	*	*	*	*
		512822-03UK	GUIDE, AUA-3100LP/UK INSTL HRD	*	*	*	*	*	*	*
		512826-00	SLV, AFW-4300 DV KIT	*	*	*	*	*	*	*
		512843-00	SLV, AUA-3100LP KIT	*	*	*	*	*	*	*
		512843-00EU	SLV, AUA-3100LP/EU KIT	*	*	*	*	*	*	*
		512843-00JA	SLV, AUA-3100LP/JA KIT w/o TAB	*	*	*	*	*	*	*
		512873-03JA	GUIDE, AUA-3100LP/JA INSTL HRD	*	*	*	*	*	*	*
		512879-03	GUIDE, USB2 CONNECT INSTL HRD	*	*	*	*	*	*	*
		512879-03FR	GUIDE, USB2 CONN/FR INSTL HRD	*	*	*	*	*	*	*
		512879-03GE	GUIDE, USB2 CONN/GE INSTL HRD	*	*	*	*	*	*	*
		512879-03IT	GUIDE, USB2 CONN/IT INSTL HRD	*	*	*	*	*	*	*
		512879-03SP	GUIDE, USB2 CONN/SP INSTL HRD	*	*	*	*	*	*	*
		512879-03UK	GUIDE, USB2 CONN/UK INSTL HRD	*	*	*	*	*	*	*
		512883-00	SLV, AUA-5100 KIT	*	*	*	*	*	*	*
		512883-00EU	SLV, AUA-5100/EU KIT	*	*	*	*	*	*	*
		512906-00EU	FLYER, DESKTOP PROD IN-BOX/EU	*	*	*	*	*	*	*
		512907-00JA	SLV, AUA-5100/JA KIT	*	*	*	*	*	*	*
		512924-03	GUIDE, AUA-3020 INSTALL HRD	*	*	*	*	*	*	*
		512924-03EU	GUIDE, AUA-3020/EU INSTALL HRD	*	*	*	*	*	*	*
		512924-03JA	GUIDE, AUA-3X2X/JA INSTALL HRD	*	*	*	*	*	*	*
		512964-03	GUIDE, 4000/7000 QK STRT HRD	*	*	*	*	*	*	*
		512964-03EU	GUIDE, 4000/7000/EU QKSTRT HRD	*	*	*	*	*	*	*
		512964-03JA	GUIDE, 4000/7000/JA QKSTRT HRD	*	*	*	*	*	*	*
		512968-00	INSERT, AUH-4000 HUB COVER	*	*	*	*	*	*	*
		512969-00	INSERT, AUH-7000 HUB COVER	*	*	*	*	*	*	*
		512971-00	SLV, AUA-3020	*	*	*	*	*	*	*
		512971-00EU	SLV, AUA-3020/EU KIT	*	*	*	*	*	*	*
		512972-00	SLV, AFW-4300 DVPICS PLUS KIT	*	*	*	*	*	*	*
		512973-00EU	SLV/BOX, 4300 FCONN PLUS/EU	*	*	*	*	*	*	*
		512976-03	GUIDE, AFW-1430 INSTL HRD	*	*	*	*	*	*	*
		512977-00	SLV, AFW-1430 KIT	*	*	*	*	*	*	*
		512977-00EU	SLV, AFW-1430/EU KIT	*	*	*	*	*	*	*
		512982-00	SLV, AUH-4000 KIT	*	*	*	*	*	*	*
		512982-00EU	SLV, AUH-4000/EU KIT	*	*	*	*	*	*	*
		512982-00JA	SLV, AUH-4000/JA KIT	*	*	*	*	*	*	*
		512983-00	SLV, AUH-4000PLUS KIT	*	*	*	*	*	*	*
		512983-00EU	SLV, AUH-4000PLUS/EU KIT	*	*	*	*	*	*	*
		512984-00	SLV, AUH-7000PLUS KIT	*	*	*	*	*	*	*
		512984-00EU	SLV, AUH-7000PLUS/EU KIT	*	*	*	*	*	*	*
		512994-00	FLYER, SOFTWARE QUICK START	*	*	*	*	*	*	*
		512997-03	GUIDE, AUA USB2CONN INSTL HRD	*	*	*	*	*	*	*
		513003-00	ERRATA, VIDEO CD ALERT NOTICE	*	*	*	*	*	*	*
		513014-03EU	GUIDE, AUA-1420/EU INSTALL HRD	*	*	*	*	*	*	*

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		513018-00	SLV/BOX, AUA-1420 KIT	*	*	*	*	*	*	*
		513018-00EU	SLV, AUA-1420/EU KIT	*	*	*	*	*	*	*
		513045-03EU	GUIDE, 2930U/EU PD INSTALL HRD	*	*	*	*	*	*	*
		513047-03	GUIDE, AVA2906 MAC/PCINSTALHRD	*	*	*	*	*	*	*
		513069-00	ERRATA, Xhub DRIVER/USBCNTRL	*	*	*	*	*	*	*
		513069-00EU	ERRATA, Xhub/EU DRVR/USBCNTRL	*	*	*	*	*	*	*
		513069-00JA	ERRATA, Xhub/JA DRVR/USBCNTRL	*	*	*	*	*	*	*
		513072-00EU	SLV, AVA-2906 MAC/EU KIT	*	*	*	*	*	*	*
		513077-00EU	SLV, AHA-2930U/EU MAC	*	*	*	*	*	*	*
		513136-00JA	FLYER, HUB/JA PROMO	*	*	*	*	*	*	*
		513139-00	SLV, AFW-4300 FCONN PLUS	*	*	*	*	*	*	*
		513141-00	SLV, AUH-4000BNDL KIT	*	*	*	*	*	*	*
		513141-00EU	SLV, AUH-4000BNDL/EU KIT	*	*	*	*	*	*	*
		513141-00JA	SLV, AUH-4000BNDL/JA KIT	*	*	*	*	*	*	*
		513143-00	SLV, 4300 DVPICS PLUS KIT	*	*	*	*	*	*	*
		513169-03	GUIDE, USB2CONN INSTALL HRD	*	*	*	*	*	*	*
		513169-03EU	GUIDE, USB2CONN/EU INSTALL HRD	*	*	*	*	*	*	*
		513169-03JA	GUIDE, USB2CONN/JA INSTALL HRD	*	*	*	*	*	*	*
		513176-00ENFR	SLV, 1100/ENFR VIDEO CD USB	*	*	*	*	*	*	*
		513176-00GE	SLV, 1100/GE VIDEO CD USB KIT	*	*	*	*	*	*	*
		513176-00ITSP	SLV, 1100/ITSP VIDEOCD USB KIT	*	*	*	*	*	*	*
		513183-00	SLV, USB2-Xchange KIT	*	*	*	*	*	*	*
		513183-00JA	SLV, USB2-Xchange/JA KIT	*	*	*	*	*	*	*
		513186-00JA	CARD, USB2.0/XHUB/JA REG/WARR	*	*	*	*	*	*	*
		513212-00JA	ERRATA, USB2-Xchange/JA	*	*	*	*	*	*	*
		513229-00	CARD, USB2-Xchange INSERT	*	*	*	*	*	*	*
		513231-00	SLV, AUA-2000 KIT	*	*	*	*	*	*	*
		513235-00	LBL, BSMI 33179	*	*	*	*	*	*	*
		513272-03	GUIDE, AUH-4100 QK START HRD	*	*	*	*	*	*	*
		513272-03EU	GUIDE, 4100/EU QK START HRD	*	*	*	*	*	*	*
		513272-03JA	GUIDE, 4100/JA QK START HRD	*	*	*	*	*	*	*
		513273-00	SLV, AUA-4000C KIT	*	*	*	*	*	*	*
		513288-03	GUIDE, USB2CONN INSTL HRD	*	*	*	*	*	*	*
		513288-03JA	GUIDE, USB2CONN/JA INSTL HRD	*	*	*	*	*	*	*
		513293-00JA	SLV, AUA-2000/JA KIT	*	*	*	*	*	*	*
		513309-00	LBL, AUA-3100LP LC PCBA LBL	*	*	*	*	*	*	*
		513393-03	GUIDE, AUA-1420A INSTALL HRD	*	*	*	*	*	*	*
		513393-03JA	GUIDE, AUA-1420A/JA INSTL HRD	*	*	*	*	*	*	*
		513397-00	LBL, AUA-5100B PCBA LBL	*	*	*	*	*	*	*
		513398-00	LBL, AUA-4000B PCBA LBL	*	*	*	*	*	*	*
		513405-00JA	SLV, AUA-3020/JA KIT	*	*	*	*	*	*	*
		513428-03	GUIDE, AFW-4300 HOSTADPT INSTL	*	*	*	*	*	*	*
		513428-03EU	GUIDE, 4300/EU HOSTADPT INSTL	*	*	*	*	*	*	*
		513530-00JA	SLV, AUA-1420A/JA KIT	*	*	*	*	*	*	*
		513545-00	LBL, AUA-2000B PCBA LBL	*	*	*	*	*	*	*
		513546-00	LBL, AUA-3100B PCBA LBL	*	*	*	*	*	*	*
		513551-00	SLV, AUA-1411 KIT	*	*	*	*	*	*	*
		513551-00EU	SLV, AUA-1411/EU KIT	*	*	*	*	*	*	*
		513551-00JA	SLV, AUA-1411/JA KIT	*	*	*	*	*	*	*
		513557-03	GUIDE, AUA-1411 INSTALL HARD	*	*	*	*	*	*	*
		513557-03JA	GUIDE, AUA-1411/JA INSTALL HRD	*	*	*	*	*	*	*
		513576-00JA	LBL, JAPAN RECYCLE "D"	*	*	*	*	*	*	*

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		513577-00JA	LBL, JAPAN RECYCLE "E"	*	*	*	*	*	*	*
		513578-00JA	LBL, JAPAN RECYCLE "G"	*	*	*	*	*	*	*
		513579-00JA	LBL, JAPAN RECYCLE "H"	*	*	*	*	*	*	*
		513581-00JA	LBL, JAPAN RECYCLE "K"	*	*	*	*	*	*	*
		513589-03	GUIDE, ASH-1205SA INSTALL	*	*	*	*	*	*	*
		513589-03EU	GUIDE, ASH-1205SA/EU INSTALL	*	*	*	*	*	*	*
		513589-03JA	GUIDE, ASH-1205SA/JA INSTALL	*	*	*	*	*	*	*
		513590-00	LBL, ASH-1205SA PCBA	*	*	*	*	*	*	*
		513608-00	SLV, ASH-1205SA KIT	*	*	*	*	*	*	*
		513608-00EU	SLV, ASH-1205SA/EU KIT	*	*	*	*	*	*	*
		513608-00JA	SLV, ASH-1205SA/JA KIT	*	*	*	*	*	*	*
		513629-00	CARD, AFW-4300V INSERT	*	*	*	*	*	*	*
		513632-00	FLYER, AUA-1411 WIN NOTICE	*	*	*	*	*	*	*
		513632-00EU	FLYER, AUA-1411/EU WIN NOTICE	*	*	*	*	*	*	*
		513632-00JA	FLYER, AUA-1411/JA WIN NOTICE	*	*	*	*	*	*	*
		513633-03	GUIDE, AUH-2000 QK START HRD	*	*	*	*	*	*	*
		513633-03ENFR	GUIDE, 2000/ENFR QK START HRD	*	*	*	*	*	*	*
		513633-03GE	GUIDE, 2000/GE QK START HRD	*	*	*	*	*	*	*
		513633-03ITSP	GUIDE, 2000/ITSP QK START HRD	*	*	*	*	*	*	*
		513633-03JA	GUIDE, 2000/JA QK START HRD	*	*	*	*	*	*	*
		513634-00	SLV, AUH-2000 KIT	*	*	*	*	*	*	*
		513634-00ENFR	SLV, AUH-2000/ENFR KIT	*	*	*	*	*	*	*
		513634-00GE	SLV, AUH-2000/GE KIT	*	*	*	*	*	*	*
		513634-00ITSP	SLV, AUH-2000/ITSP KIT	*	*	*	*	*	*	*
		513634-00JA	SLV, AUH-2000/JA KIT	*	*	*	*	*	*	*
		513637-03	GUIDE, AUH-4400 QK START HRD	*	*	*	*	*	*	*
		513637-03ENFR	GUIDE, 4400/ENFR QK START HRD	*	*	*	*	*	*	*
		513637-03GE	GUIDE, 4400/GE QK START HRD	*	*	*	*	*	*	*
		513637-03ITSP	GUIDE, 4400/ITSP QK START HRD	*	*	*	*	*	*	*
		513637-03JA	GUIDE, 4400 MINI/JA QK HRD	*	*	*	*	*	*	*
		513638-00	SLV, AUH-4400 KIT	*	*	*	*	*	*	*
		513638-00ENFR	SLV, AUH-4400/ENFR KIT	*	*	*	*	*	*	*
		513638-00GE	SLV, AUH-4400/GE KIT	*	*	*	*	*	*	*
		513638-00ITSP	SLV, AUH-4400/ITSP KIT	*	*	*	*	*	*	*
		513638-00JA	SLV, AUH-4400 MINI/JA KIT	*	*	*	*	*	*	*
		513682-03	GUIDE, MYDVD RCRDNW QK START	*	*	*	*	*	*	*
		513702-03	GUIDE, AFW-8300 INSTALL	*	*	*	*	*	*	*
		513702-03EU	GUIDE, AFW-8300/EU INSTALL	*	*	*	*	*	*	*
		513703-00	SLV, AFW-8300A KIT	*	*	*	*	*	*	*
		513703-00EU	SLV, AFW-8300A/EU KIT	*	*	*	*	*	*	*
		513737-03EU	GUIDE, 1411/EU INSTLw/oCBL HRD	*	*	*	*	*	*	*
		513738-03	GUIDE, AFW-1430A CRD INSTL HRD	*	*	*	*	*	*	*
		513738-03EU	GUIDE, 1430A/EU CRD INSTL HRD	*	*	*	*	*	*	*
		513816-00	CARD, AUA-4000V INSERT CLMSHLL	*	*	*	*	*	*	*
		513817-00	CARD, AUA-1420V INSERT CLMSHLL	*	*	*	*	*	*	*
		513818-00	CARD, AFW-1430V INSERT CLMSHLL	*	*	*	*	*	*	*
		513819-00	CARD, AFW4300CS INSERT CLMSHLL	*	*	*	*	*	*	*
		513834-00	CARD, USB2.0 A/B 6' CLMSHLL	*	*	*	*	*	*	*
		513903-00	CARD, AUA2000CS INSERT CLMSHLL	*	*	*	*	*	*	*
		513904-00	CARD, AUA5100CS INSERT CLMSHLL	*	*	*	*	*	*	*
		513906-03	GUIDE, AUA-1422 INSTALL HRD	*	*	*	*	*	*	*
		513907-00	SLV, AUA-1422 INTERNAL CLMSHEL	*	*	*	*	*	*	*

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		513908-03	GUIDE, ASH-1233CS v1.0 INSTALL	*	*	*	*	*	*	*
		513911-00	SLV, AUA-7500 KIT	*	*	*	*	*	*	*
		513912-03	GUIDE, AUA-7500 INSTL HRD	*	*	*	*	*	*	*
		513915-03	GUIDE, AFW-4300C INSTALL HRD	*	*	*	*	*	*	*
		513934-03	GUIDE, AUA-3020CS QUICK INSTAL	*	*	*	*	*	*	*
		513937-00	CARD, AUA3020CS INTRNL CLMSHLL	*	*	*	*	*	*	*
		513965-00	CARD, ASH-1205CS INSERT CLMSHL	*	*	*	*	*	*	*
		CDA-00050-01EU-A	CD ASSY, 3020/EU DVR v1.8/GD	*	*	*	*	*	*	*
		CDA-00053-01EU-A	CD ASSY, AFW-8300A/EU v1.1/GD	*	*	*	*	*	*	*
		MAN-00025-01-A	ERRATA, AUA-3020	*	*	*	*	*	*	*
		MAN-00025-01JA-A	ERRATA, AUA-3020/JA	*	*	*	*	*	*	*
		MAN-00098-01UN-A	CARD, AUA3020/UN PWR CBL	*	*	*	*	*	*	*
		MAN-00110-01-A	GUIDE, AFW-8300A INSTALL	*	*	*	*	*	*	*
		MAN-00110-01EU-A	GUIDE, AFW-8300A/EU INSTALL	*	*	*	*	*	*	*
		PAK-00187-01-A	TRAY, AUA-3020 UNVRSL CLMSHL	*	*	*	*	*	*	*
		PAK-00258-01-A	TRAY, AUA-2000C CLMSHL INSERT	*	*	*	*	*	*	*
		PAK-00259-01-A	TRAY, AUA-4000C CLMSHL INSERT	*	*	*	*	*	*	*
WIPB		1861400	USB-Xchange ADAPTER ASSEMBLY	*	*	*	*	*	*	*
		1861400-R	USB-Xchange RoHS ADAPTER ASSM	*	*	*	*	*	*	*
		1866600	CD ASSY, USB-Xchange v1.1	*	*	*	*	*	*	*
		1917906-00	PCA, AUA-5100	*	*	*	*	*	*	*
		1922206-00	PCA, AUH-4000	*	*	*	*	*	*	*
		1922206-01	PCA, AUH-7000	*	*	*	*	*	*	*
		1924600EU	CD ASSY, USB2CONN/EU DR&GD1.1	*	*	*	*	*	*	*
		1930306-00	PCA, AUA-2000LP	*	*	*	*	*	*	*
		1931000UN	CD ASSY, 4300/EFIGSJAS/W&GD1.2	*	*	*	*	*	*	*
		1940600	CD ASSY, 4300 DVPICSPLUS woDS	*	*	*	*	*	*	*
		1947100	CD ASSY, XHub4/4+/7+ v1.1 GD	*	*	*	*	*	*	*
		1947100EU	CD ASSY, XHub4/4+/7+/EU v1.2 GD	*	*	*	*	*	*	*
		1956300	CD ASSY, AUA-3121 DVR v1.1& GD	*	*	*	*	*	*	*
		1962400EU	CD ASSY, AHA-2930U/EU PD6.0/GD	*	*	*	*	*	*	*
		1966000	AUA-2000 USB ADAPTER/LE	*	*	*	*	*	*	*
		1969500	CD ASSY, 3100 USB2CONN v1.4/GD	*	*	*	*	*	*	*
		1979900	CD ASSY, AUH-4000BNDL v1.0/GD	*	*	*	*	*	*	*
		1984500	CD ASSY, XHUB4/4+/7+ v1.3/GD	*	*	*	*	*	*	*
		1984500JA	CD ASSY, XHub4/4+/7+/JAv1.3 GD	*	*	*	*	*	*	*
		1984500UK	CD ASSY, XHUB4/4+/7+v1.3/GD UK	*	*	*	*	*	*	*
		1986700	CD ASSY, AUH-4000BNDL v1.1/GD	*	*	*	*	*	*	*
		1989100-R	USB2-Xchange RoHS ADAPTER ASSM	*	*	*	*	*	*	*
		1989700	CD ASSY, USB2-Xchange v1.0/GD	*	*	*	*	*	*	*
		1989700JA	CD ASSY, USB2-XchnG/JA v1.0/GD	*	*	*	*	*	*	*
		1991800EU	CD ASSY, AUH4000BNDL/EUv1.2/GD	*	*	*	*	*	*	*
		1991800JA	CD ASSY, AUH4000BNDL/JAv1.2/GD	*	*	*	*	*	*	*
		2012006-00	PCA, AUA-5100B	*	*	*	*	*	*	*
		2012006-01	PCA, AUA-4000B	*	*	*	*	*	*	*
		2014406-50	PCA, ASH-1205SA	*	*	*	*	*	*	*
		2019706-00	PCA, AUA-3100B	*	*	*	*	*	*	*
		2019706-01	PCA, AUA-2000B	*	*	*	*	*	*	*
		2029400-R	AUA-5100B RoHS USB ADAPTER	*	*	*	*	*	*	*
		2030800	SCD, AUA-3020 HOST ADAPTER	*	*	*	*	*	*	*
		2030800-R	SCD, AUA-3020 RoHS HOST ADPTR	*	*	*	*	*	*	*
		2032100	AUA-1420A CARDBUS ADAPTER	*	*	*	*	*	*	*

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		2032100-R	AUA-1420A CARDBUS RoHS ADAPTER	*	*	*	*	*	*	*
		2033600	CD ASSY, USB2CONN v1.8 DRV/GD	*	*	*	*	*	*	*
		2033600EU	CD ASSY,USB2CONN/EU v1.8DRV/GD	*	*	*	*	*	*	*
		2033600JA	CD ASSY,USB2CONN/JA v1.8DRV/GD	*	*	*	*	*	*	*
		2035500	CD ASSY, AUA-1420A DVR v1.5 GD	*	*	*	*	*	*	*
		2035500EU	CD ASSY, 1420A/EU DVR v1.5 GD	*	*	*	*	*	*	*
		2035500JA	CD ASSY, 1420A/JA DVR v1.5 GD	*	*	*	*	*	*	*
		2035900	CD ASSY, 4100 DR/GD v1.1	*	*	*	*	*	*	*
		2035900EU	CD ASSY, 4100/EU DR/GD v1.1	*	*	*	*	*	*	*
		2035900JA	CD ASSY, 4100/JA DR/GD v1.1	*	*	*	*	*	*	*
		2039900	CD ASSY, 3020 10PK DVR v1.6/GD	*	*	*	*	*	*	*
		2042506-50	PCA, ASH-1205SA NEW FAB	*	*	*	*	*	*	*
		2043300-R	AUA-2000B USB RoHS ADAPTER	*	*	*	*	*	*	*
		2043500-R	AUA-3100B RoHS USB ADAPTER	*	*	*	*	*	*	*
		2052600	CD ASSY, ASH-1205SA v1.0	*	*	*	*	*	*	*
		2056900-R	ASH-1205SA NFAB RoHS HOST CTRLR	*	*	*	*	*	*	*
		2058000	AUA-1411 CARDBUS ADAPTER	*	*	*	*	*	*	*
		2080700	AFW-1430A CARDBUS ADAPTER	*	*	*	*	*	*	*
		2080700-R	AFW-1430A CARDBUS RoHS ADAPTER	*	*	*	*	*	*	*
		2101100	SCD, AFW-8300 HOST ADAPTER	*	*	*	*	*	*	*
		2102400	AFW-4300C 1394a PCI CARD	*	*	*	*	*	*	*
		2102400-R	AFW-4300C 1394a RoHS PCI CARD	*	*	*	*	*	*	*
		2128500	SCD, ASH-1233CS ATA/133 PCICRD	*	*	*	*	*	*	*
		2128500-R	SCD, ASH-1233CS RoHS PCI CARD	*	*	*	*	*	*	*
		2128900	AUA-1422 CARDBUS ADAPTER	*	*	*	*	*	*	*
		2128900-R	AUA-1422 CARDBUS RoHS ADAPTER	*	*	*	*	*	*	*
		2217400	SCD, AUA-3020A HOST ADAPTER	*	*	*	*	*	*	*
		2217400-R	SCD, AUA-3020A ROHS HOST ADPTR	*	*	*	*	*	*	*
		2217500	SCD, AFW-8300A HOST ADAPTER	*	*	*	*	*	*	*
		2217500-R	SCD, AFW-8300A RoHS HOST ADPTR	*	*	*	*	*	*	*
		2217600-R	SCD, AUA-2000C USB ADPTR RoHS	*	*	*	*	*	*	*
		2217700-R	SCD, AUA-4000C USB ADPTR RoHS	*	*	*	*	*	*	*
		MAN-00043-01-A	ERRATA, AUA-3020 4 PORT USB	*	*	*	*	*	*	*
		10138	HEADER, 16-PIN DIP	*	*	*	*	*	*	*
		11274	RES, CHIP 560 5% 1/8W 1206	*	*	*	*	*	*	*
		11466	TRANS, 2N3906(SOT) PNP GP	*	*	*	*	*	*	*
		11500	RES, CHIP 1K 1% 1/8W 1206	*	*	*	*	*	*	*
		11551	INSERT, 50PCK AHA-1540 (SCSI)	*	*	*	*	*	*	*
		11552	FOAM, TOP 50PCK AHA-1540(SCSI)	*	*	*	*	*	*	*
		11553	FOAM, BOT 50PCK AHA-1540(SCSI)	*	*	*	*	*	*	*
		11573	HEADER, 4-PIN SIP RA	*	*	*	*	*	*	*
		11597	RES, CHIP 2K 5% 1/8W 1206	*	*	*	*	*	*	*
		11632	CONN, DC POWER JACK RA PC MNT	*	*	*	*	*	*	*
		11699	IC, LM317(TO-220) ADJ VR +1.5A	*	*	*	*	*	*	*
		11703	SCREW, 4-40X1/4" PANHD PHHD	*	*	*	*	*	*	*
		11735	RES, CHIP 5.62K 1% 1/8W 1206	*	*	*	*	*	*	*
		11746	RES, CHIP 1.21K 1% 1/8W 1206	*	*	*	*	*	*	*
		11806	BAG, POLY 2 MIL 6X9 ZPLK CLR	*	*	*	*	*	*	*
		12076	BAG, 8" X 12" STATIC SHIELD	*	*	*	*	*	*	*
		12124	CLIP, FUSE PCB FOR 1/4"D FUSES	*	*	*	*	*	*	*
		12144	IC, AM26LS32(SO) QUAD LINE RCV	*	*	*	*	*	*	*
		12168	RES, CHIP 3.16K 1% 1/8W 1206	*	*	*	*	*	*	*

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		12256	SCREW, HEX JACK 4-40X3/16X5/16	*	*	*	*	*	*	*
		12448	OSC, XTAL TTL CLK 20MHZ SOJ 3S	*	*	*	*	*	*	*
		12558	IC, 74AC00(SO) QUAD 2-IN NAND	*	*	*	*	*	*	*
		12628	CAP, CHIP 5600PF 50V X7R 1206	*	*	*	*	*	*	*
		12695	XTAL,24.5760M LO-PRO P-RES 49S	*	*	*	*	*	*	*
		12759	CAP: 470PF 5% 50V NPO 0805	*	*	*	*	*	*	*
		12783	RES, CHIP 8.87K 1% 1/8W 1206	*	*	*	*	*	*	*
		12797	CAP, CHIP 470PF 50V X7R 0805	*	*	*	*	*	*	*
		12800	CAP, CHIP 4.7uF 20V TANT 6032	*	*	*	*	*	*	*
		12812	RES, CHIP 120K 5% 1/10W 0805	*	*	*	*	*	*	*
		12847	RES NTWK, 2.2K 14P DIP BUS SOG	*	*	*	*	*	*	*
		12861	CAP, CHIP .47uf 25V Z5U 1210	*	*	*	*	*	*	*
		12931	XTAL, 20MHZ 3X9mm P-RES TUBULR	*	*	*	*	*	*	*
		13015	RES, CHIP 113K 1% 1/10W 0805	*	*	*	*	*	*	*
		13016	RES, CHIP 150K 5% 1/10W 0805	*	*	*	*	*	*	*
		13018	RES, CHIP 324K 1% 1/10W 0805	*	*	*	*	*	*	*
		13079	IC, 24C08 8K SER EEPROM SO	*	*	*	*	*	*	*
		13083	XTAL, 24MHZ P-RES L-P SMD	*	*	*	*	*	*	*
		13125	RES, CHIP 169K 1% 1/10W 0805	*	*	*	*	*	*	*
		13143	CAP, CHIP 180PF 50V NPO 0805	*	*	*	*	*	*	*
		13175	IC, MAX3222(SSOP)3V RS232 XCVR	*	*	*	*	*	*	*
		13183	XTAL, 7.3728MHZ P-RES L-P SMD	*	*	*	*	*	*	*
		13214	SWITCH, 4-POS SPST DIP PIANO	*	*	*	*	*	*	*
		13313	IC, SCSI285 ACT TRM FIXED VREG	*	*	*	*	*	*	*
		13315	CONN, 68-PIN PCMCIA RECPT SMT	*	*	*	*	*	*	*
		13334	CAP, 100UF 10V 20%AL ELECT RAD	*	*	*	*	*	*	*
		13427	RES, CHIP 1.10K 1% 1/10W 0805	*	*	*	*	*	*	*
		13428	RES, CHIP 1.8K 5% 1/10W 0805	*	*	*	*	*	*	*
		13439	RES, CHIP 54.9 1% 1/10W 0805	*	*	*	*	*	*	*
		13499	CAP, CHIP 1.0UF 50V Y5U 1210	*	*	*	*	*	*	*
		13584	IC, GAL 16V8(PLCC) 25NS .5P	*	*	*	*	*	*	*
		13595	DIO, EC15QS02 1.1A 20V SB SMA	*	*	*	*	*	*	*
		13656	HEADER, 4 PIN RA 2.5MM	*	*	*	*	*	*	*
		13666	CONN, EDGE 68-PIN SMT TWO ROW	*	*	*	*	*	*	*
		13725	IND, CHIP 22UH 30% CLS62	*	*	*	*	*	*	*
		13739	CAP, CHIP .1UF 50V X7R 1206	*	*	*	*	*	*	*
		13795	CONN, 26-PIN I/O MALE SMT FHDT	*	*	*	*	*	*	*
		13834	XTAL, 40.00MHZ FUND 20PF 7550	*	*	*	*	*	*	*
		13873	DIODE, BAS216 SW HI SPD SOD	*	*	*	*	*	*	*
		13896	IC, UCC5606(SO)9 SCSI TERM REV	*	*	*	*	*	*	*
		13934	RES, CHIP 100K 5% 1/16W 0603	*	*	*	*	*	*	*
		14115	CAP, CHIP 20PF 50V NPO 0805	*	*	*	*	*	*	*
		14158	RES, CHIP 240 5% 1/10W 0805	*	*	*	*	*	*	*
		14177	TRANS, 2907A(SOT) PNP GP	*	*	*	*	*	*	*
		14203	CAP, 220UF 25V AL H12.5 RAD	*	*	*	*	*	*	*
		14306	RES, CHIP 18K 5% 1/10W 0805	*	*	*	*	*	*	*
		14327	RES, CHIP 150 5% 1/16W 0603	*	*	*	*	*	*	*
		14345	IC, LT1086(M) VR ADJ 1.5A	*	*	*	*	*	*	*
		14396	BRACKET, ISA DB25 2.6" SE LOGO	*	*	*	*	*	*	*
		14398	BRACKET, PCI DB25 2.6" SE LOGO	*	*	*	*	*	*	*
		14438	XTAL, 20MHZ P-RES 1.6H 8045	*	*	*	*	*	*	*
		14466	JACK, DC POWER RA 2.5mm DIA PN	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		14529	IC, 1233A-10 3.3RESET MNTR SOT	*	*	*	*	*	*	*
		14583	RES, CHIP 3.3K 5% 1/16W 0603	*	*	*	*	*	*	*
		14599	CAP: 33PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		14673	RES, CHIP 30.1 1% 1/16W 0603	*	*	*	*	*	*	*
		14741	RES, CHIP 1.0M 5% 1/16W 0603	*	*	*	*	*	*	*
		14743	RES, CHIP 3.6K 5% 1/16W 0603	*	*	*	*	*	*	*
		14753	RES, CHIP 390K 5% 1/16W 0603	*	*	*	*	*	*	*
		14811	RES, CHIP 28.7K 1% 1/16W 0603	*	*	*	*	*	*	*
		14824	CAP, CHIP 10UF 25V AL LZ535355	*	*	*	*	*	*	*
		14825	CAP, CHIP 22UF 16V AL LZ535355	*	*	*	*	*	*	*
		14833	RES, CHIP 22K 5% 1/16W 0603	*	*	*	*	*	*	*
		14871	IC, MAX1683 SW V DOUBLERS SOT	*	*	*	*	*	*	*
		14893	RES, CHIP .003 OHM 5% 1W 2512	*	*	*	*	*	*	*
		1490774-00	SCD, 1480X CASE W/LBL RECESS	*	*	*	*	*	*	*
		1490826-00	CABLE, IN 68P5CN 1.3M U160 TRM	*	*	*	*	*	*	*
		1491495-00	BOX, 21 1/4"X14 1/16"X8 3/4"	*	*	*	*	*	*	*
		1492056-00	SCD, CONVERTER 50HDF TO 50LDM	*	*	*	*	*	*	*
		14922	CAP, CHIP 10UF 6V TANT 3216	*	*	*	*	*	*	*
		1492233-00	BOX, 15 7/8"X 9 3/4"X 6 7/16"	*	*	*	*	*	*	*
		1492249-00	SCD, USB-Xchange CLAMSHHELL	*	*	*	*	*	*	*
		14923	IC, MAX809S UP RESET MNTR SOT	*	*	*	*	*	*	*
		1492428-00	BRACKET, LP FULL HT HD50 2.60	*	*	*	*	*	*	*
		1492440-00	BOX, 14 1/2"X 13 5/16"X 9 1/2"	*	*	*	*	*	*	*
		1492496-00	CABLE, IN 27" 3CN U160 TRM ICE	*	*	*	*	*	*	*
		1492605-00	BOX, 17 1/4" X12 5/8" X9 3/4"	*	*	*	*	*	*	*
		1493430-00	BOX, 18 9/16"X13 11/16"X7 7/8"	*	*	*	*	*	*	*
		1493442-00	BOX, 9" X 7" X 2 1/2" KIT	*	*	*	*	*	*	*
		1493655-00	SCD, CBL USB 4-4 10F	*	*	*	*	*	*	*
		1493788-00	SCD, CBL EX USB 2.0 A-B 6FT	*	*	*	*	*	*	*
		1493923-00	PLATE, AUH-4000 4 PORT CONN	*	*	*	*	*	*	*
		1493924-00	PLATE, AUH-7000 7 PORT CONN	*	*	*	*	*	*	*
		1493926-00	SHIELD, AUH-4000/7000 TOP	*	*	*	*	*	*	*
		1493927-00	HOUSING, AUH-4000/7000 TOP	*	*	*	*	*	*	*
		1493930-00	RAIL, AUH-4000/7000	*	*	*	*	*	*	*
		1493933-00	CLR COV, PIC FR, AUH-4000/7000	*	*	*	*	*	*	*
		1494022-00	SCD, CBL USB 2.0 6 FT	*	*	*	*	*	*	*
		1494051-00	SCD, ADPTR 5V/2.5A AC/DC SW US	*	*	*	*	*	*	*
		1494052-00UK	SCD, ADPTR 5V/2.5A AC/DC SW UK	*	*	*	*	*	*	*
		1494053-00EU	SCD, ADPTR 5V/2.5A AC/DC SW EU	*	*	*	*	*	*	*
		1494054-00AU	SCD, ADPTR 5V/2.5A AC/DC SW AU	*	*	*	*	*	*	*
		14941	CAP: 27PF 5% 50V NPO 0603	*	*	*	*	*	*	*
		1494125-00JA	SCD, ADPTR 5V/2.5A AC/DC SW JA	*	*	*	*	*	*	*
		1494132-00	BOX, USB HUB STANDARD	*	*	*	*	*	*	*
		1494147-00	BOX, MASTER USB HUB	*	*	*	*	*	*	*
		1494240-00	BAG, 6" X 8" BUBBLE	*	*	*	*	*	*	*
		1494374-00AU	SCD, ADPTR 5V/5A AC/DC SW AU	*	*	*	*	*	*	*
		1494375-00EU	SCD, ADPTR 5V/5A AC/DC SW EU	*	*	*	*	*	*	*
		1494376-00JA	SCD, ADPTR 5V/5A AC/DC SW JA	*	*	*	*	*	*	*
		1494377-00UK	SCD, ADPTR 5V/5A AC/DC SW UK	*	*	*	*	*	*	*
		1494378-00	SCD, ADPTR 5V/5A AC/DC SW US	*	*	*	*	*	*	*
		1494446-00	BRKT, AUA-2000/3100LP GROUND	*	*	*	*	*	*	*
		1494498-00	HOUSING ASSY, BOTTOM 4000/7000	*	*	*	*	*	*	*

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		1494499-00	HOUSING ASSY, TOP 4000/7000	*	*	*	*	*	*	*
		1494508-00	PAD,14 3/16" X 20 11/16" KRAFT	*	*	*	*	*	*	*
		1494575-00	INSERT, 12 PC MSTR BOX	*	*	*	*	*	*	*
		1494655-00	FOAM,14 5/8"X11 7/8"X1" HUBSTD	*	*	*	*	*	*	*
		1494833-00	BOX, MSTR 20.87"x14.72"x9.53"	*	*	*	*	*	*	*
		1495007-00	SCD, 1100 VIDEO CD USB DONGLE	*	*	*	*	*	*	*
		1495161-00	SCD, PWR SPLY ADPTR 5v 2.6A US	*	*	*	*	*	*	*
		1495161-00AU	SCD, PWR SPLY ADPTR 5v 2.6A AU	*	*	*	*	*	*	*
		1495161-00EU	SCD, PWR SPLY ADPTR 5v 2.6A EU	*	*	*	*	*	*	*
		1495161-00UK	SCD, PWR SPLY ADPTR 5v 2.6A UK	*	*	*	*	*	*	*
		1495244-00	SCD, CBL RCA PLUG 3/RCA PLUG 3	*	*	*	*	*	*	*
		1495247-00	SCD, CBL RCA PLUG 2/3.5MM PLUG	*	*	*	*	*	*	*
		1495401-00	BOX,17 23/32"X12 7/16"X10 5/32	*	*	*	*	*	*	*
		1495402-00	BOX, 9 1/4" X 6" X 1 1/2" KIT	*	*	*	*	*	*	*
		1495416-00	BOX, 22 1/8" X18 1/2" X 9 3/4"	*	*	*	*	*	*	*
		1495417-00	BOX, 10.5" X 9" X 3.25" KIT	*	*	*	*	*	*	*
		1495436-00	BOX, KIT 8.54"x 13.11"x 3.31"	*	*	*	*	*	*	*
		1495441-00	BOX,18 3/16"x13 15/16"x9 11/16	*	*	*	*	*	*	*
		1495443-00	BOX,AVC2000 8.54"x13.11"x3.31"	*	*	*	*	*	*	*
		1495451-00	LIGHTPIPE, AVC-2210/2310	*	*	*	*	*	*	*
		1495484-00	FOAM, 8 1/4" X5 1/2" ANTI-STAT	*	*	*	*	*	*	*
		1495574-00	BOX, 10" X 8" X 2 1/2"	*	*	*	*	*	*	*
		14956	5.6PF +/-0.25 PF 50V NPO 0805	*	*	*	*	*	*	*
		1495622-00	LBL, 45MM X 12MM MIRRORKOTE	*	*	*	*	*	*	*
		1495624-00	SCD, CBL USB WIRELESS 1 METER	*	*	*	*	*	*	*
		1495626-00	SHIELD, AVC-2210/2310	*	*	*	*	*	*	*
		1495661-00	SCD, XHUB 4/7 ADAPTER BOX	*	*	*	*	*	*	*
		1495697-00	SCD,8060 WIRELESS ACCESS POINT	*	*	*	*	*	*	*
		1495715-00	SCD, AWN POWER SUPPLY	*	*	*	*	*	*	*
		1495860-00	BOX, MYDVD MS 10"X 8" X 2 1/2"	*	*	*	*	*	*	*
		1495975-00	SCD, AWN-8084 ROUTER	*	*	*	*	*	*	*
		1495975-00EU	SCD, AWN-8084/EU ROUTER	*	*	*	*	*	*	*
		1495975-00FR	SCD, AWN-8084/FR ROUTER	*	*	*	*	*	*	*
		1495975-00SP	SCD, AWN-8084/SP ROUTER	*	*	*	*	*	*	*
		1496018-00	FRAME, AVC-2210	*	*	*	*	*	*	*
		1496019-00	FRAME, AVC-2310	*	*	*	*	*	*	*
		1496024-00	BUTTON, AVC-2210/2310	*	*	*	*	*	*	*
		1496224-00	BOX, 14.88" X 13.39"X 7.5"MSTR	*	*	*	*	*	*	*
		1496225-00	INSERT, 45" X 13"	*	*	*	*	*	*	*
		1496234-00	INSERT, 46" X 18"	*	*	*	*	*	*	*
		1496235-00	BOX, 18.386"X17.008"X7.205"	*	*	*	*	*	*	*
		1496310-00	SCD, CBL DC3.5 STEREO TO RCA6"	*	*	*	*	*	*	*
		1496352-00	SCD, ADPTR AD16-05 2.5A SW US	*	*	*	*	*	*	*
		1496352-00AU	SCD, ADPTR AD16-05 2.5A SW AU	*	*	*	*	*	*	*
		1496352-00EU	SCD, ADPTR AD16-05 2.5A SW EU	*	*	*	*	*	*	*
		1496352-00UK	SCD, ADPTR AD16-05 2.5A SW UK	*	*	*	*	*	*	*
		1496358-00	SCD, CBL INFRA RED 38KHZ 1.83M	*	*	*	*	*	*	*
		1496383-00	BOX, KIT 8.54"x13.11"x3.31"AVC	*	*	*	*	*	*	*
		1496399-00	BAG, CLR ANTI STATIC 5.5"X12"	*	*	*	*	*	*	*
		1496444-00	SCD, CABLE 1420A USB POWER 3FT	*	*	*	*	*	*	*
		1496446-00	BOX, 6.93" x 7.76" x 3.62" KIT	*	*	*	*	*	*	*
		1496447-00	BOX, 19.61" x14.76" x8.86"MSTR	*	*	*	*	*	*	*

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		1496504-00	BOX, 15.25" X 10.24" X 10" MSTR	*	*	*	*	*	*	*
		1496511-00	INSERT, 50.94" X 14.92" MSTR	*	*	*	*	*	*	*
		1496575-00	LBL BLNK, 2-IN-1	*	*	*	*	*	*	*
		1496581-00	SCD, CE C-TICK LOGO LABEL	*	*	*	*	*	*	*
		1496582-00	SCD, FCC LOGO LABEL	*	*	*	*	*	*	*
		1496583-00	SCD, VCCI LOGO LABEL	*	*	*	*	*	*	*
		1496584-00	SCD, CE VCCI FCC CTICK LOGOLBL	*	*	*	*	*	*	*
		1496783-00	INSERT, 29.02" X 19.45"	*	*	*	*	*	*	*
		1497146-00	TRAY,AUA1411/1420/AFW1430 CLAM	*	*	*	*	*	*	*
		1497262-00	SCD, RETAIL CABLE CLAMSHELL	*	*	*	*	*	*	*
		1497301-00	BRACKET, 1394 2-PORTS LP	*	*	*	*	*	*	*
		1497464-00	LABEL, BLANK 2"x .50" WHT POLY	*	*	*	*	*	*	*
		1497470-00	LABEL, BLNK 1.34"x.18"WHT POLY	*	*	*	*	*	*	*
		1497716-00	BOX, 13.46"x7.28"x4.53" KIT	*	*	*	*	*	*	*
		1497717-00	BAG, 10" X 8.5" BUBBLE A-S	*	*	*	*	*	*	*
		1497718-00	BOX,23.7" x 14.02" x 8.11"MSTR	*	*	*	*	*	*	*
		15229	RES, CHIP 390 5% 1/16W 0603	*	*	*	*	*	*	*
		15264	IC, 27C010 OTP ROM 120NS DIP32	*	*	*	*	*	*	*
		15409	OSC, CER SMD 66MHZ 3.3V 7550	*	*	*	*	*	*	*
		15415	CAP, CHIP 10UF 6.3V AL LE 7343	*	*	*	*	*	*	*
		15417	CAP, CHIP 10UF 10V X7R 1210	*	*	*	*	*	*	*
		15421	CONN, USB 4-PIN TYPE "B" PTH	*	*	*	*	*	*	*
		15437	IC, 64KX16 SRAM 15NS 5V TSOPII	*	*	*	*	*	*	*
		15452	RES, CHIP 13K 5% 1/16W 0603	*	*	*	*	*	*	*
		15498	SWITCH, SPST TACTILE 6MM SQ	*	*	*	*	*	*	*
		15510	CAP, CHIP 3300PF 50V X7R 0603	*	*	*	*	*	*	*
		15551	CONN, 68-P RA P-CONN NR440, HT	*	*	*	*	*	*	*
		15552	CONN, 50-P RA SCSI-2 4-40, HT	*	*	*	*	*	*	*
		15685	RES, CHIP 22 1% 1/16W 0603	*	*	*	*	*	*	*
		15798	HEADER, 50-P DIP RA SHD HT	*	*	*	*	*	*	*
		15845	XTAL, 30MHZ P-R 100PPM 49SM	*	*	*	*	*	*	*
		15847	CAP, CHIP 9PF 50V NPO 0603	*	*	*	*	*	*	*
		15848	CAP, CHIP 150UF 16V AL 636377	*	*	*	*	*	*	*
		15849	RES, CHIP 36.0 1% 1/10W 0805	*	*	*	*	*	*	*
		15850	RES, CHIP 9.1K 1% 1/10W 0805	*	*	*	*	*	*	*
		15853	CONN, USB 4-PIN RA TYPE A PTH	*	*	*	*	*	*	*
		15854	IC, MIC2027 QUAD USB PWR SW SO	*	*	*	*	*	*	*
		15855	IC, MIC2026 DUAL-CH PWR SW SO	*	*	*	*	*	*	*
		15861	SCREW, M2.5X4MM PNHD PHIL	*	*	*	*	*	*	*
		15888	CONN, USB 4P STD RA "A" PTH HT	*	*	*	*	*	*	*
		15932	CONN, 2X2 JUMPER 2.54MM PITCH	*	*	*	*	*	*	*
		15934	CONN, USB 4P UPRIGHT A PTH	*	*	*	*	*	*	*
		15947	RES, CHIP 15K 5% 1/16W 0603	*	*	*	*	*	*	*
		15948	RES, CHIP 36 1% 1/16W 0603	*	*	*	*	*	*	*
		15954	CAP, CHIP 390PF 50V NPO 0603	*	*	*	*	*	*	*
		15997	IC, 2026 DUAL USB PWR SW LO SO	*	*	*	*	*	*	*
		16013	XTAL, 30MHZ P-R 100PPM 49S PTH	*	*	*	*	*	*	*
		16022	SCREW, TFS M3X16MM PANHD PHIL	*	*	*	*	*	*	*
		16037	CAP:1800PF 10% 50V X7R 0603	*	*	*	*	*	*	*
		16049	RES, CHIP 1.24K 1% 1/16W 0603	*	*	*	*	*	*	*
		16051	HEADER, 2-PIN DIP RA HT	*	*	*	*	*	*	*
		16107	IC, 720110A USB2 HUB CNTR LQFP	*	*	*	*	*	*	*

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		16165	IC, X9C503(SO) 50K DIG POT	*	*	*	*	*	*	*
		16187	IND, CHIP 5.4UH 30% 1.6A SMT	*	*	*	*	*	*	*
		16196	CAP, CHIP 1UF 16V X7R 1206 10%	*	*	*	*	*	*	*
		16197	CAP, CHIP 22UF 10V TANT 3528	*	*	*	*	*	*	*
		16232	CAP, 220UF 16V AL H11 RAD	*	*	*	*	*	*	*
		16244	IC, LT1962 LDO VR 3.3V .3A MS8	*	*	*	*	*	*	*
		16259	RES, CHIP 240 5% 1/16W 0603	*	*	*	*	*	*	*
		16265	FILTER, EMI 50V .33A Z90 0805	*	*	*	*	*	*	*
		16280	CONN, USB 4P STD RA "A" PTH LT	*	*	*	*	*	*	*
		16365	CORD, AC PWR AUS-IEC BLK 1.8M	*	*	*	*	*	*	*
		16366	CORD, AC PWR US-IEC BLK 1.8M	*	*	*	*	*	*	*
		16367	CORD, AC PWR UK-IEC BLK 1.8M	*	*	*	*	*	*	*
		16368	CORD, AC PWR EURO-IEC BLK 1.8M	*	*	*	*	*	*	*
		16372	PWR SUPPLY, 5V 1.7A 100MMX58MM	*	*	*	*	*	*	*
		16374	IC, 720101 USB2 HOST CNTR LQFP	*	*	*	*	*	*	*
		16377	IC, DVXCEL MPEG VID ENCDR PQFP	*	*	*	*	*	*	*
		16392	IC, 7C68013 EZ-USB2.0 TQFP100	*	*	*	*	*	*	*
		16396	CONN, RCA RA YELLOW	*	*	*	*	*	*	*
		16397	CONN, RCA RA RED	*	*	*	*	*	*	*
		16398	CONN, RCA RA WHITE	*	*	*	*	*	*	*
		16399	CONN, MINI-DIN 4P RA	*	*	*	*	*	*	*
		16449	IC, MSP4448G SOUND PROC PMQFP	*	*	*	*	*	*	*
		16450	IC, DVXPLORE MPEG EN/DECDR BGA	*	*	*	*	*	*	*
		16455	IC, 78M05 VR 5V .5A DPAK	*	*	*	*	*	*	*
		16459	IC, 1117 LDO VR ADJ 1A DPAK	*	*	*	*	*	*	*
		16460	SWITCH, PWR SPST PUSH BTTN RA	*	*	*	*	*	*	*
		16466	MOD, TUNER FQ1236 NTSC F-CONN	*	*	*	*	*	*	*
		16471	IC, 1MX16 SDRAM 3.3V 6NS TSOP	*	*	*	*	*	*	*
		16480	IC, TPS40003 SYN BUCK REG MSOP	*	*	*	*	*	*	*
		16482	IC, LD29300 2.5V3A LDOVR P2PK5	*	*	*	*	*	*	*
		16488	IC, 29502 VR LDO ADJ 5A TO263	*	*	*	*	*	*	*
		16492	JACK, 5-PIN STEREO 3.5MM PTH	*	*	*	*	*	*	*
		16493	OSC, HCMOS CLK 27.5MHZ 3.3V HS	*	*	*	*	*	*	*
		16495	RES, CHIP 12K 5% 1/16W 0603	*	*	*	*	*	*	*
		16496	MOD, RCVR 7138 IR 38KHZ SIP3	*	*	*	*	*	*	*
		16500	CAP, CHIP 68UF 10V TA 7343LO	*	*	*	*	*	*	*
		16512	MOD, TUNER FQ1216ME PAL IEC	*	*	*	*	*	*	*
		16513	MOD, TUNER FQ1286 NTSC F-CONN	*	*	*	*	*	*	*
		16549	IC, SAA7115 VIDEO DECODER LQFP	*	*	*	*	*	*	*
		16550	IC, CX23416 MPEG ENCODER BGA	*	*	*	*	*	*	*
		16557	LED, ORG/GRN RA T1 CC RDL3	*	*	*	*	*	*	*
		16561	FERRITE, CHIP Z330 1.5A 0805	*	*	*	*	*	*	*
		16562	FERRITE, CHIP Z750 0.2A 0805	*	*	*	*	*	*	*
		16563	FERRITE, CHIP Z390 2A 1206	*	*	*	*	*	*	*
		16566	IC, 74LVC2G17 SCHTRIG BUF SC70	*	*	*	*	*	*	*
		16623	IC, MSP3415G SOUND PROC PMQFP	*	*	*	*	*	*	*
		16624	IC, MSP3425G SOUND PROC PMQFP	*	*	*	*	*	*	*
		16626	XTAL, 32.11MHZ P-R 30PPM HC49S	*	*	*	*	*	*	*
		16627	OSC, HCMOS 27MHZ 3.3V HS DIP	*	*	*	*	*	*	*
		16628	IC, 2MX32 SDRAM 6/7NS TSOP	*	*	*	*	*	*	*
		16636	IC, CS53L32A STEREO ADC TSSOP	*	*	*	*	*	*	*
		16637	RES, CHIP 27K 5% 1/16W 0603	*	*	*	*	*	*	*

* Confidential treatment requested

P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		16638	RES, MO 4.7 OHM 1W 5% AXIAL	*	*	*	*	*	*	*
		16639	FERRITE, CHIP Z120 3A 1206	*	*	*	*	*	*	*
		16640	IC, LT1930 DC/DC CNVRTR SO	*	*	*	*	*	*	*
		16650	JACK, 4-PIN STEREO 2.5MM PTH	*	*	*	*	*	*	*
		16651	IC, LTC1772B DC-DC CNTLR SOT23	*	*	*	*	*	*	*
		16666	SCREW, TFS M3X8MM PANHD PHIL	*	*	*	*	*	*	*
		16670	BATTERY, 2X 1.5V ZN-CL AA	*	*	*	*	*	*	*
		16689	IC, 74LVC1G00 2I NAND GATE SOT	*	*	*	*	*	*	*
		16690	CAP, 100UF 16V AL EL RAD 20%	*	*	*	*	*	*	*
		16696	CONN, RCA RA WHITE 10X11.5X19.5	*	*	*	*	*	*	*
		16697	CONN, RCA RA RED 10X11.5X19.5	*	*	*	*	*	*	*
		16698	CONN, RCA RA YELW 10X11.5X19.5	*	*	*	*	*	*	*
		16735	IC, 720112 USB2.0 CNTR TQFP80	*	*	*	*	*	*	*
		16744	IC, 720130 USB2.0 TO IDE TQFP	*	*	*	*	*	*	*
		16745	IC, TPS40051 SYN-B CNTR HTSSOP	*	*	*	*	*	*	*
		16754	RES, CHIP 510K 5% 1/16W 0805	*	*	*	*	*	*	*
		16755	RES, CHIP 2.43K 1% 1/16W 0603	*	*	*	*	*	*	*
		16757	RES, CHIP 1.5K 1% 1/16W 0603	*	*	*	*	*	*	*
		16758	RES, CHIP 39 1% 1/16W 0603	*	*	*	*	*	*	*
		16759	IND, 10UH 20% 5.4A SMT	*	*	*	*	*	*	*
		16761	RES, CHIP 3.3 5% 1/10W 0805	*	*	*	*	*	*	*
		16769	HEADER, 3A 2 PIN POLARIZE PTH	*	*	*	*	*	*	*
		16772	HEADER, 3A 4 PIN POLARIZE PTH	*	*	*	*	*	*	*
		16773	HEADER, 3A 6 PIN POLARIZE PTH	*	*	*	*	*	*	*
		16774	FILTER, EMI 6A Z600 PTH	*	*	*	*	*	*	*
		16781	IC, CD4013BC DUAL D-TYPE FF SO	*	*	*	*	*	*	*
		16786	CONN, 124P F RA MPC1 6.1H SM	*	*	*	*	*	*	*
		16787	IC, PCI16152 PCI BRDG 33MH TBGA	*	*	*	*	*	*	*
		16908	RES, CHIP 56.2 1% 1/16W 0603	*	*	*	*	*	*	*
		16909	DIO, SK14 1A 40V SCHTKY HSMB	*	*	*	*	*	*	*
		16912	HEADER, 9-PIN DIP RA SHROUDED	*	*	*	*	*	*	*
		16913	CAP, CHIP .1UF 50V X7R 0805	*	*	*	*	*	*	*
		16914	IC, CX25840 VIDEO DECODER TQFP	*	*	*	*	*	*	*
		16949	XTAL, 28.636MHZ P-R 30PPM 49S	*	*	*	*	*	*	*
		16950	RES, NTWK 100KX4 5% 3216	*	*	*	*	*	*	*
		16964	DIO, SK34 3A 40V SCHTKY SMC	*	*	*	*	*	*	*
		16972	CONN, TV ANT F-TYPE RA	*	*	*	*	*	*	*
		16973	CONN, TV ANT IEC-TYPE RA	*	*	*	*	*	*	*
		17023	IC, LM393 DUAL V CMPRTR SO	*	*	*	*	*	*	*
		17055	TRANS, XN04316 NPN/PNP MINI6	*	*	*	*	*	*	*
		17067	MOD, RCVR GP1UD281YK IR 38KHZ	*	*	*	*	*	*	*
		17068	TRANS, LTR-301 .225H PTH	*	*	*	*	*	*	*
		17071	RES, CHIP 18K 5% 1/16W 0603	*	*	*	*	*	*	*
		17072	RES, CHIP 1.8K 5% 1/16W 0603	*	*	*	*	*	*	*
		17073	IC, LT3467 DC-DC CONVTR TSOT23	*	*	*	*	*	*	*
		17075	IC, RN5VD30C VOLT DETECTOR SOT	*	*	*	*	*	*	*
		17076	IC, PDIUSB12 INTERFACE TSSOP	*	*	*	*	*	*	*
		17079	JACK, 10P STEREO 2X 3.5MM PTH	*	*	*	*	*	*	*
		17080	MOD, TUNER FM1216ME MK3	*	*	*	*	*	*	*
		17082	XTAL, 10MHZ P-R 50PPM 49S	*	*	*	*	*	*	*
		17083	XTAL, 6MHZ P-R 50PPM 49S	*	*	*	*	*	*	*
		17084	MOD, TUNER FM1236 MK3	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		17085	IC, LT1940L SWREG SD1.4A TSSOP	*	*	*	*	*	*	*
		17091	JACK, 3P STEREO 3.5MM PTH	*	*	*	*	*	*	*
		1895500	CD ASSY, 39160MAC/SRAID v1.0.2	*	*	*	*	*	*	*
		1895500EU	CD ASSY,39160MAC/SRAID/EU1.0.2	*	*	*	*	*	*	*
		2069000	CD ASSY, AVS-RECORD NOW v1.0	*	*	*	*	*	*	*
		2069100	CD ASSY, AVS-MYDVD SD v1.0	*	*	*	*	*	*	*
		490031-00	LABEL, PCA VERSION	*	*	*	*	*	*	*
		490303-00	LABEL, PCA REVISION "C"	*	*	*	*	*	*	*
		490308-00	LABEL, PCA REVISION "H"	*	*	*	*	*	*	*
		490991-36	LBL, .625"X2.18"(2 MILS THICK)	*	*	*	*	*	*	*
		490991-47	LABEL, 1.5" TMPR PRF CLR VOID	*	*	*	*	*	*	*
		491005-00	LABEL, PCA VERSION "-11"	*	*	*	*	*	*	*
		491006-00	LABEL, PCA VERSION "-12"	*	*	*	*	*	*	*
		493769-00	SCD, 1530P/COMPAQ MASTER BOX	*	*	*	*	*	*	*
		494046-00	TRAY, SOFTWARE PKG	*	*	*	*	*	*	*
		494047-00	INSERT, CD + DISK PKG	*	*	*	*	*	*	*
		494304-02	CABLE, 50PAMPCONN W/TERM FUJI	*	*	*	*	*	*	*
		494488-01	SCD, CBL PCMCIA 26P TO 50P 36"	*	*	*	*	*	*	*
		494488-02	SCD, CBL PCMCIA 26P TO 50P 18"	*	*	*	*	*	*	*
		494489-02	CABLE,PCMCIA26PSCSI2 36FUJITSU	*	*	*	*	*	*	*
		494604-00	SCD,JEWEL CASE 1460/80 CRD ASM	*	*	*	*	*	*	*
		494820-00	SCD, 1460A TOP&BOT w/INSL CVR	*	*	*	*	*	*	*
		495275-00	TRAY, 1460/1480A IN JEWEL CASE	*	*	*	*	*	*	*
		495981-00	BAG, 8" X 12" CLR POLYETHYLENE	*	*	*	*	*	*	*
		496911-00	BOX, 10" X 6.5" X 2.5" KIT	*	*	*	*	*	*	*
		497096-00	CABLE, APA-14XX/NEC	*	*	*	*	*	*	*
		498294-00	CABLE, PCMCIA 26P SCSI-2 18	*	*	*	*	*	*	*
		498294-01	CABLE, PCMCIA 26P SCSI-2 36	*	*	*	*	*	*	*
		498735-00	BAG, CLR ANTI STATIC 5.5"X10"	*	*	*	*	*	*	*
		498750-00JA	DISK, SLIMSCSI/JA UNINSTL 1.1J	*	*	*	*	*	*	*
		499203-00	SCD,APA-14XX CASE W/LBL RECESS	*	*	*	*	*	*	*
		499937-00JA	DISK, 1480X/JA SETUP v1.22J	*	*	*	*	*	*	*
		512307-00	LBL, C-TICK 7786 EPSON	*	*	*	*	*	*	*
		512308-00	LBL, EMI EPSON	*	*	*	*	*	*	*
		512428-03	GUIDE, 29160N MAC INSTALL HRD	*	*	*	*	*	*	*
		512483-00	FLYER, 29160N MAC CABLE PROMO	*	*	*	*	*	*	*
		512556-00JA	LBL, WIND 2000 DRVR/JA	*	*	*	*	*	*	*
		512572-00	CARD, 39160 MAC README FIRST	*	*	*	*	*	*	*
		512634-00JA	CD POUCH, ADAPTEC FMS/JA v4.0	*	*	*	*	*	*	*
		512909-00JA	ERRATA, AJL TECH SUPRT NUMBER	*	*	*	*	*	*	*
		513047-03EU	GUIDE, 2906/EU MAC/PC INSTLHRD	*	*	*	*	*	*	*
		513137-00JA	LBL, USB/JA CONTROL INCLUDED	*	*	*	*	*	*	*
		513342-03	GUIDE, MYDVD VIDEO SUITE QKST	*	*	*	*	*	*	*
		513381-00ENFR	SLV, AVS-MYDVD MS/ENFR v4	*	*	*	*	*	*	*
		513381-00GE	SLV, AVS-MYDVD MS/GE v4	*	*	*	*	*	*	*
		513381-00ITSP	SLV, AVS-MYDVD MS/ITSP v4	*	*	*	*	*	*	*
		513381-00UK	SLV, AVS-MYDVD MS/UK v4	*	*	*	*	*	*	*
		513416-03	GUIDE, MYDVD MEDIA SUITE QKST	*	*	*	*	*	*	*
		513416-03EU	GUIDE, MYDVD MS/EU QKSTR	*	*	*	*	*	*	*
		513631-00	CARD, AVC REMOTE CNTRL QCK REF	*	*	*	*	*	*	*
		513631-00FR	CARD, AVC/FR REMOTECNTRL QKREF	*	*	*	*	*	*	*
		513631-00GE	CARD, AVC/GE REMOTECNTRL QKREF	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		513631-00IT	CARD, AVC/IT REMOTECNTRL QKREF	*	*	*	*	*	*	*
		513631-00JA	CARD, AVC/JA REMOTECNTRLQCKREF	*	*	*	*	*	*	*
		513631-00SP	CARD, AVC/SP REMOTECNTRL QKREF	*	*	*	*	*	*	*
		513631-00UK	CARD, AVC/UK REMOTECNTRL QKREF	*	*	*	*	*	*	*
		513650-00	ERRATA, AVC-2310/2410	*	*	*	*	*	*	*
		513650-00EU	ERRATA, AVC-2310-2410/EU	*	*	*	*	*	*	*
		513652-00	LABEL, AVC REMOVE DEVICE	*	*	*	*	*	*	*
		513652-00ENFR	LABEL, AVC REMOVE DEVICE/ENFR	*	*	*	*	*	*	*
		513652-00GE	LABEL, AVC REMOVE DEVICE/GE	*	*	*	*	*	*	*
		513652-00ITSP	LABEL, AVC REMOVE DEVICE/ITSP	*	*	*	*	*	*	*
		513680-03	GUIDE, AVS-MYDVD SD QK START	*	*	*	*	*	*	*
		513683-00	SLV, AVS-MYDVD SD KIT	*	*	*	*	*	*	*
		513685-00	SLV, AVS-RECORD NOW KIT	*	*	*	*	*	*	*
		513733-00	CARD, ACK-1411 PWR WARNING	*	*	*	*	*	*	*
		513734-00	LBL, PROP 65 WARNING	*	*	*	*	*	*	*
		513886-03NK	GUIDE, 2210/NK WIN/XP-00`QK ST	*	*	*	*	*	*	*
		513892-03	GUIDE, 2010 WIN/XP-00 QK START	*	*	*	*	*	*	*
		513892-03NK	GUIDE, 2010/NK WIN/XP-00 QK ST	*	*	*	*	*	*	*
		513905-00	CARD, ASH1233CS INSERT CLMSHLL	*	*	*	*	*	*	*
		ICS-00248-01-A	CX25840-24 VIDEO DECODER TQFP	*	*	*	*	*	*	*
		TMP-1021	CAP, 10UF 450V AL D12.5L20 RDL	*	*	*	*	*	*	*
		TMP-1022	CAP, 1000UF6.3V AL D8L11.5 RDL	*	*	*	*	*	*	*
		TMP-1023	XFMR, FLYBCK 110VDC>5V1.5A 10P	*	*	*	*	*	*	*
		TMP-1025	RES, CHIP 162 1% 1/10W 0805	*	*	*	*	*	*	*
		TMP-1030	IC, MIC39150-1.8 LDO1.5A TO220	*	*	*	*	*	*	*
		TMP-1031	CAP, 470UF6.3V AL D6.3L11.2RDL	*	*	*	*	*	*	*
		V1012	CAP, CHIP 15PF 50V NPO 0603	*	*	*	*	*	*	*
		V1013	CAP, CHIP 47PF 50V COG 0603	*	*	*	*	*	*	*
		V1016	CAP, CHIP .1UF 25V Y5V 0603	*	*	*	*	*	*	*
		V1069	RES, CHIP 1K 1% 1/16W 0603	*	*	*	*	*	*	*
		V1070	RES, CHIP 10K 1% 1/16W 0603	*	*	*	*	*	*	*
		V1071	RES, CHIP 100K 1% 1/16W 0603	*	*	*	*	*	*	*
		V1074	RES, CHIP 10 5% 1/10W 0805	*	*	*	*	*	*	*
		V1080	RES, CHIP 5.1K 5% 1/10W 0805	*	*	*	*	*	*	*
		V1117	FERRITE, CHIP Z1000 0.2A 0805	*	*	*	*	*	*	*
		V1134	RES, CHIP 75 5% 1/10W 0805	*	*	*	*	*	*	*
		V1150	CAP, CHIP 10UF 10V TANT 3528	*	*	*	*	*	*	*
		V1155	CAP, CHIP 1000PF 50V X7R 0603	*	*	*	*	*	*	*
		V1177	RES, CHIP 200 1% 1/16W 0603	*	*	*	*	*	*	*
		V1178	CAP, CHIP .01UF 50V Y5V 0603	*	*	*	*	*	*	*
		V1199	RES, CHIP 1M 1% 1/16W 0603	*	*	*	*	*	*	*
		V1280	RES, CHIP 51.1 1% 1/16W 0603	*	*	*	*	*	*	*
		V1388	RES, CHIP 499 1% 1/10W 0805	*	*	*	*	*	*	*
		V1390	RES, CHIP 1K 1% 1/10W 0805	*	*	*	*	*	*	*
		V1419	FUSE, 1A 63V FAST ACT 1206	*	*	*	*	*	*	*
		V1439	RES, CHIP 2.21K 1% 1/16W 0603	*	*	*	*	*	*	*
		V1459	IC, 74AHC1G08 2I/P AND GATE SO	*	*	*	*	*	*	*
		V1470	IC, 74LCX74 DUAL D-FF SO	*	*	*	*	*	*	*
		V1623	LED, RED DIFFUSED T-1 PTH	*	*	*	*	*	*	*
		V1624	LED, GRN DIFFUSED T-1 PTH	*	*	*	*	*	*	*
		V1641	RES, CHIP 24.9K 1% 1/10W 0805	*	*	*	*	*	*	*
		V1676	FERRITE, CHIP Z120 0.3A 0805	*	*	*	*	*	*	*

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P.C.	Clas	Material #	Description	*	*	*	*	*	*	*
		V1736	RES, CHIP 49.9K 1% 1/16W 0603	*	*	*	*	*	*	*
		V1807	RES, CHIP 3.32K 1% 1/10W 0805	*	*	*	*	*	*	*
		V1848	CAP, .01UF 250VAC Y5V CER RAD	*	*	*	*	*	*	*
		V1855	CAP, CHIP 560PF 50V NPO 0805	*	*	*	*	*	*	*
		V1860	DIODE, ES1A 1A 50V RECT SMA	*	*	*	*	*	*	*
		V1861	CAP, 100UF 6.3V 20% AL EL AMD	*	*	*	*	*	*	*
		V1924	RES, CHIP 24 1% 1/16W 0603	*	*	*	*	*	*	*
		V1988	IND, 22MH 250VAC CM PTH	*	*	*	*	*	*	*
		V1989	FERRITE, CHIP Z100 3A 1206	*	*	*	*	*	*	*
		V2007	CONN, MALE AC POWER INLET 2 CO	*	*	*	*	*	*	*
		V2010	XFMR, HOMEPLUG 1.0 1CT:1CT SMD	*	*	*	*	*	*	*
		V2023	IC, 80225 100TX/10 PHY 3V PLCC	*	*	*	*	*	*	*
		V2025	CAP, .1UF 250VAC 20% CER RAD	*	*	*	*	*	*	*
		V2085	XTAL, 30MHZ 25PPM HC49U	*	*	*	*	*	*	*
		V2192	RES, CHIP 2M 5% 1/2W 2010	*	*	*	*	*	*	*
		V2195	RES, CHIP 200K 5% 1/2W 2010	*	*	*	*	*	*	*
		V2196	IC, LTV-817 1X OPCPLR SMD4	*	*	*	*	*	*	*
		V2203	IND, 100UH 0.52A 10% AXIAL	*	*	*	*	*	*	*
		V2243	IC, 45DB011B SPI FLSH 1M SOIC	*	*	*	*	*	*	*
		V2263	SWITCH, SPST SMD 6.0 X 6.0	*	*	*	*	*	*	*
		V2270	IC, TNY266 LO PWR SWITCHER DIP	*	*	*	*	*	*	*
		V2273	CAP, CHIP 270PF 50V NPO 0805	*	*	*	*	*	*	*
		V2274	CAP, CHIP 220PF 50V NPO 0805	*	*	*	*	*	*	*
		V2275	IND, CHIP 5.6UH 5% 0.12A 1008	*	*	*	*	*	*	*
		V2276	IND, CHIP 6.8UH 5% 0.115A 1008	*	*	*	*	*	*	*
		V2289	CONN, RJ45 MOD JACK W/XFMR 8P	*	*	*	*	*	*	*
		V2293	IND, 4UH +40%/-20% 1.63A SMT	*	*	*	*	*	*	*
		V2294	DIO, DL4006 800V 1A RECT MELF	*	*	*	*	*	*	*
	WIPB	1495471-00	ASSY, AVC-2X10 PANEL/FOOTER	*	*	*	*	*	*	*
		1495472-00	ASSY, AVC-2X10 BEZEL/LIGHPIPE	*	*	*	*	*	*	*
		1496415-00	ASSY, AVC-2210/2310 STAND/FOOT	*	*	*	*	*	*	*
		1862000	CD ASSY, 39160 MAC v1.0.1	*	*	*	*	*	*	*
		1862000EU	CD ASSY, 39160 MAC/EU v1.0.1	*	*	*	*	*	*	*
		1863200JA	CD ASSY, 39160 MAC/JA v1.0.2J	*	*	*	*	*	*	*
		1973600	SCD, 4300A LP UNIV HOST ADPTR	*	*	*	*	*	*	*
		2017800	SCD, 8020 USB CD ASSY v1.0 DB	*	*	*	*	*	*	*
		2017900	SCD, 8030 PC CRD HOST ADAPTR	*	*	*	*	*	*	*
		2018000	SCD, 8030 PCCRD CDASSY v1.0 DB	*	*	*	*	*	*	*
		2018300	SCD, AWN-8084 RTR CDASSY v1.0	*	*	*	*	*	*	*
		2030500	SCD, 8060 WAP CD ASSY v1.0	*	*	*	*	*	*	*
		2054400-00	MCNTR, AVC-2410 8-BIT	*	*	*	*	*	*	*
499	RAWB	14370	BAT, LI/MNO2 CR2032 3V .21AH	*	*	*	*	*	*	*
		15697	SWITCH, SPST SMD 6.8X6.4	*	*	*	*	*	*	*
		15787	IC, LT1764 LD VR 2.5V 3A DDPK	*	*	*	*	*	*	*
						*		*		

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EXHIBIT C
ADAPTEC FURNISHED EQUIPMENT/CONSIGNED COMPONENTS

Listing of Adaptec-Consigned Equipment (Custom Board)

CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008232	1060	60000343	0	Window Prodtest for PCI Express	ACE#2003/2466	08/09/2005	HY GOH	0	*	*	*
6008232	1060	60000344	0	2D IMGR:MULTI,NEAR FOCUS,CR BLACK,Scan	ACE#2003/2474	10/26/2005	HY GOH	0	*	*	*
6008211	1030	30000503	0	274X ICT FIXTURE	180-95-T455	12/15/1994	KHIMSOON	5	*	*	*
6008211	1010	10000704	0	AHA 2940 PNEUMATIC T/FIXTURE	181-96-M424	08/15/1995	CTLIAU	2	*	*	*
6008211	1010	10001739	0	AHA 2940AUW #2 ICT AUTO FIXTURE	ACE#99/1907	04/20/1999	MENG WHY	5	*	*	*
6008211	1010	10001935	0	AHA 2940U2W ICT FIXTURE# – Venture	ACE#2000/2022	11/29/1999	KYGOH	5	*	*	*
6008211	1010	10000663	0	AHA-1030P ICT FIXTURE	181-96-M398	08/15/1995	MENG WHY	2	*	*	*
6008211	1010	10001025	0	AHA1030PFT04	181-97-M583	07/15/1996	CTLIAU	2	*	*	*
6008211	1010	10000651	0	AHA-154XCP FUNCTIONAL TESTER	181-96-M383	07/15/1995	CTLIAU	2	*	*	*
6008211	1010	10001622	0	AHA-2904 for in-line auto test fixture	ACE#98/1766	05/21/1998	BENSIM	5	*	*	*
6008211	1010	10001394	0	AHA2930BCTFUNCTIONALTEST1	181-98-M832	07/15/1997	KHSEAH	5	*	*	*
6008211	1010	10001321	0	AHA-2940AU FT JIG	181-98-M800B	06/15/1997	CT LIAN	5	*	*	*
6008211	1010	10001323	0	AHA-2940AU FT JIG	181-98-M800C	06/15/1997	BENSIM	5	*	*	*
6008211	1010	10000927	0	AHA-2940AU PNEUMATIC TESTER	181-96-M524	03/15/1996	CTLIAU	2	*	*	*
6008211	1010	10001087	0	AHA-2940U FIXTURE KIT USED	181-97-M628	10/15/1996	MENG WHY	2	*	*	*
6008211	1010	10000736	0	AHA-2940U ICT GENRAD FIXTURE	181-96-M432	10/15/1995	MENG WHY	2	*	*	*
6008211	1010	10001166	0	AHA-2940UW FT JIG	181-97-M681A	11/15/1996	BENSIM	5	*	*	*
6008211	1010	10001787	0	AHA-2940UW ICT FIXTURE– #1 TO #4	ACE#2000/1955	07/28/1999	MENG WHY	5	*	*	*
6008211	1010	10000843	0	AHA-2940UWFT1	181-96-M482	12/15/1995	CTLIAU	2	*	*	*
6008211	1010	10001716	0	AHA-29XXC ICT #3 AUTO FIXTURE	ACE#99/1875	03/30/1999	MENG WHY	5	*	*	*
6008211	1010	10000865	0	AHA-3940 UWDPI CHOP-TOP	181-96-M495	02/15/1996	KHSEAH	2	*	*	*
6008211	1010	10001259	0	AHA3940AUWD GENRAD TEST FIXTUR	181-97-M769	04/15/1997	MENG WHY	5	*	*	*
6008211	1010	10000977	0	AHA-3940U FUNCTIONAL TESTER	181-97-M556	04/15/1996	CTLIAU	2	*	*	*
6008211	1010	10000976	0	AHA-3940UW FUNCTIONAL TESTER	181-97-M555	04/15/1996	CTLIAU	2	*	*	*
6008211	1010	10001261	0	AHA-3944AUWD GENRAD TEST FIXTU	181-97-M770	04/15/1997	MENG WHY	5	*	*	*
6008211	1010	10000934	0	AHA-3944UWDPI PNEUMATIC TESTER	181-96-M531	03/15/1996	CTLIAU	2	*	*	*

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6008211	1010	10001370	0	AHA8940 CHOP-TOP TESTER	181-97-M745	04/15/1997	CTLIAU	2	*	*	*
6008211	1010	10000998	0	APA+1425/50/50A/60AFT2	181-97-M570	06/15/1996	CTLIAU	2	*	*	*
6008211	1010	10000997	0	APA-1425/50/50A/60AFT3	181-97-M569	06/15/1996	CTLIAU	2	*	*	*
6008211	1010	10001453	0	ARO-1130B ICT TEST FIXTURE	ACE#98/1619	10/28/1997	MENG WHY	5	*	*	*
6008211	1010	10000695	0	CHOPTOPTESTER(AHA-3940FT3)	181-96-M418	08/15/1995	KHSEAH	2	*	*	*
6008211	1010	10001700	1	CONVERT AHA-2940U2W ICT #4AUTO F.ACCEL TO AUTO KIT	ACE#99/1852	07/28/1999	MENG WHY	5	*	*	*
6008211	1010	10000804	0	FABRICATE TABLE WHITE	181-96-M464B	12/15/1995	KYGOH	2	*	*	*
6008211	1010	10000822	0	FABRICATE WHITE TABLE	181-96-M467C	01/15/1996	KYGOH	2	*	*	*
6008211	1010	10001032	0	FIX-PHILIP HANDLER AHA2940UW	181-97-M587	08/15/1996	BENSIM	2	*	*	*
6008211	1010	10001194	0	FIXTURE KIT AHA 2940UW	181-97-M691	01/15/1997	BENSIM	5	*	*	*
6008211	1010	10001195	0	FIXTURE KIT AHA 2940UW	181-97-M691A	01/15/1997	BENSIM	5	*	*	*
6008211	1010	10001438	0	FT FIXTURE APA1480	181-97-M756	04/15/1997	CTLIAU	2	*	*	*
6008211	1010	10001386	0	FUNCTIONAL JIG	181-98-M827	07/15/1997	KYGOH	5	*	*	*
6008211	1010	10001396	0	FUNCTIONAL JIG	181-98-M833	07/15/1997	KYGOH	5	*	*	*
6008211	1010	10001036	0	FUNCTIONAL TESTER FIXTURE	181-97-M590	08/15/1996	BENSIM	5	*	*	*
6008211	1010	10001037	0	FUNCTIONAL TESTER FIXTURE	181-97-M590A	08/15/1996	BENSIM	5	*	*	*
6008211	1010	10000170	0	GENRAD APA 1425/50/60B ICT TEST FIXTURE	ACE#98/1576	03/30/1998	MENG WHY	5	*	*	*
6008211	1010	10001156	0	GENRAD FIXTURE FOR AHA-3940UW	181-97-M672	11/15/1996	MENG WHY	5	*	*	*
6008211	1010	10001056	0	GENRAD ICT FIX AHA 2944UW	181-97-M600	08/15/1996	MENG WHY	5	*	*	*
6008211	1010	10001273	0	GENRAD ICT FIX.-ANA6911A REVE	181-97-M723	01/04/1997	MENG WHY	2	*	*	*
6008211	1010	10001270	0	GENRAD ICT FIX.-AVA1505 AF/AI	181-97-M722	01/04/1997	MENG WHY	2	*	*	*
6008211	1010	10001255	0	GENRAD ICT FIXTURE - APA-1480	181-97-M719	01/04/1997	MENG WHY	2	*	*	*
6008211	1010	10001275	0	GENRAD ICT FIXTURE - AVA-2904	181-97-M724	01/04/1997	MENG WHY	2	*	*	*
6008211	1010	10001091	0	GENRAD ICT FIXTURE AHA-2930B	181-97-M631	08/15/1996	MENG WHY	2	*	*	*
6008211	1010	10001340	0	GENRAD ICT FIXTURE AHA-8940	181-98-M812	06/15/1997	MENG WHY	5	*	*	*
6008211	1010	10001299	0	GENRAD ICT FIXTURE ANA-5945	181-98-M788	06/15/1997	MENG WHY	5	*	*	*
6008211	1010	10001333	0	GENRAD ICT FIXTURE ANA-6911A	181-98-M808	06/15/1997	MENG WHY	5	*	*	*
6008211	1010	10001420	0	GENRAD ICT FIXTURE APA1480A	181-98-M846	07/15/1997	MENG WHY	5	*	*	*
6008211	1010	10001268	0	GENRAD ICT FIXTURE AVA-2902E/1	181-97-M773	04/15/1997	MENG WHY	5	*	*	*

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								#	*	*	*
6008211	1010	10001267	0	GENRAD ICT FIXTURE FOR AAA-131	181-97-M721	01/04/1997	MENG WHY	2	*	*	*
6008211	1010	10001213	0	GENRAD ICT FIXTURE FOR APA1460A (Rev E)	181-97-M706	02/15/1997	MENG WHY	2	*	*	*
6008211	1010	10001277	0	GENRAD ICT FIXTURE-AHA-3940 AU	181-97-M725	01/04/1997	MENG WHY	2	*	*	*
6008211	1010	10000872	0	GR ICT FIXTURE (AHA-3940UWDPI)	181-96-M498	02/15/1996	MENG WHY	2	*	*	*
6008211	1010	10000939	0	GR ICT FIXTURE AHA 2940AU	181-96-M536	03/15/1996	MENG WHY	2	*	*	*
6008211	1010	10000936	0	GR ICT FIXTURE AHA-3944 UWD	181-96-M533	03/15/1996	MENG WHY	2	*	*	*
6008211	1010	10000956	0	GR ICT FIXTURE APA-1425/50/60	181-97-M542	04/15/1996	MENG WHY	2	*	*	*
6008211	1010	10000871	0	GR ICT FIXTURE-AHA 1510/20/22B	181-96-M497	02/15/1996	MENG WHY	2	*	*	*
6008211	1010	10001162	0	GR ICT PHILIP FIXTURE KIT	181-97-M678	11/15/1996	MENG WHY	5	*	*	*
6008211	1010	10001183	0	GR228X PHILIPS FIXTURE	181-97-M685A	01/15/1997	MENG WHY	2	*	*	*
6008211	1010	10001382	0	ICT FIX AHA 3940AUW	181-97-M748	04/15/1997	KHIMSOON	2	*	*	*
6008211	1010	10001033	0	ICT FIX-NEW FAB AHA1510B/20B	181-97-M588	08/15/1996	MENG WHY	2	*	*	*
6008211	1010	10001034	0	ICT FIX-OLD FAB AHA1510B	181-97-M588A	08/15/1996	MENG WHY	2	*	*	*
6008211	1030	30000238	0	ICT TEST FIXTURE	180-94-T288	04/15/1993	KHIMSOON	5	*	*	*
6008211	1030	30000259	0	ICT VACUUM FIXTURE	180-94-T306	06/15/1993	KHIMSOON	5	*	*	*
6008211	1030	30000260	0	ICT VACUUM FIXTURE	180-94-T307	06/15/1993	KHIMSOON	5	*	*	*
6008211	1010	10001103	0	INTEL PENTIUM-AHA-1510/20/22B	181-97-M635B	10/15/1996	KYGOH	2	*	*	*
6008211	1010	10000780	0	ISA BUS FAULT BOARD	181-96-M449C	02/15/1996	CTLIAU	1	*	*	*
6008211	1010	10001375	0	ISA TOP ACCESS /FIXTURE INTER	181-98-M824	07/15/1997	KYGOH	5	*	*	*
6008211	1010	10002418	2	Naka Liquid Control 1-Component Dispenser	ACE#2003/2437	06/30/2005	WONGCHEE	5	*	*	*
6008211	1010	10002040	1	Nesting Module for AFC9110G	ACE#2001/2127	01/02/2001	WD TENG	5	*	*	*
6008211	1010	10002040	4	Nesting Module for ASC2916N	ACE#2001/2127	01/02/2001	WD TENG	5	*	*	*
6008211	1010	10002040	3	Nesting Module for ASR21008	ACE#2001/2127	01/02/2001	WD TENG	5	*	*	*
6008211	1010	10002040	2	Nesting Module for AVA2915	ACE#2001/2127	01/02/2001	WD TENG	5	*	*	*
6008211	1010	10000653	0	POWER SUPPLY-AHA154XCP TESTER	181-96-M383B	07/15/1995	CTLIAU	2	*	*	*
6008211	1010	10001120	0	REMOVABLE FIX-AHA2940/2940U	181-97-M648	11/15/1996	MENG WHY	5	*	*	*
6008212	1010	10000162	0	GENARD ICT FIXTURE FOR ANA-6922	ACE#98/1578	03/12/1997	MENG WHY	5	*	*	*
6008212	1010	10000163	0	GENRAD ICT FIXTURE FOR AHA-2940	ACE#98/1594	03/12/1997	MENG WHY	5	*	*	*
6008212	1010	10000823	0	FABRICATION OF CHOPTOP FIXTURE	181-96-M467D	03/15/1996	HY GOH	1	*	*	*

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6008212	1010	10001001	0	AHA152XB PCBA FLAT TOP FT	181-97-M572	06/15/1996	HY GOH	2	*	*	*
6008212	1010	10001459	0	FABRICATE APA-1460A/B PCMCIA PNEUMATIC F.TESTER#1	ACE#98/1632	03/11/1997	CTLIAU	5	*	*	*
6008212	1010	10001459	1	SEAGATE ULTRA HDISK APA-1460B PNEUMATIC F.TESTER#1	ACE#98/1632	01/10/1997	CTLIAU	5	*	*	*
6008212	1010	10001460	0	FABRICATE APA-1460A/B PCMCIA PNEUMATIC F.TESTER#2	ACE#98/1632	03/11/1997	CTLIAU	5	*	*	*
6008212	1010	10001460	1	SEAGATE ULTRA HDISK APA-1460B PNEUMATIC F.TESTER#2	ACE#98/1632	01/10/1997	CTLIAU	5	*	*	*
6008212	1010	10001461	0	FABRICATE APA-1460A/B PCMCIA PNEUMATIC F.TESTER#3	ACE#98/1632	03/11/1997	CTLIAU	5	*	*	*
6008212	1010	10001461	1	SEAGATE ULTRA HDISK APA-1460B PNEUMATIC F.TESTER#3	ACE#98/1632	01/10/1997	CTLIAU	5	*	*	*
6008212	1010	10001462	0	DATABOOK PCMCIA CARD READER	ACE#98/1632	12/14/1997	CTLIAU	5	*	*	*
6008212	1010	10001470	0	AHA-29XXC GENRAD TEST FIXTURE	ACE#98/1657	11/16/1997	MENG WHY	5	*	*	*
6008212	1010	10001471	0	GENRAD ICT FIXTURE FOR ANA-6944	ACE#98/1658	11/16/1997	MENG WHY	5	*	*	*
6008212	1010	10001483	0	GENRAD ICT FIXTURE AHA-8945CP	ACE#98/1673	02/22/1998	MENG WHY	5	*	*	*
6008212	1010	10001485	0	AVA-2902E/I/ICT AUTO FIXTURE	ACE#98/1676	04/15/1998	MENG WHY	5	*	*	*
6008212	1010	10001486	0	AHA 2910C/15C/20C/30C/30C MAC ICT AUTO FIXTURE	ACE#98/1675	04/15/1998	MENG WHY	5	*	*	*
6008212	1010	10001516	0	AHA-2940U2W ICT AUTO FIXTURE#2	ACE#98/1711	01/22/1998	MENG WHY	5	*	*	*
6008212	1010	10001518	1	Fabricate Choptop test fixture for AHA8940 #2	ACE#98/1712	03/23/1998	CT LIAU	5	*	*	*
6008212	1010	10001518	2	Fabricate Choptop test fixture for AHA8940 #3	ACE#98/1712	03/23/1998	CT LIAU	5	*	*	*
6008212	1010	10001518	3	Fabricate Choptop test fixture for AHA8940 #4	ACE#98/1712	03/23/1998	CT LIAU	5	*	*	*
6008212	1010	10001518	4	Fabricate Spare Sliding Top-plate for AHA-8945CP#1	ACE#98/1712	03/23/1998	CT LIAU	5	*	*	*
6008212	1010	10001518	5	Fabricate Spare Sliding Top-plate for AHA-8945CP#2	ACE#98/1712	03/23/1998	CT LIAU	5	*	*	*
6008212	1010	10001518	6	Fabricate Spare Sliding Top-plate for AHA-8945CP#3	ACE#98/1712	03/23/1998	CT LIAU	5	*	*	*
6008212	1010	10001518	7	Fabricate Spare Sliding Top-plate for AHA-8945CP#4	ACE#98/1712	03/23/1998	CT LIAU	5	*	*	*
6008212	1010	10001547	0	GENRAD APA-1450/60B ICT FIXTURE	ACE#98/1727	02/03/1998	MENG WHY	5	*	*	*

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6008212	1010	10001563	0	ANA-6911A/AUI FUNCTIONAL TESTER	ACE#98/1504	04/03/1998	CTLIAU	2	*	*	*
6008212	1010	10001564	0	ANA-6911 FUNCTIONAL TESTER	ACE#98/1504	04/03/1998	CTLIAU	2	*	*	*
6008212	1010	10001569	0	ANA-5945 CHOPTOP FUNCTIONAL TESTER	ACE#97/1538	04/03/1998	CTLIAU	2	*	*	*
6008212	1010	10001571	0	AHA-1425/50/50A PNEUMATIC FUNCTIONAL TESTER	ACE#98/	04/03/1998	CTLIAU	2	*	*	*
6008212	1010	10001573	0	AHA-2944UW PNEUMATIC FUNCTIONAL TESTER	ACE#97/1316	04/03/1998	CTLIAU	2	*	*	*
6008212	1010	10001581	0	AHA-2940U2W ICT GENRAD FIXTURE	ACE#98/1736	03/25/1998	MENG WHY	5	*	*	*
6008212	1010	10001589	0	GENRAD ICT FIXTURE ARO1130C	ACE#98/1748	03/30/1998	MENG WHY	5	*	*	*
6008212	1010	10001595	0	SEAGATE 2GBULTRA WIDE SCSI HD/1DE 2.1GB HD	ACE#98/1751	03/30/1998	CT LIAU	5	*	*	*
6008212	1010	10001596	0	SPARE PART FOR 8940		03/25/1998	CTLIAU	5	*	*	*
6008212	1010	10001605	0	AHA-2940UWI IN-LINE FIXTURE KIT #1		03/25/1998	BENSIM	2	*	*	*
6008212	1010	10001606	0	AHA-2940UWI IN-LINE FIXTURE KIT #2		03/25/1998	BENSIM	2	*	*	*
6008212	1010	10001609	0	AHA-3940AUWD PNEUMATIC FUNCTIONAL TESTER		03/25/1998	CT LIAU	2	*	*	*
6008212	1010	10001611	0	AHA-3944UWD PNEUMATIC FUNCTIONAL TESTER		03/25/1998	CT LIAU	2	*	*	*
6008212	1010	10001616	0	TO IMPROVE CURRENT CHOP-TOP TESTERS	ACE#98/1608	03/30/1998	CTLIAU	5	*	*	*
6008212	1010	10001618	0	TO FABRICATE AHA-2940UW PHILIPS IN-LINE UNV.FIXTUR	ACE#98/1762	04/16/1998	KENNY	5	*	*	*
6008212	1010	10001626	0	AHA-2940UW ICT MANUAL FIXTURE (#5)	ACE#99/1781	07/19/1998	MENG WHY	5	*	*	*
6008212	1010	10001629	0	AHA-2940UW DUAL PNEUMATIC FUNCTIONAL TESTER	ACE#97/1536/37	09/24/1998	CTLIAU	5	*	*	*
6008212	1010	10001631	0	AHA-2940U2W DESKTOP TESTER #2	ACE#98/1639	09/24/1998	CTLIAU	5	*	*	*
6008212	1010	10001632	0	AHA-2940U2W DESKTOP TESTER #3	ACE#98/1639/48	09/24/1998	CTLIAU	5	*	*	*
6008212	1010	10001633	0	AHA-2940U2W IN-LINE FIXTURE KIT #1	ACE#98/1639	09/24/1998	BENSIM	5	*	*	*
6008212	1010	10001634	0	AHA-2940U2W IN-LINE FIXTURE KIT #2	ACE#98/1639	09/24/1998	BENSIM	5	*	*	*
6008212	1010	10001637	0	ARO-1130B CHOPTOP FUNCTIONAL TESTER	ACE#98/1639	07/08/1997	CTLIAU	5	*	*	*
6008212	1010	10001640	0	ANA-69011 ICT TEST FIXTURE & EQUIPMENTS	ACE#99/1788	06/29/1998	MENG WHY	5	*	*	*

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6008212	1010	10001641	0	GENRAD ICT FIXTURE FOR ANA-62011	ACE#99/1787	06/29/1998	MENG WHY	5	*	*	*
6008212	1010	10001642	0	ANA-62022 ICT TEST FIXTURE & EQUIPMENT	ACE#99/1786	06/29/1998	MENG WHY	5	*	*	*
6008212	1010	10001643	0	GENRAD ICT FIXTURE FOR AHA-2940U2B	ACE#99/1790	08/31/1998	MENG WHY	5	*	*	*
6008212	1010	10001644	0	EMPTY UPPER PLATE	ACE#99/1789	06/07/1998	BEN SIN	5	*	*	*
6008212	1010	10001645	0	AAA-131B ICT TEST FIXTURE	ACE#99/1791	06/07/1998	MENG WHY	5	*	*	*
6008212	1010	10001646	0	AHA-3950U2B ICT TEST FIXTURE & EQUIPMENT	ACE#99/1792	06/29/1998	MENG WHY	5	*	*	*
6008212	1010	10001647	0	GENRAD ICT FIXTURE FOR AHA-2950U2W	ACE#99/1793	06/29/1998	MENG WHY	5	*	*	*
6008212	1010	10001649	0	AHA-2940U2 ICT TEST FIXTURE & EQUIPMENT	ACE#99/1795	06/29/1998	MENG WHY	5	*	*	*
6008212	1010	10001655	0	GENRAD ICT FIXTURE FOR AHA 2930UW	ACE#99/1809	09/22/1998	MENG WHY	5	*	*	*
6008212	1010	10001657	0	GENRAD ICT FIXTURE FOR AAC-9000 (TABASCO)	ACE#99/1811	09/22/1998	KHIMSOON	5	*	*	*
6008212	1010	10001658	0	GENRAD ICT FIXTURE FOR AAC-364 (JALAPENO)#1	ACE#99/1812	09/22/1998	MENG WHY	5	*	*	*
6008212	1010	10001660	0	FABRICATE DESKTOP FIXTURE FOR AHA-8940	ACE#99/1817	01/09/1998	CT LIAU	5	*	*	*
6008212	1010	10001662	0	GENRAD ICT FIXTURE FOR ANA 62044	ACE#99/1816	09/22/1998	MENG WHY	5	*	*	*
6008212	1010	10001663	0	GENRAD ICT FIXTURE FOR AAA-132/133B	ACE#99/1818	03/30/1999	MENG WHY	5	*	*	*
6008212	1010	10001665	0	GENRAD ICT FIXTURE FOR APA 8440	ACE#99/1821	09/22/1998	MENG WHY	5	*	*	*
6008212	1010	10001665	1	MODIFICATION FOR APA 8440 CONNECTOR TEST	ACE#99/1821	09/24/1998	MENG WHY	5	*	*	*
6008212	1010	10001670	1	INTEL PENTIUM SYSTEM UNIT	ACE#99/1826	02/09/1998	BENJAMIN	5	*	*	*
6008212	1010	10001670	0	FABRICATE IN-LINE UNIVERSAL PROBE BOARDS 2940UW	ACE#99/1826	08/31/1998	BENJAMIN	5	*	*	*
6008212	1010	10001671	0	GENRAD ICT FIXTURE FOR AAA-131CH	ACE#99/1827	09/22/1998	MENG WHY	5	*	*	*
6008212	1010	10001682	0	AHA-2910B INLINE FIXTURE KIT	ACE#98/1759	10/29/1998	CTLIAU	2	*	*	*
6008212	1010	10001683	0	AHA2930B-IN-LINE FIXTURE KIT	ACE#99/1759	10/29/1998	CTLIAU	2	*	*	*
6008212	1010	10001691	0	NEW DOCKING STATION EQUIP FOR FUNCTION #8	ACE#98/1681	10/29/1998	CTLIAU	2	*	*	*
6008212	1010	10001693	0	AAC-364 ICT FIXTURE #2	ACE#99/1843	01/21/1999	MENG WHY	2	*	*	*

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6008212	1010	10001693	1	AAC-364 ICT FIXTURE #2-MODIFICATION	ACE#2000/2005	01/21/1999	MENG WHY	2	*	*	*
6008212	1010	10001704	0	MODIFICATION FOR AHA3940UW	ACE#99/1861	01/14/1999	CTLIAU	2	*	*	*
6008212	1010	10001706	7	AHA-2910C & AHA-2906 JIG	ACE#99/1860	10/03/2000	FRANKIE	5	*	*	*
6008212	1010	10001720	0	ONE AHA2930C PHILIPS IN-LINE UNIVERSAL FIXTURE	ACE#99/1879	10/02/1999	BENSIM	2	*	*	*
6008212	1010	10001721	0	AVA-2904 ICT #2 AUTO FIXTURE	ACE#99/1880	01/03/1999	MENG WHY	5	*	*	*
6008212	1010	10001722	0	AVA-2906 ICT#2 AUTO FIXTURE	ACE#99/1881	01/03/1999	MENG WHY	5	*	*	*
6008212	1010	10001728	0	NEW JALAPENO AAC-364 FUNCTIONAL TESTER	ACE#99/1893	02/03/1999	WILFRED	2	*	*	*
6008212	1010	10001729	1	Z4000 B/C PRINTER	ACE#99/1891	07/04/1999	PPCHEW	5	*	*	*
6008212	1010	10001734	0	NEW JALAPENO & TOBASCO FUNCTIONAL TESTER	ACE#99/1898	03/17/1999	HUEYCHIN	2	*	*	*
6008212	1010	10001749	0	FABRICATE UNIVERSAL FCT FIXTURE-AHA2910C TOOTSIE	ACE#99/1909	04/13/1999	BEN SIM	5	*	*	*
6008212	1010	10001750	0	AHA-2940U2W IN LINE FIXTURE #1-JIG#41	ACE#	03/30/1999	BENSIN	2	*	*	*
6008212	1010	10001751	0	AHA-2940U2W IN LINE FIXTURE #2-JIG#42	ACE#	03/30/1999	BENSIN	2	*	*	*
6008212	1010	10001752	0	AHA-2940U2B IN LINE FIXTURE #1-JIG#35	ACE#	03/30/1999	BENSIN	2	*	*	*
6008212	1010	10001753	0	AHA-2940U2B- JIG#38	ACE#9	03/30/1999	BENSIN	2	*	*	*
6008212	1010	10001758	0	AHA-2940UW/DUAL IN LINE FIXTURE #2-JIG#20	ACE#	03/30/1999	BENSIM	2	*	*	*
6008212	1010	10001759	0	AHA-6944A CHOPTOP TESTER PCI CT#24	ACE	03/30/1999	CTLIAU	2	*	*	*
6008212	1010	10001760	0	AHA-2940U/DUAL IN LINE FIXTURE #1-JIG#11	ACE	03/30/1999	BENSIM	2	*	*	*
6008212	1010	10001762	0	AVA-2903/2906 IN LINE FIXTURE #2-JIG#45	ACE#	03/30/1999	BENSIM	2	*	*	*
6008212	1010	10001766	0	FABRICATION OF AHA-2906 JIG FOR IN-LINE USE-JIG50	ACE#2000/1913	04/13/1999	BENSIN	5	*	*	*
6008212	1010	10001769	0	AVA-2906 ICT#3 MANUAL FIXTURE	ACE#2000/1918	04/27/1999	MENG WHY	5	*	*	*
6008212	1010	10001772	0	AVA-2902E/1#3 ICT TEST FIXTURE	ACE#2000/1922	04/27/1999	MENG WHY	5	*	*	*
6008212	1010	10001798	0	ANA-62011 - DESKTOP TESTER #2-PCI CT #49	ACE#98/1670	03/08/1999	CTLIAU	5	*	*	*

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CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008212	1010	10001799	0	ANA-62011 DESKTOP TESTER #3-PCI CT #54	ACE#98/1670	03/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001800	0	ANA-62044 DESKTOP TESTER #2-PCI CT #65	ACE#98/1750/25	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001802	0	ANA-69011 DESKTOP TESTER #2-PCI CT #50	ACE98/1769/1573	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001803	0	ANA-69011 DESKTOP TESTER #3-PCI CT#51	ACE98/1769/1573	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001804	0	ANA-62022 DESKTOP TESTER #2-PCI CT #62	ACE98/1752/1638	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001806	0	AHA-6944A CHOPTOP TESTER-PCI CT #40	ACE#98/1616	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001807	0	TOOTSIE-AHA-2910C/15C/20C/30C MAC DESKTOPTESTER#2	ACE98/1633/1689	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001809	0	TOOTSIE-AHA-2910C/15C/20C/30C MAC IN LINE FIXTURE	ACE98/1633/1689	04/08/1999	BENSIM	5	*	*	*
6008212	1010	10001812	0	AAA-131B DESKTOP TESTER #2-PCI CT #44	ACE#98/1718	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001814	0	AAA-132B/133B DESKTOP TESTER #2-PCI CT#48	ACE#98/1719	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001817	0	AHA-2940U2B IN-LINE FIXTURE #2	ACE#98/1692	04/08/1999	BENSIN	5	*	*	*
6008212	1010	10001818	0	AHA-2940U2 DESKTOP TESTER#2-PCI CT#46	ACE#99/1772	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001819	0	AHA-3950U2B DESKTOP TESTER #2-PCI CT #47	ACE#99/1771	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001820	0	AHA-3950U2B – DESKTOP TESTER #3-PCI CT#55	ACE#99/1779	03/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001822	0	AHA-2950U2B IN-LINE FIXTURE #1	ACE#99/1804	04/08/1999	BENSIN	5	*	*	*
6008212	1010	10001823	0	DESKTOP TESTER #2 – AAA-131CH-PCI CT #69	ACE#99/1775	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001824	0	AAA-131CH DESKTOP TESTER #3-PCI CT #113	ACE#99/1775	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001825	0	DESKTOP TESTER#3 – ANA-62020FX-PCI CT #80	ACE#99/1784	04/08/1999	CTLIAU	5	*	*	*
6008212	1010	10001834	0	GENRAD ICT FIXTURE FOR AHA-3960D	ACE#2000/1989	08/19/1999	CHINCHIN	5	*	*	*
6008212	1010	10001841	0	AVA-2906 IN-LINE FIXTURE #1	ACE#99/1887	09/21/1999	BENSIM	2	*	*	*
6008212	1010	10001842	0	AVA-2906 – DESKTOP TESTER #1	ACE#2000/1925	09/21/1999	CTLIAU	5	*	*	*

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6008212	1010	10001843	0	AVA-2906 DESKTOP TESTER #2	ACE#2000/1925	09/21/1999	CTLIAU	5	*	*	*
6008212	1010	10001844	0	AHA-2940UW PRO INLINE FIXTURE #1	ACE#99/1867	09/21/1999	BENSIM	5	*	*	*
6008212	1010	10001845	0	AAA-132U2/133U2- DESKTOP TESTER #2	ACE#98/1756	09/21/1999	CTLIAU	5	*	*	*
6008212	1010	10001847	0	AAA-131U2 DESKTOP TESTER #2	ACE#99/1855	09/21/1999	CTLIAU	5	*	*	*
6008212	1010	10001854	0	JALAPENO DESKTOP TESTER #7	ACE#98/1764	09/21/1999	CTLIAU	5	*	*	*
6008212	1010	10001854	1	JALAPENO DESKTOP TESTER #7	ACE#2000/2077	01/30/2001	CTLIAU	5	*	*	*
6008212	1010	10001904	0	DESKTOP TESTER #1	ACE#98/1768	09/30/1999	CTLIAU	5	*	*	*
6008212	1010	10001907	0	PHASE 3 ICT TEST FIXTURES CAP EXPRESS MODIFICATION	ACE#2000/2005	11/26/1999	MENG WHY	2	*	*	*
6008212	1010	10001910	0	ASC-29160N ICT FIXTURE #01	ACE#2000/2011	01/11/1999	MENG WHY	5	*	*	*
6008212	1010	10001911	0	ASC-29160N ICT FIXTURE #02	ACE#2000/2011	11/26/1999	MENG WHY	5	*	*	*
6008212	1010	10001912	0	ASC-29160N ICT FIXTURE #03	ACE#2000/2011	11/26/1999	MENG WHY	5	*	*	*
6008212	1010	10001913	1	ACCESSORIES-SUPPORTING PILOT BUILD OF AAA-UDMA	ACE#2000/2012	10/27/1999	KHIMSOON	5	*	*	*
6008212	1010	10001917	0	APA-1480B ICT TEST FIXTURE#1 - Omni	ACE#2000/2017	03/28/2000	MENG WHY	2	*	*	*
6008212	1010	10001926	0	JALAPENO SYSTEM TEST - DESKTOP TESTER #8	ACE#2000/1896	02/11/1999	CTLIAU	2	*	*	*
6008212	1010	10001926	1	JALAPENO SYSTEM TEST - DESKTOP TESTER #8	ACE#2000/2077	01/30/2001	CTLIAU	2	*	*	*
6008212	1010	10001927	0	JALAPENO SYSTEM TEST DESKTOP TESTER #9	ACE#2000/1896	02/11/1999	CTLIAU	2	*	*	*
6008212	1010	10001927	1	JALAPENO SYSTEM TEST DESKTOP TESTER #9	ACE#2000/2077	01/30/2001	CTLIAU	2	*	*	*
6008212	1010	10001929	1	JALAPENO SYSTEM TEST DESKTOP TESTER #11	ACE#2000/2077	01/30/2001	CTLIAU	2	*	*	*
6008212	1010	10001931	1	JALAPENO SYSTEM TEST DESKTOP TESTER #13	ACE#2000/2077	01/30/2001	CTLIAU	2	*	*	*
6008212	1010	10001932	1	JALAPENO SYSTEM TEST DESKTOP TESTER #14	ACE#2000/2077	01/30/2001	CTLIAU	2	*	*	*
6008212	1010	10001933	1	JALAPENO SYSTEM TEST DESKTOP TESTER #15	ACE#2000/2077	01/30/2001	CTLIAU	2	*	*	*
6008212	1010	10001934	0	ASC 29160 ICT TEST FIXTURE	ACE#2000/2019	11/29/1999	MENG WHY	5	*	*	*
6008212	1010	10001938	0	AAC-2622 SL2 ICT GENRAD FIXTURE	ACE#2000/2027	02/20/2000	MENG WHY	5	*	*	*

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CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008212	1010	10001939	0	AAC-9000MD#2 ICT GENRAD FIXTURE	ACE#2000/2028	02/20/2000	MENG WHY	5	*	*	*
6008212	1010	10001941	0	AAC-364#1 ICT TEST FIXTURE	ACE#2000/2030	12/22/1999	MENG WHY	5	*	*	*
6008212	1010	10001952	0	ASC-29160 #2 ICT GENRAD FIXTURE AUTO	ACE#2000/2033	04/01/2000	MENG WHY	5	*	*	*
6008212	1010	10001972	0	ASC 29160 #03-ICT FIXTURE AUTO	ACE#2000/2054	02/16/2000	MENG WHY	5	*	*	*
6008212	1010	10001975	0	AHA-3960D #2 ICT FIXTURE	ACE#2000/2057	02/05/2000	MENG WHY	5	*	*	*
6008212	1010	10001982	0	DESKTOP TESTER #2 – AHA2950U2D	ACE#99/1844	02/03/2000	CTLIAU	5	*	*	*
6008212	1010	10001983	0	ICT GENRAD SYSTEM FIXTURE FOR AAA-UDMA	ACE#2000/2065	03/28/2000	CHINCHIN	5	*	*	*
6008212	1010	10001983	1	ITEMS SUPPORT TO SUPPORT AAA-UDMA	ACE#2000/2065	03/15/2000	CHINCHIN	5	*	*	*
6008212	1010	10001984	0	AAC-9001MD ICT TEST FIXTURE	ACE#2000/2065	06/03/2000	CHINCHIN	5	*	*	*
6008212	1010	10001984	1	ITEMS TO SUPPORT BUILD AAC-9001MD ICT TEST FIXTURE	ACE#2000/2065	03/15/2000	CHINCHIN	5	*	*	*
6008212	1010	10001985	0	ICT FIXTURE AAC-3642 (PILOT)	ACE#2000/2067	06/03/2000	SIM SY	5	*	*	*
6008212	1010	10001985	1	ITEMS TO SUPPORT PROD. FIXTURE AAC-3642 (PILOT)	ACE#2000/2067	03/15/2000	CHINCHIN	5	*	*	*
6008212	1010	10001990	0	JIG – AHA-2910C/AHA-2940AV/AVA-2906	ACE#2000/1994	10/03/2000	FRANKIE	5	*	*	*
6008212	1010	10002002	0	GENRAD ICT FIXTURE FOR AHA64044	ACE#2000/2071	03/21/2000	CHINCHIN	5	*	*	*
6008212	1010	10002003	0	ASC-29160 #4 ICT Auto Fixtures	ACE#2000/2073	06/14/2000	KHIMSOON	5	*	*	*
6008212	1010	10002004	0	ASC-29160N#4 ICT Auto Fixture	ACE#2000/2074	02/05/2000	CHINCHIN	5	*	*	*
6008212	1010	10002008	0	GENRAD ICT FIXTURE FOR ASC29160LP	ACE#2000/2076	03/26/2000	CHINCHIN	5	*	*	*
6008212	1010	10002009	0	Hebnao Diagn/Debug & test dev. tools for MPC8240	ACE#2000/2075	12/21/2000	SHASHI	5	*	*	*
6008212	1010	10002019	0	ASC-29160LP #2 ICT FIXTURE	ACE#2001/2087	04/06/2000	KHIMSOON	5	*	*	*
6008212	1010	10002039	0	Genrad ICT Fixture for AVA2915/30LP Fab B	ACE#2001/2121	10/18/2000	CHINCHIN	5	*	*	*
6008212	1010	10002051	0	Autoline PCI Bridge Rev C	ACE#2001/2136	08/05/2001	HY GOH	2	*	*	*
6008212	1010	10002051	3	Standard Desktop base,UTC Backplane support/cables	ACE#2001/2136	06/18/2001	HY GOH	2	*	*	*
6008212	1010	10002051	5	UTC Controller,Power/S, Back plane,Fault Injection	ACE#2001/2136	05/04/2001	HY GOH	2	*	*	*

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CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008212	1010	10002051	6	Quantum Atlas V9.1G Ultra2,SCSI SCA-2,9"Monitor,KB	ACE#2001/2136	08/02/2001	HY GOH	2	*	*	*
6008212	1010	10002054	0	ICT Fixture (Auto) AVA2915/30LP	ACE#2001/2143	08/05/2001	KEN NG	5	*	*	*
6008212	1010	10002055	0	ASC-29160N – In-line jig #1 (PCI JIG#53)	ACE#2000/1969	01/29/2001	NG HC	2	*	*	*
6008212	1010	10002055	1	ASC-29160N – In-line jig #2 (PCI JIG#57)	ACE#2000/1969	01/29/2001	NG HC	2	*	*	*
6008212	1010	10002055	2	ASC-29160N Desktop Tester #2 (PCI CT#122)	ACE#2000/1969	01/29/2001	NG HC	2	*	*	*
6008212	1010	10002056	0	AAA-114UDMA Desktop tester#2	ACE#2000/1978	01/29/2001	NG HC	2	*	*	*
6008212	1010	10002057	0	AAA-114UDMA Desktop Tester #3	ACE#2000/1978	01/29/2001	NG HC	2	*	*	*
6008212	1010	10002061	0	ASC-29160LP Desktop Tester #2 (PCI CT#126)	ACE#2000/2060	01/30/2001	NG HC	2	*	*	*
6008212	1010	10002062	0	ASC-29160LP In-Line jig #2 (PCI JIG #61)	ACE#2000/2060	01/30/2001	NG HC	2	*	*	*
6008212	1010	10002063	0	ASC-29160LP In-Line jig #1 (PCI JIG #60)	ACE#2000/2060	01/30/2001	NG HC	2	*	*	*
6008212	1010	10002073	0	Test station		07/26/2001	H Y GOH	1	*	*	*
6008212	1010	10002074	0	Test Station		07/26/2001	H Y GOH	0	*	*	*
6008212	1010	10002075	0	Test Station		07/26/2001	H Y GOH	1	*	*	*
6008212	1010	10002076	0	Test Station		07/26/2001	H Y GOH	1	*	*	*
6008212	1010	10002077	0	CPCI Test station		07/26/2001	H Y GOH	1	*	*	*
6008212	1010	10002080	0	Functional Tester for AUALP (PCI Desktop 148)	ACE#2001/2139	11/30/2001	H Y GOH	2	*	*	*
6008212	1010	10002081	0	Functional Tester for AUALP (PCI Desktop 150)	ACE#2001/2139	11/30/2001	H Y GOH	2	*	*	*
6008212	1010	10002082	0	Functional Tester AUAH4000/7000 (PCI Desktop 165)	ACE#2002/2152	11/30/2001	H Y GOH	2	*	*	*
6008212	1010	10002084	0	Functional Tester For AUA5100 (PCI Desktop 154)	ACE#2001/2150	11/30/2001	H Y GOH	2	*	*	*
6008212	1010	10002085	0	Functional Tester for AUA5100 (PCI Desktop 169)	ACE#2001/2150	11/30/2001	H Y GOH	2	*	*	*
6008212	1010	10002089	0	Genrad ICT Fixture for ASC39320D	ACE#2002/2176	01/23/2002	KEN NG	5	*	*	*
6008212	1010	10002090	0	Functional Tester for Hornet PCI #49	ACE#2001/2138	01/22/2002	H Y GOH	2	*	*	*
6008212	1010	10002090	1	Spare parts – Functional Tester for Hornet PCI #49	ACE#2001/2138	03/26/2002	H Y GOH	2	*	*	*
6008212	1010	10002091	0	Functional Tester For Hornet PCI #50	ACE#2001/2138	01/22/2002	H Y GOH	2	*	*	*

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CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008212	1010	10002091	1	Spare parts – Functional Tester For Hornet PCI #50	ACE#2001/2138	03/27/2002	H Y GOH	2	*	*	*
6008212	1010	10002092	0	Functional Tester for AFC9210 PCI CT#151	ACE#2001/2113	01/22/2002	H Y GOH	2	*	*	*
6008212	1010	10002093	0	Functional Tester for California Roll PCI CT#145	ACE#2001/2108	01/23/2002	H Y GOH	2	*	*	*
6008212	1010	10002094	0	Functional Tester for Pimento PCI #45	ACE#2001/2111	01/23/2002	H Y GOH	2	*	*	*
6008212	1010	10002094	1	Spare parts for Functional Tester for Pimento PCI #45	ACE#2001/2112	03/27/2002	H Y GOH	2	*	*	*
6008212	1010	10002095	0	Functional Tester for Pimento PCI #46	ACE#2001/2111	01/23/2002	H Y GOH	2	*	*	*
6008212	1010	10002095	1	Spare parts functional Tester for Pimento PCI #46	ACE#2001/2112	03/27/2002	H Y GOH	2	*	*	*
6008212	1010	10002096	0	Functional Tester for Pimento PCI #47	ACE#2001/2111	01/23/2002	H Y GOH	2	*	*	*
6008212	1010	10002096	1	Spare parts Functional Tester for Pimento PCI #47	ACE#2001/2112	03/27/2002	H Y GOH	2	*	*	*
6008212	1010	10002097	0	Functional Tester for AFC9110 PCT CT#139	ACE#2001/2094	01/23/2002	H Y GOH	2	*	*	*
6008212	1010	10002104	0	Prodstest stn & spare for PCI CT 172	ACE#2001/2114	03/26/2002	HY GOH	1	*	*	*
6008212	1010	10002105	0	Prodstest stn & spare for PCI CT 173	ACE#2001/2114	03/26/2002	HY GOH	1	*	*	*
6008212	1010	10002106	0	Prodstest stn & spare for PCI CT 174	ACE#2001/2114	03/26/2002	HY GOH	1	*	*	*
6008212	1010	10002107	0	System tester for Jalapeno 2 PCI Desktop 129	ACE#2000/2082	03/26/2002	HY GOH	2	*	*	*
6008212	1010	10002108	0	System Tester for Jalepeno 2 PCI desktop 133	ACE#2000/2082	03/26/2002	HY GOH	2	*	*	*
6008212	1010	10002109	0	System Tester for Jalepeno 2 PCI Desktop 131	ACE#2000/2082	03/27/2002	HY GOH	2	*	*	*
6008212	1010	10002110	0	F. Tester for California roll PCI Inline JIG62	ACE#2001/2108	03/27/2002	BOB LEE	1	*	*	*
6008212	1010	10002112	0	ASR2100S Catapult 3 up tester Desktop PCI 52	ACE#2001/2147	03/27/2002	HY GOH	2	*	*	*
6008212	1010	10002113	0	ASR2100S Catapult 3 up tester Desktop PCI CT#162	ACE#2001/2147	03/27/2002	HY GOH	2	*	*	*
6008212	1010	10002114	0	Functional Tester for Jalepeno 2 PCI Desktop 121	ACE#2000/2001	03/27/2002	HY GOH	2	*	*	*
6008212	1010	10002114	1	Upgrade Functional Tester for Mustang PCI CT#121	ACE#2002/2177	01/08/2002	HY GOH	2	*	*	*
6008212	1010	10002115	0	Functional Tester for Jalepeno 2 PCI Desktop 120	ACE#2000/2001	03/27/2002	HY GOH	2	*	*	*

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CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008212	1010	10002116	0	Functional Tester for Jalepeno 2 PCI Desktop 119	ACE#2000/2001	03/27/2002	HY GOH	2	*	*	*
6008212	1010	10002116	1	Upgrade Functional Tester for Mustang PCI CT#119	ACE#2002/2177	01/08/2002	HY GOH	2	*	*	*
6008212	1010	10002117	0	Functional Tester for Jalepeno 2 PCI Desktop 140	ACE#2000/2001	03/27/2002	HY GOH	1	*	*	*
6008212	1010	10002117	1	Upgrade Functional Tester for Mustang PCI CT#140	ACE#2002/2177	01/08/2002	HY GOH	1	*	*	*
6008212	1010	10002118	0	Spare part F. Tester for Catapult PCI CT#175	ACE#2001/2112	03/27/2002	HY GOH	2	*	*	*
6008212	1010	10002120	0	Genrad ICT Fixture for ASR2200S (Vuican)	ACE#2003/2185	07/14/2002	KEN NG	2	*	*	*
6008212	1010	10002121	0	Genrad ICT fixture for ASR2200S	ACE#2003/2189	07/14/2002	KEN NG	2	*	*	*
6008212	1010	10002122	0	Genrad ICT fixture for ASC39320/29320	ACE#2003/2190	07/14/2002	KEN NG	2	*	*	*
6008212	1010	10002123	0	Genrad ICT fixture for ANA 7711 FAB C	ACE#2003/2191	07/14/2002	KEN NG	2	*	*	*
6008212	1010	10002124	0	Genrad ICT fixture for ASA 7211	ACE#2003/2192	07/14/2002	KEN NG	2	*	*	*
6008212	1010	10002125	0	Genrad ICT Fixture for ABM 300	ACE#2003/2193	05/08/2002	KEN NG	2	*	*	*
6008212	1010	10002126	0	Genrad ICT fixture for ANA7711LP	ACE#2003/2197	08/27/2002	KEN NG	2	*	*	*
6008212	1010	10002127	0	Functional Tester for AUH-4000/7000 PCI desktop 53	ACE#2002/2152	09/23/2002	HY GOH	2	*	*	*
6008212	1010	10002129	0	Genrad ICT fixture for ASC29320LP	ACE#2003/2200	01/10/2002	KEN NG	2	*	*	*
6008212	1010	10002149	0	Fabricate Tomcat 2 Up Tester	ACE#2003/2233	03/20/2003	HY GOH	2	*	*	*
6008212	1010	10002149	1	Spare parts to built Tomcat & Catapult testers	ACE#2003/2233	03/20/2003	HY GOH	2	*	*	*
6008212	1010	10002149	2	Fabricate Catapult ASR2100S three up tester	ACE#2003/2233	03/06/2003	HY GOH	2	*	*	*
6008212	1010	10002429	0	PCA, PCI-X TRANS CARD for Window Prodtest	ACE#2003/2419	05/05/2005	HY GOH	2	*	*	*
6008212	1030	30000603	0	AHA-3960D-Desktop tester#3	ACE#99/1905	05/05/2000	HUEYCHIN	5	*	*	*
6008212	1030	30000604	0	ANA-64044 Desktop tester #2 (PCI CT#127)	ACE#2000/2046	05/05/2000	HUEYCHIN	5	*	*	*
6008212	1030	30000604	2	PCI Desktop Tester PCI CT#127 Top plates	ACE#2002/2156	01/02/2002	H Y GOH	5	*	*	*
6008212	1030	30000604	3	PCI Desktop tester PCI CT#128 top plates	ACE#2002/2156	01/02/2002	H Y GOH	5	*	*	*
6008212	1030	30000609	1	Fabricate of AUH-4000/7000 ICT Manual fixture	ACE#2002/2161	09/10/2001	KEN NG	2	*	*	*

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6008212	1030	30000609	0	Genrad ICT Fixture for AUH4000/7000 (USB2.0)	ACE#2002/2161	09/10/2001	KEN NG	2	*	*	*
6008212	1030	30000610	0	Genrad ICT Fixture for ASR2005s (Raptor)	ACE#2002/2162	09/10/2001	KEN NG	5	*	*	*
6008212	1030	30000611	0	Genrad ICT Fixture for ASR2000S (NightHawk)	ACE#2002/2163	09/10/2001	KEN NG	5	*	*	*
6008212	1030	30000612	0	Genrad ICT Fixture for ASR2110S (Phantom)	ACE#2002/2164	09/10/2001	KEN NG	5	*	*	*
6008212	1030	30000613	0	Genrad ICT Fixture for ANA 62011LV #1	ACE#2002/2165	10/16/2001	KEN NG	5	*	*	*
6008212	1030	30000614	0	Genrad ICT Fixture for ANA64022LV #1	ACE#2002/2166	10/16/2001	KEN NG	5	*	*	*
6008212	1030	30000615	0	Genrad ICT Fixutre for AFC9220/12 (Condor)	ACE#2002/2167	10/16/2001	KEN NG	5	*	*	*
6008212	1030	30000618	0	Genrad ICT Fixture for ANA64044	ACE#2002/2175	03/01/2002	KEN NG	5	*	*	*
6008212	1030	30000625	0	ICT Test Fixture ASR2020S	ACE#2003/2232	03/25/2003	KEN NG	2	*	*	*
6008212	1030	30000627	0	Trf of FT AUA-2X00/3X00B from CIP	ACE#2003/2211	03/21/2003	YUSAK	2	*	*	*
6008212	1030	30000628	0	Trf of FT ASA7211 from CIP	ACE#2002/2179	03/21/2003	TAN JULE	2	*	*	*
6008212	1030	30000629	0	Trf of FT ANA7711 from CIP	ACE#2002/2179	03/21/2003	TANJULEE	2	*	*	*
6008212	1030	30000631	0	Genrad ICT Fixture-AVC2310/2210 Willow USB-TV	ACE#2003/2237	08/04/2003	CA CHUA	2	*	*	*
6008212	1030	30000632	0	FCT for ASC 39320A	ACE#2002/2169	03/26/2003	YEEMENG	2	*	*	*
6008212	1030	30000633	0	FCT for ASC 39320A-PC CT#171 & 179	ACE#2002/2169	03/26/2003	YEEMENG	2	*	*	*
6008212	1030	30000636	0	2 WINDOW PRODTTEST TESTER	ACE#2003//2252	08/19/2003	HY GOH	2	*	*	*
6008212	1030	30000636	1	WELCHALLYN SCANNER	ACE#2003//2252	01/10/2003	HY GOH	2	*	*	*
6008212	1030	30000636	2	ATX casing with 350W power supply	ACE#2003//2252	07/30/2003	HY GOH	2	*	*	*
6008212	1030	30000636	3	Fabricate 15" monitor stand	ACE#2003//2252	09/25/2003	HY GOH	2	*	*	*
6008212	1030	30000636	4	EWS 100-6, 6v/ 16.7A	ACE#2003//2252	09/17/2003	HY GOH	2	*	*	*
6008212	1030	30000636	5	SSR power switch box	ACE#2003//2252	09/25/2003	HY GOH	2	*	*	*
6008212	1030	30000636	6	Anti static Perspec Test Jig Top plate	ACE#2003//2252	09/25/2003	HY GOH	2	*	*	*
6008212	1030	30000640	0	Genrad ICT Test Fixture-AVC2812 Hub bridge	ACE#2003/2275	09/14/2003	CHUA CHU	5	*	*	*
6008212	1030	30000658	0	Seagate 36GB look rpm U320 68 pin SCSI hard disk	ACE#2003/2252	06/10/2003	HY GOH	2	*	*	*
6008212	1030	30000659	0	420W 12v atx power supply	ACE#2003/2252	06/10/2003	HY GOH	2	*	*	*
6008212	1030	30000660	0	Genrad ICT Fixture for ASR 2026ZCR Prowler	ACE#2003/2279	10/15/2003	CHUA CHU	2	*	*	*

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6008212	1030	30000668	0	Window Prodttest tester 1	ACE#2003/2298	12/21/2003	HY GOH	5	*	*	*
6008212	1030	30000669	0	Window Prodttest tester 2	ACE#2003/2298	12/21/2003	HY GOH	5	*	*	*
6008212	1030	30000670	0	Genrad ICT Fixture AAR2810SA	ACE#2003/2300	04/12/2003	CHUA CHU	5	*	*	*
6008212	1030	30000671	0	Genrad ICT Fixture ASC39320A	ACE#2003/2222	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000672	0	Genrad ICT Fixture ASR3225S	ACE#2003/2223	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000673	0	Genrad ICT Fixture AAR2410SA (Jaguar)	ACE#2003/2229	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000674	0	Genrad ICT Fixture Willow PCI-AVC 2010	ACE#2003/2240	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000675	0	Genrad ICT Fixture AVC 2410 Willow PCI	ACE#2003/2242	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000676	0	Genrad ICT Fixture AVC 29320A	ACE#2003/2257	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000677	0	Genrad ICT Fixture AAR 2610SA	ACE#2003/2266	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000678	0	Genrad ICT Fixture ASC29320ALP	ACE#2003/2274	10/12/2003	KEN NG	5	*	*	*
6008212	1030	30000681	0	EWS100-6	ACE#2003/2312	08/03/2004	HY GOH	2	*	*	*
6008212	1030	30000683	0	HHP IT 4600 interface cable	ACE#2003/2298	01/19/2004	HY GOH	5	*	*	*
6008212	1030	30000684	0	SSG-FCT for ASC 39320A (PCI CT#195)	ACE#2002/2169	01/20/2004	YEE MENG	2	*	*	*
6008212	1030	30000713	0	SSG-FCT for ASR2200 PCI CT#183	ACE#2002/2180	02/16/2004	YEE MENG	2	*	*	*
6008212	1030	30000713	1	SSG-FCT for ASR2200 PCI CT#183	ACE#2002/2180	02/16/2004	YEE MENG	2	*	*	*
6008212	1030	30000714	0	SSG-FCT for ASR2200 PCI CT#184	ACE#2002/2180	02/16/2004	YEE MENG	2	*	*	*
6008212	1030	30000715	0	SSG-FCT for ASR2200 PCI CT#186	ACE#2002/2180	02/16/2004	YEE MENG	2	*	*	*
6008212	1030	30000723	0	24 pcs of seagate 20GB ultra ATA100	ACE#2003/2341	03/16/2004	HY GOH	5	*	*	*
6008212	1030	30000723	1	IDE HDD cable	ACE#2003/2341	03/16/2004	HY GOH	5	*	*	*
6008212	1030	30000723	2	Fabricate 4 harddrive chassis	ACE#2003/2341	04/20/2004	HY GOH	5	*	*	*
6008212	1030	30000723	3	Thermal Take X Blower	ACE#2003/2341	03/16/2004	HY GOH	5	*	*	*
6008212	1030	30000724	0	24 pcs of Maxtor 80GB Sata Hard disk	ACE#2003/2344	03/30/2004	HY GOH	5	*	*	*
6008212	1030	30000728	0	FCT AVC 2010 (PCI CT#187)	ACE#2003/2199	03/31/2004	LEROY	2	*	*	*
6008212	1030	30000729	0	FCT AVC 2310 (PCI CT#191)	ACE#2003/2199	03/31/2004	LEROY	2	*	*	*
6008212	1030	30000730	0	FCT AVC 2210 (PCI CT#192)	ACE#2003/2199	03/31/2004	LEROY	2	*	*	*
6008212	1030	30000731	0	FCT PCI CT#184 - U320 Harddisk	ACE#2002/2155	03/31/2004	SIDNEY	2	*	*	*
6008212	1030	30000732	0	FCT PCI CT#143-U320 Harddisk	ACE#2002/2155	03/31/2004	SIDNEY	2	*	*	*
6008212	1030	30000733	0	FC PCI CT#146-U320 Harddisk	ACE#2002/2155	03/31/2004	SIDNEY	2	*	*	*
6008212	1030	30000734	0	Vulcan/Crusader (Window migration)-upgrade to Xeon	ACE#2002/2173	03/31/2004	SIDNEY	2	*	*	*

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6008212	1030	30000734	1	Incorporate into Window Prodtest-PCI CT#184	ACE#2002/2173	03/31/2004	SIDNEY	2	*	*	*
6008212	1030	30000735	0	SSG-FCT AAR 1210-upgrade to Xeon	ACE#2003/2220	03/31/2004	YEE MENG	2	*	*	*
6008212	1030	30000736	0	SSG-FCT AAR 1210	ACE#2003/2220	03/31/2004	YEE MENG	2	*	*	*
6008212	1030	30000738	0	Genrad ICT Fixture -ASR2025ZCR	ACE#2003/2359	05/31/2004	KEN NG	5	*	*	*
6008212	1030	30000743	0	Genrad ICT Fixture for Capri AVC3610	ACE#2003/2368	02/07/2004	CHUA CHU	5	*	*	*
6008212	1030	30000744	0	Genrad ICT Fixture-ATB 100 keywest project	ACE#2003/2381	09/08/2004	CHUA CHU	5	*	*	*
6008212	1030	30000746	0	Kelso system tester & Flash drive program - Qty 2	ACE#2003/2269	08/31/2004	ANWAR	2	*	*	*
6008212	1030	30000747	0	FT-ASA 7211 & ANA7711-Fixture modification	ACE#2002/2179	08/31/2004	ANWAR	2	*	*	*
6008212	1030	30000753	0	Genrad ICT FIX - ASR2230SLP	ACE#2003/2390	09/13/2004	KEN NG	2	*	*	*
6008212	1030	30000754	0	Genrad ICT Fixture ASC29320ALP	ACE#2003/2391	09/15/2004	KEN NG	2	*	*	*
6008212	1030	30000755	0	ICT Fixture-ASR2020ZCR-Skyhawk	ACE#2003/2332	09/15/2004	KEN NG	2	*	*	*
6008212	1030	30000757	0	Genrad ICT fixture AAR2610SA	ACE#2003/2393	10/26/2004	KEN NG	2	*	*	*
6008212	1030	30000758	0	Genrad ICT Fixture for ASC48300 (Respin)	ACE#2003/2397	10/26/2004	KEN NG	2	*	*	*
6008212	1030	30000760	0	Combo 2 pin card (refurbish)	ACE#2003/2406	03/12/2004	HY GOH	5	*	*	*
6008212	1030	30000761	0	Genrad ICT Fixture for AAR-1420SA	ACE#2003/2424	02/03/2005	CA CHUA	2	*	*	*
6008212	1030	30000769	0	Tester from Force Computer		06/21/2005	HY GOH	2	*	*	*
6008212	1030	30000770	0	IBM Computer for AVC#2 Tester	ACE#2003/2405	06/22/2005	HY GOH	2	*	*	*
6008212	1030	30000771	0	IBM Computer for AVC#3 Tester	ACE#2003/2405	06/22/2005	HY GOH	2	*	*	*
6008212	1030	30000772	0	IBM Computer for AVC#4 Tester	ACE#2003/2405	06/22/2005	HY GOH	2	*	*	*
6008212	1030	30000773	0	IBM Computer for AVC#5 Tester	ACE#2003/2405	06/22/2005	HY GOH	2	*	*	*
6008212	1030	30000774	0	AVC#1 Tester - Tenlab- TR1000 Pro	ACE#2003/2394	06/22/2005	HY GOH	2	*	*	*
6008212	1030	30000775	0	AVC#6 Tester -Tenlab- TR1000 Pro	ACE#2003/2394	06/22/2005	HY GOH	2	*	*	*
6008212	1030	30000811	0	AVC Tester #6 Digital Converter	ACE#2003/2461	09/29/2005	HY GOH	2	*	*	*
6008212	1030	30000812	0	Spirit ASC 48300 Tester	ACE#2003/2377	10/19/2005	NING SEN	2	*	*	*
6008212	1030	30000816	0	Window Prodtest for PCI express # 1	ACE#2003/2466	11/16/2005	HY GOH	2	*	*	*
6008212	1030	30000817	0	Window Prodtest for PCI express # 2	ACE#2003/2466	11/16/2005	HY GOH	2	*	*	*
6008232	1010	10001263	0	2940 W/176 TEST PO.TOP PLATE	181-97-M771	04/15/1997	CHEE H	5	*	*	*
6008232	1010	10001264	0	1505 W/148 TEST PO.TOP PLATE	181-97-M771A	04/15/1997	CHEE H	5	*	*	*

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6008232	1010	10001493	1	FUNCTIONAL TESTER (PLD PROGRAMMING FIXTURE)	ACE#98/1687	12/28/1997	CTLIAU	5	*	*	*
6008232	1010	10001493	2	TO SUPPLY & FABRICATE 2ND DESKTOP TESTER FOR	ACE#98/1687	12/28/1997	CTLIAU	5	*	*	*
6008232	1010	10001546	0	TO DESIGN AND FABRICATE CHOPTOP TEST FIXTURE	ACE#98/1726	03/23/1998	CTLIAU	5	*	*	*
6008232	1010	10001546	1	TO DESIGN AND FABRICATE SPARE SLIDING TOP-PLATE	ACE#98/1726	08/16/1998	CTLIAU	5	*	*	*
6008232	1010	10002015	1	TRANSPORT FRAME (3 units)	ACE#2000/2085	08/30/2000	BENJAMIN	5	*	*	*
6008232	1010	10002029	0	Genrad ICT fixture for AFC9110G	ACE#2001/2106	08/22/2000	CC GAN	2	*	*	*
6008232	1030	30000603	1	AHA-3960D-Desktop tester#2	ACE#99/1905	05/05/2000	HUEYCHIN	5	*	*	*
6008232	1030	30000636	7	Seagate 36GB 10 Kps U320 SCSI Hard Disk	ACE#2003//2252	07/30/2003	HY GOH	2	*	*	*
6008236	1010	10002212	0	Test server for ICP product	ACE#2003/2289	11/26/2003	HY GOH	5	*	*	*
6008236	1010	10002280	0	Computer Chasis	ACE#2003/2334	07/06/2004	HY GOH	5	*	*	*
6008236	1030	30000661	0	5 sets of ICP functional tester	ACE#2003/2280	10/21/2003	HY GOH	5	*	*	*
6008236	1030	30000662	0	FC Equipment	ACE#2003/2280	10/21/2003	HY GOH	5	*	*	*
6008236	1030	30000691	0	ICP FUNCTIONAL TESTERS	ACE#2003/2326	05/02/2004	HY GOH	2	*	*	*
6008236	1030	30000718	0	ICP Test Equipment	ACE#2003/2336	03/30/2004	HY GOH	5	*	*	*
7008235	1010	10001960	0	AHA-2950U2W FUNCTIONAL TESTER		12/29/1999	HUEYCHIN	5	*	*	*
7008235	1010	10001976	0	DATA TRANSIT PRO SERIES-BUS ANALYER ULTRA 160M-HD	ACE#2000/1996	02/15/2000	HUEYCHIN	5	*	*	*
7008235	1010	10002014	0	Flex-cable extender	ACE#2000/2086	12/17/2000	KENNYLIM	5	*	*	*
7008235	1010	10002064	0	APA-2000 Desktop Tester #3	ACE#2000/2056	01/02/2001	NG HC	2	*	*	*
7008235	1010	10002080	1	Functional Tester For AUALP (Development Costs)	ACE#2001/2139	11/30/2001	H Y GOH	2	*	*	*
7008235	1010	10002099	0	PCI Desktop Tester PCI CT (PCI-X Test Research)	ACE#2001/2134	03/25/2002	QINFEI	2	*	*	*
7008235	1010	10002100	0	Dev, fab, & supply Generic independent press stn	ACE#2001/2128	03/25/2002	RAZAK	1	*	*	*
7008235	1010	10002101	0	Fm CIP Debug stn for Harpoon II (PCI-X Bus Passive	ACE#2001/2097	03/25/2002	NING	1	*	*	*
7008235	1010	10002446	0	Functional tester-ASA7222C/F & ASA7221C/F	ACE#2003/2415	08/30/2005	NING SEN	2	*	*	*
7008235	1030	30000630	0	Trf for FT ASA7211	ACE#2002/2179	03/21/2003	TANJULEE	2	*	*	*

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7008235	1030	30000726	0	PCIX HW Devt test fixture & autolines	ACE#2002/2151	03/30/2004	QINFEE C	2	*	*	*
7008235	1030	30000750	0	Prodtest development station	ACE#2003/2290	06/09/2004	YEE MENG	2	*	*	*
7008235	1030	30000751	0	Prodtest development station	ACE#2003/2290	06/09/2004	YEE MENG	2	*	*	*
7008235	1030	30000752	0	Prodtest development station	ACE#2003/2290	06/09/2004	YEE MENG	2	*	*	*
7008235	1030	30000767	0	ICT Genrad Fixture for Mynah	ACE#2003/2448	05/25/2005	KEN NG	2	*	*	*
7008235	1030	30000780	0	ASR4800SAS	ACE#2003/2465	09/19/2005	KEN NG	2	*	*	*
7008235	1030	30000810	0	ASR4805SAS Genrad ICT Fixture	ACE#2003/2472	03/10/2005	KEN NG	2	*	*	*
7008235	1030	30000813	0	ICT Genrad Test Fixture AAR-2820SA Intruder	ACE#2003/2476	11/22/2005	CHUACHUA	2	*	*	*
6008212	1010	10001978	0	MOLDED PAPER PULP METAL TOOLING	ACE#2000/2041	07/05/2000	CASSANDR	5	*	*	*
6008212	1010	10002017	0	CLAMSHELL TOOLING -TEST FOR NEW KIT DESIGN	ACE#2000/2064	08/05/2000	PPCHEW	5	*	*	*
6008212	1010	10002041	0	Ultra160 Moulded Pulp Tooling set	ACE#2001/2101	10/23/2000	CHAN GS	5	*	*	*
6008212	1010	10002071	0	Tooling set for tooling for 144mmx141mm sample	ACE#2002/2159	10/29/2001	GYAN TAN	5	*	*	*
6008212	1010	10002072	0	Tooling set for sample Blister Pkg (3pc tool'g set	ACE#2002/2159	10/29/2001	GYAN TAN	5	*	*	*
6008233	1010	10002067	0	Aluminium Mold Tooling	ACE#2001/2145	07/17/2001	CAS.CHUA	5	*	*	*
6008233	1010	10002070	7	Tooling from Alloyd	ACE#2002/2194	09/20/2002	FRANKIE	5	*	*	*
6008233	1010	10002070	9	Tooling from Alloyd	ACE#2002/2195	03/09/2002	FRANKIE	5	*	*	*
6008233	1010	10002079	0	Design & fabricate packing jig (Delrin White)	ACE#2002/2159	12/17/2001	GYAN TAN	5	*	*	*
6008233	1010	10002137	0	Tooling set-223Wmm x 247Lmm x 33.64MM Blister pack	ACE#2003/2212	06/01/2003	FRANKIE	5	*	*	*
6008233	1010	10002252	0	Tooling set for 153W mm x 205L mm	ACE#2003/2309	04/01/2004	FRANKIE	5	*	*	*
6008233	1010	10002253	0	G9 buffer for tooling set for DSG smaller clamshel	ACE#2003/2309	04/01/2004	FRANKIE	5	*	*	*
6008233	1010	10002357	0	Tooling for clamshell 1497692-00	ACE#2003/2382	09/09/2004	FRANKIE	2	*	*	*
6008233	1010	10002357	1	G9 buffer for tooling of clamshell pkg 1497692-00	ACE#2003/2382	09/09/2004	FRANKIE	2	*	*	*
6008251	1010	10000239	0	IPO BURN-IN OVEN	181-92-M113A	10/15/1991	HWEE BEE	3	*	*	*
6008251	1010	10000256	0	TESTING RACK	181-93-M132B	03/15/1992	HWEE BEE	3	*	*	*
6008251	1010	10000258	0	TESTING RACK	181-93-M133B	03/15/1992	HWEE BEE	3	*	*	*
6008251	1010	10000264	0	BURN-IN OVEN	181-93-M139D	03/15/1993	HWEE BEE	5	*	*	*

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	Class	Asset#						#	*	*	*
6008251	1010	10000335	0	BURN-IN OVEN	181-93-M195	08/15/1992	HWEE BEE	5	*	*	*
6008251	1010	10000339	0	BURN-IN OVEN	181-93-M199	08/15/1992	HWEE BEE	5	*	*	*
6008251	1010	10001218	0	IDC SOCKET-AHA8940 FT	181-97-M710	02/15/1997	HWEE BEE	5	*	*	*
6008251	1010	10002036	0	Computer Intel PIII-600MHz CPU	ACE#2001/2116	03/10/2000	HWEEBEE	5	*	*	*
6008251	1010	10002036	1	UTC Power/Fault Injection/Backplane/Controller	ACE#2001/2116	10/23/2000	HWEEBEE	5	*	*	*
6008251	1010	10002037	0	Intel PIII-600MHz CPU/Quantum 9.1GB 160 SCSI HD	ACE#2001/2117	03/10/2000	HWEEBEE	5	*	*	*
6008251	1010	10002037	1	UTC Power/Fault Injection/Blackplane/Controller	ACE#2001/2117	01/11/2000	HWEEBEE	5	*	*	*
6008251	1010	10002037	2	AS2010 Barcode Image scanner; Converter fm RS232 &	ACE#2001/2117	03/10/2000	HWEEBEE	5	*	*	*
6008251	1010	10002060	0	APA-2000 Desktop Tester #2	ACE#2000/2056	01/2/2001	TK WONG	2	*	*	*
6008251	1010	10002078	0	System Tester for Jalepeno 2 (PCI Desktop 132)	ACE#2000/2082	11/30/2001	HWEE BEE	2	*	*	*
6008251	1010	10002098	0	Maxtor Personal Storage 3000LE w/o USB 2.0	ACE#2002/2178	01/02/2002	HWEE BEE	5	*	*	*
6008251	1010	10002098	1	Iomega Predator 24x10x40xUSB 2.0 Ext/ CD writer	ACE#2002/2178	01/02/2002	HWEE BEE	5	*	*	*
6008251	1010	10002098	2	Tyan Thunder HES1-T (S2688)MB various	ACE#2002/2178	01/02/2002	HWEE BEE	5	*	*	*
6008251	1010	10002098	3	SP401-RA (12v) 400w power for Supermircon Server	ACE#2002/2178	03/20/2002	HWEE BEE	5	*	*	*
6008251	1010	10002119	1	PCBA 64 Bits Extender Raid Card, PCI Dimm Socket &	ACE#2003/2184	05/14/2002	HWEE BEE	5	*	*	*
6008251	1010	10002119	2	722S08-K PCI 184 pins, 3bays, 3.3v for testing	ACE#2003/2184	07/05/2002	HWEE BEE	5	*	*	*
6008251	1010	10002119	0	EWS1500-3.3	ACE#2003/2184	04/28/2002	HWEE BEE	5	*	*	*
6008251	1010	10002119	3	144P .8MM 3.3V S/o Dimm Skt	ACE#2003/2184	04/28/2002	HWEE BEE	5	*	*	*
6008251	1010	10002132	0	Functional Tester for USB2-Xchange	ACE# 2003/2182	11/29/2002	YUSAK RA	2	*	*	*
6008251	1010	10002133	0	2010S system Tester	ACE#2003/2208	11/25/2002	HWEE BEE	5	*	*	*
6008251	1010	10002133	1	Seagate Cheetah 36GB,10000rpm, U320-8units	ACE#2003/2208	12/11/2002	HWEE BEE	5	*	*	*
6008251	1010	10002134	0	2015S System Tester	ACE # 2003/2209	11/25/2002	HWEE BEE	5	*	*	*
6008251	1010	10002134	1	Seagate Cheetah 36GB,10000rpm, U320-8units	ACE # 2003/2209	12/11/2002	HWEE BEE	5	*	*	*

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CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008251	1010	10002134	2	Key Board Drawer	ACE # 2003/2209	11/25/2002	HWEE BEE	5	*	*	*
6008251	1010	10002134	3	Net Gear 8-Port 10/100 switch	ACE # 2003/2209	11/25/2002	HWEE BEE	5	*	*	*
6008251	1010	10002135	0	Vulcan & Crusader System tester	ACE#2003/2210	11/25/2002	HWEE BEE	5	*	*	*
6008251	1010	10002135	1	Seagate Cheetah 36GB,10000rpm, U320	ACE#2003/2210	12/11/2002	HWEE BEE	5	*	*	*
6008251	1010	10002143	0	DELL Workstation	ACE#2003/2224	01/28/2003	JASON YA	5	*	*	*
6008251	1010	10002151	0	Serial ATA Tester	ACE#2003/2239	04/20/2003	HWEEBEE	5	*	*	*
6008251	1010	10002151	1	Fabricate base plate for PC motherboard	ACE#2003/2239	06/05/2003	HWEEBEE	5	*	*	*
6008251	1010	10002151	2	Serial ATA power cable	ACE#2003/2239	04/20/2003	HWEEBEE	5	*	*	*
6008251	1010	10002162	0	Battery charges for Marco & AMB 300 battery packs	ACE#2003/2272	09/28/2003	QH NEO	5	*	*	*
6008251	1010	10002163	0	3.3 volt power supply-EWS 1500	ACE#2003/2276	11/20/2003	HWEE BEE	5	*	*	*
6008251	1010	10002163	1	cables for wiring power supply use in Burn in Cham	ACE#2003/2276	07/10/2003	HWEE BEE	5	*	*	*
6008251	1010	10002163	3	8981-04P, 8981-04S, 8980M, 8980F	ACE#2003/2276	07/10/2003	HWEE BEE	5	*	*	*
6008251	1010	10002194	0	IBM xSeries 235 server (Tower)	ACE#2003/2282	04/11/2003	HWEE BEE	5	*	*	*
6008251	1010	10002278	0	MODEL VC7060-ENVIRONMENTAL & HUMIDITY CHAMBER	ACE#2003/2318	04/05/2004	HWEE BEE	5	*	*	*
6008251	1010	10002307	0	XSDP8-G2 system	ACE#2003/2357	06/27/2004	JOELLE L	5	*	*	*
6008251	1010	10002307	1	Maxtor 36GB 10K rpm U320 SCSI HDD - 8pcs	ACE#2003/2357	05/25/2004	JOELLE L	5	*	*	*
6008251	1010	10002307	2	Maxtor 80GB SATA Harddisk Drive - 8pcs	ACE#2003/2357	05/25/2004	JOELLE L	5	*	*	*
6008251	1010	10002307	3	Hard Disk Enclosure -U160 SCSI Hard Disk Drive-2pc	ACE#2003/2357	06/14/2004	JOELLE L	5	*	*	*
6008251	1010	10002307	4	Keyboard Drawer (Table Top)	ACE#2003/2357	06/14/2004	JOELLE L	5	*	*	*
6008251	1010	10002307	5	Fabricate base plate for PC motherboard	ACE#2003/2357	09/22/2004	JOELLE L	5	*	*	*
6008251	1010	10002307	6	Sycard PC Host 1100 PCI to card bus bridge	ACE#2003/2357	05/30/2004	JOELLE L	5	*	*	*
6008251	1010	10002309	0	zup20-20 power supply - 2 pcs	ACE#2003/2363	03/08/2004	JOELLE L	5	*	*	*
6008251	1010	10002309	1	EWSI500-3.3 power supply - 3 pcs	ACE#2003/2363	12/08/2004	JOELLE L	5	*	*	*
6008251	1010	10002342	0	XSDL8-GG-system	ACE#2003/2373	08/31/2004	JOELLE L	5	*	*	*
6008251	1010	10002342	1	Fabricate base plate for PC motherboard	ACE#2003/2373	09/22/2004	JOELLE L	5	*	*	*
6008251	1010	10002343	0	XSDL8-GG-system	ACE#2003/2373	08/31/2004	JOELLE L	5	*	*	*
6008251	1010	10002448	0	Supermicro mainboard X6DH3-G2	ACE#2003/2470	09/26/2005	JOELLE L	5	*	*	*

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CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008251	1010	10002448	1	Maxtor Atlas 15K SAS HDD (Qty 10)	ACE#2003/2470	09/26/2005	JOELLELI	5	*	*	*
6008251	1010	10002448	2	HDD Mounting bracket	ACE#2003/2470	09/26/2005	JOELLELI	5	*	*	*
6008251	1030	30000551	0	FABRICATE AHA1030P MOTHERBOARD	180-95-T497	03/15/1995	HWEE BEE	5	*	*	*
6008251	1030	30000555	0	POWER SUPPLY LRS-49-5	180-96-T500A	11/15/1995	HWEE BEE	5	*	*	*
6008251	1030	30000556	0	PCB FABRICATION ANA-5610	180-96-T501	12/15/1995	HWEE BEE	5	*	*	*
6008251	1030	30000561	0	POWER MACINTOSH 9500/132PC	180-97-T505	05/15/1996	HWEE BEE	5	*	*	*
6008251	1030	30000572	0	MEMCD HDR STD T/H ENHNCD CABLE	180-97-T511	05/15/1997	HWEEBEE	5	*	*	*
6008251	1030	30000573	0	MEMCD HDR STD T/H ENHNCD CABLE	180-97-T511A	05/15/1997	HWEEBEE	5	*	*	*
6008251	1030	30000623	0	Vulcan & Raptor 2 System Tester	ACE#2003/2226	09/02/2003	HWEE BEE	5	*	*	*
6008251	1030	30000624	0	Fujitsu Notebook for reliability testing	ACE#2003/2230	02/20/2003	HWEEBEE	5	*	*	*
6008251	1030	30000705	0	SISTEMA S/T 2721UGN SYSTEM	ACE#2003/2331	10/03/2004	JOELLE L	5	*	*	*
6008251	1030	30000706	0	SISTEMA S/T 2720GN SYSTEM	ACE#2003/2331	10/03/2004	JOELLE L	5	*	*	*
6008251	1030	30000707	0	Maxtor 80gb sata hdd with power cable	ACE#2003/2331	10/03/2004	JOELLE L	5	*	*	*
6008251	1030	30000708	0	Maxtor 36GB UH320 HDD	ACE#2003/2331	10/03/2004	JOELLE L	5	*	*	*
6008251	1030	30000709	0	Keyboard Drawer (Table top) Plastic	ACE#2003/2331	10/03/2004	JOELLE L	5	*	*	*
6008251	1030	30000710	0	Fabricate base plate for PC mother board	ACE#2003/2331	09/22/2004	JOELLE L	5	*	*	*
6008251	1030	30000711	0	WELCHALLYN Scanner	ACE#2003/2331	02/17/2004	JOELLE L	5	*	*	*
6008251	1030	30000712	0	WELCHALLYN Scanner	ACE#2003/2331	02/17/2004	JOELLE L	5	*	*	*
6008251	1030	30000756	0	Functional Tester-AFW-2100/4300	ACE#2003/2291	09/17/2004	YUSAK RA	2	*	*	*
7008235	1010	10002102	0	Fm CIP PCI-X Protocol Checker	ACE#2001/2149	03/25/2002	YEW SENG	1	*	*	*
7008235	1010	10002103	0	Fm CIP PCI-X Exerciser for AFC-9220-9212	ACE#2001/2149	03/25/2002	YEW SENG	1	*	*	*

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Listing of Adaptec–Consigned Equipment (Custom Board Jupiter)

CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008212	1030	30000737	0	Genrad ICT Fixture for Callisto	ACE#2003/2358	05/31/2004	CHUAN AN	5	*	*	*
6008212	1030	30000740	0	Genrad ICT Fixture -PCA-00063-02-A	ACE#2003/2360	07/07/2004	KEN NG	5	*	*	*
6008212	1030	30000741	0	Genrad ICT Fixture for METIS	ACE#2003/2361	09/06/2004	KEN NG	2	*	*	*
6008212	1030	30000742	0	Genrad ICT Fixture for THEBE	ACE#2003/2362	08/29/2004	KEN NG	2	*	*	*
6008212	1030	30000762	0	Callisto #1	ACE#2003/2354	03/03/2005	MENG WHY	2	*	*	*
6008212	1030	30000763	0	Callisto # 2	ACE#2003/2354	03/03/2005	MENG WHY	2	*	*	*
6008212	1030	30000764	0	Callisto # 3	ACE#2003/2354	03/03/2005	MENG WHY	2	*	*	*
6008212	1030	30000766	0	THEBE RESPIN GENRAD ICT FIX	ACE#2003/2443	03/05/2005	CA CHUA	2	*	*	*
									*	*	*

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Listing of Adaptec–Consigned Equipment (Custom Board Eurologic)

CC#	Asset Class	Asset#	Sub #	Description	Type Name	Cap. Date	Room	Bldg #	*	*	*
6008232	1060	60000342	0	Enzo Tester	ACE#2003/2463	08/30/2005	HY GOH	0	*	*	*
6008212	1030	30000663	0	Genrad ICT Fixture 2284 for PCA-00112-02A	ACE#2003/2281	11/19/2003	KEN NG	5	*	*	*
6008212	1030	30000665	0	Genrad ICT Fixture PCA0047 Eurologic product	ACE#2003/2284	11/19/2003	CA CHUA	5	*	*	*
6008212	1030	30000666	0	Genrad ICT Fixture PCA00046- Eurologic product	ACE#2003/2285	03/12/2003	KEN NG	5	*	*	*
6008212	1030	30000667	0	Genrad ICT Fixture PCA00050	ACE#2003/2288	03/12/2003	KEN NG	5	*	*	*
6008212	1030	30000685	0	ICT Test Fix - PCA-00023-02-D, ES Module	ACE#2003/2320	11/02/2004	KEN NG	2	*	*	*
6008212	1030	30000686	0	ICT Test Fix - PCA-50474-02-A,SCSI BACKPLANE	ACE#2003/2321	11/02/2004	KEN NG	2	*	*	*
6008212	1030	30000687	0	ICT Test Fix - PCA-50475-02-A, SCSI IO MODULE	ACE#2003/2322	11/02/2004	KEN NG	2	*	*	*
6008212	1030	30000689	0	ICT Test Fix - PCA-00113-02-B	ACE#2003/2323	11/02/2004	KEN NG	2	*	*	*
6008212	1030	30000690	0	ICT Test Fix - PCA-00030-02-A SATA BACKPLANE	ACE#2003/2322	11/02/2004	KEN NG	2	*	*	*
6008212	1030	30000725	0	Genrad ICT Fixture PCA00102-02-A Eslim	ACE#2003/2343	01/04/2004	CHUAN AN	5	*	*	*
6008212	1030	30000814	0	Enzo Tester # 1	ACE#2003/2463	11/16/2005	HY GOH	2	*	*	*
6008212	1030	30000815	0	Enzo Tester # 2	ACE#2003/2463	11/16/2005	HY GOH	2	*	*	*
7008235	1030	30000768	0	Genrad ICT Fixture-TCA-00167 SAS IO Module	ACE#2003/2453	01/07/2005	CHUACHUA	2	*	*	*
7008235	1030	30000776	0	PCA00115-01-A Genrad 2284 ICT Fixture	ACE#2003/2458	03/07/2005	KEN NG	2	*	*	*
									*	*	*
									*	*	*

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Listing of Adaptec–Consigned Equipment (Custom Board System)

Asset#		Description	Serial #	Inventory #	Acq. Date	Location	Bldg #	Asset Life (Years)	*	*	*
10002178	0	Supermicro X5DPE-G2 Server Bd, Intel Server Xeon	ACE#2003/2265		09/24/2003	KHSEAH	5	5	*	*	*
10002181	0	Qlogic QLA2310F-CK(Fiber version) w/o cable	ACE#2003/2265		09/26/2003	KHSEAH	5	5	*	*	*
10002182	0	Qlogic QLA2310F-CK(copper version) w/o cable	ACE#2003/2265		09/26/2003	KHSEAH	5	5	*	*	*
10002195	1	sitting tool for J18 - J21 connector assembly	ACE#2003/2260		10/31/2003	RODERICK	5	5	*	*	*
10002195	2	sitting tool for J22/J23 connector assembly	ACE#2003/2260		10/31/2003	RODERICK	5	5	*	*	*
10002195	3	sitting tool for J3/J4 connector assembly	ACE#2003/2260		10/31/2003	RODERICK	5	5	*	*	*
10002196	0	design & fabricate base plate for PCA-00112-02-A	ACE#2003/2260		10/31/2003	RODERICK	5	5	*	*	*
10002196	1	sitting tool J30-J35 and J40-J45	ACE#2003/2260		10/31/2003	RODERICK	5	5	*	*	*
10002196	2	sitting tool J1-J12 (6 cavities tooling)	ACE#2003/2260		10/31/2003	RODERICK	5	5	*	*	*
10002214	0	DCOM Sistema MX2400 system	ACE#2003/2294	10002214	12/15/2003	RAYMOND	5	5	*	*	*
10002215	0	DCOM Sistema MX2400 system	ACE#2003/2294	10002215	12/15/2003	RAYMOND	5	5	*	*	*
10002216	0	DCOM Sistema MX2400 system	ACE#2003/2294	10002216	12/15/2003	RAYMOND	5	5	*	*	*
10002217	0	DCOM Sistema MX2400 system	ACE#2003/2294	10002217	12/15/2003	RAYMOND	5	5	*	*	*
10002218	0	Qlogic QLA2310F-CK	ACE#2003/2294		12/15/2003	RAYMOND	5	5	*	*	*
10002219	0	Qlogic QLA2310-CK (Copper)	ACE#2003/2294		12/15/2003	RAYMOND	5	5	*	*	*
10002234	0	DCOM Sistema MX2400 system (4 units)	ACE#2003/2305	10002234	02/18/2004	KARENKHO	5	5	*	*	*
10002235	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002235	05/02/2004	RAYMOND	5	5	*	*	*
10002236	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002236	05/02/2004	RAYMOND	5	5	*	*	*
10002237	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002237	05/02/2004	RAYMOND	5	5	*	*	*
10002240	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002240	05/02/2004	RAYMOND	5	5	*	*	*
10002241	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002241	05/02/2004	RAYMOND	5	5	*	*	*
10002242	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002242	05/02/2004	RAYMOND	5	5	*	*	*
10002243	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002243	05/02/2004	RAYMOND	5	5	*	*	*
10002244	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002244	05/02/2004	RAYMOND	5	5	*	*	*
10002245	0	DCOM Sistema MX2400 system	ACE#2003/2306	10002245	05/02/2004	RAYMOND	5	5	*	*	*
10002246	0	DCOM Sistema MX2400 system	ACE#2003/2306	10002246	05/02/2004	RAYMOND	5	5	*	*	*
10002247	0	DCOM Sistema MX2400 system	ACE#2003/2306	10002247	05/02/2004	RAYMOND	5	5	*	*	*
10002248	0	DCOM Sistema MX2400 system	ACE#2003/2310	10002248	01/15/2004	BOON WEE	5	5	*	*	*
10002249	0	Qlogic QLA2310F-CK	ACE#2003/2310		01/29/2004	BOON WEE	5	5	*	*	*

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Asset#		Description	Serial #	Inventory #	Acq. Date	Location	Bldg #	Asset Life (Years)	*	*	*
10002250	0	Qlogic QLA2310F-CK w/o cable	ACE#2003/2310		01/27/2004	BOON WEE	5	5	*	*	*
10002251	0	40GB IDE harddisk	ACE#2003/2310		01/15/2004	BOON WEE	5	5	*	*	*
10002254	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002254	05/02/2004	RAYMOND	5	5	*	*	*
10002255	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002255	05/02/2004	RAYMOND	5	5	*	*	*
10002256	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002256	05/02/2004	RAYMOND	5	5	*	*	*
10002257	0	DCOM Sistema MX2400 system	ACE#2003/2295	10002257	05/02/2004	RAYMOND	5	5	*	*	*
10002258	0	Keyboard extension cable	ACE#2003/2295		05/02/2004	RAYMOND	5	5	*	*	*
10002259	0	VGA Extension Cable	ACE#2003/2295		05/02/2004	RAYMOND	5	5	*	*	*
10002260	0	power card	ACE#2003/2295		05/02/2004	RAYMOND	5	5	*	*	*
10002261	0	439-7358 Spiral Wrap Tubing	ACE#2003/2295		01/13/2004	RAYMOND	5	5	*	*	*
10002262	0	32U rack, 600W x 800D	ACE#2003/2306		01/27/2004	RAYMOND	5	5	*	*	*
10002262	1	Equipment tray	ACE#2003/2306		01/27/2004	RAYMOND	5	5	*	*	*
10002262	2	Angle support	ACE#2003/2306		01/27/2004	RAYMOND	5	5	*	*	*
10002263	0	Work benches set up for System Assembly FA Lab	ACE#2003/2315		02/18/2004	SUNNY SE	5	5	*	*	*
10002263	1	32U rack, 600W x 800D/Equip tray	ACE#2003/2315		10/02/2004	SUNNY SE	5	5	*	*	*
10002263	2	shelving rack size 1300 x 600 x 2000	ACE#2003/2315		01/06/2004	SUNNY SE	5	5	*	*	*
10002265	0	Qlogic QLA2340-CK 2GB PCI-X Fibre	ACE#2003/2295		05/02/2004	RAYMOND	5	5	*	*	*
10002266	0	Dcom Sistema MX2400 system	ACE#2003/2316	10002266	02/02/2004	HWEE BEE	5	5	*	*	*
10002267	0	Dcom Sistema MX2400 system	ACE#2003/2316	10002267	02/02/2004	HWEE BEE	5	5	*	*	*
10002268	0	Dcom Sistema MX2400 system	ACE#2003/2316	10002268	02/02/2004	HWEE BEE	5	5	*	*	*
10002269	0	Dcom Sistema MX2400 system	ACE#2003/2316	10002269	02/02/2004	HWEE BEE	5	5	*	*	*
10002270	0	Dcom Sistema MX2400 system	ACE#2003/2316	10002270	02/17/2004	HWEE BEE	5	5	*	*	*
10002271	0	Dcom Sistema MX2400 system	ACE#2003/2316	10002271	02/17/2004	HWEE BEE	5	5	*	*	*
10002272	0	Dcom Sistema MX2400 system	ACE#2003/2316	10002272	02/17/2004	HWEE BEE	5	5	*	*	*
10002274	0	Qlogic QLA2310-CK - Fibre version w/o cable	ACE#2003/2316		01/29/2004	HWEE BEE	5	5	*	*	*
10002274	1	tough S114 Uport kvm switch	ACE#2003/2316		02/02/2004	HWEE BEE	5	5	*	*	*
10002275	0	Qlogic QLA2310-CK - copper version w/o cable	ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002276	0	Workbench with table top	ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002276	1	chrome wire shelf-18" x 24" x 63"	ACE#2003/2316		01/27/2004	HWEE BEE	5	5	*	*	*
10002276	2	chrome wire shelf-24" x 36" x 63"	ACE#2003/2316		01/27/2004	HWEE BEE	5	5	*	*	*
10002276	3	Anti Fatigue Mats	ACE#2003/2316		05/02/2004	HWEE BEE	5	5	*	*	*
10002276	4	ESD cleanroom chair, conductive chair	ACE#2003/2316		08/02/2004	HWEE BEE	5	5	*	*	*
10002276	5	2 GBS single drive T-card adapter	ACE#2003/2316		08/02/2004	HWEE BEE	5	5	*	*	*

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Asset#	Description	Serial #	Inventory #	Acq. Date	Location	Bldg #	Asset Life (Years)	*	*	*
10002276	6 HSSDC-3pin PTP Y cable	ACE#2003/2316		08/02/2004	HWEE BEE	5	5	*	*	*
10002276	7 "Loop back" Adaptor (HSSDC)	ACE#2003/2316		08/02/2004	HWEE BEE	5	5	*	*	*
10002276	8 LC "Loopback" Adapter (Multimode)	ACE#2003/2316		08/02/2004	HWEE BEE	5	5	*	*	*
10002276	9 Anti-Fatigue Mats	ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002276	10 Anti-Fatigue Mats	ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002276	11 QLOGIC QLA 2310F(Fibre version) w/o cable	ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002276	12 QLOGIC QLA 2310 CK(Copper version) w/o cable	ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002276	13 install avaya 1071 UTP cables, relocate UTP cabl	e ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002276	14 6pcs -MS Window 2000 Professional (OEM)	ACE#2003/2316		12/02/2004	HWEE BEE	5	5	*	*	*
10002277	0 2 layer swing door metal cupboard	ACE#2003/2315		01/29/2004	SUNNY SE	5	5	*	*	*
10002281	0 OSCILLOSCOPE TEKTRONIX 3054	ACE#2003/2335		03/10/2004	SUNNY SE	5	5	*	*	*
10002281	1 Agilent 33250A 80 MHZ Funstion Generator	ACE#2003/2335		03/10/2004	SUNNY SE	5	5	*	*	*
10002283	0 DCOM sistema Mx2400 system	ACE#2003/2316	10002283	11/4/2004	HWEE BEE	5	5	*	*	*
10002284	0 System- FC2501DR2-AC-B	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002285	0 System- FC2501DR2-AC-B	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002286	0 System- FC2501DR2-AC-B	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002287	0 System- FC2501DR2-AC-B	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002288	0 System- FC2501DR2-AC-B	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002289	0 SC2100ETR-AC-A	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002290	0 SC2100ETR-AC-A	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002291	0 SC2100ETR-AC-A	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002292	0 SC2100ETR-AC-A	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002293	0 SC2100ETR-AC-A	ACE#2003/2346		03/29/2004	HC TOH	5	5	*	*	*
10002294	0 ES Functional Tester (Altevo)	ACE#2003/2348	10002294	03/30/2004	HY GOH	5	5	*	*	*
10002300	0 Supermicro X5DPE-G2 Server Board	ACE#2003/2337		08/06/2004	KH SEAH	5	5	*	*	*
10002341	0 2G Qlogic Optical Host Adapter Controller Cards	ACE#2003/2366		07/30/2004	KH SEAH	5	5	*	*	*
10002344	0 Dcom Sistema MX2400 system	ACE#2003/2374	10002344	07/24/2004	HWEE BEE	5	5	*	*	*
10002344	1 QLA2310F-BK	ACE#2003/2374		07/19/2004	HWEE BEE	5	5	*	*	*
10002345	0 Dcom Sistema MX2400 system	ACE#2003/2374	10002345	07/24/2004	HWEE BEE	5	5	*	*	*
10002346	0 HPS 2428A	ACE#2003/2374		07/15/2004	HWEE BEE	5	5	*	*	*
10002347	0 Dcom Sistema MX2400 system	ACE#2003/2376	10002347	07/24/2004	HWEE BEE	5	5	*	*	*

* Confidential treatment requested

Asset#		Description	Serial #	Inventory #	Acq. Date	Location	Bldg #	Asset Life (Years)	*	*	*
10002347	1	QLA2310F-BK	ACE#2003/2376		07/22/2004	HWEE BEE	5	5	*	*	*
10002354	0	Dcom Sistema MX2400 system	ACE#2003/2380		09/09/2004	KH SEAH	5	5	*	*	*
10002354	1	Qlogic Host Adaptor 2G	ACE#2003/2380		09/13/2004	KH SEAH	5	5	*	*	*
10002354	2	Drives-Cheetah 10K.6 U320 36GB	ACE#2003/2380		09/09/2004	KH SEAH	5	5	*	*	*
10002354	3	power supply-Lamb, AC Pwr Sup, No Bat	ACE#2003/2380		09/09/2004	KH SEAH	5	5	*	*	*
10002355	0	DCOM Sistema MX2400 System	ACE#2003/2380		09/09/2004	KH SEAH	5	5	*	*	*
10002356	0	4-Port 10/100/1000 Base T Switch	ACE#2003/2380		09/09/2004	KH SEAH	5	5	*	*	*
10002359	0	Storage & transfer boxes for Jupiter products	ACE#2003/2386		10/29/2004	RODERICK	5	5	*	*	*
10002360	0	C-20/350 CTS climatic test	TRF FM EUROLOG	I	09/29/2004	HWEE BEE	5	5	*	*	*
10002361	0	C-40/600 CTS climatic test	TRF FM EUROLOG	I	09/29/2004	HWEE BEE	5	5	*	*	*
10002362	0	T-40/350 Temperature chamber	TRF FM EUROLOG	I	09/29/2004	HWEE BEE	5	5	*	*	*
30000635	1	RMKT series 3 Hybrid Plus DD6 Pin card / Softwar	e ACE#2003/2262		04/09/2003	CA CHUA	5	5	*	*	*
30000637	0	Eurologic system tester 9	ACE#2003/2258	30000637	08/10/2003	HY GOH	2	2	*	*	*
30000637	1	Eurologic system tester 1	ACE#2003/2258	30000637-1	08/10/2003	HY GOH	2	2	*	*	*
30000637	2	Eurologic system tester2	ACE#2003/2258	30000637-2	08/10/2003	HY GOH	2	2	*	*	*
30000637	3	Eurologic system tester3	ACE#2003/2258	30000637-3	08/10/2003	HY GOH	2	2	*	*	*
30000637	4	Eurologic system tester4	ACE#2003/2258	30000637-4	08/10/2003	HY GOH	2	2	*	*	*
30000637	5	Eurologic system tester5	ACE#2003/2258	30000637-5	08/10/2003	HY GOH	2	2	*	*	*
30000637	6	Eurologic system tester6	ACE#2003/2258	30000637-6	08/10/2003	HY GOH	2	2	*	*	*
30000637	7	Eurologic system tester7	ACE#2003/2258	30000637-7	08/10/2003	HY GOH	2	2	*	*	*
30000637	8	Eurologic system tester 8	ACE#2003/2258	30000637-8	08/10/2003	HY GOH	2	2	*	*	*
30000637	9	QLA 2310F-CK	ACE#2003/2258	30000637-9	11/09/2003	HY GOH	2	2	*	*	*
30000637	11	L Chop M (LC loop back multimode)	ACE#2003/2258		01/10/2003	HY GOH	2	2	*	*	*
30000637	12	Eurologic system tester 10	ACE#2003/2258	30000637-12	08/10/2003	HY GOH	2	2	*	*	*
30000637	24	San Bloc system	ACE#2003/2258		11/09/2003	HY GOH	2	2	*	*	*
30000637	25	Carrera system	ACE#2003/2258		11/09/2003	HY GOH	2	2	*	*	*
30000637	26	SCSI Disk drive	ACE#2003/2258		11/09/2003	HY GOH	2	2	*	*	*
30000637	27	Fibre Disk drive	ACE#2003/2258		11/09/2003	HY GOH	2	2	*	*	*
30000639	1	Qlogic QLA2310F-CK (optical version) w/o cable	ACE#2003/2273	30000639-1	09/17/2003	HY GOH	2	2	*	*	*
30000641	0	PCA -BXF200-01-G, 2GIG Backplane	ACE#2003/2278	30000641	11/14/2003	HY GOH	2	2	*	*	*
30000642	0	PCA -BXF205/204/207, 2GIG 10 (500-563)	ACE#2003/2278	30000642	11/14/2003	HY GOH	2	2	*	*	*

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Asset#		Description	Serial #	Inventory #	Acq. Date	Location	Bldg #	Asset Life (Years)	*	*	*
30000643	0	PCA BXF206-01-D, 2 GIG LS (500-564)	ACE#2003/2278	30000643	11/14/2003	HY GOH	2	2	*	*	*
30000644	0	PCA 500461-01-D, CCEM	ACE#2003/2278	30000644	11/14/2003	HY GOH	2	2	*	*	*
30000645	0	PCA 500458-02-B, CCEM	ACE#2003/2278	30000645	11/14/2003	HY GOH	2	2	*	*	*
30000646	0	PCA 500464-02-A, DUMB	ACE#2003/2278	30000646	11/14/2003	HY GOH	2	2	*	*	*
30000647	0	PCA 500457-02-A, CARRERA	ACE#2003/2278	30000647	11/14/2003	HY GOH	2	2	*	*	*
30000648	0	PCA500460-02A, TESM	ACE#2003/2278	30000648	11/14/2003	HY GOH	2	2	*	*	*
30000649	0	PCA50466-01-B, CCEM	ACE#2003/2278	30000649	11/14/2003	HY GOH	2	2	*	*	*
30000650	0	PCA500463-02A	ACE#2003/2278	30000650	11/14/2003	HY GOH	2	2	*	*	*
30000651	0	Sanbloc 2 Gig, tepro focus	ACE#2003/2278	30000651	11/14/2003	HY GOH	2	2	*	*	*
30000652	0	Carrera	ACE#2003/2278	30000652	11/14/2003	HY GOH	2	2	*	*	*
30000653	0	Avid Boards	ACE#2003/2278	30000653	11/14/2003	HY GOH	2	2	*	*	*
30000654	0	PCA-BXF202-01-D, TGIG IO (550-553)	ACE#2003/2278	30000654	11/14/2003	HY GOH	2	2	*	*	*
30000655	0	PCA-BXF201-01G, IGIG Ls (500-554)	ACE#2003/2278	30000655	11/14/2003	HY GOH	2	2	*	*	*
30000656	0	PCA500509, Hendrix	ACE#2003/2278	30000656	11/14/2003	HY GOH	2	2	*	*	*
30000657	0	PCA500511, Hendrix	ACE#2003/2278	30000657	11/14/2003	HY GOH	2	2	*	*	*
30000693	0	16 units of QLOGIC QLA2340-BK	ACE#2003/2329		11/03/2004	RAYMOND	5	5	*	*	*
30000694	0	DCOM SISTEMA MX2400 SYSTEM	ACE#2003/2329		03/29/2004	RAYMOND	5	5	*	*	*
30000695	0	DCOM SISTEMA MX2400 SYSTEM	ACE#2003/2329		03/29/2004	RAYMOND	5	5	*	*	*
30000696	0	DCOM SISTEMA MX2400 SYSTEM	ACE#2003/2329		03/29/2004	RAYMOND	5	5	*	*	*
30000697	0	DCOM SISTEMA MX2400 SYSTEM	ACE#2003/2329		03/29/2004	RAYMOND	5	5	*	*	*
30000702	0	DCOM SISTEMA MX2400 SYSTEM	ACE#2003/2328		03/29/2004	RAYMOND	5	5	*	*	*
30000702	1	Tough S114 4 port KVM	ACE#2003/2328		03/31/2004	RAYMOND	5	5	*	*	*
30000703	0	4 units of QLOGIC QLA2340-BK	ACE#2003/2328		11/03/2004	RAYMOND	5	5	*	*	*
30000704	0	32U Rack, 600W, Equipment Tray	ACE#2003/2328		11/03/2004	RAYMOND	5	5	*	*	*
30000717	0	32U Rack, 600W x 800D	ACE#2003/2338		11/03/2004	RAYMOND	5	5	*	*	*
30000717	1	Equipment Tray	ACE#2003/2338		11/03/2004	RAYMOND	5	5	*	*	*
40000713	1	Dell Optiplex 160L	ACE#2003/2259	40000713	09/24/2003	SHAO FON	3	3	*	*	*
40000734	0	SFDM-Shop Floor Data Mgmt	ACE#2003/2319	40000734	09/02/2004	CAROLYN	3	3	*	*	*
40000734	1	Modification of SFDM	ACE#2003/2319		09/02/2004	CAROLYN	3	3	*	*	*
40000734	2	Travel expense-Consultant fee	ACE#2003/2319	40000734	09/02/2004	CAROLYN	3	3	*	*	*
40000734	3	Enhancement to interface with PDS Test system	ACE#2003/2319	40000734	09/02/2004	CAROLYN	3	3	*	*	*
40000735	0	Dell Optiplex 170L micro tower 15"LCD flat panel	ACE#2003/2345		12/04/2004	YEO TECK	3	3	*	*	*
40000735	1	Install Avaya 1071 UTP cables	ACE#2003/2345		04/25/2004	YEO TECK	3	3	*	*	*
40000735	2	Install Avaya 24 port PatchMax panel	ACE#2003/2345		04/25/2004	YEO TECK	3	3	*	*	*

* Confidential treatment requested

<u>Asset#</u>		<u>Description</u>	<u>Serial #</u>	<u>Inventory #</u>	<u>Acq. Date</u>	<u>Location</u>	<u>Bldg #</u>	<u>Asset Life (Years)</u>	*	*	*
40000736	0	Dell Optiplex 170L micro tower 15"LCD flat panel	ACE#2003/2345		12/04/2004	YEO TECK	3	3	*	*	*
40000737	0	Dell Optiplex 170L micro tower 17" CRT colour mo	niACE#2003/2345		12/04/2004	YEO TECK	3	3	*	*	*
40000739	0	AO-170L-Dell Optiplex 170L small microtower-Ln 3	ACE#2003/2349		05/05/2004	YEO TECK	3	3	*	*	*
40000739	1	supply & install Avaya 1071 UTP cables	ACE#2003/2349		05/05/2004	YEO TECK	3	3	*	*	*
40000739	2	Relocation of UTP cables	ACE#2003/2349		05/05/2004	YEO TECK	3	3	*	*	*
40000740	0	AO-170L-Dell Optiplex 170L small microtower-Ln 3	ACE#2003/2349		05/05/2004	YEO TECK	3	3	*	*	*
40000741	0	AO-170L-Dell Optiplex 170L small microtower-Ln 3	ACE#2003/2349		05/05/2004	YEO TECK	3	3	*	*	*
40000742	0	AO-170L-Dell Optiplex 170L small microtower-Ln 3	ACE#2003/2349		05/05/2004	YEO TECK	3	3	*	*	*
									*	*	*

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Listing of Adaptec–Consigned Equipment (Custom System Jupiter)

Asset#		Description	Serial #	Inventory #	Acq. Date	Location	Bldg #	Asset Life (Years)	*	*	*
10002301	0	DCOM Sistema MX2400 system	ACE#2003/2355	10002301	05/20/2004	RAYMOND	5	5	*	*	*
10002302	0	DCOM Sistema MX2400 system	ACE#2003/2355	10002302	05/20/2004	RAYMOND	5	5	*	*	*
10002303	0	DCOM Sistema MX2400 system	ACE#2003/2355	10002303	05/20/2004	RAYMOND	5	5	*	*	*
10002304	0	DCOM Sistema MX2400 system	ACE#2003/2355	10002304	05/20/2004	RAYMOND	5	5	*	*	*
10002305	0	DCOM Sistema MX2400 system	ACE#2003/2355	10002305	05/20/2004	RAYMOND	5	5	*	*	*
10002306	0	DCOM Sistema MX2400 system	ACE#2003/2355	10002306	05/20/2004	RAYMOND	5	5	*	*	*
10002308	0	QLA2340-BK (Optical) - 4 pcs	ACE#2003/2355		02/06/2004	RAYMOND	5	5	*	*	*
10002350	0	DCOM Sistema MX2400 System	ACE#2003/2383		11/22/2004	RAYMOND	5	5	*	*	*
10002350	1	D Link 5port 10/100/1000 base T switch	ACE#2003/2383		12/23/2004	RAYMOND	5	5	*	*	*
10002351	0	DCOM Sistema MX2400 System	ACE#2003/2383		11/22/2004	RAYMOND	5	5	*	*	*
10002352	0	DCOM Sistema MX2400 System	ACE#2003/2383		11/22/2004	RAYMOND	5	5	*	*	*
10002353	0	DCOM Sistema MX2400 System	ACE#2003/2383		11/22/2004	RAYMOND	5	5	*	*	*
10002353	1	9 pin serial com port extension	ACE#2003/2383		11/22/2004	RAYMOND	5	5	*	*	*
10002353	2	2 M UPT crossover Network cable	ACE#2003/2383		09/09/2004	RAYMOND	5	5	*	*	*
10002353	3	symbol cobra LSI900 series barcode scanner	ACE#2003/2383	CANNOT TAG	09/09/2004	RAYMOND	5	5	*	*	*
10002353	4	Keyboard extension cable	ACE#2003/2383		11/24/2004	RAYMOND	5	5	*	*	*
10002353	5	VGA extension cable	ACE#2003/2383		11/24/2004	RAYMOND	5	5	*	*	*
10002353	6	Power Cord	ACE#2003/2383		11/24/2004	RAYMOND	5	5	*	*	*
10002353	7	QLA2340-B PCI & PCI-X to fibre channel	ACE#2003/2383		08/26/2004	RAYMOND	5	5	*	*	*
10002410	0	QLA2342-Dual Ports (Qty 20)	ACE#2003/2414		01/26/2005	RAYMOND	5	5	*	*	*
10002410	1	Rocket PCI 4 ports serial com card (Qty 10)	ACE#2003/2414		01/17/2005	RAYMOND	5	5	*	*	*
10002410	2	D Link 5 ports Gigabit switch (Qty 10)	ACE#2003/2414		01/26/2005	RAYMOND	5	5	*	*	*
30000748	0	ASA 7211 C - 6 pcs	ACE#2003/2355		1/9/2004	RAYMOND	5	5	*	*	*
30000765	0	Rocket PCI serial Com Card	ACE#2003/2427		03/15/2005	RAYMOND	2	2	*	*	*
30000765	1	16 ports Gigabit switch	ACE#2003/2427		03/15/2005	RAYMOND	2	2	*	*	*
30000765	2	2M UTP category 5 straight RJ45 to RJ45 cable	ACE#2003/2427		05/15/2005	RAYMOND	2	2	*	*	*
									*	*	*

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Listing of Adaptec–Consigned Equipment (PDS Equipment)

Brix Testing System — Equipment List

Parts

Rack #	Part Number	Part Description	Qty
4		42 U Rack with Casters and no sides	1
	RPC28A - 30NC	Bay Tech Power Distribution Units (220 Volts)	1
		1U Test Station (220 Volts) with LCD	1
		Wireless Bar Code Scanner (220 Volts)	1
	PM25 bundle	Livingston Port Master 24 Serial Port to Ethernet Mux (220 Volts)	1
	EF3123	Linksys EtherFast 3124 24 port 10/100 Ethernet Switch	1
		Relocateable Power Tap	1

Rack #	Part Number	Part Description	Qty
11		42 U Rack with Casters and no sides	1
	RPC28A - 30NC	Bay Tech Power Distribution Units (220 Volts)	1
		1U Test Station (220 Volts) with LCD	1
		Wireless Bar Code Scanner (220 Volts)	1
	PM25 bundle	Livingston Port Master 24 Serial Port to Ethernet Mux (220 Volts)	1
	FSM726	NetGear 24 port 10/100 Mbps Managed Switch with 2 GBIC ports (220 Volts)	1
		Relocateable Power Tap	1

Rack #	Part Number	Part Description	Qty
13		42 U Rack with Casters and no sides	1
	RPC28A - 30NC	Bay Tech Power Distribution Units (220 Volts)	1
		1U Test Station (220 Volts) with LCD	1
		Wireless Bar Code Scanner (220 Volts)	1
	PM25 bundle	Livingston Port Master 24 Serial Port to Ethernet Mux (220 Volts)	1
	FS726T	NetGear Prosafe 24 port 10/100 Smart Switch with 2 Gigabit ports (220 Volts)	1
		Relocateable Power Tap	1

* Confidential treatment requested

Rack #	Part Number	Part Description	Qty
9		42 U Rack with Casters and no sides	1
	RPC28A - 30NC	Bay Tech Power Distribution Units (220 Volts)	1
		1U Test Station (220 Volts) with LCD	1
		Wireless Bar Code Scanner (220 Volts)	1
	PM25 bundle	Livingston Port Master 24 Serial Port to Ethernet Mux (220 Volts)	1
	FS726	NetGear 26 port 10/100 Mbps Modular (220 Volts)	0
		Relocateable Power Tap	1

Rack #	Part Number	Part Description	Qty
14		42 U Rack with Casters and no sides	1
	RPC28A - 30NC	Bay Tech Power Distribution Units (220 Volts)	1
		1U Test Station (220 Volts) with LCD	1
		Wireless Bar Code Scanner (220 Volts)	1
	PM25 bundle	Livingston Port Master 24 Serial Port to Ethernet Mux (220 Volts)	1
	FS726T	NetGear Prosafe 24 port 10/100 Smart Switch with 2 Gigabit ports (220 Volts)	1
		Relocateable Power Tap	1

13th Drive Test		24 U Rack with Casters	1
	RPC3A - NC	Bay Tech Power Distribution Units (220 Volts)	1
		1U Test Station (220 Volts) with LCD	1
		Wireless Bar Code Scanner (220 Volts)	1
	PM25 bundle	Livingston Port Master 24 Serial Port to Ethernet Mux (220 Volts)	1
	FS726T	NetGear Prosafe 24 port 10/100 Smart Switch with 2 Gigabit ports (220 Volts)	1
		1U Test Server	1

Debug		24U Rack with Casters	1
	RPC3A - NC	Bay Tech Power Distribution Units (220 Volts)	1
		1U Test Station (220 Volts) with LCD	1
		Wireless Bar Code Scanner (220 Volts)	1
	PM25 bundle	Livingston Port Master 24 Serial Port to Ethernet Mux (220 Volts)	1
	FSM726	NetGear 24 port 10/100 Mbps Managed Switch with 2 GBIC ports (220 Volts)	1

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Listing of AMS Inventory for active SKUs with material beyond 6 months of forecast

P.C	Clas	Material #	Description	*	*	*	PO	*	6 MO REQS	TOT REQS	Excess for 6 Months	*
479	RAWB	ICS-00006-01-A	IC, A4 ASIC 144PIN QFP	*	*	*	0	*	1100	1100	29451	*
441	RAWB	16797	DIMM, 64MX72 DDR266B ECC 1.12H	*	*	*	0	*	8	8	2114	*
406	RAWB	16966	IC, ISP2312 FC>PCIA CTLR PBGA	*	*	*	0	*	2160	2920	3345	*
489	RAWB	17084	MOD, TUNER FM1236 MK3	*	*	*	27000	*	2450	2650	25713	*
489	RAWB	16466	MOD, TUNER FQ1236 NTSC F-CONN	*	*	*	27120	*	2550	2750	25221	*
479	WIPS	PCA-00018-01-B	IMPREZA PCA	*	*	*	1	*	75	81	192	*
400	FINC	754911	AIC-7901X REV A1	*	*	*	0	*	530	530	10596	*
482	WIPB	2030800	SCD, AUA-3020 HOST ADAPTER	*	*	*	31	*	30	30	10526	*
401	RAWB	15512	IC, 80960RS I/O PROCES H-PBGA	*	*	*	0	*	520	520	2818	*
480	WIPB	ASM-00367-01-A	SCD, AVC-3610 CABLE ACCSSRY	*	*	*	0	*	2560	2700	21381	*
439	RAWB	1497768-00	SCD, IC21143PD ANA-6911A/TX HP	*	*	*	0	*	12720	12720	12141	*
402	FINC	758014	AIC-8130H REV C (4 PORT)	*	*	*	0	*	10170	11170	8578	*
489	RAWB	17085	IC, LT1940L SWREG SD1.4A TSSOP	*	*	*	0	*	2450	2650	50344	*
480	RAWB	1497558-00	SCD, AVC-3610 BEANBAG MCU TQFP	*	*	*	38880	*	2450	2650	28633	*
405	FINC	757011	AIC-7221W REV A1 (W/IP SEC)	*	*	*	0	*	1755	3580	2939	*
401	RAWB	16816	IC, 4MX16X4 DDR266B LP TSOP	*	*	*	0	*	13200	14200	16168	*
479	RAWS	PCA-00118-01-A	256MB ECC DIMM PC2700 AES-170X	*	*	*	0	*	3207	4313	1590	*
401	RAWB	INT-00163	IC, SYM53C1030 D U320 SCSI BGA	*	*	*	0	*	1170	1170	1353	*
401	RAWB	INT-00169	IC, GC80303 I/O PROCESSOR BGA	*	*	*	0	*	1270	1270	463	*
439	RAWB	17051	CONN, RJ45 8P GBE GRN+GRN LED	*	*	*	0	*	4690	6480	10733	*
441	RAWB	16895	DIMM, 64MX72 PC2100 ECC UBF LP	*	*	*	0	*	47	47	135	*

* Confidential treatment requested

P.C	Clas	Material #	Description	*	*	*	PO	*	6 MO REQS	TOT REQS	Excess for 6 Months	*
479	RAWB	PCB-00030-01-D	SGL SATA BKPLN, RAW ETCH	*	*	*	0	*	100	100	388	*
479	RAWB	PCB-00046-01-B	ALTEVO FC BACKPLANE	*	*	*	0	*	100	100	68	*
441	RAWB	16795	IOTH BD, SUPERMICRO X5DPR-IG21	*	*	*	0	*	4	4	215	*
479	RAWB	CON-00084-01-A	RECP.T.SATA,22PIN,SMD,VRT	*	*	*	0	*	1200	1200	73046	*
441	RAWB	16796	CHASSIS, SUPERMICRO 813T 4SATA	*	*	*	0	*	4	4	212	*
489	RAWB	16623	IC, MSP3415G SOUND PROC PMQFP	*	*	*	0	*	200	200	13786	*
489	RAWB	16512	MOD, TUNER FQ1216ME PAL IEC	*	*	*	0	*	200	200	7158	*
403	RAWB	14627	IC, L80220/H 100TX/10T PLCC	*	*	*	0	*	100	100	6592	*
489	RAWB	1496352-00	SCD, ADPTR AD16-05 2.5A SW US	*	*	*	0	*	2750	2890	20164	*
489	RAWB	17073	IC, LT3467 DC-DC CONVTR TSOT23	*	*	*	0	*	2450	2650	72162	*
489	RAWB	494304-02	CABLE, 50PAMPCONN W/TERM FUJI	*	*	*	0	*	25	25	4559	*
441	RAWB	16798	PLUG IN, 128MB FLSH DISK 40PIN	*	*	*	8	*	4	4	1061	*
479	WIPB	PCA-00009-01-A	1GB(128MX72),3.3V,PC133,REG	*	*	*	0	*	24	24	127	*
479	WIPB	PCA-00112-02-A	DUAL SATA BP, EL VARIANT r01	*	*	*	0	*	68	74	288	*
489	RAWB	1494051-00	SCD, ADPTR 5V/2.5A AC/DC SW US	*	*	*	0	*	50	50	13572	*
404	RAWB	1497395-00	CABLE, SAS 4X-4 1X 3.0G .5M	*	*	*	0	*	40	60	2816	*
400	FINC	753320	AIC-7899W REV B	*	*	*	0	*	632	632	3753	*
489	RAWB	16735	IC, 720112 USB2.0 CNTR TQFP80	*	*	*	53500	*	2450	2650	14213	*
441	RAWB	16848	PLUG IN, PRO/100S 10/100EN NIC	*	*	*	0	*	4	4	1193	*
401	RAWB	INT-00131	IC, 16MBIT 3.3V UNIF FLSH TSOP	*	*	*	0	*	100	100	9237	*
401	RAWB	498413-00	CABLE, 50P INT/EXT 4 CONN LC	*	*	*	0	*	150	222	5382	*
482	RAWB	14573	ADAPTER, EXT 68PHDF-50PHDM NRW	*	*	*	0	*	69	85	1327	*

* Confidential treatment requested

P.C	Clas	Material #	Description	*	*	*	PO	*	6 MO REQS	TOT REQS	Excess for 6 Months	*
439	RAWB	13881	IC, DP83223(PLCC)100BASE XCVR	*	*	*	0	*	12720	12720	3287	*
480	RAWB	2128207-00	PCB, AVC-3610	*	*	*	13001	*	2450	2650	9141	*
489	RAWB	16628	IC, 2MX32 SDRAM 6/7NS TSOP	*	*	*	0	*	5100	5500	15205	*
401	RAWB	ICP-00170	IC, ISPLSI2064E PLD 100M TQFP	*	*	*	0	*	3510	4190	11842	*
401	RAWB	ICP-00177	IC, ISPMACH4A CPLD 5NS 48P QFP	*	*	*	0	*	100	100	10924	*
489	RAWB	16627	OSC, HCMOS 27MHZ 3.3V HS DIP	*	*	*	766	*	3150	3350	52813	*
445	RAWS	DRV-00029-01-A	CHEETAH 10K.6 FC 73GB	*	*	*	43	*	1	1	149	*
444	RAWS	BAT-00006-01-A	AES-xS6500 3.7V 7.2AH LION BAT	*	*	*	0	*	2	2	277	*
482	RAWB	1496494-00	SCD, AUH-2000 HUB2 USB 2.0	*	*	*	1	*	20	20	1950	*
401	RAWB	ICP-00131	IC, 16MBIT 3.3V UNIF FLSH TSOP	*	*	*	0	*	100	100	4307	*
489	RAWB	16624	IC, MSP3425G SOUND PROC PMQFP	*	*	*	0	*	200	200	5273	*
479	WIPS	MEC-BXF102-03-A	BOXSTORE WINE CARRIER,	*	*	*	346	*	38	60	814	*
479	WIPB	PCA-500457-02-B	CARRERA BACKPLANE r6.0	*	*	*	0	*	2	2	115	*
480	RAWB	1496213-00	SCD, AVC-2310/2410 REMOTE CNTL	*	*	*	0	*	995	995	10219	*
489	RAWB	17075	IC, RN5VD30C VOLT DETECTOR SOT	*	*	*	21000	*	3450	3650	52075	*
482	RAWB	1493934-00	FRAME, AUH-4000/7000 STAND	*	*	*	0	*	102	102	4106	*
440	WIPB	PCA-BXF206-08-A	2GB LS, ACER	*	*	*	0	*	4	4	90	*
400	FINC	742111	AIC-7890AB REV A	*	*	*	0	*	1	1	1272	*
401	RAWB	15327	IC, LT1638 OP AMP MSOP8	*	*	*	0	*	20	20	3956	*
489	RAWB	17055	TRANS, XN04316 NPN/PNP MINI6	*	*	*	0	*	7350	7950	152304	*
401	RAWB	1824707-00	PCB, ASC-19160	*	*	*	0	*	100	100	1756	*
481	FINC	738711	AIC-6350T REV A	*	*	*	0	*	200	200	2481	*

* Confidential treatment requested

P.C	Clas	Material #	Description	*	*	*	PO	*	6 MO REQS	TOT REQS	Excess for 6 Months	*
479	RAWS	FAS-BXG300-01-A	SCREW M3X10 T/BT	*	*	*	0	*	5690	6350	39710	*
479	RAWB	MEC-BXF303-01-E	BEZEL, SWITCH GUIDE	*	*	*	0	*	740	840	3560	*
401	RAWB	INT-00189	IC, SDRAM 64MBIT 3.3V 7.5N TSO	*	*	*	0	*	500	500	3716	*
479	RAWB	LED-00026-01-A	LED, GRN, VERT, SMD, 0402	*	*	*	0	*	14110	14110	73890	*
479	RAWS	FAS-BXG300-02-A	SCREW, M3X15 T/PN	*	*	*	0	*	2400	2400	30030	*
489	RAWB	1496352-00EU	SCD, ADPTR AD16-05 2.5A SW EU	*	*	*	0	*	65	65	1638	*
489	RAWB	17083	XTAL, 6MHZ P-R 50PPM 49S	*	*	*	0	*	2450	2650	52950	*
489	RAWB	17082	XTAL, 10MHZ P-R 50PPM 49S	*	*	*	0	*	2450	2650	53031	*
489	WIPB	2054400-00	MCNTR, AVC-2410 8-BIT	*	*	*	5	*	100	100	5295	*
480	RAWB	2042407-00	PCB, AVC-2410	*	*	*	1874	*	100	100	2176	*
439	RAWB	PCB-00193-01-B	MSTR FILE, ICP5085BR	*	*	*	0	*	1	1	29	*
480	WIPB	ASM-00485-01-A	ASSY, AVC-3610 BOTTOM/FTRTL	*	*	*	0	*	510	650	724	*
489	RAWB	16640	IC, LT1930 DC/DC CNVRTR SO	*	*	*	0	*	300	300	2810	*
439	RAWB	16331	IC, LT1963 LDO VR 1.5V1.5A SOT	*	*	*	0	*	20	20	1639	*
401	RAWB	16876	IC, AD8402 1K DIGTL POT 2CH SO	*	*	*	0	*	60	60	1477	*
489	RAWB	12931	XTAL, 20MHZ 3X9mm P-RES TUBULR	*	*	*	0	*	200	200	10536	*
480	RAWB	PMF-00077-01-A	HOUSING, AVC-3610 TOP RETAIL	*	*	*	0	*	510	650	716	*
480	RAWB	513630-00ENFR	SLV, AVC-2010/ENFR KIT	*	*	*	280	*	50	50	1937	*
480	RAWB	513625-00ENFR	SLV, AVC-2410/ENFR KIT	*	*	*	40	*	10	10	1799	*
489	RAWB	16492	JACK, 5-PIN STEREO 3.5MM PTH	*	*	*	0	*	100	100	8264	*
480	WIPB	2006806-02	PCA, AVC-2310/JA	*	*	*	0	*	90	90	29	*
489	RAWB	1495626-00	SHIELD, AVC-2210/2310	*	*	*	0	*	960	960	3471	*
480	RAWB	513605-00UK	SLV, AVC-2310/UK	*	*	*	260	*	780	780	735	*
480	RAWB	1496012-00	BRACKET, AVC-2410	*	*	*	1750	*	10	10	4282	*
480	RAWB	1495645-00	BRACKET, AVC-2010	*	*	*	0	*	50	50	3863	*

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P.C	Clas	Material #	Description	*	*	*	PO	*	6 MO REQS	TOT REQS	Excess for 6 Months	*
480	RAWB	513547-03EU	GUIDE, AVC-2310/EU QUICK START	*	*	*	190	*	30	30	796	*
480	RAWB	513613-03EU	GUIDE, AVC-2010/EU QUICK START	*	*	*	1696	*	50	50	447	*
480	RAWB	513605-00ITSP	SLV, AVC-2310/ITSP	*	*	*	60	*	10	10	399	*
489	RAWB	1496018-00	FRAME, AVC-2210	*	*	*	0	*	35	35	552	*
489	RAWB	1496019-00	FRAME, AVC-2310	*	*	*	0	*	925	925	493	*
489	RAWB	513650-00EU	ERRATA, AVC-2310-2410/EU	*	*	*	100	*	40	40	4273	*
480	RAWB	513604-00GE	SLV, AVC-2210/GE	*	*	*	0	*	20	20	118	*
480	RAWB	513604-00ENFR	SLV, AVC-2210/ENFR	*	*	*	100	*	20	20	141	*
489	RAWB	513652-00	LABEL, AVC REMOVE DEVICE	*	*	*	0	*	890	890	6356	*
480	RAWB	513544-03EU	GUIDE, AVC-2210/EU QUICK START	*	*	*	3000	*	40	40	236	*
489	RAWB	513652-00GE	LABEL, AVC REMOVE DEVICE/GE	*	*	*	0	*	30	30	5450	*
489	WIPB	1495472-00	ASSY, AVC-2X10 BEZEL/LIGHPIPE	*	*	*	0	*	960	960	202	*
489	RAWB	513652-00ENFR	LABEL, AVC REMOVE DEVICE/ENFR	*	*	*	0	*	30	30	4417	*
480	RAWB	513605-00JA	SLV, AVC-2310/JA KIT	*	*	*	290	*	90	90	76	*
480	RAWB	513605-00ENFR	SLV, AVC-2310/ENFR	*	*	*	90	*	10	10	29	*
480	RAWB	2064700EU	CD ASSY, AVC-2010/EU v1.2 GD	*	*	*	450	*	70	70	87	*
480	RAWB	2065000JA	CD ASSY, AVC-2310/JA TVv1.2 GD	*	*	*	20	*	90	90	85	*
480	RAWB	513547-03JA	GUIDE, AVC-2310/JA QUICK START	*	*	*	300	*	90	90	62	*
489	RAWB	513652-00ITSP	LABEL, AVC REMOVE DEVICE/ITSP	*	*	*	0	*	10	10	1090	*
489	RAWB	1495443-00	BOX,AVC2000 8.54"x13.11"x3.31"	*	*	*	4990	*	90	90	21	*
489	RAWB	513631-00JA	CARD, AVC/JA REMOTECNTRLQCKREF	*	*	*	1960	*	90	90	72	*
489	RAWB	513631-00FR	CARD, AVC/FR REMOTECNTRL QKREF	*	*	*	2285	*	20	20	23	*
480	RAWB	2068200EU	CD ASSY, AVC-2410/EU v1.2 GD	*	*	*	500	*	10	10	4	*
489	RAWB	513631-00SP	CARD, AVC/SP REMOTECNTRL QKREF	*	*	*	385	*	10	10	3	*
480	RAWB	2118600	CD ASSY, AVC-2410 v1.3 GD	*	*	*	590	*	10	10	2	*

* Confidential treatment requested

Listing of AMS inventory with no forecasted demand but required for warranty/RMA/NPI requirements

P.C.	Clas	Material #	Description	*	TOT	*	PO	*	6 MO REQS	TOT REQS	Rationale
479	WIPB	PCA-00018-01-A	IMPREZA PCA	*	579	*	1	*	0	0	Used on inactive ADIC products
479	WIPB	PCA-00017-01-A	MAXIMA PCA	*	165	*	0	*	0	0	ECO : To use rev B, disposition=to UAI PCA-00017-01-A
401	RAWB	IC-0386-001	16 MEG X4 60NS ECO SELF REF	*	41478	*	0	*	0	0	Used on Legacy PM product, reservation for RMA /service items as component is EOL.
440	WIPS	PWR-00012-01-B	POWER SUPPLY, JUPITER	*	2332	*	7	*	0	0	ECO : To use rev C, disposition=to UAI PWR-00012-01-B
401	WIPB	TA-0945-BUL	PM3334UW + SX4030/1UW	*	262	*	0	*	0	0	Service Requirement
401	WIPB	TA-1011-STR	PM3334UW+SM4000/4+SX4030/2W	*	233	*	0	*	0	0	Service Requirement
479	WIPB	1967400	ADS-7200S SUB ASSY	*	19	*	0	*	0	0	Service
401	RAWB	PC-1050-006	PM3755U2B PCB	*	5077	*	0	*	0	0	Used on Legacy PM product, reservation for RMA /service items as component is EOL.
479	WIPS	EMA-BXF113-01-F	FFX1 RAID CONTROLLER	*	27	*	0	*	0	0	Used on Eurologic legacy product, not forecasted but there are adhoc demands
401	RAWB	IC-0353-002	ISP1080 64 BIT PCI 388 PBGA	*	1997	*	0	*	0	0	Warranty and Repair
489	RAWB	1495007-00	SCD, 1100 VIDEO CD USB DONGLE	*	3436	*	0	*	0	0	Service
401	RAWB	PA-0082-001	EPM7256AE 7NS 3.3V 256 MAC	*	3735	*	0	*	0	0	Service
401	RAWB	AS-0012-003	DOMINO RAID ACCEL 256 PIN PBGA	*	4948	*	0	*	0	0	Used on Legacy PM product, reservation for RMA /service items as component is EOL.
401	RAWB	15370	DIMM, 16MX72 SDRAM PC100 1.75H	*	2034	*	0	*	0	0	AAC-3642 already obsolete, need reservation for RMA/service parts
401	RAWB	IC-0306-001	PCI9080 I20 PCI BUS MASTER	*	1754	*	0	*	0	0	EOL component, last time buy. Used on Force. Reservation needed for RMA service parts

* Confidential treatment requested

P.C.	Clas	Material #	Description	*	TOT	*	PO	*	6 MO REQS	TOT REQS	Rationale
439	RAWB	14857	IC, 21143PD PCI LAN CNTLR PQFP	*	8683	*	0	*	0	0	Used on inactive ANA-69XX products. Inventory due to last time buy
479	WIPS	ASM-00185-01-A	IMPREZA MODULE ASSY	*	72	*	0	*	0	0	Used on inactive ADIC products, inventory in RA92 location
401	RAWB	DM-1032-002	168P 32MB ECC SDRAM DIMM PC100	*	2881	*	0	*	0	0	Products will be EOL but need reservation for RMA/service parts
401	RAWB	ICP-00162	IC, SYM53C1010 DUAL U3 329 BGA	*	1924	*	0	*	0	0	Products will be EOL but need reservation for RMA/service parts
401	RAWB	PC-1035-005	SX4055U2 PCB	*	9096	*	0	*	0	0	Legacy product but not EOL . Reservation for RMA/service parts
401	RAWB	IC-0304-001	MGX16 50NS 3.3V ECO DIMM TSOP	*	7223	*	0	*	0	0	Service
445	RAWS	DRV-00045-01-A	DAYTONA U320 73GB	*	286	*	73	*	0	0	Service Requirements
401	RAWB	IC-0353-001	ISP1080 64 BIT PCI TO SCSI	*	2098	*	0	*	0	0	Reservation made for RMA, EOL component
401	RAWB	14644	IC, 21554 PCI-PCI BRIDGE PBGA	*	2038	*	0	*	0	0	Used on AAC(obsolete) products. Inventory reserved for RMA
401	RAWB	15486	HEATSINK, HT-34X34 W/CHOM T411	*	30880	*	0	*	0	0	Used on AAC products. Inventory reserved for RMA
401	RAWB	CN-0164-001	68 POS .8MM RE SHIELDED	*	9770	*	0	*	0	0	Legacy product but not EOL yet. Inventory will be kept for RMA purpose.
445	RAWS	DRV-00078-01-B	CHEETAH 15K.4 FC 146GB RoHS	*	116	*	4	*	0	0	Service Requirements
445	RAWS	DRV-00025-01-A	CHEETAH 10K.6 U320 146GB	*	176	*	102	*	0	0	Service Requirements
401	RAWB	HD-0022-001	SCREWLOCK, BOARDMOUNT	*	179256	*	0	*	0	0	Inventory transferred from OTC; legacy products need to reserve inventory for RMA purpose
479	RAWS	XLPSU-AR2-A03	POWER SUPPLY XL600 RA03	*	248	*	0	*	0	0	System legacy products ; may require to support service part and RMA
439	RAWB	15485	IC, HPFC5166A TACHYON FC PBGA	*	693	*	0	*	0	0	Used on AFC
404	RAWB	ICS-00192-01-A	VSC7153 SAS XPNDR 24 PORT SBGA	*	1155	*	0	*	0	0	NPI
401	RAWB	15355	IC, DS2119ME B4 LVD/SE U2TSSOP	*	35000	*	0	*	0	0	Legacy product but not EOL yet. Inventory will be kept for RMA purpose.
401	RAWB	INT-00133	IC, 16MBIT 5V UNIF FL5H TSOP	*	10384	*	0	*	0	0	Used on Bisbee. Potentially, last shipment for top level sku by Mar 6.
439	RAWB	15491	MODULE, IBM GBIC LASER XCVR FC	*	337	*	0	*	0	0	Used on AFC

* Confidential treatment requested

P.C.	Clas	Material #	Description	*	TOT	*	PO	*	6 MO REQS	TOT REQS	Rationale
479	RAWS	PCA-00155-01-A	1GB ECC DIMM PC2700 AES-170X	*	343	*	0	*	0	0	NPI
404	RAWB	PCB-00175-01-A	MSTR FILE, ASR-4805SAS RESPIN	*	1212	*	0	*	0	0	New product, potential new requirement
445	RAWS	DRV-00028-01-A	CHEETAH 10K.6 FC 146GB	*	136	*	59	*	0	0	Service Requirements
479	RAWB	ICS-00070-01-A	IC, U160 SCSI EXPANDER C1	*	796	*	0	*	0	0	Inactive top level skus but not EOL
489	RAWB	16787	IC, PCI6152 PCI BRDG 33MH TBGA	*	7800	*	0	*	0	0	ECO life cycle phase from production to prototype. Inventory procured by AIM
479	WIPB	PCA-500461-02-D	CERA,CCESM, RPETR CARD	*	217	*	0	*	0	0	Used on Eurologic legacy products.
401	WIPB	BM-1050-06-6A	PM3755U2B BOM (1080-ES3)	*	120	*	0	*	0	0	Legacy product but not EOL yet. Inventory will be kept for RMA purpose.
439	RAWB	15516	IC, HDMP2630 2.125 GBPS MQFP	*	2240	*	0	*	0	0	Used on AFC
401	RAWB	1491969-00	HOLDER, AAC-9001 BATTERY CLIP	*	15568	*	0	*	0	0	Product obsoleted; reservation for RMA/serice parts
442	WIPS	TCA-00115-01-C	ALTEVO SAS MIDPLANE, TESTED	*	123	*	0	*	0	0	NPI
445	RAWS	DRV-00046-01-A	DAYTONA U320 36GB	*	247	*	4	*	0	0	Service Requirements
401	RAWB	14685	IC, 28F800FLSH 3V TOP120 TSOP1	*	9607	*	0	*	0	0	Service
401	RAWB	15360	IC, DS2118MB B1 LVD/SE U2 SSOP	*	32550	*	0	*	0	0	Service
445	RAWS	DRV-00027-01-A	CHEETAH 10K.6 U320 36GB	*	198	*	16	*	0	0	Service Requirements
401	RAWB	13960	IC, LT1085 LDO VR 3.3V 3A M	*	13708	*	0	*	0	0	Service
401	RAWB	13704	CAP, CHIP 22UF 20V TA FUS 7343	*	80288	*	0	*	0	0	Service
480	RAWB	1497648-00	SCD, CBL INT ANT F-TYPE	*	28044	*	0	*	0	0	Used on AVC3610
401	RAWB	OS-0016-001	80MHZ CRYSTAL	*	17076	*	0	*	0	0	Service
439	RAWB	12998	IC, CY7B951 CLK RCVRY SO-24	*	881	*	0	*	0	0	Service
401	RAWB	IC-0385-001	4 MEG X 4 60NS 3.3V ECO	*	13560	*	0	*	0	0	Service
401	RAWB	IC-0413-001	80960RN I/O uP H-PBGA	*	401	*	0	*	0	0	Service
479	WIPB	PCA-50466-01-B	USTS, DUAL U BUS BCKPLNE r3.0	*	221	*	0	*	0	0	Service
401	RAWB	14497	CONN, 200-POS RCPT .025"CL SMT	*	4111	*	0	*	0	0	Service
445	RAWS	DRV-00088-01-A	CHEETAH 15K.4 SAS 36GB	*	5	*	60	*	0	0	Service Requirements
439	RAWB	17065	IC, 82545GM GBE CNTLR 1C TFBGA	*	436	*	0	*	0	0	NPI
406	RAWB	16965	IC, 88E1111 GBE PHY XCVR TFBGA	*	2180	*	0	*	0	0	NPI
401	RAWB	14094	CAP, CHIP 10UF 6V TA FUS 3528	*	119357	*	0	*	0	0	Service

* Confidential treatment requested

P.C.	Clas	Material #	Description	*	TOT	*	PO	*	6 MO REQS	TOT REQS	Rationale
401	RAWB	14265	IC, GAL 22V10(PLCC)3.3 15NS 0P	*	9721	*	0	*	0	0	Service
401	RAWB	IC-0339-001	3 AMP 3.3 600MV DROPOUT	*	13946	*	0	*	0	0	Service
439	RAWB	15535	OSC, PECL 106.25MHZ 50PPM SOJ	*	1571	*	0	*	0	0	Service
401	RAWB	IC-0374-001	74CBT16244 16-BT BUS	*	14455	*	0	*	0	0	Service
401	RAWB	IC-0387-001	LTC1643L PCI-BUS 16-PIN SSOP	*	4779	*	0	*	0	0	Service
445	RAWS	DRV-00007-01-A	CHEETAH 5 73LP 10K FCAL	*	56	*	65	*	0	0	Service Requirements
401	WIPB	BM-1051-06-2B	PM3755U2B BOM (COMPAQ) UNIQUE	*	68	*	0	*	0	0	Service Requirements
479	WIPB	PCA-500460-02-A	CERA, TESM, JOINER CARD	*	320	*	0	*	0	0	Mfg reqm't
479	RAWS	PCA-00138-01-A	512MB ECC DIMM PC2700	*	200	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00049-01-A	DIAMONDMAX +9 200GB SATA	*	192	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00062-01-A	DESKSTAR 250GB SATA	*	136	*	217	*	0	0	Service Requirements
445	RAWS	DRV-00026-01-A	CHEETAH 10K.6 U320 73GB	*	74	*	6	*	0	0	Service Requirements
404	WIPB	PCA-00142-01-C	MIDWAY SAS RAID CNTRLR (ENZO)	*	12	*	0	*	0	0	NPI
401	WIPB	BM-1050-06-3C	PM3755U2B BOM	*	33	*	0	*	0	0	Service Requirements
401	WIPB	BM-1050-06-6B	PM3755U2B BOM (1080-ES3)	*	32	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00006-01-A	CHEETAH 5 73LP 10K U160.	*	25	*	28	*	0	0	Service Requirements
445	RAWS	DRV-00034-01-A	CHEETAH 15K.3 FC 18GB	*	64	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00032-01-A	CHEETAH 15K.3 FC 73GB	*	33	*	6	*	0	0	Service Requirements
445	RAWS	DRV-00047-01-A	CUDA V SATA 120GB	*	67	*	0	*	0	0	Service Requirements
479	WIPS	GEN-00174-01-A	IBM DAYTONA DRV KIT AVID	*	1560	*	0	*	0	0	Unforecasted Option
445	RAWS	DRV-00008-01-A	CHEETAH 5 36LD 10K FCAL	*	20	*	14	*	0	0	Service Requirements
445	RAWS	DRV-00033-01-A	CHEETAH 15K.3 FC 36GB	*	31	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00035-01-A	CHEETAH 15K.3 U320 73GB	*	16	*	1	*	0	0	Service Requirements
445	RAWS	DRV-00007-03-A	73LP CH5 10K 520BPS FCAL	*	11	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00003-01-A	CHEETAH 5 36LD 10K U160	*	22	*	27	*	0	0	Service Requirements
479	RAWS	LBL-00025-01-A	LABEL, TOWER, TOP, AVID	*	4679	*	300	*	0	0	Service Requirements
445	RAWS	DRV-00057-01-A	CUDA 7200.7 SATA 160GB	*	52	*	0	*	0	0	Service Requirements
489	RAWB	1495975-00FR	SCD, AWN-8084/FR ROUTER	*	56	*	0	*	0	0	
445	RAWS	DRV-00011-01-A	SEAGATE BARRACUDA 180GB	*	5	*	0	*	0	0	Service Requirements
401	WIPB	BM-1051-06-2A	PM3755U2B BOM (COMPAQ) UNIQUE	*	10	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00040-01-A	DAYTONA FC 73GB	*	14	*	2	*	0	0	Service Requirements
445	RAWS	DRV-00010-01-A	CHEETAH X15 18LD 15K FC	*	35	*	8	*	0	0	Service Requirements

* Confidential treatment requested

P.C.	Clas	Material #	Description	*	TOT	*	PO	*	6 MO REQS	TOT REQS	Rationale
401	WIPB	BM-1230-03-1D	PM3757U2 UART BOM	*	6	*	0	*	0	0	Service Requirements
401	WIPB	PCA-00189-01-A	ICP9085LI (MARAUDER-X)	*	6	*	0	*	0	0	NPI
445	RAWS	DRV-00112-01-A	HITACHI 15K147 4GFC 146GB RoHS	*	4	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00072-01-A	MAP 10K 147GB U320	*	6	*	0	*	0	0	Service Requirements
479	RAWS	20GXR	MOON LS CAM RA03	*	1674	*	0	*	0	0	
445	RAWS	DRV-00036-01-A	CHEETAH 15K.3 U320 36GB	*	9	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00058-01-A	CUDA 7200.7 SATA 80GB	*	21	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00064-01-A	DESKSTAR 160GB SATA	*	15	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00030-01-A	CHEETAH 10K.6 FC 36GB	*	8	*	4	*	0	0	Service Requirements
445	RAWS	DRV-00059-01-A	CUDA 7200.7 SATA 120GB	*	14	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00079-01-B	CHEETAH 15K.4 FC 73GB RoHS	*	4	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00067-01-A	CHEETAH 15K.4 U320 36GB	*	6	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00111-01-A	HITACHI 15K147 4GFC 73GB RoHS	*	4	*	0	*	0	0	Service Requirements
479	WIPS	PAK-00110-02-A	2U, OUTER PAK, AVID	*	30	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00037-01-A	CHEETAH 15K.3 U320 18GB	*	5	*	0	*	0	0	Service Requirements
445	RAWS	GEN-00168-03-A	LABEL AVID DRV 36 LVD	*	564	*	300	*	0	0	Service Requirements
479	RAWS	LBL-00019-05-A	LABEL, TOWER, AVID, BOT	*	996	*	100	*	0	0	Service Requirements
401	WIPB	HA-1050-06-3C	PM3755U2B H/W ASSY 1080-ES2	*	2	*	0	*	0	0	Service Requirements
439	WIPB	PCA-00149-01-B	CALLISTO RESPIN FIBRE CHAN 733	*	1	*	0	*	0	0	NPI
445	RAWS	GEN-00032-01-A	LBL 180GB G5 DRV AVID	*	381	*	0	*	0	0	Service Requirements
479	RAWS	ASA-LBL-3046	LABEL AVID ENCLOSURE	*	702	*	0	*	0	0	Service Requirements
479	RAWS	HDW-PDS03-01-A	STANDOFF,PLASTIC,HEX,.375L	*	880	*	0	*	0	0	Service Requirements
401	WIPB	HA-1050-05-1E	PM3755U2B H/W ASSY	*	1	*	0	*	0	0	Service Requirements
479	WIPS	PAK-00025-01-A	PACK, 2GB DRIVE X4 AVID	*	73	*	55	*	0	0	Service Requirements
479	RAWS	ASA-LBL-BSMI	LBL, AVID BSMI P/N	*	699	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00086-01-A	HITACHI 10K300 FC 73GB	*	1	*	0	*	0	0	Service Requirements
479	RAWS	ASA-LBL-3179	DECAL,BEZEL 36GB AVID G5	*	182	*	0	*	0	0	Service Requirements
479	RAWS	LBL-00022-01-A	LABEL, SCSI, 18GB AVID	*	500	*	0	*	0	0	Service Requirements
479	RAWS	LBL-00022-02-A	LABEL, SCSI, 36GB AVID	*	500	*	0	*	0	0	Service Requirements
445	RAWS	DRV-00048-01-A	DIAMONDMAX +9 160GB SATA	*	2	*	0	*	0	0	Service Requirements
479	RAWS	GEN-00164-08-A	LBL, 146GB SC DRV — AVID	*	240	*	0	*	0	0	Service Requirements
479	WIPS	PAK-BXG108-05-A	PACK, AVID FLEXIBLOC SHELF	*	2	*	88	*	0	0	Service Requirements
443	RAWS	ASA-LBL-3178	AVID DRIVE 18GB LABEL	*	93	*	0	*	0	0	Service Requirements
479	RAWS	HDW-300001	SCREW, 6-32 X .375 HEX H RA01	*	1500	*	0	*	0	0	Service Requirements

* Confidential treatment requested

P.C.	Clas	Material #	Description	*	TOT	*	PO	*	6 MO REQS	TOT REQS	Rationale
439	RAWB	17233	IC, MAX6375 2.32V V DET SC70	*	72	*	0	*	0	0	Service Requirements
479	WIPS	PAK-00024-01-A	PACK, 2GB DRIVE SNG AVID	*	20	*	435	*	0	0	Service Requirements
479	RAWS	ASA-LBL-3180	DECAL,BEZEL 73GB AVID G5	*	53	*	0	*	0	0	Service Requirements
479	WIPB	ASA-ESM	AVID ESM MODULE R.A05	*	12	*	0	*	0	0	Service Requirements

* Confidential treatment requested

ASSET PURCHASE AND SALE AGREEMENT

BY AND AMONG

**SANMINA-SCI CORPORATION
SANMINA-SCI SYSTEMS SINGAPORE PTE. LTD.**

AND

ADAPTEC MANUFACTURING (S) PTE. LTD.

Dated as of December 23, 2005

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EXHIBITS

- Exhibit A – Transition Services Agreement
- Exhibit B – Employee Secondment Agreement
- Exhibit C – Facility Transfer Agreement
- Exhibit D – Supply Agreement

ASSET PURCHASE AND SALE AGREEMENT

THIS ASSET PURCHASE AND SALE AGREEMENT (this “**Agreement**”) is made and entered into as of December 23, 2005, by and among Sanmina-SCI Corporation, a Delaware corporation (“**Parent**”), Sanmina-SCI Systems Singapore Pte. Ltd., a company incorporated in Singapore and a wholly-owned subsidiary of Parent (“**Buyer**”) and Adaptec Manufacturing (S) Pte. Ltd., a company incorporated in Singapore (“**Seller**”). Parent, Buyer and Seller are sometimes referred to herein individually as a “**Party**” and collectively as the “**Parties**.”

RECITALS

A. Seller is engaged the Business at the facility listed on Schedule A (the “**Facility**”). For purpose of this Agreement, the “**Business**” means the printed circuit board assembly manufacturing and storage system manufacturing currently conducted by Seller using the Purchased Assets at the Facility, which Business will be transferred to Buyer pursuant to this Agreement.

B. Seller desires to sell to Buyer, and Buyer desires to purchase from Seller, on the terms and subject to the conditions set forth herein, the Purchased Assets of Seller described herein, and Seller desires Buyer to assume the Assumed Liabilities, which Buyer would agree to assume on the terms and subject to the conditions set forth herein.

C. The Board of Directors of each of Parent, Buyer and Seller believes it is in the best interests of its respective corporation and shareholders that the transactions contemplated hereby be consummated and, in furtherance thereof, has approved this Agreement and the transactions contemplated hereby.

D. Parent, Buyer and Seller desire to make certain representations, warranties, covenants and other agreements in connection with the transactions contemplated hereby.
NOW, THEREFORE, in consideration of the covenants and representations set forth herein, and for other good and valuable consideration, the parties agree as follows:

ARTICLE I

DEFINITIONS

1.1 Certain Definitions. As used in this Agreement, the following terms have the following meanings (terms defined in the singular to have a correlative meaning when used in the plural and vice versa). Certain other terms are defined in the text of this Agreement.

(a) “**Actions or Proceeding**” means any action, suit, proceeding, or arbitration.

- (b) **“Affiliate”** means any Person that directly or indirectly, through one of more intermediaries, controls or is controlled by or is under common control with the Person specified. For purposes of this definition, control of a Person means the power, direct or indirect, to direct or cause the direction of the management and policies of such Person whether by voting power, Contract or otherwise and, in any event and without limitation of the previous sentence, any Person owning ten percent (10%) or more of the voting securities of another Person shall be deemed to control that Person.
- (c) **“Assets”** of any Person means all assets and properties of every kind, nature, character and description (whether real, personal or mixed, whether tangible or intangible, whether absolute, accrued, contingent, fixed or otherwise and wherever situated), including the goodwill related thereto, operated, owned or leased by such Person, including without limitation, accounts and notes receivable, chattel paper, documents, instruments, general intangibles, real estate, equipment, inventory and goods.
- (d) **“Assumed Liabilities”** has the meaning set forth in Section 2.2(b).
- (e) **“Books and Records”** of any Person means all files, documents, instruments, papers, books and records relating to the business, operations, condition of (financial or other), results of operations and Assets of such Person, including without limitation financial statements, Tax Returns, budgets, reliability and cost data, pricing guidelines, ledgers, journals, deeds, title policies, minute books, stock certificates and books, stock transfer ledgers, Contracts, Permits, customer lists, computer files and programs, retrieval programs, operating data and plans and environmental studies and plans.
- (f) **“Business Day”** shall mean a day other than Saturday and Sunday or any day on which banks located in the Republic of Singapore or the State of California are authorized or obligated to close.
- (g) **“Closing Fixed Asset and Inventories Statement”** means the statement of Closing Net Asset Value of Fixed Assets and Inventories based on the unaudited pro forma balance sheet in respect of the Business as of the Closing Date, prepared in accordance with generally accepted accounting principles as consistently applied by Seller in Seller’s preparation of its periodic financial statements in each of the three quarters which precede the Closing Date (other than the omission of notes and normal reoccurring adjustments).
- (h) **“Closing Date”** means the date which is two (2) business days following the satisfaction or, if permitted pursuant to the terms of Article VII hereof, waiver of the conditions to Closing set forth in Article VII hereof, or at such other place and such other time or date as the parties hereto shall mutually agree.
- (i) **“Closing Documents”** means all those documents, deeds and other instruments which are required by the Definitive Agreements or by operation of law for the consummation of the purchase and sale of the Purchased Assets pursuant to this Agreement and the Ancillary Agreements and the other transactions contemplated thereby (the **“Transaction”**).

- (j) “**Closing Net Asset Value**” shall mean the following:
- (i) an amount equivalent to the standard cost of Inventories as of November 4, 2005 on the books of Seller on the Closing Date and, to the extent Inventories did not have standard cost on the books of Seller as of November 4, 2005, standard cost as of the Closing Date; **plus**
- (ii) an amount equivalent to the net book value of Fixed Assets on the books of Seller as of the Closing Date.
- (k) “**Critical Employees**” shall mean the mean the Employees identified on Schedule 5.7 hereto.
- (l) “**Definitive Agreements**” means this Agreement, the Ancillary Agreements and the other the binding, detailed and definitive agreements to be executed between the Parties in respect of the Transaction.
- (m) “**Employee**” means each employee or consultant of Seller, including without limitation Transferred Employees, who is employed in connection with the Business.
- (n) “**Employee Secondment Agreement**” shall mean that certain agreement substantially in the form attached as Exhibit B hereto pursuant to which certain employees of Seller engaged in the Business will be seconded to Buyer.
- (o) “**Employment Liabilities**” shall mean any and all claims, debts, liabilities, commitments and obligations, whether fixed, contingent or absolute, matured or unmatured, liquidated or unliquidated, accrued or unaccrued, known or unknown, whenever or however arising, including all costs and expenses relating thereto arising under law, rule, regulation, permit, action or proceeding before any governmental authority, order or consent decree or any award of any arbitrator of any kind relating to any benefit plan, employment agreement or otherwise relating to an Employee and his or her employment with Seller.
- (p) “**Escrow Agreement**” shall mean the escrow agreement in the form reasonably agreed upon by Buyer, Seller and Citibank, N.A. (or such other escrow agent as Seller and Buyer shall agree), as escrow agent (the “**Escrow Agent**”).
- (q) “**Excluded Liabilities**” has the meaning set forth in Section 2.2(c).
- (r) “**Execution Date**” means the date of the signing and execution of the Definitive Agreements.
- (s) “**Expensed Items**” means supplies and similar consumable material on hand at the Facility that are related to and of a nature customarily used in the Business (other than such supplies and materials associated with any Excluded Assets).
- (t) “**Facility**” means the facility used in the operation of the Business and located at the location set forth on Exhibit A, including all leasehold and facility improvements thereto and fixtures.

- (u) **“Facility Transfer Agreement”** means the agreement substantially in the form attached as Exhibit C hereto pursuant to which ownership of the Facility will be transferred to Buyer.
- (v) **“Fixed Assets”** means all items of plant, equipment, machinery, tools, furniture and furnishings, office materials and supplies and other fixed assets listed or described in Schedule 1.1(v) as of the Closing Date, *provided, however*, that as defined herein Fixed Assets shall not include any of the Excluded Assets and the Facility, including the Facility, leasehold improvements and fixtures or any buildings or other structures, information technology systems (other than Purchased IT Systems) or custom equipment, including but not limited to custom, Business-specific test fixtures, that can only be used in the Business and is not readily adaptable to alternative uses and including equipment utilized by the ASIC and desktop software group engineering teams of Seller that are located at the Facility.
- (w) **“Governmental Body”** means any:
- (i) nation, province, state, county, city, town, village, district, or other jurisdiction of any nature;
 - (ii) federal, provincial, state, local, municipal, foreign, or other government;
 - (iii) governmental or quasi-governmental authority of any nature (including any governmental agency, branch, department, official, or entity and any court or other tribunal);
 - (iv) multi-national organization or body; or
 - (v) body exercising, or entitled to exercise, any administrative, executive, judicial, legislative, police, regulatory, or taxing authority or power of any nature.
- (x) **“GST Tax Amount”** shall mean an amount equal to Singapore Goods and Services Tax (“GST”) that may be chargeable in respect of the sale of the Purchased Assets under this Agreement.
- (y) **“Indebtedness”** of any Person means all monetary obligations of such Person (i) for borrowed money, (ii) evidenced by notes, bonds, debentures or similar instruments, (iii) for the deferred purchase price of goods or services (other than trade payables or accruals incurred in the ordinary course of business), (iv) under capital leases or (v) in the nature of guarantees of the obligations described in clauses (i) through (iv) above of any other Person.
- (z) **“Intellectual Property”** means any or all of the following and all worldwide common law and statutory rights in, arising out of, or associated therewith: (i) United States and foreign patents and utility models and applications therefor and all reissues, divisions, reexaminations, renewals, extensions, provisional, continuations and continuations-in-part thereof (**“Patents”**); (ii) inventions (whether patentable or not), improvements, trade secrets, proprietary information, know-how, and any rights in technology, invention disclosures,

technical data and customer lists, and all documentation relating to any of the foregoing; (iii) copyrights, copyright registrations and applications therefor, and all other rights corresponding thereto throughout the world; (iv) domain names, uniform resource locators (“URLs”), other names and locators associated with the Internet, and applications or registrations therefor (“Domain Names”); (v) industrial designs and any registrations and applications therefor; (vi) trade names, logos, common law trademarks and service marks, trademark and service mark registrations, related goodwill and applications therefor throughout the world (“Trademarks”); (vii) all rights in databases and data collections; (viii) all moral and economic rights of authors and inventors, however denominated; and (ix) any similar or equivalent rights to any of the foregoing (as applicable).

(aa) “**Inventories**” means all good production ready inventories of raw materials and work in process listed on Schedule 1.1(aa) as of the Closing Date. Schedule 1.1(aa) shall include Inventories which, based on firm, non-cancelable customer purchase orders or customer forecasts, which Seller believes will be used in products to be delivered to Seller within the six (6) month period following the Closing Date. For purposes of Section 6.2 hereof, the term “Inventories” shall also include material, components and other supplies acquired by Seller pursuant to purchase orders or other Assigned Contracts assumed by Sellers hereunder as of the Closing Date. Inventories shall not include finished goods.

(bb) “**Law**” means any law, statute, rule, regulation, ordinance, extension order, or other pronouncement having the effect of law of the United States, any foreign country or any U.S., Singapore or foreign state, county, city or other political subdivision or of any Governmental Body.

(cc) “**Liability**” means any Indebtedness, obligation or other liability of a Person (whether absolute, accrued, contingent, fixed or otherwise, or whether due or to become due).

(dd) “**Lien**” means any mortgage, pledge, lien, charge, claim, security interest, adverse claims of ownership or use, restrictions on transfer, defect of title or other encumbrance of any sort, other than (a) mechanic’s, materialmen’s, and similar liens with respect to any amounts not yet due and payable, and (b) customary liens for Taxes not yet due and payable.

(ee) “**Material Adverse Effect**” means with respect to (i) Parent or Buyer, any material adverse change in the business, operations, assets (including intangible assets), liabilities (contingent or otherwise), results of operations or financial performance or condition (financial or otherwise) of such Party, which is material to Parent and Buyer, taken as a whole, and (ii) with respect to Seller, any material adverse change in the business, operations, assets (including intangible assets), liabilities (contingent or otherwise), results of operations or financial performance or condition (financial or otherwise) of such Party which is material to the Business taken as a whole; *provided, however*, that in determining whether a Material Adverse Effect has occurred, any effect to the extent attributable to the following shall not be considered: (a) changes in laws, rules or regulations of general applicability or interpretations thereof by governmental entities, and (b) any effects resulting from the announcement of this Agreement in accordance with this Agreement.

- (ff) **“Multiemployer Plan”** shall mean any “Pension Plan” which is a “multiemployer plan,” as defined in Section 3(37) of ERISA.
- (gg) **“Order”** means any writ, judgment, decree, injunction, administrative order, directive or similar order or directive of any Governmental Body (in each such case whether preliminary or final).
- (hh) **“Permit”** shall mean the licenses, permits, authorizations, registrations, certificates, variances, approvals, consents and franchises and similar rights obtained from governments and any Governmental Body, and any pending applications relating to the foregoing.
- (ii) **“Person”** means any individual, corporation (including any non-profit corporation), company, general or limited partnership, limited liability company, joint venture, estate, trust, association, organization, labor union, Governmental Body or other entity.
- (jj) **“Preliminary Fixed Asset and Inventories Statement”** means the statement of Preliminary Net Asset Value of Fixed Assets and Inventories based upon Seller’s good faith estimate of the unaudited pro forma balance sheet in respect of the Business as of the Closing Date prepared in accordance with generally accepted accounting principles as consistently applied by Seller in Seller’s preparation of its periodic financial statements in each of the three quarters which precede the Closing Date (other than the omission of notes and normal reoccurring adjustments).
- (kk) **“Preliminary Net Asset Value”** shall mean the following:
- (i) an amount equivalent to the standard cost of Inventories as of November 4, 2005 on the books of Seller on the Closing Date and, to the extent Inventories did not have standard cost on the books of Seller as of November 4, 2005, standard cost as of the Closing Date; **plus**
- (ii) an amount equivalent to the net book value of Fixed Assets on the books of Seller as of the Closing Date
- (ll) **“Purchased IT Systems”** are those systems set forth on Schedule 1.1(II).
- (mm) **“Purchase Order”** means all material, components and other supplies to be acquired by Seller pursuant to purchase orders listed on Schedule 1.1(mm) which are not Inventory or Expensed Items. Schedule 1.1(mm) shall include purchase orders for material, components and other supplies which, based on firm, non-cancelable customer purchase orders or customer forecasts, Seller reasonably believes will be used in products to be delivered to Seller within the six (6) month period following the Closing Date after taking into account the Inventory set forth on Schedule 1.1(aa).
- (nn) **“Purchase Price”** means an amount equal to the Preliminary Net Asset Value (as adjusted pursuant to Section 2.4) (the **“Preliminary Net Asset Value Amount”**) **plus** the purchase price of the Facility (the **“Facility Purchase Price”**) of \$9.5 million.

(oo) **“Representatives”** means, with respect to a Person, that Person’s officers, directors, employees, accountants, counsel, investment bankers, financial advisors, agents and other representatives.

(pp) **“Seller’s Retained Environmental Liabilities”** means any liability, obligation, judgment, penalty, fine, cost or expense, (including reasonable attorneys’ fees and environmental consultant costs) of any kind or nature, or the duty to indemnify, defend or reimburse any Person (an **“Environmental Liability”**) with respect to: (i) the presence on or before the Closing Date of any Hazardous Material in the soil, groundwater, surface water, air or building materials of any Business Facility (other than any Hazardous Material in Inventory Fixed Asset and Expenses Items), or known by Seller to be migrating to any Business Facility as of the Closing Date (**“Pre-Existing Contamination”**); (ii) the migration at any time prior to or after the Closing Date of Pre-Existing Contamination to any other real property, or the soil, groundwater, surface water, air or building materials thereof; (iii) the exposure of any Person to Pre-Existing Contamination or to Hazardous Materials in the course of or as a consequence of any activities of the operation of the printed circuit board assembly manufacturing and storage system manufacturing business conducted by Seller in Singapore prior to the Closing, without regard to whether any health effect of the exposure has been manifested as of the Closing Date; (iv) the violation of any Environmental Laws by the Seller or its agents, employees, predecessors in interest, contractors, invitees or licensees prior to the Closing Date or in connection with the operation of the Business prior to the Closing Date; (v) any actions or proceedings brought or threatened by any third party with respect to any of the foregoing that they existed as of the Closing Date and (vi) Section 1.1(pp)(iv) to the extent it continues during the six (6) month period following the Closing Date; provided, however, that to the extent Buyer becomes aware of any of the foregoing during the six (6) month period following the Closing Date and such liability arises from Buyer’s continued operation of the Business, Buyer shall promptly notify and confer with Seller and shall take reasonable steps to mitigate and if appropriate remediate such noncompliance provided that Seller shall reimburse Buyer for reasonable costs incurred therefore. For the avoidance of doubt, such remediation costs shall be included in Seller’s Retained Environmental Liabilities. The foregoing notwithstanding, an Environmental Liability shall not be considered a Seller’s Retained Environmental Liability to the extent it arises from Buyer’s negligent actions.

(qq) **“Subsidiaries”** means any and all corporations, partnerships, joint ventures, associations and other entities controlled by the applicable Person directly or indirectly through one or more intermediaries.

(rr) **“Supply Agreement”** means that certain Supply Agreement attached hereto as Exhibit D entered into by Buyer and Seller as of the date hereof relating to the provision of manufacturing services by Buyer.

(ss) **“Transferred Employee”** means any Employee or other individual currently providing services to Seller who becomes an employee of Buyer as a result of the Secondment Agreement.

(tt) **“Transition Services Agreement”** means that certain Transition Services Agreement substantially in the form attached hereto as Exhibit A to be entered into by Buyer and

Seller in substantially the same form at the Closing with respect to the provision of certain transition services with respect to the Business following the Closing Date.

ARTICLE II

PURCHASE AND SALE OF ASSETS

2.1 Purchase and Sale of Assets.

- (a) Purchase and Sale of Assets Purchase and Sale. Upon the terms and subject to the conditions set forth herein, at the Closing (as defined in Section 2.3(a) hereof), Buyer shall purchase from Seller, and Seller shall irrevocably sell, convey, transfer, assign and deliver to Buyer, the Purchased Assets (as defined in Section 2.1(b) hereof), free and clear of all Liens (other than Permitted Liens). All payment amounts expressed in this Agreement are in U.S. dollars.
- (b) Definition of Purchased Assets. For all purposes of and under this Agreement, the term “**Purchased Assets**” shall mean, refer to and include all of Seller’s right, title and interest in and to all of the following tangible and intangible assets, properties and rights to the extent owned, used or held for use by Seller as of the Closing (but specifically excluding the Excluded Assets (as defined in Section 2.1(c) hereof)):
- (i) the Fixed Assets, the Inventories, Purchased IT Systems, the Expensed Items and the other tangible personal property used in connection with the Business, and listed on Schedule 2.1(b)(i) hereto (the “**Tangible Personal Property**”);
- (ii) all rights of Seller in, to or under (A) the leases or subleases of Tangible Personal Property listed on Schedule 2.1(b)(ii)(A) as to which Seller is the lessor or sublessor, and (B) the leases of Tangible Personal Property listed on Schedule 2.1(b)(ii)(B) as to which Seller is the lessee or sublessee, together with any options to purchase the underlying property (the leases and subleases described in subclauses (A) and (B) hereof, the “**Personal Property Leases**”);
- (iii) all Books and Records of Seller solely relating to the Purchased Assets and necessary for the conduct of the Business at the Closing, other than Books and Records of Seller concerning trade secrets or other confidential information of Seller, privileged information, internal financial statements and related information or records; and files and records of Employees or related human resource matters prior to the Closing (the “**Seller Records**”);
- (iv) all rights under any contracts, indentures, mortgages, instruments, Liens, guaranties or other agreements of Seller set forth on Schedule 2.1(b)(iv) and the Purchase Orders, other than the Excluded Agreements (the “**Assigned Contracts**”);
- (v) all Permits (including applications therefor) used in the conduct of the Business set forth in Schedule 2.1(b)(v) (the “**Assumed Permits**”);

(vi) all prepaid expenses listed in Schedule 2.1(b)(vi), and all prepaid expenses made following the date hereof and prior to the Closing that relate exclusively to the Business (the “**Prepaid Expenses**”); and

(vii) all security deposits deposited by or on behalf of Seller as lessee or sublessee under the leases for the Personal Property Leases (the “**Security Deposits**”).

The foregoing notwithstanding, the definition of “Purchased Assets” shall not include “Expensed Items” for purposes of the representations and warranties set forth in Article III of this Agreement.

(c) Definition of Excluded Assets. Notwithstanding anything to the contrary set forth in this Section 2.1 or elsewhere in this Agreement, the term “**Purchased Assets**” shall not mean, refer to or include the following (collectively, the “**Excluded Assets**”) to the extent owned, used or held for use by Seller as of the Closing:

(i) Cash, cash equivalents, investments in cash, securities or otherwise and all Seller bank accounts;

(ii) all refunds of Taxes with respect to Taxes paid or accrued by Seller and not reimbursed or paid by Buyer;

(iii) all claims, actions, deposits, prepayments, refunds, causes of action, choses in action, rights of recovery, rights of set off, and rights of recoupment of any kind or nature (including any such item relating to Taxes) to the extent attributable to the Excluded Agreements, Excluded Assets or the Excluded Liabilities;

(iv) all rights of Seller under this Agreement and Ancillary Agreement, or any other agreement, certificate, instrument or other document executed and delivered by Seller or Buyer in connection with the Transaction or any side agreement between Seller and Buyer entered into on or after the date hereof;

(v) all Books and Records of Seller which relate to the Taxes, Excluded Agreements or Excluded Assets; *provided, however,* Seller agrees that it shall provide Buyer with copies of, or reasonable access to, such Books and Records to the extent that any such Books and Records (i) relate to any of the Business, the Purchased Assets or Assumed Liabilities; and (ii) do not reflect confidential information or privileged materials;

(vi) all accounts receivable and all notes, bonds and other evidences of Indebtedness, and all security agreements related thereto, including any rights with respect to any third party collection procedures or any other Actions or Proceedings which have been commenced in connection therewith;

(vii) all Intellectual Property of Seller, including the trade name Adaptec and derivatives thereof and logos associated therewith and all related trademarks and service marks, and software licenses.

(viii) all assets other than Purchased Assets, including but not limited to land, buildings, leasehold improvements, information technology systems, hardware and software (and other related intellectual property) and custom equipment including specifically custom test fixtures specific to the Business and including equipment and assets utilized by the ASIC and desktop software group engineering teams of Seller.

(ix) all capital stock, options and other securities of Seller, and all corporate minutes and stock books of account of Seller, blank stock certificates, qualifications to conduct business as a foreign corporation, arrangements with registered agents relating to foreign qualifications, taxpayer and other identification numbers, seals and other documents relating to the organization, maintenance and existence of Seller as a corporation;

(x) all agreements and contracts to which Seller is a party or is bound or to which its assets are subject that are not Assigned Contracts; and

(xi) all assets or rights that relate to the Employee Plans of Seller, all Books and Records relating to the Employees of Seller as of the Closing.

2.2 Assumption of Liabilities.

(a) Assumption. Upon the terms and subject to the conditions set forth herein, at the Closing, Buyer shall assume from Seller, and Seller shall irrevocably convey, transfer and assign to Buyer, all of the Assumed Liabilities (as defined in Section 2.2(b) hereof). Buyer shall not assume any liabilities of Seller pursuant hereto, other than the Assumed Liabilities.

(b) Definition of Assumed Liabilities. For all purposes of and under this Agreement, the term “**Assumed Liabilities**” shall mean, refer to and include the following Liabilities of Seller (but specifically excluding the Excluded Liabilities (as defined in Section 2.2(c) hereof)):

(i) all Liabilities under Assumed Permits arising after the Closing Date; and

(ii) all Liabilities related to the Purchased Assets or the operation of the Business to the extent arising from or related to any facts or circumstances occurring after the Closing Date;

(iii) all Liabilities relating to Employees that are hired by Buyer or Parent for actions that occur after the date of hire.

(c) Definition of Excluded Liabilities. Notwithstanding anything to the contrary set forth in this Section 2.2 or elsewhere in this Agreement, the term “**Assumed Liabilities**” shall not mean, refer to or include the following (collectively, “**Excluded Liabilities**”):

(i) all Liabilities relating to agreements not assumed by Buyer (the “**Excluded Agreements**”);

- (ii) any and all Liabilities or obligations of Seller arising from the breach by Seller of any term, covenant or provisions of any of the Assigned Contracts prior to the Closing;
- (iii) subject to Section 2.6, all Liabilities for Taxes of Seller or Taxes attributable to the ownership or operation of the Purchased Assets for any taxable period (or portion of any period) ending on or prior to the Closing Date and, including, without limitation, all liabilities for Taxes attributable to the Transaction;
- (iv) all Liabilities relating to options, warrants and other rights to purchase or otherwise acquire shares of capital stock of Seller or any Affiliate of Seller;
- (v) all Liabilities to shareholders of Seller or any Affiliate of Seller in their capacity as such;
- (vi) all Liabilities of Seller under the Definitive Agreements or any other certificate, instrument or other agreement entered into by the Parties in connection with the Transaction;
- (vii) except as set forth in Section 2.2(b), all Employment Liabilities and all Liabilities arising under or with respect to any Pension Plan;
- (viii) Seller's Retained Environmental Liabilities;
- (ix) all Liabilities for legal, accounting, audit and investment banking fees, brokerage commissions, and any other expenses incurred by the Seller in connection with the Transaction;
- (x) all Liabilities for or related to Indebtedness of Seller, on its own behalf or on behalf of other Persons, to banks, financial institutions or other Persons with respect to borrowed money, and including any accrued interest payable in respect thereof;
- (xi) all Liabilities that are attributable to any of the Excluded Assets;
- (xii) all Liabilities of Seller with respect to accounts payable;
- (xiii) all Liabilities of Seller for injury to or death of persons (including, without limitation, workers' compensation claims) or damages to or destruction of properties or assets, arising from the sale or distribution of products distributed, or business services provided, by Seller on or before the Closing Date, whether or not any such liability arises before or after the Closing Date, including, without limitation, liability for consequential and punitive damages in connection with the foregoing; and
- (xiv) all Liabilities other than Assumed Liabilities.

2.3 Closing.

- (a) The consummation of the purchase and sale of the Purchased Assets (the “**Closing**”) shall take place at such place as Buyer and Seller mutually agree, at 10:00 A.M. local time, on the Closing Date unless otherwise mutually agreed by Buyer and Seller. The Closing shall be deemed to be effective as of 12:01 A.M., local time, at the place where the Purchased Assets are located on the applicable Closing Date (the “**Closing Time**”).
- (b) As soon as practicable following the date hereof and at all times until the Closing of the purchase by Buyer of all of the Purchased Assets listed or described in Section 2.1(b), Buyer and Seller shall cooperate in good faith to (i) formulate and effect a plan and closing schedule for the transfer of the Purchased Assets and the Business to Buyer pursuant to this Agreement, and (ii) identify the Purchased Assets to be purchased by Buyer pursuant to this Agreement at the Closing, and (iii) identify the Assumed Liabilities to be assumed by Buyer pursuant to this Agreement at the Closing.
- (c) At least five (5) Business Days prior to the Closing Date, Seller shall furnish to Buyer the Preliminary Fixed Asset and Inventories Statement indicating the Preliminary Net Asset Value as of such date. Buyer shall have been given full access to the relevant records and working papers used by Seller to prepare the Preliminary Fixed Asset and Inventories Statement. The Preliminary Fixed Asset and Inventories Statement shall be reasonably acceptable to Buyer; *provided, however,* that the Preliminary Fixed Asset and Inventories Statement shall be deemed to be reasonably acceptable to Buyer if prepared in accordance with the terms of this Agreement.
- (d) At the Closing, on the terms and subject to the conditions set forth in this Agreement, as full payment for the transfer of the Purchased Assets by Seller to Buyer, Parent and/or Buyer shall pay to Seller the Purchase Price (as defined below) and the GST Tax Amount by wire transfer of immediately available funds in United States dollars to such account or accounts as Seller may direct by written notice delivered to Buyer by Seller at least two (2) Business Days prior to the applicable Closing Date, subject to Section 2.3(f) below with respect to the Escrow.
- (e) At the Closing, and simultaneously with the payment of the Purchase Price and the GST Tax Amount payable in connection therewith pursuant to Section 2.3(d), (i) Seller shall assign and transfer to Buyer good and valid title in and to the Purchased Assets (free and clear of all Liens, other than Permitted Liens) by delivery of (A) a General Assignment and Bill of Sale in form and substance reasonably acceptable to Buyer and Seller (the “**General Assignment**”), duly executed by Seller; (B) the Facility Transfer Agreement duly executed by Seller; and such other instruments of conveyance, assignment and transfer as Buyer shall reasonably request, in form and substance reasonably acceptable to Buyer and Seller, as shall be effective to vest in Buyer good and valid title to the applicable Purchased Assets as contemplated by this Agreement (the General Assignment and the other instruments being collectively referred to herein as the “**Assignment Instruments**”); and (ii) Buyer shall assume from Seller the due payment, performance and discharge of the Assumed Liabilities by delivery of (A) an Assumption Agreement in form and substance reasonably acceptable to Seller and Buyer (the “**Assumption Agreement**”), duly executed by Buyer and (B) such other instruments of

assumption as Seller shall reasonably request, in form and substance reasonably acceptable to Seller and Buyer, as shall be effective to cause Buyer to assume the Assumed Liabilities as and to the extent provided in Section 2.2(b) (the Assumption Agreement and such other instruments referred to in clause (ii)(B) being collectively referred to herein as the “**Assumption Instruments**”). At the Closing, there shall also be delivered to Seller and Buyer the certificates and other contracts, documents and instruments required to be delivered pursuant to Article VII hereof.

(f) **Escrow.** At the Closing, ten percent (10%) of the Purchase Price being paid under Section 2.3(d) above shall be paid to the Escrow Agent to be held and administered by the Escrow Agent in escrow as security for the indemnification obligations of Seller for Damages under Article IX (the “**Escrow**”) pursuant to the terms of the Escrow Agreement; *provided* that to the extent the Purchase Price is adjusted pursuant to Section 2.4, (i) upward, then ten percent of such Increase Amount payable by Buyer under Section 2.4(f)(i) shall be paid into Escrow and held pursuant to the Escrow Agreement, or (ii) downward, then ten percent (10%) of such Decrease Amount will be paid by the Escrow Agent to Buyer. In addition, to the extent that Buyer and/or Parent exercises its Put Right under Sections 6.2 or 6.3 of the Purchase Agreement, and the Seller purchases certain Unused Inventories or Inventories from the Buyer and/or Parent, all or a portion of the purchase price of such Unused Inventories or Inventories shall be paid by the release of an amount equal to such purchase price of such inventories (calculated in accordance with Sections 6.2 and 6.3) from the Escrow Account to the Buyer and/or Parent (the “**Inventory Escrow Amount**”); provided, however, that the Inventory Escrow Amount shall not exceed ten (10%) percent of the portion of the Purchase Price paid for the Inventories as determined in Section 1.1(j)(i). Any amounts then held in Escrow and not previously paid in respect of any claims for indemnification under Article IX or, released in connection with Seller’s purchase of Inventory under Sections 6.2 or 6.3, or subject to any pending claims under Article IX, shall be released to Seller not more than five (5) days after the twelve month anniversary of the Closing (the “**Escrow Release Date**”). Any amounts earned in respect of the Escrow shall be considered a part of the Escrow and held pursuant to the Escrow Agreement.

2.4 Post-Closing Purchase Price Adjustments.

(a) **Preparation of Closing Net Asset Value Statement.** As soon as reasonably practicable after the Closing Date (within thirty five (35) days if commercially reasonable but, in any event, not later than forty-five (45) days after the Closing Date), Seller shall prepare and deliver to Buyer at Seller’s expense an unaudited Closing Fixed Asset and Inventories Statement indicating the Closing Net Asset Value as of the Closing Date (the “**Closing Net Asset Value Statement**”). The date Seller delivers the Closing Net Asset Value Statement shall be referred to as the “**Notice Date**”. Buyer shall reasonably cooperate with Seller’s finance organization in order to enable the preparation of the Closing Fixed Asset and Inventories Statement.

(b) **Verification.** As soon as reasonably practicable after the Notice Date (but not later than thirty (30) days after the Notice Date), Buyer shall verify (i) that the Fixed Assets and the Inventories stated in the Preliminary Fixed Asset and Inventories Statement and the statement of the Preliminary Net Asset Value accurately reflect the Fixed Assets and Inventories delivered to Buyer as part of the Purchased Assets at the Closing and (ii) that the Closing Net

Asset Value is accurately reflected on the Closing Fixed Asset and Inventories Statement (the “**Verification**”). Seller shall reasonably cooperate with Buyer in order to enable Buyer to perform the Verification.

(c) Review of Preliminary Closing. Buyer shall be given full access, during regular business hours, to the relevant records and working papers used by Seller to prepare the Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement and to review the results of the Verification in relation to the Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement. If Buyer believes that any changes are required to be made to the Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value (including but not limited to changes based on differences between the Closing Fixed Asset and Inventories Statement the results of the Verification) (a “**Material Uncertainty**”), Buyer shall, within the later of seventy-five (75) days following the Closing Date or thirty (30) days following the receipt by it of the Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement (the “**Dispute Period**”), give written notice to Seller (a “**Dispute Notice**”) of any such proposed change or Material Uncertainty, describing the change or Material Uncertainty and the basis for the change or Material Uncertainty in reasonable detail. The Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement shall be binding and conclusive upon, and deemed accepted by, Buyer unless Buyer shall have timely delivered a Dispute Notice to Seller during the Dispute Period.

(d) Disputes. Disputes between Buyer and Seller relating to the Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement that cannot be resolved by them through negotiation within thirty (30) days after receipt by Seller of a Dispute Notice shall be referred to an independent accounting firm reasonably agreed upon by the Parties for arbitration (the “**Independent Accountant**”) with respect to the Dispute Notice. The Independent Accountant will be instructed to select, in its discretion, the individuals within its organization who will have primary responsibility for this matter and to reach a determination within forty-five (45) days from the date of referral. The Independent Accountant determination hereunder shall be limited to determining the Closing Net Asset Value. The Independent Accountant will not have the authority alter or vary this Agreement. The decision of the Independent Accountant will be final and binding upon the Parties. The engagement of the Independent Accountant shall be paid one-half by Seller and one-half by Buyer. The Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement as adjusted by the Independent Accountant in accordance with this Section 2.4(d), shall be final and binding on the parties. It is understood and agreed that the decision of the Independent Accountant shall not be subject to judicial review by any court or tribunal under any circumstances whatsoever and the Parties hereby expressly waive any right to appeal or otherwise seek judicial review of any decision of the Independent Accountant under this Section 2.4(d).

(e) Final Closing Fixed Asset and Inventories Statement. The Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement shall become final with respect to all or any portion thereof, and binding upon Buyer and Seller upon the earlier of (i) the failure by Buyer to timely object to all or any portion thereof during the Dispute Period, (ii) an agreement between Buyer and Seller with respect thereto, or (iii) the decision by the Independent Accountant with respect to any disputed matters pursuant to Section 2.4(d). The

Closing Fixed Asset and Inventories Statement and the Closing Net Asset Value Statement as finally determined under this Section 2.4, shall be referred to herein as the “**Final Closing Fixed Asset and Inventories Statement**” and the “**Final Closing Net Asset Value**,” respectively.

(f) Adjustment to the Closing Net Asset Value. The Preliminary Net Asset Value Amount paid at the Closing shall be subject to adjustment pursuant to the following provisions of this Section 2.4(f):

(i) If the Final Closing Net Asset Value as reflected in the Final Closing Fixed Asset and Inventories Statement is less than the Preliminary Net Asset Value as reflected in the applicable Preliminary Fixed Asset and Inventories Statement, then the Final Closing Net Asset Value shall be decreased on a dollar-for-dollar basis by an amount (the “**Decrease Amount**”) equal to the amount by which the Final Closing Net Asset Value as reflected in the Final Closing Fixed Asset and Inventories Statement is less than the Preliminary Net Asset Value as reflected in the Preliminary Fixed Asset and Inventories Statement, and the Decrease Amount shall be payable ninety percent (90%) from Seller to Buyer and ten percent (10%) released from the Escrow by the Escrow Agent to Buyer in immediately available funds pursuant to Section 2.4(g). In the event of a Decrease Amount, there shall be a corresponding adjustment to the GST Tax Amount.

(ii) If the Final Closing Net Asset Value as reflected in the Final Closing Fixed Asset and Inventories Statement is greater than the Preliminary Net Asset Value as reflected in the Preliminary Fixed Asset and Inventories Statement, then the Final Closing Net Asset Value shall be increased on a dollar-for-dollar basis by an amount (the “**Increase Amount**”) equal to the amount by which the Final Closing Net Asset Value as reflected in the Final Closing Fixed Asset and Inventories Statement is greater than the Preliminary Net Asset Value as reflected in the Preliminary Fixed Asset and Inventories Statement, and ninety percent (90%) of the Increase Amount shall be payable by Buyer to Seller in immediately available funds pursuant to Section 2.4(g), and ten percent (10%) of the Increase Amount shall be payable by Buyer to the Escrow Agent to be held in Escrow pursuant to the Escrow Agreement. In the event of an Increase Amount, there shall be a corresponding adjustment to the GST Tax Amount.

(g) Payments of Adjustment Amount. As soon as practicable (but not more than ten (10) Business Days) after all or any portion of a Closing Net Asset Value shall become final and binding pursuant to Section 2.4(e) hereof, Buyer or Seller, as the case may be, shall make the payment contemplated by Section 2.4(f) in respect of all or such portion of such Closing Net Asset Value that has become final and binding (it being the intention of the parties that the payment of all undisputed amounts set forth in the Final Closing Fixed Asset and Inventories Statement that become final and binding pursuant to Section 2.4(e) shall not be contingent upon the resolution of any disputed amounts set forth in such Final Closing Fixed Asset and Inventories Statement).

2.5 Prorations. The following prorations relating to the Purchased Assets and the ownership and conduct of the Business shall be made as of the Closing Date, with Seller liable to the extent such items relate to any time period up to the Closing Date, and Buyer liable to the extent such items relate to periods beginning at and immediately after the applicable Closing Date:

- (a) Governmental property or similar taxes or levys on or with respect to the Purchased Assets;
- (b) rents, additional rents, operating expense pass throughs, Taxes and other items payable by Seller under any personal property leases; and

Except as otherwise agreed by the parties, the net amount of all such pro-rations will be settled and paid on the Closing Date.

2.6 Taxes. Buyer and Seller shall bear equally any sales, use, value-added, gross receipts, excise, registration, stamp duty or other similar taxes or governmental fees arising out of the transfer of the Purchased Assets to Buyer pursuant hereto ("**Transfer Taxes**"); *provided* Buyer shall pay GST that may be chargeable in respect of the sale of the Purchased Assets under this Agreement subject to Seller issuing and delivering to Buyer a tax invoice relating to such GST and provided that GST is chargeable or payable with respect to the sale of the Purchased Assets under this Agreement and such sale is not considered by the relevant tax authorities in Singapore to be a sale of a business as a going concern. To the extent permitted by applicable law, Parent, Buyer and Seller shall cooperate in minimizing Transfer Taxes.

(a) Straddle Period Taxes. In the case of any real or personal property taxes or any similar ad valorem taxes attributable to the Purchased Assets for which Taxes are reported on a Tax Return covering a period commencing before the Closing and ending thereafter (a "**Straddle Period Tax**"), any such Straddle Period Taxes shall be prorated between Buyer and Seller on a per diem basis. The party required by law to file a Tax Return with respect to Straddle Period Taxes shall do so within the time period prescribed by law.

(b) Tax Returns. To the extent relevant to the Business or the Purchased Assets, each party shall (i) provide the other with such assistance as may reasonably be required in connection with the preparation of any Tax Return and the conduct of any audit or other examination by any governmental authority or in connection with judicial or administrative proceedings relating to any liability for Taxes and (ii) retain and provide the other with all records or other information that may be relevant to the preparation of any Tax Returns, or the conduct of any audit or examination, or other proceeding related to Taxes.

2.7 Nontransferable Assets. To the extent that any Purchased Asset or Assumed Liability to be sold, conveyed, assigned, transferred, delivered or assumed to or by Buyer pursuant hereto, or any claim, right or benefit arising thereunder or resulting therefrom, is not capable of being sold, conveyed, assigned, transferred or delivered without the approval, consent or waiver of the issuer thereof or the other party thereto, or any third person (including a Governmental Body), or if such sale, conveyance, assignment, transfer or delivery or attempted sale, conveyance, assignment, transfer or delivery would constitute a breach or termination right thereof or a violation of any law, decree, order, regulation or other governmental edict, except as expressly otherwise provided herein, this Agreement shall not constitute a sale, conveyance, assignment, transfer or delivery thereof, or an attempted sale, conveyance, assignment, transfer or delivery thereof absent such approvals, consents or waivers. If any such approval, consent or waiver shall not be obtained, or if an attempted assignment of any such Purchased Asset or the assumption of any Assumed Liability by Buyer would be ineffective so that Buyer would not in

fact receive all such Purchased Assets or assume all such Assumed Liabilities pursuant hereto, Seller, Buyer and Parent shall cooperate in a mutually agreeable arrangement and use reasonable diligent efforts to provide Buyer with the benefits and assume the obligations of such Purchased Assets and Assumed Liabilities in accordance with this Agreement, including subcontracting, sub-licensing, or sub-leasing to Buyer, or under which Seller, at Buyer's expense, would enforce for the benefit of Buyer, with Buyer assuming all of Seller's obligations thereunder, any and all rights of Seller against a third party thereto; *provided* that in no event shall Seller be required to make a cash payment to a third-party (other than as required under any agreement with such third-party) or to Buyer or Parent solely in connection with its obligations under this Section 2.6. Buyer and Parent agree to reasonably cooperate with Seller and supply relevant information to such party or parties or such third-party in order to assist Seller in its obligations under this Section 2.6.

2.8 Taking of Necessary Action; Further Action. From time to time after the Closing Date, at the request of any Party hereto and at the expense of such Party, the Parties hereto shall execute and deliver such other instruments of sale, transfer, conveyance, assignment and confirmation and take such action as Parent or Buyer may reasonably determine is necessary to transfer, convey and assign to Buyer, and to confirm Buyer's title to or interest in the Purchased Assets pursuant to this Agreement, to put Buyer in actual possession and operating control of such Purchased Assets as contemplated by this Agreement and to assist Buyer in exercising all rights with respect thereto.

2.9 Allocation of Purchase Price Consideration. The sum of the Purchase Price and the Assumed Liabilities (except to the extent that such Assumed Liabilities are not required to be capitalized for income tax purposes) shall be allocated among the Purchased Assets as of the Closing Date in accordance with Schedule 2.9, which shall be delivered by Buyer three (3) business days prior to the Closing Date and shall be reasonably acceptable to the Seller. Any subsequent adjustments to the sum of the Purchase Price and Assumed Liabilities (except to the extent that such Assumed Liabilities are not required to be capitalized for income tax purposes) shall be reflected by Buyer in the allocation hereunder in a manner consistent with Section 1060 of the Code and the regulations thereunder. For all Tax purposes, Purchaser and Seller agree to report the transactions contemplated in this Agreement in a manner consistent with the terms of this Agreement, including the allocation under Schedule 2.9, and that none of them will take any position inconsistent therewith in any Tax Return, in any refund claim, in any related litigation, or other related dispute.

ARTICLE III

REPRESENTATIONS AND WARRANTIES OF SELLER

Subject to such exceptions as are specifically disclosed in the disclosure letter supplied by Seller to Parent and Buyer (the "**Seller Disclosure Letter**"), Seller hereby represents and warrants to Parent and Buyer that the statements contained in this Article III are true and correct as of the date of this Agreement and will be true and correct as of the Closing (as though made at the Closing); *provided*, that the representations and warranties made as of a specified date will be true and correct as of such date.

3.1 Organization, Qualification, and Corporate Power. Seller is a corporation duly organized and validly existing under the laws of Singapore. Seller has all necessary corporate power and authority to enter into this Agreement and all agreements and instruments delivered pursuant hereto (the “**Ancillary Agreements**”), to carry out its obligations hereunder and thereunder and to consummate the transactions contemplated hereby and thereby. Seller is duly licensed or qualified to do business and are in good standing in each jurisdiction in which the properties owned or leased by them or the operation of the Business makes such licensing or qualification necessary, except to the extent that the failure to be so licensed or qualified would not (i) adversely affect the ability of Seller to carry out its obligations under, and to consummate the transactions contemplated by, this Agreement and the Ancillary Agreements and (ii) result in a Material Adverse Effect on the Business or the Purchased Assets.

3.2 Authorization. The execution and delivery of this Agreement and the Ancillary Agreements by Seller, the performance by Seller of its obligations hereunder and thereunder and the consummation by Seller of the transactions contemplated hereby and thereby have been duly authorized by all requisite action on the part of Seller and its subsidiaries and no other corporate proceedings on the part of Seller are necessary to authorize this Agreement or the Ancillary Agreements, or to consummate the transactions contemplated hereby and thereby. This Agreement and the Ancillary Agreements to which Seller is a party have been duly and validly executed and constitute the valid and legally binding obligations of Seller, enforceable against Seller in accordance with their respective terms and conditions, except as such enforceability may be limited by principles of public policy and subject to the laws of general application relating to bankruptcy, insolvency and the relief of debtors and rules of law governing specific performance, injunctive relief or other equitable remedies. Except as set forth in Section 3.2 of the Seller Disclosure Letter, Seller does not own and has never owned any subsidiaries.

3.3 No Conflicts. Neither the execution and the delivery of this Agreement and the Ancillary Agreements by Seller nor the consummation of the Transaction will (A) violate any material constitution, Law, injunction, judgment, order, decree, ruling, charge, or other restriction of any government, governmental agency, or court to which Seller is subject, (B) violate or conflict with any provision of the charter documents, bylaws or organizational documents of the Seller, or (C) conflict with, result in a breach of, constitute a default under, result in the acceleration of, create in any party the right to accelerate, terminate, modify, or cancel, or require any notice or consent under, any Assigned Contract or any Assumed Permit (or result in the imposition of any Lien upon any of the Purchased Assets).

3.4 Consents. Except as set forth in Section 3.4 of the Seller Disclosure Letter, no consent, waiver, approval, order, license, permit, certificates, filing or authorization of, or registration, declaration or filing with, any Governmental Body or any third party is required by or with respect to Seller in connection with the execution and delivery of this Agreement or the consummation of the Transaction, except for such consents, waivers, approvals, orders, authorizations, registrations, declarations and filings as may be required under applicable securities laws.

3.5 Legal Compliance. The Business as being conducted by Seller has been and at the Closing will be in material compliance with all applicable Laws (including without limitation rules, regulations, codes, plans, injunctions, judgments, orders, extension orders, decrees, rulings,

and charges thereunder). No Action, or to the knowledge of Seller, investigation, charge, complaint, claim, demand, notice or inquiry, is pending, or to the knowledge of Seller, is threatened against Seller by any Governmental Body alleging any failure to so comply in any material respect. Seller has all material Permits that are necessary to operate the Business and hold the Purchased Assets as of the Closing.

3.6 Tax Matters. For purposes of this Agreement, (i) “**Tax**” or, collectively, “**Taxes**”, means (i) any and all, regardless of country, national, federal, state, local and foreign taxes, assessments and other governmental charges, duties, impositions and liabilities, including taxes based upon or measured by gross receipts, income, profits, sales, use and occupation, and value added (including GST), ad valorem, transfer, franchise, withholding, payroll, recapture, employment, excise and property taxes, stamp duties and customs and other import and export duties together with all interest, penalties and additions imposed with respect to such amounts; (ii) any liability for the payment of any amounts of the type described in clause (i) as a result of being or ceasing to be a member of an affiliated, consolidated, combined or unitary group for any period (including, without limitation, any liability under Treas. Reg. Section 1.1502-6 or any comparable provision of foreign, state or local law); and (iii) any liability for the payment of any amounts of the type described in clause (i) or (ii) as a result of any express or implied obligation to indemnify any other person or as a result of any obligations under any agreements or arrangements with any other person with respect to such amounts and including any liability for taxes of a predecessor or transferor entity.

Except to the extent not relevant to the Purchased Assets or the Business:

- (a) Seller has timely filed all returns, estimates, information statements and reports with respect to any material Taxes (“**Tax Returns**”) that it was required to file. All such Tax Returns are correct and complete in all material respects and have been completed in accordance with applicable law. All Taxes owed by Seller (whether or not shown on any Tax Return) were paid in full when due.
- (b) Seller has timely withheld or paid with respect to its employees or other third parties and timely paid over any withheld amounts to the appropriate Taxing authority all Singaporean and U.S. federal and state income Taxes, Federal Insurance Contribution Act, Federal Unemployment Tax Act and other taxes required to be withheld or paid.
- (c) Seller has made available to Parent copies of all Tax Returns relating to the Business or the Purchased Assets for all periods since the Seller’s incorporation.
- (d) Seller has paid all Taxes for which Seller is liable to pay in respect of the Purchased Assets.

3.7 Title of Properties; Absence of Liens and Encumbrances; Condition of Equipment.

- (a) All current leases related to the Business are in full force and effect, are valid and effective in accordance with their respective terms, and there is not, under any of such leases, any existing default or event of default (or event which with notice or lapse of time, or

both, would constitute a default) on the part of Seller and, to the knowledge of Seller, on the part of any other party thereto.

(b) Seller has good and valid title to, or, in the case of leased properties and assets valid leasehold interests in, all of the Purchased Assets, free and clear of any Liens, except (i) as reflected in the Seller Disclosure Letter, and (ii) such imperfections of title and encumbrances, if any, which do not detract from the value or interfere with the present use of, in any material respect, assets subject thereto (the "Permitted Liens"). Seller is a party to and enjoys the right to the benefits of all Assigned Contracts.

(c) All of the Fixed Assets are in good operating condition and repair (normal wear and tear excepted) and are suitable for the purposes for which they are currently used.

(d) Seller has the complete power and right to sell, assign, transfer, convey and deliver the Purchased Assets to Buyer pursuant to this Agreement. Following the consummation of the Transaction and the execution of the instruments of transfer contemplated by this Agreement and the Ancillary Agreements, Buyer will own, with good and valid title to, or otherwise acquire the interests of Seller and its subsidiaries in, the Purchased Assets, free and clear of any Liens, other than the Permitted Liens.

3.8 Intellectual Property. Other than Intellectual Property Rights included in the Purchased Assets and Assumed Liabilities and Intellectual Property Rights related to the Excluded Assets, no transfer of Intellectual Property Rights from Seller to Buyer or Parent is required for Buyer and/or Parent to conduct the Business as currently conducted by Seller. The manufacturing processes of the Business as currently conducted by the Seller at the Closing and continued by Buyer or Parent pursuant to the Supply Agreement do not infringe or misappropriate any Intellectual Property of any third party. For the avoidance of doubt, the foregoing sentence shall take prevail in the event of a conflict between such sentence and the Supply Agreement.

3.9 Contracts. Section 3.9 of Seller Disclosure Letter lists all written or oral contracts, agreements, commitments and other arrangements (including any amendment thereto) outstanding as of the date hereof to which Seller is a party and that relates to the Business, other than bids submitted to customers, purchase orders and sales orders in the ordinary course of business (collectively, the "**Business Contracts**"). Seller has delivered to Parent a correct and complete copy of each Business Contract, and any written modification, amendment or additional terms (and a written summary setting forth the terms and conditions of any oral modification, amendment or additional terms) to the Business Contracts. With respect to each Business Contract: (A) the Business Contract, with respect to Seller and, to Seller's knowledge, all other parties thereto, is legal, valid, binding, enforceable, and in full force and effect in all respects; (B) neither Seller nor, to Seller's knowledge, any other party is in breach or default, and no event has occurred, which with notice or lapse of time would constitute a breach or default, or permit termination, modification, or acceleration, under the Business Contract; and (C) Seller has not received notice that any party has repudiated any provision of the Business Contract. Except as set forth on Section 3.4 of the Seller Disclosure Letter, Seller has obtained or will obtain prior to the Closing Date, all necessary consents, waivers and approvals of parties to any Assigned Contract as are required thereunder in connection with the transactions contemplated by this

Agreement or to remain in effect without modification after the Closing. Following the Closing, Buyer will be permitted to exercise all of Seller's rights under such Assigned Contracts to the same extent in all material respects that Seller would have been able to had the Transaction not occurred.

3.10 Power of Attorney. There are no outstanding powers of attorney executed on behalf of Seller and related to the Business, the Purchased Assets or the Assigned Contracts.

3.11 Insurance. Seller has delivered to Parent copies of each insurance policy (including policies providing property, casualty, liability, and workers' compensation coverage and bond and surety arrangements) related to the Business with respect to which Seller is a party. With respect to each such insurance policy: (A) the policy is legal, valid, binding, enforceable, and in full force and effect (and there has been no notice of cancellation or nonrenewal of the policy received); (B) Seller is not in breach or default (including with respect to the payment of premiums or the giving of notices), and no event has occurred which, with notice or the lapse of time, would constitute such a breach or default by Seller, or permit termination, modification, or acceleration, under the policy; (C) Seller has not received notice that any party to the policy has repudiated any provision thereof; and (D) there has been no failure by Seller to give any notice or present any claim under the policy in due and timely fashion. Section 3.11 of Seller Disclosure Letter describes any self-insurance arrangements presently maintained by Seller.

3.12 Litigation. Section 3.12 of Seller Disclosure Letter sets forth each instance in which to the Business or the Purchased Assets (i) is subject to any outstanding injunction, judgment, order, decree, ruling, or charge or (ii) is or has been, or, to the knowledge of Seller, is threatened to be made a party, to any action, suit, proceeding, hearing, mediation, arbitration, or investigation of, in, or before any court or quasi-judicial or administrative agency of any federal, state, local, or foreign jurisdiction or before any mediator or arbitrator.

3.13 Employees. Schedule 3.13 contains a complete and accurate list of all current Employees as of the date hereof, showing for each such Employee the following: employee name, position held, annual base salary and visa status.

3.14 Labor Matters. No Employee has advised any officer of Seller that he or she plans to terminate employment with Seller or within the twelve (12) months from the date of the Closing. The Seller is not a party to any special collective bargaining agreement and no special collective bargaining agreement is being negotiated with respect to the Business. There are no collective relations in any Facility. The Employees are not organized, and there is no Employees' committee or collective representation of any kind. There is no material unfair labor practice, charge or complaint pending against the Seller with respect to the Business, nor is there any material labor strike, work stoppage, grievance or other labor dispute pending or, to the knowledge of the Seller, threatened in writing or orally against the Seller with respect to the Business. The Seller: (i) is in compliance in all material respects with all applicable Laws respecting employment and wage and hours, and with all terms and conditions of employment, agreements with third parties, codes of conduct, visas, work permits, in each case, with respect to Employees; (ii) have withheld, paid and reported all amounts required by Law or by agreement to be withheld, reported and paid with respect to wages, salaries and other payments to Employees; (iii) are not liable for any arrears of wages or any taxes or any penalty for failure to

comply with any of the foregoing; and (iv) are not liable for any payment to any Governmental Body, any trust or other fund governed by or maintained by or on behalf of any Governmental Body, with respect to unemployment compensation benefits, social security or other benefits or obligations for Employees (other than routine payments to be made in the normal course of business and consistent with past practice). There are no pending, or to the knowledge of Seller, threatened against the Seller under any employment policy or disability policy.

3.15 Environment, Health and Safety. For purposes of this Agreement, the following terms shall have the meanings ascribed to them below:

(a) Definitions:

(i) **"Hazardous Material"** is any material, chemical, substance or waste that has been designated by any Governmental Body to be radioactive, toxic, hazardous or otherwise a danger to health, reproduction or the environment or the disposal, treatment, transfer, storage or manufacture of which is regulated in any manner by a Governmental Body.

(ii) **"Business Facility"** is any property including the land, the improvements thereon, the groundwater thereunder and the surface water thereon, that is or at any time has been owned, operated, occupied, controlled or leased by the Seller in connection with the operation of the printed circuit board assembly manufacturing and storage system manufacturing business conducted by Seller in Singapore.

(iii) **"Environmental Laws"** are all applicable laws, rules, regulations, orders, treaties, statutes, and codes promulgated by any Governmental Body which prohibit, regulate or control any Hazardous Material or any Hazardous Material Activity, including, without limitation, the Factories Act (Cap 104) of Singapore, the Fire Safety Act (Cap 109A) of Singapore, the Environmental Pollution Control Act (Cap 94A) of Singapore, the Environmental Public Health Act (Cap 95) of Singapore, and any other laws and regulations in Singapore pertaining to occupational health and safety, or pollution control, the regulations promulgated to any of the foregoing, and all amendments and modifications of any of the foregoing.

(iv) **"Hazardous Materials Activity"** is the transportation, transfer, recycling, storage, use, treatment, manufacture, removal, remediation, release (or threat of release), exposure of others to, sale, or distribution of any Hazardous Material or any product containing a Hazardous Material.

(v) **"Environmental Permit"** is any approval, permit, license, clearance or consent required to be obtained from any private person or any Governmental Body with respect to a Hazardous Materials Activity which is or was conducted by the Seller.

(b) Condition of Property: As of the Closing, except in compliance with Environmental Laws and in a manner that could not reasonably be expected to subject the Seller to liability, to knowledge of Seller, no Hazardous Materials, underground storage tanks, asbestos which is friable or Polychlorinated Biphenyls (PCBs), are present on any Business Facility or were present on any other Business Facility at the time it ceased to be owned, operated, occupied, controlled or leased by the Seller. To the knowledge of the Seller, there are no

underground storage tanks, asbestos which is friable or likely to become friable or PCBs present on any Business Facility.

(c) Hazardous Materials Activities: The Seller has conducted all Hazardous Material Activities relating to the Business in compliance in all material respects with all applicable Environmental Laws. The Hazardous Materials Activities of the Seller prior to the Closing have not resulted in the exposure of any person to a Hazardous Material in a manner which has caused or could reasonably be expected to cause an adverse health effect to any such person.

(d) Permits: Seller holds all Environmental Permits necessary for the conduct of the Seller's Business as currently being conducted by Seller.

(e) Environmental Litigation: No action, proceeding, revocation proceeding, amendment procedure, writ, injunction or claim is pending, or to the best of the Seller's knowledge, threatened, concerning or relating to any Environmental Permit or any Hazardous Materials Activity of the Seller relating to its Business, or any Business Facility.

(f) Reports and Records: The Seller has delivered to Buyer or made available for inspection by Buyer and its agents, representatives and employees all records in the Seller's possession concerning the Hazardous Materials Activities of the Seller relating to its Business and all environmental audits and environmental assessments of any Business Facility conducted at the request of, or otherwise in the possession of the Seller. The Seller has complied with all environmental disclosure obligations imposed by applicable law with respect to this transaction.

3.16 Fees. Seller has no liability or obligation to pay any fees or commissions to any broker, finder, agent or attorney, with respect to the transactions contemplated by this Agreement.

3.17 Complete Copies of Materials. Seller has delivered or made available true and complete copies of each document (or summaries of same) that has been requested by Parent, Buyer or their counsel.

3.18 Board Approval. The Board of Directors of Seller has (i) approved this Agreement, the Ancillary Agreements and the Transaction, (ii) determined that the Transaction is in the best interests of the shareholders of Seller and is on terms that are fair to such shareholders, and (iii) if required by applicable Law, recommended that the shareholders of Seller approve this Agreement, the Ancillary Agreements and the Transaction.

3.19 Inventories. The Inventories are in all material respects similar in quality to the raw materials, supplies and work-in-process generally included in the inventory of the Business in the past. Seller has good and valid title to the Inventories free and clear of all Liens, other than Permitted Liens. The Inventories do not consist of, in any material amount, items that are obsolete or damaged. The Inventories do not consist of any items held on consignment. Seller is not under any obligation or liability with respect to accepting returns of items of Inventories or merchandise in the possession of its customers other than in the ordinary course of the Business consistent with past practice. Seller has not changed the price of any Inventories except for (i) reductions to reflect any reduction in the cost thereof to Seller, (ii) reductions and increases

responsive to normal competitive conditions and consistent with Seller's past sales practices, (iii) increases to reflect any increase in the cost thereof to Seller and (iv) increases and reductions made with the written consent of Parent. All of the Inventories are located at the Facility.

3.20 Facility and Tangible Personal Property. Subject to the lease relating to the Facility, the Facility is owned by the Seller free and clear of any Liens except for Permitted Liens. The Seller is in peaceful and undisturbed possession of the Facility. There are no structural, electrical, mechanical, plumbing, roof, paving or other defects in any improvements located on the Facility (normal wear and tear excepted) as would, in any one instance, result in an expenditure in excess of US\$100,000 to rectify or, in the aggregate, US\$300,000 to rectify. There are no outstanding written or, to the Seller's knowledge, oral contracts made by Seller for any alterations or improvements on or to the Property which have not been fully paid. The Seller has caused the Purchased Assets to be maintained in accordance with good business practice, and all the Purchased Assets are in good operating condition and repair and (normal wear and tear excepted) are suitable for the purposes for which they are used and intended.

3.21 Sufficiency of Purchased Assets. Other than the Excluded Assets and the Employees, and subject any assets or services being provided pursuant to the Ancillary Agreements, the sale of the Purchased Assets and the Facility pursuant to this Agreement and the Ancillary Agreements will effectively convey to Buyer all of the Assets necessary to operate the Business, as heretofore conducted by Seller prior to the Closing.

3.22 Operations Permits. Section 3.23 of the Seller Disclosure Letter sets forth each License held by Seller as of the date hereof and that relates, directly or indirectly, and whether or not exclusively related, to the Business (collectively, the "**Business Permits**").

(a) Seller is not in material default (or with the giving of notice or lapse of time, or both, would be in material default) under, or violation in any material respect of, any Business License.

(b) The Permits to be assumed by Buyer in the Transaction are sufficient to enable Buyer to conduct the Business as heretofore conducted by the Seller in compliance in all material respects with all applicable Laws.

3.23 ISO Certifications and Non-Governmental Certifications.

(a) The Facility is currently certified ISO 9002/ ISO 14001. The manufacturing operations conducted at the Facility are in material compliance with the European Union directives regarding RoHS.

(b) Section 3.24 of the Seller's Disclosure Letter contains a complete and accurate list of all customer, supplier and other non-governmental entities that have issued certifications or quality assurance criteria regarding the Purchased Assets or Facility.

3.24 Suppliers. Listed in Section 3.25 of the Seller Disclosure Letter are the names and addresses of each of the ten most significant suppliers of raw materials, supplies, merchandise and other goods for the Business for the twelve-month period ended September 30, 2005 and the amount for which each such supplier invoiced Seller and its subsidiaries during

such period. Except as disclosed in Section 3.25 of the Disclosure Letter, neither Seller nor any of its subsidiaries has received any notice that any such supplier will not sell raw materials, supplies, merchandise and other goods to Seller or any of its subsidiaries at any time after the Closing Date on terms and conditions similar to those imposed on current sales to the Business, subject only to general and customary price increases and existing agreements with such suppliers.

ARTICLE IV

REPRESENTATIONS AND WARRANTIES OF PARENT AND BUYER

Subject to such exceptions as are specifically disclosed in the disclosure letter supplied by the Parent to Seller (the “**Parent Disclosure Letter**”), each of Parent and Buyer, jointly and severally, hereby represents and warrants to Seller that the statements contained in this Article IV are true and correct as of the date of this Agreement and will be true and correct as of the Closing (as though made at the Closing); *provided*, that the representations and warranties made as of a specified date will be true and correct as of such date.

4.1 Organization, Qualification, and Corporate Power. Parent is a corporation duly organized, validly existing, and in good standing under the laws of Delaware. Buyer is a corporation duly organized, validly existing, and in good standing under the laws of Singapore. Parent and Buyer are duly authorized to conduct business and are in good standing under the laws of each other jurisdiction where such qualification is required and in which the failure to so qualify would not (i) in the aggregate have a Material Adverse Effect on Parent or Buyer, taken as a whole, or (ii) adversely affect the ability of Parent or Buyer to execute and deliver this Agreement and the Ancillary Agreements, or consummate the Transactions.

4.2 Authorization. Parent and Buyer have full power and authority to enter into, execute and deliver this Agreement and the Ancillary Agreements to which they are parties, and to consummate the Transaction and to perform their obligations hereunder and thereunder. This Agreement and the Ancillary Agreements to which they are parties constitute the valid and legally binding obligations of Parent or Buyer, enforceable against Parent or Buyer in accordance with their respective terms and conditions, except as such enforceability may be limited by principles of public policy and subject to the laws of general application relating to bankruptcy, insolvency and the relief of debtors and rules of law governing specific performance, injunctive relief or other equitable remedies.

4.3 No Conflicts. Neither the execution and the delivery of this Agreement nor the consummation of the transactions contemplated hereby, will (A) violate any material constitution, statute, regulation, rule, injunction, judgment, order, decree, ruling, charge, or other restriction of any government, governmental agency, or court to which Parent or Buyer is subject, (B) violate or conflict with any provision of the charters, bylaws or organizational documents of Parent or Buyer, or (C) conflict with, result in a breach of, constitute a default under, result in the acceleration of, create in any party the right to accelerate, terminate, modify, or cancel, or require any notice under, any agreement, contract, lease, license, instrument, or other arrangement to which Parent or Buyer is a party or by which either is bound or to which

any of their assets is subject, other than any of the foregoing which would not in the aggregate have a Material Adverse Effect on Parent or Buyer, taken as a whole, or (ii) adversely affect the ability of Parent or Buyer to execute and deliver this Agreement and the Ancillary Agreements, or consummate the Transactions.

4.4 Consents. No consent, waiver, approval, order, license, permit, certificates, filing or authorization of, or registration, declaration or filing with, any Governmental Body or any third party, is required by or with respect to Parent or Buyer in connection with the execution and delivery of this Agreement or the consummation of the Transaction, except for (i) such consents, waivers, approvals, orders, authorizations, registrations, declarations and filings as may be required under applicable federal and state securities laws, (ii) any applicable filings required under the noncompetition laws, and (iv) such consents, waivers, approvals, orders, authorizations, registrations, declarations and filings in which the failure of which to obtain would not (i) in the aggregate have a Material Adverse Effect on Parent or Buyer, or (ii) adversely affect the ability of Parent or Buyer to execute and deliver this Agreement and the Ancillary Agreements, or consummate the Transactions.

4.5 Purchase Price. Buyer has and will have sufficient cash on hand to pay the Purchase Price and the GST Tax Amount that may be chargeable in respect of the sale of the Purchased Assets under this Agreement at the Closing.

ARTICLE V

PRE-CLOSING COVENANTS

With respect to the period between the execution of this Agreement and the earlier of the termination of this Agreement in accordance with its terms and the Closing (the “**Pre-Closing Period**”):

5.1 Operation of Business.

(a) Seller agrees that, during the Pre-Closing Period, except as contemplated by this Agreement, any Ancillary Agreement or the Transactions, or as otherwise consented to or approved in advance by Parent or Buyer, Seller shall:

(i) use all commercially reasonable efforts to (i) preserve intact the present business organization, reputation, contractual and other arrangements of the Business then under the control of Seller, (ii) keep available (subject to dismissals and retirements in the ordinary course of business consistent with past practice) the services of the present Employees of the Business, (iii) maintain the Purchased Assets in good working order and condition, ordinary wear and tear excepted, (iv) maintain the goodwill of customers, suppliers, distributors and other Persons to whom Seller sells goods or provides services or with whom Seller otherwise has significant business relationships in connection with the Business, and (v) continue all current sales, service, marketing, promotional, product development and other activities relating to the Business;

- (ii) except to the extent required by applicable Law and consistent with past practice, (i) cause the Books and Records of the Business to be maintained in the usual, regular and ordinary manner, and (ii) not permit any change in any pricing, investment, accounting, financial reporting, inventory, credit, allowance or Tax practice, policy or election or Seller that would materially and adversely affect the Business, the Purchased Assets or increase the Assumed Liabilities;
 - (iii) use all commercially reasonable efforts to continue in full force and effect all material insurance policies (or comparable insurance policies) insuring the Business and its Assets; and
 - (iv) comply in all material respects with all Laws and Orders applicable to the Business, and promptly following receipt thereof deliver to Buyer copies of any written notice received from any Governmental Body or other Person alleging any violation of any such Law or Order.
- (b) Seller agrees that, during the Pre-Closing Period, except as contemplated by this Agreement, the Ancillary Agreements or this Transaction or as otherwise consented to or approved in advance by Parent or Buyer, Seller shall not:
- (i) Except for any existing benefit plan or program or contract, make any representation or promise, oral or written, to any Employee concerning any employee benefit plan, except for statements as to the rights or accrued benefits of any Employee under the terms of any employee benefit plan or agreements, or otherwise required by Law;
 - (ii) Except for any existing benefit plan or program or contract, make any increase in the salary, wages or other compensation (cash, equity or otherwise) of any Employee whose annual salary is or, after giving effect to such change, would be the equivalent individually to in excess of US\$50,000 and in the aggregate in excess of US\$100,000;
 - (iii) adopt, enter into or become bound by any employee benefit plan, any employment-related contract or any collective bargaining agreement with respect to the Business or any of the Employees, or, amending, modifying or terminating (partially or completely) any such employee benefit Plan, employment-related contract or collective bargaining agreement, except to the extent required by applicable Law or existing contractual obligation and, in the event compliance with legal requirements presents options, only to the extent that the option which Seller reasonably believes to be the least costly is chosen, except in the ordinary course of business consistent with past practice;
 - (iv) terminate the employment of any Employee, except for cause, provided Seller provides notice to Parent or Buyer prior to any such termination, or
 - (v) enter into any Contract to do or engage in any of the foregoing items set forth in this Section 5.1(b).
- (c) Seller agrees that, during the Pre-Closing Period, except as permitted by this Agreement, the Ancillary Agreements or this Transaction, or as otherwise consented to or approved in advance by Parent or Buyer, Seller shall not:

- (i) acquire, lease, license or dispose of or agree to acquire lease, license or dispose of any assets that would constitute Purchased Assets hereunder, other than in the ordinary course of business consistent with past practice, or create or incur any material Lien, other than a Permitted Lien, on any assets that would constitute Purchased Assets hereunder;
- (ii) enter into, amend, modify, terminate (partially or completely), grant any waiver under or give any consent with respect to any Business Contract or any Assumed Permit, in each case other than in the ordinary course of business consistent with past practice;
- (iii) violate, breach or default in any material respect under, or take or fail to take any action that (with or without notice or lapse of time or both) would constitute a material violation or breach of, or material default under, any term or provision of any Assigned Contract or any Assumed Permit;
- (iv) make any material changes in the conduct of the Business, except as specifically contemplated or permitted by this Agreement, or any Ancillary Agreement or this Transaction; or
- (v) enter into any Contract to do or engage in any of the foregoing items set forth in this Section 5.1(c).

5.2 Access to Information. The Seller shall permit the Buyer and its representatives during the Pre-Closing Period to have reasonable access during normal business hours, upon reasonable advance notice, to the Books and Records, Employees and assets of the Business (including the testing and investigation of any Facility as the Buyer deems reasonably necessary prior to the Closing) then under the control of Seller for the purposes of, among other things, identifying and verifying the value of the Purchased Assets to be purchased at the Closing; *provided, however,* that such access shall be conducted by the Buyer and its representatives in such a manner as not to interfere unreasonably with the businesses or operations of the Seller or the Business. In order to facilitate the resolution of any claims made by or against or incurred by Parent or Buyer after the Closing or for any other reasonable purpose, for a period of five years following the Closing, Seller shall, and shall cause its subsidiaries to, (i) retain all books and records which are not transferred to Buyer pursuant to this Agreement and which relate to the Business for periods prior to the Closing and which shall not otherwise have been delivered to Buyer and (ii) upon reasonable notice, afford the officers, employees and authorized agents and representatives of Parent or Buyer, reasonable access (including the right to make photocopies at Parent of Buyer's expense), during normal business hours, to such books and records, all subject to Section 5.8 regarding confidentiality.

5.3 Notice of Developments. During the Pre-Closing Period, Seller shall give prompt notice to Buyer of (i) the occurrence or non-occurrence of any event of which Seller has knowledge, the occurrence or non-occurrence of which is reasonably likely to cause any representation or warranty of Seller contained in this Agreement to be untrue or inaccurate at or prior to the Closing and (ii) any failure of Seller to comply with or satisfy any covenant, condition or agreement to be complied with or satisfied by it hereunder; *provided, however,* that

the delivery of any notice pursuant to this Section 5.3 shall not limit or otherwise affect any remedies available to the Party receiving such notice.

5.4 **No Solicitation.** During the Pre-Closing Period, neither Seller nor any subsidiary of Seller shall (nor shall it permit its Representatives to) directly or indirectly take any of the following actions with any Person other than Parent, Buyer and their designees: (a) solicit, initiate, consider, encourage or accept any proposals or offers from, or conduct discussions with or engage in negotiations with, any Person relating to any possible Acquisition Proposal with Seller or any of its subsidiaries (whether such subsidiaries are in existence on the date hereof or are hereafter organized), (b) provide information with respect to Seller to any Person, other than Parent or Buyer, relating to, or otherwise cooperate with, facilitate or encourage any effort or attempt by any such Person with regard to, any possible Acquisition Proposal with Seller or any subsidiary of Seller (whether such subsidiaries are in existence on the date hereof or are hereafter organized), except as required by Law, (c) enter into a contract or agreement (whether oral or written) with any Person, other than Parent or Buyer, providing for an Acquisition Proposal with Seller or any subsidiary (whether such subsidiaries are in existence on the date hereof or are hereafter organized), or (d) make or authorize any statement, recommendation or solicitation in support of any possible Acquisition Proposal with Seller or any subsidiary (whether such subsidiary is in existence on the date hereof or are hereafter organized) other than by Parent or Buyer. Seller shall, and shall cause its Representatives to, immediately cease and cause to be terminated any such contacts or negotiations with any Person relating to any Acquisition Proposal. As used in this Section 5.4, "**Acquisition Proposal**" shall mean a proposal or offer for (i) a merger, consolidation or other business combination involving an acquisition of the Business or the Purchased Assets or (ii) any extraordinary business transaction involving or otherwise relating to the Business or Purchased Assets.

5.5 **Reasonable Efforts.** During the Pre-Closing Period, each of the Parties will use their reasonable efforts to take all action and to do all things necessary, proper, or advisable in order to consummate and make effective the transactions contemplated by this Agreement (including satisfaction, but not waiver, of the closing conditions set forth in Article VII below).

5.6 **Notices and Consents.** During the Pre-Closing Period, Seller will give any notices to third parties and use reasonable commercial efforts to obtain any third party consents that are required in connection with the matters identified in Sections 3.3 and 3.4 of Seller Disclosure Letter or otherwise required in connection with the Transaction so as to preserve all material rights of or benefits to Seller. During the Pre-Closing Period, each of the Parties will give any notices to, make any filings with, and use its commercially reasonable efforts to obtain any authorizations, consents, and approvals of Governmental Bodies in connection with the matters identified in Sections 3.3 and 3.4 of Seller Disclosure Letter or as otherwise required in connection with the Transactions contemplated by this Agreement.

5.7 **Employee Matters.** In the event that any of the Critical Employees terminate their employment with the Seller prior to the Closing or during that portion of the transition period in which such Critical Employees have significant remaining transition related functions, the Buyer and Seller will use reasonable commercial efforts to seek to implement a mutually agreed alternative solution for the fulfillment of such functions. Any costs associated with these matters, including any compensation incentives paid to Critical Employees to encourage them to

remain employed after the Closing through the end of the transition period as provided in the Secondment Agreement, will be shared equally by Buyer and Seller; as mutually agreed by them; *provided* that Parent and Buyer will be responsible only for costs approved by them in advanced; *provided further* that Parent and Buyer will be solely responsible for any compensation for work after the date of transfer of any Transferred Employee hired by either of them.

5.8 **Confidentiality.** All Book and Records of Seller, and other confidential and/or proprietary information of a party to this Agreement are hereinafter referred to as “**Confidential Information.**” A party who owns and discloses its Confidential Information is referred to below as a “**Disclosing Party**” and a party who receives or is given access to a Disclosing Party’s Confidential Information is referred to below as a “**Receiving Party.**” Each party hereto agrees that all Confidential Information of another party that is disclosed to such party in the course of negotiating the Transactions contemplated by this Agreement or conducting due diligence in connection herewith will be held in confidence, and will not be used or disclosed by the Receiving Party except for the purposes relating to or permitted by this Agreement for which such Confidential Information was disclosed, and upon termination of this Agreement or the consummation of the Transactions contemplated hereby, will be promptly destroyed by the Receiving Party or returned to the Disclosing Party, upon the Disclosing Party’s written request. No party’s employees will be given access to Confidential Information of another party except on a “need to know” basis and such employees shall be informed of the need to keep such Confidential Information confidential. It is agreed that Confidential Information will not include information that: (i) was known to such Receiving Party before receipt of such information from the Disclosing Party; (ii) is or becomes generally known to the public through no breach of this Section or any act or omission on the part of the Receiving Party; (iii) is disclosed by a third party having the legal right to disclose such information with no obligation of confidence to the Disclosing Party, or is required to be disclosed as a result of court order or similar process; or (iv) is independently developed by the Receiving Party without use of any of the Disclosing Party’s Confidential Information (as evidenced by a contemporaneous writing).

ARTICLE VI OTHER AGREEMENTS AND COVENANTS

6.1 **Additional Documents and Further Assurances.** Each Party hereto, at the reasonable request of another Party hereto, shall execute and deliver such other instruments and do and perform such other acts and things as may be reasonably necessary or desirable for effecting completely the consummation of the Transactions contemplated hereby (*provided* that the foregoing will not require any Party to make any payment of consideration to any other Person).

6.2 **Inventory Put and Call; Covenant to Purchase Inventory.** For a period of thirty (30) days following the three (3) month anniversary of the Closing (the “**First Exercise Period**”), (i) Buyer shall have the option to sell to Seller and Seller shall have to obligation to purchase from Buyer (the “**Put Right**”) all Inventories that Buyer and Seller reasonably agree will reasonably be expected to not have been used in the manufacture and sale of products of the Business during the 6-month period following the Closing Date (collectively, the “**Estimated**

Unused Inventories") and (ii) for a period of thirty (30) days following the six (6) month anniversary of the Closing (the **"Second Exercise Period"**), Buyer shall have a Put Right with respect to all Inventories that have not been used in the manufacture and sale of products of the Business during the 6-month period following the Closing Date (collectively, and together with the Estimated Unused Inventories, the **"Unused Inventories"**) and; *provided, however*, that the Unused Inventories shall be deemed to be reduced by the following:

- (a) The amount of any inventories of the same kind, or suitable for the same purposes, as any Unused Inventories, if any, purchased by Buyer and its affiliates and used in substitution for such Unused Inventories during such 6-month period, unless such substituted inventories are used by Buyer or such affiliates at the request of Seller;
- (b) The amount of any Unused Inventories, if any, lost, stolen, destroyed or otherwise damaged during such 6-month period; and
- (c) The amount of any Unused Inventories, if any, to be used by Buyer or its affiliates after such 6-month period pursuant to binding, noncancellable purchase orders received or assumed by Buyer or such affiliates during such 6-month period to be shipped within 30 days after the end of such 6-month period.
- (d) For purposes of the identification of any Unused Inventories, the Inventories shall be deemed to be used prior to any other inventories of the same kind, or suitable for the same purposes, as such Unused Inventories acquired by Buyer or its affiliates after the date of this Agreement.
- (e) Buyer may exercise its Put Right described in Section 6.2(a) solely by the delivery, within the First Exercise Period or the Second Exercise Period, as the case may be, to Seller of notice to such effect that (i) sets forth (A) a specific description of any Unused Inventories and (B) the original purchase price less any amount paid by Seller to Buyer with respect to such Unused Inventory following the Closing Date (such as a "buy down") of such Inventories as of the Closing Date (the **"Inventory Repurchase Price"**) and (ii) is accompanied by an officer's certificate of Buyer that certifies that such Unused Inventories have been identified, and the Inventory Repurchase Price thereof has been calculated, in accordance with this Section 6.2. Within ten (10) business days after the receipt Seller of such notice, Seller shall, if it objects to such notice, deliver to Buyer notice that Seller disputes Buyer's identification of the Unused Inventories or the calculation of the Inventory Repurchase Price. If Seller fails to timely deliver to Buyer such notice within such 10 business day period, then Seller shall be deemed to have accepted the exercising party's identification of the Unused Inventories and calculation of the Inventory Repurchase Price. If Seller timely delivers to the Buyer such notice within such 10 business day period, then the parties shall attempt in good faith to reach a resolution of such disagreement. If such disagreement is not resolved within five (5) days after delivery of Seller's notice, the Independent Accountants shall be directed to compute the amount of the Unused Inventories and the Inventory Repurchase Price as promptly as practicable and such computation shall be binding upon the Parties hereto. The expenses of Independent Accountant in connection with such computation shall be borne equally by Buyer and Seller.

(f) Payment. Seller shall pay to Buyer the amount of the Inventory Repurchase Price as finally determined in this Section within five (5) business days of any such determination and Buyer shall transfer title of the Unused Inventory to Seller. The Unused Inventory shall be in substantially the same condition (other than changes due to the passage of time) as when purchased by Buyer free and clear of any Liens (except for Permitted Liens). Except as set forth in the foregoing sentence, Buyer makes no representations or warranties with respect to the Unused Inventories.

6.3 Repurchase of Inventory and Equipment Under Certain Circumstances.

(a) In the event that during the term of the Supply Agreement, (i) Seller sells, transfers or otherwise disposes of its DSG business, its systems business or any other business unit of Seller being supplied by Buyer pursuant to the Supply Agreement to a third party, other than Buyer or Parent, or an Affiliate of either (in each case, an “**Affected Business**”) and (ii) both (1) the acquirer of the Affected Business does not agree to be bound by and subject to the terms of the Supply Agreement as in effect on the date of closing of the transaction involving the Affected Business and (2) Adaptec, Inc. (“**Adaptec**”) does not remain primarily liable for its obligations under the Supply Agreement or Adaptec or the acquirer of the Affected Business terminates the Supply Agreement in connection with the sale of the Affected Business, Seller agrees to repurchase any Fixed Assets or Inventories sold to Buyer hereunder and then held by Buyer on the date of such repurchase that are associated with the Affected Business necessary to support Adaptec’s requirements under the Supply Agreement associated with the Affected Business (and any capital equipment and any raw material or work in process purchased by Parent or Buyer necessary to support Adaptec’s requirements under the Supply Agreement that are associated with the Affected Business) (the “**Repurchased Assets**”). In connection with any repurchase of the Repurchased Assets, Buyer shall represent to Seller that Buyer is duly and validly organized under the laws of the jurisdiction in which it is incorporated, that the repurchase has been duly authorized by all requisite action on the part of Buyer, that such transfer and purchase does not violate any applicable law or require the consent or authorization of any third party, that Buyer has good and valid title to the Repurchased Assets, free and clear of any Liens, except Permitted Liens, and that Buyer has the complete authority, power and right to sell, assign, transfer, convey and deliver the Repurchased Assets to Seller pursuant to the repurchase. The repurchase price for any Inventories sold to Seller pursuant to this Section 6.3(a) shall be (i) if the Seller’s obligation to repurchase the Repurchased Assets under this Section 6.3 is triggered prior to the expiration or exercise of the put right in Section 6.2, determined in the same manner as the Inventory Repurchase Price is determined pursuant to Section 6.2 hereof, and (ii) if the Seller’s obligation to repurchase the Repurchased Assets under this Section 6.3 is triggered after the expiration or exercise of the put right in Section 6.2, then the repurchase price shall be the standard cost of such Inventories as shown on the books and records of Buyer. The repurchase price for Fixed Assets shall equal the depreciated value of such Fixed Assets that would be shown on the books and records of Seller if Seller had continued to own such Fixed Assets on the date of the closing of the divestiture of the Affected Business. The repurchase price for the Fixed Assets and Inventories pursuant to this Section 6.3(a) shall be determined by Buyer within fifteen (15) days of the occurrence of an event that gives Buyer the right to trigger a repurchase pursuant to this Section. Thereafter, Seller or Parent may object to such determination using the same framework as set forth in

Section 6.2(e) hereof and payment shall be made by Seller or Parent pursuant to the provisions of Section 6.2(f) hereof.

(b) In the event that during the term of the Supply Agreement, (i) Seller is acquired by a third party merger, or other business combination transaction in which the shareholders of Adaptec immediately prior to such transaction own immediately after such transaction less than 50% of the outstanding voting securities of the acquiring or surviving entity (or its ultimate corporate parent) or the sale of substantially all of the assets of the Seller or Adaptec's, other than an acquisition, merger, business combination or sale to Buyer or Parent, or an Affiliate of either, and (ii) both (1) the acquirer of Adaptec or all or substantially all of the assets of Seller or Adaptec does not agree to be bound by and subject to the terms of the Supply Agreement as in effect on the date of closing of the transaction and (2) Adaptec does not remain primarily liable for its obligations under the Supply Agreement or terminates the Supply Agreement prior to its expiration date in connection with such transaction, Seller agrees to repurchase any Fixed Assets or Inventories sold to Buyer and held by Buyer on the date of such repurchase necessary to support Adaptec's requirements under the Supply Agreement associated with the business or assets being sold (and any capital equipment and any raw material or work in process purchased by Parent or Buyer necessary to support Adaptec's requirements under the Supply Agreement associated with the business or assets being sold) (the "**Acquisition Assets**"). Buyer shall represent to Seller that Buyer is duly and validly organized under the laws of the jurisdiction in which it is incorporated, that the repurchase has been duly authorized by all requisite action on the part of Buyer that such transfer and purchase does not violate any applicable law or require the consent or authorization of any third party, that Buyer has good and valid title to the Acquisition Assets, free and clear of any Liens, except Permitted Liens, and that Buyer has the complete authority, power and right to sell, assign, transfer, convey and deliver the Acquisition Assets to Seller pursuant to the sale of the Acquisition Assets. The repurchase price for any Inventories sold to Seller or Parent pursuant to this Section 6.3(b) shall be (i) if the Seller's obligation to repurchase the Repurchased Assets under this Section 6.3 is triggered prior to the expiration or exercise of the put right in Section 6.2, determined in the same manner as the Inventory Repurchase Price is determined pursuant to Section 6.2 hereof, and (ii) if the Seller's obligation to repurchase the Repurchased Assets under this Section 6.3 is triggered after the expiration or exercise of the put right in Section 6.2, then the repurchase price shall be the standard cost of such Inventories as shown on the books and records of Buyer. The repurchase price for Fixed Assets shall equal the depreciated value of such Fixed Assets that would be shown on the books and records of Seller if Seller had continued to own such Fixed Assets on the date of the closing of the divestiture of the Acquisition Assets. The repurchase price for the Fixed Assets and Inventories pursuant to this Section 6.3(b) shall be determined by Buyer within fifteen (15) days of the occurrence of an event that gives Buyer the right to trigger a repurchase pursuant to this Section. Thereafter, Parent may object to such determination using the same framework as set forth in Section 6.2(e) hereof and payment shall be made by Parent pursuant to the provisions of Section 6.2(f) hereof. A transaction involving the sale of an Affected Business or a sale of Acquisition Assets subject to the repurchase obligations of Seller pursuant to Sections 6.3(a) or (b), is referred to as a "Disposition Transaction".

6.4 Consigned Inventories. In the event Seller has in Buyer's determination a reasonable amount of inventories related to the Business as of the Closing Date in excess of the Inventories, the Parties may reasonably agree that such inventory (the "**Consigned Inventory**")

shall remain at the Facility following the Closing Date without charge to Seller or Adaptec and Seller and Adaptec shall be given reasonable access to such inventory. Following each exercise of the Put Right, any Unused Inventory shall remain at the Facility following such exercise and thereafter be treated as Consigned Inventory without charge to Seller or Adaptec and Seller and Adaptec shall be given reasonable access to such inventory. During the period reasonably determined by the Buyer (the “**Consignment Period**”), Buyer agrees that, in the event Buyer requires inventories of the same kind and nature as, and in addition to, the Inventories purchased on the Closing Date for the manufacture of the products of the Business for delivery to Seller, Parent and Buyer shall use the Consigned Inventories to the extent reasonably possible. In the event Parent or Buyer use the Consigned Inventories to manufacture products for Seller, Parent or Buyer shall pay Seller the then standard costs of such inventories on the date of purchase thereof. Following the Consignment Period, Seller may remove the Consigned Inventory from the Facility upon reasonable prior written notice to Buyer and Parent, and Seller shall remove such Consigned Inventory within a reasonable time following Buyer’s request to Seller to remove such Consigned Inventory.

ARTICLE VII

CONDITIONS TO THE CLOSING

7.1 Conditions to Parent’s and Buyer’s Obligation to Close. The obligations of Parent and Buyer hereunder are subject to the fulfillment or satisfaction on, and as of the Closing, of each of the following conditions (any one or more of which may be waived by Parent, but only in a writing signed by Parent):

- (a) Representations and Warranties. The representations and warranties of Seller set forth in Article III that are qualified as to materiality or Material Adverse Effect, or in Sections 3.1, 3.2 or 3.3 shall be true and correct, and those that are not so qualified shall be true and correct in all material respects, in each case as of the date of this Agreement, and as of the Closing with the same force and effect as if made on and as of the Closing (except to the extent expressly made as of a particular date, in which case as of such date).
- (b) Covenants. Seller shall have performed or complied in all material respects with all agreements and covenants required by this Agreement to be performed or complied with by Seller on or prior to the Closing.
- (c) No Actions. No action, suit, or proceeding shall be threatened or pending before any court or quasi-judicial or administrative agency of any non-U.S. or any U.S. federal, state or local jurisdiction or before any arbitrator wherein an unfavorable injunction, judgment, order, decree, ruling, or charge would, if successful, (A) prevent consummation of any of the Transactions contemplated by this Agreement, or (B) result in a Material Adverse Effect to Seller of the Purchased Assets.
- (d) Closing Certificates. Seller shall have delivered to Parent an officer’s certificate to the effect that each of the conditions specified above in Section 7.1(a) to 7.1(c) (inclusive) is satisfied in all respects.

- (e) Third Party Consents. All consents (or waivers in lieu thereof) to the performance by Parent, Buyer and Seller of their respective obligations under this Agreement and the Ancillary Agreements or to the consummation of the Transaction, listed on Schedule 7.1(e), (i) shall have been obtained, (ii) shall be in form and substance satisfactory to Parent, and (iii) shall be in full force and effect.
- (f) Delivery of Documents. Seller will have delivered to Buyer the following documents:
- (i) the Assumption Instruments, the Transition Services Agreement, the Escrow Agreement and the Employee Secondment Agreement;
 - (ii) all documents necessary to effect the transfer of the Purchased Assets and the Assumed Liabilities as listed in 7.1(f)(ii);
 - (iii) the Seller Books and Records;
 - (iv) assignment instruments with regard to the Assigned Contracts and the Assumed Permits, including, to the extent required, consents to the assignments from all Persons whose consent is required for such assignment;
 - (v) consents from all Persons to discharge any Lien (other than Permitted Liens) existing as of the Closing on the Purchased Assets, the Business or the Facility set forth in Schedule 7.1(f)(v); and
- (g) Material Adverse Effect. There shall not have been a Material Adverse Effect on the Business or the Purchased Assets, taken as a whole, nor shall there have occurred any event or development that could reasonably be expected to result in the future in a Material Adverse Effect on the Purchased Assets, taken as a whole.
- (h) Schedules. Seller shall have delivered to Buyer Schedule 1.1(v), Schedule 1.1(aa) and Schedule 1.1(mm) at least three (3) business days prior to the Closing Date.
- (i) Board of Directors. Buyer shall have received a certified copy of the resolutions of the board of directors of Seller executed by an officer of Seller approving this Agreement, the sale and transfer of the Purchased Assets to Buyer pursuant to this Agreement, and the Ancillary Agreements.
- (j) Preliminary Fixed Asset and Inventories Statement. Seller shall have executed and delivered to Buyer the Preliminary Fixed Asset and Inventories Statement and a statement indicating the Preliminary Net Asset Value.
- (k) Delivery of Documents. Seller will have delivered to Buyer the following documents:
- (i) the Ancillary Agreements executed by Seller; and

(ii) assumption instruments with regard to the Assigned Contracts and the Assumed Licenses.

(l) No Actions. No action, suit, or proceeding shall be threatened or pending before any court or quasi-judicial or administrative agency of any non-U.S. or any U.S. federal, state or local jurisdiction or before any arbitrator wherein an unfavorable injunction, judgment, order, decree, ruling, or charge would, if successful, (A) prevent consummation of any of the Transactions contemplated by this Agreement, or (B) result in a Material Adverse Effect to the Business or the Purchased Assets.

7.2 Conditions to Seller's Obligations. The obligations of Seller hereunder are subject to the fulfillment or satisfaction on, and as of the Closing, of each of the following conditions (any one or more of which may be waived by Seller, but only in writing signed by Seller):

(a) Representations and Warranties. The representations and warranties of Parent and Buyer set forth in Article IV that are qualified as to materiality or Material Adverse Effect, or in Sections 4.1, 4.2 or 4.3 shall be true and correct, and those that are not so qualified shall be true and correct in all material respects, in each case as of the date of this Agreement, and as of the Closing with the same force and effect as if made on and as of the Closing (except to the extent expressly made as of a particular date, in which case as of such date).

(b) Covenants. Parent and Buyer shall have performed or complied in all material respects with all agreements and covenants required by this Agreement to be performed or complied with by them on or prior to the Closing.

(c) Closing Certificate. Parent shall have delivered to Seller an officer's certificate to the effect that each of the conditions specified above in Section 7.2(a) and 7.2(b) is satisfied in all respects.

(d) Board of Directors. Seller shall have received a certified copy of the resolutions of the board of directors of Buyer approving this Agreement, the sale and transfer of the Purchased Assets to Buyer, and the Ancillary Agreements.

(e) Purchase Price. Seller shall have received the Purchase Price and the GST Tax Amount.

(f) Delivery of Documents. Buyer will have delivered to Seller the following documents:

(i) the Assumption Instruments, the Transition Service Agreement, the Escrow Agreement and the Employee Secondment Agreement; and

(ii) assumption instruments with regard to the Assigned Contracts and the Assumed Licenses.

(g) Material Adverse Effect. There shall not have been a Material Adverse Effect on Parent or Buyer, taken as a whole, nor shall there have occurred any event or

development that could reasonably be expected to result in the future in a Material Adverse Effect on Parent or Buyer, taken as a whole.

(h) **No Actions.** No action, suit, or proceeding shall be threatened or pending before any court or quasi-judicial or administrative agency of any non U.S. or any U.S. federal, state or local jurisdiction or before any arbitrator wherein an unfavorable injunction, judgment, order, decree, ruling, or charge would, if successful, (A) prevent consummation of any of the Transactions contemplated by this Agreement, or (B) result in a Material Adverse Effect to Parent or Buyer.

ARTICLE VIII

SURVIVAL OF REPRESENTATIONS, WARRANTIES AND COVENANTS

8.1 **Representations, Warranties and Covenants.** The covenants contained in this Agreement shall survive the applicable Closing Date in accordance with their terms. The representations and warranties contained in this Agreement and the Ancillary Agreements shall survive the applicable Closing Date for a period of twelve (12) months (such date upon which they expire being referred to herein as the “**Survival Date**”) and shall thereafter expire; *provided, however*, that notwithstanding the foregoing (i) the representations and warranties of Seller contained in Section 3.16 (Environment, Health and Safety) shall survive the Closing Date for a period of twenty-four (24) months. Buyer’s or Parent’s (or any Buyer Indemnitee’s) right to make a claim for indemnification under Section 9.1, and Seller’s (or any Seller Indemnitee’s) right to make a claim for indemnification under Section 9.2, shall expire with respect to such claims which are not made on or prior to the date, if any, on which the survival period for such representation or warranty expires. Any claims under Article IX must be asserted in writing with reasonable particularity by the party making such claim, including indemnifying the basis of the claim and estimate of the potential Damages covered thereby.

ARTICLE IX

INDEMNIFICATION

9.1 **Indemnification by Seller.** Subject to this Section 9, Seller agrees to defend, indemnify and hold harmless Parent and Buyer and their respective successors, assigns and Affiliates (individually, a “**Buyer Indemnitee**”, and collectively, the “**Buyer Indemnitees**”) from and against and in respect of any and all losses, damages, deficiencies, liabilities, assessments, judgments, costs and expenses, including attorneys’ fees (both those incurred in connection with the defense or prosecution of the indemnifiable claim and those incurred in connection with the enforcement of this provision), net of insurance proceeds received by the Buyer Indemnitee with respect thereto (collectively, “**Damages**”) suffered or incurred by any Buyer Indemnitee which is caused by, resulting from or arising out of:

(a) any breach of any representation, warranty or covenant of Seller contained in this Agreement or in any Ancillary Agreement, or other agreement, certificate, instrument or other document entered into or delivered by Seller at the Closing in connection herewith (it being

understood and agreed that solely for purposes of determining the amount of Damages for purposes of the indemnification obligations set forth in this Article IX, all qualifications as to “materiality,” and all “Material Adverse Effect” qualifications, contained in such representations and warranties shall be disregarded and have no force or effect);

- (b) any Excluded Liabilities;
- (c) Taxes of Seller to the extent provided in Section 2.6;
- (d) Liabilities of Seller, whether arising before or after the Closing Date, arising from or relating to the ownership or actions or inactions of Seller or the conduct of the Business prior to the Closing; and
- (e) any and all Damages suffered or incurred by Buyer Indemnitee by reason of or in connection with any claim or cause of action of any third party to the extent arising out of the operation of the Business prior to the Closing.

To the extent that Seller’s undertakings set forth in this Section 9.1 may be unenforceable, Seller shall contribute the maximum amount that it is permitted to contribute under applicable Law to the payment and satisfaction of all Damages incurred by Buyer Indemnitee.

9.2 Indemnification by Buyer and Parent. Subject to this Article IX, the Buyer and Parent each joint and severally agrees to defend, indemnify and hold harmless the Seller and its respective successors, assigns and Affiliates (individually, a “**Seller Indemnitee**”, and collectively, the “**Seller Indemnitees**”) from and against and in respect of any and all Damages suffered or incurred by any Seller Indemnitee which is caused by, resulting from or arising out of:

- (a) any breach of any representation, warranty or covenant of Buyer contained in this Agreement, or in any Ancillary Agreement, or other agreement, certificate, instrument or other document entered into or delivered by any Buyer at the Closing in connection herewith (it being understood and agreed that solely for purposes of determining the amount of Damages for purposes of the indemnification obligations set forth in this Article IX, all qualifications as to “materiality,” and all “Material Adverse Effect” qualifications, contained in such representations and warranties shall be disregarded and have no force or effect); and
- (b) any Assumed Liabilities or Assigned Contracts arising out of circumstances existing after the Closing Date;
- (c) Taxes of Buyer to the extent provided in Section 2.6.
- (d) Liabilities of Buyer or Parent arising from or relating to the ownership or actions or inactions of Buyer and Parent or the conduct of the Business on or after the Closing; and

(e) any and all Damages suffered or incurred by Seller Indemnitee by reason of or in connection with any claim or cause of action of any third party prior to the extent arising out of the operation of the Business on or after the Closing.

To the extent that Buyers or Parent's undertakings set forth in this Section 9.2 may be unenforceable, Buyer and/or Parent shall contribute the maximum amount that it is permitted to contribute under applicable Law to the payment and satisfaction of all Damages incurred by Seller Indemnities.

9.3 **Notice and Opportunity to Defend.** If any action, proceeding, claim, liability, demand or assessment shall be asserted against any Buyer Indemnitee or any Seller Indemnitee (the "**Indemnitee**") in respect of which such Indemnitee proposes to demand indemnification, such Indemnitee shall notify the party obligated to provide indemnification pursuant to Section 9.1 or Section 9.2 (the "**Indemnifying Party**") thereof within a reasonably prompt period of time after assertion thereof; *provided, however*, that the failure to so notify the Indemnifying Party shall only affect the Indemnitee's right to indemnification hereunder to the extent that the Indemnifying Party's interests are actually and materially prejudiced thereby. Subject to rights of or duties to any insurer or other third Person having liability therefor, the Indemnifying Party shall have the right, within ten (10) days after receipt of such notice, to assume the control of the defense, compromise or settlement of any such action, suit, proceeding, claim, liability, demand or assessment, and to retain counsel in connection therewith; *provided, however*, that if the Indemnifying Party shall exercise its right to assume such control:

(a) the Indemnitee may, in its sole discretion and at its own expense, employ separate counsel to represent it in any such matter, and in such event counsel selected by the Indemnifying Party shall be required to cooperate with such counsel of the Indemnitee in such defense, compromise or settlement for the purpose of informing and sharing information with such Indemnitee;

(b) for any subject matter, the Indemnitee will, at its own expense, make available to the Indemnifying Party those employees of the Indemnitee or any Affiliate of the Indemnitee whose assistance, testimony or presence is necessary to assist the Indemnifying Party in evaluating and in defending any such action, suit, proceeding, claim, liability, demand or assessment; *provided, however*, that any such access shall be conducted in such a manner as not to interfere unreasonably with the business activities of the Indemnitee and its Affiliates;

(c) the Indemnifying Party shall not compromise or settle any such action, suit, proceeding, claim, liability or assessment without the consent of the Indemnitee, which consent shall not be unreasonably withheld or delayed;

(d) in the event that any action, suit, proceeding, claim, liability or assessment (or the compromise or settlement thereof) involves a claim for (i) injunctive relief that affects or could reasonably be expected to affect the Business in material any respect, or (ii) a claim for damages (or a claim that could reasonably be expected to result in damages) in excess of limitations set forth in Section 9.5(c) and Section 9.5(g), Parent shall have the right to control the defense and settlement thereof, at the sole cost and expense of the Indemnified Party (subject to the limitations set forth in Article IX and subject to the Indemnified Party's right to make a claim

for Damages in respect of such cost and expense if appropriate); *provided, however*, that Parent shall not compromise or settle any such action, suit, proceeding, claim, liability or assessment without the consent of the Indemnifying Party, which consent shall not be unreasonably withheld or delayed.

9.4 **Remedies.** Except for the right to seek to specifically enforce the covenants hereunder, and except as specifically provided in this Agreement (including, without limitation, the immediately succeeding sentence), following the Closing Date, in the absence of fraud or intentional misrepresentation (a “**Fraud Claim**”), the sole and exclusive remedy of both Buyer and Seller with respect to any breach of any representation or warranty contained in this Agreement, or any Ancillary Agreement or in any agreement, certificate, instrument or other document entered into in connection herewith at the Closing or any covenant or agreement in this Agreement, shall be restricted to the indemnification rights set forth in this Article IX. Nothing contained in this Article IX or elsewhere in this Agreement shall limit the liability of either Party under this Agreement if this Agreement is terminated pursuant to Section 10.1 or otherwise, or if the transactions contemplated hereby shall not be consummated for any reason. The foregoing notwithstanding, except for a Fraud Claim, a Party shall have no further obligations under this Article IX with respect to Damages arising from a breach of a representation or warranty contained in Article III or Article IV in the event the other Party waives in writing such Party’s satisfaction of the closing condition under Section 7.1(a) or Section 7.2(a), as the case may be, due to such breach and closes the transaction.

9.5 **Certain Limitations.** The liability of the Seller, Parent or the Buyer, as applicable, for claims under this Agreement shall be limited by the following:

(a) At any time after the applicable Survival Date for a representation and warranty, (i) the Seller shall have no further obligations under this Article IX for breaches of such representations and warranties of the Seller, except for Damages with respect to which the Buyer Indemnitee has timely given the Seller written notice prior to such date in accordance with Sections 8.1 and 9.3 and (ii) the Buyer shall have no further obligations under this Article IX for breaches of such representations and warranties of the Buyer, except for Damages with respect to which the Seller Indemnitee has given the Buyer written notice prior to such date in accordance with Sections 8.1 and 9.3.

(b) Notwithstanding anything to the contrary herein, except with respect to Fraud Claims, any claim by a Buyer Indemnitee against Seller pursuant to Section 9.1(a) shall be payable by Seller only in the event that the accumulated amount of Damages in respect of Seller’s obligations to indemnify the Buyer Indemnitees under this Agreement shall exceed \$100,000 in the aggregate (the “**Seller Indemnification Threshold**”); *provided, however*, that at such time as the aggregate amount of Damages in respect of the indemnity obligations of Seller shall exceed the Seller Indemnification Threshold, Seller shall thereafter be liable for all Damages suffered or incurred by the Buyer Indemnitees in excess of such initial \$100,000 of Damages.

(c) Notwithstanding anything to the contrary herein, except with respect to Fraud Claims (for which there shall be no limitation), in no event shall the maximum aggregate liability of Seller in respect of any claims by the Buyer Indemnitees against Seller pursuant to

Section 9.1(a) for Damages suffered or incurred by any Buyer Indemnitees exceed 10% of the value of the Purchase Price (as adjusted pursuant to Section 2.4), except that with respect to Damages suffered or incurred by any Buyer Indemnitee due to a breach of Section 3.16 the maximum aggregate liability of Seller shall be 20% of the value of the Purchase Price (as adjusted pursuant to Section 2.4).

(d) Notwithstanding anything to the contrary herein, the limitations contained in this Section 9.5 shall not apply to claims for indemnification by Buyer Indemnitees against Seller in pursuant to Sections 9.1(b), 9.1(c), 9.1(d), and 9.1(e); *provided, however*, that except for Fraud Claims, Buyer's or Parent's (or any Buyer Indemnitee's) right to make a claim for indemnification under Sections 9.1(b), 9.1(c), 9.1(d), and 9.1(e) shall expire with respect to such claims which are not made on or prior to the date five years following the Closing Date.

9.6 Environmental Covenants. The obligations and rights of the Buyer Indemnitees and Seller Indemnitees with respect to indemnification for Environmental Liabilities under this Article IX (whether as an Excluded Liability, Assumed Liability or as a result of a representation or warranty made in this Agreement), collectively the "**Environmental Covenants**," are in addition to, independent from, and severable from the rights and obligations of said parties under all other provisions of this Agreement. It is expressly acknowledged by all parties hereto that neither the acts or omissions of any party hereto, nor any failure of any condition or breach of a representation contained in this Agreement, any Ancillary Agreements, or any other agreements entered into in connection therewith, shall impair the rights of Seller Indemnitees or Buyer Indemnitees to enforce the Environmental Covenants for their benefit, it being understood that the Environmental Covenants are being given in consideration of the closing of the transactions contemplated by this Agreement. The Environmental Covenants shall survive the sale, transfer, assignment, or hypothecation of any ownership interest in a party benefited hereby or obligated hereunder and the sale, transfer, assignment, or hypothecation of the business activities of the Facility or Purchased Assets or the real property at which the Facility is located, or any portion thereof or interest therein, by any Parent, Buyer or Seller to any Person.

9.7 Escrow. With respect to any claims for indemnification, Buyer shall first proceed against the Escrow with respect to claims Buyer has for indemnification pursuant to this Section 9. In the event the Escrow is not sufficient to satisfy any valid indemnification claim of Buyer, or in the event such claim is made in accordance with the provisions of this Section 9 after the Escrow has terminated and recourse to such claim properly be made beyond the escrow, then Seller shall remain obligated to satisfy such indemnification claim of Buyer in full (subject to the other limitations in this Article IX).

ARTICLE X
TERMINATION

10.1 Termination of the Agreement. The Parties may terminate this Agreement as provided below:

- (a) Parent and Seller may terminate this Agreement as to all Parties by mutual written consent at any time prior to the Closing;
- (b) Parent or Seller may terminate this Agreement by written notice if the Closing has not occurred by January 31, 2006; *provided, however*, that the right to terminate this Agreement under this Section 10.1(b)(i) shall not be available to any Party whose action or failure to act has been a principal cause of or resulted in the failure of the Closing to occur on or before such date and such action or failure to act constitutes a breach of this Agreement;
- (c) Parent or Seller may terminate this Agreement by written notice if: (i) there shall be a final nonappealable order of a court of competent jurisdiction in effect preventing consummation of the transactions contemplated by this Agreement or (iii) there shall be any statute, rule, regulation or order enacted, promulgated or issued or deemed applicable to the transactions contemplated by this Agreement by any Governmental Body that would make consummation of the transactions contemplated by this Agreement illegal;
- (d) Parent or Seller if (i) there shall be a final nonappealable order of a court competent jurisdiction in effect preventing consummation of the transactions contemplated by this Agreement or (ii) there shall be any statute, rule, regulation or order enacted, promulgated or issued or deemed applicable to the transactions contemplated by this Agreement by any Governmental Body that would make consummation of the transactions contemplated by this Agreement illegal.
- (e) Parent may terminate this Agreement by written notice if there shall be any action taken, or any statute, rule, regulation or order enacted, promulgated or issued or deemed applicable to the transactions contemplated by this Agreement by any Governmental Body, which would (i) prohibit Parent's or Buyer's ownership or operation of all or a material portion of the Business or the Purchased Assets or (ii) compel Parent or Buyer to dispose of or hold separate all or a material portion of the business or assets of Parent or Seller as a result of the transactions contemplated by this Agreement;
- (f) Parent may terminate this Agreement by written notice if it is not in material breach of its obligations under this Agreement and there has been a material breach of any representation, warranty, covenant or agreement contained in this Agreement on the part of Seller and such breach has not been cured within thirty (30) calendar days after written notice to Seller; *provided, however*, that, no cure period shall be required for a breach which by its nature cannot be cured;
- (g) Seller may terminate this Agreement by written notice if it is not in material breach of its obligations under this Agreement and there has been a material breach of any representation, warranty, covenant or agreement contained in this Agreement on the part of

Parent or Buyer and such breach has not been cured within thirty (30) calendar days after written notice to Parent; *provided, however*, that no cure period shall be required for a breach which by its nature cannot be cured; and

(h) Parent may terminate this Agreement by written notice if an event having a Material Adverse Effect or that may be expected to have a Material Adverse Effect on the Business or on the Purchased Assets shall have occurred after the date of this Agreement.

10.2 Effect of Termination. If any Party terminates this Agreement pursuant to Section 10.1 above, all rights and obligations of the Parties hereunder shall terminate without any liability of any Party to any other Party (except for any liability of any Party then in breach); *provided* that each Party shall remain liable for any breaches of this Agreement prior to its termination and *provided, further*, that the provisions contained in Section 5.8 (confidentiality) and Article XI (miscellaneous) shall survive termination.

ARTICLE XI

MISCELLANEOUS

11.1 Press Releases and Public Announcements. No Party shall issue any press release or make any public announcement relating to the subject matter of this Agreement without the prior written approval of the other Party; *provided, however*, that (a) either Party may make any public disclosure it believes in good faith is required by applicable law or any listing or trading agreement concerning its publicly-traded securities (in which case such Party will use its reasonable efforts to advise the other Parties prior to making the disclosure) and (b) Seller may correspond with third parties in writings in form and substance reasonably satisfactory to Parent with respect to obtaining consents from such parties pursuant to Section 7.1(f).

11.2 No Third-Party Beneficiaries. Except as provided in Article IX with respect to indemnification, this Agreement shall not confer any rights or remedies upon any Person other than the Parties, and their respective successors and permitted assigns, other than as specifically set forth herein.

11.3 Entire Agreement and Modification. This Agreement (including the exhibits hereto) and the Ancillary Agreements constitutes the entire agreement among the Parties with respect to the subject matter hereof and supersedes any prior understandings, agreements, warranties or representations by or among the Parties, written or oral, to the extent they related in any way to the subject matter hereof..

11.4 Amendment. This Agreement may be amended by the Parties hereto at any time by execution of an instrument in writing signed on behalf of each of the Parties hereto.

11.5 Waivers. The rights and remedies of the Parties to this Agreement are cumulative and not alternative. Neither the failure nor any delay by any Party in exercising any right, power or privilege under this Agreement or the documents referred to in this Agreement will operate as a waiver of such right, power or privilege, and no single or partial exercise of such right, power, or privilege will preclude any other or further exercise of such right, power, or privilege or the

exercise of any other right, power, or privilege. To the maximum extent permitted by applicable law, (i) no claim or right arising out of this Agreement or the documents referred to in this Agreement can be discharged by one Party, in whole or in part, by a waiver or renunciation of the claim or right unless in writing signed by the other Party; (ii) no waiver that may be given by a Party will be applicable except in the specific instance for which it is given; and (iii) no notice to or demand on one Party will be deemed to be a waiver of any obligation of such Party or of the right of the Party giving such notice or demand to take further action without notice or demand as provided in this Agreement or the documents referred to in this Agreement.

11.6 Successors and Assigns. This Agreement shall be binding upon and inure to the benefit of the Parties named herein and their respective successors and permitted assigns. No Party may assign either this Agreement or any of its rights, interests, or obligations hereunder without the prior written approval of the other Parties; *provided, however*, that so long as Parent remains liable for all obligations under this Agreement, Parent may (i) assign any or all of its rights and interests hereunder to one or more of its Affiliates and (ii) designate one or more of its Affiliates to perform its obligations hereunder.

11.7 Counterparts. This Agreement may be executed in counterparts, each of which shall be deemed an original but all of which together will constitute one and the same instrument.

11.8 Headings. The section headings contained in this Agreement are inserted for convenience only and shall not affect in any way the meaning or interpretation of this Agreement.

11.9 Notices. All notices and other communications required or permitted hereunder shall be in writing, shall be effective when given, and shall in any event be deemed to be given upon receipt or, if earlier, (a) upon delivery, if delivered by hand, (b) three Business Days after the Business Day of deposit with Federal Express or similar overnight courier, freight prepaid or (c) one Business Day after the Business Day of facsimile transmission, if delivered by facsimile transmission with copy by Federal Express or similar overnight courier, freight prepaid, and shall be addressed to the intended recipient as set forth below:

If to Parent or Buyer:

Sanmina-SCI Corporation
2700 North First Street
San Jose, CA 95134
Attention: Robin Walker, Senior Vice President, Corporate Development
Steven Jackman, Vice President and Corporate Counsel
Telephone No.: (408) 964-3500
Facsimile No.: (408) 964-3636

Copy to:

Wilson Sonsini Goodrich & Rosati, Professional Corporation
650 Page Mill Road
Palo Alto, California 94304
Attention: Christopher D. Mitchell, Esq.
Facsimile No.: (650) 493-6811

If to Seller:

Marshall Mohr
Chief Financial Officer
Adaptec, Inc.
691 S. Milpitas Boulevard
Milpitas, CA 95035
Fax: (408) 957-1682

Copy to:

Randy Gast
Vice President of Global Operations
Adaptec, Inc.
691 S. Milpitas Boulevard
Milpitas, CA 95035
Fax: (408) 957-7185

Copy to:

Fenwick & West LLP
275 Battery Street, Suite 1600
San Francisco, California 94111
Attention: Samuel B. Angus, Esq.
Facsimile No.: (415) 281-1350

Any Party may change the address to which notices, requests, demands, claims, and other communications hereunder are to be delivered by giving the other Parties ten (10) days' advance written notice to the other Parties pursuant to the provisions above.

11.10 Governing Law. This Agreement shall be governed in all respects solely by the substantive laws of the State of California, without regard to conflicts of laws or the choice of law principles of any jurisdiction including the State of California, and without the need of any Party to establish the reasonableness of the relationship between the laws of the State of California and the subject matter of this Agreement, and all questions concerning the validity and construction hereof shall be determined in accordance with the laws of the State of California. Notwithstanding the foregoing, the Employee Secondment Agreement and the Facility Transfer Agreement will be governed by the laws of the Republic of Singapore.

11.11 Severability. Any term or provision of this Agreement that is invalid or unenforceable in any situation in any jurisdiction shall not affect the validity or enforceability of the remaining terms and provisions hereof or the validity or enforceability of the offending term or provision in any other situation or in any other jurisdiction.

11.12 Expenses. Subject to the provisions of this Agreement, each Party will bear its own costs and expenses (including legal and accounting fees and expenses) incurred in connection with this Agreement and the transactions contemplated hereby.

11.13 Construction.

(a) The Parties have participated jointly in the negotiation and drafting of this Agreement. In the event an ambiguity or question of intent or interpretation arises, this Agreement shall be construed as if drafted jointly by the Parties and no presumption or burden of proof shall arise favoring or disfavoring any Party by virtue of the authorship of any of the provisions of this Agreement. Any reference to any federal, state, local, or foreign statute or law shall be deemed also to refer to all rules and regulations promulgated thereunder, unless the context requires otherwise. The word "including" shall mean including without limitation.

(b) Unless the context requires otherwise, all words used in this Agreement in the singular number shall extend to and include the plural, all words in the plural number shall extend to and include the singular, and all words in any gender shall extend to and include all genders.

11.14 Seller Disclosure Letter.

(a) The disclosures in Seller Disclosure Letter, and those in any supplement thereto, must relate only to the representations and warranties in the section of the Agreement to which they expressly relate and to any other representation or warranties in this Agreement to the extent it is readily apparent that such disclosures relate to such other representations and warranties.

(b) Statements contained within the Seller Disclosure Letter shall be deemed to be representations and warranties under this Agreement.

11.15 Attorneys' Fees. If any legal proceeding or other action relating to this Agreement is brought or otherwise initiated, the prevailing Party shall be entitled to recover reasonable attorneys' fees, costs and disbursements (in addition to any other relief to which the prevailing Party may be entitled).

11.16 Further Assurances. The Parties agree (a) to furnish upon request to each other such further information, (b) to execute and deliver to each other such other documents, and (c) to do such other acts and things, all as the other Party may reasonably request for the purpose of carrying out the intent of this Agreement and the documents referred to in this Agreement.

11.17 Time of Essence. With regard to all dates and time periods set forth or referred to in this Agreement, time is of the essence.

11.18 Consent to Jurisdiction. Subject to Section 11.2 above, the competent court in Santa Clara, California (the "**Competent Court**") (and not any other court in any state or country) shall have exclusive jurisdiction in connection with this Agreement. Subject to Section 11.2 above, each Party hereby irrevocably submits to the exclusive jurisdiction of the Competent Court in any action or proceeding arising out of or relating to this Agreement and irrevocably waives any objection such person may now or hereafter have as to the venue of any such suit, action or proceeding brought in the Competent Court or that the Competent Court is an inconvenient forum.

11.19 Schedules and Exhibits. The Schedules and Exhibits described herein and attached hereto constitute an inseparable part of this Agreement and are incorporated into this Agreement for all purposes as if fully set forth herein. Any disclosure made in any Schedule to this Agreement which may be applicable to another Schedule to this Agreement shall be deemed to be made with respect to such other Schedule only if a specific cross reference is made thereto or if it is readily apparent that such disclosure should apply to such other Schedule.

IN WITNESS WHEREOF, the Parties hereto have executed this Agreement on of the date first above written.

Parent: **SANMINA-SCI CORPORATION**

By: /s/ Jure Sola
Name: Jure Sola
Title: Chief Executive Officer

Buyer: **SANMINA-SCI SYSTEMS SINGAPORE PTE. LTD.**

By: /s/ Jure Sola
Name: Jure Sola
Title: Chief Executive Officer

Seller: **ADAPTEC MANUFACTURING (S) PTE. LTD.**

By: /s/ Marshall Mohr
Name: Marshall Mohr
Title: VP&CFO, Adaptec, Inc.

Exhibit A
Transition Services Agreement
(See Tab 4)

Exhibit B
Employee Secondment Agreement
(See Tab 5)

Exhibit C
Facility Transfer Agreement
(See Tab 6)

Exhibit D
Manufacturing Services and Supply Agreement
(See Tab 7)

Confidential Treatment Requested. Certain portions of this document have been omitted pursuant to a request for confidential treatment and, where applicable, have been marked with an asterisk to denote where omissions have been made. The confidential material has been filed separately with the Securities and Exchange Commission.

**AMENDMENT TO
MANUFACTURING SERVICES AND SUPPLY AGREEMENT**

THIS AMENDMENT TO MANUFACTURING SERVICES AND SUPPLY AGREEMENT (the “**Amendment**”) with an effective date as of the Closing Date is made and entered into by and between **ADAPTEC, INC.**, a Delaware corporation having a place of business at 691 S, Milpitas Blvd., Milpitas, California 95035, on behalf of itself and its Affiliates (collectively, “**ADAPTEC**”), and **SANMINA-SCI CORPORATION**, a Delaware corporation having its principal place of business at 2700 North First Street, San Jose, California 95134, on behalf of itself and its Affiliates (collectively “**SANMINA-SCI**”). ADAPTEC and SANMINA-SCI are sometimes individually referred to herein as a “**Party**” and collectively referred to herein as the “**Parties**”. Capitalized terms used in this Amendment that are not defined below or elsewhere in this Amendment are defined in the Manufacturing Services and Supply Agreement or the Asset Purchase Agreement dated December 23, 2005 among the parties and their Singapore subsidiaries (the “Asset Purchase Agreement”) and will have the meaning given to such terms in the Asset Purchase Agreement or the Manufacturing Services and Supply Agreement, as the case may be.

RECITALS

A. The Parties have entered into a Manufacturing Services and Supply Agreement (“*Agreement*”) with an effective date as of the Closing Date.

B. The Parties wish to amend the Agreement in accordance with the terms herein contained.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, the Parties agree as follows:

1. Section 4.5 of the Agreement is hereby deleted in its entirety and replaced with the following:

4.5 Payment Terms. Payment terms for all Products purchased by a party hereunder are net * days after the date of the Invoice. The Parties acknowledge that these terms are intended to be “firm” (e.g., that payment is expected to be received on the * day after the Invoice date). ADAPTEC shall be *. On any invoices not paid by the due date, ADAPTEC shall pay interest from due date to the date of payment at the rate of 1.5% per month unless such invoice was disputed in good faith, in which case the interest rate shall be reduced to 1.0% per month. Unless otherwise stated, all prices are stated in and all payments shall be made in U.S. Dollars.

2. Except as set forth in this Amendment, the Agreement shall remain unchanged.

* Confidential treatment requested

**CERTIFICATION OF CHIEF EXECUTIVE OFFICER
PURSUANT TO SECTION 302 OF THE SARBANES-OXLEY ACT OF 2002**

I, Subramanian Sundaresh, certify that:

1. I have reviewed this quarterly report on Form 10-Q of Adaptec, Inc.;
2. Based on my knowledge, this report does not contain any untrue statement of a material fact or omit to state a material fact necessary to make the statements made, in light of the circumstances under which such statements were made, not misleading with respect to the period covered by this report;
3. Based on my knowledge, the financial statements, and other financial information included in this report, fairly present in all material respects the financial condition, results of operations and cash flows of the registrant as of, and for, the periods presented in this report;
4. The registrant's other certifying officer and I are responsible for establishing and maintaining disclosure controls and procedures (as defined in Exchange Act Rules 13a-15(e) and 15d-15(e)) and internal control over financial reporting (as defined in Exchange Act Rules 13a-15(f) and 15d-15(f)) for the registrant and have:
 - a) designed such disclosure controls and procedures, or caused such disclosure controls and procedures to be designed under our supervision, to ensure that material information relating to the registrant, including its consolidated subsidiaries, is made known to us by others within those entities, particularly during the period in which this report is being prepared;
 - b) designed such internal control over financial reporting, or caused such internal control over financial reporting to be designed under our supervision, to provide reasonable assurance regarding the reliability of financial reporting and the preparation of financial statements for external purposes in accordance with generally accepted accounting principles;
 - c) evaluated the effectiveness of the registrant's disclosure controls and procedures and presented in this report our conclusions about the effectiveness of the disclosure controls and procedures, as of the end of the period covered by this report based on such evaluation; and
 - d) disclosed in this report any change in the registrant's internal control over financial reporting that occurred during the registrant's most recent fiscal quarter (the registrant's fourth fiscal quarter in the case of an annual report) that has materially affected, or is reasonably likely to materially affect, the registrant's internal control over financial reporting; and
5. The registrant's other certifying officer and I have disclosed, based on our most recent evaluation of internal control over financial reporting, to the registrant's auditors and the audit committee of registrant's board of directors (or persons performing the equivalent function):
 - a) all significant deficiencies and material weaknesses in the design or operation of internal control over financial reporting which are reasonably likely to adversely affect the registrant's ability to record, process, summarize and report financial information; and
 - b) any fraud, whether or not material, that involves management or other employees who have a significant role in the registrant's internal control over financial reporting.

Date: February 7, 2006

/s/ SUBRAMANIAN SUNDARESH

Subramanian Sundaresh
Chief Executive Officer

**CERTIFICATION OF CHIEF FINANCIAL OFFICER
PURSUANT TO SECTION 302 OF THE SARBANES-OXLEY ACT OF 2002**

I, Marshall L. Mohr, certify that:

1. I have reviewed this quarterly report on Form 10-Q of Adaptec, Inc.;
2. Based on my knowledge, this report does not contain any untrue statement of a material fact or omit to state a material fact necessary to make the statements made, in light of the circumstances under which such statements were made, not misleading with respect to the period covered by this report;
3. Based on my knowledge, the financial statements, and other financial information included in this report, fairly present in all material respects the financial condition, results of operations and cash flows of the registrant as of, and for, the periods presented in this report;
4. The registrant's other certifying officer and I are responsible for establishing and maintaining disclosure controls and procedures (as defined in Exchange Act Rules 13a-15(e) and 15d-15(e)) and internal control over financial reporting (as defined in Exchange Act Rules 13a-15(f) and 15d-15(f)) for the registrant and have:
 - a) designed such disclosure controls and procedures, or caused such disclosure controls and procedures to be designed under our supervision, to ensure that material information relating to the registrant, including its consolidated subsidiaries, is made known to us by others within those entities, particularly during the period in which this report is being prepared;
 - b) designed such internal control over financial reporting, or caused such internal control over financial reporting to be designed under our supervision, to provide reasonable assurance regarding the reliability of financial reporting and the preparation of financial statements for external purposes in accordance with generally accepted accounting principles;
 - c) evaluated the effectiveness of the registrant's disclosure controls and procedures and presented in this report our conclusions about the effectiveness of the disclosure controls and procedures, as of the end of the period covered by this report based on such evaluation; and
 - d) disclosed in this report any change in the registrant's internal control over financial reporting that occurred during the registrant's most recent fiscal quarter (the registrant's fourth fiscal quarter in the case of an annual report) that has materially affected, or is reasonably likely to materially affect, the registrant's internal control over financial reporting; and
5. The registrant's other certifying officer and I have disclosed, based on our most recent evaluation of internal control over financial reporting, to the registrant's auditors and the audit committee of registrant's board of directors (or persons performing the equivalent function):
 - a) all significant deficiencies and material weaknesses in the design or operation of internal control over financial reporting which are reasonably likely to adversely affect the registrant's ability to record, process, summarize and report financial information; and
 - b) any fraud, whether or not material, that involves management or other employees who have a significant role in the registrant's internal control over financial reporting.

Date: February 7, 2006

/s/ MARSHALL L. MOHR

Marshall L. Mohr
Chief Financial Officer

**CERTIFICATION OF CHIEF EXECUTIVE OFFICER AND CHIEF FINANCIAL OFFICER
PURSUANT TO SECTION 906 OF THE SARBANES-OXLEY ACT OF 2002**

I, Subramanian Sundaresh, certify to the best of my knowledge based upon a review of the Quarterly Report on Form 10-Q of Adaptec, Inc. for the quarter ended December 31, 2005 (the "*Form 10-Q*"), that the Form 10-Q fully complies with the requirements of Section 13(a) or 15(d) of the Securities Exchange Act of 1934, as amended, and that information contained in the Form 10-Q fairly presents, in all material respects, the financial condition and results of operations of Adaptec, Inc. for the periods covered by the Form 10-Q.

Date: February 7, 2006

By: /s/ SUBRAMANIAN SUNDARESH
Subramanian Sundaresh
Chief Executive Officer

I, Marshall L. Mohr, certify to the best of my knowledge based upon a review of the Form 10-Q, that the Form 10-Q fully complies with the requirements of Section 13(a) or 15(d) of the Securities Exchange Act of 1934, as amended, and that information contained in the Form 10-Q fairly presents, in all material respects, the financial condition and results of operations of Adaptec, Inc. for the periods covered by the Form 10-Q.

Date: February 7, 2006

By: /s/ MARSHALL L. MOHR
Marshall L. Mohr
Chief Financial Officer